Right choice for ultimate yield

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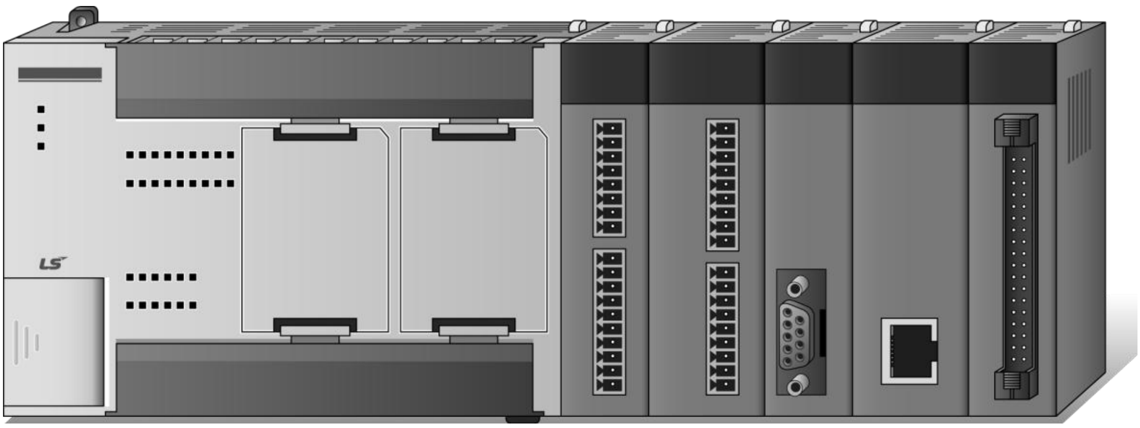
Programmable Logic Controller

XBC Standard/Economic Type Main Unit

XGT Series

User's Manual

Main unit	XBC-DR20SU	XBC-DR10E
	XBC-DN20S(U)	XBC-DN10E
	XBC-DP20SU	XBC-DP10E
	XBC-DR30SU	XBC-DR14E
	XBC-DN30S(U)	XBC-DN14E
	XBC-DP30SU	XBC-DP14E
	XBC-DR40SU	XBC-DR20E
	XBC-DN40SU	XBC-DN20E
	XBC-DP40SU	XBC-DP20E
	XBC-DR60SU	XBC-DR30E
	XBC-DN60SU	XBC-DN30E
	XBC-DP60SU	XBC-DP30E



Safety Instructions

- Read this manual carefully before installing, wiring, operating, servicing or inspecting this equipment.
- Keep this manual within easy reach for quick reference.

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Safety Instruction

Before using the product …

For your safety and effective operation, please read the safety instructions thoroughly before using the product.

- Safety Instructions should always be observed in order to prevent accident or risk with the safe and proper use the product.

- Instructions are separated into “Warning” and “Caution”, and the meaning of the terms is as follows;

⚠ **Warning**	This symbol indicates the possibility of serious injury or death if some applicable instruction is violated
⚠ **Caution**	This symbol indicates the possibility of slight injury or damage to products if some applicable instruction is violated

- The marks displayed on the product and in the user’s manual have the following meanings.

  ⚠ Be careful! Danger may be expected.

  ⚠ Be careful! Electric shock may occur.

- The user’s manual even after read shall be kept available and accessible to any user of the product.

Safety Instruction

Safety Instructions when designing

⚠ Warning

- **Please, install protection circuit on the exterior of PLC to protect the whole control system from any error in external power or PLC module.** Any abnormal output or operation may cause serious problem in safety of the whole system.
  - Install applicable protection unit on the exterior of PLC to protect the system from physical damage such as emergent stop switch, protection circuit, the upper/lowest limit switch, forward/reverse operation interlock circuit, etc.
  - If any system error (watch-dog timer error, module installation error, etc.) is detected during CPU operation in PLC, the whole output is designed to be turned off and stopped for system safety. However, in case CPU error if caused on output device itself such as relay or TR can not be detected, the output may be kept on, which may cause serious problems. Thus, you are recommended to install an addition circuit to monitor the output status.

- **Never connect the overload than rated to the output module nor allow the output circuit to have a short circuit**, which may cause a fire.

- **Never let the external power of the output circuit be designed to be On earlier than PLC power**, which may cause abnormal output or operation.

- **In case of data exchange between computer or other external equipment and PLC through communication or any operation of PLC (e.g. operation mode change), please install interlock in the sequence program to protect the system from any error**. If not, it may cause abnormal output or operation.

Safety Instruction

Safety Instructions when designing

⚠ Caution

- **I/O signal or communication line shall be wired at least 100mm away from a high-voltage cable or power line.** If not, it may cause abnormal output or operation.

Safety Instructions when designing

⚠ Caution

- **Use PLC only in the environment specified in PLC manual or general standard of data sheet.** If not, electric shock, fire, abnormal operation of the product or flames may be caused.

- **Before installing the module, be sure PLC power is off.** If not, electric shock or damage on the product may be caused.

- **Be sure that each module of PLC is correctly secured.** If the product is installed loosely or incorrectly, abnormal operation, error or dropping may be caused.

- **Be sure that I/O or extension connecter is correctly secured.** If not, electric shock, fire or abnormal operation may be caused.

- **If lots of vibration is expected in the installation environment, don’t let PLC directly vibrated.** Electric shock, fire or abnormal operation may be caused.

- **Don’t let any metallic foreign materials inside the product**, which may cause electric shock, fire or abnormal operation..

Safety Instruction

Safety Instructions when wiring

⚠Warning

- **Prior to wiring, be sure that power of PLC and external power is turned off.** If not, electric shock or damage on the product may be caused.

- **Before PLC system is powered on, be sure that all the covers of the terminal are securely closed.** If not, electric shock may be caused

⚠Caution

- **Let the wiring installed correctly after checking the voltage rated of each product and the arrangement of terminals.** If not, fire, electric shock or abnormal operation may be caused.

- **Secure the screws of terminals tightly with specified torque when wiring.** If the screws of terminals get loose, short circuit, fire or abnormal operation may be caused.

*

- **Surely use the ground wire of Class 3 for FG terminals, which is exclusively used for PLC**. If the terminals not grounded correctly, abnormal operation may be caused.

- **Don't let any foreign materials such as wiring waste inside the module while wiring,** which may cause fire, damage on the product or abnormal operation.

Safety Instruction

Safety Instructions for test-operation or repair

⚠ Warning

- **Don't touch the terminal when powered**. Electric shock or abnormal operation may occur.

- **Prior to cleaning or tightening the terminal screws, let all the external power off including PLC power.** If not, electric shock or abnormal operation may occur.

- **Don't let the battery recharged, disassembled, heated, short or soldered**. Heat, explosion or ignition may cause injuries or fire.

⚠ Caution

- **Don't remove PCB from the module case nor remodel the module.** Fire, electric shock or abnormal operation may occur.

- **Prior to installing or disassembling the module, let all the external power off including PLC power.** If not, electric shock or abnormal operation may occur.

- **Keep any wireless installations or cell phone at least 30cm away from PLC**. If not, abnormal operation may be caused.

Safety Instructions for waste disposal

⚠ Caution

- **Product or battery waste shall be processed as industrial waste.** The waste may discharge toxic materials or explode itself.

Revision History

Version	Date	Remark	Page
V 1.0	2010.3	1. First Edition	-
V 1.1	2010.12	1. XGB output module added (XBC-RY08B, XBE-DC16B) 2. Error fixed 3. Sequence diagram on troubleshooting fixed	
V 1.2	2010.12	1. XGB SU type added (XBC-DN20SU, XBC-DN30SU) 2. RTC option board added (XBO-RTCA)	- Chapter 9
V 1.3	2011.06	1. XGB SU type added (XBC-DN40SU, XBC-DN60SU, XBC-DR40SU, XBC-DR60SU) 2. XGB option module added (XBO-DC04A, XBC-TN04A, XBO-M2MB)	- Ch10, Ch11, Ch12
V1.4	2012.01	1. XGB E type added (XBC-DN10E, XBC-DN14E, XBC-DN20E, XBC-DN30E, XBC-DP10E, XBC-DP14E, XBC-DP20E, XBC-DP30E)	-
V1.5	2013.01	1. XGB SU type added (XBC-DP20SU, XBC-DP30SU, XBC-DP40SU, XBC-DP60SU) 2. Data Backup time modified	- 4-14

※ The number of User’s manual is indicated the right side of the back cover.

About User's Manual

Congratulations on purchasing PLC of LSIS Co.,Ltd.
Before use, make sure to carefully read and understand the User's Manual about the functions, performances, installation and programming of the product you purchased in order for correct use and importantly, let the end user and maintenance administrator to be provided with the User's Manual.

The Use's Manual describes the product. If necessary, you may refer to the following description and order accordingly. In addition, you may connect our website(http://eng.lsis.biz/) and download the information as a PDF file.

Relevant User's Manual

Title	Description	No. of User Manual
XG5000 User's Manual	It describes how to use XG5000 software especially about online functions such as programming, printing, monitoring and debugging by using XGT series products.	10310000512
XGK/XGB Series Instruction & Programming	It describes how to use the instructions for programming using XGK/XGB series.	10310000510
XGB Analog User's Manual	It describes how to use the specification of analog input/analog output/temperature input module, system configuration and built-in PID control for XGB main unit.	10310000920
XGB Cnet I/F User's Manual	It describes how to use built-in communication function for XGB main unit and external Cnet I/F module.	10310000816
XGB Fast Ethernet I/F User's Manual	It describes how to use XGB FEnet I/F module.	10310000873

◎ Contents ◎

Chapter 1 Introduction

1.1 Guide to Use This Manual

This manual includes specifications, functions and handling instructions for the XGB series PLC.
This manual is divided up into chapters as follows.

No.	Title	Contents
Chapter 1	Introduction	Describes configuration of this manual, unit's features and terminology.
Chapter 2	System Configurations	Describes available units and system configuration in the XGB series.
Chapter 3	General Specifications	Describes general specifications of units used in the XGB series.
Chapter 4	CPU Specifications	Describes performances, specifications and operations.
Chapter 5	Program Configuration and Operation Method	
Chapter 6	CPU Module Functions	
Chapter 7	Input/Output Specifications	Describes operation of basic and input/output.
Chapter 8	Built-in High-speed Counter Function	Describes built-in high-speed counter functions.
Chapter 9	Installation and Wiring	Describes installation, wiring and handling instructions for reliability of the PLC system.
Chapter 10	Maintenance	Describes the check items and method for long-term normal operation of the PLC system.
Chapter 11	Troubleshooting	Describes various operation errors and corrective actions.
Appendix 1	Flag List	Describes the types and contents of various flags.
Appendix 2	Dimension	Shows dimensions of the main units and expansion modules.
Appendix 3	Compatibility with MASTER-K	Describes the compatibility with MASTER-K.
Appendix 4	Instruction List	Describes the special relay and instruction list.

1.2 Features

The features of XGB system are as follows.

(1) The system secures the following high performances.

(a) High Processing Speed

(b) Max. 284 I/O control supporting small & mid-sized system implementation

Item	Type		Reference
	XBC-DRxxE	XBC-DxxxS(U)	
Operation processing speed	0.24 μs / Step	94ns / Step	-
Max IO contact point	38 points	284 points	In case of using option module 4 points (Coming soon)
Program capacity	4kstep	15kstep	-
Max. no. of expanded stage	Option module 2 stages	7 stages (including option module 2 stages)	-

(c) Enough program capacity

(d) Expanded applications with the support of floating point.

(e) XBC-DRxxE is expressed as “E” type and XBC-DxxxS(U) is expressed as “S(U)” type.

(2) Compact : the smallest size comparing to the same class model of competitors.

(a) Compact panel realized through the smallest size.

(Unit: mm)

Item	Type	Size (W * H * D)	Reference
Basic unit	XBC-Dx20S	135*90*64	“S” type
	XBC-Dx30S		
	XBC-Dx20SU		“SU” type
	XBC-Dx30SU		
	XBC-Dx40SU	161 * 90 * 64	
	XBC-Dx60SU	210 * 90 * 64	
	XBC-Dx10E	100*90*64	“E” type
	XBC-Dx14E		
	XBC-Dx20E	135*90*64	
	XBC-Dx30E		
Extension module	XBE-,XBF-,XBL-	20 * 90 * 60	Basis of minimum size

(3) Easy attachable/extensible system for improved user convenience.

(a) By adopting a removable terminal block connector (M3 X 6 screw), convenience of wiring may be increased. (“S(U)” type main unit)

(b) By adopting connector coupling method, modules may be easily connected and separated.

(4) Improved maintenance ability with kinds of register, RTC option, comment backup and etc

(a) Convenient programming environment by providing analogue register and index register.

(b) Improved maintenance ability by operating plural programs and task program through module program.

(c) Built-in Flash ROM enabling permanent backup of program without any separate battery.

(d) Improved maintenance ability by types of comment backup.

(e) Built-in RTC function enabling convenient history and schedule management

(5) Optimized communication environment.

(a) With max. 2 channels of built-in COM (1 channel for “E” type (except load port)), communication is available without any expanded of module.

(b) Supporting various protocols to improve the convenience (dedicated, Modbus, user-defined communication)

(c) Communication module may be additionally increased by adding modules (up to 2 stages such as Cnet, Enet and etc). (“S(U)” type main unit)

(d) Convenient network-diagnostic function through network & communication frame monitoring.

(e) Convenient networking to upper systems through Enet or Cnet. (“S(U)” type main unit)

(6) Applications expanded with a variety of I/O modules.

(a) 8, 16, 32 points modules provided (if relay output, 8/16 points module).

(b) Single input, single output and combined I/O modules supported.

(7) Applications expanded through analog-dedicated register design and full attachable mechanism.

(a) All analogue modules can be attachable on extension base. (“S(U)” type: up to 7 stages available)

(b) With analog dedicated register(U) and monitoring dedicated function, convenient use for I/O is maximized (can designate operations using easy programming of U area and monitoring function)

(8) Integrated programming environment

(a) XG 5000: intensified program convenience, diverse monitoring, diagnosis and editing function

(b) XG - PD: COM/network parameters setting, frame monitoring, protocol analysis function

(9) Built-in high speed counter function

(a) Providing High-speed counter 1phase, 2phase and more additional functions.

(b) Providing parameter setting, diverse monitoring and diagnosis function using XG5000.

(c) Monitoring function in XG5000 can inspect without program, inspecting external wiring, data setting and others.

(10) Built-in position control function (“S(U)” type TR output main unit)

(a) Supporting max 100Kpps 2 axes.

(b) Providing parameter setting, operation data collection, diverse monitoring and diagnosis by using XG5000.

(c) Commissioning by monitoring of XG5000, without program, inspecting external wiring and operation data setting.

(11) Built-in PID (“S(U)” type main unit)

(a) Supporting max. 16 loops.

(b) Setting parameters by using XG5000 and supporting loop status monitoring conveniently with trend monitor.

(c) Control constant setting through the improved Auto-tuning function.

(d) With many other additional functions including PWM output, ΔMV, ΔPV and SV Ramp, improving the control preciseness.

(e) Supporting types of control modes such as forward/backward mixed operation, 2-stage SV PID control, cascade control and etc.

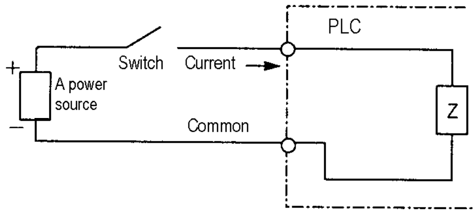
(f) A variety of warning functions such as PV MAX and PV variation warning securing the safety.

1.3 Terminology

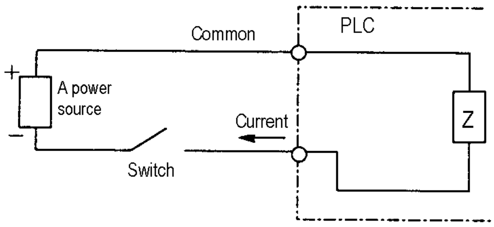
The following table gives definition of terms used in this manual.

Terms	Definition	Remark
Module	A standard element that has a specified function which configures the system. Devices such as I/O board, which inserted onto the mother board.	Example) Expansion module, Special module, Communication module
Unit	A single module or group of modules that perform an independent operation as a part of PLC systems.	Example) Main unit, Expansion unit
PLC System	A system which consists of the PLC and peripheral devices. A user program can control the system.	-
XG5000	A program and debugging tool for the MASTER-K series. It executes program creation, edit, compile and debugging. (PADT: Programming Added Debugging Tool)	-
XG - PD	Software to execute description, edition of basic parameter, high speed link, P2P parameter, and function of communication diagnosis	-
I/O image area	Internal memory area of the CPU module which used to hold I/O status.	
Cnet	Computer Network	-
FEnet	Fast Ethernet Network	-
Pnet	Profibus-DP Network	-
Dnet	DeviceNet Network	-
RTC	Abbreviation of ‘Real Time Clock’. It is used to call general IC that contains clock function.	-
Watchdog Timer	Supervisors the pre-set execution times of programs and warns if a program is not competed within the pre-set time.	-

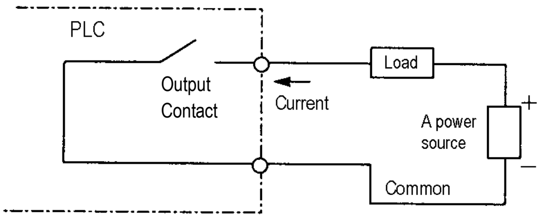
<table>
<tr><th>Terms</th><th>Definition</th><th>Remark</th></tr>
<tr><td>Sink Input</td><td>Current flows from the switch to the PLC input terminal if a input signal turns on.



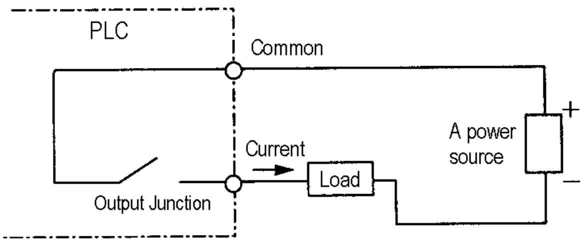
</td><td>Z: Input impedance</td></tr>
<tr><td>Source Input</td><td>Current flows from the PLC input terminal to the switch after a input signal turns on.



</td><td>-</td></tr>
<tr><td>Sink Output</td><td>Current flows from the load to the output terminal and the PLC output turn on.



</td><td>-</td></tr>
<tr><td>Source Output</td><td>Current flows from the output terminal to the load and the PLC output turn on.



</td><td>-</td></tr>
</table>

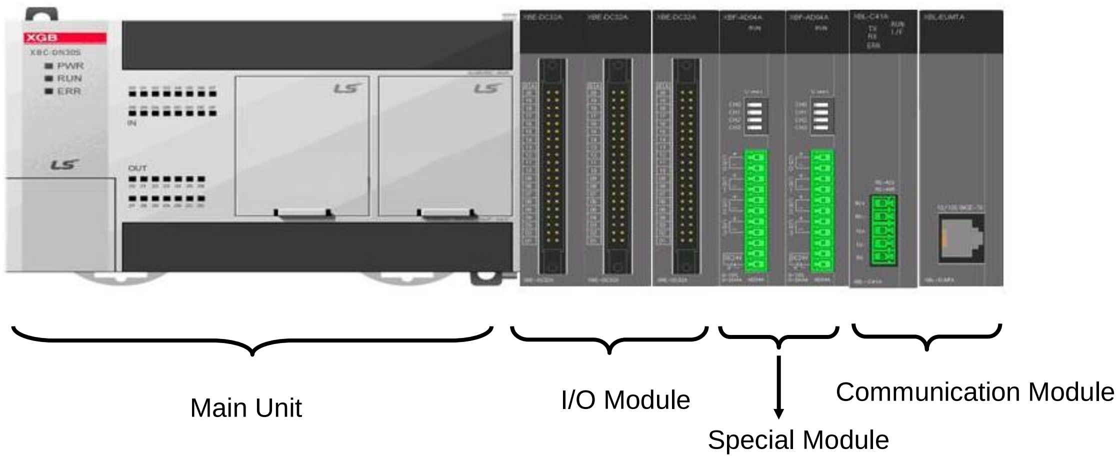
Chapter 2 System Configuration

The XGB series has suitable to configuration of the basic, computer link and network systems.

This chapter describes the configuration and features of each system.

2.1 XGB System Configuration

XGB series System Configuration is as follows.
For "E" type, only option module can be attached
For "S" type, up to 7 stages connection is available. But in case of attaching 2 option modules, up to 5 stages connection is available. (For communication module, up to 2 connection is available.)



Item			Description
Total I/O points			• XBC-DxxxS ("S(U)" type): 20~284 points
			• XBC-DxxxE ("E" type): 10~38 points
Maximum number of expansion modules		Digital I/O module	• "S(U)" type: Max. 7
		Special module	• "S(U)" type: Max. 7
		Communication I/F module	• "S(U)" type: Max. 2
		Option module	• "S(U)" type: Max. 2
			• "E" type: Max. 2 (In case of 10/14 points, only one is available)
Items	Main unit	"S" type	• XBC-DR20/30/40/60SU • XBC-DN20/30S • XBC-DN20/30/40/60SU • XBC-DP20/30/40/60SU
		"E" type	• XBC-DR10/14/20/30E • XBC-DN10/14/20/30E • XBC-DP10/14/20/30E

<table>
<tr><th colspan="3">Item</th><th>Description</th></tr>
<tr><td rowspan="7">Items</td><td rowspan="3">Expansion module</td><td>Digital I/O module</td><td>• XBE-DC08/16A/B/32A • XBE-TN08/16/32A • XBE-TP08/16/32A
• XBE-RY08A/B/16A • XBE-DR16A</td></tr>
<tr><td>A/D·D/A module</td><td>• XBF-AD04A • XBF-DV04A • XBF-DC04A
• XBF-AH04A • XBF-TC04S • XBF-PD02A
• XBF-RD04A • XBF-AD08A • XBF-HD02A
• XBF-HO02A • XBF-AD04C • XBF-DV04C
• XBF-DC04C</td></tr>
<tr><td>Communication I/F module</td><td>• XBL-C41A • XBL-C21A • XBL-EIPT
• XBL-EMTA • XBL-EIMT • XBL-CMEA
• XBL-CSEA</td></tr>
<tr><td rowspan="4">Option module</td><td>Digital I/O module</td><td>• XBO-DC04A
• XBO-TN04A</td></tr>
<tr><td>Special module</td><td>• XBO-AD02A • XBO-DA02A • XBO-AH02A
• XBO-RD01A • XBO-TC02A</td></tr>
<tr><td>RTC module</td><td>• XBO-RTCA</td></tr>
<tr><td>Memory module</td><td>• XBO-M2MB</td></tr>
</table>

2.2 Product List

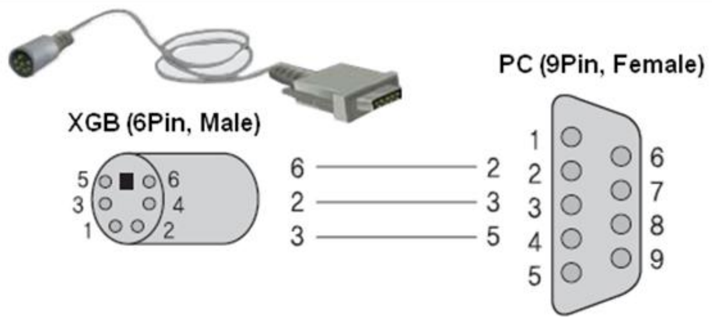
XGB series' product list is as follows.

Types	Model	Description	Remark
Main Unit	XBC-DR32H	AC100~220V power supply, DC24V input 16 point, Relay output 16 point	
	XBC-DN32H	AC100~220V power supply, DC24V input 16 point, Transistor output 16 point	
	XBC-DR64H	AC100~220V power supply, DC24V input 32 point, Relay output 32 point	
	XBC-DN64H	AC100~220V power supply, DC24V input 32 point, Transistor output 32 point	
	XBC-DR20SU	AC100~220V power supply, DC 24V input 12 point, relay output 8 point	
	XBC-DN20S(U)	AC100~220V power supply, DC24V input 12 point, transistor 8 point	
	XBC-DP20SU	AC100~220V power supply, DC24V input 12 point, transistor 8 point	
	XBC-DR30SU	AC100~220V power supply, DC 24V input 18 point, relay output 12 point	
	XBC-DN30S(U)	AC100~220V power supply, DC 24V input 18 point, transistor output 12 point	
	XBC-DP30SU	AC100~220V power supply, DC 24V input 18 point, transistor output 12 point	
	XBC-DR40SU	AC100~220V power supply, DC 24V input 24 point, relay output 16 point	
	XBC-DN40SU	AC100~220V power supply, DC 24V input 24 point, transistor output 16 point	
	XBC-DP40SU	AC100~220V power supply, DC 24V input 24 point, transistor output 16 point	
	XBC-DR60SU	AC100~220V power supply, DC 24V input 36 point, relay output 24 point	
	XBC-DN60SU	AC100~220V power supply, DC 24V input 36 point, transistor output 24 point	
	XBC-DP60SU	AC100~220V power supply, DC 24V input 36 point, transistor output 24 point	
	XBC-DR10E	AC100~220V power supply, DC 24V input 6 point, relay output 4 point	
	XBC-DR14E	AC100~220V power supply, DC 24V input 8 point, relay output 6 point	
	XBC-DR20E	AC100~220V power supply, DC 24V input 12 point, relay output 8 point	
	XBC-DR30E	AC100~220V power supply, DC 24V input 18 point, relay output 12 point	
	XBC-DN10E	AC100~220V power supply, DC 24V input 6 point, transistor output 4 point	
	XBC-DN14E	AC100~220V power supply, DC 24V input 8 point, transistor output 6 point	
	XBC-DN20E	AC100~220V power supply, DC 24V input 12 point, transistor output 8 point	
	XBC-DN30E	AC100~220V power supply, DC 24V input 18 point, transistor output 12 point	
	XBC-DP10E	AC100~220V power supply, DC 24V input 6 point, transistor output 4 point	
	XBC-DP14E	AC100~220V power supply, DC 24V input 8 point, transistor output 6 point	
	XBC-DP20E	AC100~220V power supply, DC 24V input 12 point, transistor output 8 point	
	XBC-DP30E	AC100~220V power supply, DC 24V input 18 point, transistor output 12 point	
	XBM-DN16S	DC24V Power supply, DC24V Input 8 point, Transistor output 8 point	
	XBM-DN32S	DC24V Power supply, DC24V Input 16 point, Transistor output 16 point	
	XBM-DR16S	DC24V Power supply, DC24V Input 8 point, Relay output 8 point	
Expansion Module	XBE-DC08A	DC24V Input 8 point	
	XBE-DC16A/B	DC24V Input 16 point	
	XBE-DC32A	DC24V Input 32 point	
	XBE-RY08A	Relay output 8 point	
	XBE-RY08B	Relay output 8 point (independent point)	
	XBE-RY16A	Relay output 16 point	
	XBE-TN08A	Transistor output 8 point	
	XBE-TN16A	Transistor output 16 point	
	XBE-TN32A	Transistor output 32 point	
	XBE-TN64A	Transistor output 64 point (sink type)	
	XBE-TP16A	Transistor output 16 point (source type)	
	XBE-TP32A	Transistor output 32 point (source type)	
	XBE-DR16A	DC24V Input 8 point, Relay output 8 point	

Types	Model	Description	Remark
Special Module	XBF-AD04A	Current/Voltage input 4 channel	
	XBF-DC04A	Current output 4 channel	
	XBF-DV04A	Voltage output 4 channel	
	XBF-AH04A	Current/voltage input 2 channel, output 2 channel	
	XBF-RD04A	RTD (Resistance Temperature Detector) input 4 channel	
	XBF-TC04S	TC (Thermocouple) input 4 channel	
	XBF-AD08A	Current/voltage input 8 channel	
	XBF-PD02A	2 axes, line driver type	
	XBF-HD02A	High Speed Counter 2channel, line driver type	
	XBF-HO02A	High Speed Counter 2channel, open collector type	
	XBF-AD04C	Current/Voltage input 4 channel, High resolution	
	XBF-DV04C	Current output 4 channel, High resolution	
	XBF-DC04C	Voltage output 4 channel, High resolution	
Communication Module	XBL-C21A	Cnet (RS-232C/Modem) I/F	
	XBL-C41A	Cnet (RS-422/485) I/F	
	XBL-EMTA	Enet I/F	
	XBL-EIMT/F/H	RAPIEnet I/F	
	XBL-EIPT	EtherNet/IP module	
	XBL-CMEA	CANopen Master	
	XBL-CSEA	CANOpen Slave	
Option Module	XBO-M1024	Memory module	
	XBO-AD02A	Current/voltage input 2channel	
	XBO-DA02A	Current/voltage output 2 channel	
	XBO-AH02A	Current/Voltage input 1 channel, output 1 channel	
	XBO-RD01A	RTD input 1 channel	
	XBO-TC02A	Thermocouple input 2 channel	
	XBO-DC04A	DC 24V input 4 point (“S” type HSC 4 channel)	
	XBO-TN04A	Sink type transistor output 4 channel (“S” type Positioning 2 axes (low speed))	
	XBO-RTCA	RTC module	
	XBO-M2MB	Memory module	
Download Cable	PMC-310S	Connection cable (PC to PLC), 9pin(PC)-6pin(PLC)	
	USB-301A	Connection cable (PC to PLC), USB	

Note

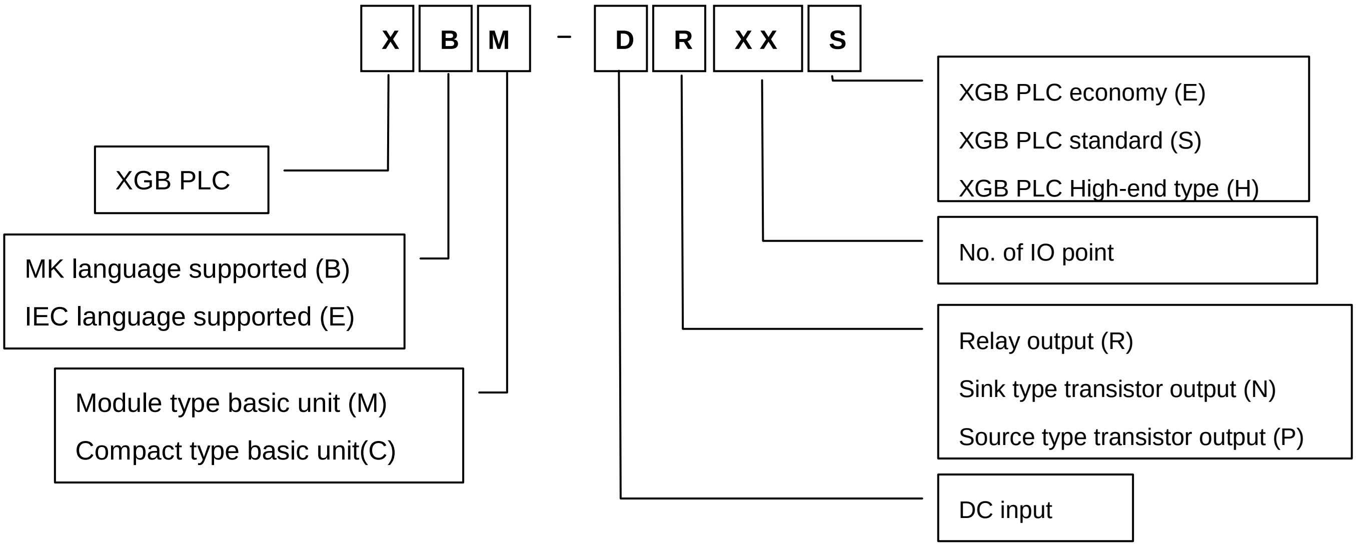
Download Cable (PMC-310S) Diagram



2.3 Classification and Type of Product Name

2.3.1 Classification and type of basic unit

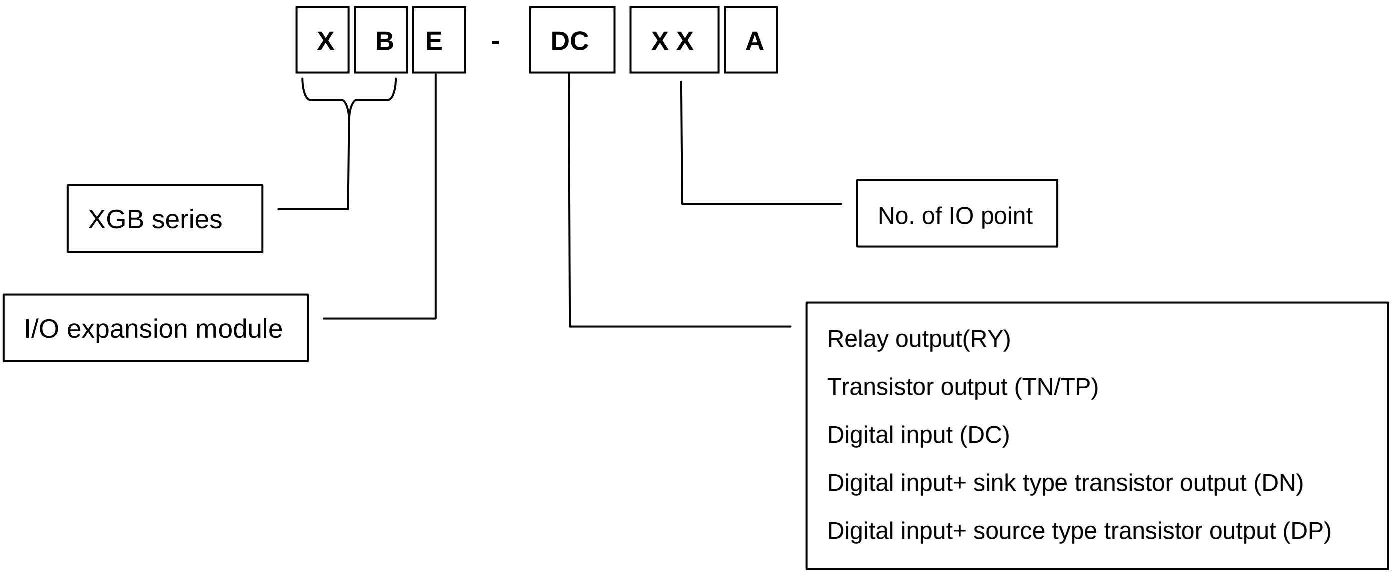
Name of basic unit is classified as follows.



Classification	Name	DC input	Relay output	Transistor output	Power
Modular type main unit	XBM-DR16S	8 point	8 point	None	DC24V
	XBM-DN16S	8 point	None	8 point	
	XBM-DN32S	16 point	None	16 point	
Compact type main nit	XBC-DR32H	16 point	16 point	None	AC110V~220V
	XBC-DN32H	16 point	None	16 point	
	XBC-DR64H	32 point	32 point	None	
	XBC-DN64H	32 point	None	32 point	
	XBC-DN20S(U)	12 point	None	8 point	
	XBC-DN30S(U)	18 point	None	12 point	
	XBC-DN40SU	24 point	None	16 point	
	XBC-DN60SU	36 point	None	24 point	
	XBC-DP20SU	12 point	None	8 point	
	XBC-DP30SU	18 point	None	12 point	
	XBC-DP40SU	24 point	None	16 point	
	XBC-DP60SU	36 point	None	24 point	
	XBC-DR20SU	12 point	8 point	None	
	XBC-DR30SU	18 point	12 point	None	
	XBC-DR40SU	24 point	16 point	None	
	XBC-DR60SU	36 point	24 point	None	
	XBC-DR10E	6 point	4 point	None	
	XBC-DR14E	8 point	6 point	None	
	XBC-DR20E	12 point	8 point	None	
	XBC-DR30E	18 point	12 point	None	
	XBC-DN10E	6 point	None	4 point	
	XBC-DN14E	8 point	None	6 point	
	XBC-DN20E	12 point	None	8 point	
	XBC-DN30E	18 point	None	12 point	
	XBC-DP10E	6 point	None	4 point	
	XBC-DP14E	8 point	None	6 point	
	XBC-DP20E	12 point	None	8 point	
	XBC-DP30E	18 point	None	12 point	

2.3.2 Classification and type of expansion module

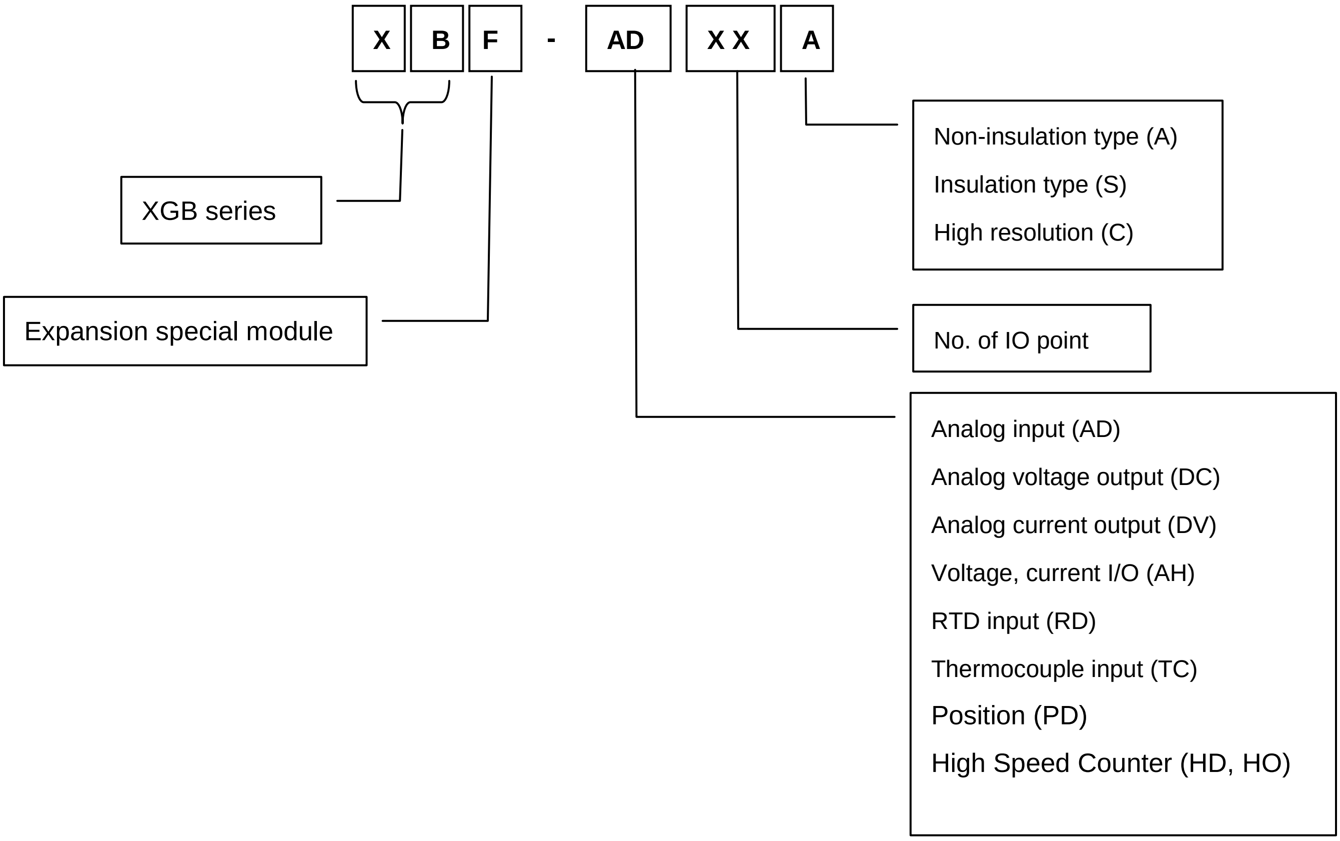
Name of expansion module is classified as follows.



Name	DC input	Relay output	Transistor output	Reference
XBE-DC08A	8 point	None	None	
XBE-DC16A/B	16 point	None	None	
XBE-DC32A	32 point	None	None	
XBE-RY08A/B	None	8 point	None	
XBE-RY16A	None	16 point	None	
XBE-TN08A	None	None	8 point	
XBE-TN16A	None	None	16 point	Sink type
XBE-TN32A	None	None	32 point	
XBE-TP08A	None	None	8 point	
XBE-TP16A	None	None	16 point	Source type
XBE-TP32A	None	None	32 point	
XBE-DR16A	8 point	8 point	None	

2.3.3 Classification and type of special module

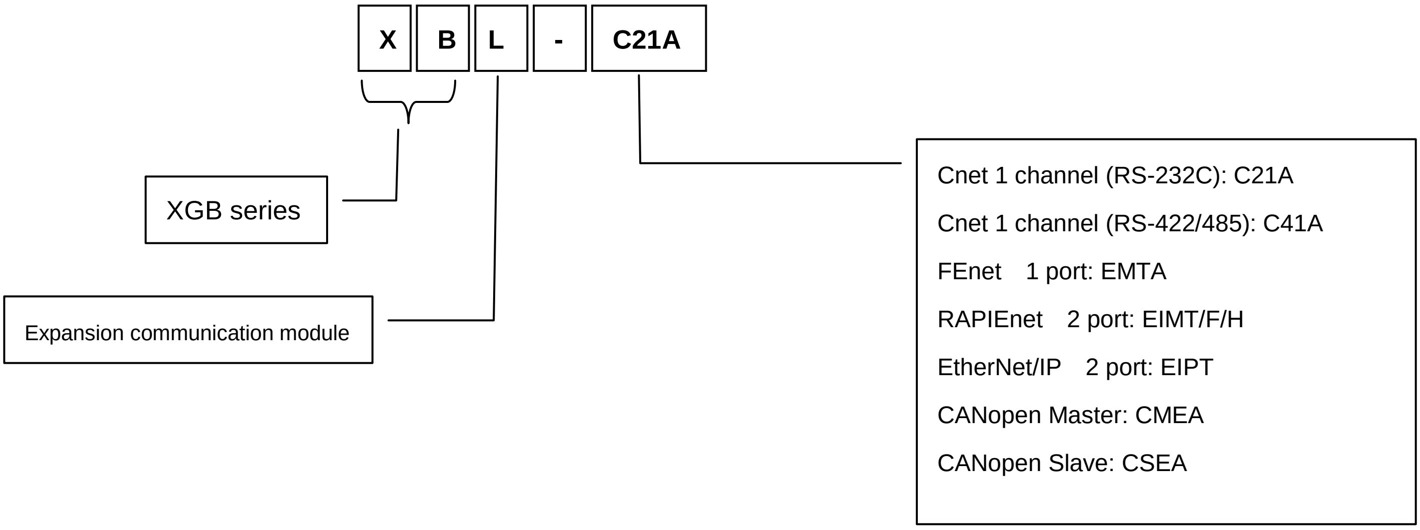
Special module is classified as follows.



Classification	Name	No. of input ch.	Input type	No. of output ch.	Output type
Analog input	XBF-AD04A	4	Voltage/Current	None	-
	XBF-AD08A	8	Voltage/Current	None	
	XBF-AD04C	4	Voltage/Current	None	-
Analog output	XBF-DC04A	None	-	4	Current
	XBF-DC04C	None	-	4	Current
	XBF-DV04A	None	-	4	Voltage
	XBF-DV04C	None	-	4	Voltage
Analog I/O	XBF-AH04A	2	Voltage/Current	2	Voltage/Current
RTD input	XBF-RD04A	4	PT100/JPT100	None	-
TC input	XBF-TC04S	4	K, J, T, R	None	-
Position	XBF-PD02A	-	-	2	LineDrive Type
High Speed Counter	XBF-HD02A	2	LineDrive Type	-	-
	XBF-HO02A	2	OpenCollector Type	-	-

2.3.4 Classification and type of communication module

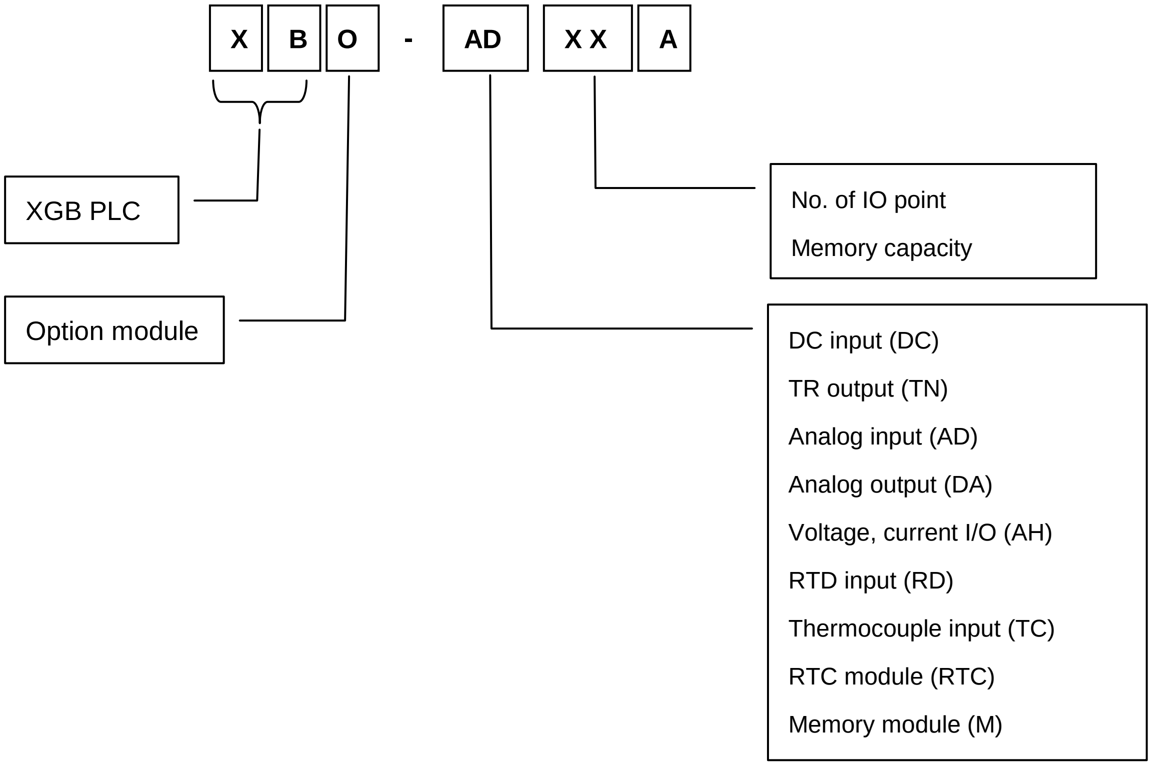
Name of communication module is classified as follows.



Classification	Name	Type
Cnet Comm. Module	XBL-C21A	RS-232C, 1 channel
	XBL-C41A	RS-422/485, 1 channel
FEnet Comm. Module	XBL-EMTA	Electricity, open type Ethernet
RAPIEnet Comm. Module	XBL-EIMT	Comm. Module between PLCs, electric media, 100 Mbps industrial Ethernet supported
	XBL-EIMF	Comm. Module between PLCs, fiberoptic media, 100 Mbps industrial Ethernet supported
	XBL-EIMH	Comm. Module between PLCs, electric/ fiberoptic media, 100 Mbps industrial Ethernet supported
EtherNet/IP Comm. Module	XBL-EIPT	Electricity, open type Ethernet
CANopen	XBL-CMEA	CANopen Master
	XBL-CSEA	CANopen Slave

2.3.5 Classification and type of option module

Name of option module is classified as follows.



Classification	Name	No. of input CH	Input type	No. of output CH	Output type
DC input	XBO-DC04A	4	DC 24V	None	-
TR output	XBO-TN04A	None	-	4	DC 24V
Analog input	XBO-AD02A	2	Voltage/current	None	
Analog output	XBO-DA02A	None	-	2	Voltage/current
Analog I/O	XBO-AH02A	1	Voltage/current	1	Voltage/current
RTD input	XBO-RD01A	1	PT100/JPT100	None	-
TC input	XBO-TC02A	2	K, J	None	-
RTC module	XBO-RTCA	None	-	None	-
Memory module	XBO-M2MB	None	-	None	-

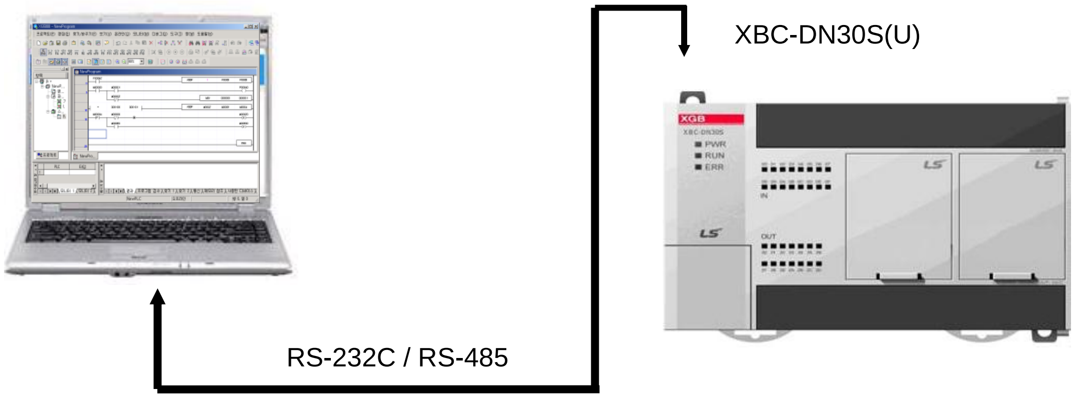
2.4 System Configuration

2.4.1 Cnet I/F system

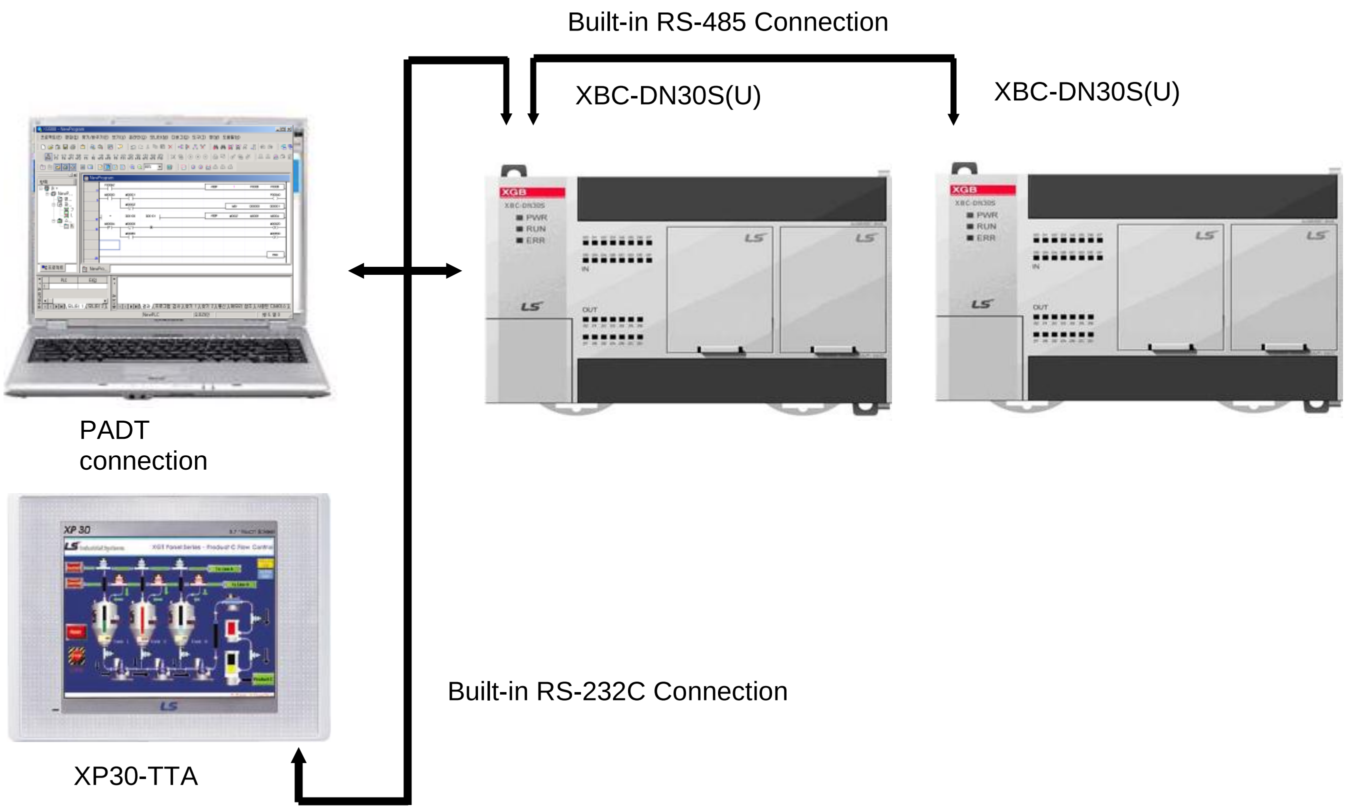
Cnet I/F System is used for communication between the main unit and external devices using RS-232C/RS-422 (485) Interface. The XGB series has a built-in RS-232C port, RS-485 port
For “E” type, only one communication port between RS-232C and RS-485 can be used and you can specify at parameter setting window. For “S” type, RS-232C and RS-485 can be used independently and add RS-232C dedicated Cnet I/F module (XBL-C21A) and RS-422/485 dedicated Cnet I/F module (XBL-C41A). It is possible to configure the following communication system on demand

(1) 1:1 communication system

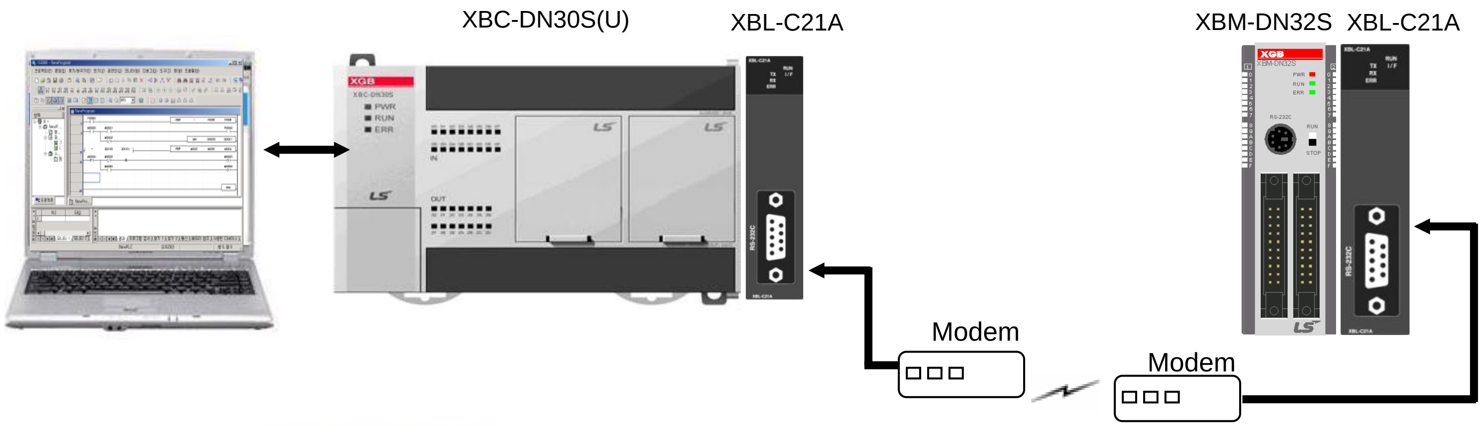
(a) 1:1 communication of an external device (computer) with main unit using a built-in port (RS-232C/RS-485)

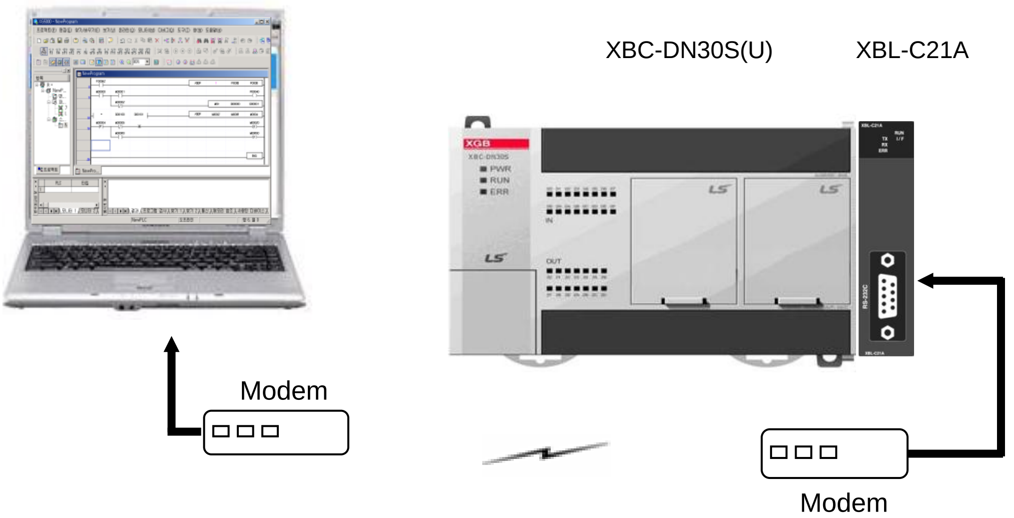


(b) 1:1 communication with main unit using a built-in RS-485 port
(In case of built-in RS-232C,it is for connecting to HMI device.)

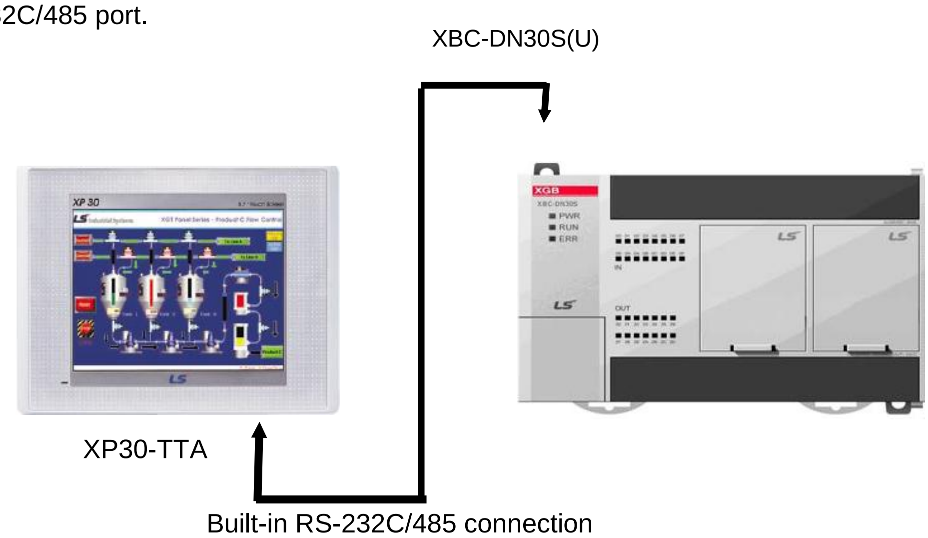


(c) 1:1 RS-232C Communication with remote device via modem by Cnet I/F modules



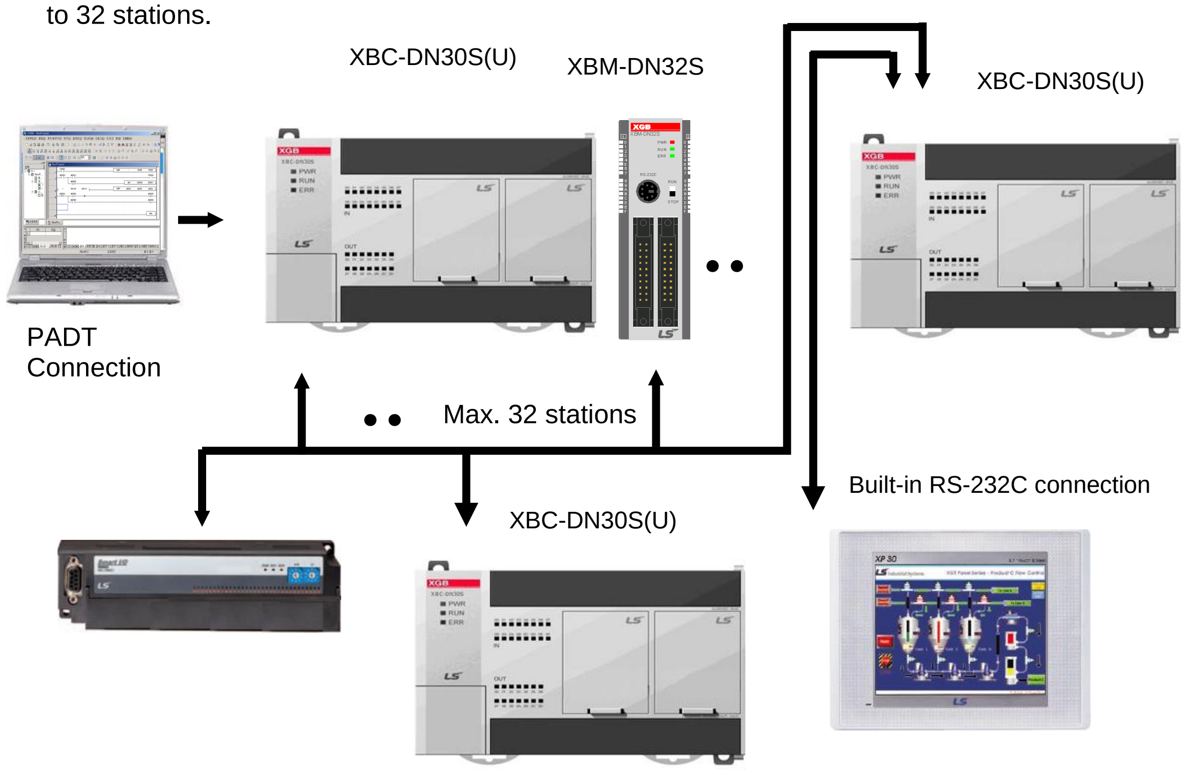


(d) 1:1 communication of an external device (monitoring unit) with main unit using a built-in RS-232C/485 port.

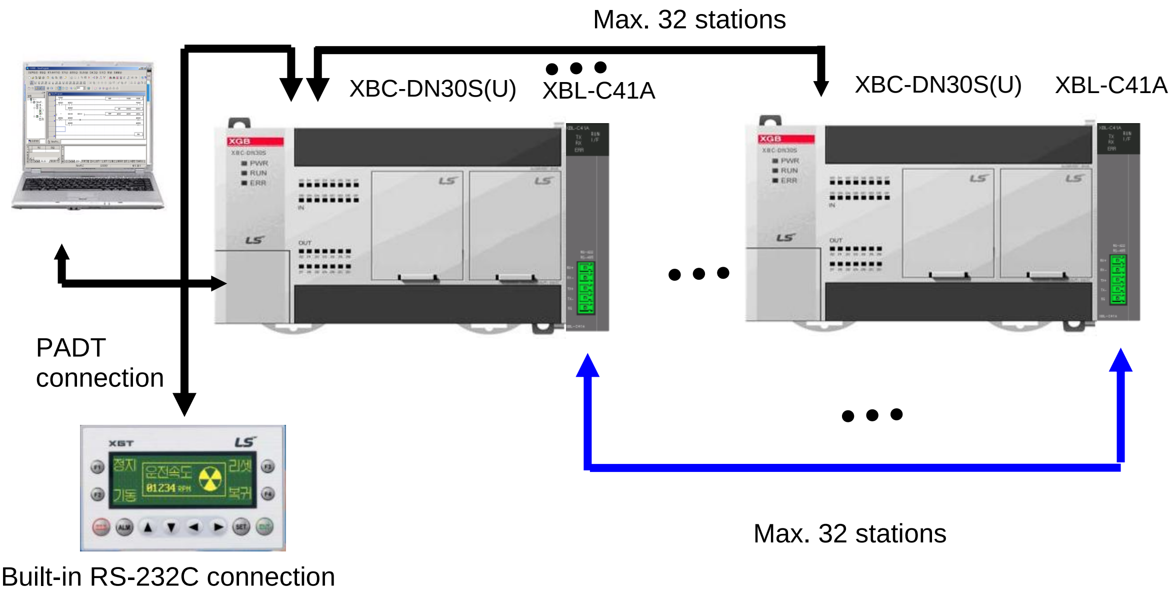


(2) 1:n Communication system

(a) Using RS-485 built-in function can connect between one computer and multiple main units for up to 32 stations.



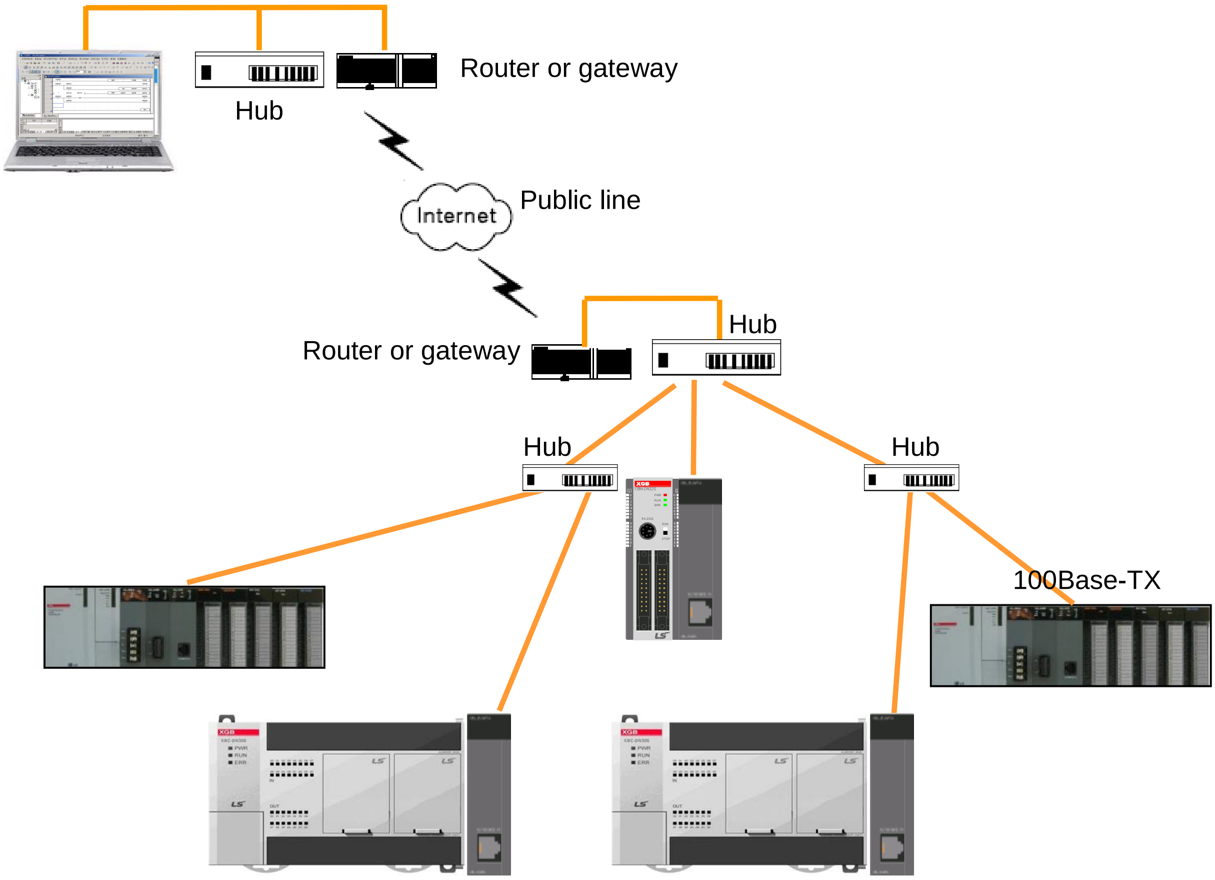
(b) Using RS-485 built-in function/expansion Cnet I/F module can be connect for up to 32 stations.



Note
1) Refer to 'XGB Cnet I/F user manual' for details

2.4.2 Ethernet system

Ethernet made by cooperation of Xerox, Intel, DEC is standard LAN connection method (IEEE802.3), which is network connection system using 1.5KB packet with 100Mbps transmission ability. Since Ethernet can combine a variety of computer by network, it is called as standard specification of LAN and diverse products. By adopting CSMA/CD method, it is easy to configure the network and collect large capacity data.



Note
1) Refer to 'XGB FEnet I/F user manual' for details

Chapter 3 General Specifications

3.1 General Specifications

The General specification of XGB series is as below.

<table>
<tr><th>No.</th><th>Items</th><th colspan="4">Specification</th><th>Reference</th></tr>
<tr><td>1</td><td>Ambient Temp.</td><td colspan="4">0 ~ 55 °C</td><td rowspan="5">-</td></tr>
<tr><td>2</td><td>Storage Temp.</td><td colspan="4">−25 ~ +70 °C</td></tr>
<tr><td>3</td><td>Ambient humidity</td><td colspan="4">5 ~ 95%RH (Non-condensing)</td></tr>
<tr><td>4</td><td>Storage humidity</td><td colspan="4">5 ~ 95%RH (Non-condensing)</td></tr>
<tr><td rowspan="8">5</td><td rowspan="8">Vibration resistance</td><td colspan="3">Occasional vibration</td><td>-</td></tr>
<tr><td>Frequency</td><td>Acceleration</td><td>Amplitude</td><td>Times</td><td rowspan="8">IEC61131-2</td></tr>
<tr><td>10 ≤ f < 57Hz</td><td>–</td><td>0.075mm</td><td rowspan="6">10 times each direction (X,Y and Z)</td></tr>
<tr><td>57 ≤ f ≤ 150Hz</td><td>9.8m/s² (1G)</td><td>–</td></tr>
<tr><td colspan="3">Continuous vibration</td></tr>
<tr><td>Frequency</td><td>Acceleration</td><td>Amplitude</td></tr>
<tr><td>10 ≤ f < 57Hz</td><td>–</td><td>0.035mm</td></tr>
<tr><td>57 ≤ f ≤ 150Hz</td><td>4.9m/s² (0.5G)</td><td>–</td></tr>
<tr><td>6</td><td>Shock resistance</td><td colspan="4">• Peak acceleration : 147 m/s² (15G)
• Duration : 11ms
• Half-sine, 3 times each direction per each axis</td></tr>
<tr><td rowspan="5">7</td><td rowspan="5">Noise resistance</td><td>Square wave impulse noise</td><td colspan="3">AC: ±1,500 V
DC: ±900 V</td><td>LSIS standard</td></tr>
<tr><td>Electrostatic discharge</td><td colspan="3">Voltage: 4kV (Contact discharge)</td><td>IEC61131-2
IEC61000-4-2</td></tr>
<tr><td>Radiated electromagnetic field noise</td><td colspan="3">80 ~ 1,000 MHz, 10V/m</td><td>IEC61131-2,
IEC61000-4-3</td></tr>
<tr><td rowspan="2">Fast transient /Burst noise</td><td>Segment</td><td>Power supply module</td><td>Digital/Analog Input/Output, Communication Interface</td><td rowspan="2">IEC61131-2
IEC61000-4-4</td></tr>
<tr><td>Voltage</td><td>2kV</td><td>1kV</td></tr>
<tr><td>8</td><td>Environment</td><td colspan="4">Free from corrosive gases and excessive dust</td><td rowspan="4">-</td></tr>
<tr><td>9</td><td>Altitude</td><td colspan="4">Up to 2,000 ms</td></tr>
<tr><td>10</td><td>Pollution degree</td><td colspan="4">2 or less</td></tr>
<tr><td>11</td><td>Cooling</td><td colspan="4">Air-cooling</td></tr>
</table>

Notes

1) IEC (International Electrotechnical Commission):
An international nongovernmental organization which promotes internationally cooperated standardization in electric/electronic field, publishes international standards and manages applicable estimation system related with.

2) Pollution degree:
An index indicating pollution degree of the operating environment which decides insulation performance of the devices. For instance, Pollution degree 2 indicates the state generally that only non-conductive pollution occurs. However, this state contains temporary conduction due to dew produced.

Chapter 4 CPU Specifications

4.1 Performance Specifications

The following table shows the general specifications of the XGB compact type CPU (XBC-Dx10/14/20/30E).

<table>
<tr><th colspan="2" rowspan="4">Items</th><th colspan="4">Specifications (“E” type)</th><th rowspan="4">Remark</th></tr>
<tr><th>XBC-DR10E</th><th>XBC-DR14E</th><th>XBC-DR20E</th><th>XBC-DR30E</th></tr>
<tr><th>XBC-DN10E</th><th>XBC-DN14E</th><th>XBC-DN20E</th><th>XBC-DN30E</th></tr>
<tr><th>XBC-DP10E</th><th>XBC-DP14E</th><th>XBC-DP20E</th><th>XBC-DP30E</th></tr>
<tr><td colspan="2">Program control method</td><td colspan="4">Reiterative operation, fixed cycle operation, constant scan</td><td rowspan="15">-</td></tr>
<tr><td colspan="2">I/O control method</td><td colspan="4">Scan synchronous batch processing method (Refresh method), Directed by program instruction</td></tr>
<tr><td colspan="2">Program language</td><td colspan="4">Ladder Diagram, Instruction List</td></tr>
<tr><td rowspan="2">Number of instructions</td><td>Basic</td><td colspan="4">28</td></tr>
<tr><td>Application</td><td colspan="4">677</td></tr>
<tr><td colspan="2">Processing speed (Basic instruction)</td><td colspan="4">0.24 ㎲/Step</td></tr>
<tr><td colspan="2">Program capacity</td><td colspan="4">4 k steps</td></tr>
<tr><td colspan="2">Max. I/O points</td><td>14 point
Main + 1 option</td><td>18 point
Main + 1 option</td><td>28 point
Main + 2 options</td><td>38 point
Main + 2 options</td></tr>
<tr><td rowspan="11">Data area</td><td>P</td><td colspan="4">P0000 ~ P127F (2,048 point)</td></tr>
<tr><td>M</td><td colspan="4">M0000 ~ M255F (4,096 point)</td></tr>
<tr><td>K</td><td colspan="4">K00000 ~ K2559F (Special area: K2600~2559F) (40,960 point)</td></tr>
<tr><td>L</td><td colspan="4">L00000 ~ L1279F (20,480 point)</td></tr>
<tr><td>F</td><td colspan="4">F000 ~ F255F (4,096 point)</td></tr>
<tr><td>T</td><td colspan="4">100ms, 10ms, 1ms : T000 ~ T255 (256 point)
(Adjustable by parameter setting)</td></tr>
<tr><td>C</td><td colspan="4">C000 ~ C255 (256 point)</td></tr>
<tr><td>S</td><td colspan="4">S00.00 ~ S127.99</td></tr>
<tr><td>D</td><td colspan="4">D0000 ~ D5119 (5120 word)</td><td rowspan="3">Word</td></tr>
<tr><td>U</td><td colspan="4">U00.00 ~ U07.31
(Analog data refresh area: 256 word, analog data refresh area)</td></tr>
<tr><td>Z</td><td colspan="4">Z000~Z127 (128 Word)</td></tr>
<tr><td colspan="2">Total program</td><td colspan="4">128</td><td rowspan="9">-</td></tr>
<tr><td colspan="2">Initial task</td><td colspan="4">1</td></tr>
<tr><td colspan="2">Cyclic task</td><td colspan="4">Max. 8</td></tr>
<tr><td colspan="2">I/O task</td><td colspan="4">Max. 4</td></tr>
<tr><td colspan="2">Internal device task</td><td colspan="4">Max. 8</td></tr>
<tr><td colspan="2">Operation mode</td><td colspan="4">RUN, STOP, DEBUG</td></tr>
<tr><td colspan="2">Self-diagnosis function</td><td colspan="4">Detects errors of scan time, memory, I/O</td></tr>
<tr><td colspan="2">Program port</td><td colspan="4">RS-232C (Loader)</td></tr>
<tr><td colspan="2">Back-up method</td><td colspan="4">Latch area setting in basic parameter</td></tr>
</table>

Items	Specifications ("E" type)				Remark
	XBC-DR10E	XBC-DR14E	XBC-DR20E	XBC-DR30E	
	XBC-DN10E	XBC-DN14E	XBC-DN20E	XBC-DN30E	
	XBC-DP10E	XBC-DP14E	XBC-DP20E	XBC-DP30E	
Internal consumption current	250mA	280mA	350mA	470mA	
	180mA	190mA	200mA	210mA	
	180mA	190mA	200mA	210mA	
Weight	330g	340g	450g	465 g	
	313g	315g	418g	423g	
	313g	315g	418g	423g	

The following table shows the general specifications of the XGB compact type CPU (XBC-DN20/30S).

Items		Specifications ("S" type)		Remark
		XBC-DN20S	XBC-DN30S	
Program control method		Reiterative operation, fixed cycle operation, constant scan		-
I/O control method		Scan synchronous batch processing method (Refresh method), Directed by program instruction		
Program language		Ladder Diagram, Instruction List		
Number of instructions	Basic	28		
	Application	687		
Processing speed (Basic instruction)		94 ns/Step		
Program capacity		15 k steps		
Max. I/O points		244 point (Main + Expansion 7 stages)	254 point (Main + Expansion 7 stages)	
Data area	P	P0000 ~ P1023F (16,384 point)		
	M	M0000 ~ M1023F (16,384 point)		
	K	K0000 ~ K4095F (65,536 point)		
	L	L0000 ~ L2047F (32,768 point)		
	F	F0000 ~ F1023F (16,384 point)		
	T	100ms, 10ms, 1ms : T0000 ~ T1023 (1,024 point) (Adjustable by parameter setting)		
	C	C0000 ~ C1023 (1,024)		
	S	S00.00 ~ S127.99		
	D	D0000 ~ D10239 (10,240 word)		Word
	U	U00.00 ~ U0A.31 (Analog data refresh area: 352 word)		
	Z	Z000~Z127 (128 Word)		
	R	R0000~R10239 (10,240 word)		
Total program		128		-
Initial task		1		
Cyclic task		Max. 8		
I/O task		Max. 8		
Internal device task		Max. 8		
Operation mode		RUN, STOP, DEBUG		
Self-diagnosis function		Detects errors of scan time, memory, I/O		
Program port		RS-232C 1 channel		
Back-up method		Latch area setting in basic parameter		
Internal consumption current		240 mA	255 mA	
Weight		470g	475g	

The following table shows the general specifications of the XGB compact type CPU (XBC-Dx20/30/40/60SU).

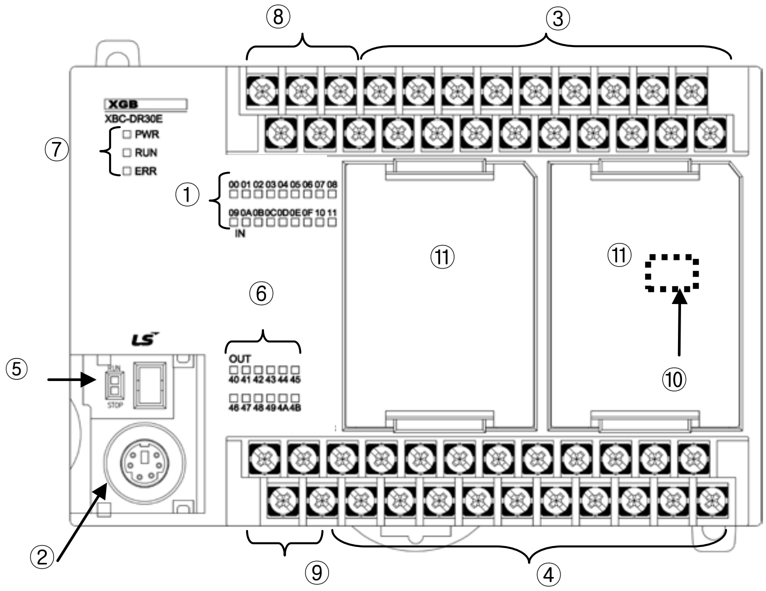
<table>
<tr><th colspan="2" rowspan="4">Items</th><th colspan="4">Specifications (“SU” type)</th><th rowspan="4">Remark</th></tr>
<tr><th>XBC-DR20SU</th><th>XBC-DR30SU</th><th>XBC-DR40SU</th><th>XBC-DR60SU</th></tr>
<tr><th>XBC-DN20SU</th><th>XBC-DN30SU</th><th>XBC-DN40SU</th><th>XBC-DN60SU</th></tr>
<tr><th>XBC-DP20SU</th><th>XBC-DP30SU</th><th>XBC-DP40SU</th><th>XBC-DP60SU</th></tr>
<tr><td colspan="2">Program control method</td><td colspan="4">Reiterative operation, fixed cycle operation, constant scan</td><td rowspan="16">-</td></tr>
<tr><td colspan="2">I/O control method</td><td colspan="4">Scan synchronous batch processing method (Refresh method),
Directed by program instruction</td></tr>
<tr><td colspan="2">Program language</td><td colspan="4">Ladder Diagram, Instruction List</td></tr>
<tr><td rowspan="2">Number of instructions</td><td>Basic</td><td colspan="4">28</td></tr>
<tr><td>Application</td><td colspan="4">687</td></tr>
<tr><td colspan="2">Processing speed
(Basic instruction)</td><td colspan="4">94 ns/Step</td></tr>
<tr><td colspan="2">Program capacity</td><td colspan="4">15 k steps</td></tr>
<tr><td colspan="2">Max. I/O points</td><td>244 point
(Main + Expansion 7 stages)</td><td>254 point
(Main + Expansion 7 stages)</td><td>264 point
(Main + Expansion 7 stages)</td><td>284 point
(Main + Expansion 7 stages)</td></tr>
<tr><td rowspan="12">Data area</td><td>P</td><td colspan="4">P0000 ~ P1023F (16,384 point)</td></tr>
<tr><td>M</td><td colspan="4">M0000 ~ M1023F (16,384 point)</td></tr>
<tr><td>K</td><td colspan="4">K0000 ~ K4095F (65,536 point)</td></tr>
<tr><td>L</td><td colspan="4">L0000 ~ L2047F (32,768 point)</td></tr>
<tr><td>F</td><td colspan="4">F0000 ~ F1023F (16,384 point)</td></tr>
<tr><td>T</td><td colspan="4">100ms, 10ms, 1ms : T0000 ~ T1023 (1,024 point)
(Adjustable by parameter setting)</td></tr>
<tr><td>C</td><td colspan="4">C0000 ~ C1023 (1,024)</td></tr>
<tr><td>S</td><td colspan="4">S00.00 ~ S127.99</td></tr>
<tr><td>D</td><td colspan="4">D0000 ~ D10239 (10,240 word)</td><td rowspan="4">Word</td></tr>
<tr><td>U</td><td colspan="4">U00.00 ~ U0A.31 (Analog data refresh area: 352 word)</td></tr>
<tr><td>Z</td><td colspan="4">Z000~Z127 (128 Word)</td></tr>
<tr><td>R</td><td colspan="4">R0000~R10239 (10,240 word)</td></tr>
<tr><td colspan="2">Total program</td><td colspan="4">128</td><td rowspan="9">-</td></tr>
<tr><td colspan="2">Initial task</td><td colspan="4">1</td></tr>
<tr><td colspan="2">Cyclic task</td><td colspan="4">Max. 8</td></tr>
<tr><td colspan="2">I/O task</td><td colspan="4">Max. 8</td></tr>
<tr><td colspan="2">Internal device task</td><td colspan="4">Max. 8</td></tr>
<tr><td colspan="2">Operation mode</td><td colspan="4">RUN, STOP, DEBUG</td></tr>
<tr><td colspan="2">Self-diagnosis function</td><td colspan="4">Detects errors of scan time, memory, I/O</td></tr>
<tr><td colspan="2">Program port</td><td colspan="4">RS-232C 1 channel, USB 1 channel</td></tr>
<tr><td colspan="2">Back-up method</td><td colspan="4">Latch area setting in basic parameter</td></tr>
</table>

Items	Specifications ("SU" type)				Remark
	XBC-DR20SU	XBC-DR30SU	XBC-DR40SU	XBC-DR60SU	
	XBC-DN20SU	XBC-DN30SU	XBC-DN40SU	XBC-DN60SU	
	XBC-DP20SU	XBC-DP30SU	XBC-DP40SU	XBC-DP60SU	
Internal consumption current	478 mA	626 mA	684 mA	942 mA	
	252 mA	310 mA	288 mA	340 mA	
	305 mA	352 mA	355 mA	394 mA	
Weight	514g	528g	594g	804g	
	475g	476g	578g	636g	
	442g	446g	544g	717g	

<table>
<tr><th colspan="3" rowspan="2">Items</th><th colspan="2">Specifications</th><th rowspan="2">Remark</th></tr>
<tr><th>“E” type</th><th>“S(U)” type</th></tr>
<tr><td rowspan="17">Built-in function</td><td colspan="2">PID control function</td><td colspan="2">Controlled by instructions, Auto-tuning, PWM output,
Forced output, Adjustable operation scan time, Anti Windup, Delta MV function, SV-Ramp function
Max. 16 loops are supported</td><td>Supported in “S(U)” type</td></tr>
<tr><td colspan="2" rowspan="2">Cnet I/F function</td><td colspan="2">Dedicated protocol support
MODBUS protocol support
User defined protocol support</td><td rowspan="6"></td></tr>
<tr><td>Select one port between RS-232C 1 port, RS-485 1 port by parameter</td><td>RS-232C 1 port, RS-485 1 port respectively</td></tr>
<tr><td rowspan="4">High-speed counter</td><td>Capacity</td><td>1 phase: 4 kHz 4 channel
2 phase: 2 kHz 2 channel</td><td>1 phase: 100 kHz 2 channel,
20kHz 6 channel
2 phase: 50 kHz 1 channel,
8kHz 3 channel</td></tr>
<tr><td rowspan="2">Counter mode</td><td colspan="2">4 different counter modes according to input pulse and addition/subtraction method
• 1 phase pulse input: addition/subtraction counter
• 1 phase pulse input: addition/subtraction counter by B phase
• 2 phase pulse input: addition/subtraction counter</td></tr>
<tr><td>• 2 phase pulse input: addition/subtraction by rising pulse phase differences</td><td>• 2 phase pulse input: addition/subtraction by rising/falling pulse phase differences</td></tr>
<tr><td>Additional function</td><td colspan="2">• Internal/External preset function
• Latch counter function
• Comparison output function
• Revolution number per unit time function</td></tr>
<tr><td rowspan="5">Positioning function</td><td>Basic function</td><td colspan="2">No. of control axis: 2 axes
Control method: position/speed control
Control unit: pulse
Positioning data: 80 data/axis (operation step No. 1~80)
Operation mode: End/Keep/Continuous
Operation method: Single, Repeated operation</td><td rowspan="5">Supported in “S(U)” type transistor output</td></tr>
<tr><td>Positioning function</td><td colspan="2">Positioning method: Absolute / Incremental
Address range: -2,147,483,648 ~ 2,147,483,647
Speed: Max. 100kpps(setting range 1 ~ 100,000pps)
Acceleration / Deceleration method : trapezoidal method</td></tr>
<tr><td>Return to Origin</td><td colspan="2">By Home and DOG (Off)
By Home and DOG (On)
By DOG</td></tr>
<tr><td>JOG operation</td><td colspan="2">Setting range: 1~100,000 (High / Low speed)</td></tr>
<tr><td>Additional function</td><td colspan="2">Inching operation, Speed synchronizing operation, Position synchronizing operation, linear interpolation operation etc.</td></tr>
<tr><td colspan="2">Pulse catch</td><td>50 ㎲
4 point (P0000 ~ P0003)</td><td>10 ㎲ 2 point
(P0000 ~ P0001)
50 ㎲ 6 point
(P0002 ~ P0007)</td><td rowspan="3">-</td></tr>
<tr><td colspan="2">External interrupt</td><td>4 point: 50 ㎲
(P0000 ~ P0003)</td><td>10 ㎲ 2 point
(P0000 ~ P0001)
50 ㎲ 6 point
(P0002 ~ P0007)</td></tr>
<tr><td colspan="2">Input filter</td><td colspan="2">Select among 1,3,5,10,20,70,100 ㎳ (Adjustable)</td></tr>
</table>

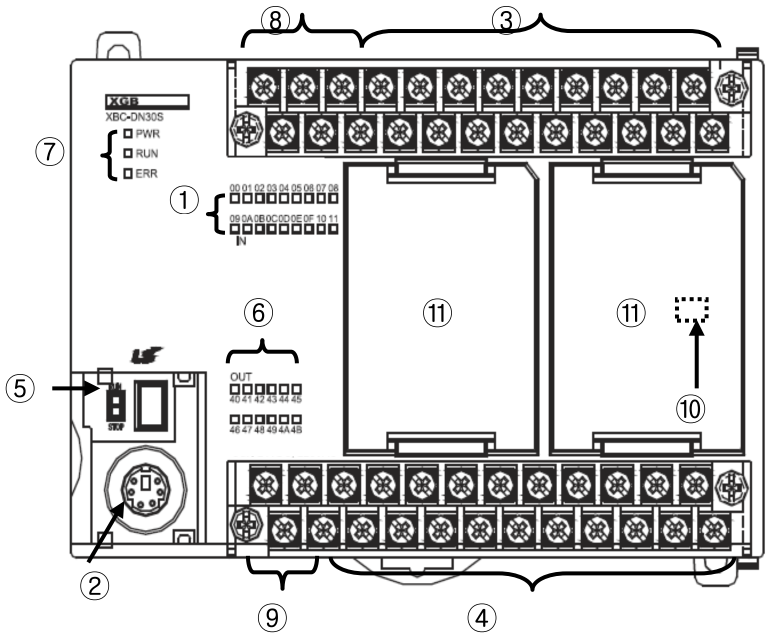
4.2 Names of Part and Function

"E" Type



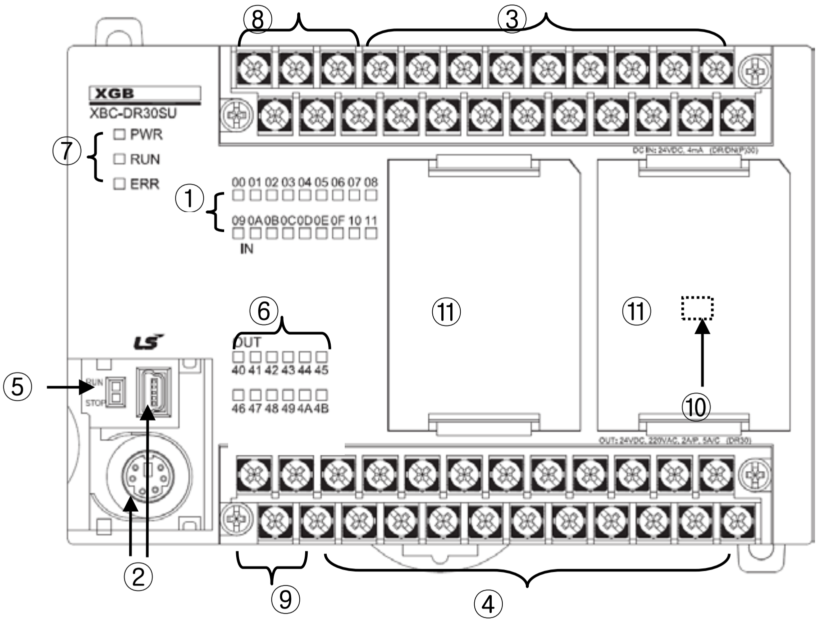
No.	Name	Description
①	Input indicator LED	▪ Input indicator LED
②	PADT connecting connector	▪ PADT connector RS-232C 1 channel
③	Input terminal block	▪ Input terminal block
④	Output terminal block	▪ Output terminal block
⑤	RUN/STOP mode switch	▪ Sets the operation mode of main unit STOP → RUN: execute operation of program RUN → STOP: stop operation of program (In case of STOP, remote mode is available)
⑥	Output indicator LED	▪ Output indicator LED
⑦	Status indicator LED	It indicates CPU module's status. ▪ PWR(Red on): Power status ▪ RUN(Green on): RUN status ▪ Error(Red flickering): In case of error, it is flickering.
⑧	Built-in communication Connecting connector	• Built-in RS-232C/485 connecting connector
⑨	Power supply connector	▪ AC100~240V power supply connector
⑩	OS mode dip switch	▪ Dip switch for setting O/S download/Operation mode On: Boot mode, available to download O/S Off: User mode, available to download program using PADT
⑪	Option board holder	▪For connection option board

"S" Type



No.	Name	Description
①	Input indicator LED	▪ Input indicator LED
②	PADT connecting connector	▪ PADT connector RS-232C 1 channel
③	Input terminal block	▪ Input terminal block
④	Output terminal block	▪ Output terminal block
⑤	RUN/STOP mode switch	▪ Sets the operation mode of main unit STOP → RUN: execute operation of program RUN → STOP: stop operation of program (In case of STOP, remote mode is available)
⑥	Output indicator LED	▪ Output indicator LED
⑦	Status indicator LED	It indicates CPU module's status. ▪ PWR(Red on): Power status ▪ RUN(Green on): RUN status ▪ Error(Red flickering): In case of error, it is flickering.
⑧	Built-in communication Connecting connector	• Built-in RS-232C/485 connecting connector
⑨	Power supply connector	▪ AC100~240V power supply connector
⑩	OS mode dip switch	▪ Dip switch for setting O/S download/Operation mode On: Boot mode, available to download O/S Off: User mode, available to download program using PADT
⑪	Option board holder	▪ For connection option board

"SU" Type



No.	Name	Description
①	Input indicator LED	▪ Input indicator LED
②	PADT connecting connector	▪ PADT connector RS-232C 1 channel, USB 1 channel
③	Input terminal block	▪ Input terminal block
④	Output terminal block	▪ Output terminal block
⑤	RUN/STOP mode switch	▪ Sets the operation mode of main unit STOP → RUN: execute operation of program RUN → STOP: stop operation of program (In case of STOP, remote mode is available)
⑥	Output indicator LED	▪ Output indicator LED
⑦	Status indicator LED	It indicates CPU module's status. ▪ PWR(Red on): Power status ▪ RUN(Green on): RUN status ▪ Error(Red flickering): In case of error, it is flickering.
⑧	Built-in communication Connecting connector	• Built-in RS-232C/485 connecting connector
⑨	Power supply connector	▪ AC100~240V power supply connector
⑩	OS mode dip switch	▪ Dip switch for setting O/S download/Operation mode On: Boot mode, available to download O/S Off: User mode, available to download program using PADT
⑪	Option board holder	▪For connection option board

4.3 Power Supply Specifications

It describes the power supply specification of main unit.

Items			Specification					
			XBC-Dx10/14E	XBC-Dx20/30E	XBC-Dx20S(U)	XBC-Dx30S(U)	XBC-Dx40SU	XBC-Dx60SU
Input	Rated voltage (UL warranty voltage)		AC 100 ~ 240 V					
	Input voltage range		AC85~264V(-15%, +10%)					
	Inrush current		50APeak or less					
	Input current		0.5A or less (220V), 1A or less (110V)					
	Efficiency		65% or more					
	Permitted momentary power failure		Less than 10 ㎳					
Output	Rated output	DC5V	500mA	800mA	1.5A	1.5A	2.0A	2.5A
		DC24V	0.2A	0.2A	0.3A	0.3A	0.3A	0.5A
	Output voltage ripple		DC5V (±2%)					
Power supply status indication			LED On when power supply is normal					
Cable specification			0.75 ~ 2 mm^2					

* Use the power supply which has 4 A or more fuse for protecting power supply.

1) Consumption current (DC 5V)

Type	Model	Consumption current (Unit : ㎃)
Main unit	XBM-DR16S	400
	XBM-DN16S	250
	XBM-DN32S	280
	XBC-DR32H	660
	XBC-DR64H	1,040
	XBC-DN32H	260
	XBC-DN64H	330
	XBC-DN30S	255
	XBC-DN20S	240
	XBC-DN20SU	252
	XBC-DN30SU	270
	XBC-DN40SU	288
	XBC-DN60SU	340
	XBC-DP20SU	305
	XBC-DP30SU	352
	XBC-DP40SU	355
	XBC-DP60SU	394
	XBC-DR20SU	478
	XBC-DR30SU	626
	XBC-DR40SU	684
	XBC-DR60SU	942
	XBC-DR30E	470
	XBC-DR20E	350
	XBC-DR14E	280
	XBC-DR10E	250
	XBC-DN30E	210
	XBC-DN20E	200
	XBC-DN14E	190
	XBC-DN10E	180
	XBC-DP30E	210
	XBC-DP20E	200
	XBC-DP14E	190
	XBC-DP10E	180
Expansion I/O module	XBE-DC32A	50
	XBE-DC16A/B	30
	XBE-DC08A	20
	XBE-RY16A	440
	XBE-RY08A/B	240
	XBE-TN32A	80
	XBE-TN16A	50
	XBE-TN08A	40
	XBE-TP32A	80
	XBE-TP16A	50
	XBE-TP08A	40
	XBE-DR16A	250

Type	Model	Consumption current (Unit : ㎃)
Expansion special module	XBF-AD04A	120
	XBF-AD08A	105
	XBF-AH04A	120
	XBF-DV04A	110
	XBF-DC04A	110
	XBF-RD04A	100
	XBF-TC04S	100
	XBF-PD02A	500
	XBF-HD02A	260
	XBF-HO02A	200
	XBF-AD04C	100
	XBF-DC04C	160
	XBF-DV04C	160
Expansion communication module	XBL-C21A	120
	XBL-C41A	120
	XBL-EMTA	300
	XBL-EIMT	280
	XBL-EIMF	670
	XBL-EIMH	480
	XBL-EIPT	290
	XBL-CMEA	211
	XBL-CSEA	202
Option module	XBO-DC04A	80
	XBO-TN04A	100
	XBO-AD02A	50
	XBO-DA02A	150
	XBO-AH02A	150
	XBO-RD01A	30
	XBO-TC02A	50
	XBO-RTCA	30
	XBO-M2MB	-

4.4 Calculation Example of Consumption Current/Voltage

Calculate the consumption current and configure the system not to exceed the output current capacity of basic unit.

(1) XGB PLC configuration example 1
Consumption of current/voltage is calculated as follows.

Type	Model	Unit No.	Internal 5V consumption current (Unit : ㎃)	Remark
Main unit	XBC-DN20S	1	240	In case contact points are On. (Maximum consumption current)
Expansion module	XBE-DC32A	2	50	
	XBE-TN32A	2	80	
	XBF-AD04A	1	120	All channel is used. (Maximum consumption current)
	XBF-DC04A	1	110	
	XBL-C21A	1	110	
Consumption current	850 ㎃			-
Consumption voltage	4.25 W			0.85 * 5V = 4.25W

In case system is configured as above, since 5V consumption current is total 850mA and 5V output of XGB standard type main unit is maximum 1.5A, normal system configuration is available.

(2) XGB PLC configuration example 2

Type	Model	Unit No.	Internal 5V consumption current (Unit : ㎃)	Remark
Main unit	XBC-DN30S	1	255	In case all contact points are On. (Maximum consumption current)
Expansion module	XBE-DR16A	2	250	
	XBE-RY16A	2	440	
	XBF-AD04A	2	120	All channel is used. (Maximum consumption current)
	XBL-C21A	1	110	
Consumption current	1,985 ㎃			-
Consumption voltage	9.925 W			1.985 x 5V = 9.925W

If system is configured as above, total 5V current consumption is exceeded 1,985 mA and it exceeds the 5V output of XGB standard type main unit. Normal system configuration is not available. Although we assume the above example that all contact points are on, please use high-end type main unit which 5V output capacity is higher than standard type main unit.

(3) XGB PLC configuration example 3

Type	Model	Unit No.	Internal 5V consumption current (Unit : ㎃)	Remark
Main unit	XBC-DN32H	1	260	In case of all contact points are On. (Maximum consumption current)
Expansion module	XBE-DR16A	2	250	
	XBE-RY16A	2	440	
	XBF-AD04A	2	120	All channel is used. (Maximum consumption current)
	XBL-C21A	1	110	
Consumption current	1,990 ㎃			-
Consumption voltage	9.95 W			1.99A x 5V = 9.95W

The above system is an example using XBC-DN32H about system example (2). Unlike (2) example, 5V output capacity of XBC-DN32H is maximum 2A, normal configuration is available.

4.5 Data Backup Time

When RTC module is not installed with main unit, data is kept by super capacitor.
The following table shows the data backup time of the main unit,

Type	Data backup time		Remark
XBC “S” type “SU” type	backup by the Capacitor	18 Days	At normal temperature (25℃)
	RTC module installed	3 Yeas	
XBC “E” type	backup by the Capacitor	5 Days	
	RTC module installed	3 Yeas	

But charge super capacitor enough while power is on over 30 minute.

In case super capacitor is not charged enough or power is off more than data backup time, latch data is not kept and warning occurs. At this time, phenomenon and measure are as follows.

(1) Phenomenon
  (a) RUN mode
    1) In case of Remote Run mode, operation mode changes to Stop mode. In case of Local Run mode, it operates normally with abnormal data backup warning
    2) In case of Stop mode, abnormal data backup warning occurs.
  (b) Latch data
    1) Latch area 1,2 : all data are cleared into “0”.
    2) K area, F area : all data are cleared into “0”.

(2) Measure
  (a) In case abnormal data backup warning occurs when turning off and turning on within data backup time, technical assistance of main unit is necessary. Be careful data backup time is getting shorter at high temperature.

Notice

Above data backup time can be different according to temperature condition.

Chapter 5 Program Configuration and Operation Method

5.1 Program Instruction

5.1.1 Program execution methods

(1) Cyclic operation method (Scan)

This is a basic program proceeding method of PLC that performs the operation repeatedly for the prepared program from the beginning to the last step, which is called ‘program scan’. The series of processing like this is called ‘cyclic operation method’. The processing is divided per stage as below.

Stage	Processing description
Start	-
Initialization processing	• A stage to start the scan processing which is executed once when power is applied or Reset is executed, as below. ▸ I/O module reset ▸ Self-diagnosis execution ▸ Data clear ▸ Address allocation of I/O module and type register • If initializing task is designated, Initializing program is executed.
Input image area refresh	• Reads the state of input module and saves it in input image area before starting the operation of program.
Program operation processing Program start ⋮ Program last step	• Performs the operation in order from the program start to last step.
Output image area refresh	• Performs the operation in order from the program start to last step.
END	• A processing stage to return to the first step after CPU module completes 1 scan processing and the processing performed is as below. ▸ Update the current value of timer and counter etc. ▸ User event, data trace service ▸ Self-diagnosis ▸ High speed link, P2P e-Service ▸ Check the state of key switch for mode setting

(2) Interrupt operation (Cycle time, Internal device)

This is the method that stops the program operation in proceeding temporarily and carries out the operation processing which corresponds to interrupt program immediately in case that there occurs the status to process emergently during PLC program execution.

The signal to inform this kind of urgent status to CPU module is called ‘interrupt signal’. There is a Cycle time signal that operates program every appointed time and external interrupt signal that operates program by external contact (“S” type: P000~P007, “E” type: P000~P003). Besides, there is an internal device start program that starts according to the state change of device assigned inside.

(3) Constant Scan (Fixed Period)

This is the operation method that performs the scan program every appointed time. This stands by for a while after performing all the scan program, and starts again the program scan when it reaches to the appointed time. The difference from constant program is the update of input/output and the thing to perform with synchronization.

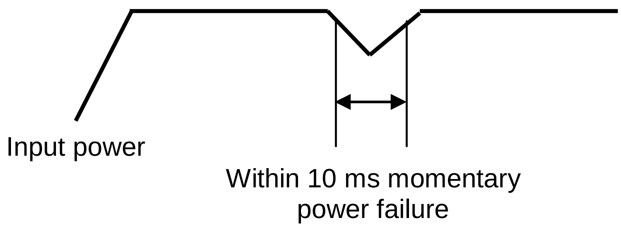
At constant operation, the scan time indicates the net program processing time where the standby time is deducted. In case that scan time is bigger than ‘constant’, [F0005C] ‘_CONSTANT_ER’ flag shall be ‘ON’.

5.1.2 Operation processing during momentary power failure

CPU module detects the momentary power failure when input power voltage supplied to power module is lower than the standard. If CPU module detects the momentary power failure , it carries out the operation processing as follows.

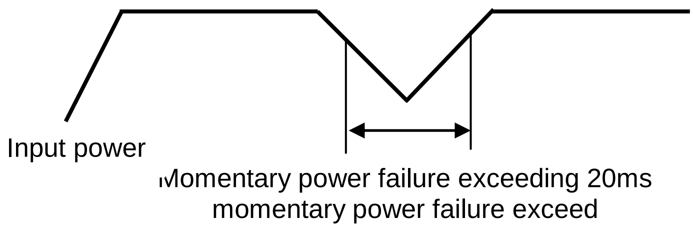
If momentary power failure within 10 ms is occurred, main unit (CPU) keeps the operation. But, if momentary power failure above 10 ㎳, the operation is stop and the output is Off. Restart processing like at power input shall be performed.

(1) Momentary power failure within 10 ms



• CPU keeps the operation.

(2) Momentary power failure exceeding 10 ms



• Restart processing like at power input shall be performed.

Remark

1) Momentary power failure?

This means the state that the voltage of supply power at power condition designated by PLC is lowered as it exceeds the allowable variable range and the short time (some ms ~ some dozens ms) interruption is called ‘momentary power failure’).

5.1.3 Scan time

The processing time from program step 0 to the next step 0 is called 'Scan Time'.

(1) Scan time calculation expression
Scan time is the sum of the processing time of scan program and interrupt program prepared by the user and PLC internal time, and is distinguished by the following formula.

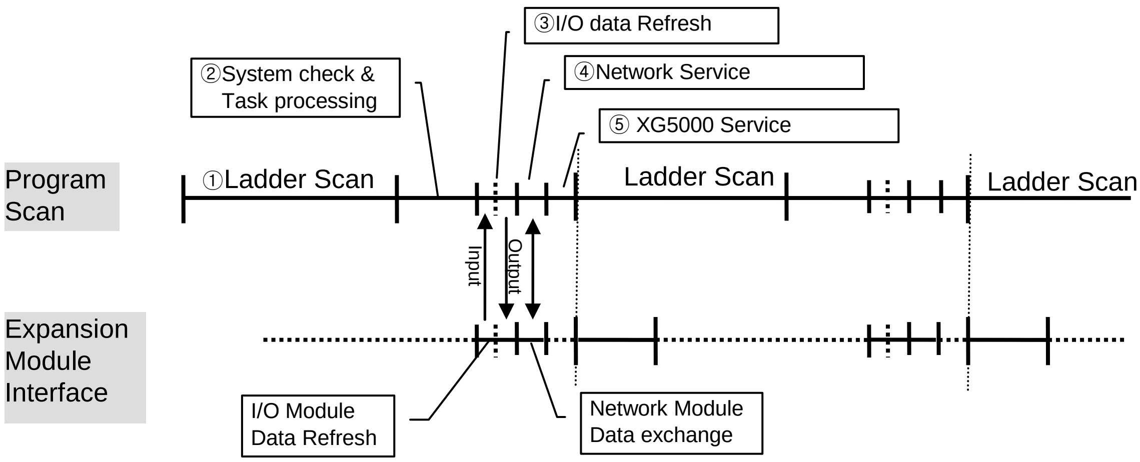
(a) Scan time = Scan program processing time ＋ Interrupt program processing time ＋ PLC internal processing time

- Scan program processing time = processing time of user program except interrupt program
- Interrupt program processing time = Sum of interrupt program proceeding time processed during 1 scan
- PLC internal processing time = Self-diagnosis time ＋ I/O refresh time ＋ Internal data processing time ＋ Communication service processing time

(b) Scan time depends on whether to execute interrupt program and communication processing.

Type	MPU processing time		Expansion interface processing time		
	Executing ladder (4Kstep)	PLC internal processing time	Digital I/O module (32 point, 1 unit)	Analog module (8 channel, 1 unit)	Comm. module (main/expansion) (200 byte, 1 block)
"E" type	5.4 ㎳	1.0 ㎳	-	-	0.5 ㎳
"S" type	3.0 ㎳	0.5 ㎳	0.3 ㎳	3.0 ㎳	0.8 ㎳

The main unit executes controls along the following steps. A user can estimate the control performance of a system that the user is to structure from the following calculation.



Scan time = ① Scan program process ＋ ② System check & Task process ＋ ③I/O data Refresh + ④ Network Service + ⑤ XG5000 Service + ⑥ User Task Program process

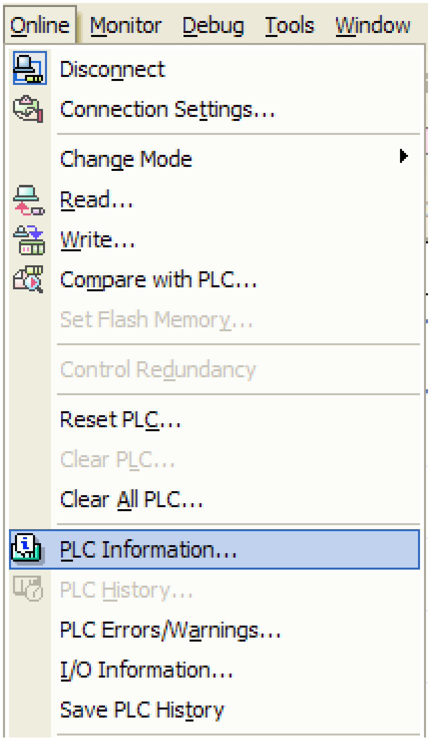
① Scan program process = no. of instruction x process speed per each instruction (refer to XGK/XGB instruction user manual)
② System check & Task process: 600 ㎲ ~ 1.0 ms [varies depending on the usage of auxiliary functions]
③ XG5000 Service process time: 100 ㎲ at the max data monitor
④ Task Program process time: sum of task processing time that occurs within a scan; the time calculation by task programs are as same as that of scan program.

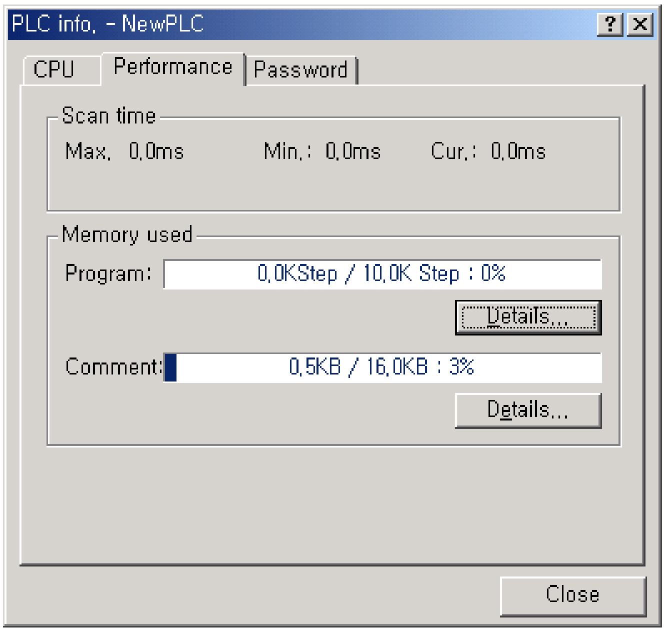
(2) Example

The scan time of a system consisting of main unit (program 4kstep) + five 32-point I/O modules + one analog module + one communication modules (200 byte 1 block)

Scan time(㎲) = ladder execution time + system processing time + digital module I/O processing time + analog I/O processing time + communication module processing time + XG5000 Service processing time
= (2047 x (0.67(LOAD)+ 0.80(OUT)) + (500) + (300 x 5) + (3000 x 1) + (800 x 1) + (100) ㎲
= 3009 + 500 + 1500 + 3000 + 800 + 100 ㎲ = 8909 ㎲
= 8.9 ㎳
(But, in case of online editing or writing XG-PD parameter, scan time increases temporary up to 100ms)

(3) Scan time monitor
(a) Scan time can be monitored 『Online』 - 『PLC Information』 - 『Performance』.





(b) Scan time is save in special relay (F) area as follows.
- F0050: max. value of scan time (unit: 0.1 ms)
- F0051: min. value of scan time (unit: 0.1 ms)
- F0052: current value of scan time (unit: 0.1 ms)

5.1.4 Scan Watchdog timer

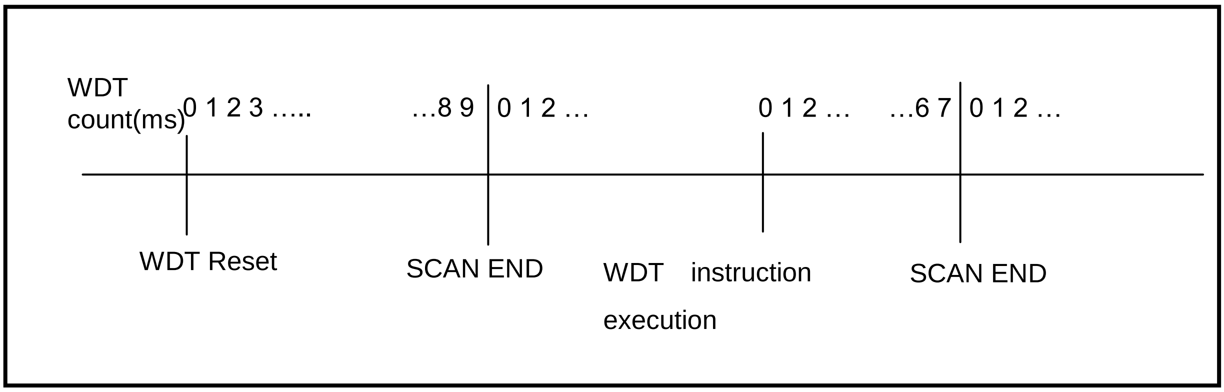
WDT (Watchdog Timer) is the function to detect the program congestion by the error of hardware and software of PLC CPU module.

(1) WDT is the timer used to detect the operation delay by user program error. The detection time of WDT is set in Basic parameter of XG5000.

(2) If WDT detects the excess of detection setting time while watching the elapsed time of scan during operation, it stops the operation of PLC immediately and keeps or clears the output according to parameter setting

(3) If the excess of Scan Watchdog Time is expected in the program processing of specific part while performing the user program (FOR ~ NEXT instruction, CALL instruction), clear the timer by using 'WDT' instruction.
'WDT' instruction initializes the elapsed time of Scan Watchdog Timer and starts the time measurement from 0 again.
(For further information of WDT instruction, please refer to Instruction.)

(4) To clear the error state of watchdog, we can use the following method : power re-supply, manipulation of manual reset switch, mode conversion to STOP mode.



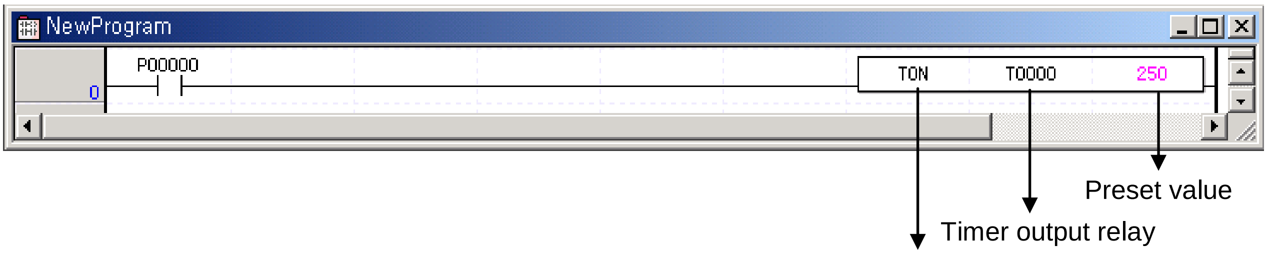
Remark

1) The setting range of Watchdog Timer is 10 ~ 1000ms (Unit: 1ms).

5.1.5 Timer processing

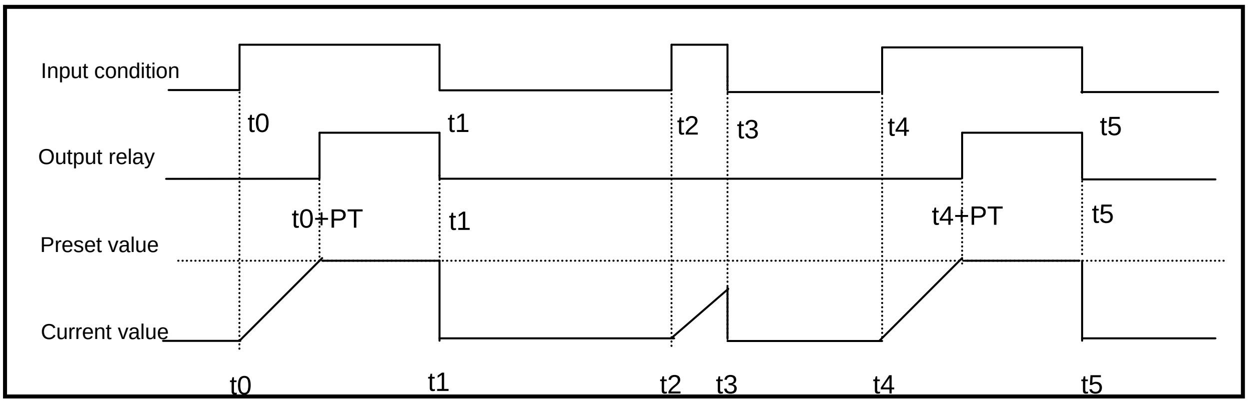
The XGB series use up count timer. There are 5 timer instructions such as on-delay (TON), off-delay (TOFF), integral (TMR), monostable (TMON), and re-triggerable (TRTG) timer.

The measuring range of 100msec timer is 0.1 ~ 6553.5 seconds, 10msec timer is 0.01 ~ 655.35 seconds, and that of 1msec timer is 0.001 ~ 65.53 seconds. Please refer to the 'XG5000 User manual' for details.



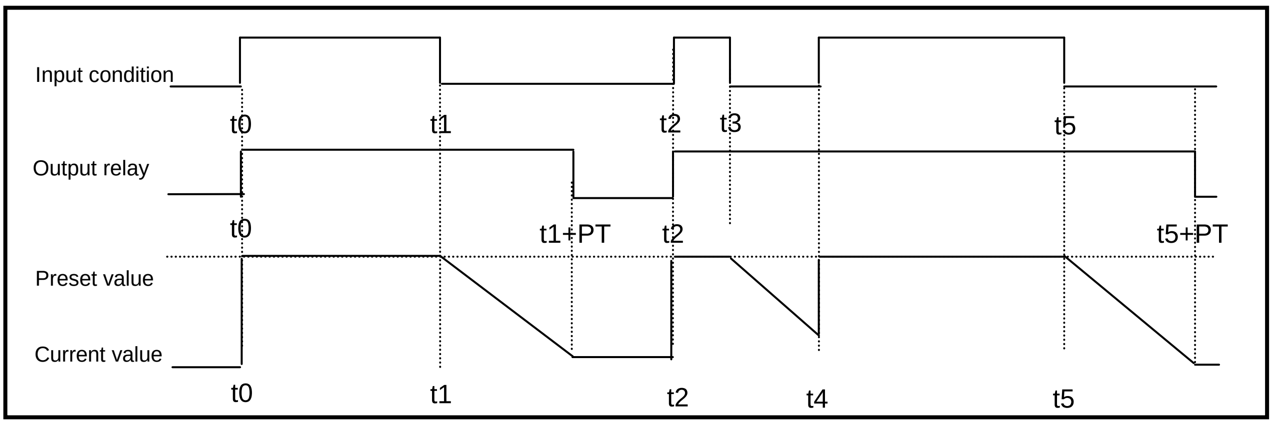
(1) On delay timer

The current value of timer starts to increase from 0 when the input condition of TON instruction turns on. When the current value reaches the preset value (Current value=Preset value), the timer output relay (Txxxx) turns on. When the timer input condition is turned off, the current value becomes 0 and the timer output relay is turned off.



(2) Off delay timer

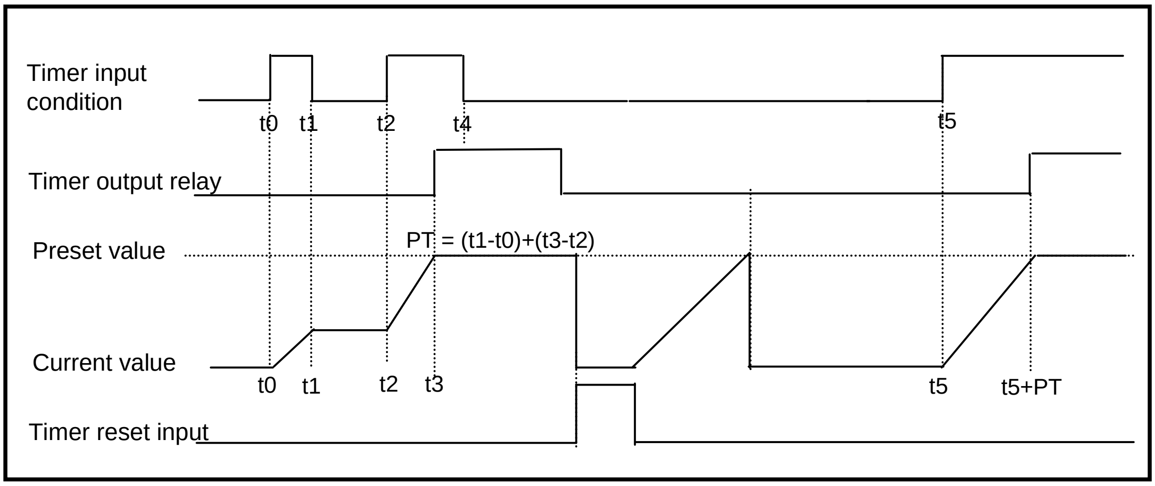
The current value of timer set as preset value and the timer output relay is turned on when the input condition of TOFF instruction turns on. When the input condition is turned off, the current value starts to decrease. The timer output relay is turned off when the current value reaches 0.



(3) Integral timer

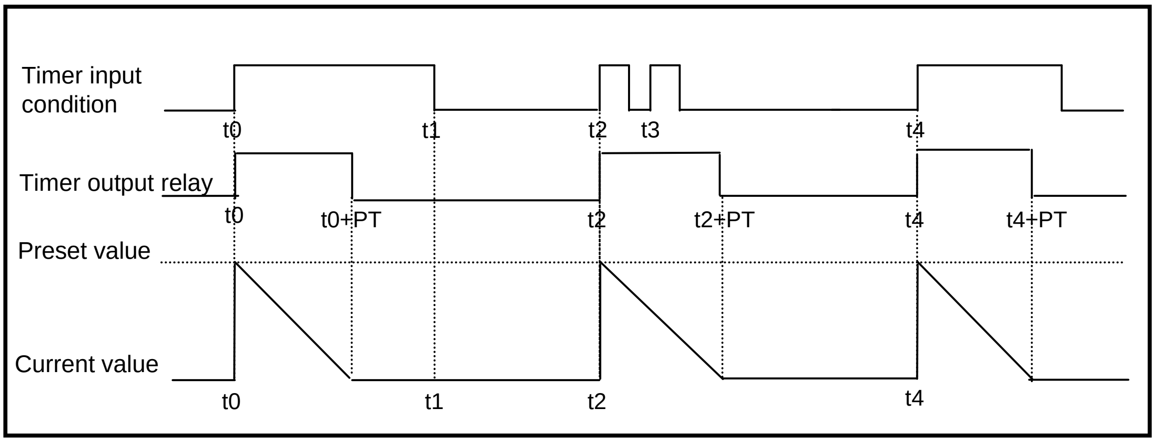
In general, its operation is same as on-delay timer. Only the difference is the current value will not be clear when the input condition of TMR instruction is turned off. It keeps the elapsed value and restart to increase when the input condition is turned on again. When the current value reaches preset value, the timer output relay is turned on.

The current value can be cleared by the RST instruction only.



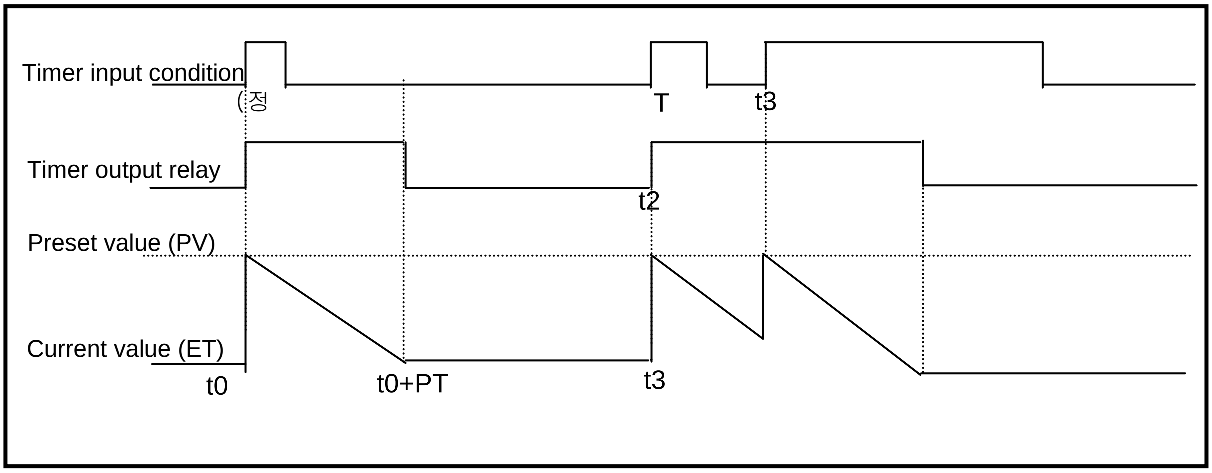
(4) Monostable timer

In general, its operation is same as off-delay timer. However, the change of input condition is ignored while the timer is operating (decreasing). When current value reaches preset value the timer output relay is turned off and current value is cleared.



(5) Retriggerable timer

The operation of retriggerable timer is same as that of monostable timer. Only difference is that the retriggerable timer is not ignore the input condition of TRTG instruction while the timer is operating (decreasing). The current value of retriggerable timer will be set as preset value whenever the input condition of TRTG instruction is turned on.



Remark

The Maximum timer error of timers of XGB series is ‘1 scan time + the time from 0 step to timer instruction’

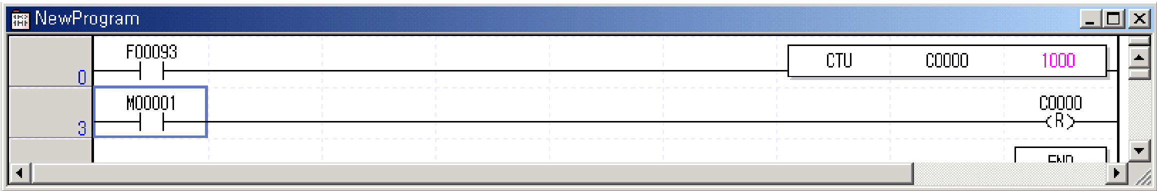
5.1.6 Counter processing

The counter counts the rising edges of pulses driving its input signal and counts once only when the input signal is switched from off to on. XGB series have 4 counter instructions such as CTU, CTD, CTUD, and CTR. The followings shows brief information for counter operation. Refer to the 'XGB Instruction Manual' for details.

- Up counter increases the current value.
- Down counter decreases the current value.
- Up/Down counter compares the input value from both counters input.
- Ring counter increase the current value and the current value is cleared as 0 when the current value reaches the preset value.

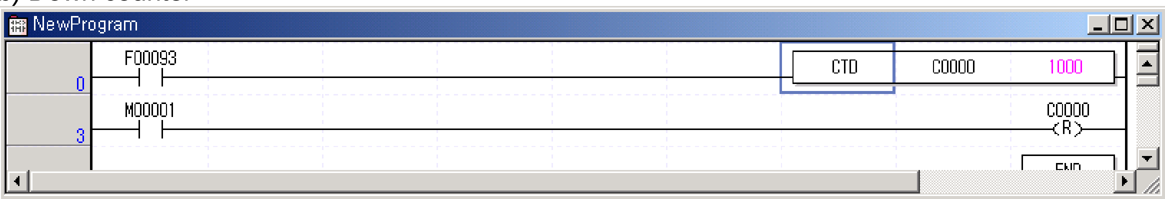
(1)Renewal of counter's current value and contact On/Off

(a) Up counter



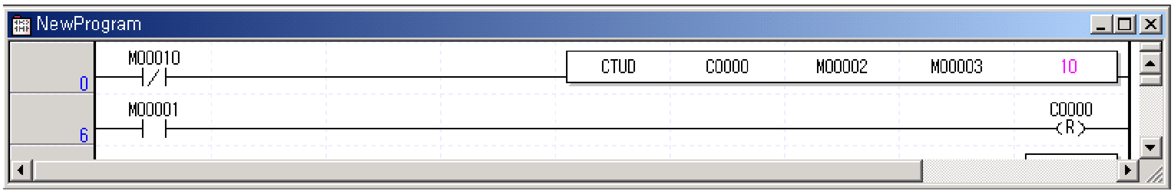
- Up counter increases the current value at the rising edges of input.
- The counter output contact (Cxxx) is turned On when the current value reaches the preset value. When the reset input is turned On, the counter output contact (Cxxx) is turned Off.

(b) Down counter



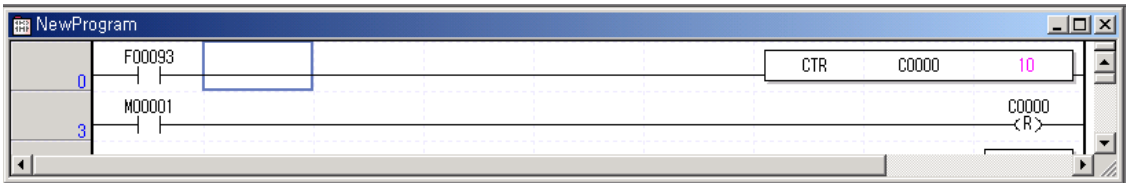
- Down counter decreases the current value at the rising edges of input.
- The counter output contact (Cxxx) is turned On when the current value reaches the preset value. When the reset input is turned On, the counter output contact (Cxxx) is turned Off.

(c) Up/Down counter



- The current value is increased with the rising edge of up-count input signal, and decreased with the rising edge of down-count input signal. The counter output contact (Cxxx) is turned On when the current value is same as or more than current value. The counter output contact (Cxxx) is turned Off when the current value is same as or less than current value.
- When the reset input is turned On, the current value is cleared as 0.

(d) Ring counter



- The current value is increased with the rising edge of the counter input signal, and the counter output contact (Cxxx) is turned on when the current value reaches the preset value. Then the current value and counter output contact (Cxxx) is cleared as 0 when the next rising edge of the counter input signal is applied.
- When the reset input is turned On, the counter output contact is cleared as 0.

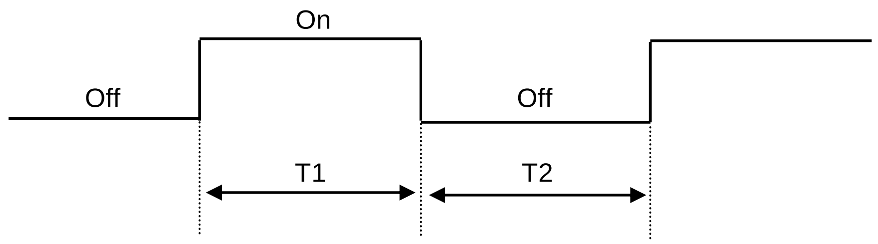
(2) Maximum counting speed

The maximum counting speed of determined by the length of scan time. Counting is possible only when the on/off switching time of the counter input signal is longer than scan time.

Maximum counting speed $C_{max} = \frac{n}{100} \times (\frac{1}{t_S})$

n : duty (%)
t_S : scan time [s]

- Duty is the ratio of the input signal's on time to off time as a percentage.



T1 ≤ T2, n = ——— x 100 [%]

$T1 > T2, \quad n = \frac{T2}{T1+T2} \times 100\ [\%]$

Remark

1) Use of High Speed Counter

In order to counter pulse that is faster than maximum counting speed of normal counter, use built-in High Speed counter function.

5.2 Program Execution

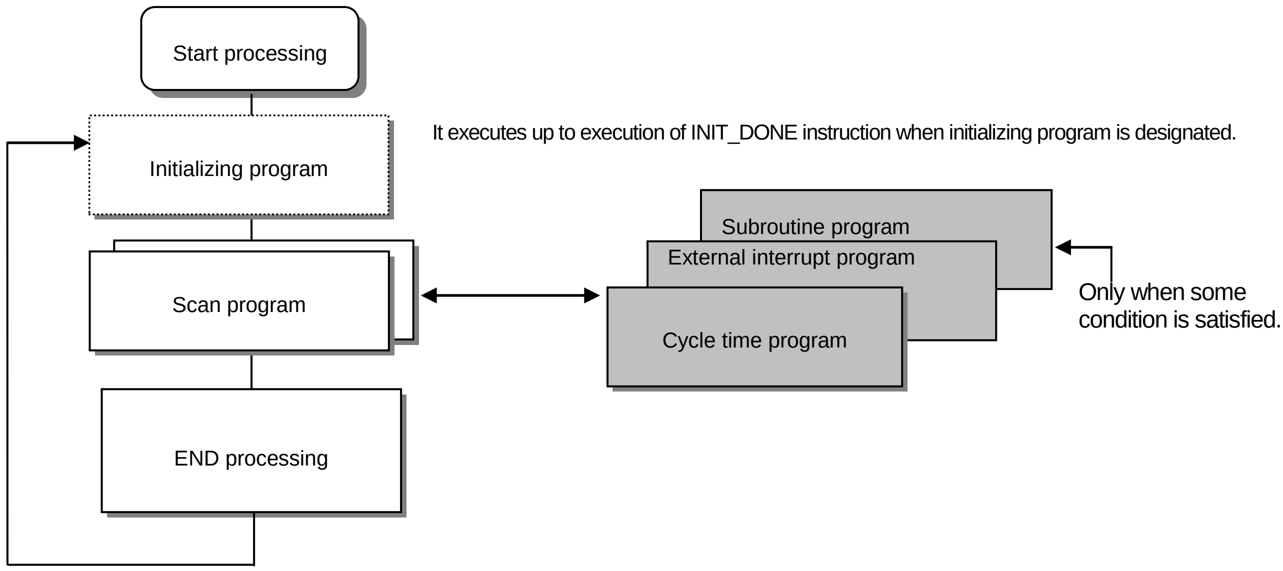
5.2.1 Configuration of program

All functional elements need to execute a certain control process are called as a 'program'. Program is stored in the built-in RAM mounted on a CPU module or flash memory of a external memory module. The following table shows the classification of the program.

Program type	Description
Initializing program	• It will be executed till the specific Flag 'INIT_DONE' is on. And while the initialization task is executed, cycle task, external interrupt task and internal device task are not executed. I/O refresh, high speed counter and communication are executed
Scan program	• The scan program is executed regularly in every scan.
Cycle time interrupt program	• The program is performed according to the fixed time interval in case that the required processing time condition is as below. ▸ In case that the faster processing than 1 scan average processing time is required ▸ In case that the longer time interval than 1 scan average processing time is required ▸ In case that program is processed with the appointed time interval
External interrupt program	• The external interrupt program is performed process on external interrupt signal.
Subroutine program	• Only when some condition is satisfied.(in case that input condition of CALL instruction is On)

5.2.2 Program execution methods

Here describes the program proceeding method that is executed when the power is applied or key switch is 'RUN'. The program performs the operation processing according to the configuration as below.



(1) Scan program

(a) Function

- This program performs the operation repeatedly from 0 step to last step in order prepared by the program to process the signal that is repeatedly regularly every scan.

- In case that the execution condition of interrupt by task interrupt or interrupt module while executing program is established, stop the current program in execution and perform the related interrupt program.

(2) Interrupt program

(a) Function

- This program stops the operation of scan program and then processes the related function in prior to process the internal/external signal occurred periodically/non-periodically.

(b) Type

- Task program is divided as below.
  - ▶ Cycle time task program: available to use up to 8.
  - ▶ Internal device task program: available to use up to 8.
  - ▶ I/O (External contact task program): “S” type available to use up to 8. (P000 ~ P007)
“E” type available to use up to 4. (P000~P003)

- Cycle time task program
  - ▶ Performs the program according to the fixed time internal.

- Internal device task program
  - ▶ Performs the corresponding program when the start condition of internal device occurs.
  - ▶ The start condition detection of device shall be performed after processing of scan program.

- I/O (External contact task program)
  - ▶ Performs the program according to the input external signal (“S” type: P000~P007, “E” type: P000~P003).

Remark

(1) Write the interrupt program as shortly as possible. In case same interrupt occurs repeatedly before completion of interrupt, program is not executed and O/S watch dog error may occur.

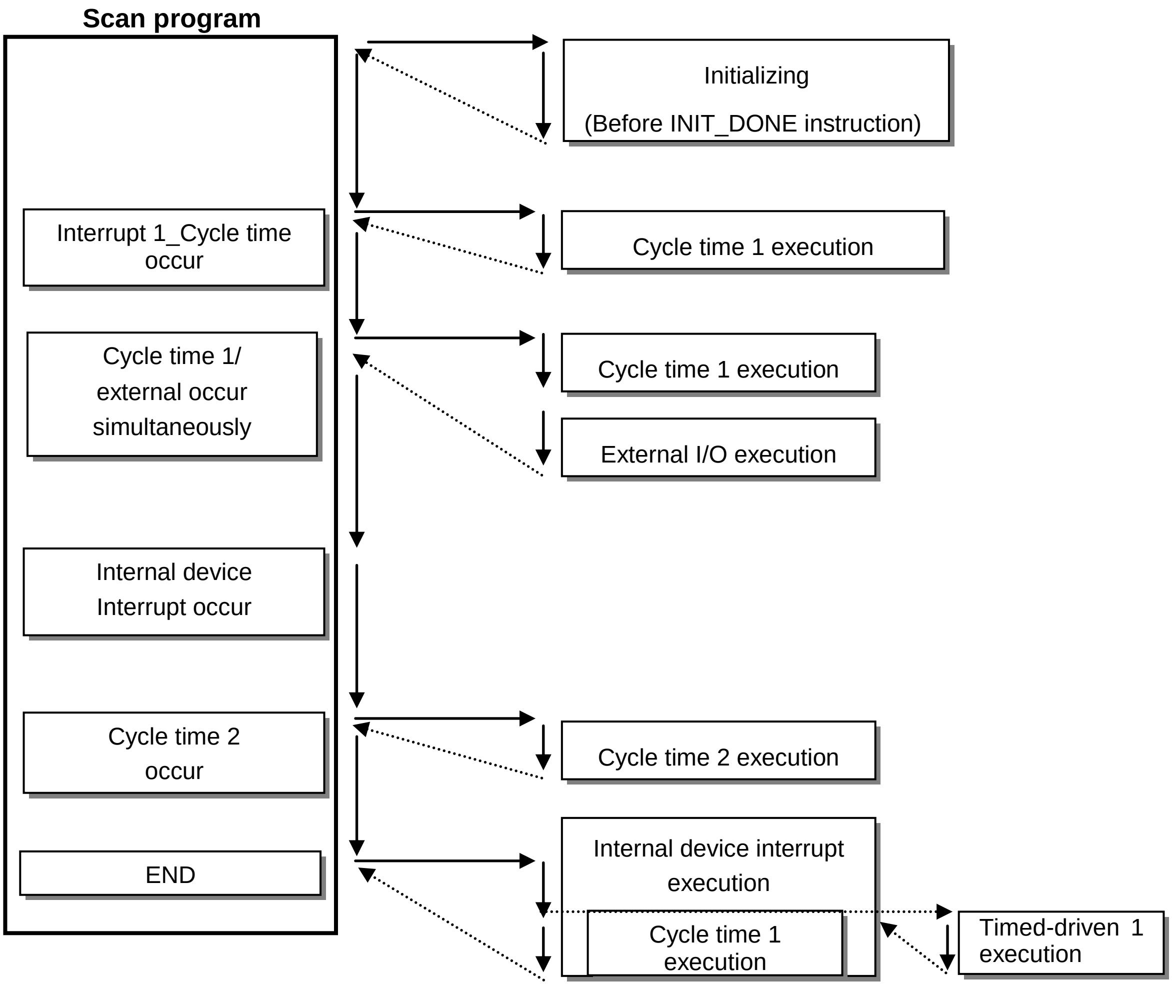
(2) Though interrupt which has lower priority occurs many times during execution of interrupt which has higher priority, interrupt which has lower priority occurs only one time.

5.2.3 Interrupt

For your understanding of Interrupt function, here describes program setting method of XG5000 which is an XGB programming S/W. Example of interrupt setting is as shown bellows.

• Interrupt setting

Interrupt source	Interrupt name	priority	Task No.	Program
Initializing	Interrupt 0_	-	-	-
Cycle time 1	Interrupt 1_cycle time	2	0	Cycle time 1
External	Interrupt 2_external	2	8	External
Internal device	Interrupt 3_internal	3	14	Internal
Cycle time 2	Interrupt 4_cycle time	3	1	Cycle time 2



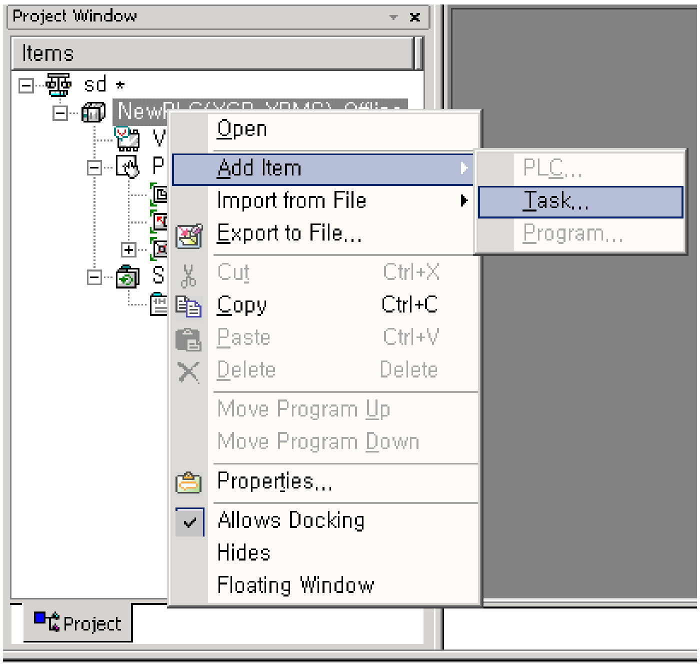
Remark

- In case that several tasks to be executed are waiting, execute from the highest Task Program in priority. When the same priority tasks are waiting, execute from the order occurred.
- While interrupt executing, if the highest interrupt is occurred, the highest interrupt is executed earliest of all.
- When power On, All interrupts are in the state 'Enable'. In case you don't use it, disable the interrupts by using DI instruction. If you want to use it again, enable by using EI instruction.
- Internal device interrupt is executed after END instruction.

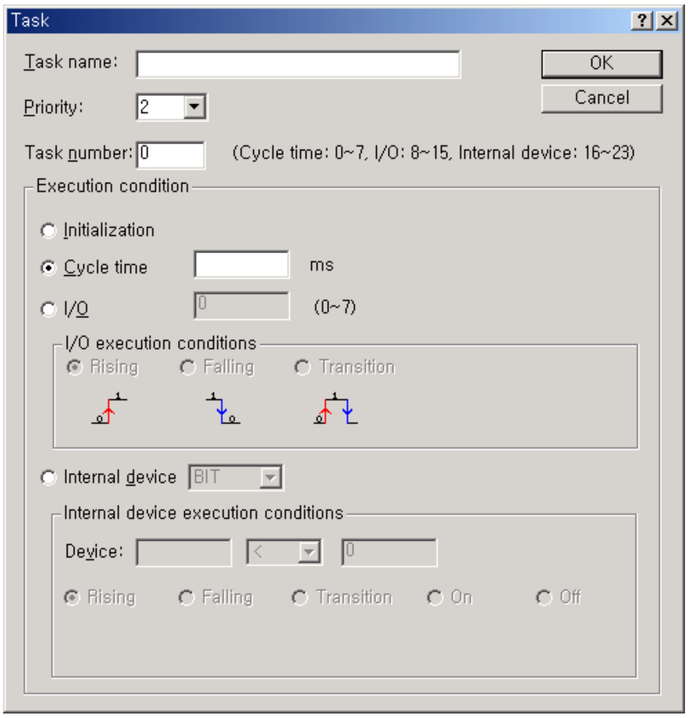
(1)How to prepare interrupt program

Generate the task in the project window of XG5000 as below and add the program to be performed by each task. For further information, please refer to XG5000 user's manual.
(It can be additional when XG5000 is not connected with PLC.)

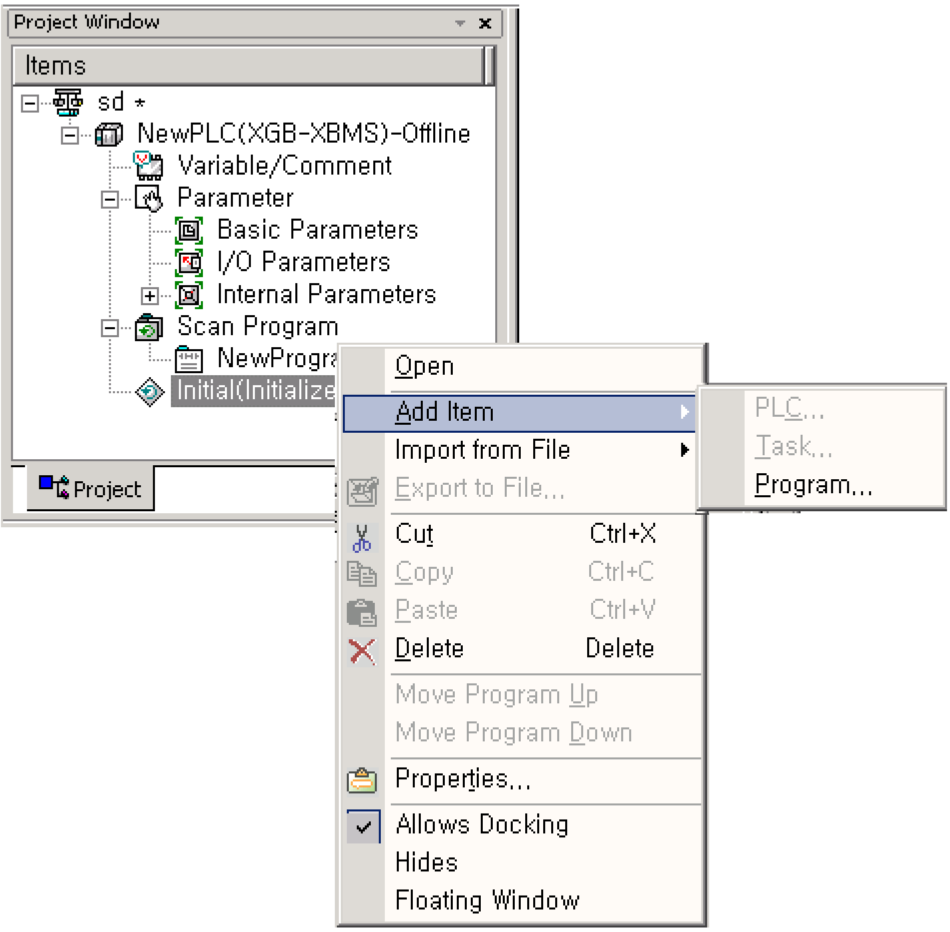
(a) Click right button of mouse on project name and click 『Add item』 - 『Task』.



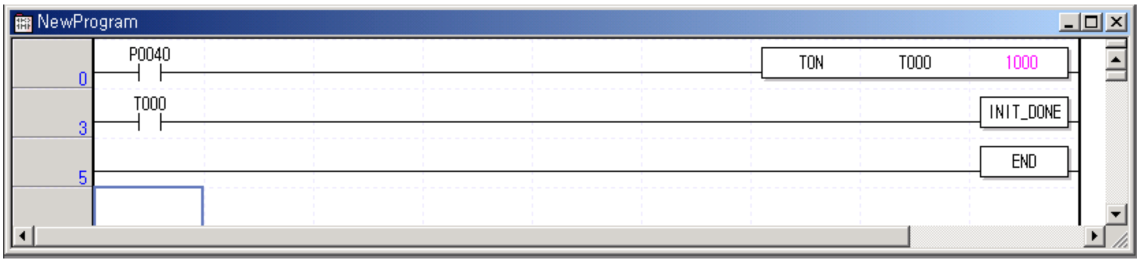
(b) The screen of Task setting is shown. Click 『Initialization』 in Execution condition and make a Task name.



(c) Click right button of mouse at registered task and select『Add Item』-『Program』.



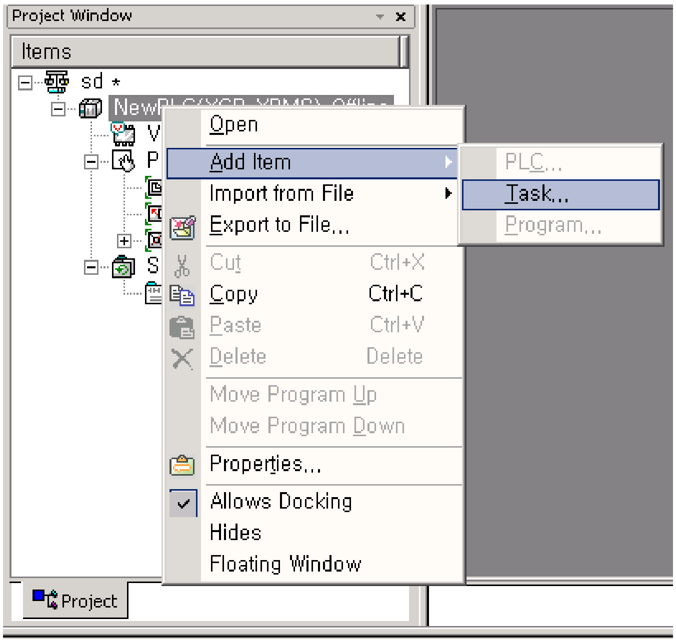
(d) Make initializing program. In initializing program, INIT_DONE instruction must be made. If not, Scan program is not executed.



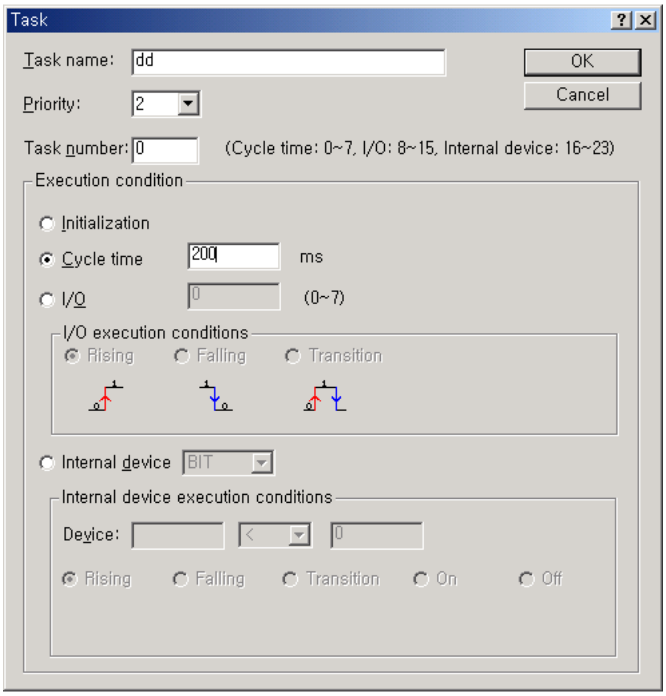
(2) How to prepare Cycle interrupt program

Generate the task in the project window of XG5000 as below and add the program to be performed by each task. For further information, please refer to XG5000 user's manual.
(It can be additional when XG5000 is not connected with PLC)

(a) Click right button of mouse at registered task and select 『Add Item』 - 『Task』.



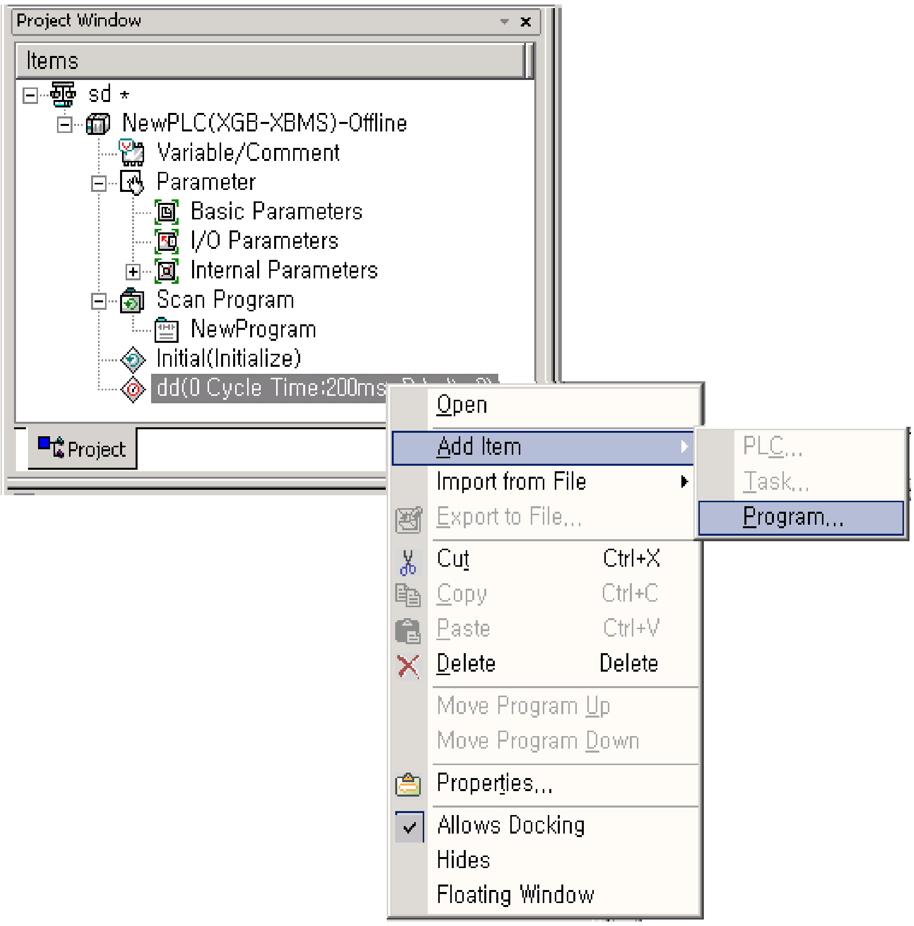
• It shows setting screen of Task.



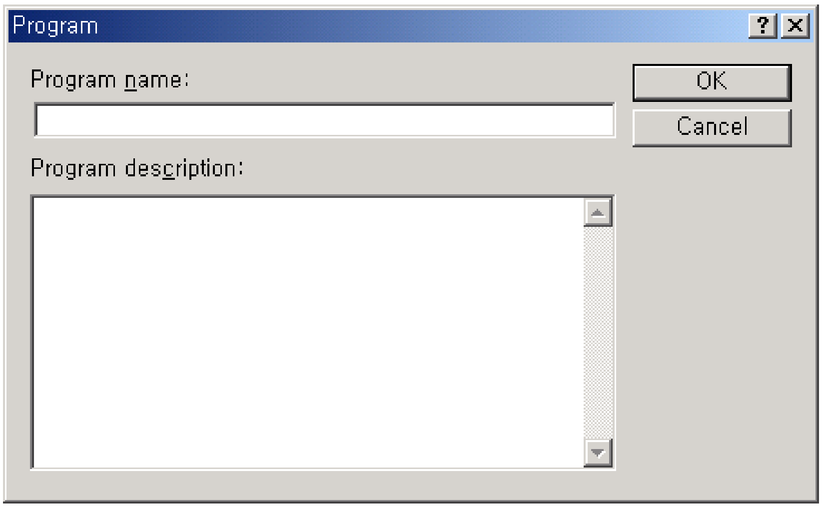
(b) Task type

Classification		Description	Remark
Task name		Make Task name.	Character, number available
Priority		Set the priority of task. (2~7)	“2” is the highest priority number.
Task number		Set the Task number. • Cycle time task (0 ~ 7): 8 • External I/O task (8 ~ 15): “S” type: 8, “E” type: 4 • Internal device task (16 ~ 23): 8	-
Execution condition	Initialization	Set the initial program when running the project.	Till the execution of INIT_DONE instruction
	Cycle time	Set the cyclic interrupt.	0~4294967295 ㎳ available
	I/O	Set the external I/O.	P000 ~ P007 available
	Internal device	Set the internal device to interrupt execution. • Bit: Among Rising, Falling, Transition, On, Off • Word: Among >,>=,<,<=	-

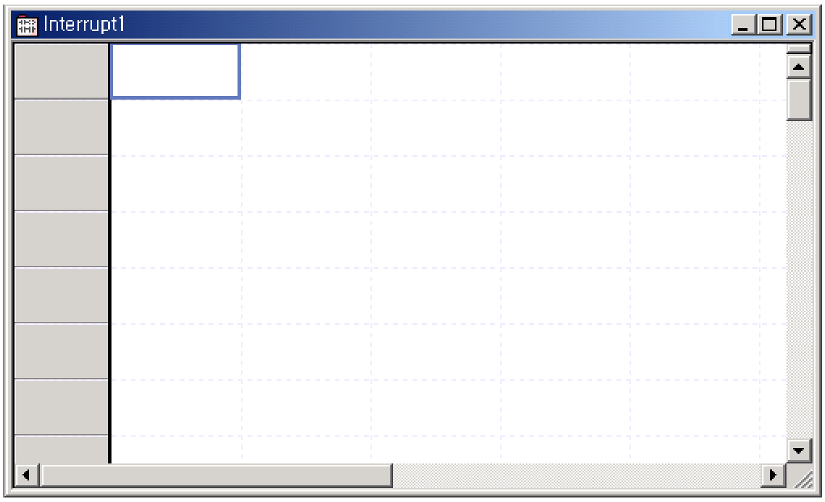
(c) Click right button of mouse at registered task and select『Add Item』-『Program』.



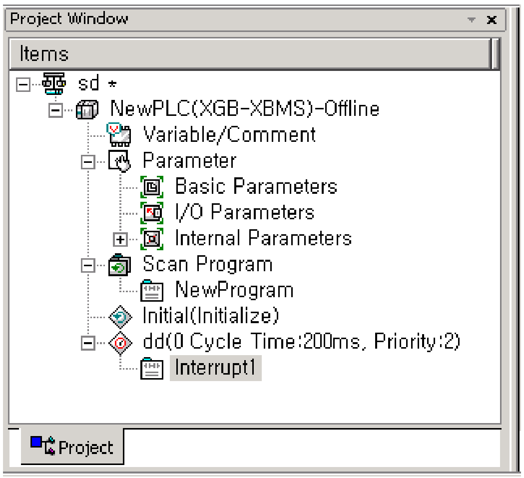
(d) Register the Program name and Program description.



(e) It is displayed the program window to write task program.



(f) It is displayed the setting in project window.



(3) Task type

Task type and function is as follows.

Spec. \ Type	Cycle time task (Interval task)	I/O task (Interrupt task)		Internal device task (Single task)
		"S" type	"E" type	
Max. Task number	8	8	4	8
Start condition	Cyclic (setting up to max. 4,294,967.295 sec. by 1ms unit)	Rising or falling edge of main unit's contact P000 ~P007	Rising or falling edge of main unit's contact P000 ~P003	Internal device execution condition
Detection and execution	Cyclic execution per setting time	Immediate execution at the edge of main unit's contact		Retrieve the condition and execute after completing Scan Program
Detection delay time	Max. 1 ms delay	Max. 0.05 ms delay		Delay as much as max. scan time
Execution priority	2~7 level setting (2 level is highest in priority)	2~7 level setting (2 level is highest in priority)		2~7 level setting (2 level is highest in priority)
Task no.	Within 0~7 range without user duplication	With 8~15 range without user duplication		Within 16~23 range without user duplication

(4) Processing methods of task program

Here describes common processing method and notices for Task program.

(a) Feature of task program
1) Task Program is executed only when execution condition occurs without every scan repeat processing. When preparing Task Program, please consider this point.
2) For example, if a timer and counter were used in cyclic task program of 10 second cycle, this timer occurs the tolerance of max. 10 seconds and the counter and the timer and as the counter checks the input status of counter per 10 seconds, the input changed within 10 seconds is not counted up.

(b) Execution priority
1) In case that several tasks to be executed are waiting, execute from the highest Task Program in priority. When the same priority tasks are waiting, execute from the order occurred.
2) In case Cycle time task and external I/O task is occurred concurrently, execute from the highest task program. (In sequence of XG5000 setting)
3) The task program priority should be set considering the program features, importance and the emergency when the execution requested.

(c) Processing delay time
There are some causes for Task Program processing delay as below. Please consider this when task setting or program preparation.
1) Task detection delay (Refer to detailed description of each task.)
2) Program proceeding delay caused by Priority Task Program proceeding

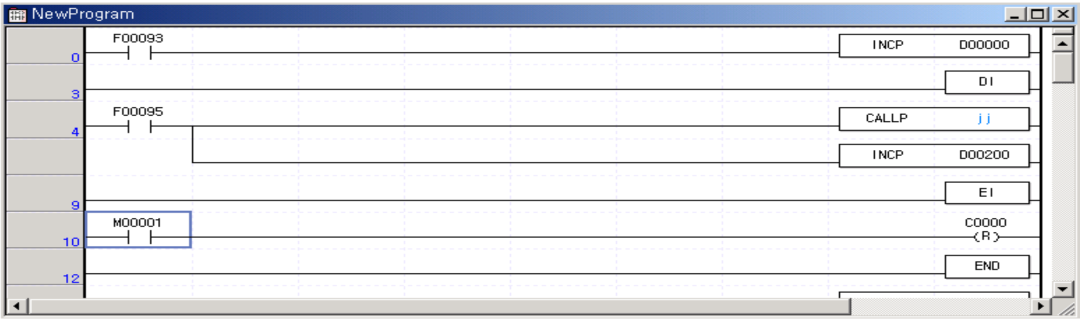
(d) Relationship of initialize, Scan Program and Task Program
1) ser identification task does not start while performing Initialization Task Program.
2) As Scan Program is set as lowest priority, if task occurs, stop Scan Program and process Task Program in advance. Accordingly, if task occurs frequently during 1 scan or concentrates intermittently, scan time may extend abnormally. Cares should be taken in case of task condition setting.

(e) Protection of Program in execution from Task Program

1) In case that the continuity of program execution is interrupted by high priority Task Program during program execution, it is available to prohibit the execution of Task Program partially for the part in problem. In this case, it is available to perform the program protection by ' DI (Task Program Start Disabled) and 'EI (Task Program Start Enabled)' application instruction.

2) Insert 'DI' application instruction in the start position of the part requiring the protection and insert 'EI' application instruction in the position to release. Initialization Task is not influenced by 'DI', 'EI' application instruction.

3) If interrupt is occurred while 'CALLP' instruction executing, interrupt program is executed after 'CALLP' instruction execution.



(5) Cyclic task program processing method

Here describes the processing method in case that task (start condition) of Task program is set as Cycle time.

(a) Items to be set in Task

Set the execution cycle and priority which are the start condition o f Task program to execution. Check the task no. to manage the task.

(b) Cyclic task processing

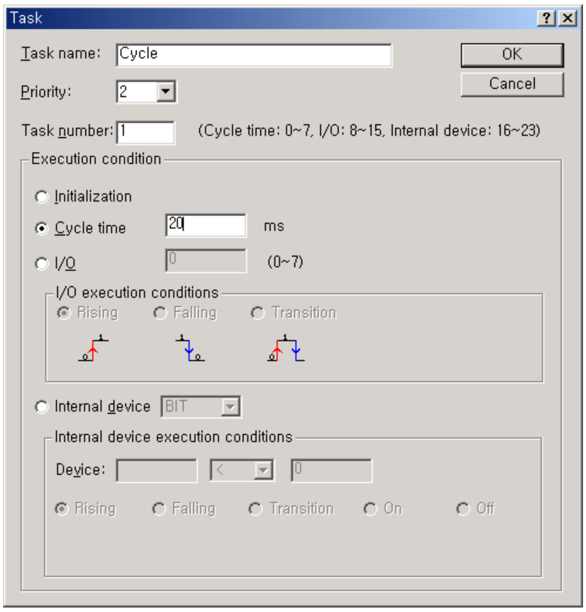
Performance the corresponding cyclic task program per setting time interval (execution cycle).

(c) Notice in using cyclic task program

1) When cyclic task program is in execution currently or waiting for execution, if the demand to execute the same task program occurs, the new occurred task shall be disregarded.

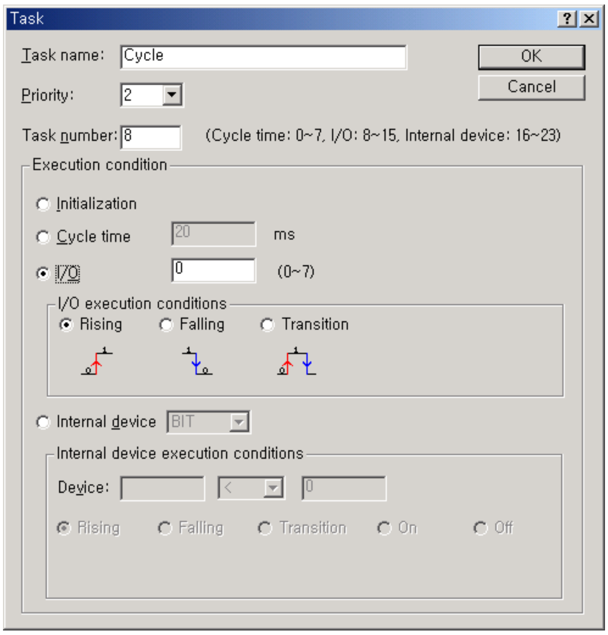
2) Timer that makes a demand to execute cyclic task program only while operation mode is Run mode, shall be added. The shutdown time shall be all disregarded.

3) When setting the execution cycle of cyclic task program, consider the possibility that the demand to execute several cyclic task program at the same time occurs.
If 4 cyclic task programs that the cycle is 2sec, 4sec, 10sec and 20sec are used, 4 demands of execution per 20 seconds shall be occurred at the same time and scan time may extend instantaneously.



(6) I/O task program processing

It described the I/O task program processing. (“S” type: P000~P007, “E” type: P000~P003)



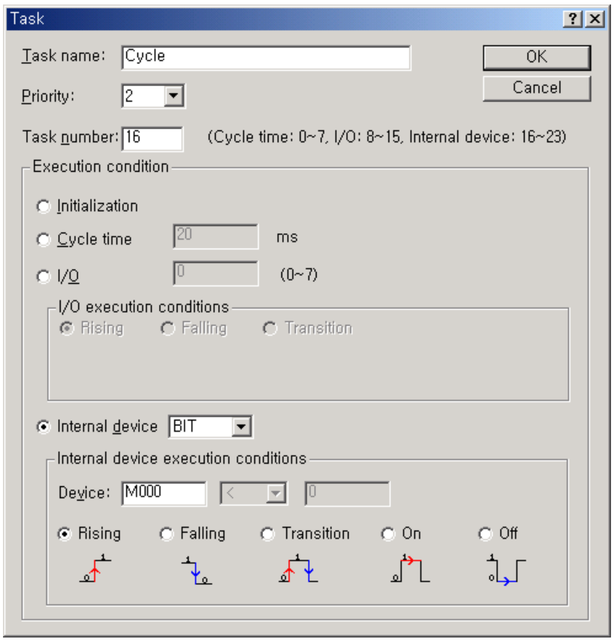
(a) Items to be set in Task
Set the execution condition and priority to the task being executed. Check the task no. to manage the task.

(b) I/O task processing
If interrupt signal from external signal (I/O) is occurred on main unit (“S” type: P000 ~ P007. “E” type: P000~P003), task program is executed by external (I/O) signal.

(c) Precaution in using I/O task program
1) If task program which is executed by interrupt signal is on execution or standby status, new task program which is requested by identical I/O is ignored.
2) Only operation mode is Run mode, execution request of task program is recognized. Namely, execution request of task program is ignored when operation mode is Stop mode.

(7) Internal device task program processing

Here describes the processing method of international device task program which extended the task (start condition) of task program from contact point to device as execution range.



(a) Items to be set in Task

Set the execution condition and priority to the task being executed. Check the task no. for task management.

(b) Internal device task processing

After completing the scan program execution in CPU module, if the condition that becomes the start condition of internal device task program is met, according to the priority, it shall be executed.

(c) Precautions in using internal device task program

1) Accordingly, even if the execution condition of internal device task program occurs in Scan Program or Task Program (Cycle time, I/O), it shall not be executed immediately but executed at the time of completion of Scan Program.
2) If the demand to execute Internal Device Task Program occurs, the execution condition shall be examined at the time of completion of Scan Program. Accordingly, if the execution condition of Internal Device Task occurs by Scan Program or Task Program (Cycle time) during '1 scan' and disappears, the task shall not be executed as it is not possible to detect the execution at the time of examination of execution condition.

(8) Verification of task program

(a) Is the task setting proper?
If task occurs frequently more than needed or several tasks occur in one scan at the same time, scan time may lengthen or be irregular. In case not possible to change the task setting, verify max. scan time.

(b) Is the priority of task arranged well?
The low priority task program shall be delayed by the high priority task program, which results in disabling the processing within the correct time and even task collision may occur as next task occurs in the state that the execution of previous task is delayed. Consider the emergency of task and execution time etc when setting the priority.

(c) Is the Task Program written in shortest?
If the execution time of Task Program is longer, scan time may lengthen or be irregular. Even it may cause the collision of task program. Write the execution time as short as possible. (Especially, when writing the cyclic task program, write the execution time so that the task program can be executed within 10% cycle of the shortest task among several tasks.)

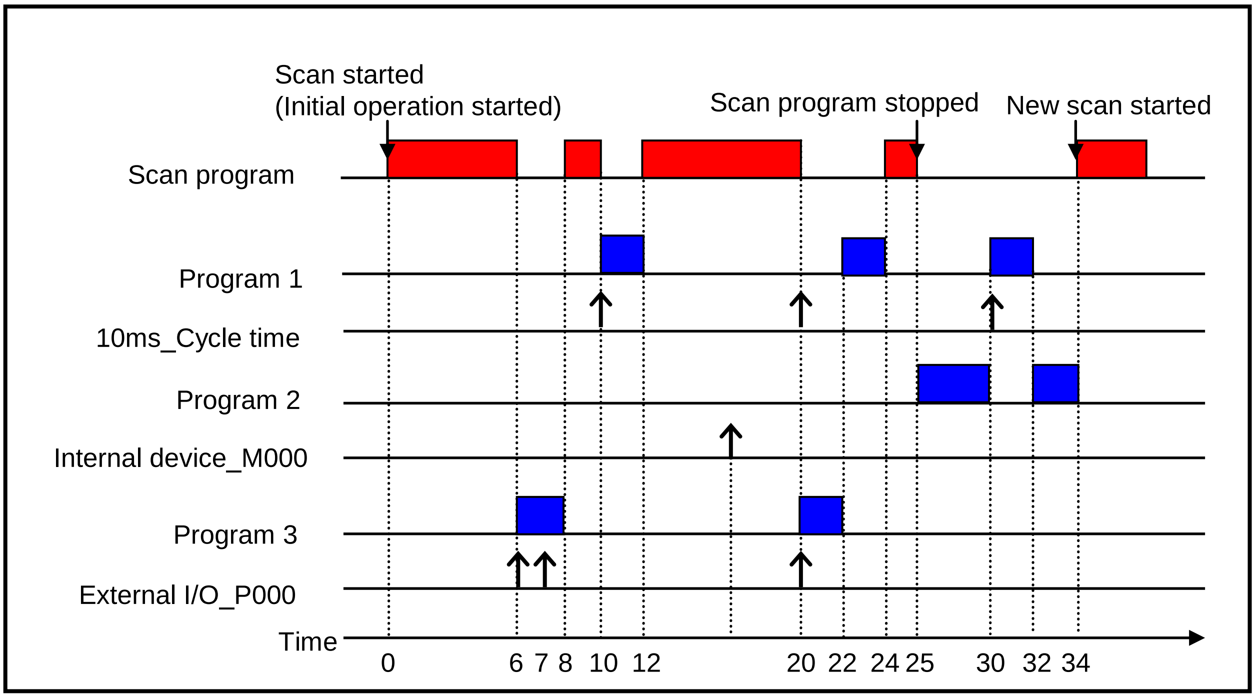
(d) Is program protection for the high priority task needed during program execution?
If other task is inserted during task program execution, complete the task in execution and operate the standby tasks in the order of high priority. In case that it is not allowed to insert other task in Scan Program, prevent the insert partially by using ‘DI’ and ‘EI’ application instruction. The problem may occur while processing the global variables used commonly with other program or special or communication module.

(9) Program configuration and processing example

If task and program are registered as below.

Interrupt type	Interrupt name	Priority	Task No.	Program
Cycle time	10 ㎳_cycle time	3	0	Program 1
Internal device	Internal device_M00	5	16	Program 2
I/O	I/O_P00	2	8	Program 3

1) Scan program name: “ Scan Program”
2) Execution time respective program: Scan program = 17 ㎳, Program 1 = 2 ㎳, Program 2= 7 ㎳, Program 3 = 2 ㎳



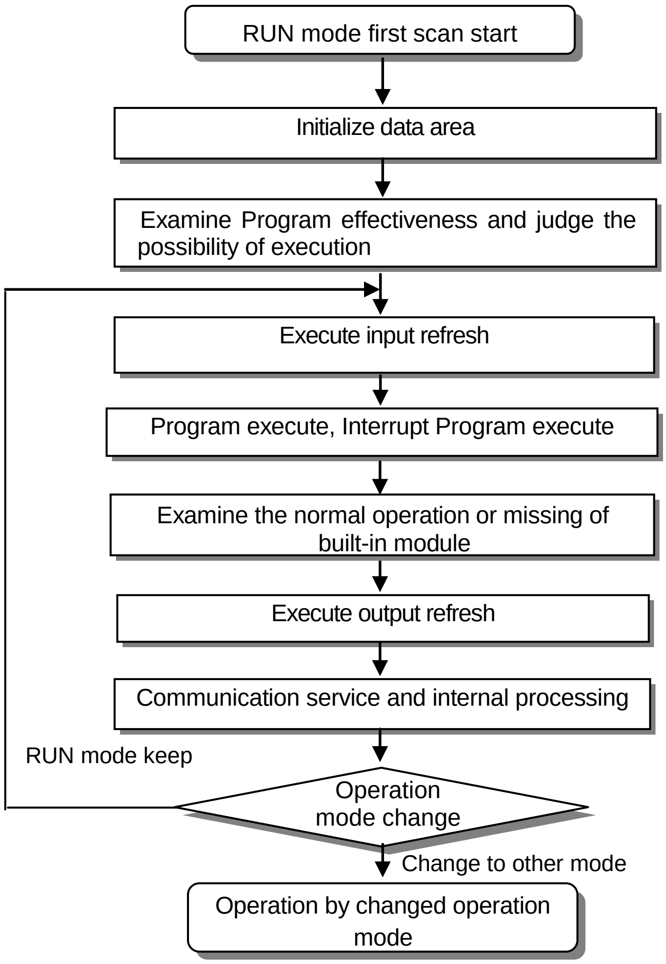
Process per time	
Time (㎳)	Process
0	Scan started and scan program started to execute.
0~6	Scan program is executed.
6~8	Scan program is stop because execution external I/O (P000) is requested. And program 3 is executed. Request of execution at 7[ms] is ignored because program 3 has been executing.
8~10	Program 3 is finished and Scan program is continued.
10~12	Scan program is stop by request of ‘10 ㎳_Cycle time’ interrupt signal and execute program 1.
12~20	Program 1 is finished and Scan program is continued.
20	Request of ‘Cycle time’ interrupt signal and ‘External I/O (P000)’ signal is occurred concurrently but priority of ‘External I/O’ signal is higher than ‘Cycle time’ interrupt signal so program 3 is executed and program 1 is standby.
20~22	Program 3 is finished and Scan program is continued.
22~24	After program 3 is completed, program 1 (the program of ‘10ms_Cycle time’ is executed.
24~25	P1 execution completed and the stopped scan program execution finished
25	At the finished point of scan program, check the request of Internal device ‘M000’ execution and execute program 2.
25~30	Program P2 is executed.
30~32	When ‘10 ㎳_Cycle time’ interrupt signal is occurred, the priority of that is higher than Internal device ‘M000’ though program 2 is stopped and program 1 is executed.
32~34	P1 executed completed and the stopped P2 execution finished
34	New scan starts (Start scan program execution)

5.3 Operation Mode

For operation mode of CPU module, there are 3 types such as RUN mode, STOP mode and DEBUG mode..
Here describes the operation processing of each operation mode.

5.3.1 RUN mode

This is the mode to executed program operation normally.



(1) Processing at mode change
At the beginning, execute initialization of data area and examine the effectiveness of program and judge the possibility of execution.

(2) Operation processing contents
Execute I/O refresh and program operation.
(a) Detects the start condition of Interrupt Program and executes Interrupt Program.
(b) Examines the normal operation or missing of built-in module.
(c) Communication service and other internal processing.

5.3.2 STOP mode

This is the mode in stop state without Program operation. It is available to transmit the program through XG5000 only in Remote STOP mode.

(1) Processing at Mode Change
Clear the output image area and execute output refresh.

(2) Operation Processing Contents
(a) Executes I/O refresh.
(b) Examines the normal operation or missing of built-in module.
(c) Communication service or other internal processing.

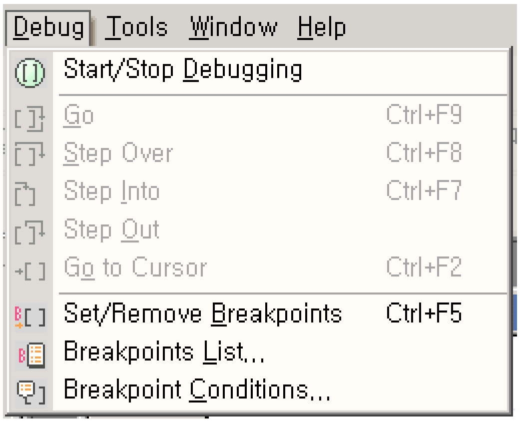
5.3.3 DEBUG mode (Supported at "S" type)

This is the mode to detect Program error or trace the operation process and the conversion to this mode is available only in STOP mode. This is the mode to check the program execution state and the contents of each data and verify the program.

(1) Processing at mode change
(a) Initializes the data area at the beginning of mode change.
(b) Clears the output image area and execute input refresh.

(2) Operation processing contents
(a) Executes I/O refresh.
(b) Debug operation according to setting state.
(c) After finishing Debug operation by the end of Program, execute output refresh.
(d) Examine the normal operation or missing of built-in module.
(e) Executes communication service or other service.

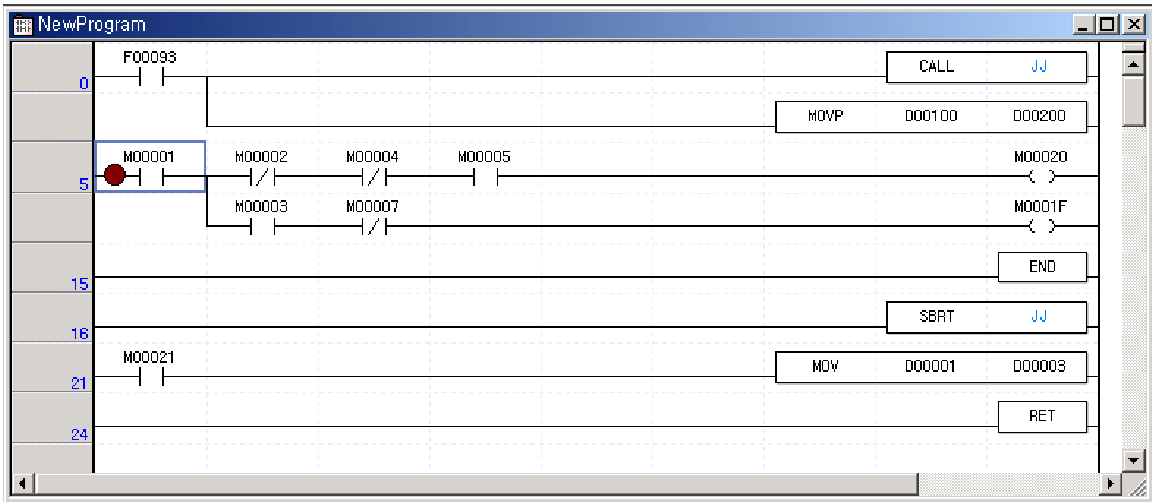
(3) Debug operation
❑ It describes debug mode.



Item	Description	Remark
Start/Stop Debugging	Change the debug ↔ stop mode	
Go	It starts debug operation.	
Step Over	It operates by 1 step.	
Step Into	It starts the subroutine program.	Other operation is identical to Step Over.
Step Out	It finished the subroutine program.	
Go to Cursor	It operates to current cursor position.	
Set/Remove Breakpoints	Set/Removes current cursor position to break points.	
Breakpoints List	It displays list of breakpoints.	
Breakpoint Conditions	It specifies device value and number of scan.	

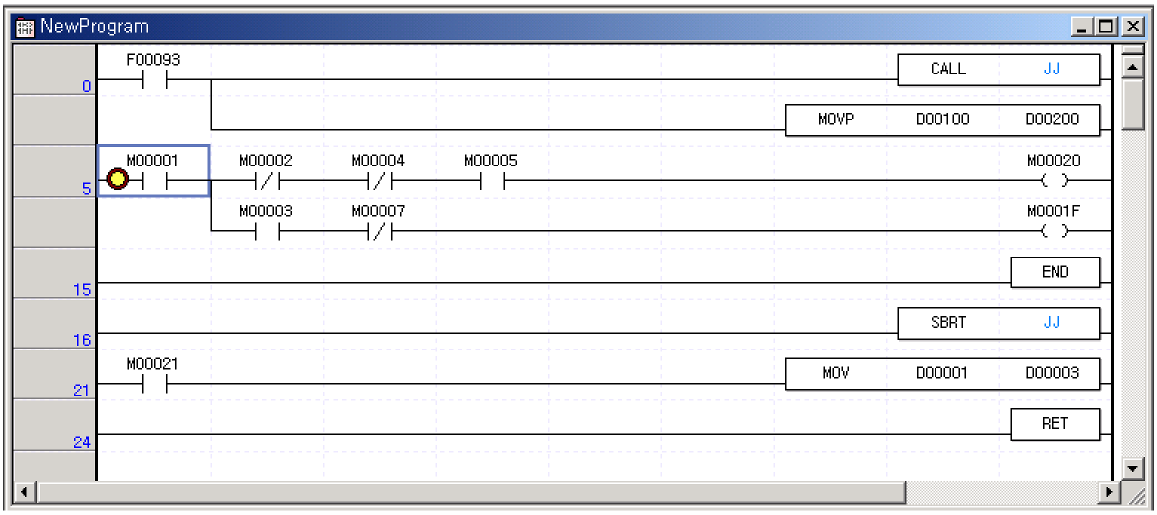
(a) Set/Remove Breakpoints

▪ Sets breakpoint at current cursor position. After breakpoint setting, (breakpoint setting indicator) is displayed.



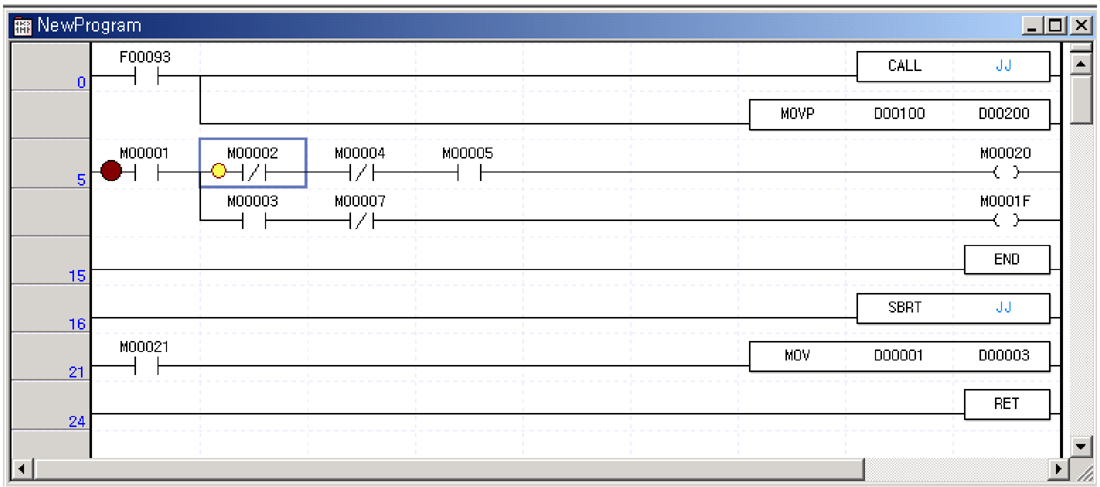
(b) Go

▪ Run the program to breakpoint. At break-pointer (stop indicator) is displayed.



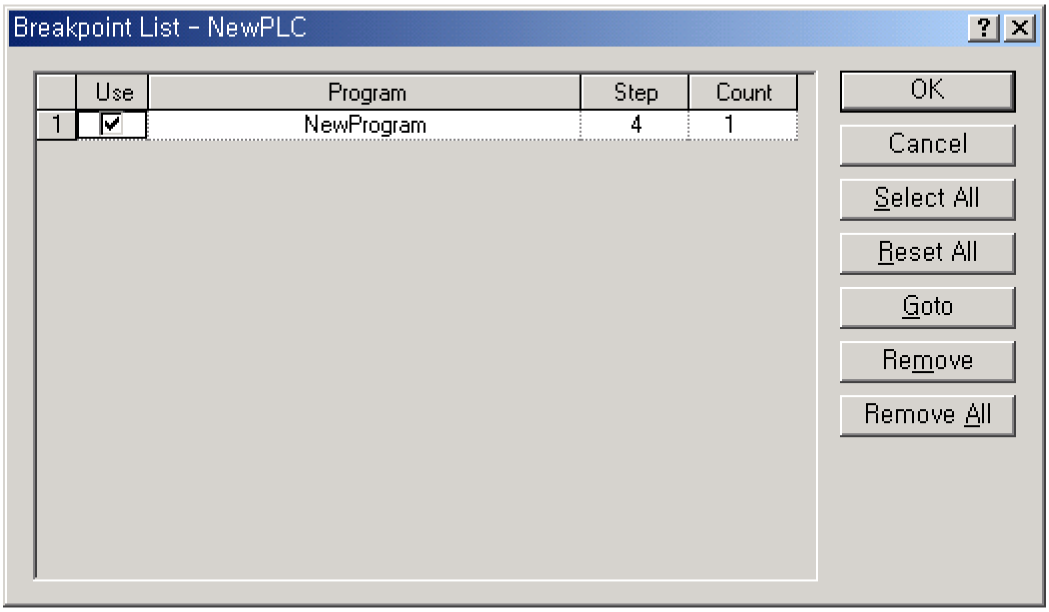
(c) Step Over

▪ Run the program to next step. At break point, Step over indicator is displayed.



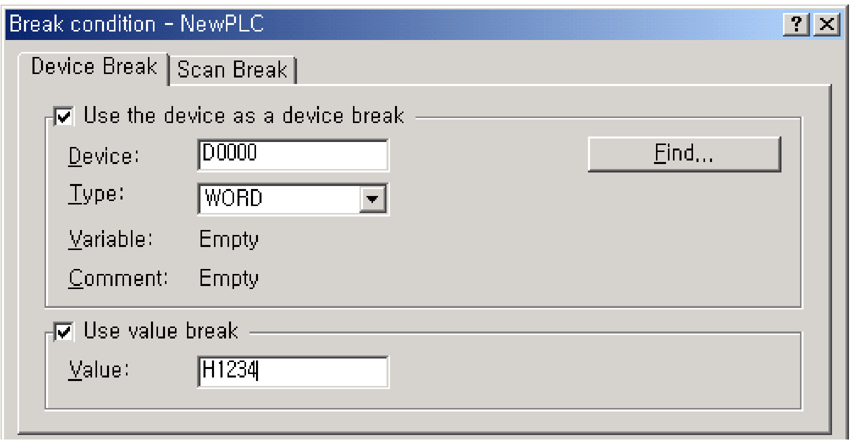
(d) Breakpoint List

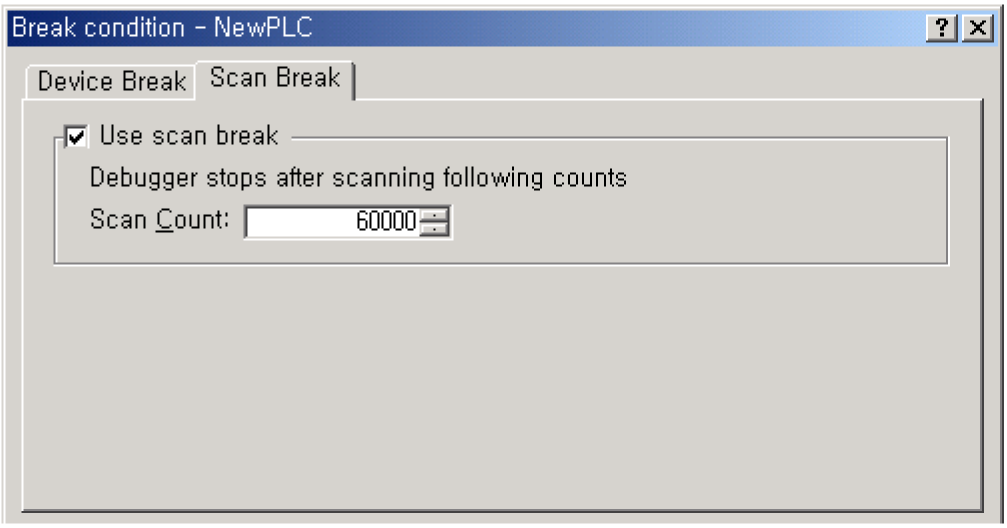
▪ It displays current Breakpoint List. It supports Select All, Reset All, Goto, Remove, Remove All.



(e) Break condition

▪ It sets Device Break and Scan Break.





Remark

1) Refer to XG5000 Users Manual ‘Chapter 12 Debugging’ for detailed information.

5.3.4 Change operation mode

(1) Operation Mode Change Method

The method to change operation mode are as follows.

(a) By mode key of CPU module
(b) By connecting the programming tool (XG5000) to communication port of CPU
(c) By changing the operation mode of other CPU module connected to network by XG5000 connected to communication port of CPU.
(d) By using XG5000, HMI, computer link module connected to network
(e) By 'STOP' instruction during program execution

(2) Type of operation mode

The operation mode setting is as follows.

Operation mode switch	XG5000 command	Operation mode
RUN	unchangeable	Local Run
STOP	RUN	Remote Run
	STOP	Remote Stop
	Debug	Debug Run
	Mode change	Previous operation mode
RUN -> STOP	-	Stop

(a) Remote mode conversion is available only in the state of **'Remote Enabled: On'**, **'Mode switch: Stop'**.
In case of changing the Remote 'RUN' mode to 'STOP' by switch, operate the switch as follows.
(STOP) → RUN → STOP.

Warning

In case of changing Remote RUN mode to RUN mode by switch, PLC operation continues the operation without interruption.

It is available to modify during RUN in RUN mode by switch but the mode change operation by XG5000 is limited. This should be set only in case that remote mode change is not allowed.

5.4 Memory

There are two types of memory in CPU module that the user can use. One is Program Memory that saves the user program written by the user to build the system, and the other is Data Memory that provides the device area to save the data during operation.

5.4.1 Data memory

(1) Bit device area

Various Bit Device are provided per function. The indication method is indicated by device type for first digit, word position by decimal for middle digit and bit position by hexadecimal for the last digit.

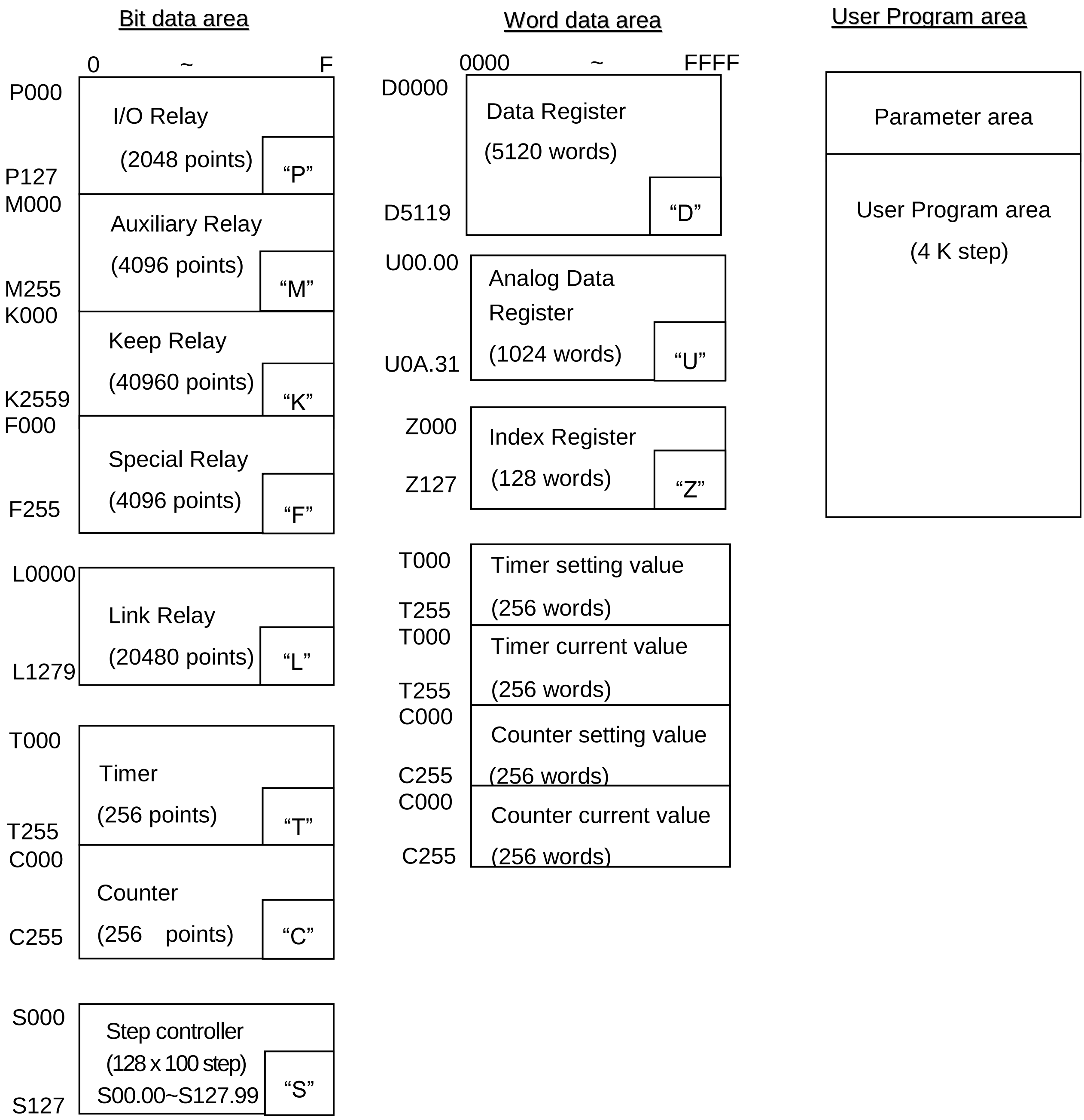
Area per device		Device features	Description
"E" type	"S" type		
P0000 ~ P127f	P0000~ P1023f	I/O device "P"	Image area to save the state of I/O device. After reading the input module state, saves it in the corresponding P area and sends P area Data saving the operation result to output module.
M0000 ~ M255f	M0000~ M1023f	Internal device "M"	Internal Memory provided to save Bit Data in Program
L0000 ~ L1279f	L0000~ L2047f	Communication device "L"	Device to indicate high speed link/P2P service state information of communication module.
K00000 ~ K2559f	K00000~ K4095f	Preservation device "K"	Device area to preserve the data during power shutdown, which is used without setting power shutdown preservation parameter separately. (Pay attention to write in special area (K2600 ~ 2559F)).
F0000 ~ F255f	F0000~ F1023f	Special device "F"	System flag area that manages the flag necessary for system operation in PLC.
T0000 ~ T255	T0000~ T1023	Timer device "T"	Area to save the state of contact/current value/set value of timer device
C0000 ~ C255	C0000~ C1023	Counter device "C"	Area to save the state of contact/current value/set value of counter device
S00.00 ~ S127.99	S00.00~ S127.99	Step controller "S" 128 x 100 step	Relay for step control

(2) Word device area

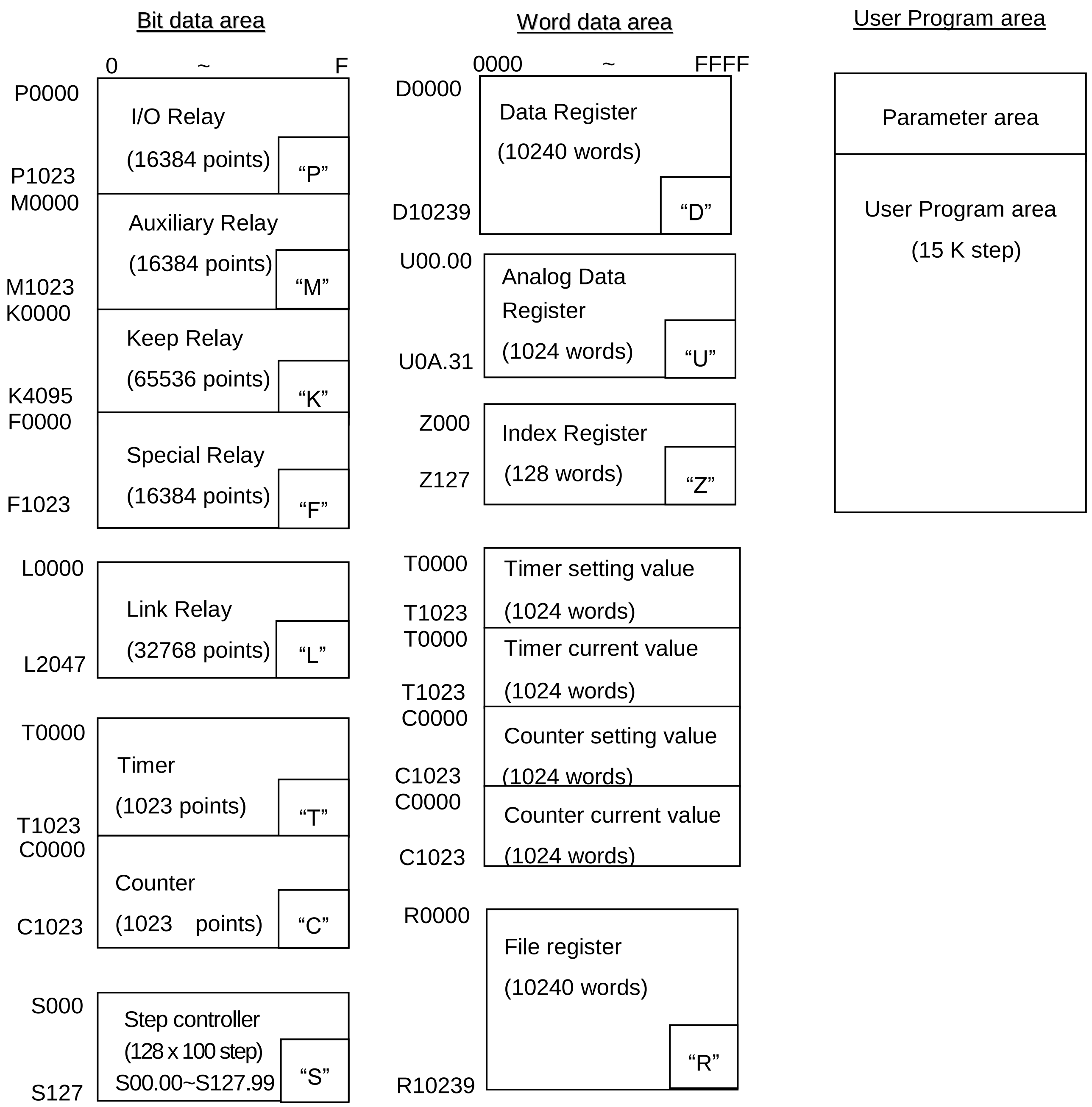
Area per device		Device features	Description
“E” type	“S” type		
D00000 ~ D5119	D0000~ D10239	Data register “D”	Area to preserve the internal data. Bit expression possible. (D0000.0)
U00.00 ~ U0A.31	U00.00~ U0A.31	Analog data register “U”	Register used to read data from special module installed in the slot. Bit expression possible
Z000 ~ Z127	Z000~ Z127	Index register “Z”	Dedicated device to use Index function Bit expression impossible
T0000 ~ T255	T0000~ T1023	Timer current value register “T”	Area to indicate the current value of timer
C0000 ~ C255	C0000~ C1023	Counter current value register “C”	Area to indicate the current value of counter
-	R0000~ R10239	File register “R”	Register for saving file Bit expression available (F0000.0)

5.5 Configuration Diagram of Data Memory

5.5.1 “E” type



5.5.2 "S" type


Bit data area
0 ~ F
P0000
I/O Relay
(16384 points)
"P"
P1023
M0000
Auxiliary Relay
(16384 points)
"M"
M1023
K0000
Keep Relay
(65536 points)
"K"
K4095
F0000
Special Relay
(16384 points)
"F"
F1023
L0000
Link Relay
(32768 points)
"L"
L2047
T0000
Timer
(1023 points)
"T"
T1023
C0000
Counter
(1023 points)
"C"
C1023
S000
Step controller
(128 x 100 step)
S00.00~S127.99
"S"
S127
Word data area
0000 ~ FFFF
D0000
Data Register
(10240 words)
"D"
D10239
U00.00
Analog Data Register
(1024 words)
"U"
U0A.31
Z000
Index Register
(128 words)
"Z"
Z127
T0000
Timer setting value
(1024 words)
T1023
T0000
Timer current value
(1024 words)
T1023
C0000
Counter setting value
(1024 words)
C1023
C0000
Counter current value
(1024 words)
C1023
R0000
File register
(10240 words)
"R"
R10239
User Program area
Parameter area
User Program area
(15 K step)

5.5.3 Data latch area setting

When PLC stops and restarts the data required for operation or the data occurred during operation, if you want to keep and use those data, data latch can be used and it is available to use a certain area of some data device as latch area by parameter setting.

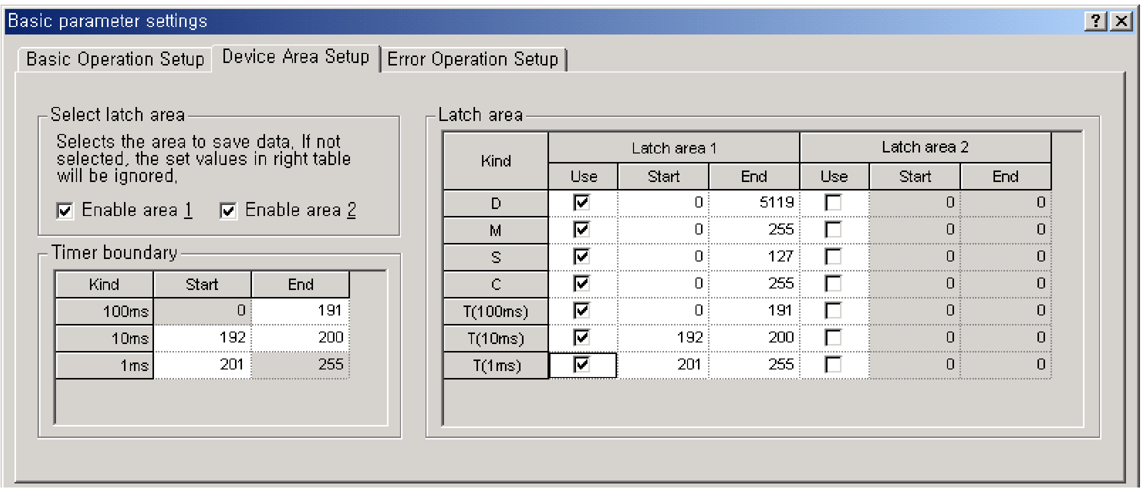
The below shows the features for latch device.

Device	1st latch	2nd latch	Features
P	X	X	Image area to save the state of I/O device
M	O	O	Internal device area
K	X	X	Device keeping the device state during power shutdown
F	X	X	System flag area
T	O	O	Timer related area (Bit/words both)
C	O	O	Counter related area (Bit/words both)
S	O	O	Relay for step control
D	O	O	General words data save area
U	X	X	Analog Data Register (latch disabled)
L	X	X	High speed link/P2P Service state device of communication module (latch enabled)
Z	X	X	Index dedicated Register (latch disabled)
R	O	O	File register (latch enabled)

Remark

▪ K, L, R devices are basically latched.

(1) Latch area setting
(a) Click Device Area Setup of Basic parameter settings.



(2) Data latch area operation

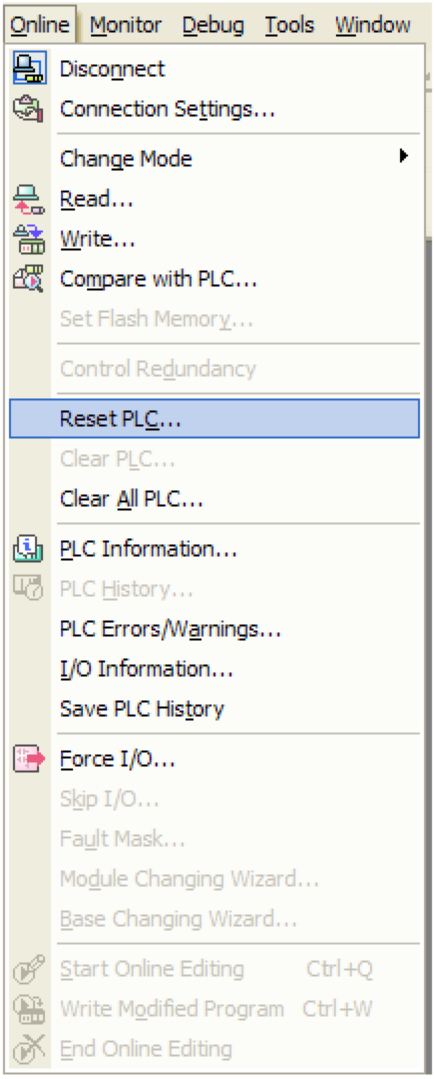
(a) The method to delete the latched data is as below.

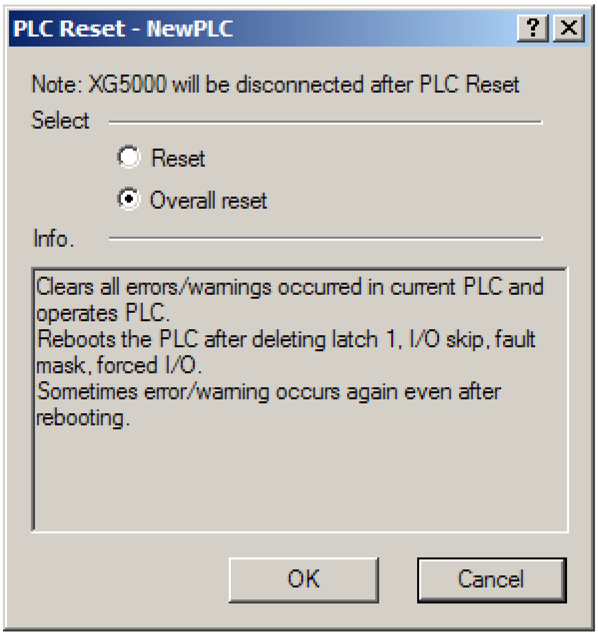
- latch 1, latch 2 clear operation by XG5000
- write by Program (initialization program recommended)
- write ‘0’ FILL from XG5000 monitor mode.

For keep or reset (clear) operation of latch area data according to PLC operation, please refer to the below table.

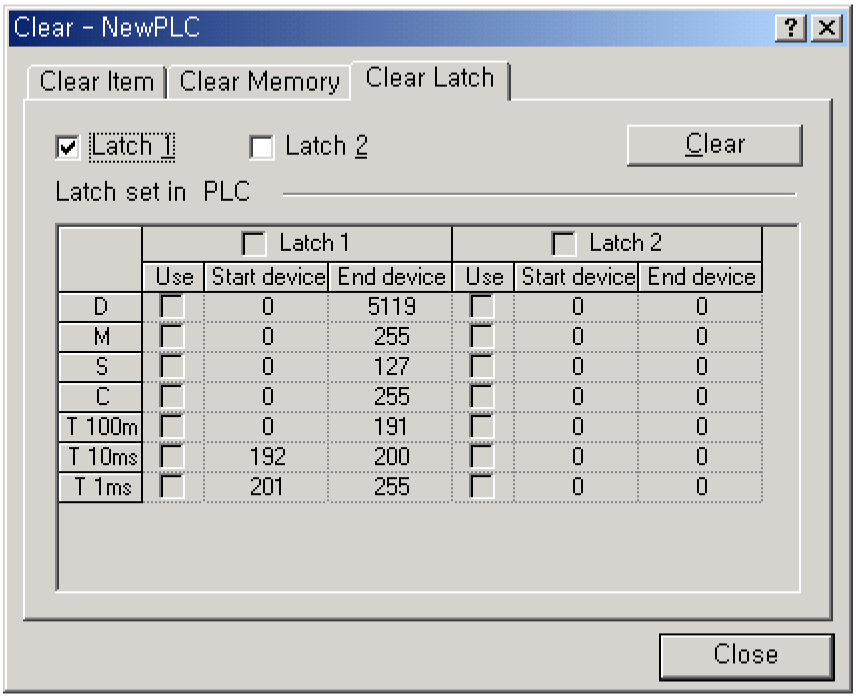
No.	Classification	Detailed operation	Latch 1	Latch 2
1	Power change	Off/On	Keep	Keep
2	Reset by XG5000	Overall reset	Reset	Keep
3	Program write (online)	-	Keep	Keep
4	Data broken	SRAM broken by battery error	Reset	Reset
		Data broken by other reason	Reset	Reset
5	XG5000 online	Clear Latch 1	Reset	Keep
		Clear Latch 2	Reset	Reset

(b) Latch 1 area is cleared by『Online』- 『Reset PLC』- “Overall reset”.





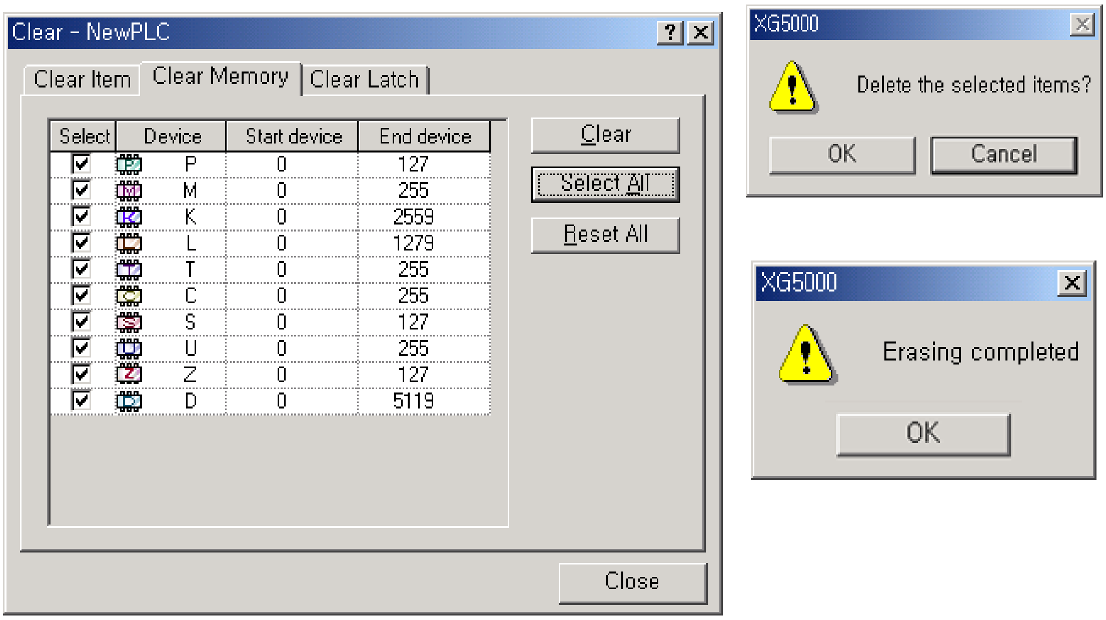
(c) Latch 1, 2 area is cleared by『Online』-『Clear PLC』.



(3) Data initialization

In case of Memory Delete state, the memory of all device shall be cleared as ‘0’. In case of giving the data value at the beginning according to system, please use the initialization task.

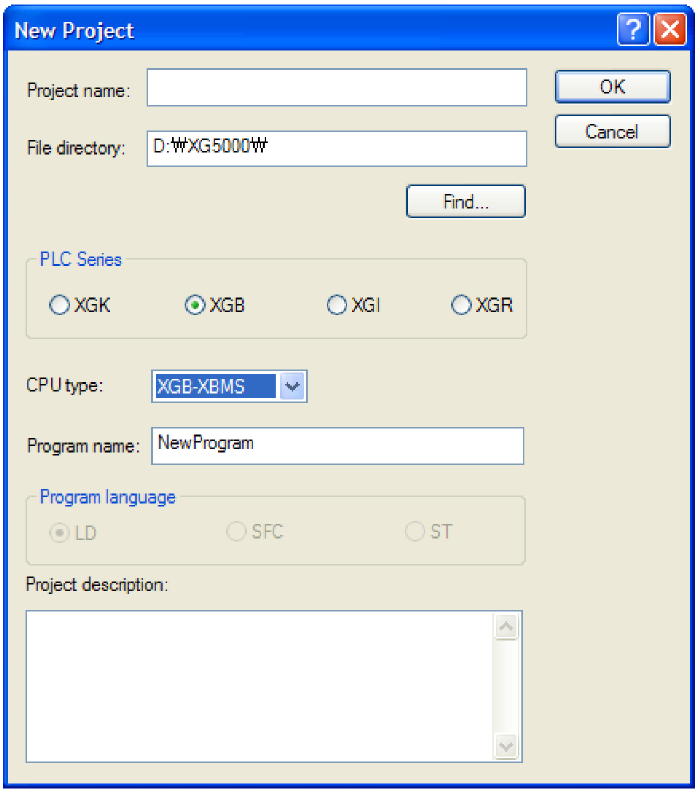
(a) Device area is cleared by click ‘Clear’ in 『Online』-『Clear PLC』-『Clear Memory』.



Chapter 6 CPU Functions

6.1 Type Setting

It describes setting of XGB PLC type.



PLC Series	CPU type	Description	Reference
XGB	XGB-DR16C3	Dedicated product	Modular type
	XGB-DR32HL	Dedicated product	Modular type
	XGB-XBCE	“E” type : XBC-DR10/14/20/30E	Compact type
	XGB-XBCH	“H” type : XBC-DR32/64H , XBC-DN32/64H	Compact type
	XGB-XBCS	“S(U)” type : XBC-DR20/30/40/60SU, XBC-DN20/30S(U), XBC-DN40/60SU	Compact type
	XGB-XBMS	“S” type : XBM-DN16/32S , XBM-DR16S	Modular type
	XGB-XECH	“H” type : XEC-DR32/64H, XEC-DN32/64H	Compact type IEC language

Remark

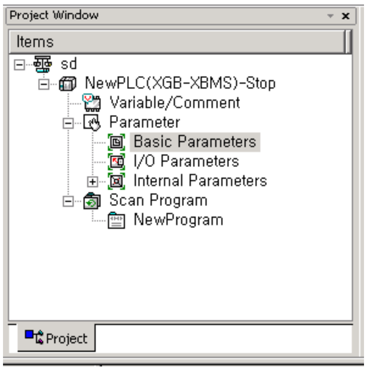
▪ In case type is different, connection is not available.

6.2 Parameter Setting

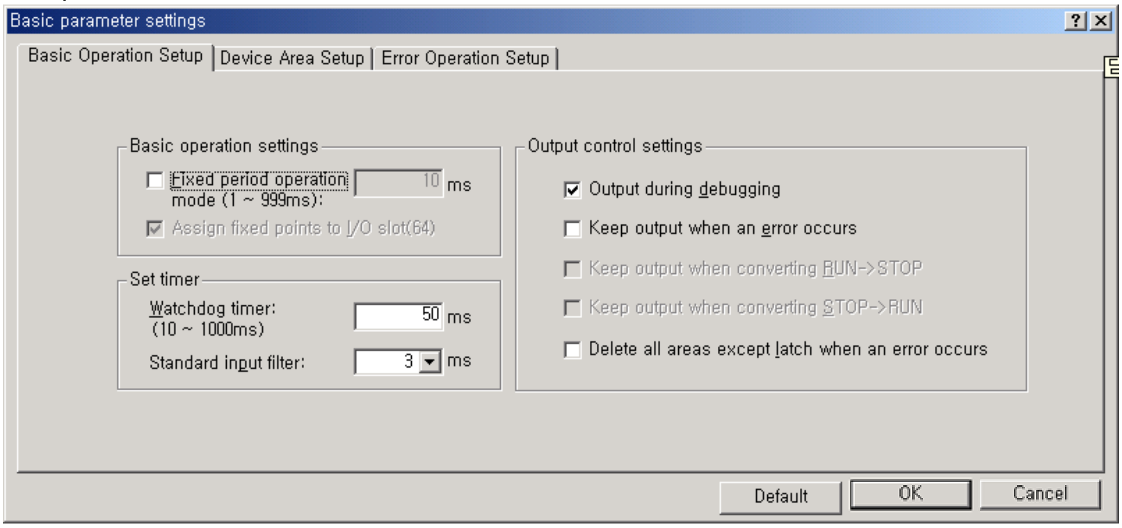
This paragraph describes how to set parameters.

6.2.1 Basic parameter setting

Clicking Basic Parameter in the project window shows the following window.



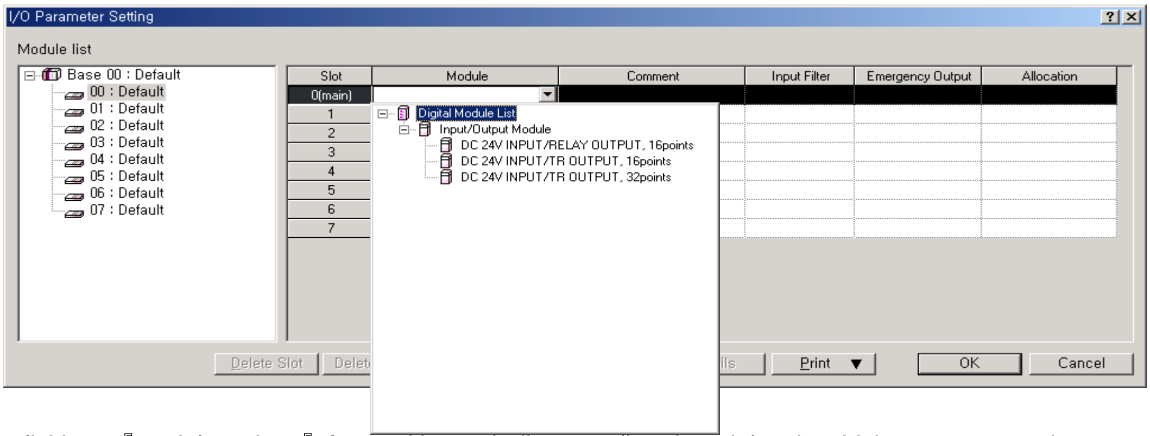
There are three main options ; “Basic Operation Setup” , “Device Area Setup” and “Error Operation Setup”.



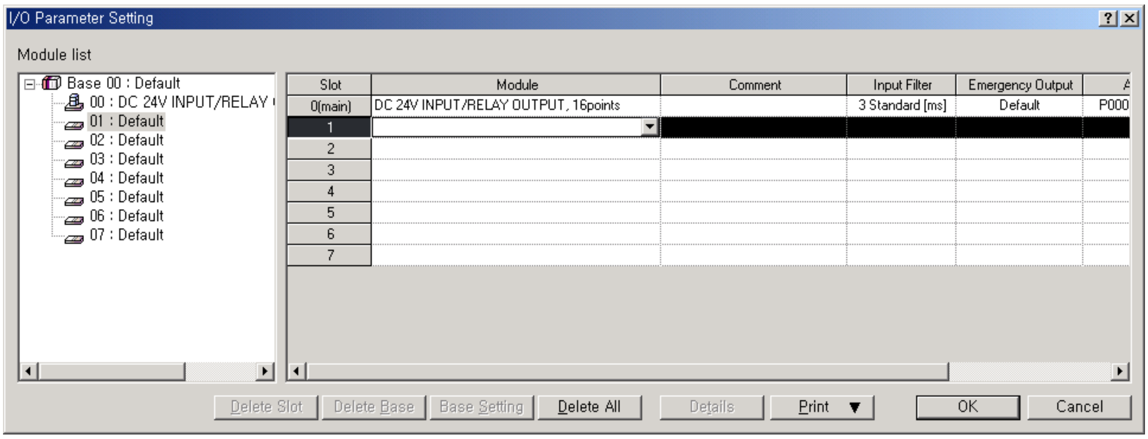
Category	Item	Description	Note
Basic operations	Fixed period operation	Set the time of fixed period operation.	1~999 ㎳
	Watchdog timer	Set the time of scan watchdog.	10~1000 ㎳
	Standard input filter	Set the time of standard input filter.	1,3,5,10,20,70,100 ㎳
	Output during debugging	Set whether to allow output actually during debugging operation.	Allowance/Prohibition
	Keep output when an error occurs	Set whether to preserve output holding function set in I/O parameter in case of error.	Allowance/Prohibition
	Delete all areas except latch when an error occurs	Set whether to clear each device that is not designated as a latch area in case of error	Allowance/Prohibition
Device area	Select latch area	Set the latch area of each device.	-
Error operation	Operation resumes in case of operation error	Set whether to pause or resume operation in case of operation error.	Pause/Resume

6.2.2 I/O parameter setting

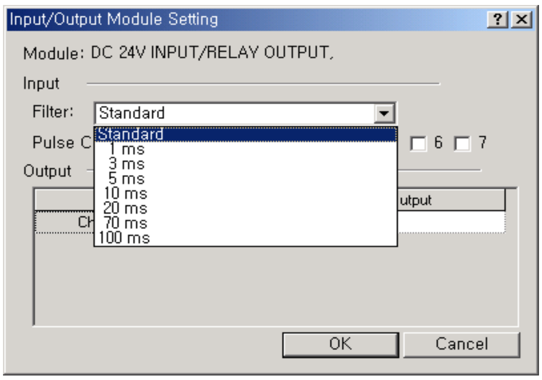
This setting is to set and reserve each I/O information. Clicking 『I/O Parameter』 in the project window shows the following setting window.

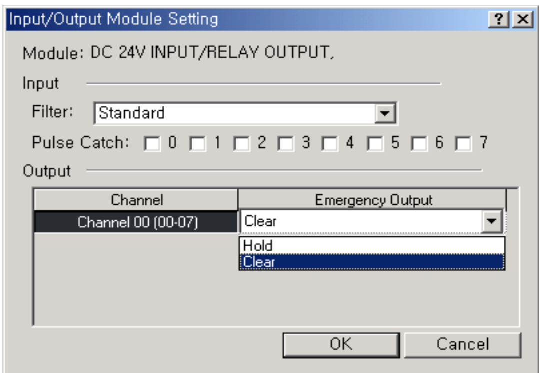


Clicking 『Module』 in 『Slot Position』 indicates a list of modules, in which you may set I/O corresponding to the actual system. Then, the following window is displayed.



Clicking 『Details』 in 『Slot Position』 shows the following window to set filter and emergency output.





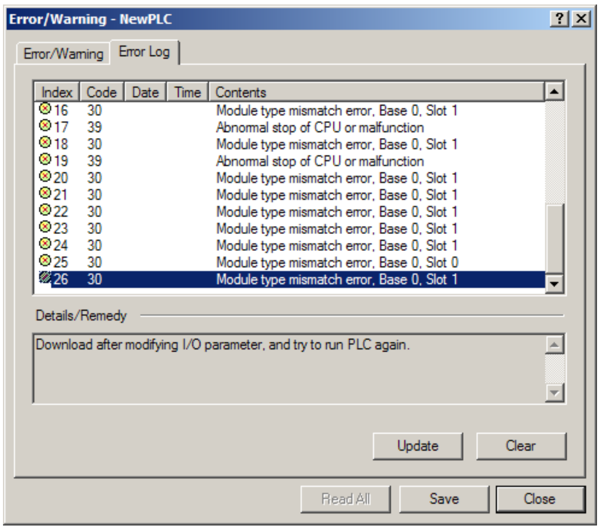
Remark

(1) If settings are different with I/O module actually accessed, “Inconsistent module type error” occurs, displaying error.
(2) Without settings, CPU reads each I/O module information and operates.

6.3 Self-diagnosis Function

6.3.1 Saving of error log

CPU module logs errors occurred so that the causes will be identified and fixed easily. Clicking 『Error/Warning』 of 『Online』 shows the current error and previous error log.



Item	Description	Remarks
Error/Warning	Display the current error/warning.	-
Error Log	Display a log of error/warning occurred.	Saving up to 100

Remark

(1) Saved data are not deleted until selecting a menu of XG5000 and clicking “Delete”.

6.3.2 Troubleshooting

(1) Trouble types

Trouble occurs due to PLC itself, system configuration error or abnormal operation result detected. Trouble is divided into trouble mode stopping operation for the safety and warning mode generating alert to user with a mode in trouble.

The causes troubling PLC system are as follows.

- PLC hardware trouble
- System configuration error
- Operation error while operating user program
- Error detected owing to external device in trouble

(2) Operation mode if trouble occurs

PLC system logs any trouble occurred in flag and determines whether to stop or resume operation depending on trouble mode.

(a) PLC hardware trouble

In case an error occurs so that PLC such as CPU module and power module may not work normally, the system is halted, but any warning may not interfere with the operation.

(b) Operation error while operating user program

Representing an error occurred during operation of user program, in case of numeric operation error, it displays the error in error flag but the system resumes operating. However, if the operation time exceeds by the operation monitoring time limit and I/O module does not control it normally, the system is halted.

(c) Error detected owing to external device in trouble

Representing the detection of external device to be controlled by users program of PLC, if an error is detected, the system is halted, but any warning may not interfere with the operation.

Remark

(1) If any trouble occurs, the trouble number is saved in a special relay F002,003.
(2) For details of flag, refer to the appendix 1 Flag List.

6.4 Remote Functions

CPU module may change operation by communication as well as by key switches mounted on the module. To operate it remotely, it is necessary to set ‘RUN/STOP’ switch to ‘STOP’.

(1) Remote operations are as follows.
  (a) Operable by accessing to XG5000 through RS-232C port mounted on CPU module.
  (b) Can operate other PLC connected to PLC network with CPU module connected to XG5000.

(2) Remote RUN/STOP
  (a) Remote RUN/STOP is the externally controlled RUN/STOP function.
  (b) It is convenient when CPU module is located at a position hard to control or when CPU module within control panel is to control RUN/STOP function remotely.

(3) Remote DEBUG
  (a) It manages debugging remotely when remote mode is STOP. Namely, DEBUG operation is to execute program operation depending on designated operation conditions.
  (b) Remote DEBUG is a convenient function when confirming program operation status or data during system debugging.

(4) Remote Reset
  (a) Remote reset is to reset CPU module remotely if an error occurs at a place hard to directly control CPU module.
  (b) Like operation by switches, it supports ‘Reset’ and ‘Overall Reset’.

Remark

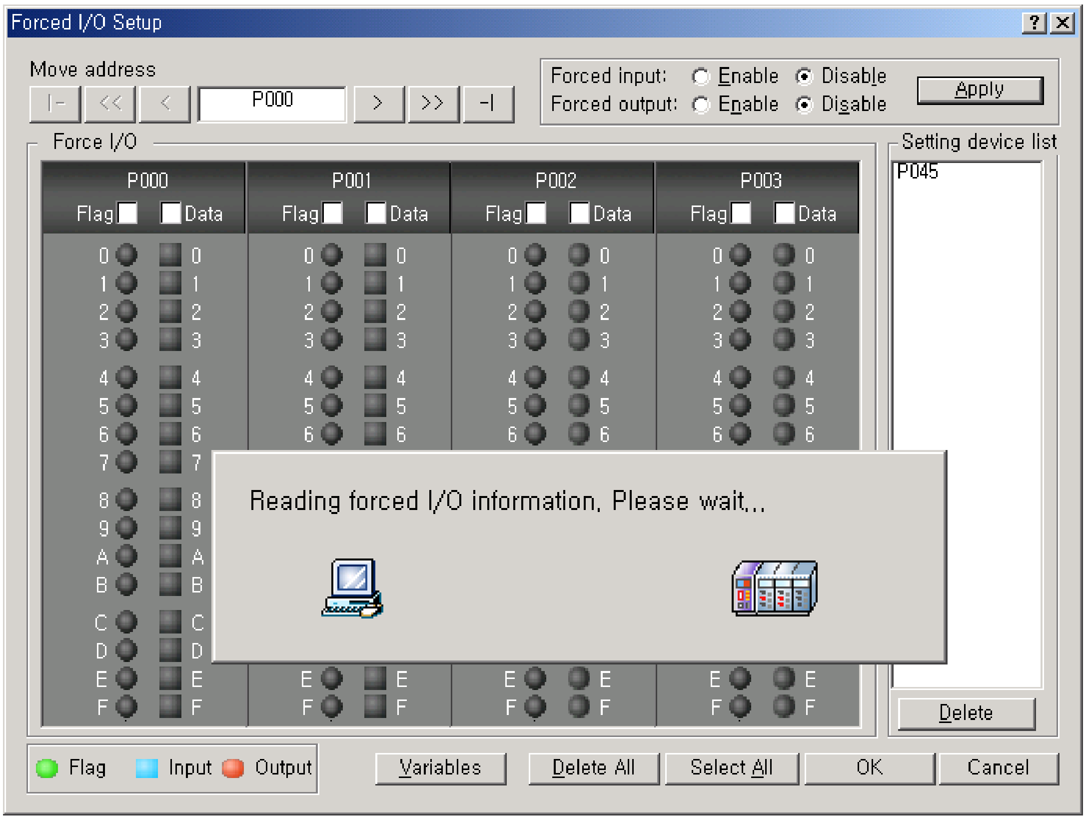
(1) For details regarding remote functions, refer to ‘Ch10 Online’ of XG5000 Users Manual.

6.5 Forced Input/Output On and Off Function

Force I/O function is used to force to turn I/O areas on or off, regardless of program results.

6.5.1 Force I/O setup

Click 『 Online 』 - 『 Force I/O 』.



Item		Description
Move address	|- -|	Move to the beginning and end of I/O area (P000↔P127)
	<< >>	Move to ±8 of I/O area displayed at the very left.
	< >	Move to ±1 of I/O area.
Application		Set whether to allow or not Force I/O
Single	Flag	Set whether to allow or not Force I/O by bits.
	Data	Set Force I/O data on or off by bits.
Select All		Set to allow Force I/O with all I/O area on
Delete All		Delete to allow Force I/O with all I/O area off.
Setting device		Display I/O area set as a bit.

6.5.2 Processing time and processing method of Force Input/Output On and Off

(1) Forced Input
Regarding input, at the time of input refresh it replaces the data of contact set as Force On/Off among data read from input module with the data as Force and updates input image area. Therefore, user program executes operations with actual input data while Force input area is operated with data set as Force.

(2) Forced Output
Regarding output, at the time of output refresh upon the execution user program operation, it replaces the data of contact set as Force On/Off among data of output image area containing operation results with data set as Force and outputs the data in output module. Unlike (Force) input, the output image area is not changed by Force On/Off setting.

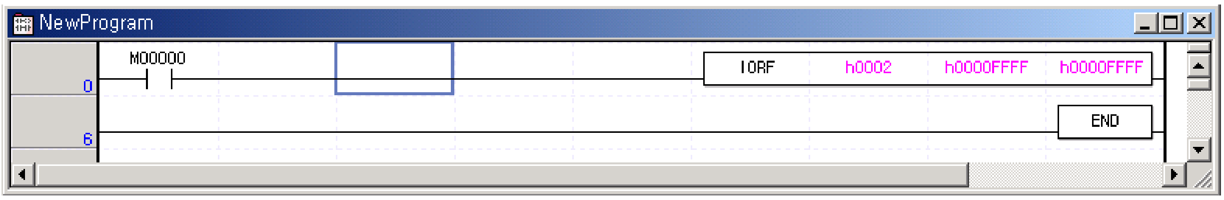
(3) Cautions when using Force I/O function
(a) It operates from the time when I/O is individually set as 'Allow' after setting Force data.
(b) It is possible to set Force input although I/O module is not actually mounted.
(c) Despite of the power changed Off -> On, operation mode changes or any operation by pressing reset key, the data of which On/Off is set before is kept in CPU module.
(d) Even in STOP mode, Force I/O data is not removed.
(e) To set new data from the beginning, it is necessary to deselect all settings of I/O by using 'Delete All' option.

(4) Operation in case of error
(a) If error occurs after setting forced output, PLC operates based on "Keep output when an error occurs" in Basic parameter and "Emergency output" in I/O parameter.
If you set "Emergency output" as "Clear" after setting "Keep output when an error occurs", output is cleared when an error occurs. If you set "Emergency output" as "Hold" after setting "Keep output when an error occurs", output is held when an error occurs.
(b) If you don't set "Keep output when an error occurs", output is off when an error occurs.

6.6 Direct Input/Output Operation

Refreshing I/O operates after completion of scan program. If data of I/O is changed while program is scanned, it does not refreshed at the changed moment. Refreshed I/O data is applied after 'END' instruction on program.

This function may be useful when directly reading the status of input contact during program operation by refreshing I/O by means of 'IORF' instruction or outputting operation results to output contact.



'IORF' command is operated when M00000 is ON. First operand designates slot number. Second operand designates the upper 32 bit data as mask data. Third operand designates the lower 32 bit data as mask data. The bit to refresh set as 1 (hFF) and others set as 0 (h00) (not refreshed).

Remark

- When using IORF instruction to read/write data at expansion module, scan time increases by 2ms. So when executing interrupt task program by external input less than 10ms or cycle time task less than 10ms, task collision may occurs.
-For details regarding IORF instruction, refer to XGK/XGB Instructions List.

6.7 Diagnosis of External Device

This flag is provided for a user to diagnose any fault of external device and, in turn, execute halt or warning of the system. Use of this flag displays faults of external device without any complicated program prepared and monitors fault location without any specific device (XG5000 and etc) or source program.

(1) Detection and classification of faults in external device

(a) The trouble (fault) of external device may be detected by user program and largely divided, depending on the type, into error and warning; the former requires halt of PLC operation and the latter simply displays the status while PLC keeps working.

(b) 'Error' uses 'F202 (_ANC_ERR)' and 'Warning' uses 'F203 (_ANC_WB) flag'.

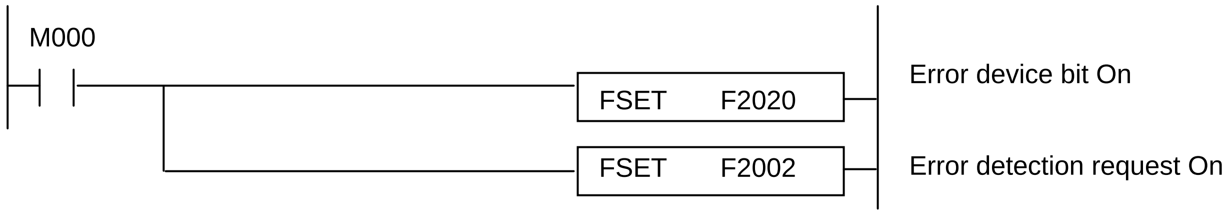
(c) As the detection request flag, 'Error' uses 'F2002 (_CHK_ANC_ERR) flag' while 'Warning' uses 'F2003 (_CHK_ANC_WB) flag'.

(2) Troubleshooting external device

(a) When detecting any trouble of external device in user program, it writes a value except '0' by classifying the type, which is defined by a user in 'F202 (_ANC_ERR)' while the detection request flag checks it at the time when the program ends with 'F2002 (_CHK_ANC_ERR) On, and PLC outputs based on the "Emergency Output" setting in I/O parameter, making it as the same error status as detected by PLC itself.

(b) If any trouble occurs, a user may identify the cause by using XG5000 and alternatively by monitoring 'F202 (_ANC_ERR) flag'.

❑ Example



(c) If any trouble occurs, CPU is in error status and operation halts. At this moment, F2020 and F2002 flags are off (error LED switches on and off every second.)

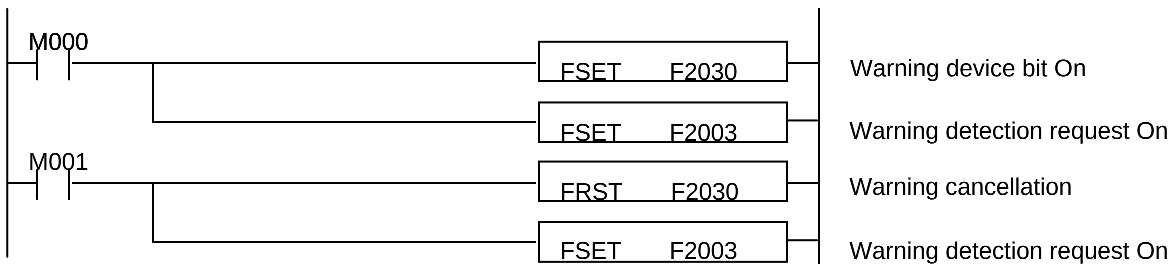
(3) Processing warning of external device

(a) When detecting any warning of external device in user program, it turns on a flag in the warning position of system flag 'F203 (_ANC_WB) and if turning on the detection request flag, 'F2003 (_CHK_ANC_WB)' , it displays warning at the time when scan program ends. If a warning occurs, the detection request flag, 'F2003 (_CHK_ANC_WB)' is automatically off (F203 is not deleted).

(b) If a warning occurs, the LED switches on and off every other second.

(c) If turning off a bit in question of F203 and turning on F2003 bit after processing warning, warning is cancelled and the LED turns off.

❑ Example

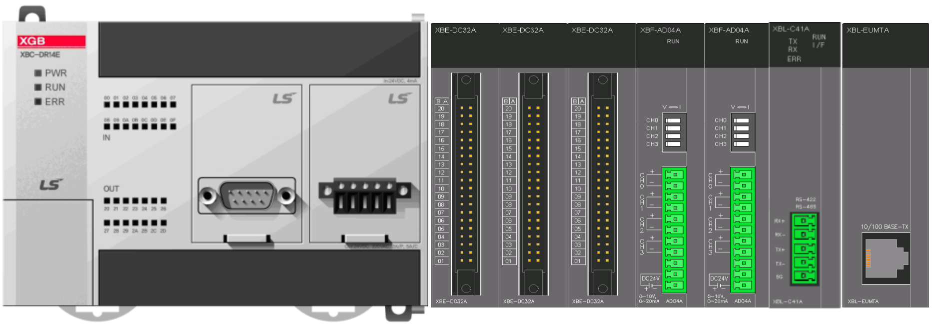


6.8 Allocation of Input/Output Number

Allocation of I/O number is to allocate an address to every I/O of each module to read data from input module and output data to output module when it executes operations.
XGB series adopts 64 points occupation to every module.

(1) Allocation of I/O number
124 points are allocated to main unit and 64 points are allocated to every module except main unit (incl. special, communication).

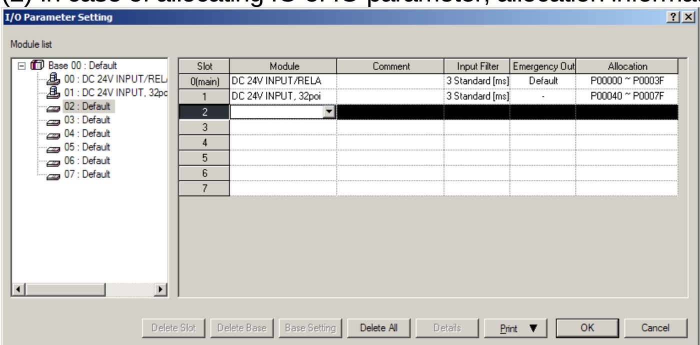
System Configuration



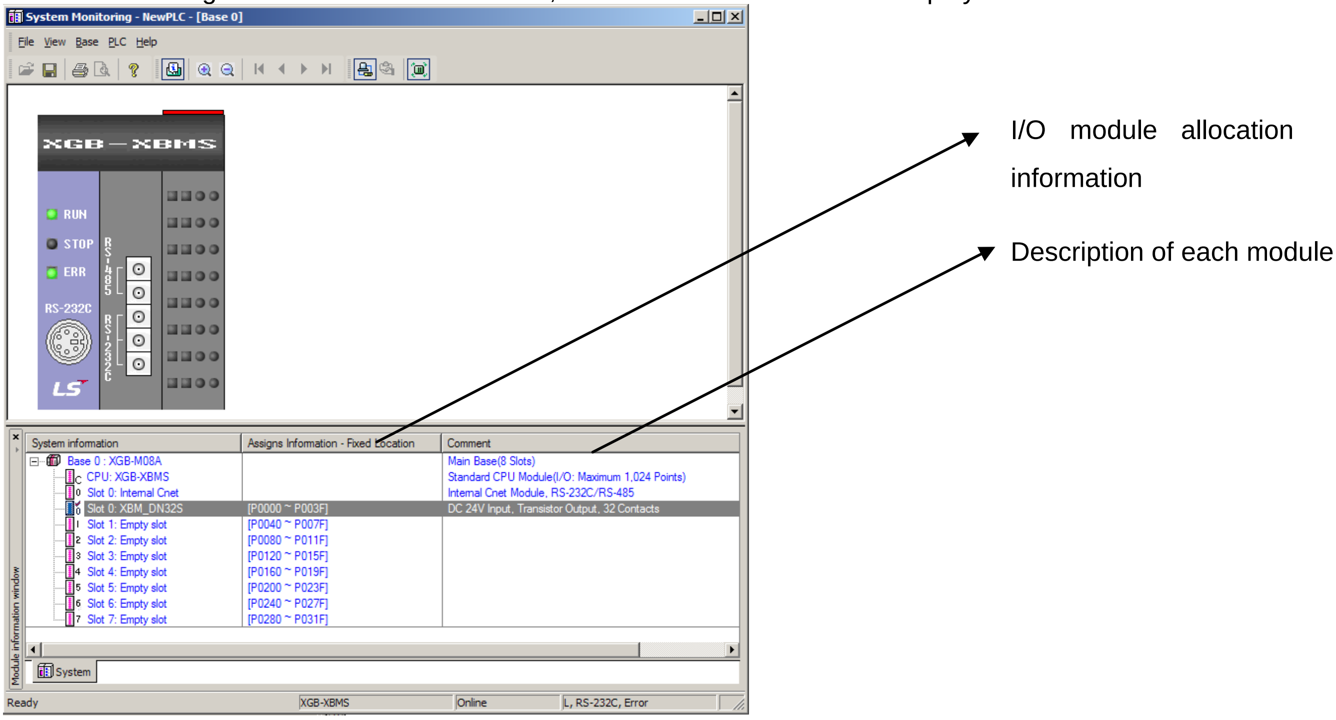
Number of Connection stage	Type	I/O allocation	Remarks
0	XBC-DN30S(U)	Input : P0000 ~ P003F Output : P0040 ~ P007F	Main unit fixed
1	XBE-DC32A	Input : P0080~P011F	Actual input: P0080 ~ P009F
2	XBE-TN32A	Output : P0120 ~ P015F	Actual output : P0120 ~ P013F
3	XBL-C21A	P0160 ~ P019F	-
4	XBF-AD04A	P0200 ~ P023F	-
5	XBF-DV04A	P0240 ~ P027F	-
6	XBE-DC32A	Input : P0280 ~ P031F	Actual input : P0280 ~ P029F
7	XBE-TN32A	Output : P0320 ~ P035F	Actual output : P0320 ~ P033F

Empty I/O point is available for internal relay.

(2) In case of allocating IO of IO parameter, allocation information is displayed.



In case of using monitor function of XG5000, I/O allocation information is displayed.



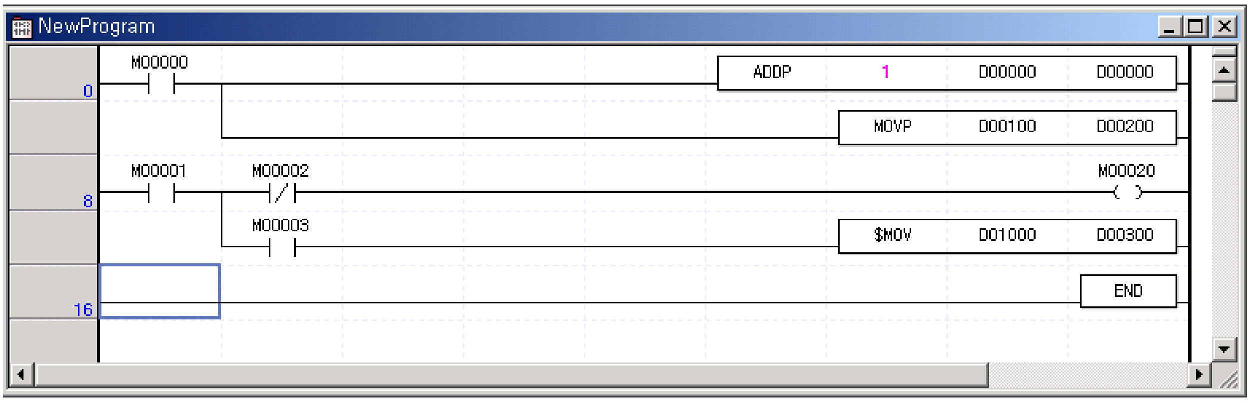
6.9 Online Editing

It is possible to modify program and communication parameter during operation of PLC without control operation stopped. The following describes basic modification. For details of modifying program, refer to XG5000 Users Manual.

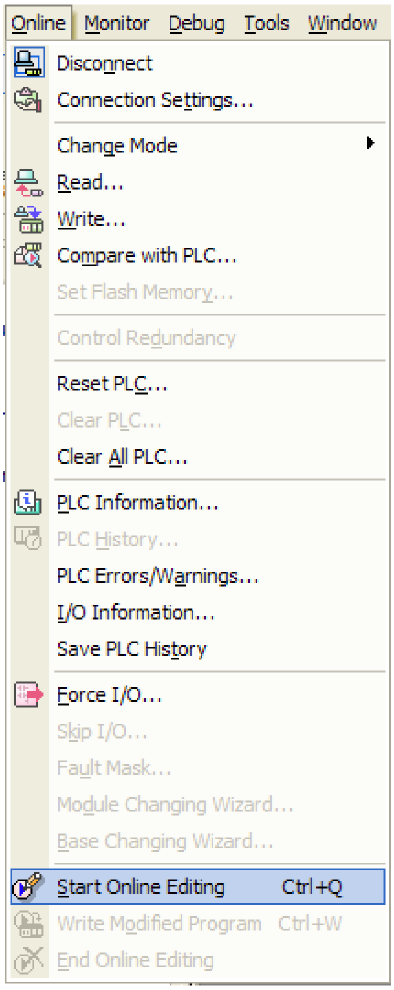
Items to be modified during operation are as follows.

- Program
- Communication parameter

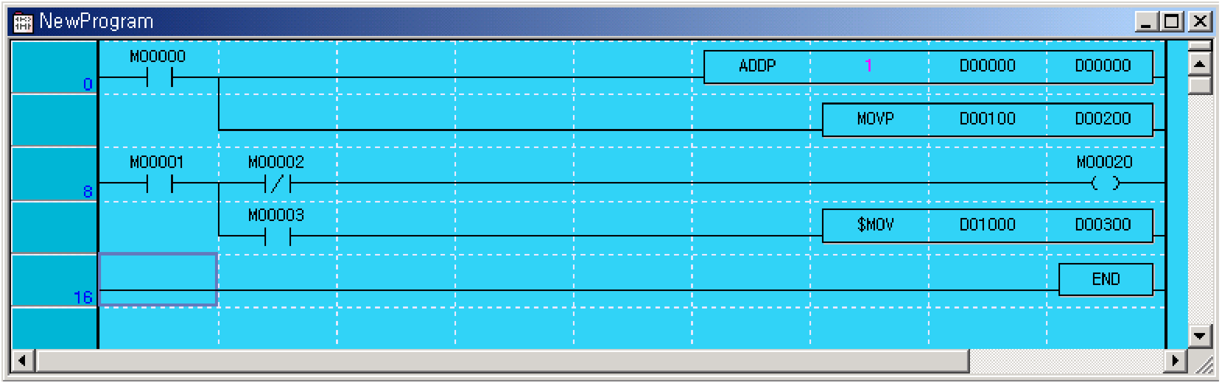
(1) It displays programs that are currently running.



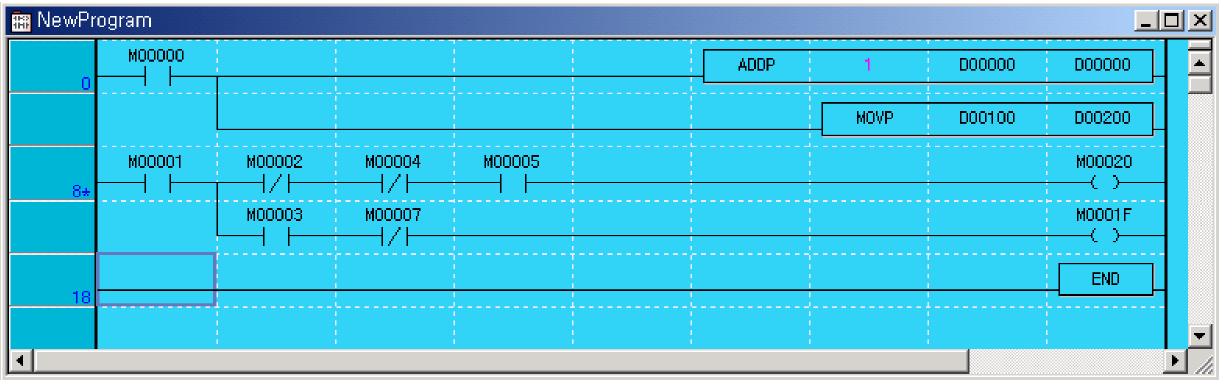
(2) Click 『Online』 - 『Start Online Editing』.



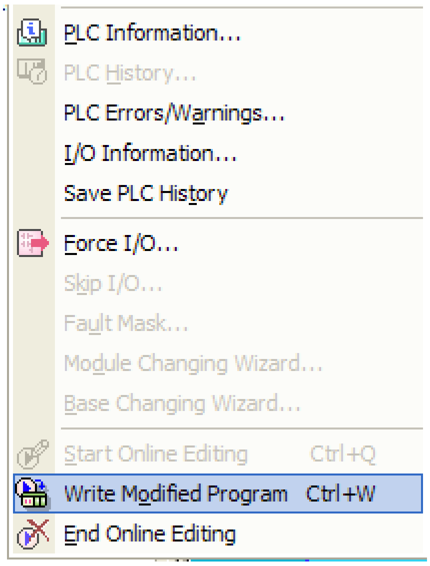
(3) It turns to program modification mode during run when the program background is changed.

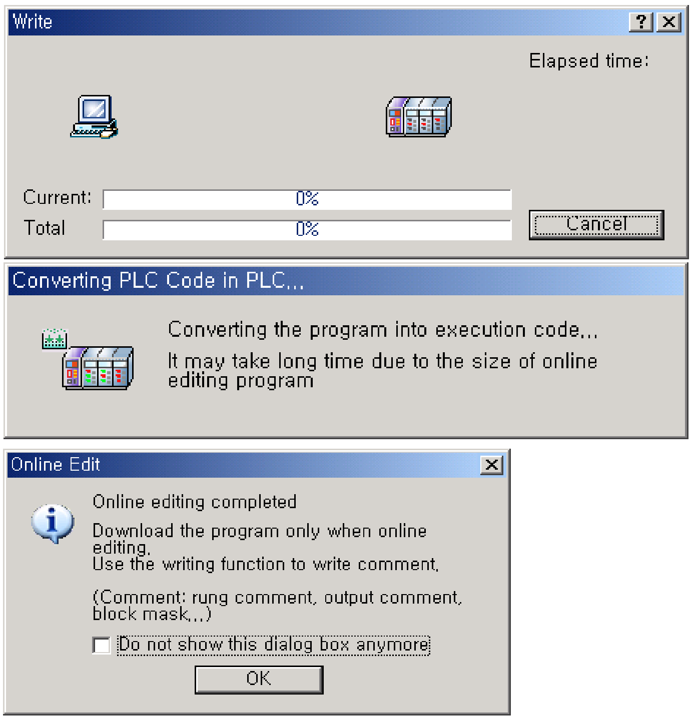


(4) Modifying a program.

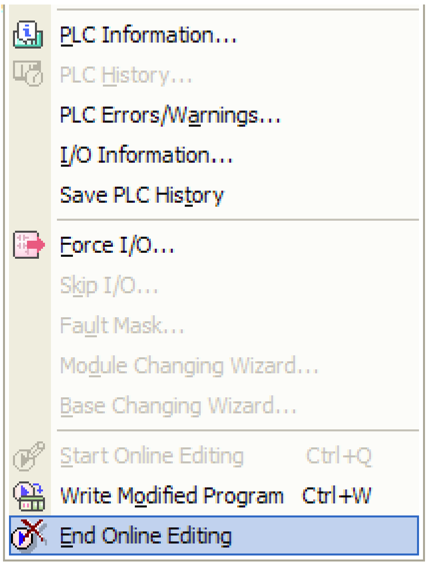


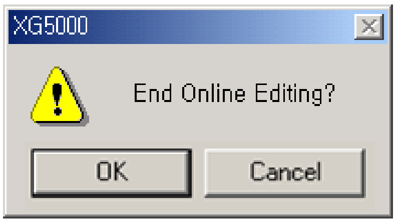
(5) Upon the modification of program, click 『Online』 - 『Write Modified Program』.



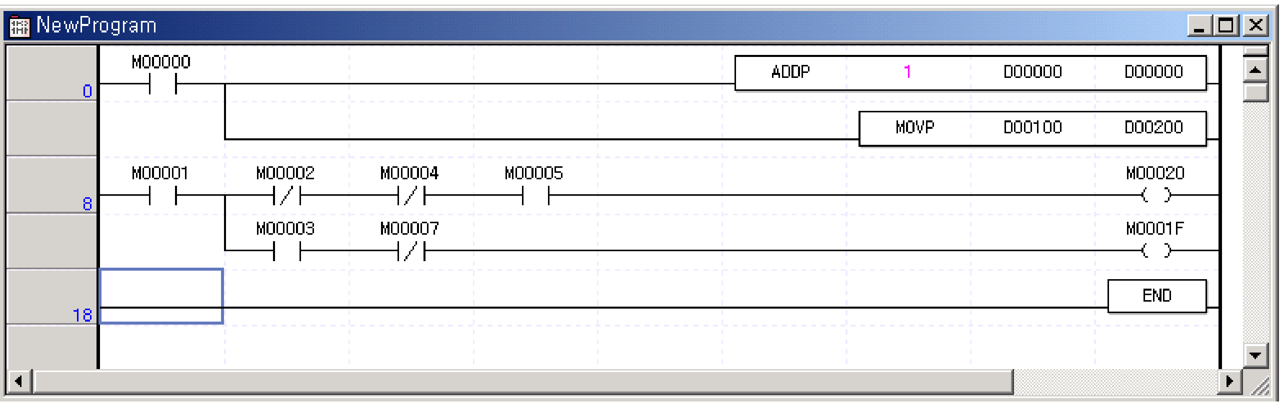


(6) Upon the writing of program, click 『Online』 - 『End Online Editing』.





(7) The program background returns and the program modification during run is completed.



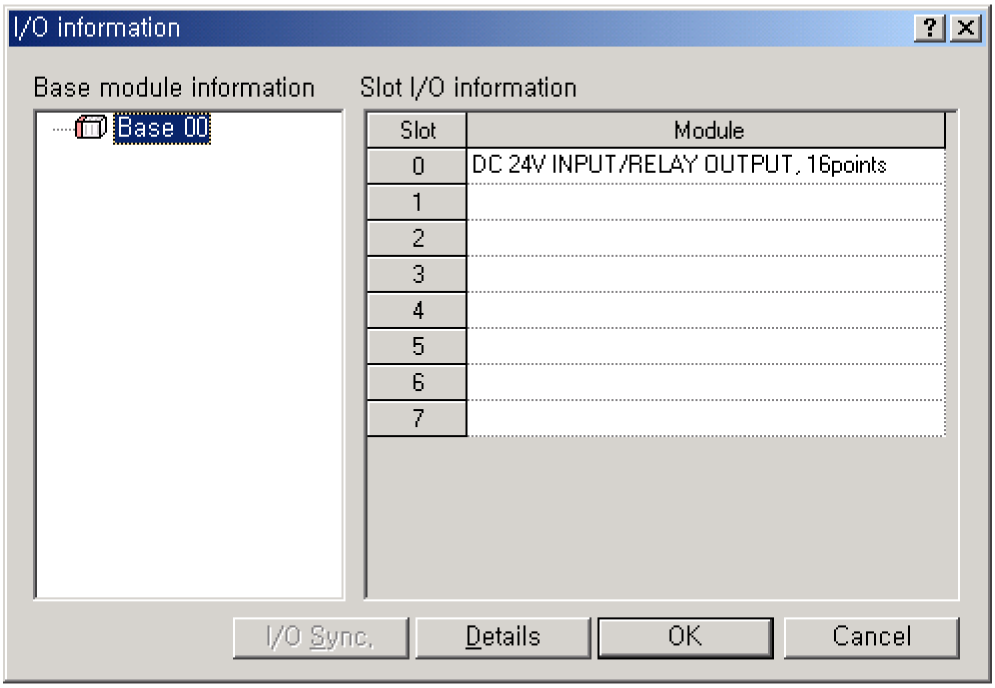
Remark

- For parameter modification during run, change each parameter on XG-PD and click 『Online』 - 『Write Modified Program 』.

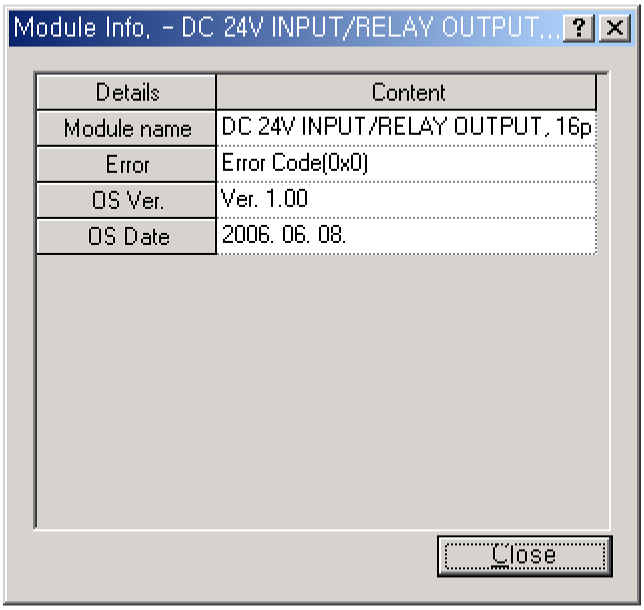
6.10 Reading Input/Output Information

It monitors information of individual modules consisted of XGB series system.

(1) Click『Online』-『I/O Info』. Then, information of each module connected to the system is monitored.



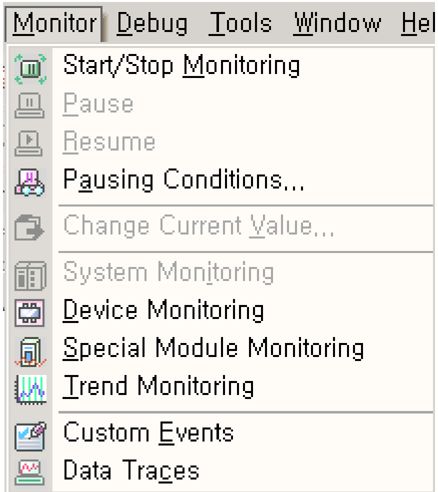
(2) If clicking Details after selecting a module, it displays detail information of a selected module.



6.11 Monitoring

It monitors system information of XGB series system.

(1) Clicking『Monitor』 displays the following sub-menus.

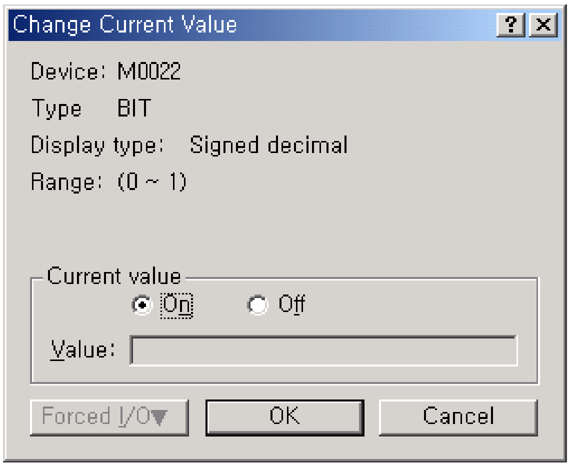


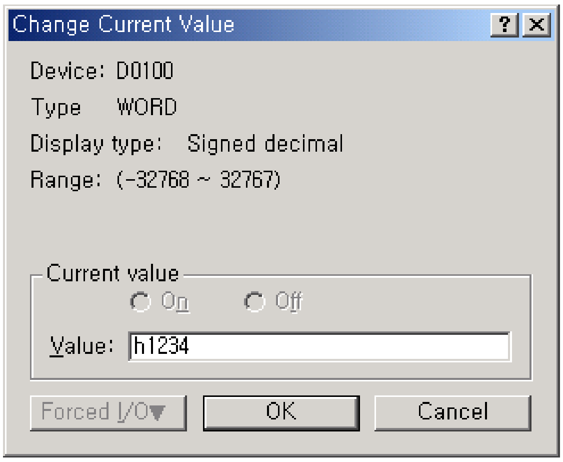
(2) Items and descriptions

Item	Description	Remarks
Start/Stop Monitoring	Designate the start and stop of monitor.	Click for reverse turn.
Pause	Pause monitoring.	-
Resume	Resume paused monitor.	-
Pausing Conditions	Pause monitoring if a preset value of device corresponds to condition.	Monitor resumes; clicking for resume.
Change Current Value	Change the present value of currently selected device.	-
System Monitoring	Monitor general system information.	-
Device Monitoring	Monitor by device (type).	-
Trend Monitoring	Monitor trend of device set in the system.	For details, refer to XG5000 Users Manual.
Custom Events	Monitor the value of device set when an event set by a user occurs.	
Data Traces	Trace the value of device.	

(a) Change current value

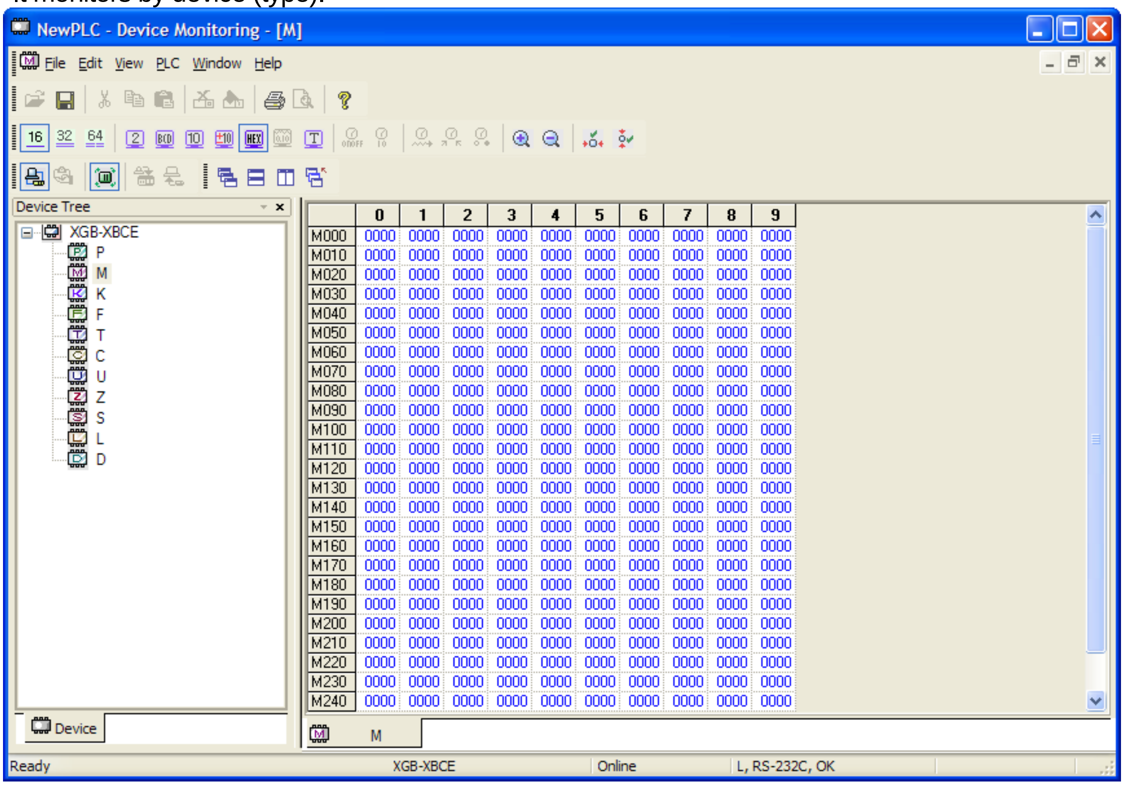
▪It changes the current value of each device selected in the current program window.





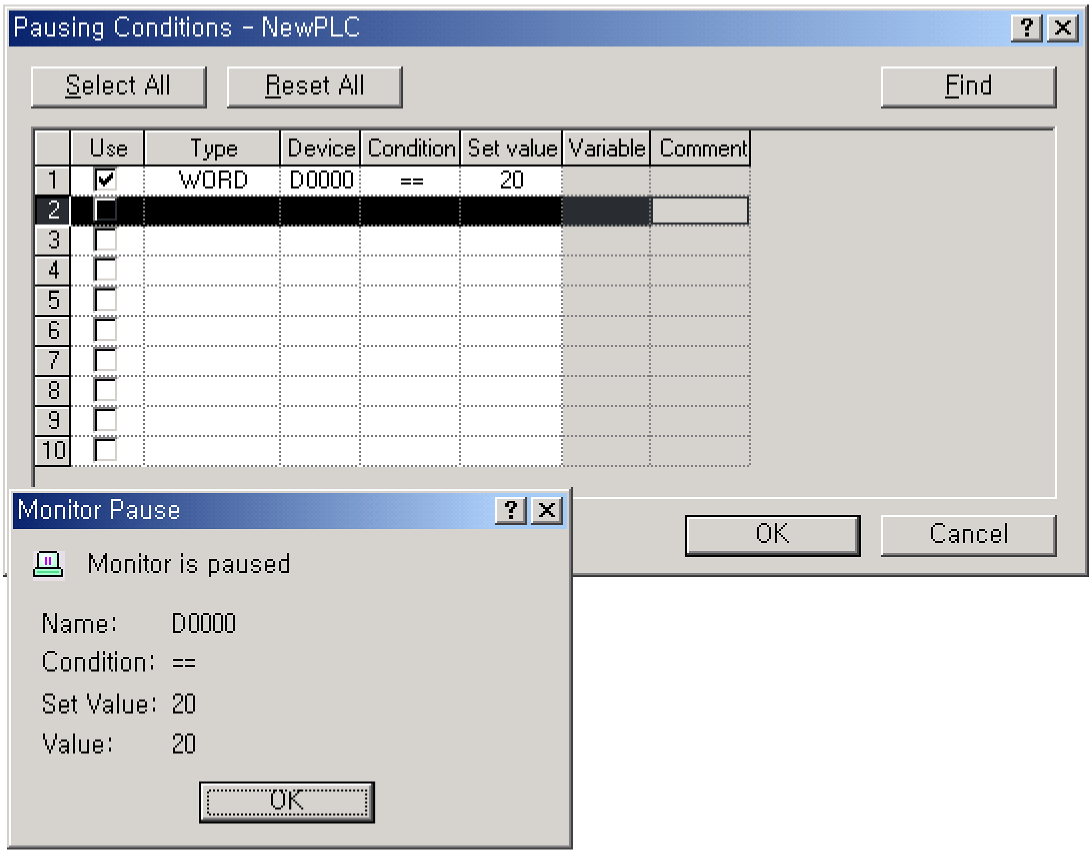
(b) Device monitoring

▪It monitors by device (type).



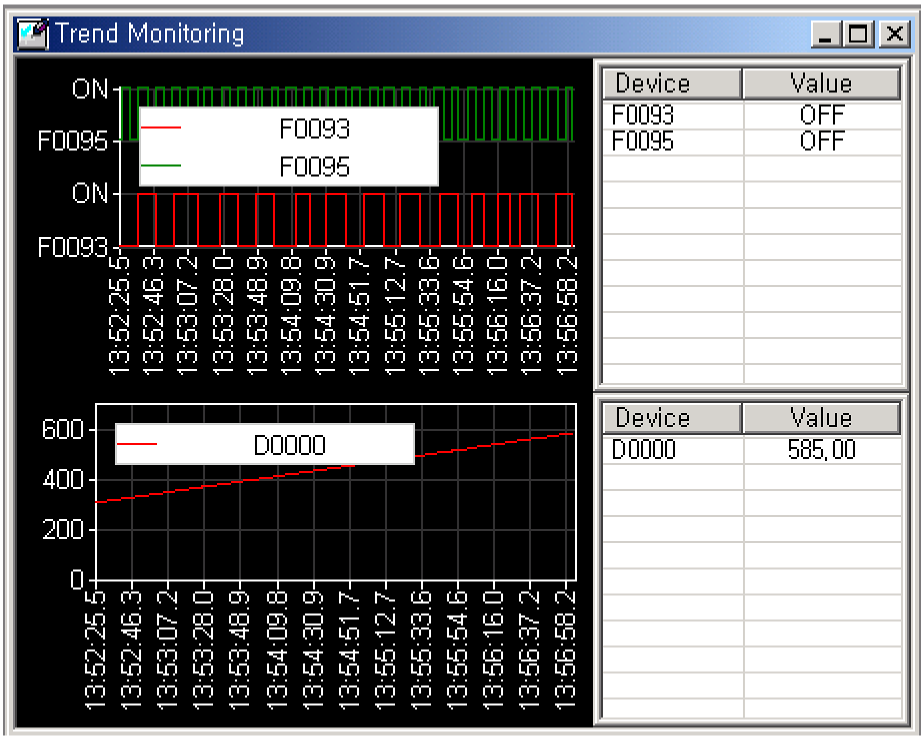
(c) Pausing conditions

▪It stops monitoring in case a device value set in the program corresponds.



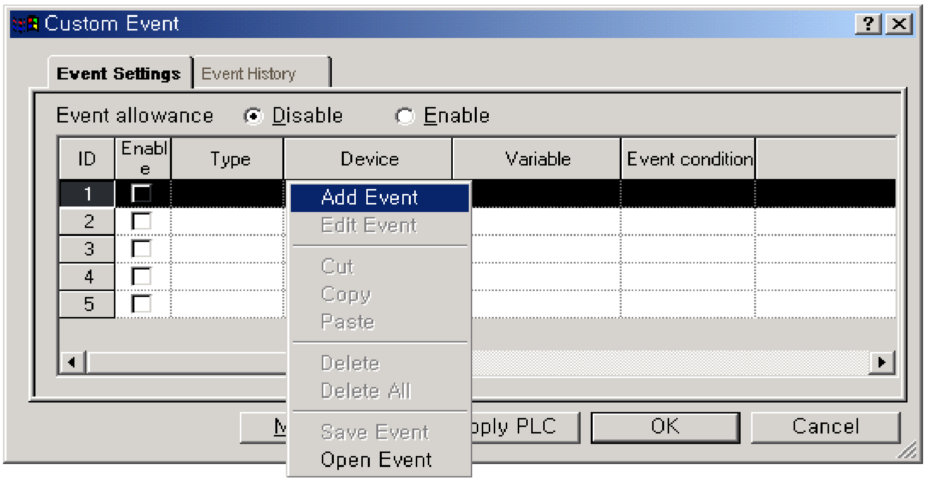
(d) Trend monitoring

▪It displays device values graphically.

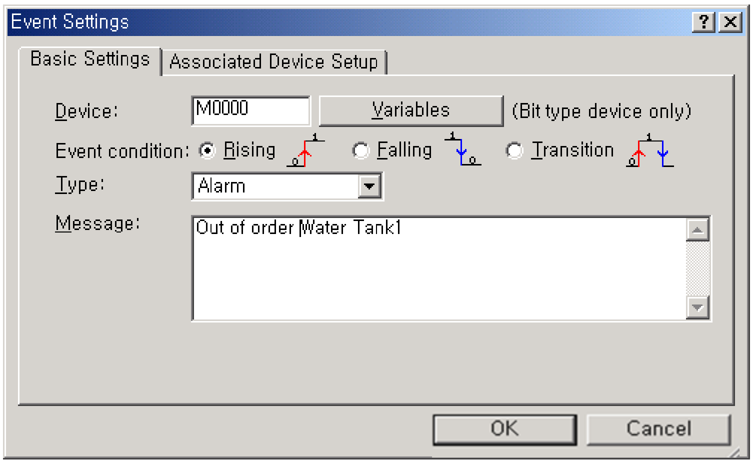


(e) Custom events

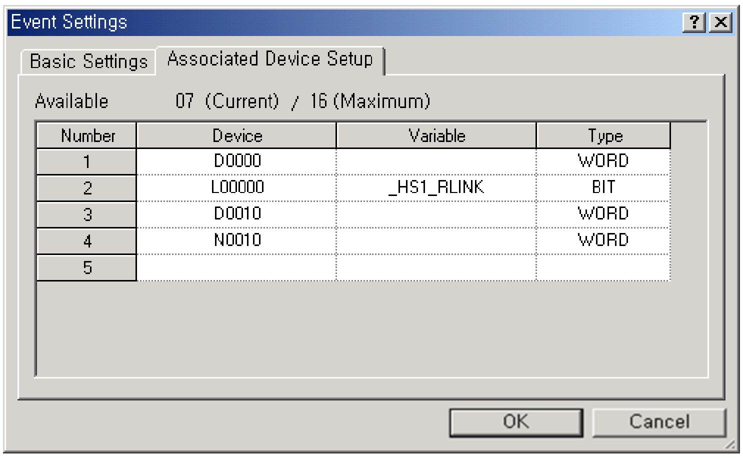
1) It monitors detail information when an event set by a user occurs. Additional user event may be registered.



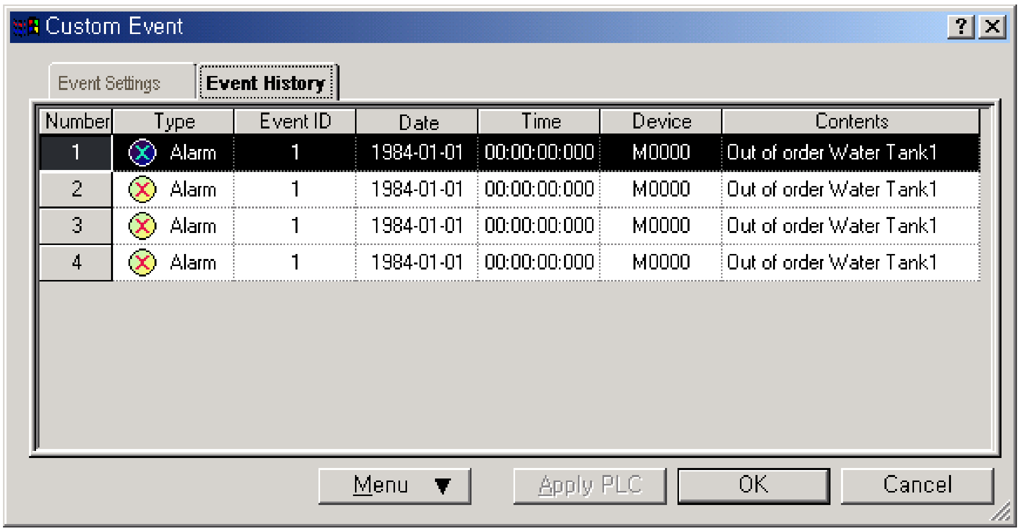
2) It sets basic setting and relative device.
If rising edge of M0000 device occurs, it records the message of an alarm, “Out of order Water Tank 1” and the device values of D0000,L0000,D0100,N1000 are recorded.



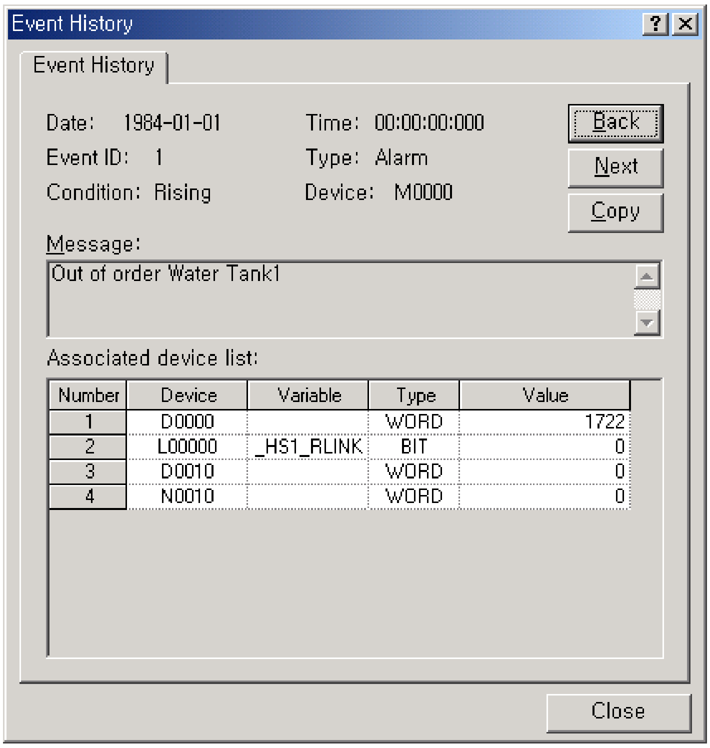
3) Set the relative device(s).



4) Monitor event history of custom event.



5) Double-clicking a number produced monitors the relative values of device and the detail message as follows.



Remark

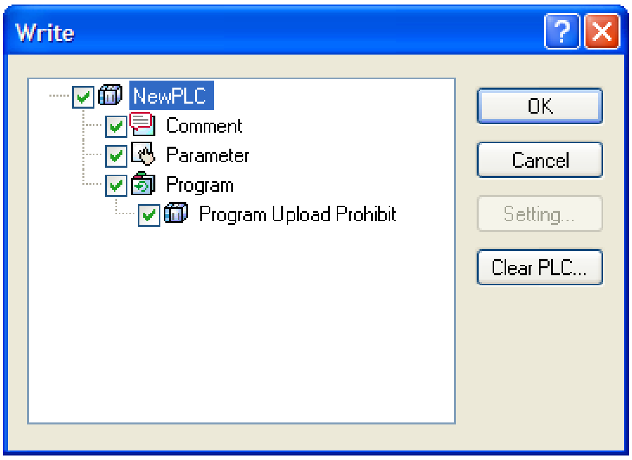
▪For details of monitor, refer to XG5000 Users Manual.

6.12 Program Upload Prohibit

Program Upload Prohibit function prohibits from uploading comment, parameter, program saved on PLC. If Program Upload Prohibit function is set, you can't open from PLC, read PLC and compare PLC.

(1) How to set

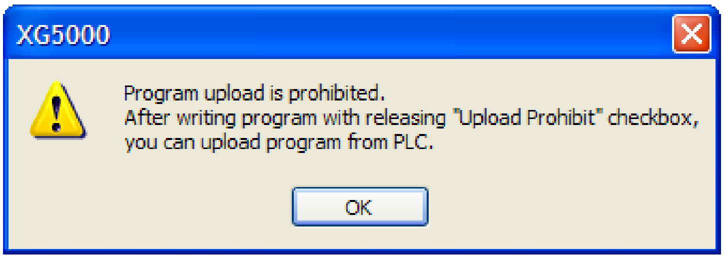
(a) Click 『Online』 - 『Write』



(b) Select "Program" to activate "Program Upload Prohibit"

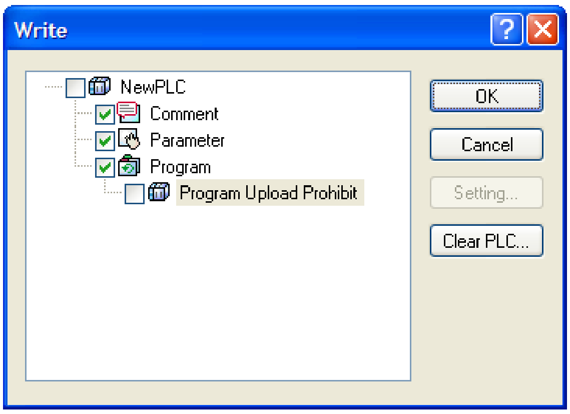
(c) Select "Program Upload Prohibit" and click OK.

(2) When reading PLC is prohibited, if you try to read PLC, the following dialog box appears. After releasing Program Upload Prohibit, execute reading.



(3) How to release Program Upload Prohibit

(a) Click 『Online』 - 『Write』.



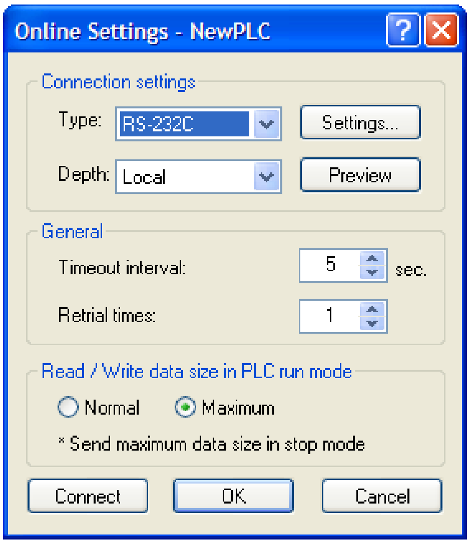
(b) Release Program Upload Prohibit and click OK.

6.13 Clear All PLC

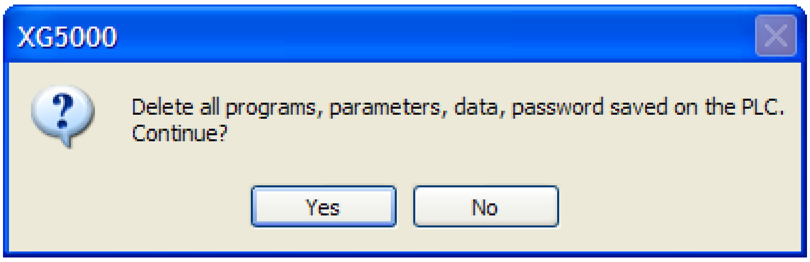
Clear All PLC function clears parameter, program, data, password saved on PLC

(1) How to clear all PLC

(a) Click 『Online』 - 『Clear All PLC』.



(b) After selection connection method, click 『Connect』 or 『OK』.



(c) If you select 『Yes』 on the dialog box, PLC program, parameter, data, password will be deleted.

Note

- Clear All PLC function can be executed though not connected.
- If you use Clear All PLC function, password will be deleted. So be careful.
- In case you lose password, use this function to clear password.

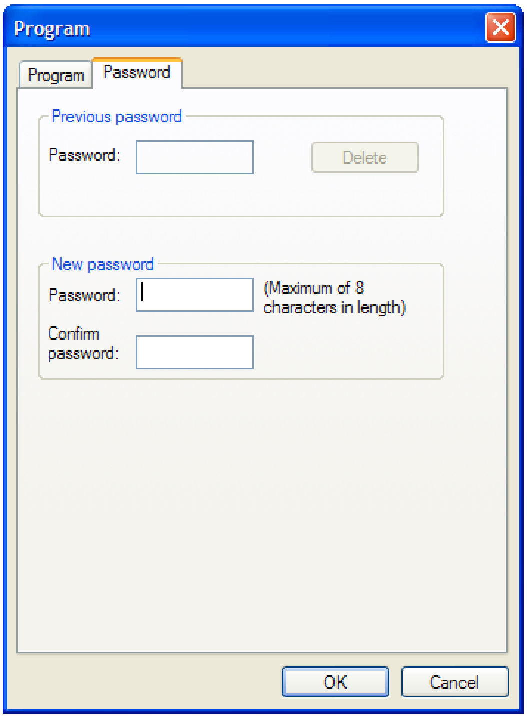
6.14 Password Setting per Program Block

Password Setting per Program Block function sets password for each program block. You should input password to open program.

(1) How to set program block password

(a) Click 『Properties』 after selecting program in project window.

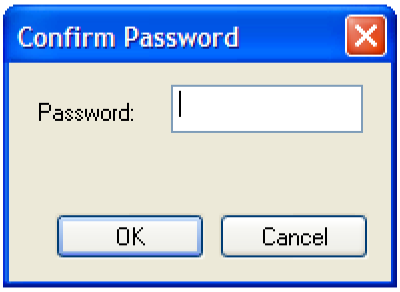
(b) Click password tap.



(c) Click 『OK』 after inputting new password.

(2) Opening password-set program

(a) When you open password-set program, the following window appears.

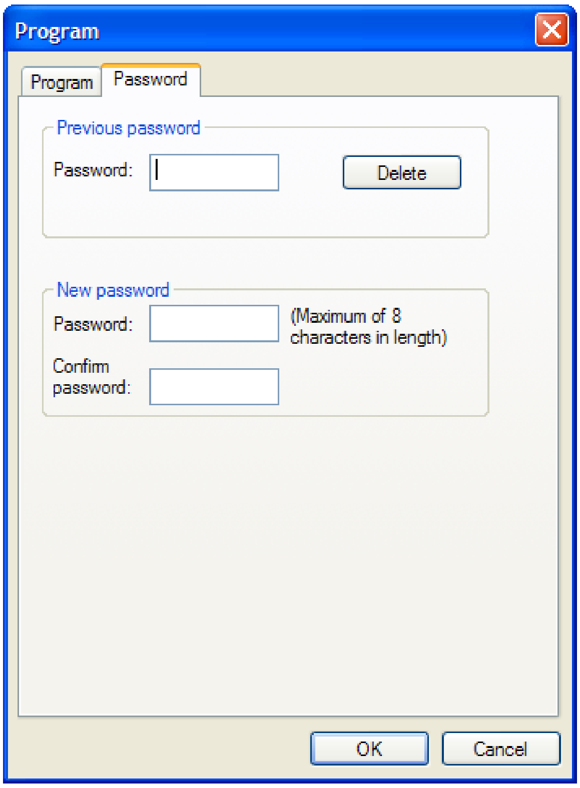


(b) After inputting correct password, click 『OK』 to open program.

(3) How to delete program block password

(a) After program in project window, click 『Properties』.

(b) Click password tap.



(c) After inputting previous password, click 『Delete』.
(d) Click 『OK』.

Chapter 7 Input/Output Specifications

7.1 Introduction

Here describes the notices when selecting digital I/O module used for XGB series.

(1) For the type of digital input, there are two types such as current sink input and current source input.

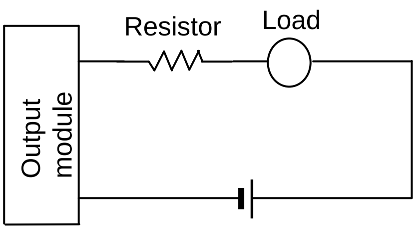
(2) The number of max. Simultaneous input contact point is different according to module type. It depends on the input voltage, ambient temperature. Use input module after checking the specification.

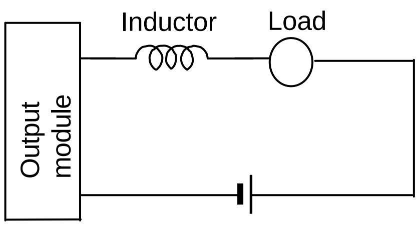
(3) When response to high speed input is necessary, use interrupt input contact point. Up to 8 interrupt points are supported.

(4) In case that open/close frequency is high or it is used for conductive load open/close, use Transistor output module or triac output module as the durability of Relay Output Module shall be reduced.

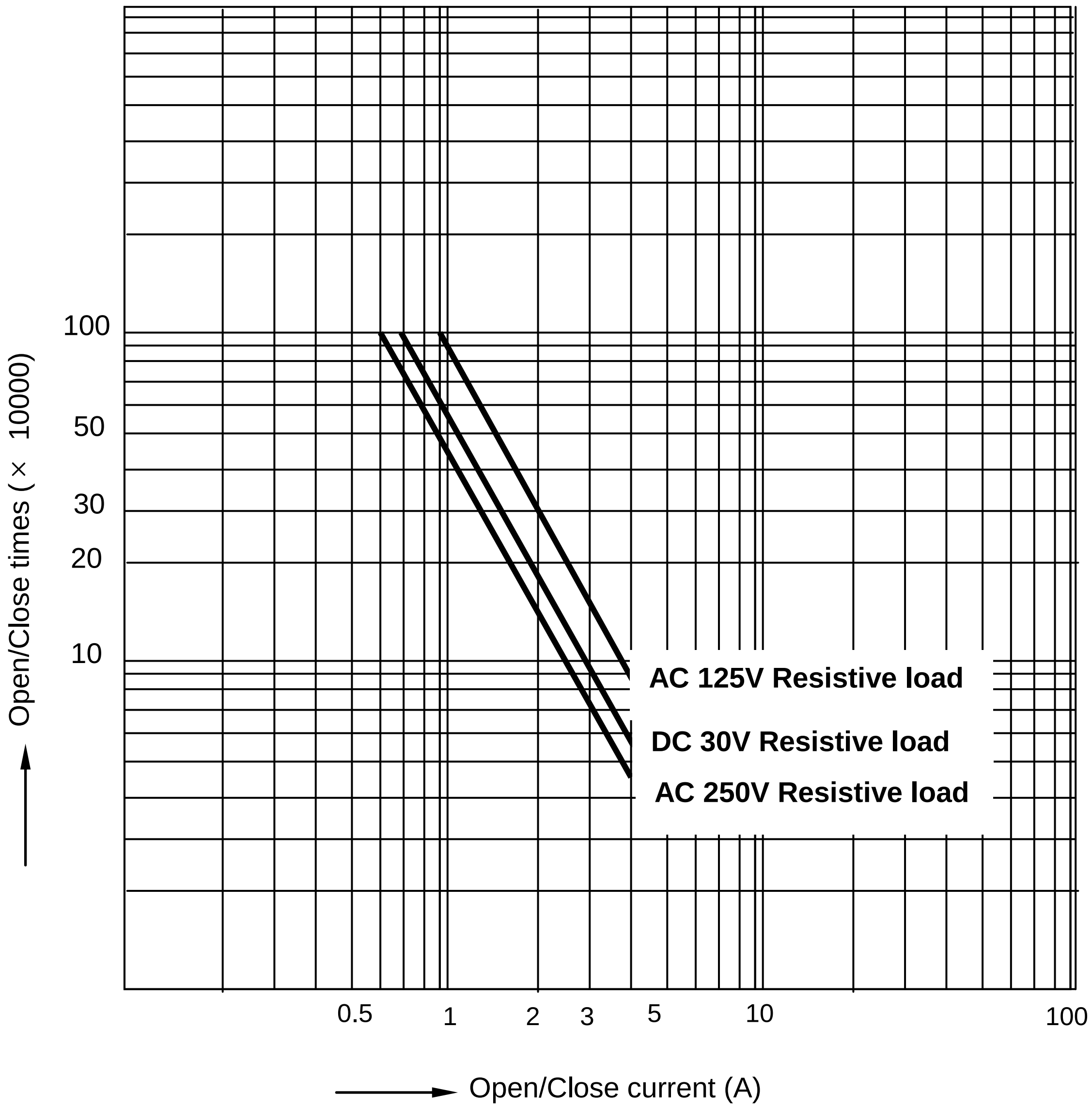
(5) For output module to run the conductive (L) load, max. open/close frequency should be used by 1second On, 1 second Off.

(6) For output module, in case that counter timer using DC/DC Converter as a load was used, Inrush current may flow in a certain cycle when it is ON or during operation. In this case, if average current is selected, it may cause the failure. Accordingly, if the previous load was used, it is recommended to connect resistor or inductor to the load in serial in order to reduce the impact of Inrush current or use the large module having a max. load current value.



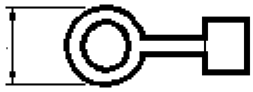


(7) Relay life of Relay output module is shown as below.
Max. life of Relay used in Relay output module is shown as below.

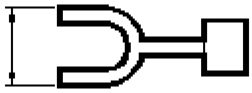


(8) A clamped terminal with sleeve can not be used for the XGB terminal strip. The clamped terminals suitable for terminal strip are as follows (JOR 1.25-3:Daedong Electricity in Korea).

6.0mm or less



6.0mm or less



(9) The cable size connected to a terminal strip should be 0.3~0.75㎟ stranded cable and 2.8㎜ thick. The cable may have different current allowance depending on the insulation thickness.

(10) The coupling torque available for fixation screw and terminal strip screw should follow the table below.

Coupling position	Coupling torque range
IO module terminal strip screw (M3 screw)	42 ~ 58 N·㎝
IO module terminal strip fixation screw (M3 screw)	66 ~ 89 N·㎝

(11) Relay life graph is not written based on real use. (This is not a guaranteed value). So consider margin. Relay life is specified under following condition.

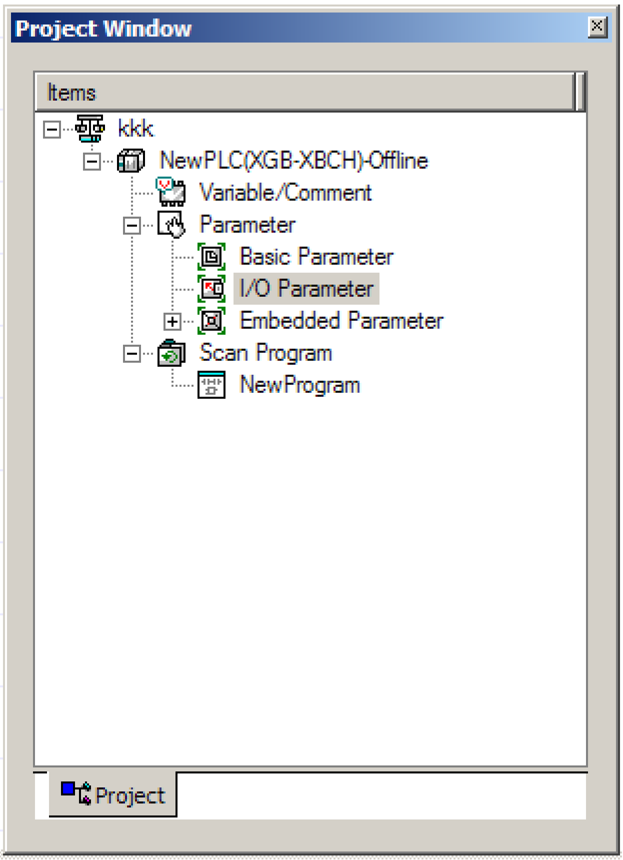
(a) Rated voltage, load: 3 million times: 100 million times
(b) 200V AC 1.5A, 240V AC 1A (COS¢ =0.7): 1 million times
(c) 200V AC 0.4A, 240V AC 0.3A (COS¢ =0.7): 3 million times
(d) 200V AC 1A, 240V AC 0.5A (COS¢ =0.35): 1 million times
(e) 200V AC 0.3A, 240V AC 0.15A (COS¢ =0.35): 3 million times
(f) 24V DC 1A, 100V DC 0.1A (L/R=7ms): 1million times
(g) 24V DC 0.3A, 100V DC 0.03A (L/R=7ms): 3million times

(12) Noise can be inserted into input module. To prevent this noise, the user can set filter for input delay in parameter. Consider the environment and set the input filter time.

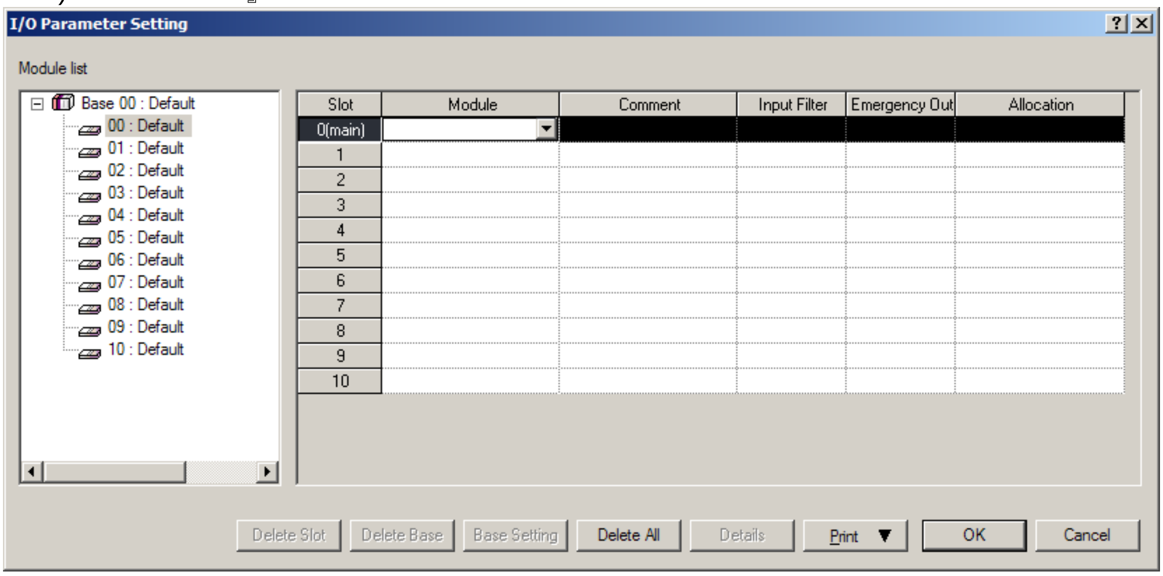
Input filter time (ms)	Noise signal pulse size (ms)	Reference
1	0.3	
3	1.8	Initial value
5	3	
10	6	
20	12	
70	45	
100	60	

(a) Setting input filter

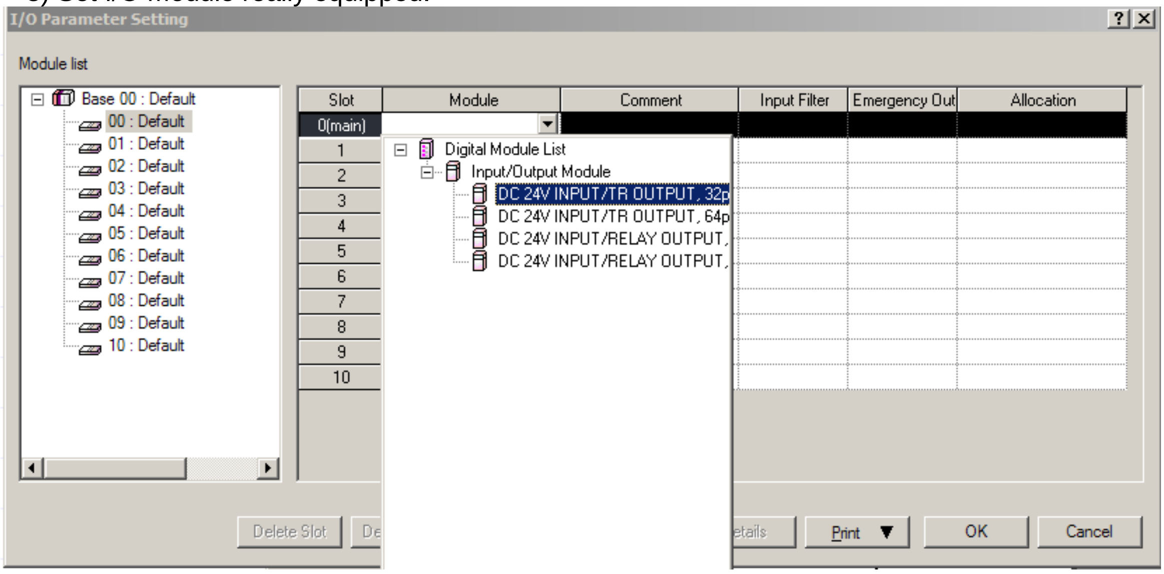
1) Click I/O Parameter』 in the project window of XG5000



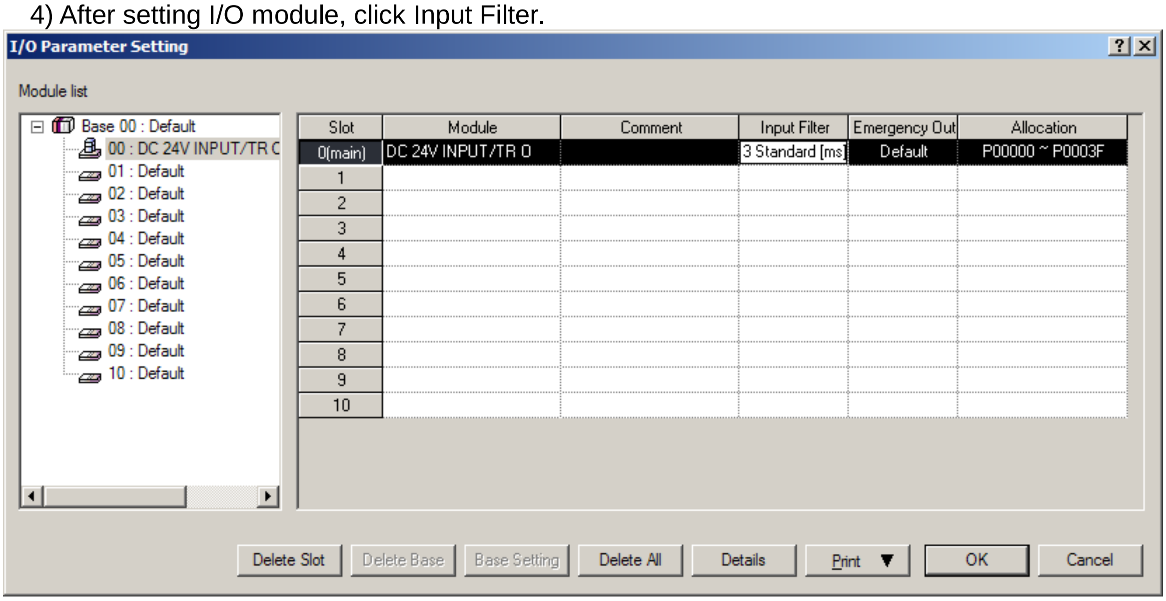
2) Click『Module』 at the slot location.



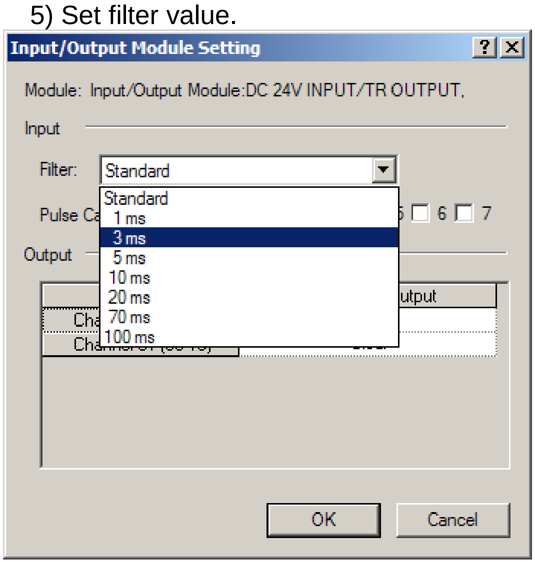
3) Set I/O module really equipped.



4) After setting I/O module, click Input Filter.

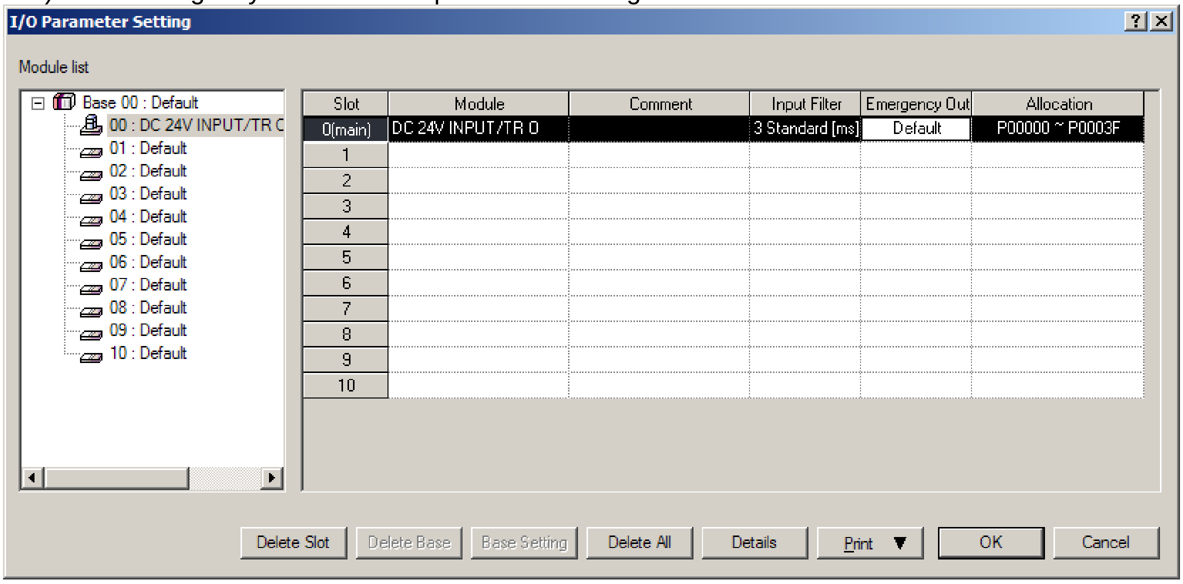


5) Set filter value.

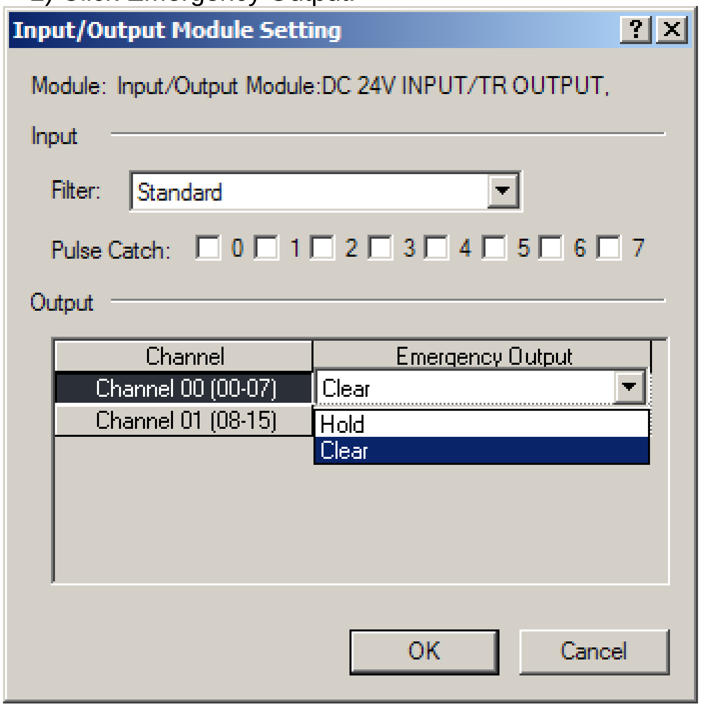


(b) Setting output status in case of error

1) Click Emergency Out in the I/O parameter setting window.



2) Click Emergency Output.



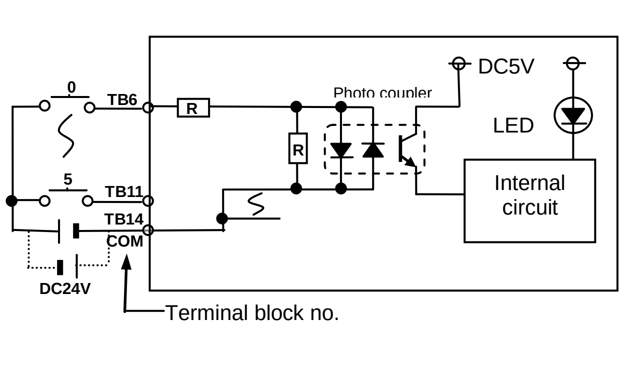
If it is selected as Clear, the output will be Off and if Hold is selected, the output will be kept.

7.2 Main Unit Digital Input Specifications

7.2.1 XBC-DR10E 6 point DC24V input (Source/Sink type)

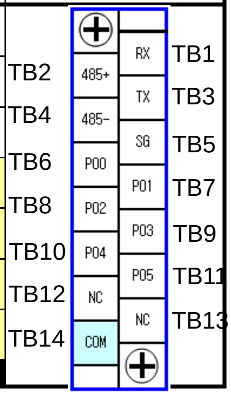
Specification \ Model		Main unit
		XBC-DR10E
Input point		6 point
Insulation method		Photo coupler insulation
Rated input voltage		DC24V
Rated input current		About 4 ㎃ (Contact point 0~3: about 7 ㎃)
Operation voltage range		DC20.4~28.8V (within ripple rate 5%)
On voltage / On current		DC19V or higher / 3 ㎃ or higher
Off voltage / Off current		DC6V or lower / 1 ㎃ or lower
Input resistance		About 5.6 ㏀ (P00~P03: about 2.7 ㏀)
Response time	Off → On	1/3/5/10/20/70/100 ㎳ (Set by I/O parameter) Default: 3 ㎳
	On → Off	
Insulation pressure		AC560Vrms / 3 cycle (altitude 2000m)
Insulation resistance		10 ㏁ or more by MegOhmMeter
Common method		6 point / COM
Proper cable size		0.3 ㎟
Operation indicator		LED On when Input On
External connection method		14 point terminal block connector (M3 X 6 screw)
Weight		330g

Circuit configuration



No.	Contact	No.	Contact
		TB1	RX
TB2	485+	TB3	TX
TB4	485-	TB5	SG
TB6	00	TB7	01
TB8	02	TB9	03
TB10	04	TB11	05
TB12	NC	TB13	NC
TB14	COM		

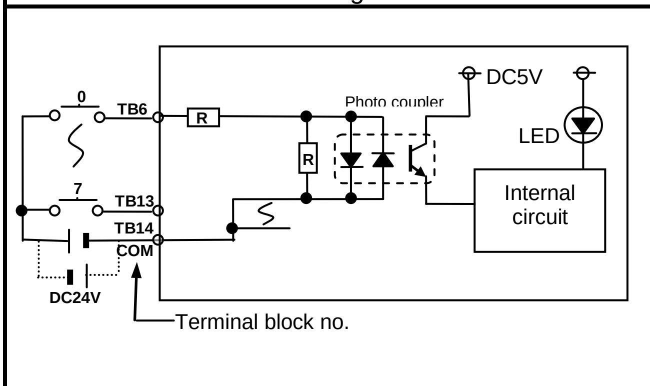
Type



7.2.2 XBC-DR14E 8 point DC24V input (Source/Sink type)

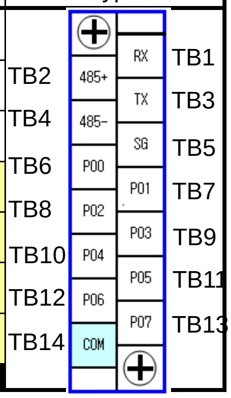
Model / Specification		Main unit XBC-DR14E
Input point		8 point
Insulation method		Photo coupler insulation
Rated input voltage		DC24V
Rated input current		About 4 ㎃ (Contact point 0~3: about 7 ㎃)
Operation voltage range		DC20.4~28.8V (Within ripple rate 5%)
On voltage / On current		DC19V or higher / 3 ㎃ or higher
Off voltage / Off current		DC6V or lower / 1 ㎃ or lower
Input resistance		About 5.6 ㏀ (P00~P03: about 2.7 ㏀)
Response time	Off → On	1/3/5/10/20/70/100 ㎳ (set by I/O parameter) default: 3 ㎳
	On → Off	
Insulation pressure		AC560Vrms / 3 cycle (altitude 2000m)
Insulation resistance		10 ㏁ or more by MegOhmMeter
Common method		8 point / COM
Proper cable size		0.3 ㎟
Operation indicator		LED On when Input On
External connection method		14 point terminal block connector (M3 X 6 screw)
Weight		340g

Circuit configuration



No.	Contact	No.	Contact
		TB1	RX
TB2	485+	TB3	TX
TB4	485-	TB5	SG
TB6	00	TB7	01
TB8	02	TB9	03
TB10	04	TB11	05
TB12	06	TB13	07
TB14	08		

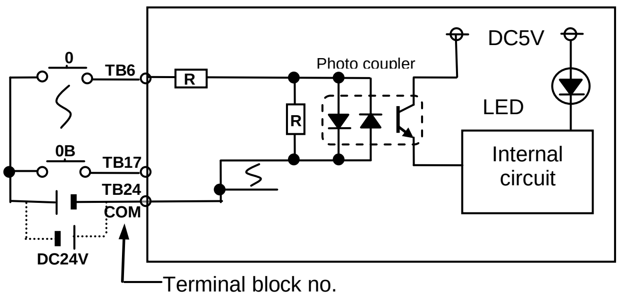
Type



7.2.3 XBC-DR20E 12 point DC24V input (Source/Sink type)

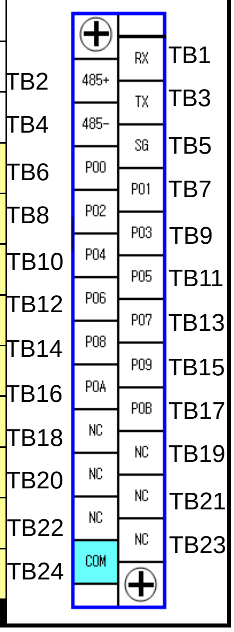
Model / Specification		Main unit
		XBC-DR20E
Input point		12 point
Insulation method		Photo coupler insulation
Rated input voltage		DC24V
Rated input current		About 4 ㎃ (Contact point 0~3: about 7 ㎃)
Operation voltage range		DC20.4~28.8V (within ripple rate 5%)
On voltage / On current		DC19V or higher / 3 ㎃ or higher
Off voltage / Off current		DC6V or lower / 1 ㎃ or lower
Input resistance		About 5.6 ㏀ (P00~P07: about 2.7 ㏀)
Response time	Off → On	1/3/5/10/20/70/100 ㎳ (set by I/O parameter) default: 3 ㎳
	On → Off	
Insulation pressure		AC560Vrms / 3 cycle (altitude 2000m)
Insulation resistance		10 ㏁ or more by MegOhmMeter
Common method		12 point / COM
Proper cable size		0.3 ㎟
Operation indicator		LED On When Input On
External connection method		24 point terminal block connector (M3 X 6 screw)
Weight		450g

Circuit configuration



No.	Contact	No.	Contact
		TB1	RX
TB2	485+	TB3	TX
TB4	485-	TB5	SG
TB6	00	TB7	01
TB8	02	TB9	03
TB10	04	TB11	05
TB12	06	TB13	07
TB14	08	TB15	09
TB16	0A	TB17	0B
TB18	NC	TB19	NC
TB20	NC	TB21	NC
TB22	NC	TB23	NC
TB24	COM		

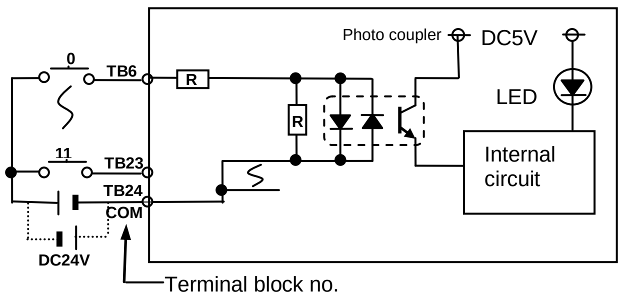
Type



7.2.4 XBC-DR30E 18 point DC24V input (Source/Sink type)

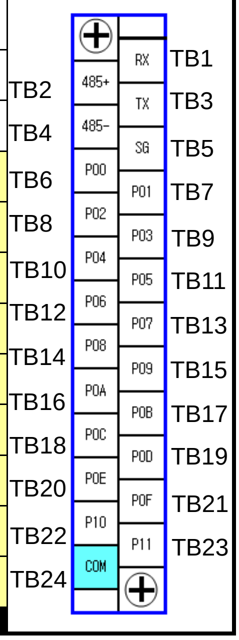
Specification \ Model		Main unit XBC-DR30E
Input point		18 point
Insulation method		Photo coupler insulation
Rated input voltage		DC24V
Rated input current		About 4 mA (Contact point 0~3: about 7 mA)
Operation voltage range		DC20.4~28.8V (within ripple rate 5%)
On voltage / On current		DC19V or higher / 3 mA or higher
Off voltage / Off current		DC6V or lower / 1 mA or lower
Input resistance		About 5.6 kΩ (P00~P07: about 2.7 kΩ)
Response time	Off → On	1/3/5/10/20/70/100 ms (set by I/O parameter) default: 3 ms
	On → Off	
Insulation pressure		AC560Vrms / 3 cycle (altitude 2000m)
Insulation resistance		10 MΩ or higher by MegOhmMeter
Common method		18 point / COM
Proper cable size		0.3 mm²
Operation indicator		LED on when Input On
External connection method		24 point terminal block connector (M3 X 6 screw)
Weight		465g

Circuit configuration



No.	Contact	No.	Contact
		TB1	RX
TB2	485+	TB3	TX
TB4	485-	TB5	SG
TB6	00	TB7	01
TB8	02	TB9	03
TB10	04	TB11	05
TB12	06	TB13	07
TB14	08	TB15	09
TB16	0A	TB17	0B
TB18	0C	TB19	0D
TB20	0E	TB21	0F
TB22	10	TB23	11
TB24	COM		

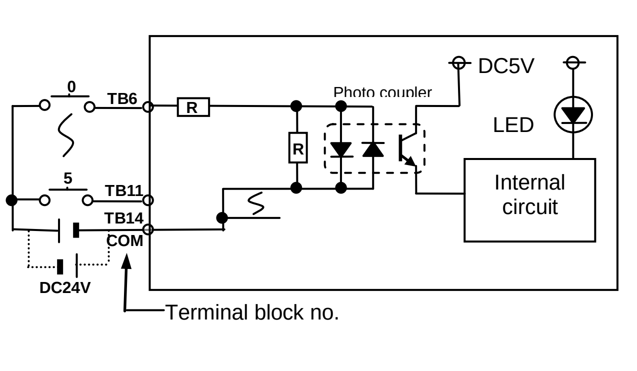
Type



7.2.5 XBC-DN10E 6 point DC24V input (Source/Sink type)

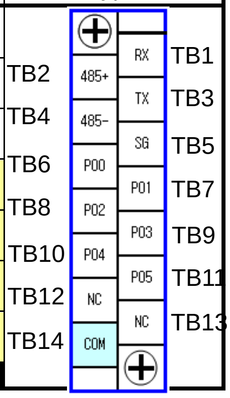
Specification \ Model		Main unit
		XBC-DN10E
Input point		6 point
Insulation method		Photo coupler insulation
Rated input voltage		DC24V
Rated input current		About 4 ㎃ (Contact point 0~3: about 7 ㎃)
Operation voltage range		DC20.4~28.8V (within ripple rate 5%)
On voltage / On current		DC19V or higher / 3 ㎃ or higher
Off voltage / Off current		DC6V or lower / 1 ㎃ or lower
Input resistance		About 5.6 ㏀ (P00~P03: about 2.7 ㏀)
Response time	Off → On	1/3/5/10/20/70/100 ㎳ (Set by I/O parameter) Default: 3 ㎳
	On → Off	
Insulation pressure		AC560Vrms / 3 cycle (altitude 2000m)
Insulation resistance		10 ㏁ or more by MegOhmMeter
Common method		6 point / COM
Proper cable size		0.3 ㎟
Operation indicator		LED On when Input On
External connection method		14 point terminal block connector (M3 X 6 screw)
Weight		330g

Circuit configuration



No.	Contact	No.	Contact
		TB1	RX
TB2	485+	TB3	TX
TB4	485-	TB5	SG
TB6	00	TB7	01
TB8	02	TB9	03
TB10	04	TB11	05
TB12	NC	TB13	NC
TB14	COM		

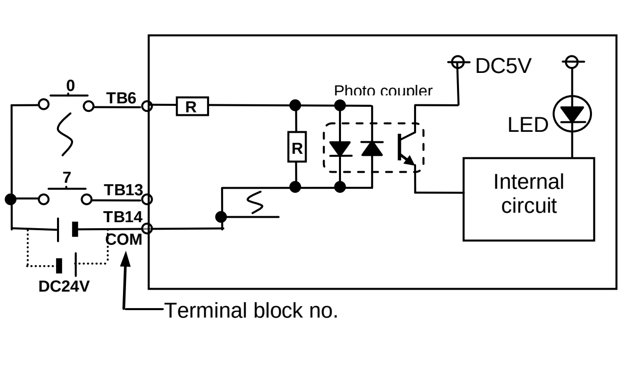
Type



7.2.6 XBC-DN14E 8 point DC24V input (Source/Sink type)

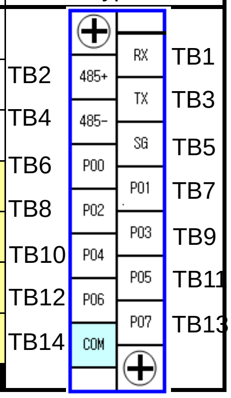
Model / Specification		Main unit XBC-DN14E
Input point		8 point
Insulation method		Photo coupler insulation
Rated input voltage		DC24V
Rated input current		About 4 ㎃ (Contact point 0~3: about 7 ㎃)
Operation voltage range		DC20.4~28.8V (Within ripple rate 5%)
On voltage / On current		DC19V or higher / 3 ㎃ or higher
Off voltage / Off current		DC6V or lower / 1 ㎃ or lower
Input resistance		About 5.6 ㏀ (P00~P03: about 2.7 ㏀)
Response time	Off → On	1/3/5/10/20/70/100 ㎳ (set by I/O parameter) default: 3 ㎳
	On → Off	
Insulation pressure		AC560Vrms / 3 cycle (altitude 2000m)
Insulation resistance		10 ㏁ or more by MegOhmMeter
Common method		8 point / COM
Proper cable size		0.3 ㎟
Operation indicator		LED On when Input On
External connection method		14 point terminal block connector (M3 X 6 screw)
Weight		340g

Circuit configuration



No.	Contact	No.	Contact
		TB1	RX
TB2	485+	TB3	TX
TB4	485-	TB5	SG
TB6	00	TB7	01
TB8	02	TB9	03
TB10	04	TB11	05
TB12	06	TB13	07
TB14	08		

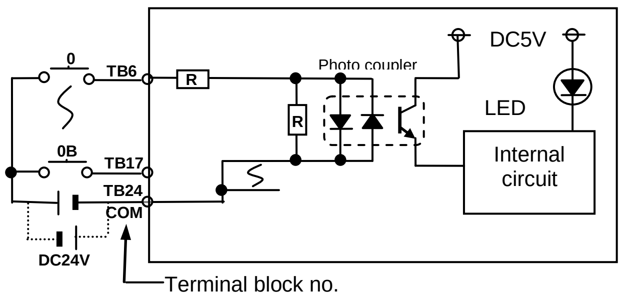
Type



7.2.7 XBC-DN20E 12 point DC24V input (Source/Sink type)

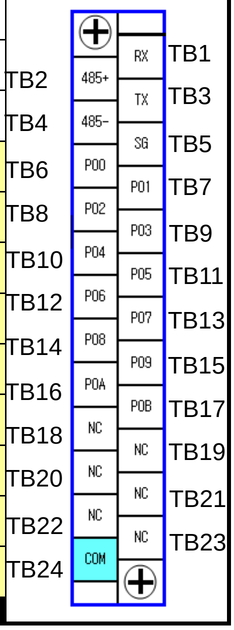
Specification \ Model		Main unit
		XBC-DN20E
Input point		12 point
Insulation method		Photo coupler insulation
Rated input voltage		DC24V
Rated input current		About 4 ㎃ (Contact point 0~3: about 7 ㎃)
Operation voltage range		DC20.4~28.8V (within ripple rate 5%)
On voltage / On current		DC19V or higher / 3 ㎃ or higher
Off voltage / Off current		DC6V or lower / 1 ㎃ or lower
Input resistance		About 5.6 ㏀ (P00~P07: about 2.7 ㏀)
Response time	Off → On	1/3/5/10/20/70/100 ㎳ (set by I/O parameter) default: 3 ㎳
	On → Off	
Insulation pressure		AC560Vrms / 3 cycle (altitude 2000m)
Insulation resistance		10 ㏁ or more by MegOhmMeter
Common method		12 point / COM
Proper cable size		0.3 ㎟
Operation indicator		LED On When Input On
External connection method		24 point terminal block connector (M3 X 6 screw)
Weight		450g

Circuit configuration



No.	Contact	No.	Contact
		TB1	RX
TB2	485+	TB3	TX
TB4	485-	TB5	SG
TB6	00	TB7	01
TB8	02	TB9	03
TB10	04	TB11	05
TB12	06	TB13	07
TB14	08	TB15	09
TB16	0A	TB17	0B
TB18	NC	TB19	NC
TB20	NC	TB21	NC
TB22	NC	TB23	NC
TB24	COM		

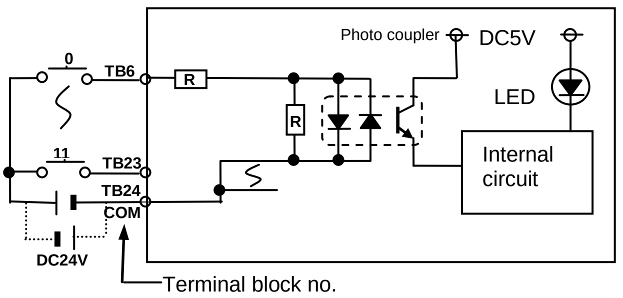
Type



7.2.8 XBC-DN30E 18 point DC24V input (Source/Sink type)

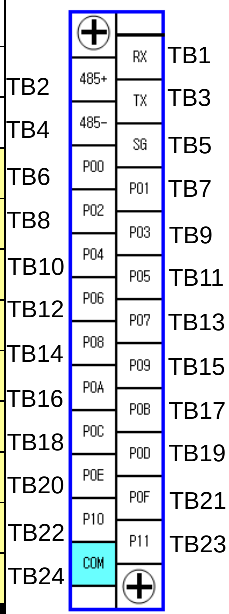
Specification \ Model		Main unit
		XBC-DN30E
Input point		18 point
Insulation method		Photo coupler insulation
Rated input voltage		DC24V
Rated input current		About 4 ㎃ (Contact point 0~3: about 7 ㎃)
Operation voltage range		DC20.4~28.8V (within ripple rate 5%)
On voltage / On current		DC19V or higher / 3 ㎃ or higher
Off voltage / Off current		DC6V or lower / 1 ㎃ or lower
Input resistance		About 5.6 ㏀ (P00~P07: about 2.7 ㏀)
Response time	Off → On	1/3/5/10/20/70/100 ㎳ (set by I/O parameter) default: 3 ㎳
	On → Off	
Insulation pressure		AC560Vrms / 3 cycle (altitude 2000m)
Insulation resistance		10 ㏁ or higher by MegOhmMeter
Common method		18 point / COM
Proper cable size		0.3 ㎟
Operation indicator		LED on when Input On
External connection method		24 point terminal block connector (M3 X 6 screw)
Weight		465g

Circuit configuration



No.	Contact	No.	Contact
		TB1	RX
TB2	485+	TB3	TX
TB4	485-	TB5	SG
TB6	00	TB7	01
TB8	02	TB9	03
TB10	04	TB11	05
TB12	06	TB13	07
TB14	08	TB15	09
TB16	0A	TB17	0B
TB18	0C	TB19	0D
TB20	0E	TB21	0F
TB22	10	TB23	11
TB24	COM		

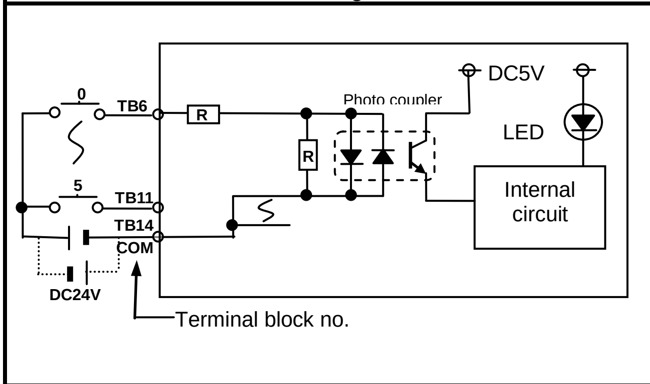
Type



7.2.9 XBC-DP10E 6 point DC24V input (Source/Sink type)

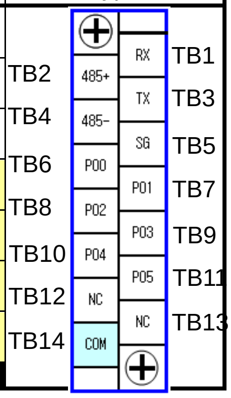
Specification \ Model		Main unit
		XBC-DP10E
Input point		6 point
Insulation method		Photo coupler insulation
Rated input voltage		DC24V
Rated input current		About 4 ㎃ (Contact point 0~3: about 7 ㎃)
Operation voltage range		DC20.4~28.8V (within ripple rate 5%)
On voltage / On current		DC19V or higher / 3 ㎃ or higher
Off voltage / Off current		DC6V or lower / 1 ㎃ or lower
Input resistance		About 5.6 ㏀ (P00~P03: about 2.7 ㏀)
Response time	Off → On	1/3/5/10/20/70/100 ㎳ (Set by I/O parameter) Default: 3 ㎳
	On → Off	
Insulation pressure		AC560Vrms / 3 cycle (altitude 2000m)
Insulation resistance		10 ㏁ or more by MegOhmMeter
Common method		6 point / COM
Proper cable size		0.3 ㎟
Operation indicator		LED On when Input On
External connection method		14 point terminal block connector (M3 X 6 screw)
Weight		330g

Circuit configuration



No.	Contact	No.	Contact
		TB1	RX
TB2	485+	TB3	TX
TB4	485-	TB5	SG
TB6	00	TB7	01
TB8	02	TB9	03
TB10	04	TB11	05
TB12	NC	TB13	NC
TB14	COM		

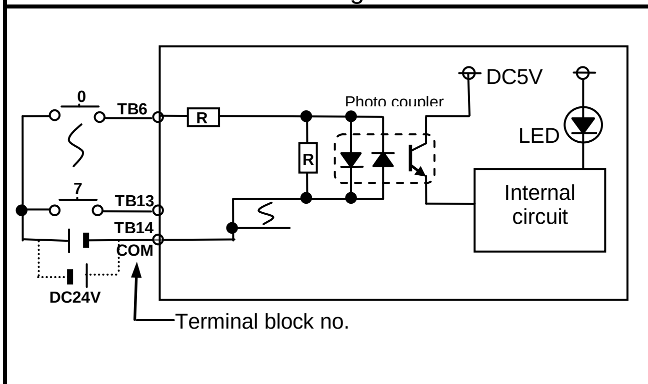
Type



7.2.10 XBC-DP14E 8 point DC24V input (Source/Sink type)

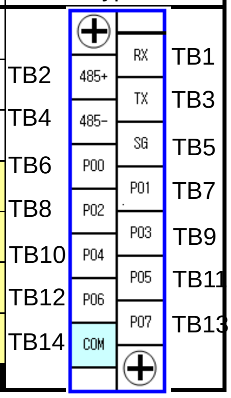
Model / Specification		Main unit
		XBC-DP14E
Input point		8 point
Insulation method		Photo coupler insulation
Rated input voltage		DC24V
Rated input current		About 4 ㎃ (Contact point 0~3: about 7 ㎃)
Operation voltage range		DC20.4~28.8V (Within ripple rate 5%)
On voltage / On current		DC19V or higher / 3 ㎃ or higher
Off voltage / Off current		DC6V or lower / 1 ㎃ or lower
Input resistance		About 5.6 ㏀ (P00~P03: about 2.7 ㏀)
Response time	Off → On	1/3/5/10/20/70/100 ㎳ (set by I/O parameter) default: 3 ㎳
	On → Off	
Insulation pressure		AC560Vrms / 3 cycle (altitude 2000m)
Insulation resistance		10 ㏁ or more by MegOhmMeter
Common method		8 point / COM
Proper cable size		0.3 ㎟
Operation indicator		LED On when Input On
External connection method		14 point terminal block connector (M3 X 6 screw)
Weight		340g

Circuit configuration



No.	Contact	No.	Contact
		TB1	RX
TB2	485+	TB3	TX
TB4	485-	TB5	SG
TB6	00	TB7	01
TB8	02	TB9	03
TB10	04	TB11	05
TB12	06	TB13	07
TB14	08		

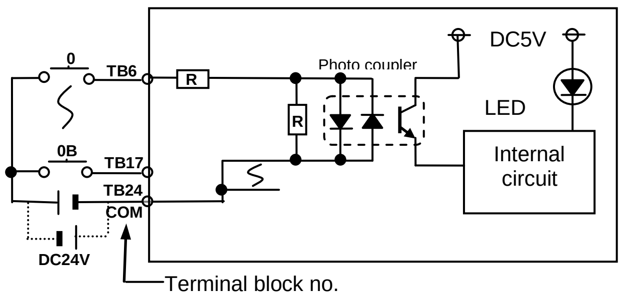
Type



7.2.11 XBC-DP20E 12 point DC24V input (Source/Sink type)

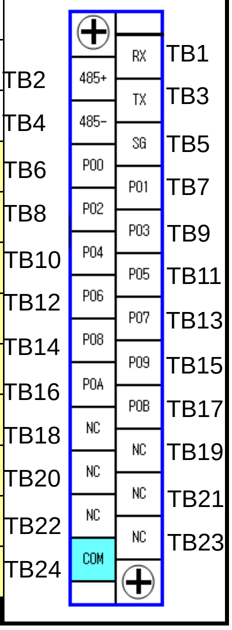
Model / Specification		Main unit XBC-DP20E
Input point		12 point
Insulation method		Photo coupler insulation
Rated input voltage		DC24V
Rated input current		About 4 ㎃ (Contact point 0~3: about 7 ㎃)
Operation voltage range		DC20.4~28.8V (within ripple rate 5%)
On voltage / On current		DC19V or higher / 3 ㎃ or higher
Off voltage / Off current		DC6V or lower / 1 ㎃ or lower
Input resistance		About 5.6 ㏀ (P00~P07: about 2.7 ㏀)
Response time	Off → On	1/3/5/10/20/70/100 ㎳ (set by I/O parameter) default: 3 ㎳
	On → Off	
Insulation pressure		AC560Vrms / 3 cycle (altitude 2000m)
Insulation resistance		10 ㏁ or more by MegOhmMeter
Common method		12 point / COM
Proper cable size		0.3 ㎟
Operation indicator		LED On When Input On
External connection method		24 point terminal block connector (M3 X 6 screw)
Weight		450g

Circuit configuration



No.	Contact	No.	Contact
		TB1	RX
TB2	485+	TB3	TX
TB4	485-	TB5	SG
TB6	00	TB7	01
TB8	02	TB9	03
TB10	04	TB11	05
TB12	06	TB13	07
TB14	08	TB15	09
TB16	0A	TB17	0B
TB18	NC	TB19	NC
TB20	NC	TB21	NC
TB22	NC	TB23	NC
TB24	COM		

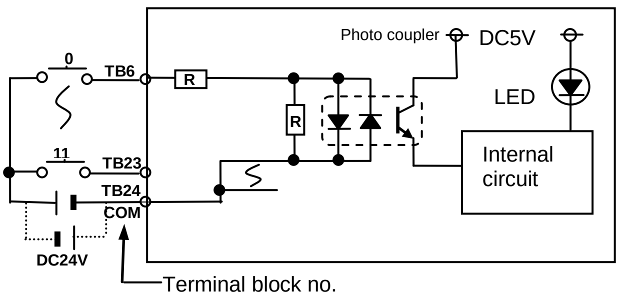
Type



7.2.12 XBC-DP30E 18 point DC24V input (Source/Sink type)

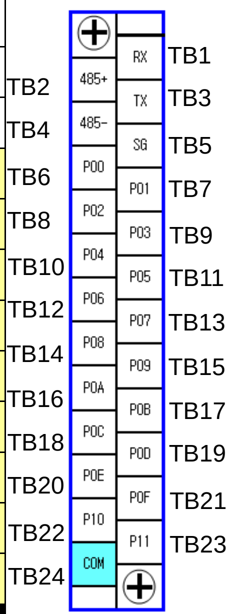
Model / Specification		Main unit XBC-DP30E
Input point		18 point
Insulation method		Photo coupler insulation
Rated input voltage		DC24V
Rated input current		About 4 ㎃ (Contact point 0~3: about 7 ㎃)
Operation voltage range		DC20.4~28.8V (within ripple rate 5%)
On voltage / On current		DC19V or higher / 3 ㎃ or higher
Off voltage / Off current		DC6V or lower / 1 ㎃ or lower
Input resistance		About 5.6 ㏀ (P00~P07: about 2.7 ㏀)
Response time	Off → On	1/3/5/10/20/70/100 ㎳ (set by I/O parameter) default: 3 ㎳
	On → Off	
Insulation pressure		AC560Vrms / 3 cycle (altitude 2000m)
Insulation resistance		10 ㏁ or higher by MegOhmMeter
Common method		18 point / COM
Proper cable size		0.3 ㎟
Operation indicator		LED on when Input On
External connection method		24 point terminal block connector (M3 X 6 screw)
Weight		465g

Circuit configuration



No.	Contact	No.	Contact
		TB1	RX
TB2	485+	TB3	TX
TB4	485-	TB5	SG
TB6	00	TB7	01
TB8	02	TB9	03
TB10	04	TB11	05
TB12	06	TB13	07
TB14	08	TB15	09
TB16	0A	TB17	0B
TB18	0C	TB19	0D
TB20	0E	TB21	0F
TB22	10	TB23	11
TB24	COM		

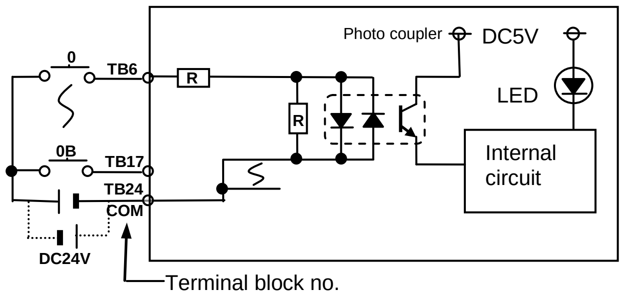
Type



7.2.13 XBC-DN20S 12 point DC24V input (Source/Sink type)

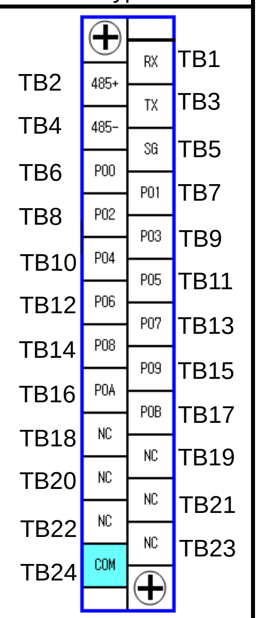
Specification \ Model		Main unit XBC-DN20S
Input point		12 point
Insulation method		Photo coupler insulation
Rated input voltage		DC24V
Rated input current		About 4 ㎃ (Contact point 0~7: about 10 ㎃)
Operation voltage range		DC20.4~28.8V (within ripple rate 5%)
On voltage / On current		DC19V or higher / 3 ㎃ or higher
Off voltage / Off current		DC6V or lower / 1 ㎃ or lower
Input resistance		About 5.6 ㏀ (P00~P07: about 2.7 ㏀)
Response time	Off → On	1/3/5/10/20/70/100 ㎳ (set by I/O parameter) default: 3 ㎳
	On → Off	
Insulation pressure		AC560Vrms / 3 cycle (altitude 2000m)
Insulation resistance		10 ㏁ or higher by MegOhmMeter
Common method		12 point / COM
Proper cable size		0.3 ㎟
Operation indicator		LED on when Input On
External connection method		24 point terminal block connector (M3 X 6 screw)
Weight		470g

Circuit configuration



No.	Contact	No.	Contact
		TB1	RX
TB2	485+	TB3	TX
TB4	485-	TB5	SG
TB6	00	TB7	01
TB8	02	TB9	03
TB10	04	TB11	05
TB12	06	TB13	07
TB14	08	TB15	09
TB16	0A	TB17	0B
TB18	NC	TB19	NC
TB20	NC	TB21	NC
TB22	NC	TB23	NC
TB24	COM		

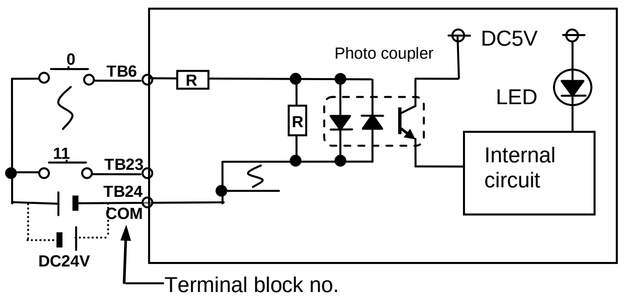
Type



7.2.14 XBC-DN30S 18 point DC24V input (Source/Sink type)

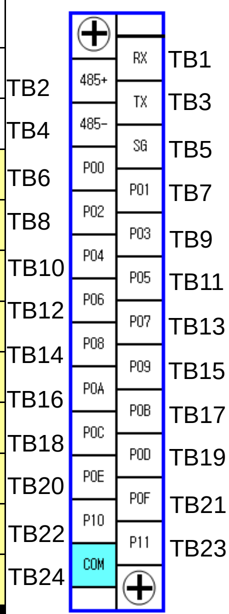
Model / Specification		Main unit XBC-DN30S
Input point		18 point
Insulation method		Photo coupler insulation
Rated input voltage		DC24V
Rated input current		About 4 ㎃ (Contact point 0~7: about 10 ㎃)
Operation voltage range		DC20.4~28.8V (within ripple rate 5%)
On voltage / On current		DC19V or higher / 3 ㎃ or higher
Off voltage / Off current		DC6V or lower / 1 ㎃ or lower
Input resistance		About 5.6 ㏀ (P00~P07: about 2.7 ㏀)
Response time	Off → On	1/3/5/10/20/70/100 ㎳ (set by I/O parameter) default: 3 ㎳
	On → Off	
Insulation pressure		AC560Vrms / 3 cycle (altitude 2000m)
Insulation resistance		10 ㏁ or higher by MegOhmMeter
Common method		18 point / COM
Proper cable size		0.3 ㎟
Operation indicator		LED on when Input On
External connection method		24 point terminal block connector (M3 X 6 screw)
Weight		475g

Circuit configuration



No.	Contact	No.	Contact
		TB1	RX
TB2	485+	TB3	TX
TB4	485-	TB5	SG
TB6	00	TB7	01
TB8	02	TB9	03
TB10	04	TB11	05
TB12	06	TB13	07
TB14	08	TB15	09
TB16	0A	TB17	0B
TB18	0C	TB19	0D
TB20	0E	TB21	0F
TB22	10	TB23	11
TB24	COM		

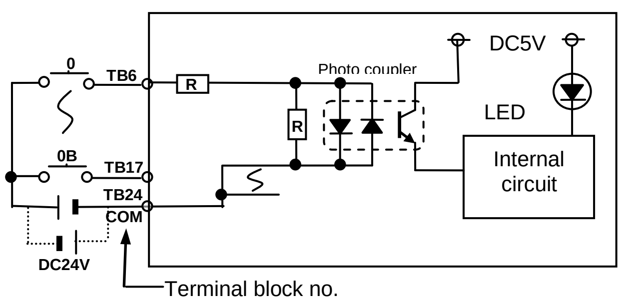
Type



7.2.15 XBC-DR20SU 12 point DC24V input (Source/Sink type)

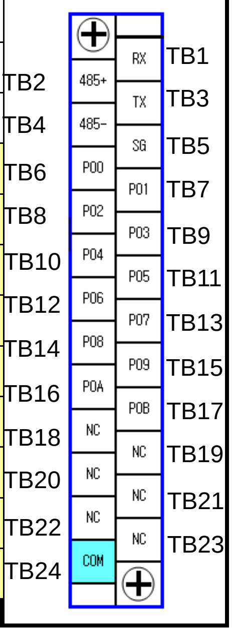
Model / Specification		Main unit
		XBC-DR20SU
Input point		12 point
Insulation method		Photo coupler insulation
Rated input voltage		DC24V
Rated input current		About 4 ㎃ (point 0~1: about 16 ㎃, point 2~7: about 10 ㎃)
Operation voltage range		DC20.4~28.8V (within ripple rate 5%)
On voltage / On current		DC19V or higher / 3 ㎃ or higher
Off voltage / Off current		DC6V or lower / 1 ㎃ or lower
Input resistance		About 5.6 ㏀ (P00~P01: about 1.5 ㏀, P02~P07: about 2.7 ㏀)
Response time	Off → On	1/3/5/10/20/70/100 ㎳ (set by I/O parameter) default: 3 ㎳
	On → Off	
Insulation pressure		AC560Vrms / 3 cycle (altitude 2000m)
Insulation resistance		10 ㏁ or more by MegOhmMeter
Common method		12 point / COM
Proper cable size		0.3 ㎟
Operation indicator		LED On When Input On
External connection method		24 point terminal block connector (M3 X 6 screw)
Weight		514g

Circuit configuration



No.	Contact	No.	Contact
		TB1	RX
TB2	485+	TB3	TX
TB4	485-	TB5	SG
TB6	00	TB7	01
TB8	02	TB9	03
TB10	04	TB11	05
TB12	06	TB13	07
TB14	08	TB15	09
TB16	0A	TB17	0B
TB18	NC	TB19	NC
TB20	NC	TB21	NC
TB22	NC	TB23	NC
TB24	COM		

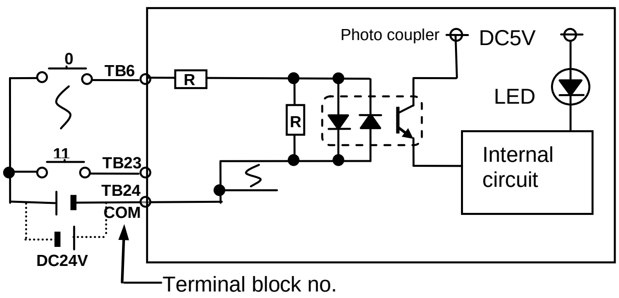
Type



7.2.16 XBC-DR30SU 18 point DC24V input (Source/Sink type)

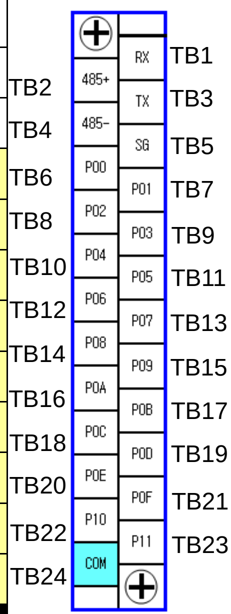
Specification \ Model		Main unit XBC-DR30SU
Input point		18 point
Insulation method		Photo coupler insulation
Rated input voltage		DC24V
Rated input current		About 4 ㎃ (point 0~1: about 16 ㎃, point 2~7: about 10 ㎃)
Operation voltage range		DC20.4~28.8V (within ripple rate 5%)
On voltage / On current		DC19V or higher / 3 ㎃ or higher
Off voltage / Off current		DC6V or lower / 1 ㎃ or lower
Input resistance		About 5.6 ㏀ (P00~P01: about 1.5 ㏀, P02~P07: about 2.7 ㏀)
Response time	Off → On	1/3/5/10/20/70/100 ㎳ (set by I/O parameter) default: 3 ㎳
	On → Off	
Insulation pressure		AC560Vrms / 3 cycle (altitude 2000m)
Insulation resistance		10 ㏁ or higher by MegOhmMeter
Common method		18 point / COM
Proper cable size		0.3 ㎟
Operation indicator		LED on when Input On
External connection method		24 point terminal block connector (M3 X 6 screw)
Weight		475g

Circuit configuration



No.	Contact	No.	Contact
		TB1	RX
TB2	485+	TB3	TX
TB4	485-	TB5	SG
TB6	00	TB7	01
TB8	02	TB9	03
TB10	04	TB11	05
TB12	06	TB13	07
TB14	08	TB15	09
TB16	0A	TB17	0B
TB18	0C	TB19	0D
TB20	0E	TB21	0F
TB22	10	TB23	11
TB24	COM		

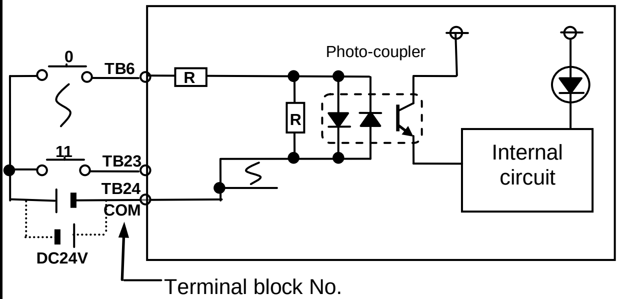
Type



7.2.17 XBC-DR40SU 24 point DC24V input (Source/Sink Type)

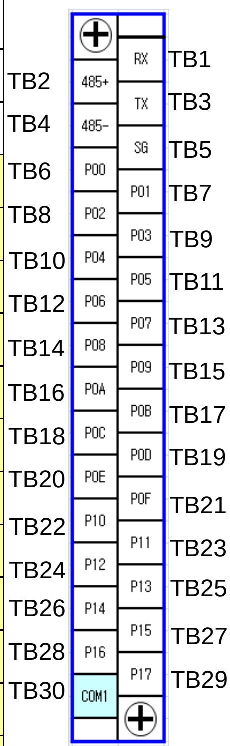
Specification \ Model		Main unit
		XBC-DR40SU
Input point		24 point
Insulation method		Photo coupler insulation
Rated input voltage		DC24V
Rated input current		About 4 ㎃ (point 0~1: about 16 ㎃, point 2~7: about 10 ㎃)
Operation voltage range		DC20.4~28.8V (within ripple rate 5%)
On voltage / On current		DC19V or higher / 3 ㎃ or higher
Off voltage / Off current		DC6V or lower / 1 ㎃ or lower
Input resistance		About 5.6 ㏀ (P00~P01: about 1.5 ㏀, P02~P07: about 2.7 ㏀)
Response time	Off → On	1/3/5/10/20/70/100 ㎳ (set by I/O parameter) default: 3 ㎳
	On → Off	
Insulation pressure		AC560Vrms / 3 cycle (altitude 2000m)
Insulation resistance		10 ㏁ or higher by MegOhmMeter
Common method		24 point / COM
Proper cable size		0.3 ㎟
Operation indicator		LED on when Input On
External connection method		30 point terminal block connector (M3 X 6 screw)
Weight		594g

Circuit configuration



No.	Contact	No.	Contact
		TB1	RX
TB2	485+	TB3	TX
TB4	485-	TB5	SG
TB6	00	TB7	01
TB8	02	TB9	03
TB10	04	TB11	05
TB12	06	TB13	07
TB14	08	TB15	09
TB16	0A	TB17	0B
TB18	0C	TB19	0D
TB20	0E	TB21	0F
TB22	10	TB23	11
TB24	12	TB25	13
TB26	14	TB27	15
TB28	16	TB29	17
TB30	COM		

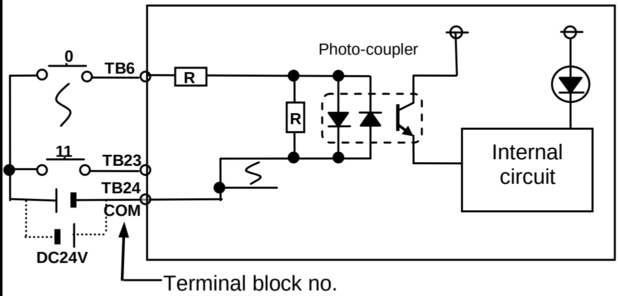
Type



7.2.18 XBC-DR60SU 36 point DC24V input (Source/Sink Type)

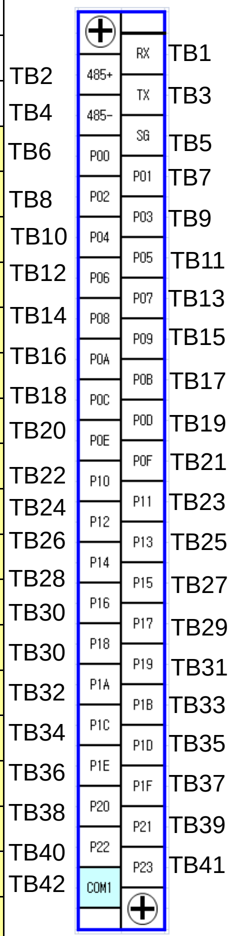
Model / Specification		Main unit XBC-DR60SU
Input point		36 point
Insulation method		Photo coupler insulation
Rated input voltage		DC24V
Rated input current		About 4 ㎃ (point 0~1: about 16 ㎃, point 2~7: about 10 ㎃)
Operation voltage range		DC20.4~28.8V (within ripple rate 5%)
On voltage / On current		DC19V or higher / 3 ㎃ or higher
Off voltage / Off current		DC6V or lower / 1 ㎃ or lower
Input resistance		About 5.6 ㏀ (P00~P01: about 1.5 ㏀, P02~P07: about 2.7 ㏀)
Response time	Off → On	1/3/5/10/20/70/100 ㎳ (set by I/O parameter) default: 3 ㎳
	On → Off	
Insulation pressure		AC560Vrms / 3 cycle (altitude 2000m)
Insulation resistance		10 ㏁ or higher by MegOhmMeter
Common method		36 point / COM
Proper cable size		0.3 ㎟
Operation indicator		LED on when Input On
External connection method		42 point terminal block connector (M3 X 6 screw)
Weight		804g

Circuit configuration



No.	Contact	No.	Contact
		TB1	RX
TB2	485+	TB3	TX
TB4	485-	TB5	SG
TB6	00	TB7	01
TB8	02	TB9	03
TB10	04	TB11	05
TB12	06	TB13	07
TB14	08	TB15	09
TB16	0A	TB17	0B
TB18	0C	TB19	0D
TB20	0E	TB21	0F
TB22	10	TB23	11
TB24	12	TB25	13
TB26	14	TB27	15
TB28	16	TB29	17
TB30	18	TB31	19
TB32	1A	TB33	1B
TB34	1C	TB35	1D
TB36	1E	TB37	1F
TB38	20	TB39	21
TB40	22	TB41	23
TB42	COM		

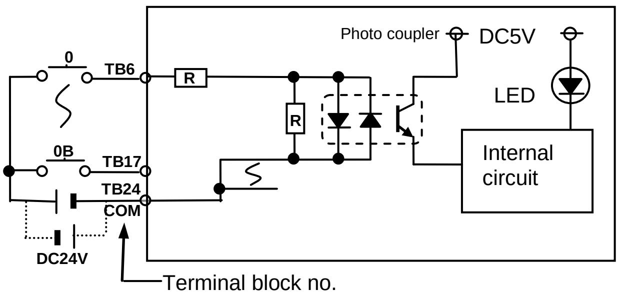
Type



7.2.19 XBC-DN20SU 12 point DC24V input (Source/Sink type)

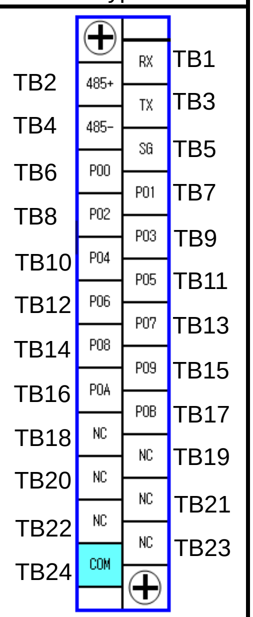
Model / Specification		Main unit XBC-DN20SU
Input point		12 point
Insulation method		Photo coupler insulation
Rated input voltage		DC24V
Rated input current		About 4 ㎃ (Contact point 0~3: about 7 ㎃)
Operation voltage range		DC20.4~28.8V (within ripple rate 5%)
On voltage / On current		DC19V or higher / 3 ㎃ or higher
Off voltage / Off current		DC6V or lower / 1 ㎃ or lower
Input resistance		About 5.6 ㏀ (P00~P01: about 1.5 ㏀, P02~P07: about 2.7 ㏀)
Response time	Off → On	1/3/5/10/20/70/100 ㎳ (set by I/O parameter) default: 3 ㎳
	On → Off	
Insulation pressure		AC560Vrms / 3 cycle (altitude 2000m)
Insulation resistance		10 ㏁ or higher by MegOhmMeter
Common method		12 point / COM
Proper cable size		0.3 ㎟
Operation indicator		LED on when Input On
External connection method		24 point terminal block connector (M3 X 6 screw)
Weight		475g

Circuit configuration



No.	Contact	No.	Contact
		TB1	RX
TB2	485+	TB3	TX
TB4	485-	TB5	SG
TB6	00	TB7	01
TB8	02	TB9	03
TB10	04	TB11	05
TB12	06	TB13	07
TB14	08	TB15	09
TB16	0A	TB17	0B
TB18	NC	TB19	NC
TB20	NC	TB21	NC
TB22	NC	TB23	NC
TB24	COM		

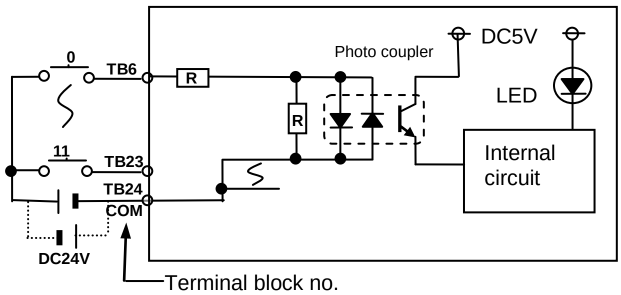
Type



7.2.20 XBC-DN30SU 18 point DC24V input (Source/Sink type)

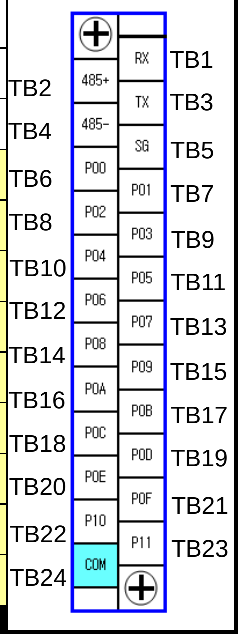
Model / Specification		Main unit
		XBC-DN30SU
Input point		18 point
Insulation method		Photo coupler insulation
Rated input voltage		DC24V
Rated input current		About 4 ㎃ (point 0~1: about 16 ㎃, point 2~7: about 10mA)
Operation voltage range		DC20.4~28.8V (within ripple rate 5%)
On voltage / On current		DC19V or higher / 3 ㎃ or higher
Off voltage / Off current		DC6V or lower / 1 ㎃ or lower
Input resistance		About 5.6 ㏀ (P00~P01: about 1.5 ㏀, P02~P07: about 2.7 ㏀)
Response time	Off → On	1/3/5/10/20/70/100 ㎳ (set by I/O parameter) default: 3 ㎳
	On → Off	
Insulation pressure		AC560Vrms / 3 cycle (altitude 2000m)
Insulation resistance		10 ㏁ or higher by MegOhmMeter
Common method		18 point / COM
Proper cable size		0.3 ㎟
Operation indicator		LED on when Input On
External connection method		24 point terminal block connector (M3 X 6 screw)
Weight		476g

Circuit configuration



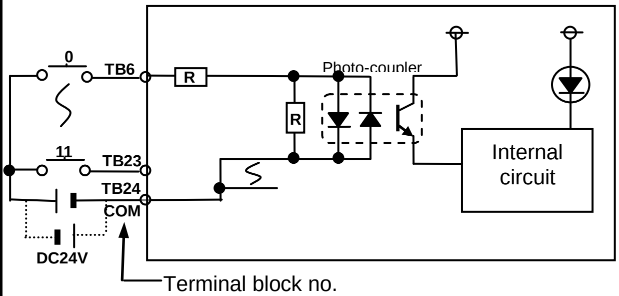
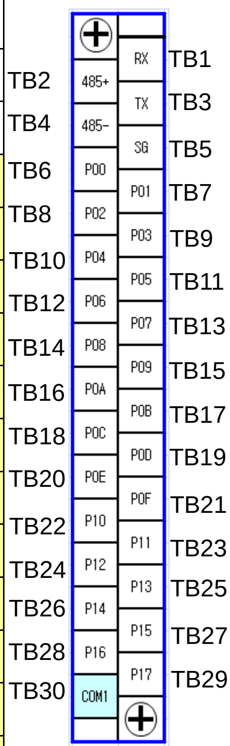
No.	Contact	No.	Contact
		TB1	RX
TB2	485+	TB3	TX
TB4	485-	TB5	SG
TB6	00	TB7	01
TB8	02	TB9	03
TB10	04	TB11	05
TB12	06	TB13	07
TB14	08	TB15	09
TB16	0A	TB17	0B
TB18	0C	TB19	0D
TB20	0E	TB21	0F
TB22	10	TB23	11
TB24	COM		

Type



7.2.21 XBC-DN40SU 24 point DC24V input (Source/Sink Type)

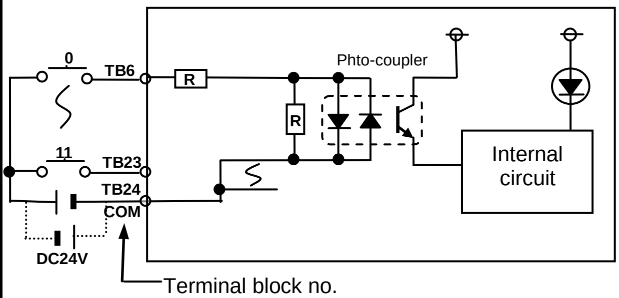
Model / Specification		Main unit XBC-DN40SU
Input point		24 point
Insulation method		Photo coupler insulation
Rated input voltage		DC24V
Rated input current		About 4 mA (point 0~1: about 16 mA, point 2~7: about 10 mA)
Operation voltage range		DC20.4~28.8V (within ripple rate 5%)
On voltage / On current		DC19V or higher / 3 mA or higher
Off voltage / Off current		DC6V or lower / 1 mA or lower
Input resistance		About 5.6 kΩ (P00~P01: about 1.5 kΩ, P02~P07: about 2.7 kΩ)
Response time	Off → On	1/3/5/10/20/70/100 ms (set by I/O parameter) default: 3 ms
	On → Off	
Insulation pressure		AC560Vrms / 3 cycle (altitude 2000m)
Insulation resistance		10 MΩ or higher by MegOhmMeter
Common method		24 point / COM
Proper cable size		0.3 mm²
Operation indicator		LED on when Input On
External connection method		30 point terminal block connector (M3 X 6 screw)
Weight		578g

Circuit configuration	No.	Contact	No.	Contact	Type
			TB1	RX	
	TB2	485+	TB3	TX	
	TB4	485-	TB5	SG	
	TB6	00	TB7	01	
	TB8	02	TB9	03	
	TB10	04	TB11	05	
	TB12	06	TB13	07	
	TB14	08	TB15	09	
	TB16	0A	TB17	0B	
	TB18	0C	TB19	0D	
	TB20	0E	TB21	0F	
	TB22	10	TB23	11	
	TB24	12	TB25	13	
	TB26	14	TB27	15	
	TB28	16	TB29	17	
	TB30	COM			

7.2.22 XBC-DN60SU 36 point DC24V input (Source/Sink Type)

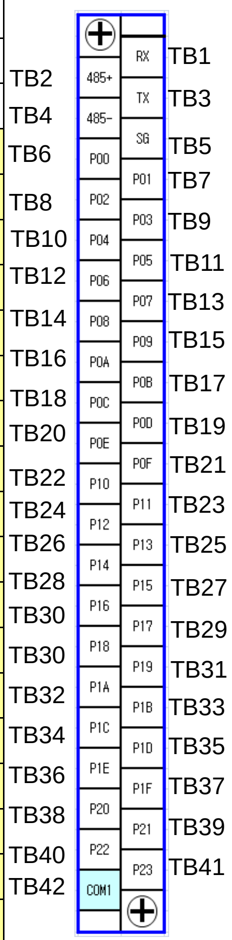
Specification \ Model		Main unit XBC-DN60SU
Input point		36 point
Insulation method		Photo coupler insulation
Rated input voltage		DC24V
Rated input current		About 4 ㎃ (point 0~1: about 16 ㎃, point 2~7: about 10 ㎃)
Operation voltage range		DC20.4~28.8V (within ripple rate 5%)
On voltage / On current		DC19V or higher / 3 ㎃ or higher
Off voltage / Off current		DC6V or lower / 1 ㎃ or lower
Input resistance		About 5.6 ㏀ (P00~P01: about 1.5 ㏀, P02~P07: about 2.7 ㏀)
Response time	Off → On	1/3/5/10/20/70/100 ㎳ (set by I/O parameter) default: 3 ㎳
	On → Off	
Insulation pressure		AC560Vrms / 3 cycle (altitude 2000m)
Insulation resistance		10 ㏁ or higher by MegOhmMeter
Common method		36 point / COM
Proper cable size		0.3 ㎟
Operation indicator		LED on when Input On
External connection method		42 point terminal block connector (M3 X 6 screw)
Weight		636g

Circuit configuration



No.	Contact	No.	Contact
TB2	485+	TB1	RX
TB4	485-	TB3	TX
TB6	00	TB5	SG
TB8	02	TB7	01
TB10	04	TB9	03
TB12	06	TB11	05
TB14	08	TB13	07
TB16	0A	TB15	09
TB18	0C	TB17	0B
TB20	0E	TB19	0D
TB22	10	TB21	0F
TB24	12	TB23	11
TB26	14	TB25	13
TB28	16	TB27	15
TB30	18	TB29	17
TB32	1A	TB31	19
TB34	1C	TB33	1B
TB36	1E	TB35	1D
TB38	20	TB37	1F
TB40	22	TB39	21
TB42	COM	TB41	23

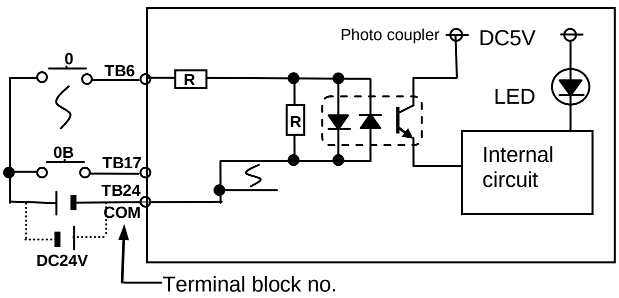
Type



7.2.23 XBC-DP20SU 12 point DC24V input (Source/Sink type)

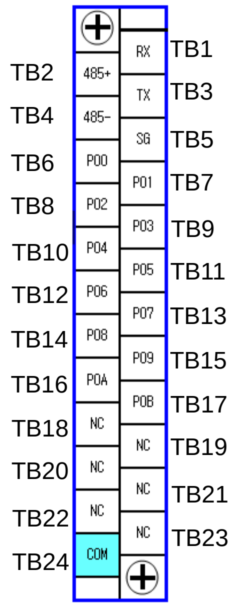
Model / Specification		Main unit
		XBC-DP20SU
Input point		12 point
Insulation method		Photo coupler insulation
Rated input voltage		DC24V
Rated input current		About 4 ㎃ (Contact point 0~3: about 7 ㎃)
Operation voltage range		DC20.4~28.8V (within ripple rate 5%)
On voltage / On current		DC19V or higher / 3 ㎃ or higher
Off voltage / Off current		DC6V or lower / 1 ㎃ or lower
Input resistance		About 5.6 ㏀ (P00~P01: about 1.5 ㏀, P02~P07: about 2.7 ㏀)
Response time	Off → On	1/3/5/10/20/70/100 ㎳ (set by I/O parameter) default: 3 ㎳
	On → Off	
Insulation pressure		AC560Vrms / 3 cycle (altitude 2000m)
Insulation resistance		10 ㏁ or higher by MegOhmMeter
Common method		12 point / COM
Proper cable size		0.3 ㎟
Operation indicator		LED on when Input On
External connection method		24 point terminal block connector (M3 X 6 screw)
Weight		475g

Circuit configuration



No.	Contact	No.	Contact
		TB1	RX
TB2	485+	TB3	TX
TB4	485-	TB5	SG
TB6	00	TB7	01
TB8	02	TB9	03
TB10	04	TB11	05
TB12	06	TB13	07
TB14	08	TB15	09
TB16	0A	TB17	0B
TB18	NC	TB19	NC
TB20	NC	TB21	NC
TB22	NC	TB23	NC
TB24	COM		

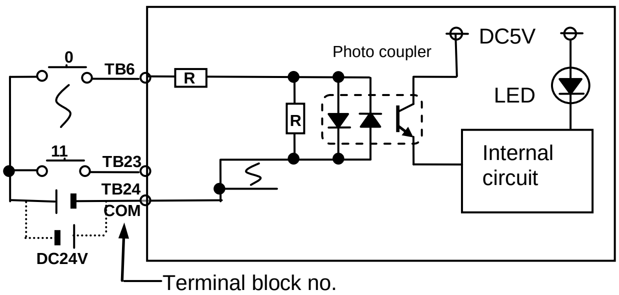
Type



7.2.24 XBC-DP30SU 18 point DC24V input (Source/Sink type)

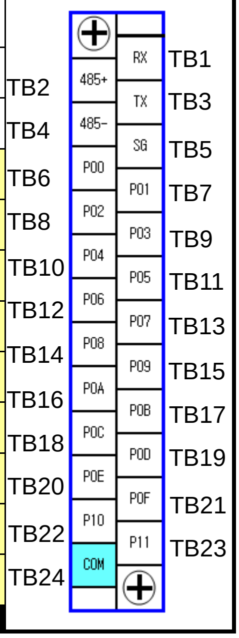
Model / Specification		Main unit XBC-DP30SU
Input point		18 point
Insulation method		Photo coupler insulation
Rated input voltage		DC24V
Rated input current		About 4 ㎃ (point 0~1: about 16 ㎃, point 2~7: about 10mA)
Operation voltage range		DC20.4~28.8V (within ripple rate 5%)
On voltage / On current		DC19V or higher / 3 ㎃ or higher
Off voltage / Off current		DC6V or lower / 1 ㎃ or lower
Input resistance		About 5.6 ㏀ (P00~P01: about 1.5 ㏀, P02~P07: about 2.7 ㏀)
Response time	Off → On	1/3/5/10/20/70/100 ㎳ (set by I/O parameter) default: 3 ㎳
	On → Off	
Insulation pressure		AC560Vrms / 3 cycle (altitude 2000m)
Insulation resistance		10 ㏁ or higher by MegOhmMeter
Common method		18 point / COM
Proper cable size		0.3 ㎟
Operation indicator		LED on when Input On
External connection method		24 point terminal block connector (M3 X 6 screw)
Weight		476g

Circuit configuration



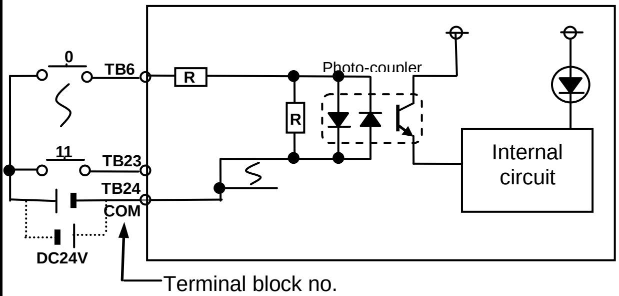
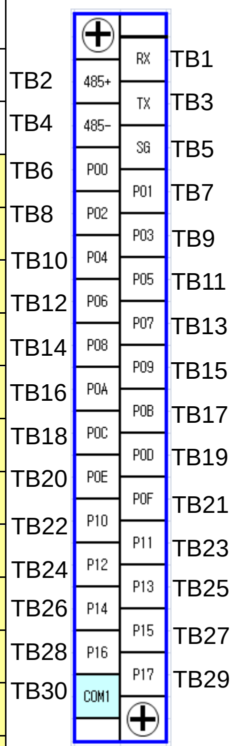
No.	Contact	No.	Contact
		TB1	RX
TB2	485+	TB3	TX
TB4	485-	TB5	SG
TB6	00	TB7	01
TB8	02	TB9	03
TB10	04	TB11	05
TB12	06	TB13	07
TB14	08	TB15	09
TB16	0A	TB17	0B
TB18	0C	TB19	0D
TB20	0E	TB21	0F
TB22	10	TB23	11
TB24	COM		

Type



7.2.25 XBC-DP40SU 24 point DC24V input (Source/Sink Type)

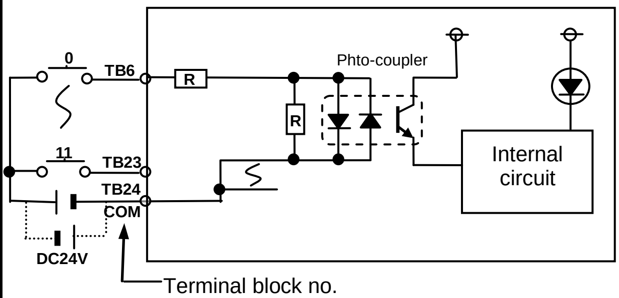
Specification \ Model		Main unit
		XBC-DP40SU
Input point		24 point
Insulation method		Photo coupler insulation
Rated input voltage		DC24V
Rated input current		About 4 ㎃ (point 0~1: about 16 ㎃, point 2~7: about 10 ㎃)
Operation voltage range		DC20.4~28.8V (within ripple rate 5%)
On voltage / On current		DC19V or higher / 3 ㎃ or higher
Off voltage / Off current		DC6V or lower / 1 ㎃ or lower
Input resistance		About 5.6 ㏀ (P00~P01: about 1.5 ㏀, P02~P07: about 2.7 ㏀)
Response time	Off → On	1/3/5/10/20/70/100 ㎳ (set by I/O parameter) default: 3 ㎳
	On → Off	
Insulation pressure		AC560Vrms / 3 cycle (altitude 2000m)
Insulation resistance		10 ㏁ or higher by MegOhmMeter
Common method		24 point / COM
Proper cable size		0.3 ㎟
Operation indicator		LED on when Input On
External connection method		30 point terminal block connector (M3 X 6 screw)
Weight		578g

Circuit configuration	No.	Contact	No.	Contact	Type
			TB1	RX	
	TB2	485+	TB3	TX	
	TB4	485-	TB5	SG	
	TB6	00	TB7	01	
	TB8	02	TB9	03	
	TB10	04	TB11	05	
	TB12	06	TB13	07	
	TB14	08	TB15	09	
	TB16	0A	TB17	0B	
	TB18	0C	TB19	0D	
	TB20	0E	TB21	0F	
	TB22	10	TB23	11	
	TB24	12	TB25	13	
	TB26	14	TB27	15	
	TB28	16	TB29	17	
	TB30	COM			

7.2.26 XBC-DP60SU 36 point DC24V input (Source/Sink Type)

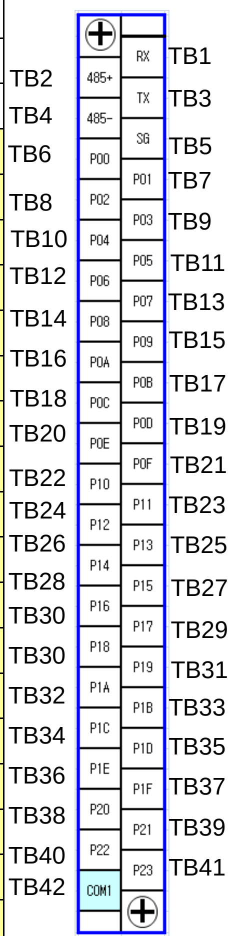
Specification \ Model		Main unit XBC-DP60SU
Input point		36 point
Insulation method		Photo coupler insulation
Rated input voltage		DC24V
Rated input current		About 4 ㎃ (point 0~1: about 16 ㎃, point 2~7: about 10 ㎃)
Operation voltage range		DC20.4~28.8V (within ripple rate 5%)
On voltage / On current		DC19V or higher / 3 ㎃ or higher
Off voltage / Off current		DC6V or lower / 1 ㎃ or lower
Input resistance		About 5.6 ㏀ (P00~P01: about 1.5 ㏀, P02~P07: about 2.7 ㏀)
Response time	Off → On	1/3/5/10/20/70/100 ㎳ (set by I/O parameter) default: 3 ㎳
	On → Off	
Insulation pressure		AC560Vrms / 3 cycle (altitude 2000m)
Insulation resistance		10 ㏁ or higher by MegOhmMeter
Common method		36 point / COM
Proper cable size		0.3 ㎟
Operation indicator		LED on when Input On
External connection method		42 point terminal block connector (M3 X 6 screw)
Weight		636g

Circuit configuration



No.	Contact	No.	Contact
		TB1	RX
TB2	485+	TB3	TX
TB4	485-	TB5	SG
TB6	00	TB7	01
TB8	02	TB9	03
TB10	04	TB11	05
TB12	06	TB13	07
TB14	08	TB15	09
TB16	0A	TB17	0B
TB18	0C	TB19	0D
TB20	0E	TB21	0F
TB22	10	TB23	11
TB24	12	TB25	13
TB26	14	TB27	15
TB28	16	TB29	17
TB30	18	TB31	19
TB32	1A	TB33	1B
TB34	1C	TB35	1D
TB36	1E	TB37	1F
TB38	20	TB39	21
TB40	22	TB41	23
TB42	COM		

Type

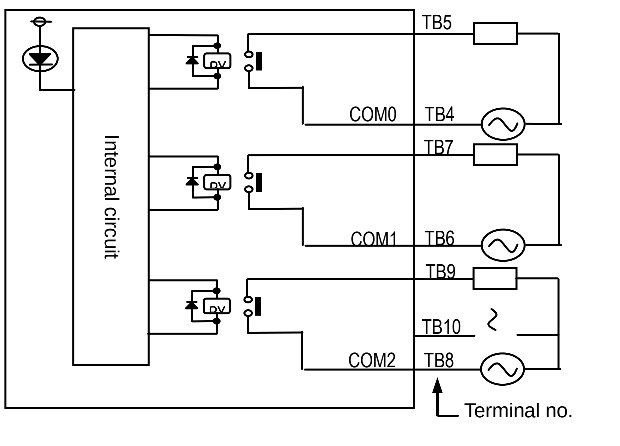


7.3 Main Unit Digital Output Specification

7.3.1 XBC-DR10E 4 point relay output

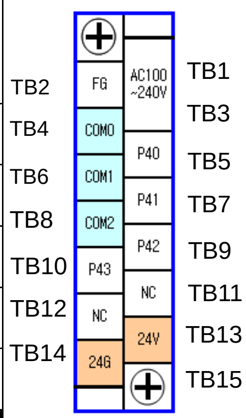
Specification \ Model		Main unit XBC-DR10E
Output point		4 point
Insulation method		Relay insulation
Rated load voltage/current		DC24V 2A (resistive load) / AC220V 2A (COSΦ = 1), 5A/COM
Min. load voltage/current		DC5V / 1 mA
Max. load voltage		AC250V, DC125V
Off leakage current		0.1 mA (AC220V, 60 Hz)
Max. On/Off frequency		3,600 times / hour
Surge absorber		None
Service life	Mechanical	20 million times or more
	Electrical	Rated load voltage / Current 100,000 times or more
		AC200V / 1.5A, AC240V / 1A (COSΦ = 0.7) 100,000 times or more
		AC200V / 1A, AC240V / 0.5A (COSΦ = 0.35) 100,000 times or more
		DC24V / 1A, DC100V / 0.1A (L / R = 7 ms) 100,000 times or more
Response time	Off → On	10 ms or less
	On → Off	12 ms or less
Common method		2 point / COM
Proper cable size		Stranded cable 0.3~0.75 mm² (External diameter 2.8 mm or less)
Operation indicator		LED On when Output On
External connection method		14 point terminal block connector (M3 X 6 screw)
Weight		330g

Circuit configuration



No.	Contact	No.	Contact
		TB1	AC100 ~240V
TB2	FG	TB3	
TB4	COM0	TB5	40
TB6	COM1	TB7	41
TB8	COM2	TB9	42
TB10	43	TB11	NC
TB12	NC	TB13	24V
TB14	24G		

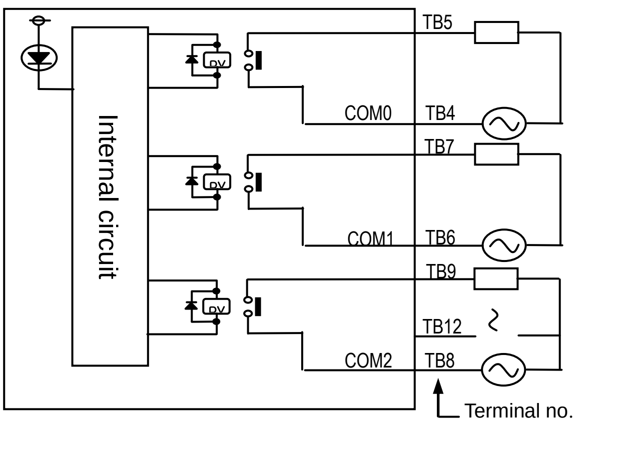
Type



7.3.2 XBC-DR14E 6 point relay output

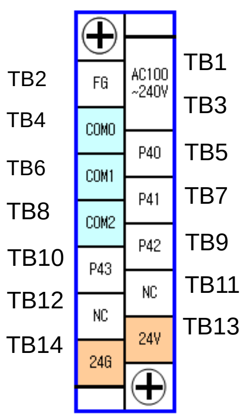
Model / Specification		Main unit
		XBC-DR14E
Output point		6 point
Insulation method		Relay insulation
Rated load voltage/current		DC24V 2A (resistive load) / AC220V 2A (COSΦ = 1), 5A/COM
Min. load voltage/current		DC5V / 1 ㎃
Max. load voltage		AC250V, DC125V
Off leakage current		0.1 ㎃ (AC220V, 60 ㎐)
Max. On/Off frequency		3,600 times / hour
Surge absorber		None
Service life	Mechanical	20 million times or more
	Electrical	Rated load voltage / Current 100,000 times or more
		AC200V / 1.5A, AC240V / 1A (COSΦ = 0.7) 100,000 times or more
		AC200V / 1A, AC240V / 0.5A (COSΦ = 0.35) 100,000 times or more
		DC24V / 1A, DC100V / 0.1A (L / R = 7 ㎳) 100,000 times or more
Response time	Off → On	10 ㎳ or less
	On → Off	12 ㎳ or less
Common method		4 point / COM
Proper cable size		Stranded cable 0.3~0.75 ㎟ (External diameter 2.8 ㎜ or less)
Operation indicator		LED On when Output On
External connection method		14 point terminal block connector (M3 X 6 screw)
Weight		340g

Circuit configuration



No.	Contact	No.	Contact
		TB1	AC100 ~240V
TB2	FG	TB3	
TB4	COM0	TB5	40
TB6	COM1	TB7	41
TB8	COM2	TB9	42
TB10	43	TB11	NC
TB12	NC	TB13	24V
TB14	24G		

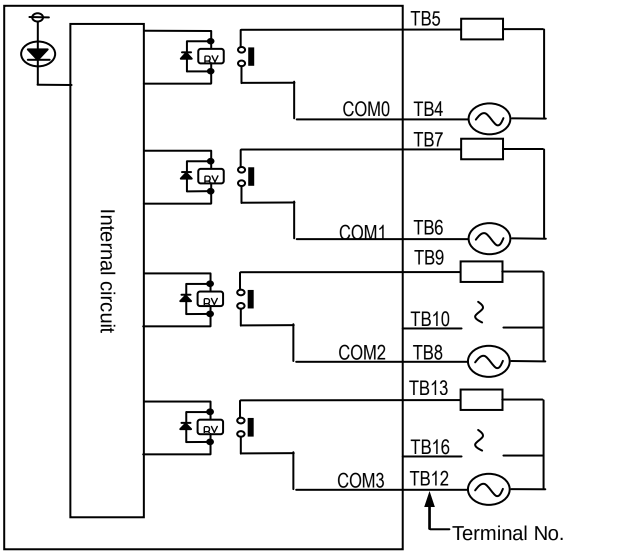
Type



7.3.3 XBC-DR20E 8 point relay output

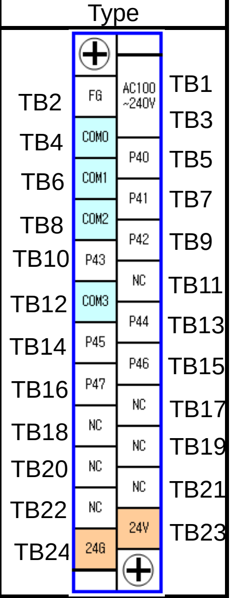
Model / Specification		Main unit XBC-DR20E
Output point		8 point
Insulation method		Relay insulation
Rated load voltage/current		DC24V 2A (resistive load) / AC220V 2A (COSΦ = 1), 5A/COM
Min. load voltage/current		DC5V / 1 ㎃
Max. load voltage		AC250V, DC125V
Off leakage current		0.1 ㎃ (AC220V, 60 ㎐)
Max. On/Off frequency		3,600 times / hour
Surge absorber		None
Service life	Mechanical	20 million times or more
	Electrical	Rated load voltage / Current 100,000 times or more
		AC200V / 1.5A, AC240V / 1A (COSΦ = 0.7) 100,000 times or more
		AC200V / 1A, AC240V / 0.5A (COSΦ = 0.35) 100,000 times or more
		DC24V / 1A, DC100V / 0.1A (L / R = 7 ㎳) 100,000 times or more
Response time	Off → On	10ms or less
	On → Off	12ms or less
Common method		4 point / COM (COM0~COM8), 8 point / COM (COM4~COM5)
Proper cable size		Stranded cable 0.3~0.75 ㎟ (External diameter 2.8 ㎜ or less)
Operation indicator		LED On when Output On
External connection method		24 point terminal block connector (M3 X 6 screw)
Weight		450g

Circuit configuration



No.	Contact	No.	Contact
		TB1	AC100 ~240V
TB2	FG	TB3	
TB4	COM0	TB5	40
TB6	COM1	TB7	41
TB8	COM2	TB9	42
TB10	43	TB11	NC
TB12	COM3	TB13	44
TB14	45	TB15	46
TB16	47	TB17	NC
TB18	NC	TB19	NC
TB20	NC	TB21	NC
TB22	NC	TB23	24V
TB24	24G		

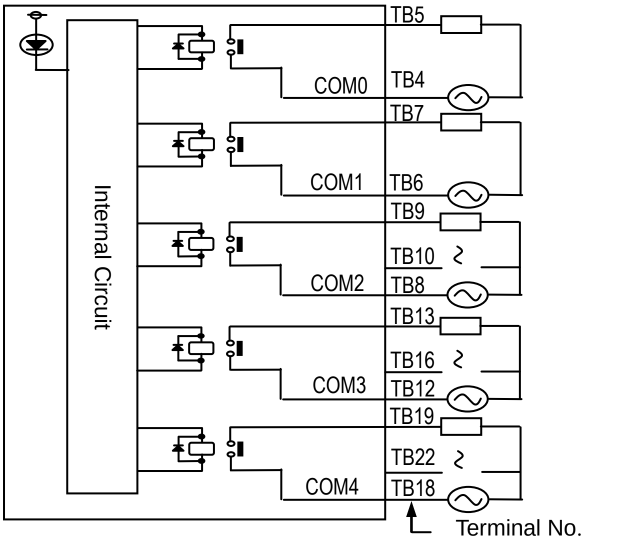
Type



7.3.4 XBC-DR30E 12 point relay output

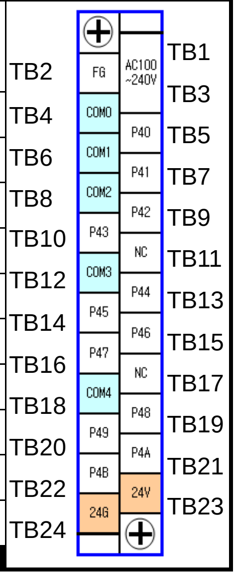
Specification \ Model		Main unit XBC-DR30E
Output point		12 point
Insulation method		Relay insulation
Rated load voltage/current		DC24V 2A (resistive load) / AC220V 2A (COSΦ = 1), 5A/COM
Min. load voltage/current		DC5V / 1 ㎃
Max. load voltage		AC250V, DC125V
Off leakage current		0.1 ㎃ (AC220V, 60 ㎐)
Max. On/Off frequency		3,600 times / hour
Surge absorber		None
Service life	Mechanical	20 million times or more
	Electrical	Rated load voltage / Current 100,000 times or more
		AC200V / 1.5A, AC240V / 1A (COSΦ = 0.7) 100,000 times or more
		AC200V / 1A, AC240V / 0.5A (COSΦ = 0.35) 100,000 times or more
		DC24V / 1A, DC100V / 0.1A (L / R = 7 ㎳) 100,000 times or more
Response time	Off → On	10 ㎳ or less
	On → Off	12 ㎳ or less
Common method		4 point / COM (COM0~COM8), 8 point / COM (COM4~COM5)
Proper cable size		Stranded cable 0.3~0.75 ㎟ (External diameter 2.8 ㎜ or less)
Operation indicator		LED On when Output On
External connection method		2 point terminal block connector (M3 X 6 screw)
Weight		465g

Circuit configuration



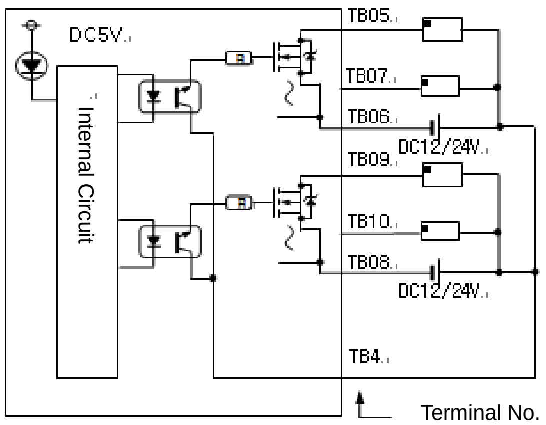
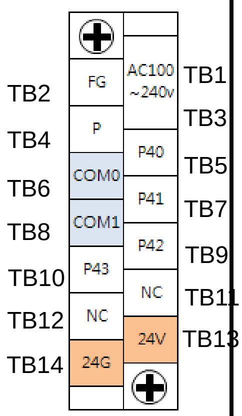
No.	Contact	No.	Contact
		TB1	AC100 ~240V
TB2	FG	TB3	
TB4	COM0	TB5	40
TB6	COM1	TB7	41
TB8	COM2	TB9	42
TB10	43	TB11	NC
TB12	COM3	TB13	44
TB14	45	TB15	46
TB16	47	TB17	NC
TB18	COM4	TB19	48
TB20	49	TB21	4A
TB22	4B	TB23	24V
TB24	24G		

Type



7.3.5 XBC-DN10E 4 point transistor output (Sink type)

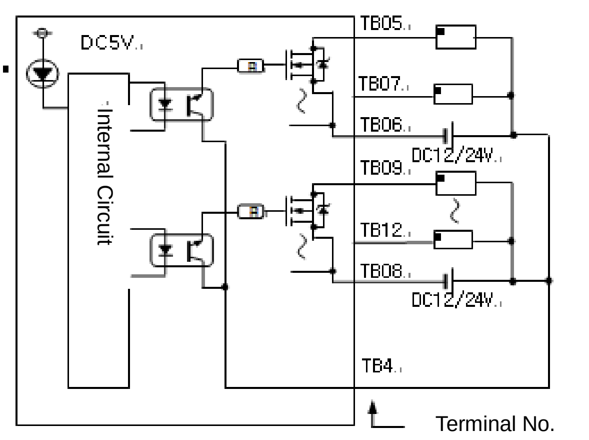
Specification \ Model		Main unit XBC-DN10E
Output point		4 point
Insulation method		Photo coupler insulation
Rated load voltage		DC 12 / 24V
Operation load voltage range		DC 10.2 ~ 26.4V
Max. load current		0.5A / 1 point, 2A / 1COM
Off leakage current		0.1 ㎃ or less
Max. inrush current		4A / 10 ㎳ or less
Max. voltage drop when On		DC 0.4V or less
Surge absorber		Zener diode
Response time	Off → On	1 ㎳ or less
	On → Off	1 ㎳ or less (rated load, resistive load)
Common method		4 point / COM
Proper wire size		Stranded wire 0.3~0.75 ㎟ (external diameter 2.8 ㎜ or less)
External power	Voltage	DC12/24V ± 10% (Ripple voltage 4 Vp-p or less)
	Current	25 ㎃ or less (When connecting DC24V)
Operation indicator		LED On when Output On
External connection method		14 point terminal block connector(M3 X 6 screw)
Weight		313g

Circuit configuration	No.	Contact	No.	Contact	Type
			TB1	AC100 ~240V	
	TB2	FG	TB3		
	TB4	P	TB5	40	
	TB6	COM0	TB7	41	
	TB8	COM1	TB9	42	
	TB10	43	TB11	NC	
	TB12	NC	TB13	24V	
	TB14	24G			

7.3.6 XBC-DN14E 6 point transistor output (Sink type)

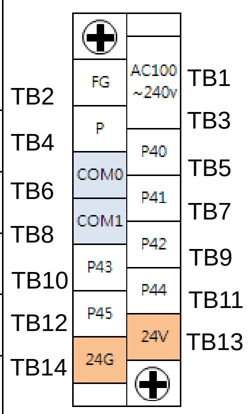
Specification \ Model		Main unit XBC-DN14E
Output point		6 point
Insulation method		Photo coupler insulation
Rated load voltage		DC 12 / 24V
Operation load voltage range		DC 10.2 ~ 26.4V
Max. load current		0.5A / 1 point, 2A / 1COM
Off leakage current		0.1 ㎃ or less
Max. inrush current		4A / 10 ㎳ or less
Max. voltage drop when On		DC 0.4V or less
Surge absorber		Zener diode
Response time	Off → On	1 ㎳ or less
	On → Off	1 ㎳ or less (rated load, resistive load)
Common method		4 point / COM
Proper wire size		Stranded wire 0.3~0.75 ㎟ (external diameter 2.8 ㎜ or less)
External power	Voltage	DC12/24V ± 10% (Ripple voltage 4 Vp-p or less)
	Current	25 ㎃ or less (When connecting DC24V)
Operation indicator		LED On when Output On
External connection method		14 point terminal block connector(M3 X 6 screw)
Weight		315g

Circuit configuration



No.	Contact	No.	Contact
		TB1	AC100 ~240V
TB2	FG	TB3	
TB4	P	TB5	40
TB6	COM0	TB7	41
TB8	COM1	TB9	42
TB10	43	TB11	44
TB12	45	TB13	24V
TB14	24G		

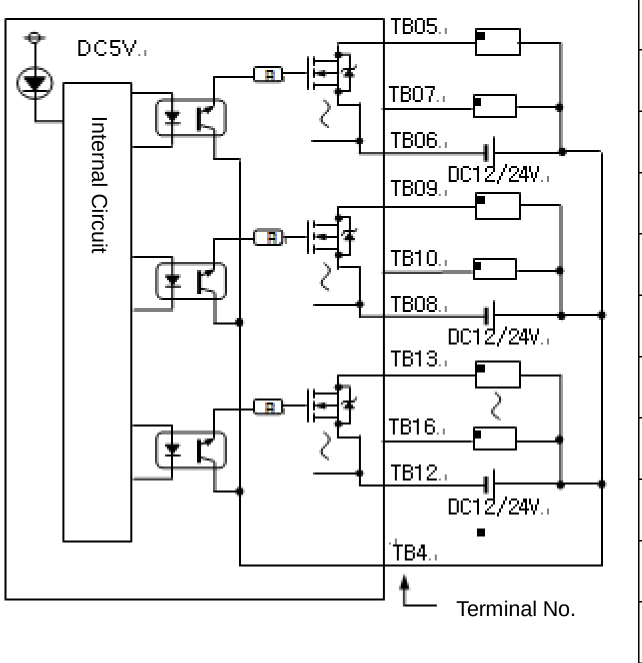
Type



7.3.7 XBC-DN20E 8 point transistor output (Sink type)

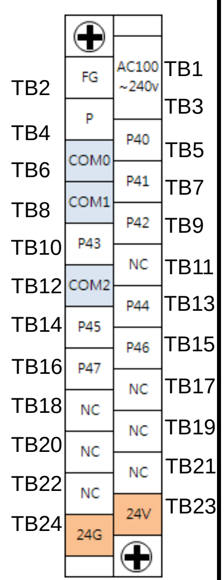
Specification \ Model		Main unit XBC-DN20E
Output point		8 point
Insulation method		Photo coupler insulation
Rated load voltage		DC 12 / 24V
Operation load voltage range		DC 10.2 ~ 26.4V
Max. load current		0.5A / 1 point, 2A / 1COM
Off leakage current		0.1 ㎃ or less
Max. inrush current		4A / 10 ㎳ or less
Max. voltage drop when On		DC 0.4V or less
Surge absorber		Zener diode
Response time	Off → On	1 ㎳ or less
	On → Off	1 ㎳ or less (rated load, resistive load)
Common method		4 point / COM
Proper wire size		Stranded wire 0.3~0.75 ㎟ (external diameter 2.8 ㎜ or less)
External power	Voltage	DC12/24V ± 10% (Ripple voltage 4 Vp-p or less)
	Current	25 ㎃ or less (When connecting DC24V)
Operation indicator		LED On when Output On
External connection method		24 point terminal block connector(M3 X 6 screw)
Weight		418g

Circuit configuration



No.	Contact	No.	Contact
		TB1	AC100 ~240V
TB2	FG	TB3	
TB4	P	TB5	40
TB6	COM0	TB7	41
TB8	COM1	TB9	42
TB10	43	TB11	NC
TB12	COM2	TB13	44
TB14	45	TB15	46
TB16	47	TB17	NC
TB18	NC	TB19	NC
TB20	NC	TB21	NC
TB22	NC	TB23	24V
TB24	24G		

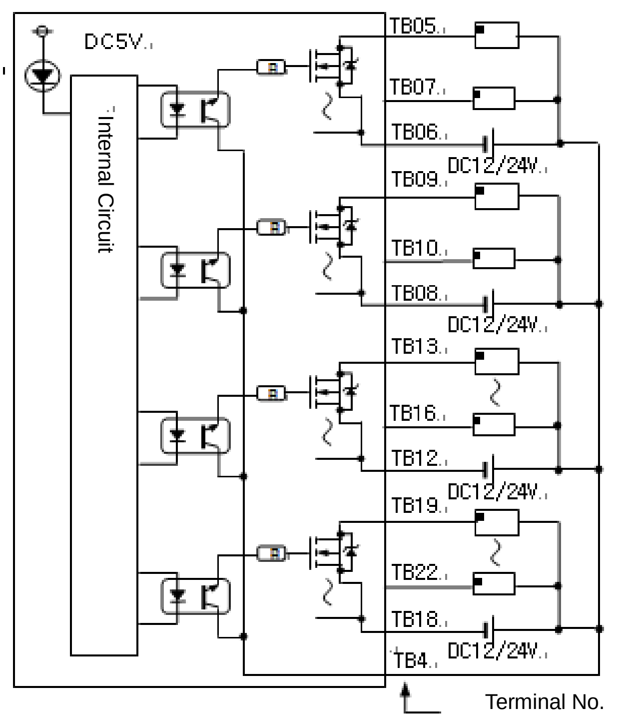
Type



7.3.8 XBC-DN30E 12 point transistor output (Sink type)

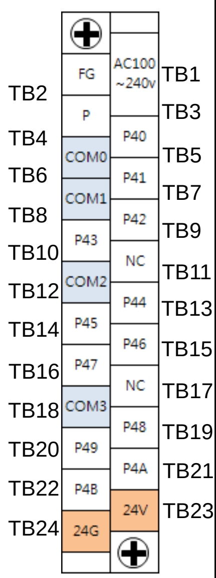
Specification		Main unit XBC-DN30E
Output point		12 point
Insulation method		Photo coupler insulation
Rated load voltage		DC 12 / 24V
Operation load voltage range		DC 10.2 ~ 26.4V
Max. load current		0.5A / 1 point, 2A / 1COM
Off leakage current		0.1 ㎃ or less
Max. inrush current		4A / 10 ㎳ or less
Max. voltage drop when On		DC 0.4V or less
Surge absorber		Zener diode
Response time	Off → On	1 ㎳ or less
	On → Off	1 ㎳ or less (rated load, resistive load)
Common method		4 point / COM
Proper wire size		Stranded wire 0.3~0.75 ㎟ (external diameter 2.8 ㎜ or less)
External power	Voltage	DC12/24V ± 10% (Ripple voltage 4 Vp-p or less)
	Current	25 ㎃ or less (When connecting DC24V)
Operation indicator		LED On when Output On
External connection method		24 point terminal block connector(M3 X 6 screw)
Weight		423g

Circuit configuration



No.	Contact	No.	Contact
		TB1	AC100 ~240V
TB2	FG	TB3	
TB4	P	TB5	40
TB6	COM0	TB7	41
TB8	COM1	TB9	42
TB10	43	TB11	NC
TB12	COM2	TB13	44
TB14	45	TB15	46
TB16	47	TB17	NC
TB18	COM3	TB19	48
TB20	49	TB21	4A
TB22	4B	TB23	24V
TB24	24G		

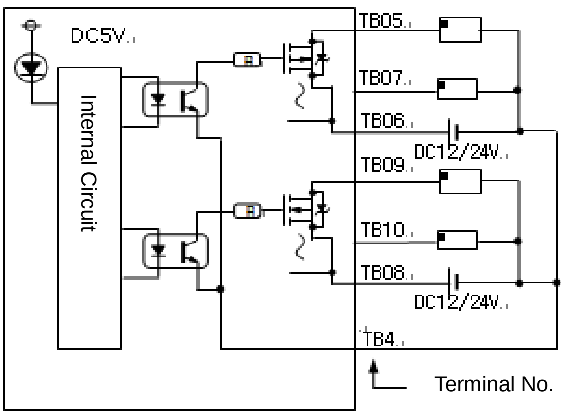
Type



7.3.9 XBC-DP10E 4 point transistor output (Source type)

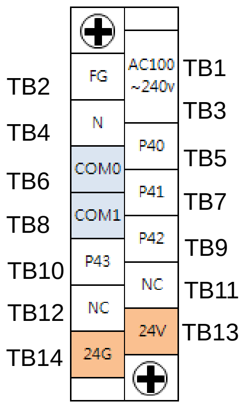
Specification \ Model		Main unit XBC-DP10E
Output point		4 point
Insulation method		Photo coupler insulation
Rated load voltage		DC 12 / 24V
Operation load voltage range		DC 10.2 ~ 26.4V
Max. load current		0.5A / 1 point, 2A / 1COM
Off leakage current		0.1 ㎃ or less
Max. inrush current		4A / 10 ㎳ or less
Max. voltage drop when On		DC 0.4V or less
Surge absorber		Zener diode
Response time	Off → On	1 ㎳ or less
	On → Off	1 ㎳ or less (rated load, resistive load)
Common method		4 point / COM
Proper wire size		Stranded wire 0.3~0.75 ㎟ (external diameter 2.8 ㎜ or less)
External power	Voltage	DC12/24V ± 10% (Ripple voltage 4 Vp-p or less)
	Current	25 ㎃ or less (When connecting DC24V)
Operation indicator		LED On when Output On
External connection method		14 point terminal block connector(M3 X 6 screw)
Weight		313g

Circuit configuration



No.	Contact	No.	Contact
		TB1	AC100 ~240V
TB2	FG	TB3	
TB4	N	TB5	40
TB6	COM0	TB7	41
TB8	COM1	TB9	42
TB10	43	TB11	NC
TB12	NC	TB13	24V
TB14	24G		

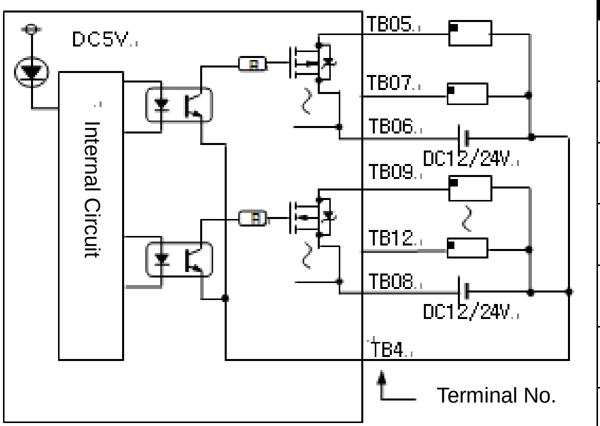
Type



7.3.10 XBC-DP14E 6 point transistor output (Source type)

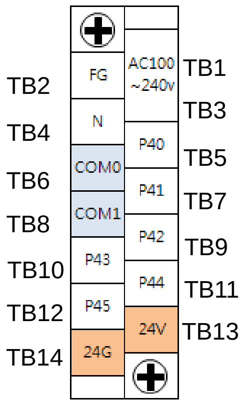
Specification \ Model		Main unit
		XBC-DP14E
Output point		6 point
Insulation method		Photo coupler insulation
Rated load voltage		DC 12 / 24V
Operation load voltage range		DC 10.2 ~ 26.4V
Max. load current		0.5A / 1 point, 2A / 1COM
Off leakage current		0.1 ㎃ or less
Max. inrush current		4A / 10 ㎳ or less
Max. voltage drop when On		DC 0.4V or less
Surge absorber		Zener diode
Response time	Off → On	1 ㎳ or less
	On → Off	1 ㎳ or less (rated load, resistive load)
Common method		4 point / COM
Proper wire size		Stranded wire 0.3~0.75 ㎟ (external diameter 2.8 ㎜ or less)
External power	Voltage	DC12/24V ± 10% (Ripple voltage 4 Vp-p or less)
	Current	25 ㎃ or less (When connecting DC24V)
Operation indicator		LED On when Output On
External connection method		14 point terminal block connector(M3 X 6 screw)
Weight		315g

Circuit configuration



No.	Contact	No.	Contact
		TB1	AC100 ~240V
TB2	FG	TB3	
TB4	N	TB5	40
TB6	COM0	TB7	41
TB8	COM1	TB9	42
TB10	43	TB11	44
TB12	45	TB13	24V
TB14	24G		

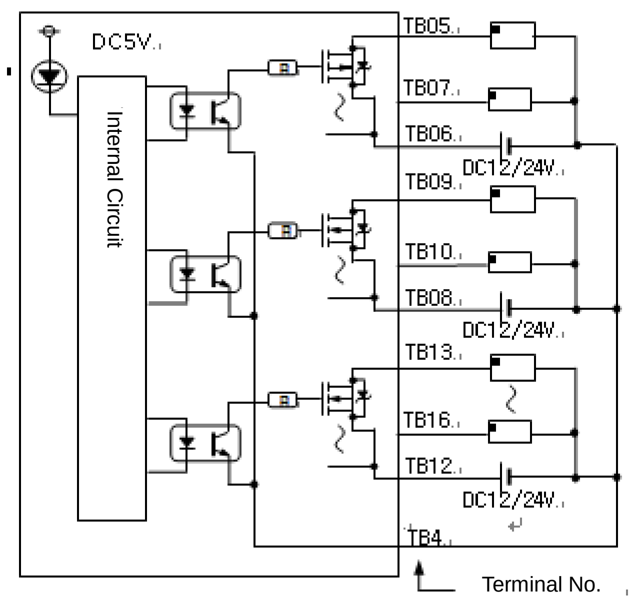
Type



7.3.11 XBC-DP20E 8 point transistor output (Source type)

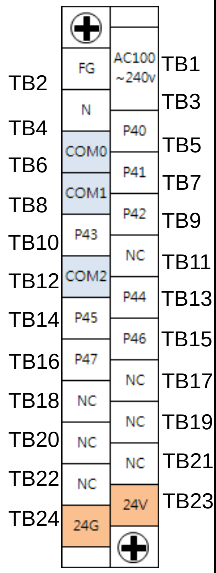
Specification \ Model		Main unit XBC-DP20E
Output point		8 point
Insulation method		Photo coupler insulation
Rated load voltage		DC 12 / 24V
Operation load voltage range		DC 10.2 ~ 26.4V
Max. load current		0.5A / 1 point, 2A / 1COM
Off leakage current		0.1 ㎃ or less
Max. inrush current		4A / 10 ㎳ or less
Max. voltage drop when On		DC 0.4V or less
Surge absorber		Zener diode
Response time	Off → On	1 ㎳ or less
	On → Off	1 ㎳ or less (rated load, resistive load)
Common method		4 point / COM
Proper wire size		Stranded wire 0.3~0.75 ㎟ (external diameter 2.8 ㎜ or less)
External power	Voltage	DC12/24V ± 10% (Ripple voltage 4 Vp-p or less)
	Current	25 ㎃ or less (When connecting DC24V)
Operation indicator		LED On when Output On
External connection method		24 point terminal block connector(M3 X 6 screw)
Weight		418g

Circuit configuration



No.	Contact	No.	Contact
		TB1	AC100 ~240V
TB2	FG	TB3	
TB4	N	TB5	40
TB6	COM0	TB7	41
TB8	COM1	TB9	42
TB10	43	TB11	NC
TB12	COM2	TB13	44
TB14	45	TB15	46
TB16	47	TB17	NC
TB18	NC	TB19	NC
TB20	NC	TB21	NC
TB22	NC	TB23	24V
TB24	24G		

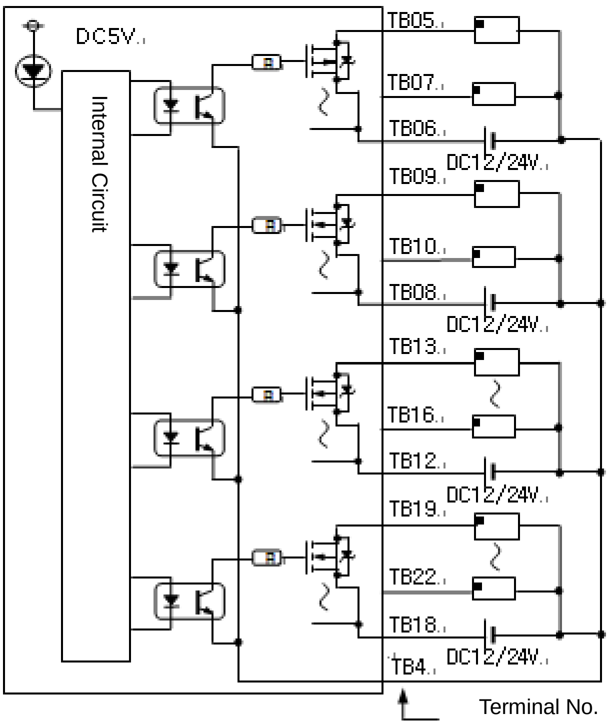
Type



7.3.12 XBC-DP30E 12 point transistor output (Source type)

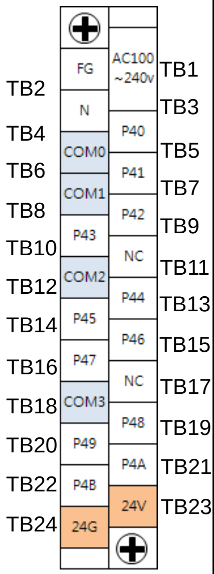
Specification \ Model		Main unit
		XBC-DP30E
Output point		12 point
Insulation method		Photo coupler insulation
Rated load voltage		DC 12 / 24V
Operation load voltage range		DC 10.2 ~ 26.4V
Max. load current		0.5A / 1 point, 2A / 1COM
Off leakage current		0.1 ㎃ or less
Max. inrush current		4A / 10 ㎳ or less
Max. voltage drop when On		DC 0.4V or less
Surge absorber		Zener diode
Response time	Off → On	1 ㎳ or less
	On → Off	1 ㎳ or less (rated load, resistive load)
Common method		4 point / COM
Proper wire size		Stranded wire 0.3~0.75 ㎟ (external diameter 2.8 ㎜ or less)
External power	Voltage	DC12/24V ± 10% (Ripple voltage 4 Vp-p or less)
	Current	25 ㎃ or less (When connecting DC24V)
Operation indicator		LED On when Output On
External connection method		24 point terminal block connector(M3 X 6 screw)
Weight		423g

Circuit configuration



No.	Contact	No.	Contact
		TB1	AC100 ~240V
TB2	FG	TB3	
TB4	N	TB5	40
TB6	COM0	TB7	41
TB8	COM1	TB9	42
TB10	43	TB11	NC
TB12	COM2	TB13	44
TB14	45	TB15	46
TB16	47	TB17	NC
TB18	COM3	TB19	48
TB20	49	TB21	4A
TB22	4B	TB23	24V
TB24	24G		

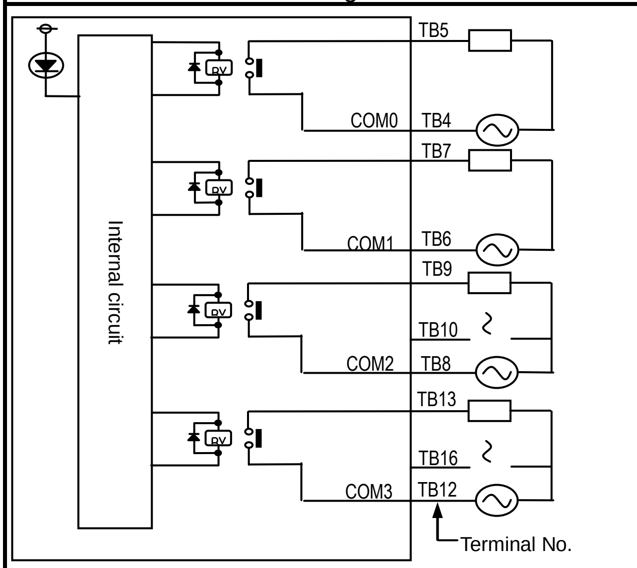
Type



7.3.13 XBC-DR20SU 8 point relay output

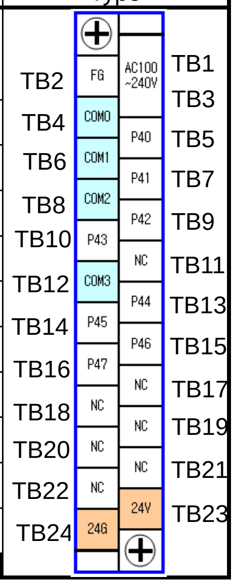
Specification \ Model		Main unit XBC-DR20SU
Output point		8 point
Insulation method		Relay insulation
Rated load voltage/current		DC24V 2A (resistive load) / AC220V 2A (COSΦ = 1), 5A/COM
Min. load voltage/current		DC5V / 1 ㎃
Max. load voltage		AC250V, DC125V
Off leakage current		0.1 ㎃ (AC220V, 60 ㎐)
Max. On/Off frequency		3,600 times / hour
Surge absorber		None
Service life	Mechanical	20 million times or more
	Electrical	Rated load voltage / Current 100,000 times or more
		AC200V / 1.5A, AC240V / 1A (COSΦ = 0.7) 100,000 times or more
		AC200V / 1A, AC240V / 0.5A (COSΦ = 0.35) 100,000 times or more
		DC24V / 1A, DC100V / 0.1A (L / R = 7 ㎳) 100,000 times or more
Response time	Off → On	10ms or less
	On → Off	12ms or less
Common method		4 point / COM (COM0~COM8), 8 point / COM (COM4~COM5)
Proper cable size		Stranded cable 0.3~0.75 ㎟ (External diameter 2.8 ㎜ or less)
Operation indicator		LED On when Output On
External connection method		42 point terminal block connector (M3 X 6 screw)
Weight		450g

Circuit configuration



No.	Contact	No.	Contact
		TB1	AC100 ~240V
TB2	FG	TB3	
TB4	COM0	TB5	40
TB6	COM1	TB7	41
TB8	COM2	TB9	42
TB10	43	TB11	NC
TB12	COM3	TB13	44
TB14	45	TB15	46
TB16	47	TB17	NC
TB18	NC	TB19	NC
TB20	NC	TB21	NC
TB22	NC	TB23	24V
TB24	24G		

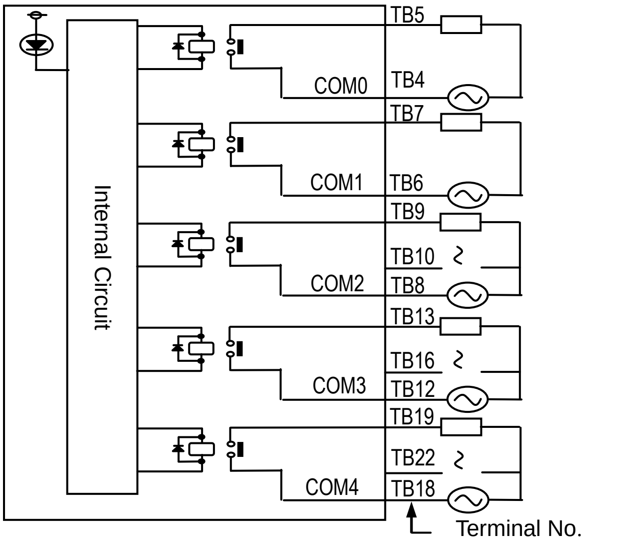
Type



7.3.14 XBC-DR30SU 12 point relay output

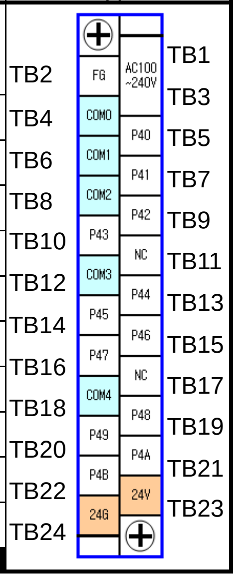
Specification \ Model		Main unit XBC-DR30SU
Output point		12 point
Insulation method		Relay insulation
Rated load voltage/current		DC24V 2A (resistive load) / AC220V 2A (COSΦ = 1), 5A/COM
Min. load voltage/current		DC5V / 1 ㎃
Max. load voltage		AC250V, DC125V
Off leakage current		0.1 ㎃ (AC220V, 60 ㎐)
Max. On/Off frequency		3,600 times / hour
Surge absorber		None
Service life	Mechanical	20 million times or more
	Electrical	Rated load voltage / Current 100,000 times or more
		AC200V / 1.5A, AC240V / 1A (COSΦ = 0.7) 100,000 times or more
		AC200V / 1A, AC240V / 0.5A (COSΦ = 0.35) 100,000 times or more
		DC24V / 1A, DC100V / 0.1A (L / R = 7 ㎳) 100,000 times or more
Response time	Off → On	10 ㎳ or less
	On → Off	12 ㎳ or less
Common method		4 point / COM (COM0~COM8), 8 point / COM (COM4~COM5)
Proper cable size		Stranded cable 0.3~0.75 ㎟ (External diameter 2.8 ㎜ or less)
Operation indicator		LED On when Output On
External connection method		42 point terminal block connector (M3 X 6 screw)
Weight		465g

Circuit configuration



No.	Contact	No.	Contact
		TB1	AC100 ~240V
TB2	FG	TB3	
TB4	COM0	TB5	40
TB6	COM1	TB7	41
TB8	COM2	TB9	42
TB10	43	TB11	NC
TB12	COM3	TB13	44
TB14	45	TB15	46
TB16	47	TB17	NC
TB18	COM4	TB19	48
TB20	49	TB21	4A
TB22	4B	TB23	24V
TB24	24G		

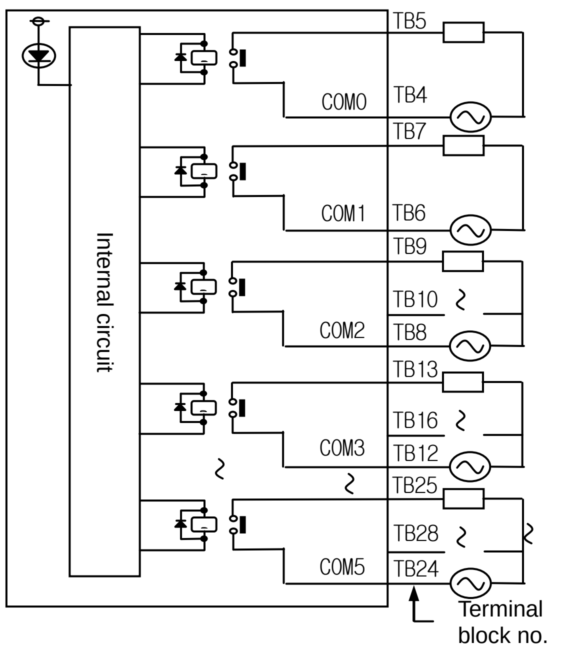
Type



7.3.15 XBC-DR40SU 16 point relay output

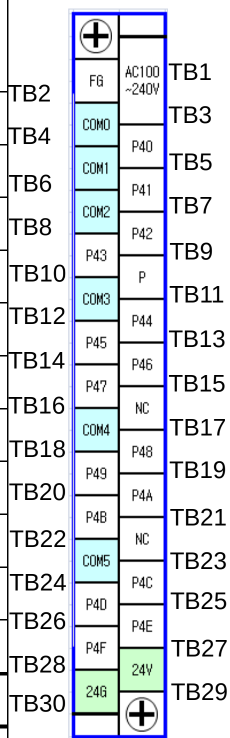
Specification \ Model		Main unit
		XBC-DR40SU
Output point		16 point
Insulation method		Relay insulation
Rated load voltage/current		DC24V 2A (resistive load) / AC220V 2A (COSΦ = 1), 5A/COM
Min. load voltage/current		DC5V / 1 ㎃
Max. load voltage		AC250V, DC125V
Off leakage current		0.1 ㎃ (AC220V, 60 ㎐)
Max. On/Off frequency		3,600 times / hour
Surge absorber		None
Service life	Mechanical	20 million times or more
	Electrical	Rated load voltage / Current 100,000 times or more
		AC200V / 1.5A, AC240V / 1A (COSΦ = 0.7) 100,000 times or more
		AC200V / 1A, AC240V / 0.5A (COSΦ = 0.35) 100,000 times or more
		DC24V / 1A, DC100V / 0.1A (L / R = 7 ㎳) 100,000 times or more
Response time	Off → On	10ms or less
	On → Off	12ms or less
Common method		4 point / COM (COM0~COM8), 8 point / COM (COM4~COM5)
Proper cable size		Stranded cable 0.3~0.75 ㎟ (External diameter 2.8 ㎜ or less)
Operation indicator		LED On when Output On
External connection method		30 point terminal block connector (M3 X 6 screw)
Weight		594g

Circuit configuration



No.	Contact	No.	Contact
		TB1	AC100 ~240V
TB2	FG	TB3	
TB4	COM0	TB5	40
TB6	COM1	TB7	41
TB8	COM2	TB9	42
TB10	43	TB11	P
TB12	COM3	TB13	44
TB14	45	TB15	46
TB16	47	TB17	NC
TB18	COM4	TB19	48
TB20	49	TB21	4A
TB22	4B	TB23	NC
TB24	COM5	TB25	4C
TB26	4D	TB27	4E
TB28	4F	TB29	24V
TB30	24G		

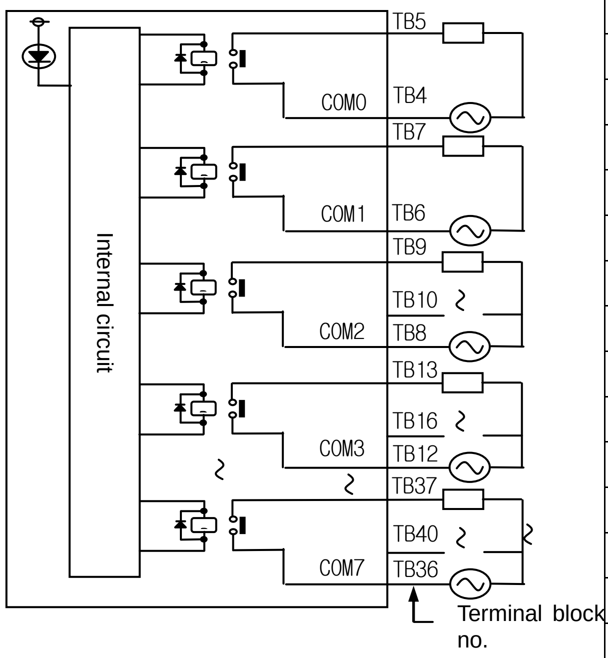
Type



7.3.16 XBC-DR60SU 24 point relay output

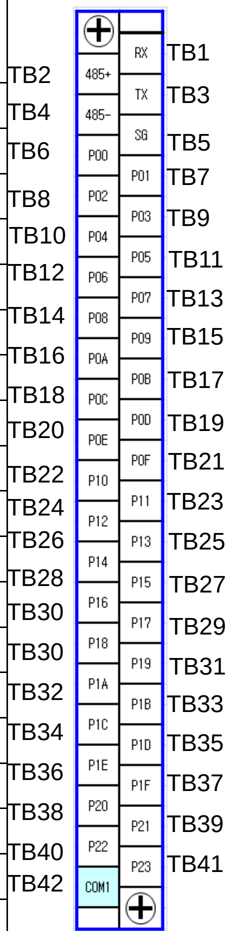
Specification \ Model		Main unit XBC-DR60SU
Output point		24 point
Insulation method		Relay insulation
Rated load voltage/current		DC24V 2A (resistive load) / AC220V 2A (COSΦ = 1), 5A/COM
Min. load voltage/current		DC5V / 1 ㎃
Max. load voltage		AC250V, DC125V
Off leakage current		0.1 ㎃ (AC220V, 60 ㎐)
Max. On/Off frequency		3,600 times / hour
Surge absorber		None
Service life	Mechanical	20 million times or more
	Electrical	Rated load voltage / Current 100,000 times or more
		AC200V / 1.5A, AC240V / 1A (COSΦ = 0.7) 100,000 times or more
		AC200V / 1A, AC240V / 0.5A (COSΦ = 0.35) 100,000 times or more
		DC24V / 1A, DC100V / 0.1A (L / R = 7 ㎳) 100,000 times or more
Response time	Off → On	10ms or less
	On → Off	12ms or less
Common method		4 point / COM (COM0~COM8), 8 point / COM (COM4~COM5)
Proper cable size		Stranded cable 0.3~0.75 ㎟ (External diameter 2.8 ㎜ or less)
Operation indicator		LED On when Output On
External connection method		30 point terminal block connector (M3 X 6 screw)
Weight		804g

Circuit configuration



No.	Contact	No.	Contact
		TB1	AC100 ~240V
TB2	FG	TB3	
TB4	COM0	TB5	40
TB6	COM1	TB7	41
TB8	COM2	TB9	42
TB10	43	TB11	P
TB12	COM3	TB13	44
TB14	45	TB15	46
TB16	47	TB17	NC
TB18	COM4	TB19	48
TB20	49	TB21	4A
TB22	4B	TB23	NC
TB24	COM5	TB25	4C
TB26	4D	TB27	4E
TB28	4F	TB29	NC
TB30	COM6	TB31	50
TB32	51	TB33	52
TB34	53	TB35	NC
TB36	COM7	TB37	54
TB38	55	TB39	56
TB40	57	TB41	24V
TB42	24G		

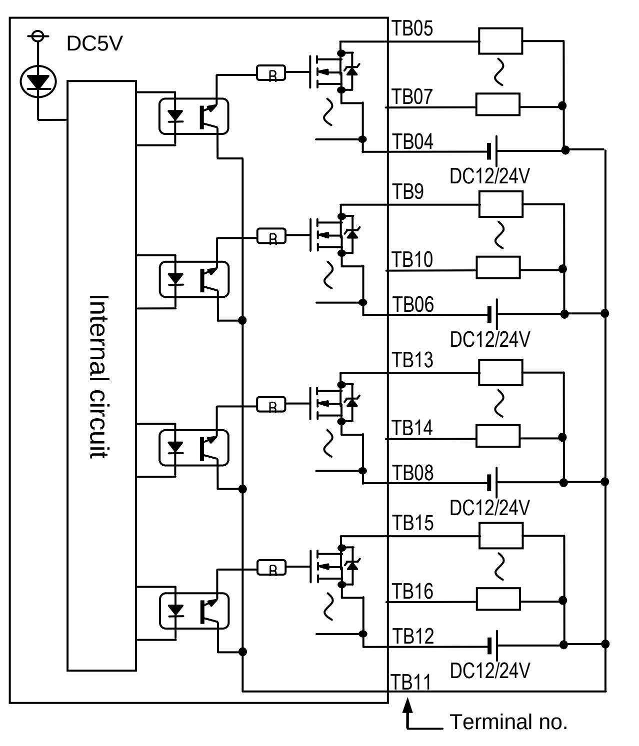
Type



7.3.17 XBC-DN20S(U) 8 point transistor output (Sink type)

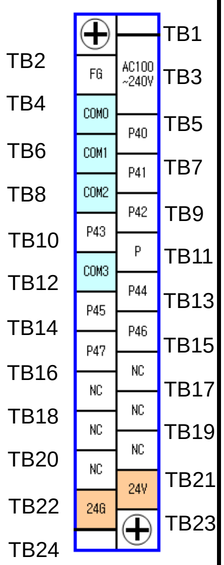
Specification \ Model		Main unit XBC-DN20S(U)
Output point		8 point
Insulation method		Photo coupler insulation
Rated load voltage		DC 12 / 24V
Operation load voltage range		DC 10.2 ~ 26.4V
Max. load current		0.5A / 1 point, 2A / 1COM
Off leakage current		0.1 ㎃ or less
Max. inrush current		4A / 10 ㎳ or less
Max. voltage drop when On		DC 0.4V or less
Surge absorber		Zener diode
Response time	Off → On	1 ㎳ or less
	On → Off	1 ㎳ or less (rated load, resistive load)
Common method		4 point / COM
Proper wire size		Stranded wire 0.3~0.75 ㎟ (external diameter 2.8 ㎜ or less)
External power	Voltage	DC12/24V ± 10% (Ripple voltage 4 Vp-p or less)
	Current	25 ㎃ or less (When connecting DC24V)
Operation indicator		LED On when Output On
External connection method		24 point terminal block connector(M3 X 6 screw)
Weight		470g

Circuit configuration



No.	Contact	No.	Contact
		TB1	AC100 ~240V
TB2	FG	TB3	
TB4	COM0	TB5	40
TB6	COM1	TB7	41
TB8	COM2	TB9	42
TB10	43	TB11	P
TB12	COM3	TB13	44
TB14	45	TB15	46
TB16	47	TB17	NC
TB18	NC	TB19	NC
TB20	NC	TB21	NC
TB22	NC	TB23	24V
TB24	24G		

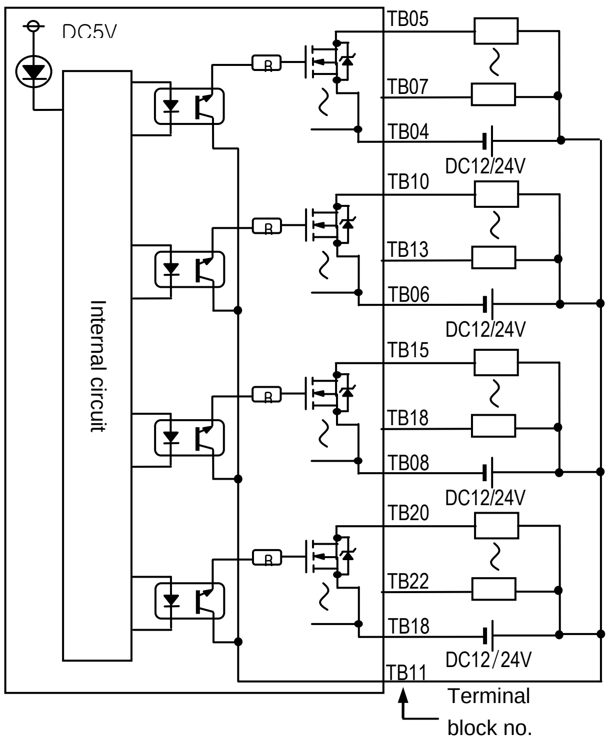
Type



7.3.18 XBC-DN30S(U) 12 point transistor output (Sink type)

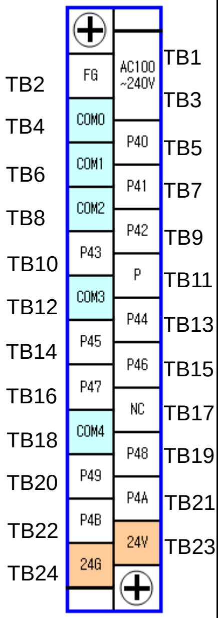
Specification \ Model		Main unit XBC-DN30S(U)
Output point		12 point
Insulation method		Photo coupler insulation
Rated load voltage		DC 12 / 24V
Operation load voltage range		DC 10.2 ~ 26.4V
Max. load current		0.5A / 1 point, 2A / 1COM
Off leakage current		0.1 ㎃ (AC220V, 60 ㎐)
Max. inrush current		4A / 10 ㎳ or less
Max. voltage drop when On		DC 0.4V or less
Surge absorber		Zener diode
Response time	Off → On	1 ㎳ or less
	On → Off	1 ㎳ or less (rated load, resistive load)
Common method		4 point / COM
Proper wire size		Stranded wire 0.3~0.75 ㎟ (external diameter 2.8 ㎜ or less)
External power	Voltage	DC12/24V ± 10% (Ripple voltage 4 Vp-p or less)
	Current	25 ㎃ or less (When connecting DC24V)
Operation indicator		LED On when Output On
External connection method		24 point terminal block connector(M3 X 6 screw)
Weight		475g

Circuit configuration



No.	Contact	No.	Contact
		TB1	AC100 ~240V
TB2	FG	TB3	
TB4	COM0	TB5	40
TB6	COM1	TB7	41
TB8	COM2	TB9	42
TB10	43	TB11	P
TB12	COM3	TB13	44
TB14	45	TB15	46
TB16	47	TB17	NC
TB18	COM4	TB19	48
TB20	49	TB21	4A
TB22	4B	TB23	24V
TB24	24G		

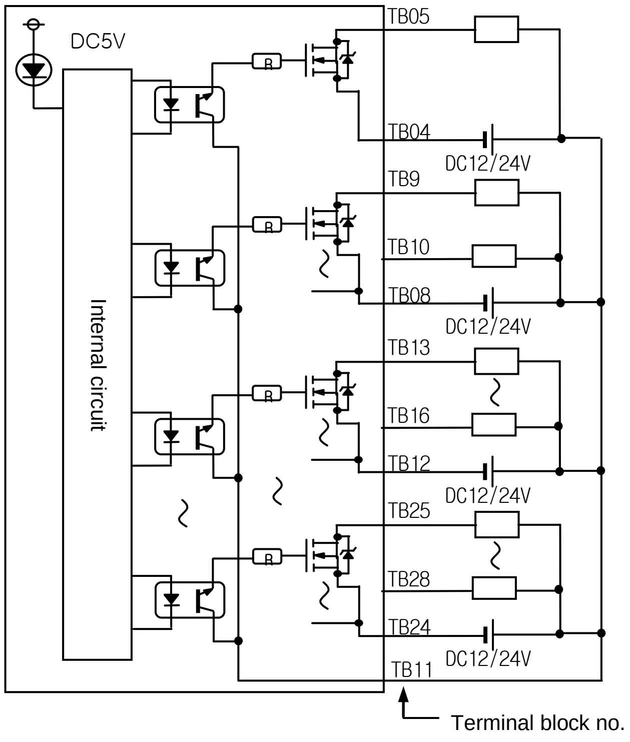
Type



7.3.19 XBC-DN40SU 16 point TR output (Sink type)

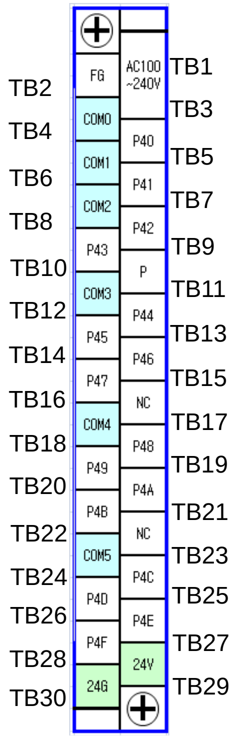
Specification \ Model		Main unit XBC-DN40SU
Output point		16 point
Insulation method		Photo-coupler insulation
Rated load voltage		DC 12 / 24V
Load voltage range		DC 10.2 ~ 26.4V
Max. load current		0.5A / 1point, 2A / 1COM (P40, P41: 0.1A / 1point)
Off leakage current		0.1 ㎃ or less
Max. inrush current		4A / 10 ㎳ or less
Max. voltage drop when On		DC 0.4V or less
Surge killer		Zener diode
Response time	Off → On	1 ㎳ or less
	On → Off	1 ㎳ or less (rated load, resistive load)
Common method		4 point / COM
Proper cable size		Stranded cable 0.3~0.75 ㎟ (External diameter 2.8 ㎜ or less)
External supply power	Voltage	DC12/24V ± 10% (ripple voltage 4 Vp-p or less)
	Current	25 ㎃ or less (when connecting DC24V)
Operation indicator		LED On When Output On
External connection method		30 point terminal block connector (M3 X 6 screw)
Weight		578g

Circuit configuration



No.	Contact	No.	Contact
TB2	FG	TB1	AC100 ~240V
TB4	COM0	TB3	
TB6	COM1	TB5	40
TB8	COM2	TB7	41
TB10	43	TB9	42
TB12	COM3	TB11	P
TB14	45	TB13	44
TB16	47	TB15	46
TB18	COM4	TB17	NC
TB20	49	TB19	48
TB22	4B	TB21	4A
TB24	COM5	TB23	NC
TB26	4D	TB25	4C
TB28	4F	TB27	4E
TB30	24G	TB29	24V

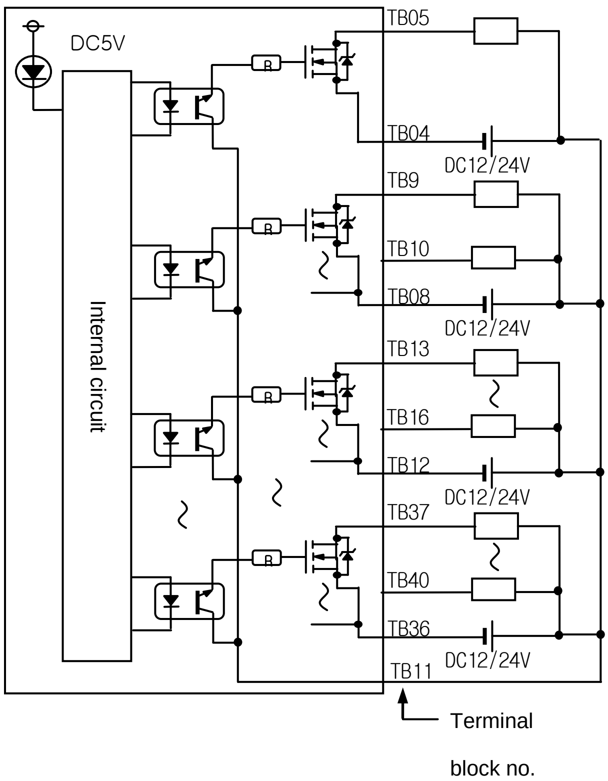
Type



7.3.20 XBC-DN60SU 24 point TR output (Sink type)

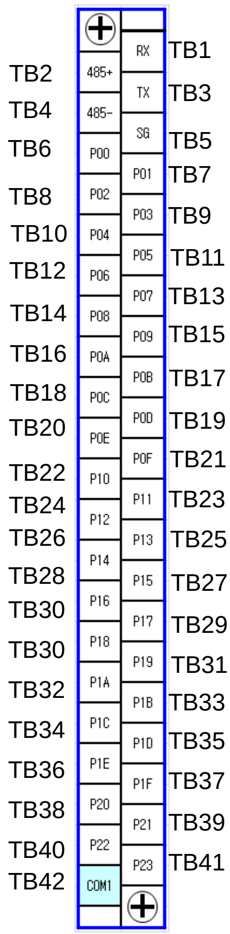
Specification \ Model		Main unit XBC-DN60SU
Output point		24 point
Insulation method		Photo-coupler insulation
Rated load voltage		DC 12 / 24V
Load voltage range		DC 10.2 ~ 26.4V
Max. load current		0.5A / 1point, 2A / 1COM (P40, P41: 0.1A / 1point)
Off leakage current		0.1 ㎃ or less
Max. inrush current		4A / 10 ㎳ or less
Max. voltage drop when On		DC 0.4V or less
Surge killer		Zener diode
Response time	Off → On	1 ㎳ or less
	On → Off	1 ㎳ or less (rated load, resistive load)
Common method		4 point / COM
Proper cable size		Stranded cable 0.3~0.75 ㎟ (External diameter 2.8 ㎜ or less)
External supply power	Voltage	DC12/24V ± 10% (ripple voltage 4 Vp-p or less)
	Current	25 ㎃ or less (when connecting DC24V)
Operation indicator		LED On When Output On
External connection method		42 point terminal block connector (M3 X 6 screw)
Weight		636g

Circuit configuration



No.	Contact	No.	Contact
		TB1	AC100 ~240V
TB2	FG	TB3	
TB4	COM0	TB5	40
TB6	COM1	TB7	41
TB8	COM2	TB9	42
TB10	43	TB11	P
TB12	COM3	TB13	44
TB14	45	TB15	46
TB16	47	TB17	NC
TB18	COM4	TB19	48
TB20	49	TB21	4A
TB22	4B	TB23	NC
TB24	COM5	TB25	4C
TB26	4D	TB27	4E
TB28	4F	TB29	NC
TB30	COM6	TB31	50
TB32	51	TB33	52
TB34	53	TB35	NC
TB36	COM7	TB37	54
TB38	55	TB39	56
TB40	57	TB41	24V
TB42	24G		

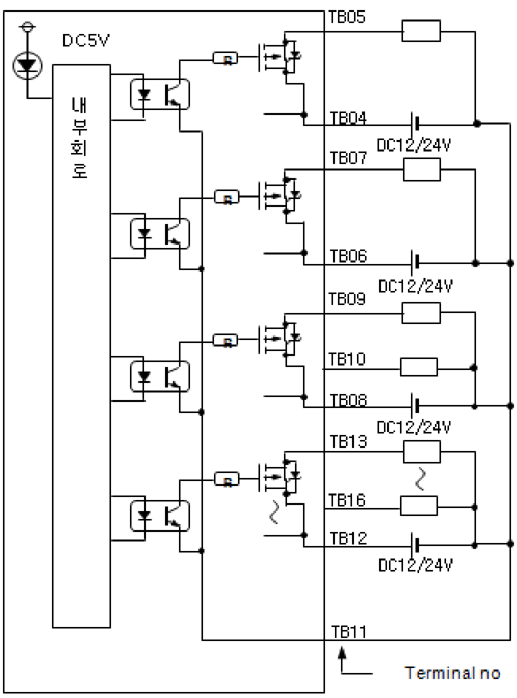
Type



7.3.21 XBC-DP20SU 8 point transistor output (Source type)

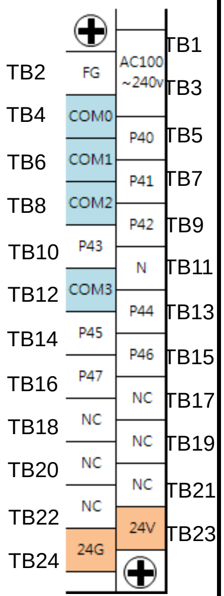
Specification \ Model		Main unit XBC-DP20SU
Output point		8 point
Insulation method		Photo coupler insulation
Rated load voltage		DC 12 / 24V
Operation load voltage range		DC 10.2 ~ 26.4V
Max. load current		0.5A / 1point, 2A / 1COM (P40, P41: 0.1A / 1point)
Off leakage current		0.1 ㎃ or less
Max. inrush current		4A / 10 ㎳ or less
Max. voltage drop when On		DC 0.4V or less
Surge absorber		Zener diode
Response time	Off → On	1 ㎳ or less
	On → Off	1 ㎳ or less (rated load, resistive load)
Common method		4 point / COM
Proper wire size		Stranded wire 0.3~0.75 ㎟ (external diameter 2.8 ㎜ or less)
External power	Voltage	DC12/24V ± 10% (Ripple voltage 4 Vp-p or less)
	Current	25 ㎃ or less (When connecting DC24V)
Operation indicator		LED On when Output On
External connection method		24 point terminal block connector(M3 X 6 screw)
Weight		470g

Circuit configuration



No.	Contact	No.	Contact
		TB1	AC100 ~240V
TB2	FG	TB3	
TB4	COM0	TB5	40
TB6	COM1	TB7	41
TB8	COM2	TB9	42
TB10	43	TB11	P
TB12	COM3	TB13	44
TB14	45	TB15	46
TB16	47	TB17	NC
TB18	NC	TB19	NC
TB20	NC	TB21	NC
TB22	NC	TB23	24V
TB24	24G		

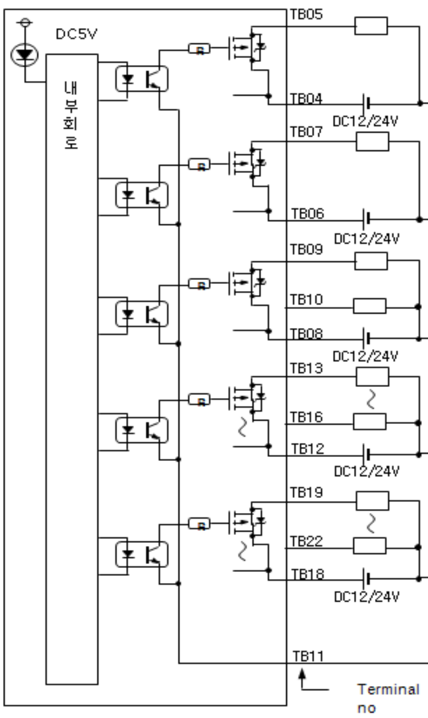
Type



7.3.22 XBC-DP30SU 12 point transistor output (Source type)

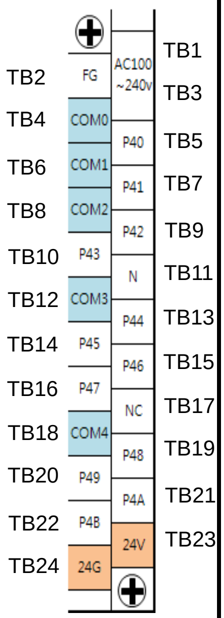
Specification \ Model		Main unit XBC-DP30SU
Output point		12 point
Insulation method		Photo coupler insulation
Rated load voltage		DC 12 / 24V
Operation load voltage range		DC 10.2 ~ 26.4V
Max. load current		0.5A / 1point, 2A / 1COM (P40, P41: 0.1A / 1point)
Off leakage current		0.1 ㎃ (AC220V, 60 ㎐)
Max. inrush current		4A / 10 ㎳ or less
Max. voltage drop when On		DC 0.4V or less
Surge absorber		Zener diode
Response time	Off → On	1 ㎳ or less
	On → Off	1 ㎳ or less (rated load, resistive load)
Common method		4 point / COM
Proper wire size		Stranded wire 0.3~0.75 ㎟ (external diameter 2.8 ㎜ or less)
External power	Voltage	DC12/24V ± 10% (Ripple voltage 4 Vp-p or less)
	Current	25 ㎃ or less (When connecting DC24V)
Operation indicator		LED On when Output On
External connection method		24 point terminal block connector(M3 X 6 screw)
Weight		475g

Circuit configuration



No.	Contact	No.	Contact
		TB1	AC100 ~240V
TB2	FG	TB3	
TB4	COM0	TB5	40
TB6	COM1	TB7	41
TB8	COM2	TB9	42
TB10	43	TB11	P
TB12	COM3	TB13	44
TB14	45	TB15	46
TB16	47	TB17	NC
TB18	COM4	TB19	48
TB20	49	TB21	4A
TB22	4B	TB23	24V
TB24	24G		

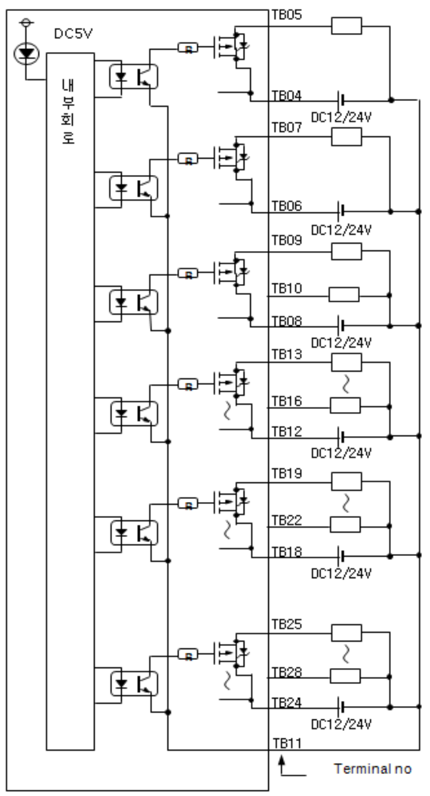
Type



7.3.23 XBC-DP40SU 16 point TR output (Source type)

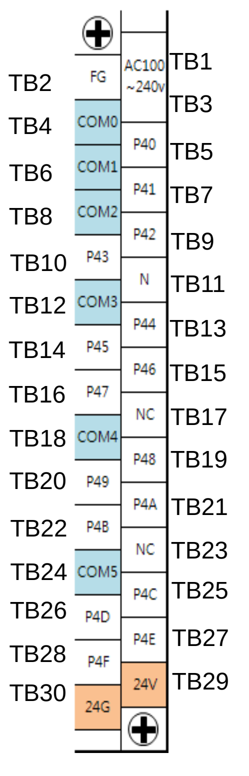
Specification \ Model		Main unit XBC-DP40SU
Output point		16 point
Insulation method		Photo-coupler insulation
Rated load voltage		DC 12 / 24V
Load voltage range		DC 10.2 ~ 26.4V
Max. load current		0.5A / 1point, 2A / 1COM (P40, P41: 0.1A / 1point)
Off leakage current		0.1 ㎃ or less
Max. inrush current		4A / 10 ㎳ or less
Max. voltage drop when On		DC 0.4V or less
Surge killer		Zener diode
Response time	Off → On	1 ㎳ or less
	On → Off	1 ㎳ or less (rated load, resistive load)
Common method		4 point / COM
Proper cable size		Stranded cable 0.3~0.75 ㎟ (External diameter 2.8 ㎜ or less)
External supply power	Voltage	DC12/24V ± 10% (ripple voltage 4 Vp-p or less)
	Current	25 ㎃ or less (when connecting DC24V)
Operation indicator		LED On When Output On
External connection method		30 point terminal block connector (M3 X 6 screw)
Weight		578g

Circuit configuration



No.	Contact	No.	Contact
		TB1	AC100 ~240V
TB2	FG	TB3	
TB4	COM0	TB5	40
TB6	COM1	TB7	41
TB8	COM2	TB9	42
TB10	43	TB11	P
TB12	COM3	TB13	44
TB14	45	TB15	46
TB16	47	TB17	NC
TB18	COM4	TB19	48
TB20	49	TB21	4A
TB22	4B	TB23	NC
TB24	COM5	TB25	4C
TB26	4D	TB27	4E
TB28	4F	TB29	24V
TB30	24G		

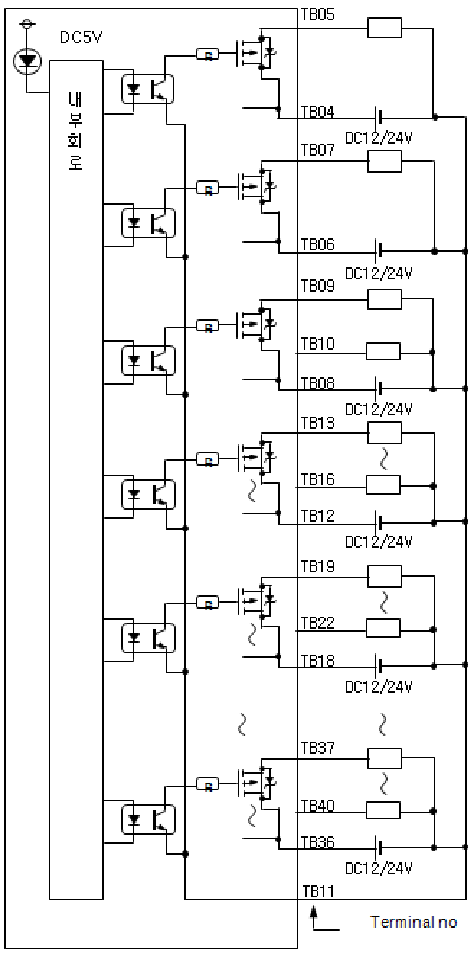
Type



7.3.24 XBC-DP60SU 24 point TR output (Source type)

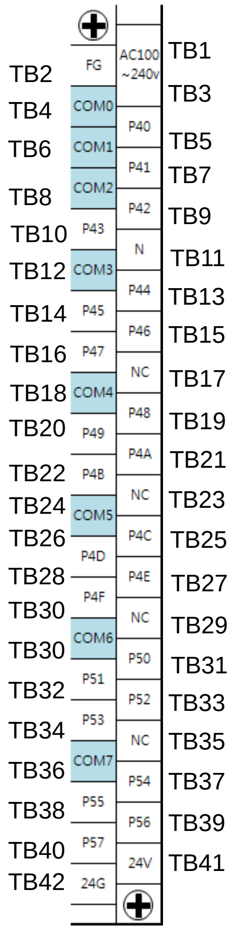
Specification \ Model		Main unit XBC-DP60SU
Output point		24 point
Insulation method		Photo-coupler insulation
Rated load voltage		DC 12 / 24V
Load voltage range		DC 10.2 ~ 26.4V
Max. load current		0.5A / 1point, 2A / 1COM (P40, P41: 0.1A / 1point)
Off leakage current		0.1 ㎃ or less
Max. inrush current		4A / 10 ㎳ or less
Max. voltage drop when On		DC 0.4V or less
Surge killer		Zener diode
Response time	Off → On	1 ㎳ or less
	On → Off	1 ㎳ or less (rated load, resistive load)
Common method		4 point / COM
Proper cable size		Stranded cable 0.3~0.75 ㎟ (External diameter 2.8 ㎜ or less)
External supply power	Voltage	DC12/24V ± 10% (ripple voltage 4 Vp-p or less)
	Current	25 ㎃ or less (when connecting DC24V)
Operation indicator		LED On When Output On
External connection method		42 point terminal block connector (M3 X 6 screw)
Weight		636g

Circuit configuration



No.	Contact	No.	Contact
TB2	FG	TB1	AC100 ~240V
TB4	COM0	TB3	
TB6	COM1	TB5	40
TB8	COM2	TB7	41
TB10	43	TB9	42
TB12	COM3	TB11	P
TB14	45	TB13	44
TB16	47	TB15	46
TB18	COM4	TB17	NC
TB20	49	TB19	48
TB22	4B	TB21	4A
TB24	COM5	TB23	NC
TB26	4D	TB25	4C
TB28	4F	TB27	4E
TB30	COM6	TB29	NC
TB32	51	TB31	50
TB34	53	TB33	52
TB36	COM7	TB35	NC
TB38	55	TB37	54
TB40	57	TB39	56
TB42	24G	TB41	24V

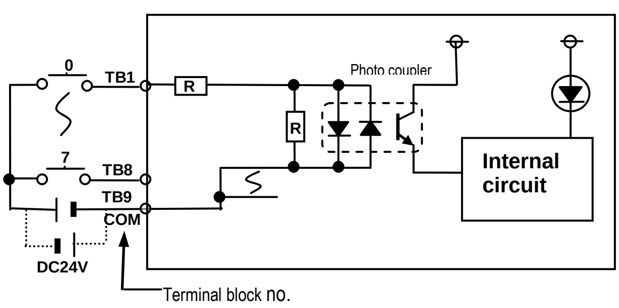
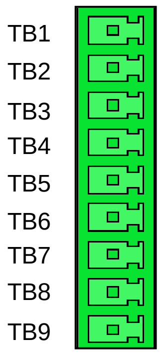
Type



7.4 Digital Input Module Specification

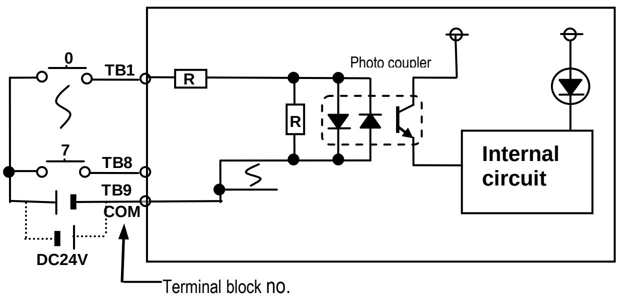
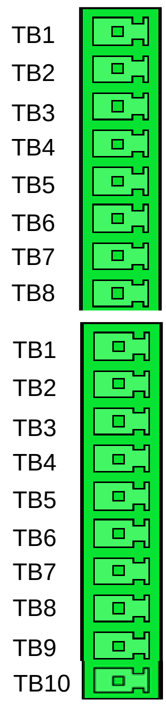
7.4.1 8 point DC24V input module (Source/Sink type)

Specification \ Model		DC input module
		XBE-DC08A
Input point		8 point
Insulation method		Photo coupler insulation
Rated input voltage		DC24V
Rated input current		About 4 ㎃
Operation voltage range		DC20.4~28.8V (ripple rate < 5%)
On Voltage/Current		DC19V or higher / 3 ㎃ or higher
Off Voltage/Current		DC6V or less / 1 ㎃ or less
Input resistance		About 5.6 ㏀
Response time	Off → On	1/3/5/10/20/70/100 ㎳(set by CPU parameter) Default: 3 ㎳
	On → Off	
Insulation pressure		AC560Vrms / 3Cycle (altitude 2000m)
Insulation resistance		10 ㏁ or more by Megohmmeter
Common method		8 point / COM
Proper cable size		Stranded pair 0.3~0.75 ㎟ (External diameter 2.8 ㎜ or less)
Current consumption		30 ㎃ (when all point On)
Operation indicator		Input On, LED On
External connection method		9 point terminal block connector
Weight		52 g

Circuit configuration	No.	Contact	Type
	TB1	0	
	TB2	1	
	TB3	2	
	TB4	3	
	TB5	4	
	TB6	5	
	TB7	6	
	TB8	7	
	TB9	COM	

7.4.2 16 point DC24V input module (Sink/Source type)

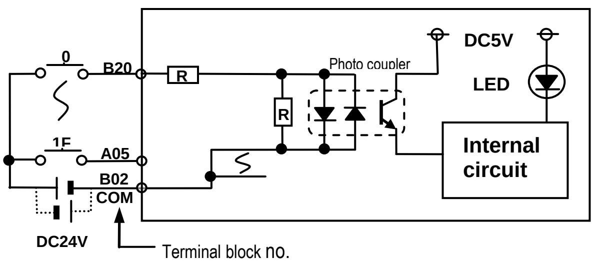
Specification \ Model		DC input module	
		XBE-DC16A	XBE-DC16B
Input point		16 point	
Insulation method		Photo coupler insulation	
Rated input voltage		DC24V	DC12/24V
Rated input current		About 4 ㎃	About 4/8 ㎃
Operation voltage range		DC20.4~28.8V (ripple rate < 5%)	DC9.5~30V (ripple rate < 5%)
On Voltage/Current		DC19V or higher / 3 ㎃ or higher	DC9V or higher / 3 ㎃ or higher
Off Voltage/Current		DC6V or less / 1 ㎃ or less	DC5V or less / 1 ㎃ or less
Input resistance		About 5.6 ㏀	About 2.7 ㏀
Response time	Off → On	1/3/5/10/20/70/100 ㎳ (set by CPU parameter) Default: 3 ㎳	
	On → Off		
Insulation pressure		AC560Vrms / 3Cycle (altitude 2000m)	
Insulation resistance		10 ㏁ or more by Megohmmeter	
Common method		16 point / COM	
Proper cable size		Stranded cable 0.3~0.75 ㎟ (External diameter 2.8 ㎜ or less)	
Current consumption		40 ㎃ (when all point On)	
Operation indicator		Input On, LED On	
External connection method		8 pin terminal block connector + 10 pin terminal block connector	
Weight		53 g	

Circuit configuration	No.	Contact	Type
	TB1	0	
	TB2	1	
	TB3	2	
	TB4	3	
	TB5	4	
	TB6	5	
	TB7	6	
	TB8	7	
	TB1	8	
	TB2	9	
	TB3	A	
	TB4	B	
	TB5	C	
	TB6	D	
	TB7	E	
	TB8	F	
	TB9	COM	
	TB10	COM	

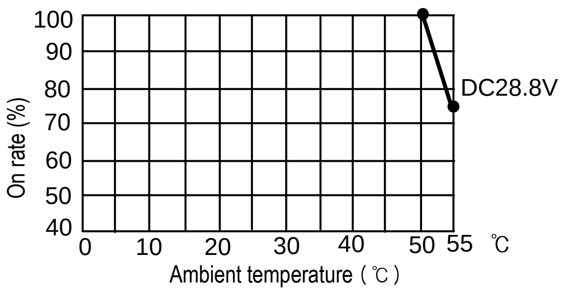
7.4.3 32 point DC24V input module (Source/Sink type)

Specification \ Model		DC input module XBE-DC32A
Input point		32 point
Insulation method		Photo coupler insulation
Rated input voltage		DC24V
Rated input current		About 4 ㎃
Operation voltage range		DC20.4~28.8V (ripple rate < 5%)
Input Derating		Refer to Derating diagram
On Voltage/Current		DC 19V or higher / 3 ㎃ or higher
Off Voltage/Current		DC 6V or less / 1 ㎃ or less
Input resistance		About 5.6 ㏀
Response time	Off → On	1/3/5/10/20/70/100 ㎳ (set by CPU parameter) Default:3 ㎳
	On → Off	
Insulation pressure		AC 560Vrms / 3 Cycle (altitude 2000m)
Insulation resistance		10 ㏁ or more by Megohmmeter
Common method		32 point / COM
Proper cable size		0.3 ㎟
Current consumption		50 ㎃ (when all point On)
Operation indicator		Input On, LED On
External connection method		40 pin connector
Weight		60g

Circuit configuration

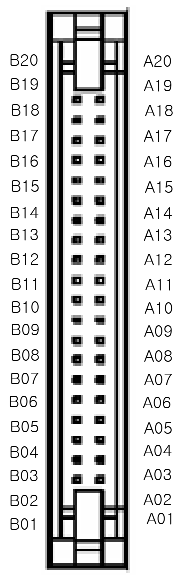


Input Derating diagram



No.	Contact	No.	Contact
B20	00	A20	10
B19	01	A19	11
B18	02	A18	12
B17	03	A17	13
B16	04	A16	14
B15	05	A15	15
B14	06	A14	16
B13	07	A13	17
B12	08	A12	18
B11	09	A11	19
B10	0A	A10	1A
B09	0B	A09	1B
B08	0C	A08	1C
B07	0D	A07	1D
B06	0E	A06	1E
B05	0F	A05	1F
B04	NC	A04	NC
B03	NC	A03	NC
B02	COM	A02	COM
B01	COM	A01	COM

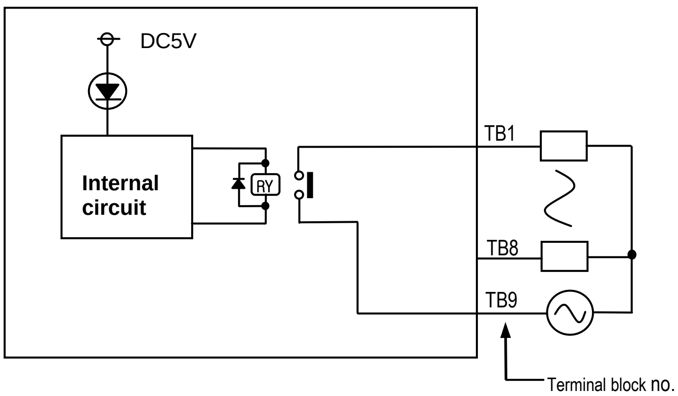
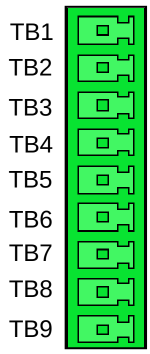
Type



7.5 Digital Output Module Specification

7.5.1 8 point relay output module

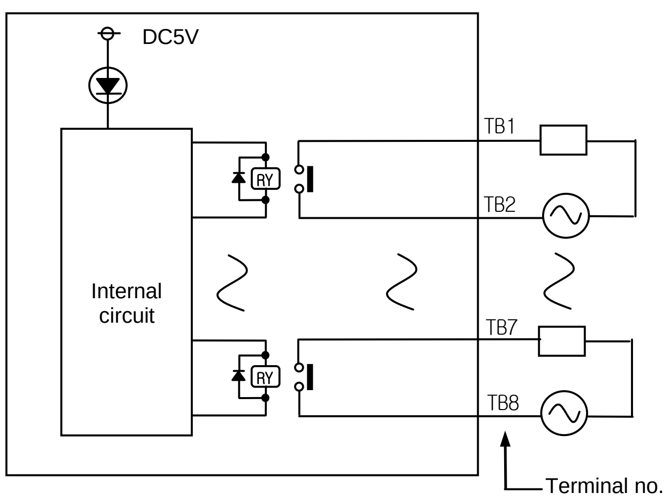
Specification \ Model		Relay output module
		XBE-RY08A
Output point		8 point
Insulation method		Relay insulation
Rated load voltage / Current		DC24V 2A (Resistive load) / AC220V 2A (COSΨ = 1), 5A/COM
Min. load voltage/Current		DC5V / 1 ㎃
Max. load voltage/Current		AC250V, DC125V
Off leakage current		0.1 ㎃ (AC220V, 60 ㎐)
Max. On/Off frequency		3,600 times/hr
Surge absorber		None
Service life	Mechanical	20 millions times or more
	Electrical	Rated load voltage / current 100,000 times or more
		AC200V / 1.5A, AC240V / 1A (COSΨ = 0.7) 100,000 times or more
		AC200V / 1A, AC240V / 0.5A (COSΨ = 0.35) 100,000 times or more
		DC24V / 1A, DC100V / 0.1A (L / R = 7 ㎳) 100,000 times or more
Response time	Off → On	10 ㎳ or less
	On → Off	12 ㎳ or less
Common method		8 point / COM
Proper cable size		Stranded cable 0.3~0.75 ㎟ (External diameter 2.8 ㎜ or less)
Current consumption		230 ㎃ (when all point On)
Operation indicator		Output On, LED On
External connection method		9 point terminal block connector
Weight		80g

Circuit configuration	No.	Contact	Type
	TB1	0	
	TB2	1	
	TB3	2	
	TB4	3	
	TB5	4	
	TB6	5	
	TB7	6	
	TB8	7	
	TB9	COM	

7.5.2 8 point relay output module (Independent point)

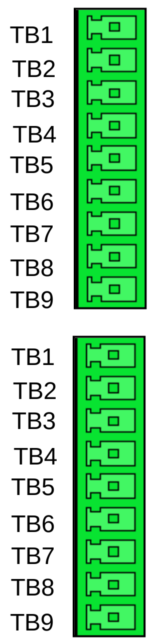
Specification \ Model		Relay output module XBE-RY08B
Output point		8 point
Insulation method		Relay insulation
Rated load voltage / Current		DC24V 2A (Resistive load) / AC220V 2A (COSΨ = 1), 2A/COM
Min. load voltage/Current		DC5V / 1 ㎃
Max. load voltage/Current		AC250V, DC125V
Off leakage current		0.1 ㎃ (AC220V, 60 ㎐)
Max. On/Off frequency		3,600 times/hr
Surge absorber		None
Service life	Mechanical	20 millions times or more
	Electrical	Rated load voltage / current 100,000 times or more
		AC200V / 1.5A, AC240V / 1A (COSΨ = 0.7) 100,000 times or more
		AC200V / 1A, AC240V / 0.5A (COSΨ = 0.35) 100,000 times or more
		DC24V / 1A, DC100V / 0.1A (L / R = 7 ㎳) 100,000 times or more
Response time	Off → On	10 ㎳ or less
	On → Off	12 ㎳ or less
Common method		1 point / COM
Proper cable size		Stranded cable 0.3~0.75 ㎟ (External diameter 2.8 ㎜ or less)
Current consumption		230 ㎃ (when all point On)
Operation indicator		Output On, LED On
External connection method		9 point terminal block connector x 2
Weight		81g

Circuit configuration



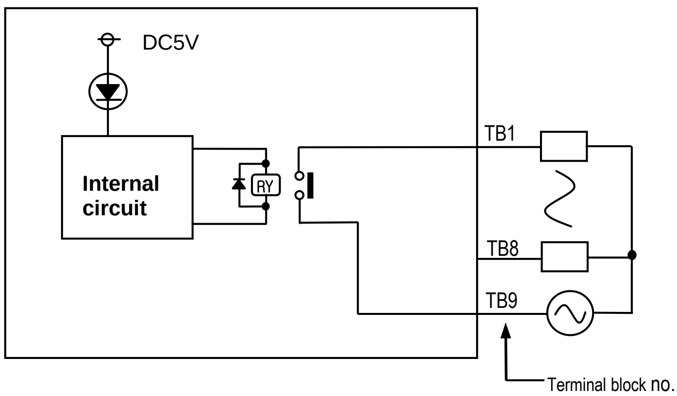
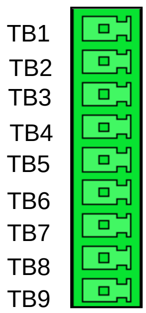
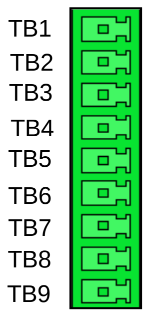
No.	configuration
TB1	0
TB2	COM0
TB3	1
TB4	COM1
TB5	2
TB6	COM2
TB7	3
TB8	COM3
TB9	NC
TB1	4
TB2	COM4
TB3	5
TB4	COM5
TB5	6
TB6	COM6
TB7	7
TB8	COM7
TB9	NC

No.



7.5.3 16 point relay output module

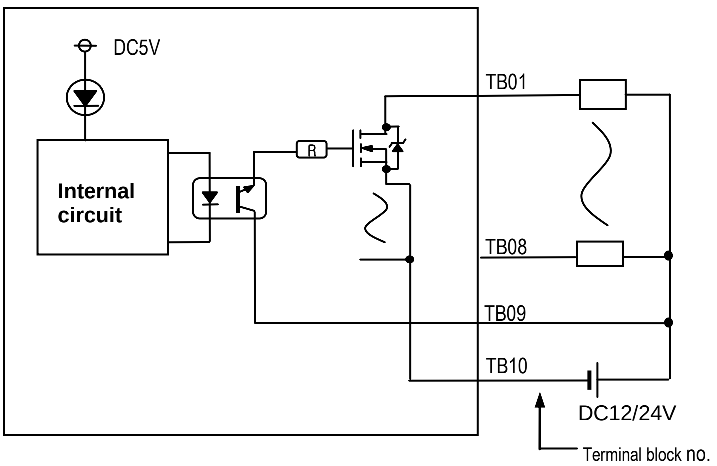
Specification \ Model		Relay output module
		XBE-RY16A
Output point		16 point
Insulation method		Relay insulation
Rated load voltage/ current		DC24V 2A (Resistive load) / AC220V 2A (COSΨ = 1), 5A/COM
Min. load voltage/current		DC5V / 1 mA
Max. load voltage/current		AC250V, DC125V
Off leakage current		0.1 mA (AC220V, 60 Hz)
Max. On/Off frequency		3,600 times/hr
Surge absorber		None
Service life	Mechanical	20 millions times or more
	Electrical	Rated load voltage / current 100,000 times or more
		AC200V / 1.5A, AC240V / 1A (COSΨ = 0.7) 100,000 times or more
		AC200V / 1A, AC240V / 0.5A (COSΨ = 0.35) 100,000 times or more
		DC24V / 1A, DC100V / 0.1A (L / R = 7 ms) 100,000 times or more
Response time	Off → On	10 ms or less
	On → Off	12 ms or less
Common method		8 point / COM
Proper cable size		Stranded cable 0.3~0.75 mm² (External diameter 2.8 mm or less)
Current consumption		420 mA (when all point On)
Operation indicator		Output On, LED On
External connection method		9 point terminal block connector x 2 ea
Weight		130g

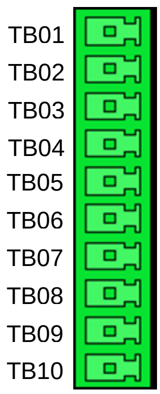
Circuit configuration	No.	Contact	Type
	TB1	0	
	TB2	1	
	TB3	2	
	TB4	3	
	TB5	4	
	TB6	5	
	TB7	6	
	TB8	7	
	TB9	COM	
	TB1	8	
	TB2	9	
	TB3	A	
	TB4	B	
	TB5	C	
	TB6	D	
	TB7	E	
	TB8	F	
	TB9	COM	

7.5.4 8 point transistor output module (Sink type)

Specification \ Model		Transistor output module
		XBE-TN08A
Output point		8 point
Insulation method		Photo coupler insulation
Rated load voltage		DC 12 / 24V
Load voltage range		DC 10.2 ~ 26.4V
Max. load voltage		0.5A / 1 point
Off leakage current		0.1 ㎃ or less
Max. inrush current		4A / 10 ㎳ or less
Max. voltage drop (On)		DC 0.4V or less
Surge absorber		Zener Diode
Response time	Off → On	1 ㎳ or less
	On → Off	1 ㎳ or less (Rated load, resistive load)
Common method		8 point / COM
Proper cable size		Stranded cable 0.3~0.75 ㎟ (External diameter 2.8 ㎜ or less)
Current consumption		40 ㎃ (when all point On)
External power supply	Voltage	DC12/24V ± 10% (ripple voltage 4 Vp-p or less)
	Current	10 ㎃ or less (DC24V connection)
Operation indicator		Output On, LED On
External connection method		10 point terminal block connector
Weight		53

Circuit configuration	No.	Contact	Type
	TB01	0	
	TB02	1	
	TB03	2	
	TB04	3	
	TB05	4	
	TB06	5	
	TB07	6	
	TB08	7	
	TB09	DC12 /24V	
	TB10	COM	

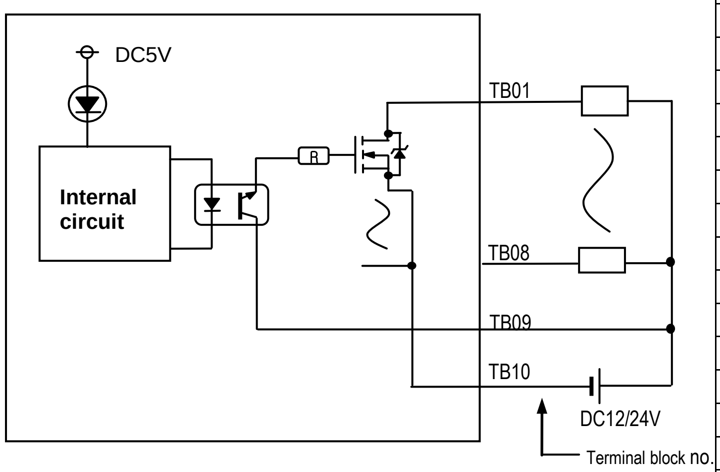




7.5.5 16 point transistor output module (Sink type)

Specification \ Model		Transistor output module
		XBE-TN16A
Output point		16 point
Insulation method		Photo coupler insulation
Rated load voltage		DC 12 / 24V
Load voltage range		DC 10.2 ~ 26.4V
Max. load voltage		0.2A / 1 point, 2A / 1COM
Off leakage current		0.1 ㎃ or less
Max. inrush current		4A / 10 ㎳ or less
Max. voltage drop (On)		DC 0.4V or less
Surge absorber		Zener Diode
Response time	Off → On	1 ㎳ or less
	On → Off	1 ㎳ or less (Rated load, resistive load)
Common method		16 point / COM
Proper cable size		Stranded cable 0.3~0.75 ㎟ (External diameter 2.8 ㎜ or less)
Current consumption		60 ㎃ (when all point On)
External power supply	Voltage	DC12/24V ± 10% (ripple voltage 4 Vp-p or less)
	Current	10 ㎃ or less (DC24V connection)
Operation indicator		Output On, LED On
External connection method		8 pin terminal block connector + 10 pin terminal block connector
Weight		54 g

Circuit configuration



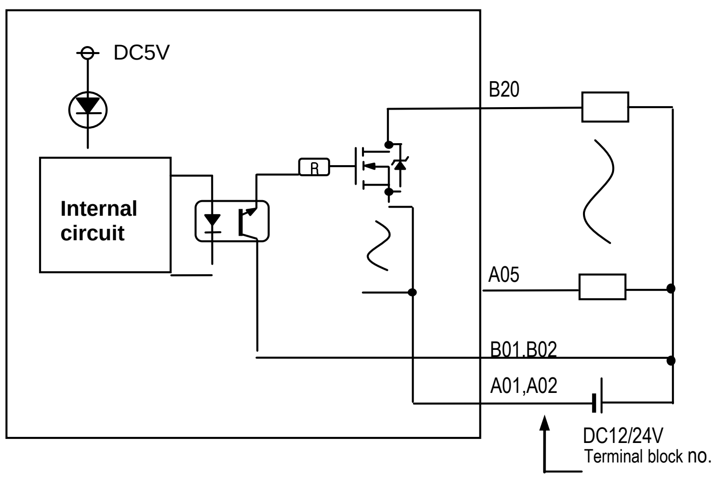
No.	Contact
TB01	0
TB02	1
TB03	2
TB04	3
TB05	4
TB06	5
TB07	6
TB08	7
TB01	8
TB02	9
TB03	A
TB04	B
TB05	C
TB06	D
TB07	E
TB08	F
TB09	DC12 /24V
TB10	COM

Type

7.5.6 32 point transistor output module (Sink type)

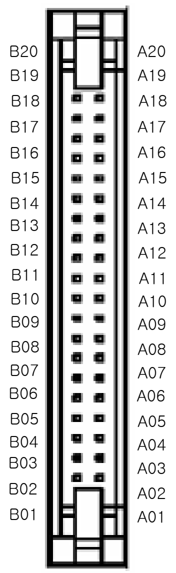
Specification \ Model		Transistor output module XBE-TN32A
Output point		32 point
Insulation method		Photo coupler insulation
Rated load voltage		DC 12 / 24V
Load voltage range		DC 10.2 ~ 26.4V
Max. load voltage		0.2A / 1 point, 2A / 1COM
Off leakage current		0.1 ㎃ or less
Max. inrush current		0.7A / 10 ㎳ or less
Max. voltage drop (On)		DC 0.4V or less
Surge absorber		Zener Diode
Response time	Off → On	1 ㎳ or less
	On → Off	1 ㎳ or less (Rated load, resistive load)
Common method		32 point / COM
Proper cable size		0.3 ㎟
Current consumption		120 ㎃ (when all point On)
External power supply	Voltage	DC12/24V ± 10% (ripple voltage 4 Vp-p or less)
	Current	20 ㎃ or less (DC24V connection)
Operation indicator		Output On, LED On
External connection method		40 pin connector
Weight		60g

Circuit configuration



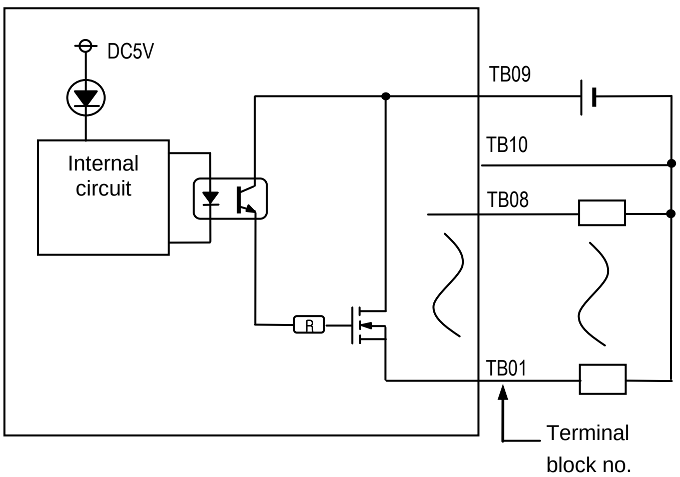
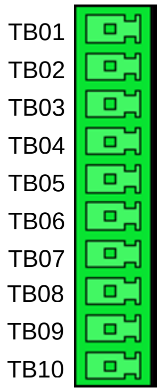
No.	Contact	No.	Contact
B20	00	A20	10
B19	01	A19	11
B18	02	A18	12
B17	03	A17	13
B16	04	A16	14
B15	05	A15	15
B14	06	A14	16
B13	07	A13	17
B12	08	A12	18
B11	09	A11	19
B10	0A	A10	1A
B09	0B	A09	1B
B08	0C	A08	1C
B07	0D	A07	1D
B06	0E	A06	1E
B05	0F	A05	1F
B04	NC	A04	NC
B03	NC	A03	NC
B02	DC12/ 24V	A02	COM
B01		A01	

Type



7.5.7 8 point transistor output module (Source type)

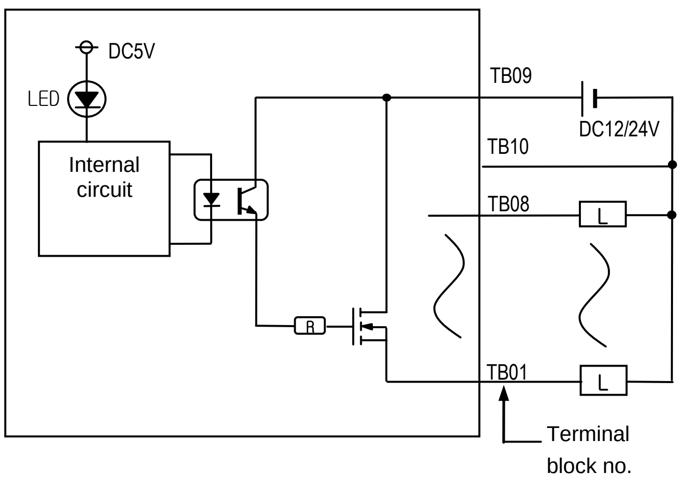
Specification \ Model		Transistor output module
		XBE-TP08A
Output point		8 point
Insulation method		Photo coupler insulation
Rated load voltage		DC 12 / 24V
Load voltage range		DC 10.2 ~ 26.4V
Max. load voltage		0.5A / 1 point
Off leakage current		0.1 ㎃ or less
Max. inrush current		4A / 10 ㎳ or less
Max. voltage drop (On)		DC 0.4V or less
Surge absorber		Zener Diode
Response time	Off → On	1 ㎳ or less
	On → Off	1 ㎳ or less (Rated load, resistive load)
Common method		8 point / COM
Proper cable size		Stranded cable 0.3~0.75 ㎟ (external diameter 2.8 ㎜ or less)
Current consumption		40 ㎃ (when all outputs are on)
External power	Voltage	DC12/24V ± 10% (ripple voltage 4 Vp-p or less)
	Current	10 ㎃ or less (when connecting DC24V)
Operation indicator		LED on when output on
External connection method		10 pin terminal block connector
Weight		30g

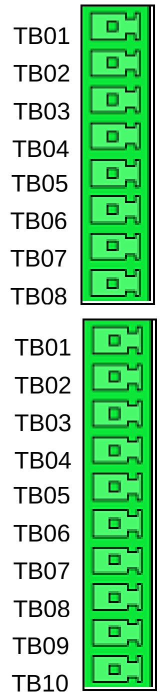
Circuit configuration	No.	Contact	Type
	TB01	0	
	TB02	1	
	TB03	2	
	TB04	3	
	TB05	4	
	TB06	5	
	TB07	6	
	TB08	7	
	TB09	COM	
	TB10	0V	

7.5.8 16 point transistor output module (Source type)

Specification \ Model		Transistor output module
		XBE-TP16A
Output point		16 point
Insulation method		Photo coupler insulation
Rated load voltage		DC 12 / 24V
Load voltage range		DC 10.2 ~ 26.4V
Max. load voltage		0.5A / 1 point, 2A / 1COM
Off leakage current		0.1 ㎃ or less
Max. inrush current		4A / 10 ㎳ or less
Max. voltage drop (On)		DC 0.4V or less
Surge absorber		Zener Diode
Response time	Off → On	1 ㎳ or less
	On → Off	1 ㎳ or less (Rated load, resistive load)
Common method		16 point / COM
Proper cable size		Stranded cable 0.3~0.75 ㎟ (external diameter 2.8 ㎜ or less)
Current consumption		60 ㎃ (When all outputs are on)
External power	Voltage	DC12/24V ± 10% (ripple voltage 4 Vp-p or less)
	Current	10 ㎃ or less (connecting DC24V)
Operation indicator		LED On when output On
External connection method		8 pin terminal block connector + 10 pin terminal block connector
Weight		40g

Circuit configuration	No.	Contact	Type
	TB01	0	
	TB02	1	
	TB03	2	
	TB04	3	
	TB05	4	
	TB06	5	
	TB07	6	
	TB08	7	
	TB01	8	
	TB02	9	
	TB03	A	
	TB04	B	
	TB05	C	
	TB06	D	
	TB07	E	
	TB08	F	
	TB09	COM	
	TB10	0V	

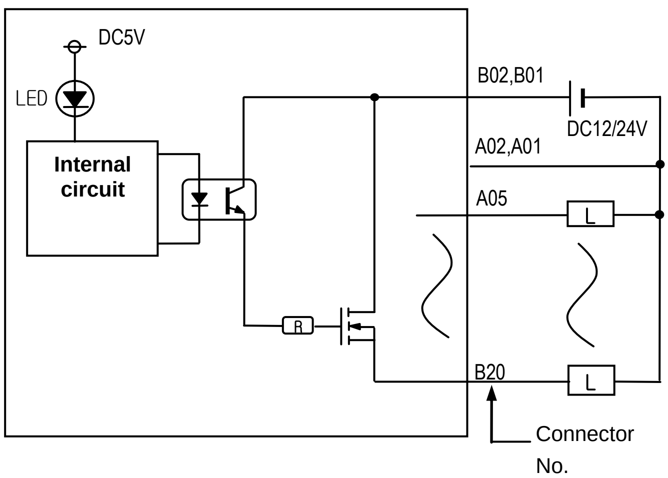




7.5.9 32 point transistor output module (Source type)

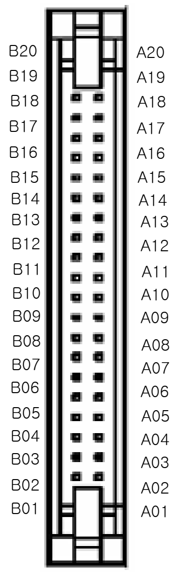
Specification \ Model		Transistor output module XBE-TP32A
Output point		32 point
Insulation method		Photo coupler insulation
Rated load voltage		DC 12 / 24V
Load voltage range		DC 10.2 ~ 26.4V
Max. load voltage		0.2A / 1 point, 2A / 1COM
Off leakage current		0.1 ㎃ or less
Max. inrush current		4A / 10 ㎳ or less
Max. voltage drop (On)		DC 0.4V or less
Surge absorber		Zener Diode
Response time	Off → On	1 ㎳ or less
	On → Off	1 ㎳ or less (Rated load, resistive load)
Common method		32 point / COM
Proper cable size		0.3 ㎟
Current consumption		120 ㎃ (When all outputs are on)
External power	Voltage	DC12/24V ± 10% (ripple voltage 4 Vp-p or less)
	Current	20 ㎃ or less (connecting DC24V)
Operation indicator		LED On when output On
External connection method		40 pin connector
Weight		60g

Circuit configuration



No.	Contact	No.	Contact
B20	00	A20	10
B19	01	A19	11
B18	02	A18	12
B17	03	A17	13
B16	04	A16	14
B15	05	A15	15
B14	06	A14	16
B13	07	A13	17
B12	08	A12	18
B11	09	A11	19
B10	0A	A10	1A
B09	0B	A09	1B
B08	0C	A08	1C
B07	0D	A07	1D
B06	0E	A06	1E
B05	0F	A05	1F
B04	NC	A04	NC
B03	NC	A03	NC
B02	COM	A02	0V
B01		A01	

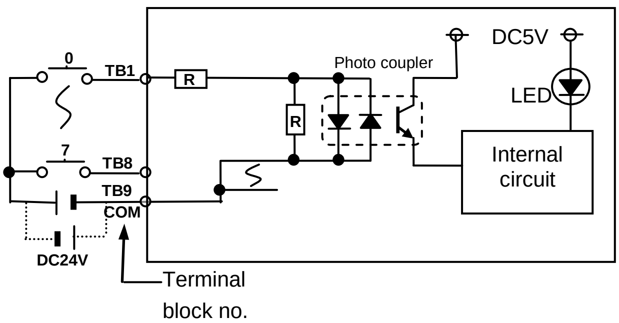
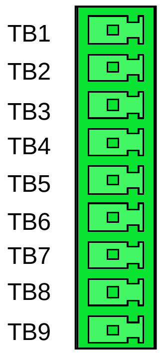
Type



7.6 Combined Digital I/O module Input Specification

7.6.1 8 point DC24V input (Source/Sink type)

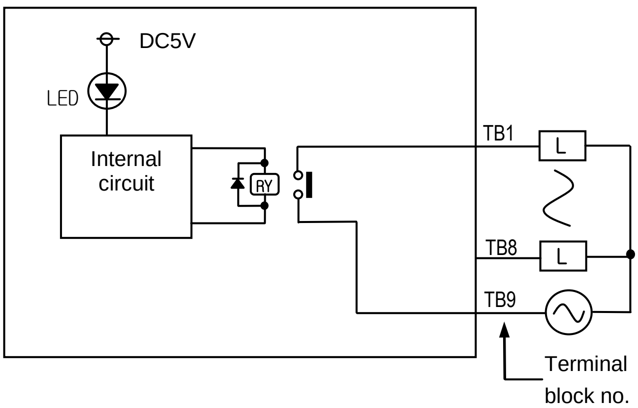
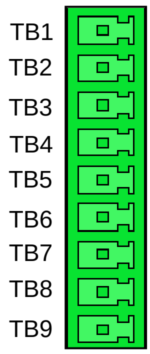
Specification \ Model		DC input module
		XBE-DR16A
Input point		8 point
Insulation method		Photo coupler insulation
Rated input voltage		DC24V
Rated input current		About 4 ㎃
Operation voltage range		DC20.4~28.8V (within ripple rate 5%)
On Voltage/Current		DC19V or higher / 3 ㎃ or higher
Off Voltage/Current		DC6V or less / 1 ㎃ or less
Input resistance		About 5.6 ㏀
Response time	Off → On	1/3/5/10/20/70/100 ㎳(set by CPU parameter) Default: 3 ㎳
	On → Off	
Insulation pressure		AC560Vrms / 3Cycle (altitude 2000m)
Insulation resistance		10 ㏁ or more by Megohmmeter
Common method		8 point / COM
Proper cable size		Stranded cable 0.3~0.75 ㎟ (External diameter 2.8 ㎜ or less)
Current consumption		280 ㎃ (When all inputs and outputs are on)
Operation indicator		LED on when input on
External connection method		9 pin terminal block connector
Weight		81g

Circuit configuration	No.	Contact	Type
	TB1	0	
	TB2	1	
	TB3	2	
	TB4	3	
	TB5	4	
	TB6	5	
	TB7	6	
	TB8	7	
	TB9	COM	

7.7 Combined Digital I/O module Output Specification

7.7.1 8 point relay output

Specification \ Model		Relay output module XBE-DR16A
Output point		8 point
Insulation method		Relay insulation
Rated load voltage / Current		DC24V 2A(Resistive load) / AC220V 2A(COSΨ = 1), 5A/COM
Min. load voltage/Current		DC5V / 1 ㎃
Max. load voltage		AC250V, DC125V
Off leakage current		0.1 ㎃ (AC220V, 60 ㎐)
Max. On/Off frequency		3,600 times/hr
Surge absorber		None
Service life	Mechanical	20 millions times or more
	Electrical	Rated load voltage / current 100,000 times or more
		AC200V / 1.5A, AC240V / 1A (COSΨ = 0.7) 100,000 times or more
		AC200V / 1A, AC240V / 0.5A (COSΨ = 0.35) 100,000 times or more
		DC24V / 1A, DC100V / 0.1A (L / R = 7 ㎳) 100,000 times or more
Response time	Off → On	10 ㎳ or less
	On → Off	12 ㎳ or less
Common method		8 point / COM
Proper cable size		Stranded cable 0.3~0.75 ㎟ (external diameter 2.8 ㎜ or less)
Current consumption		280 ㎃ (When all inputs and outputs are on)
Operation indicator		LED on when output on
External connection method		9 pin terminal block connector
Weight		81g

Circuit configuration	No.	Contact	Type
	TB1	0	
	TB2	1	
	TB3	2	
	TB4	3	
	TB5	4	
	TB6	5	
	TB7	6	
	TB8	7	
	TB9	COM	

7.8 IO Wiring by Using Smart Link Board

7.8.1 Smart link board

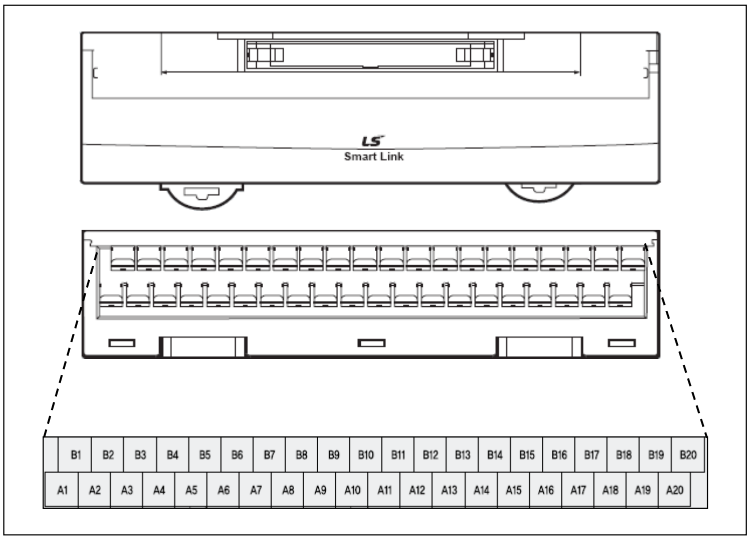
Easy wiring is available by connecting the IO connector with smart link board.
The available smart link and IO cable are as follows.

XGB		Smart link		Connection cable		
Item	Model	Model	No. of Pin	Model	Length	Contents
Main unit	XBM-DN32S	SLP-T40P	40	SLT-CT101-XBM	1m	For main unit connection (20Pin + 20Pin)
	XBM-DN16S					
Expansion module	XBE-DC32A	SLP-T40P	40	SLT-CT101-XBE	1m	For expansion module connection (40Pin)
	XBE-TN32A	SLP-T40P	40	SLT-CT101-XBE	1m	
		SLP-RY4A	40	SLP-CT101-XBE	1m	For expansion module connection (40Pin) Exclusive for relay built-in SLP type

It describes wring of XGB, SLP-T40P and SLT-CT101-XBM.
For wring of other smart link boards or XGB extension module, refer to XGB user manual for hardware.

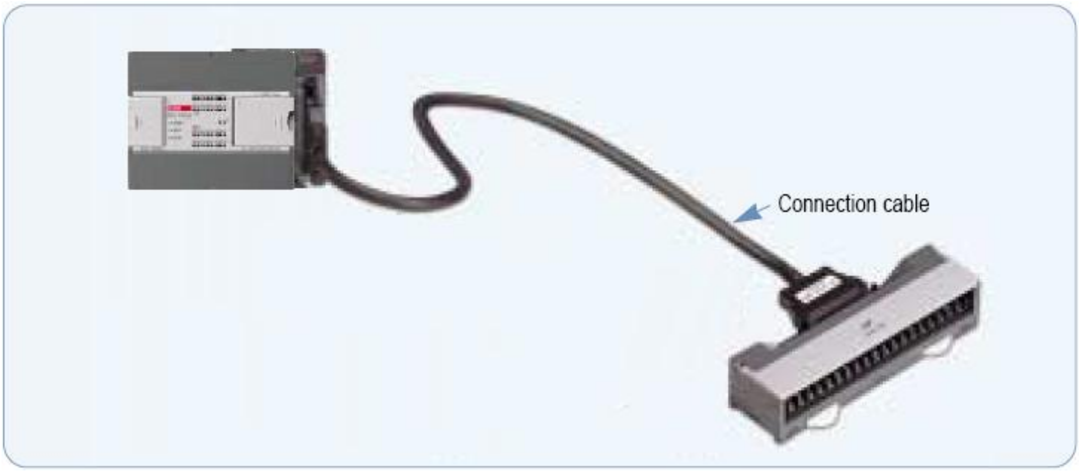
1) SLT-T40P terminal array

Terminal array of SLP-T40P is as follows.

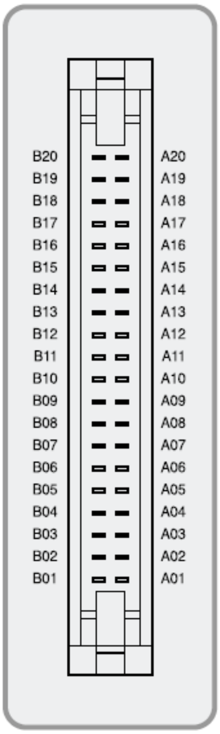


Item	Specification
Rated voltage	AC/DC 125[V]
Rated current	Max. 1[A]
Withstanding voltage	600V 1min
Insulation resistor	100 ㏁ (DC500V)
Cable specification	1.25[㎟] or below
Terminal/screw	M3 X 8L
Torque	6.2 ㎏f.㎝ or above
Terminal material	PBT, UL94V-0
Weight	186g

2) Wiring of SLT-T40P and XGB extension modulet
Wiring of XGB extension module through SLP-T40P and SLT-CT101-XBE is as follows.



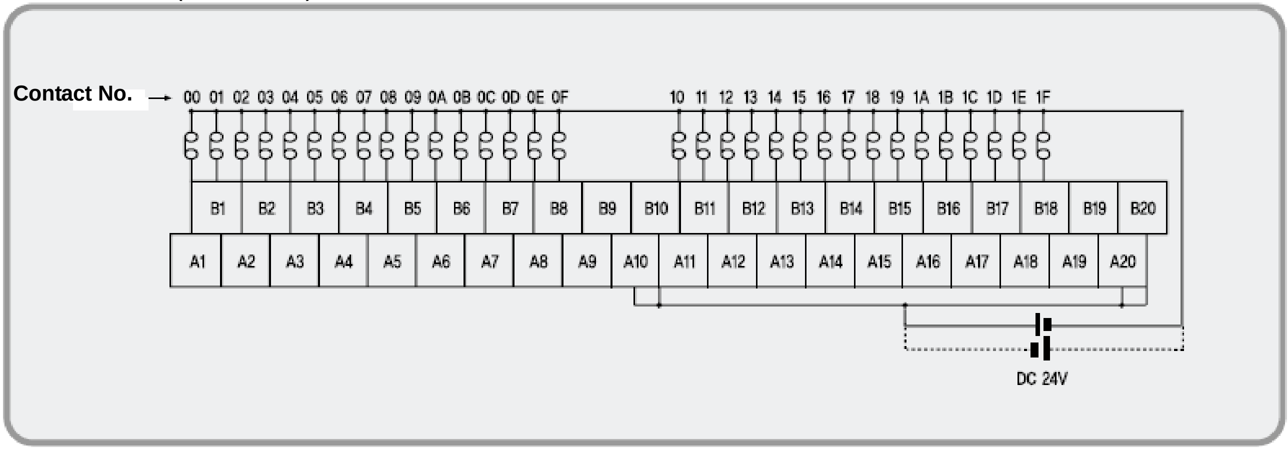
At this time, relationship of XGB IO signal and Smart link board terminal number is as follows.
The following figure describes signal allocation when SLT-CT101-XBE is used as connection cable.
When the user makes the cable, make sure that wring is done as figure below.



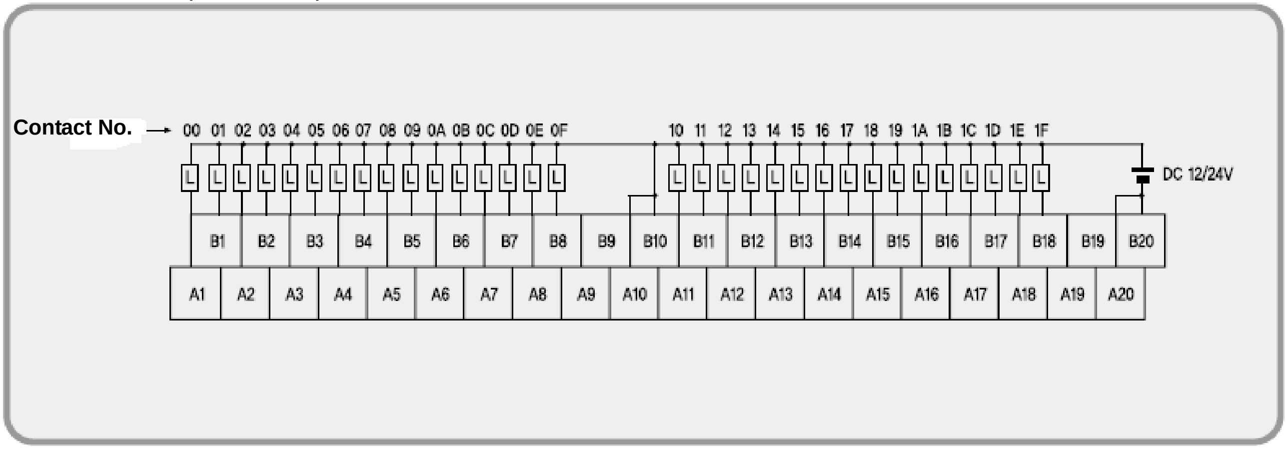
Pin No.		PLC						Terminal block Name	
		XBE-DC32A		XBE-TN32A		XBE-TP32A		Terminal block board (SLP-T40P)	
B20	A20	00	10	00	10	00	10	A1	A11
B19	A19	01	11	01	11	01	11	B1	B11
B18	A18	02	12	02	12	02	12	A2	A12
B17	A17	03	13	03	13	03	13	B2	B12
B16	A16	04	14	04	14	04	14	A3	A13
B15	A15	05	15	05	15	05	15	B3	B13
B14	A14	06	16	06	16	06	16	A4	A14
B13	A13	07	17	07	17	07	17	B4	B14
B12	A12	08	18	08	18	08	18	A5	A15
B11	A11	09	19	09	19	09	19	B5	B15
B10	A10	0A	1A	0A	1A	0A	1A	A6	A16
B09	A09	0B	1B	0B	1B	0B	1B	B6	B16
B09	A08	0C	1C	0C	1C	0C	1C	A7	A17
B07	A07	0D	1D	0D	1D	0D	1D	B7	B17
B06	A06	0E	1E	0E	1E	0E	1E	A8	A18
B05	A05	0F	1F	0F	1F	0F	1F	B8	B18
B04	A04	NC	NC	NC	NC	NC	NC	A9	A19
B03	A03	NC	NC	NC	NC	NC	NC	B9	B19
B02	A02	COM	COM	DC12/24V	COM	COM	DC0V	A10	A20
B01	A01							B10	B20

3) I/O wiring

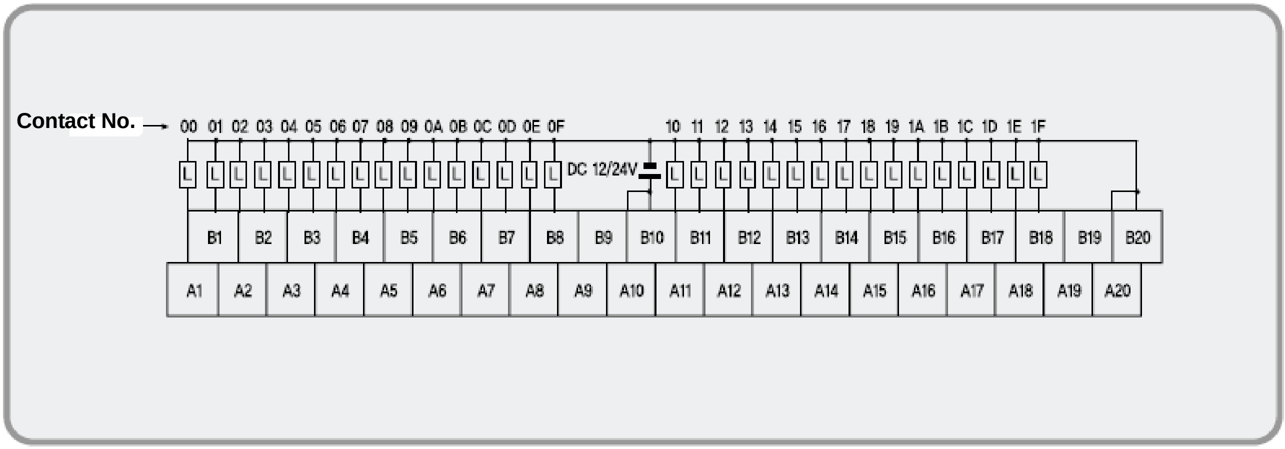
- XBE-DC32A (SLP-T40P)



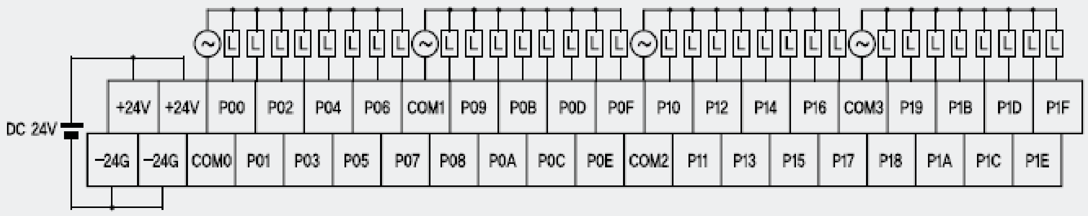
- XBE-TN32A (SLP-T40P)



- XBE-TP32A (SLP-T40P)



- XBE-TN32A (SLP-RY4A)



Chapter 8 Built-in High-speed Counter Function

XGB series have built-in function of High-speed counter in main unit. This chapter describes specifications and usage of High-speed counter's function.

8.1 High-speed Counter Specifications

❑ It describes specifications, setting and usage of function, programming and wiring with external device of built-in main unit.

8.1.1 Performance specifications

(1) Performance specification

Classification		Description	
		"E" type	"S(U)" type
Count input signal	Signal	A-phase, B-phase	
	Input type	Voltage input (Open collector)	
	Signal level	DC 24V	
Max. count speed		4kpps	100kpps
Number of channels	1 phase	4kpps 4 channels	100kpps 2 channels/ 20kpps 6 channels
	2 phase	2kpps 2 channels	50kpps 1 channel / 8kpps 3 channels
Count range		Signed 32 Bit (-2,147,483,648 ~ 2,147,483,647)	
Count mode (Program setting)		Linear count (if 32-bit range exceeded, Carry/Borrow occurs) Counter max. and min. value is indicated	
		Ring count (repeated count within setting range)	
Input mode (Program setting)		1-phase input	
		2-phase input	
		CW/CCW input	
Signal type		Voltage	
Up/Down setting	1 phase input	Increasing/decreasing operation setting by B-phase input	
		Increasing/decreasing operation setting by program	
	2 phase input	Operating setting by rising edge phase difference	Operating setting by rising/falling edge phase difference
	CW/CCW	A-phase input: increasing operation	
		B-phase input: decreasing operation	
Multiplication function	1 phase input	1 multiplication	
	2 phase input	2 multiplication	4 multiplication
	CW/CCW	1 multiplication	
Control input	Signal	Preset instruction input	
	Signal level	DC 24V input type	
	Signal type	Voltage	
External output	Output points	1 point/channel (for each channel) :uses output contact point of main unit	2 point/channel (for each channel) :use output contact point of main unit
	Type	Selects single-compared (>, >=, =, =<, <) or section-compared output (included or excluded) (program setting)	
	Output type	Relay, Open-collector output (Sink)	

Classification	Description	
	"E" type	"S(U)" type
Count Enable	To be set through program (count available only in enable status)	
Preset function	To be set through terminal (contact) or program	
Auxiliary mode (Program setting)	Count Latch Count per unit time (time setting value: 1~60,000ms)	

(2) Counter/Preset input specification

Classification	Spcification
Input voltage	24V DC (20.4V ~ 28.8V)
Input current	4㎃
On guranteed voltage (min.)	20.4V
Off guranteed voltage (max.)	6V

Notice

If higher pulse than high speed counter input limit is inputted, 「abnormal operation stop」 error may occur because MPU processing time increases to count fast and memory becomes full.
When using high speed counter, consider this.

8.1.2 Designation of parts

(1) Designation of parts

(a) “E” type

Terminal No.	Names		Usage	
	1-phase	2-phase	1-phase	2-phase
P000	Ch0 counter input	Ch0 A-phase input	Counter input terminal	A-phase input
P001	Ch1 counter input	Ch0 B-phase input	Counter input terminal	B-phase input
P002	Ch2 counter input	Ch2 A-phase input	Counter input terminal	A-phase input
P003	Ch3 counter input	Ch2 B-phase input	Counter input terminal	B-phase input
P004	Ch0 preset 24V	Ch0 preset 24V	Preset input terminal	Preset input terminal
P005	Ch1 preset 24V	-	Preset input terminal	No use
P006	Ch2 preset 24V	Ch2 preset 24V	Preset input terminal	Preset input terminal
P007	Ch4 preset 24V	-	Preset input terminal	No use
COM0	Input common	Input common	Common terminal	Common terminal

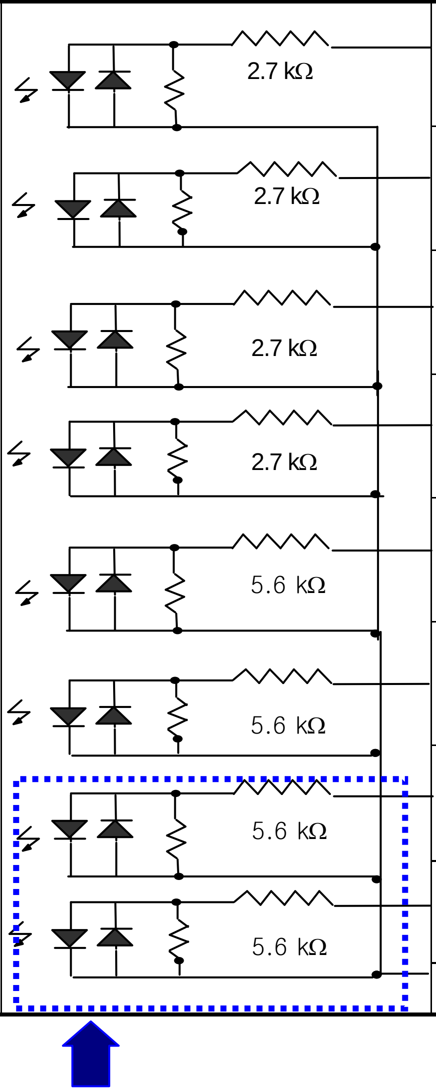
(b) “S(U)” type

Terminal No.	Names		Usage	
	1-phase	2-phase	1-phase	2-phase
P000	Ch0 counter input	Ch0 A-phase input	Counter input terminal	A-phase input
P001	Ch1 counter input	Ch0 B-phase input	Counter input terminal	B-phase input
P002	Ch2 counter input	Ch2 A-phase input	Counter input terminal	A-phase input
P003	Ch3 counter input	Ch2 B-phase input	Counter input terminal	B-phase input
P004	Ch4 counter input	Ch4 A-phase input	Counter input terminal	A-phase input
P005	Ch5 counter input	Ch4 B-phase input	Counter input terminal	B-phase input
P006	Ch6 counter input	Ch6 A-phase input	Counter input terminal	A-phase input
P007	Ch7 counter input	Ch6 B-phase input	Counter input terminal	B-phase input
P008	Ch0 preset 24V	Ch0 preset 24V	Preset input terminal	Preset input terminal
P009	Ch1 preset 24V	-	Preset input terminal	No use
P00A	Ch2 preset 24V	Ch2 preset 24V	Preset input terminal	Preset input terminal
P00B	Ch4 preset 24V	-	Preset input terminal	No use
P00C	Ch5 preset 24V	Ch4 preset 24V	Preset input terminal	Preset input terminal
P00D	Ch6 preset 24V	-	Preset input terminal	No use
P00E	Ch7 preset 24V	Ch6 preset 24V	Preset input terminal	Preset input terminal
P00F	Ch8 preset 24V	–	Preset input terminal	No use
COM0	Input common	Input common	Input common	Input common

(2) Interface with external devices

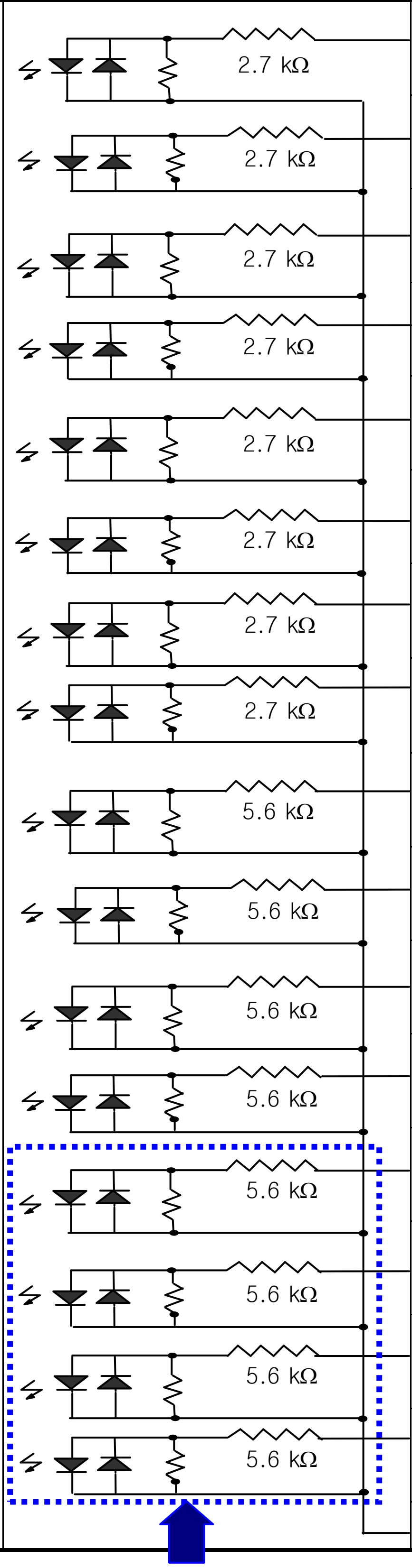
The internal circuit of High-speed counter is as shown below.

(a) “E” type

I/O	Internal circuit	Terminal No.	Signal 1-phase	Signal 2-phase	Operation	On/Off guaranteed voltage
Input		P00	Ch 0 Pulse input	Ch 0 A-phase input	On	20.4~28.8V
					Off	6V or less
		P01	Ch 1 Pulse input	Ch 0 B-phase input	On	20.4~28.8V
					Off	6V or less
		P02	Ch 2 Pulse input	Ch 2 A-phase input	On	20.4~28.8V
					Off	6V or less
		P03	Ch 3 Pulse input	Ch 2 B-phase input	On	20.4~28.8V
					Off	6V or less
		P04	Ch 0 Preset input	Ch 0 Preset input	On	20.4~28.8V
					Off	6V or less
		P05	Ch 1 Preset input	-	On	20.4~28.8V
					Off	6V or less
		P06	Ch 2 Preset input	Ch 2 Preset input	On	20.4~28.8V
					Off	6V or less
		P07	Ch 3 Preset input	-	On	20.4~28.8V
					Off	6V or less
		COM0	COM (input common)			

For XBC-DR10E, there is no physical circuit for P0006 ~ P0007. Turn on this contact point by program.

(b) “S(U)” type

I/O	Internal circuit	Terminal No.	Signal 1-phase	Signal 2-phase	Operation	On/Off guaranteed voltage
Input		P0000	Ch 0 Pulse input	Ch 0 A-phase input	On	20.4~28.8V
					Off	6V or less
		P0001	Ch 1 Pulse input	Ch 0 B-phase input	On	20.4~28.8V
					Off	6V or less
		P0002	Ch 2 Pulse input	Ch 2 A-phase input	On	20.4~28.8V
					Off	6V or less
		P0003	Ch 3 Pulse input	Ch 2 B-phase input	On	20.4~28.8V
					Off	6V or less
		P0004	Ch 4 Pulse input	Ch 4 A-phase input	On	20.4~28.8V
					Off	6V or less
		P0005	Ch 5 Pulse input	Ch 4 B-phase input	On	20.4~28.8V
					Off	6V or less
		P0006	Ch 6 Pulse input	Ch 6 A-phase input	On	20.4~28.8V
					Off	6V or less
		P0007	Ch 7 Pulse input	Ch 6 B-phase input	On	20.4~28.8V
					Off	6V or less
		P0008	Ch 0 Preset input	Ch 0 Preset input	On	20.4~28.8V
					Off	6V or less
		P0009	Ch 1 Preset input	-	On	20.4~28.8V
					Off	6V or less
		P000A	Ch 2 Preset input	Ch 2 Preset input	On	20.4~28.8V
					Off	6V or less
		P000B	Ch 3 Preset input	-	On	20.4~28.8V
					Off	6V or less
		P000C	Ch 4 Preset input	Ch 4 Preset input	On	20.4~28.8V
					Off	6V or less
		P000D	Ch 5 Preset input	-	On	20.4~28.8V
					Off	6V or less
		P000E	Ch 6 Preset input	Ch 6 Preset input	On	20.4~28.8V
					Off	6V or less
		P000F	Ch 7 Preset input	-	On	20.4~28.8V
					Off	6V or less
		COM0	COM(input common)			

For XBC-DR/DN20S, there is no physical circuit for P000C ~ P000F. Turn on this contact point by program.

8.1.3 “E” type Functions

(1) Counter mode

(a) High Speed counter module can count High Speed pulses which can not be processed by CPU module’s counter instructions (CTU, CTD, CTUD, etc.), up to binary value of 32 bits (-2,147,483,648 ~ 2,147,483,647).

(b) Available input is 1-phase input, 2-phase input and CW/ CCW input.

(c) Count increasing/decreasing methods are as follows;

1) For 1-phase input: (1) Increasing/decreasing count operation by program setting

(2) Increasing/decreasing count operation by B-phase input signal

2) For 2-phase input: setting by difference in phase between A-phase and B-phase

3) For CW/CCW input: Increasing operation if B-phase is LOW with A-phase input, and Decreasing operation if A-phase is LOW with B-phase input.

(d) Auxiliary modes are as follows;

1) Count Latch

2) Periodic Pulse Count

(e) Pulse input mode

1) 1-phase count mode

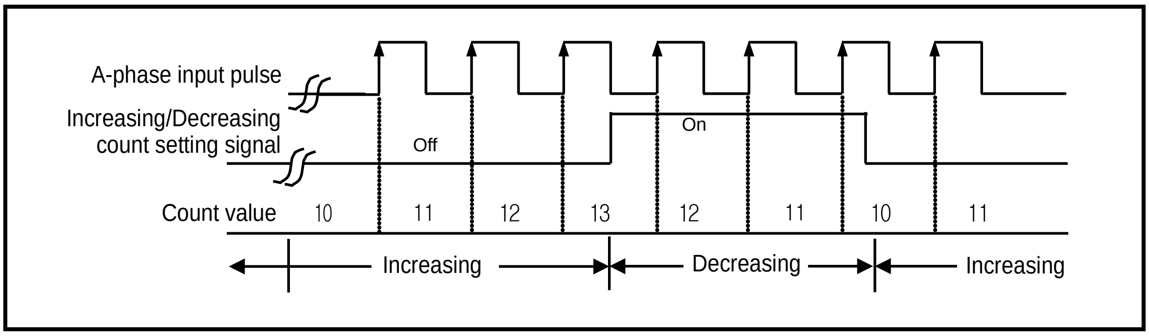
a) Increasing/decreasing count operation by program setting

● 1-phase 1-input 1-multiplication operation mode

A-phase input pulse counts at rising and increasing/decreasing will be decided by the applicable program.

Increasing/Decreasing classification	A-phase input pulse rising	A-phase input pulse falling
Increasing/decreasing count setting signal Off	Increasing count	-
Increasing/decreasing count setting signal On	Decreasing count	-

● Operation example



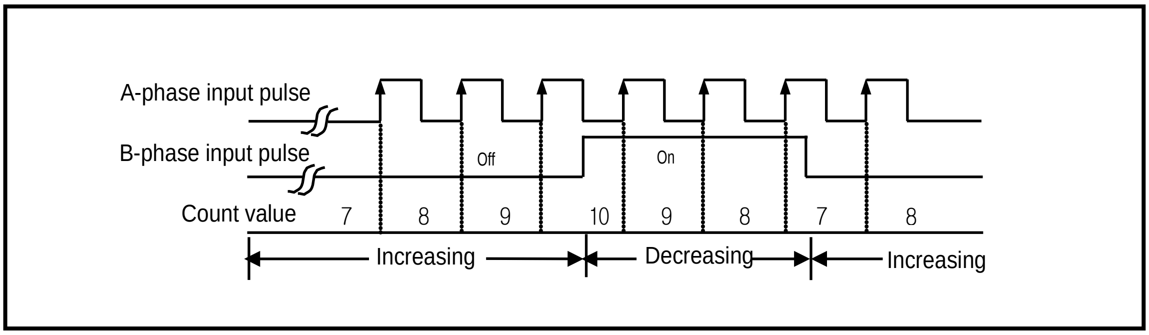
b) Increasing/decreasing count operation by B-phase input signal

● 1-phase 2-input 1-multiplication operation mode

A-phase input pulse counts at rising and increasing/decreasing will be decided by B-phase.

Increasing/Decreasing classification	A-phase input pulse rising	A-phase input pulse falling
B-phase input pulse Off	Increasing count	-
B-phase input pulse On	Decreasing count	-

● Operation example

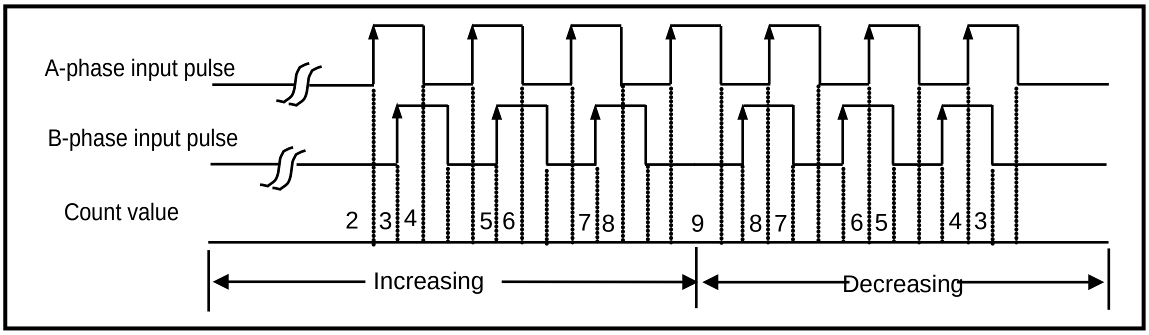


2) 2-phase count mode

a) 2-phase 2-multiplication operation mode

A-phase input pulse and B-phase input pulse count at rising. If A-phase input is antecedent to B-phase input, increasing operation starts, and if B-phase input is antecedent to A-phase input, decreasing operation starts.

▪ Operation example



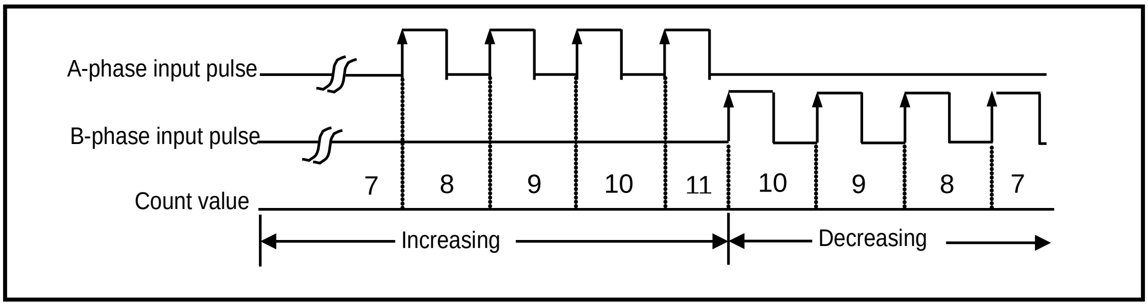
3) CW(Clockwise)/CCW(Counter Clockwise) operation mode

A-phase input pulse counts at rising , or B-phase input pulse counts at rising.

Increasing operation executed when B-phase input pulse is Low with A-phase input pulse at rising, and Decreasing operation executed when A-phase input pulse is Low with B-phase input pulse at rising.

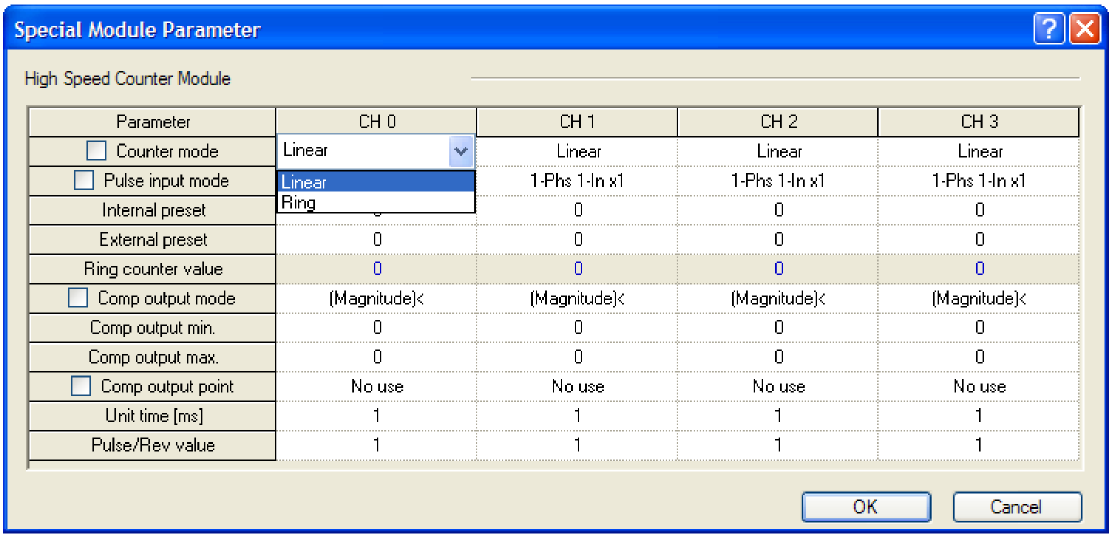
Increasing/Decreasing classification	A-phase input pulse High	A-phase input pulse Low
B-phase input pulse High	-	decreasing count
B-phase input pulse Low	Increasing count	-

▪ Operation example



(2) Counter type

2 types of count (Linear counter, Ring counter) can be selected for the applicable use based on functions.



▪ Counter mode is saved at the following special K area.

Mode	Area per each channel (word)				Reference[*1)]
	Ch.0	Ch.1	Ch.2	Ch.3	
Counter mode	K300	K330	K360	K390	0 : linear 1 : ring

*1) If counter mode is set as value other than 0, 1, error code ‘20’ will occur.

2 types of count can be selected for the applicable use based on functions.

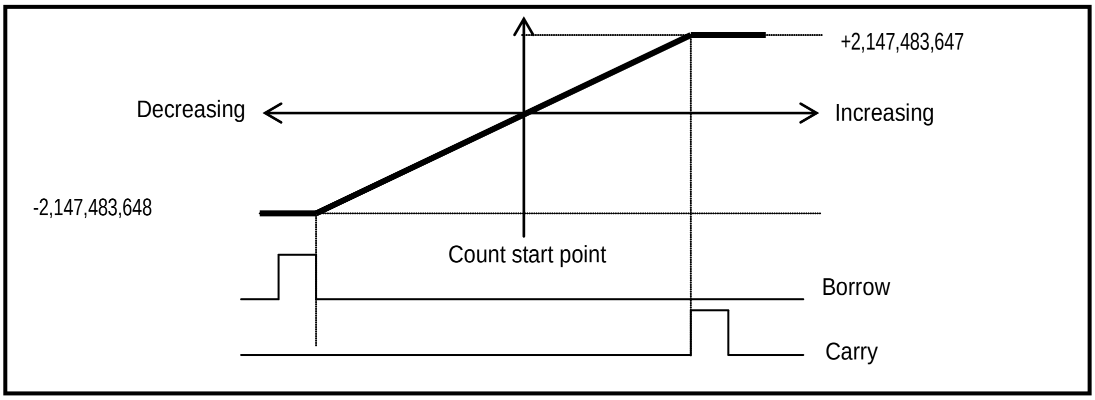
(a) Linear counter

1) Linear Count range: -2,147,483,648 ~ 2,147,483,647

2) If count value reaches the maximum value while increased, Carry will occur, and if count value reaches the minimum value while decreased, Borrow will occur.

3) If Carry occurs, count stops and increasing is not available but decreasing is available.

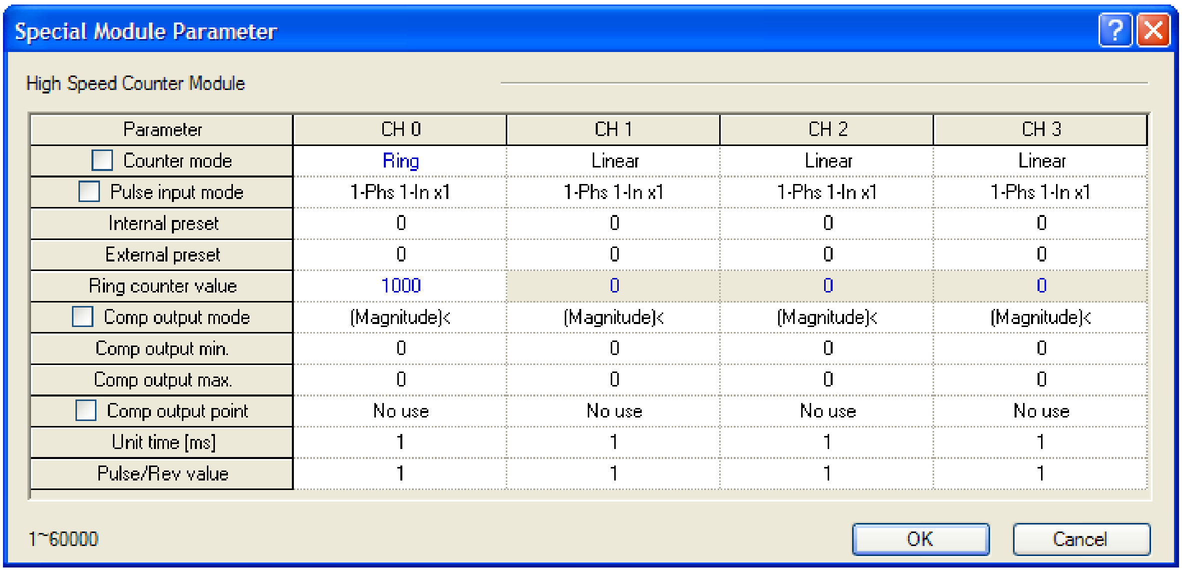
4) If Borrow occurs, count stops and decreasing is not available but increasing is available.



(b) Ring count

■ Ring Count range: user-defined minimum value ~ user-defined maximum value

■ Count display: If Ring Counted, user-defined minimum value of Ring Count is counted and displayed, but the value is not displayed.



Special Module Parameter

High Speed Counter Module

Parameter	CH 0	CH 1	CH 2	CH 3
Counter mode	Ring	Linear	Linear	Linear
Pulse input mode	1-Phs 1-In x1	1-Phs 1-In x1	1-Phs 1-In x1	1-Phs 1-In x1
Internal preset	0	0	0	0
External preset	0	0	0	0
Ring counter value	1000	0	0	0
Comp output mode	(Magnitude)<	(Magnitude)<	(Magnitude)<	(Magnitude)<
Comp output min.	0	0	0	0
Comp output max.	0	0	0	0
Comp output point	No use	No use	No use	No use
Unit time [ms]	1	1	1	1
Pulse/Rev value	1	1	1	1

1~60000

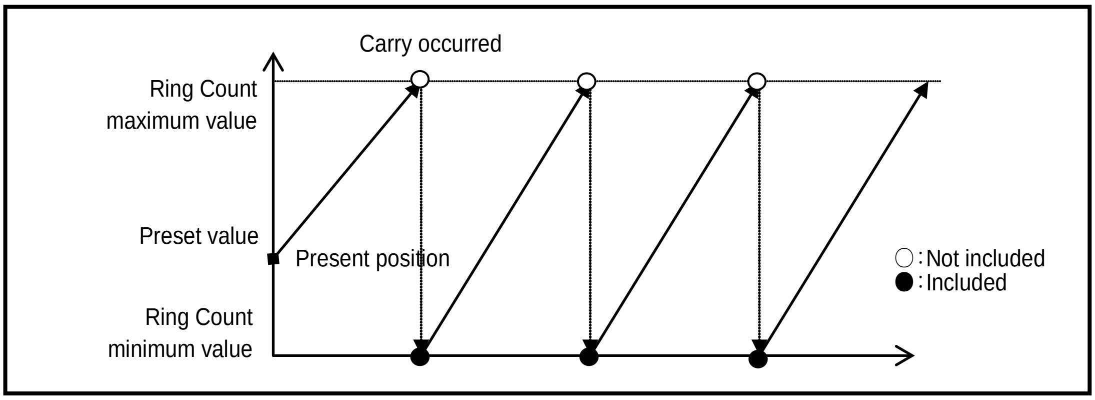
OK Cancel

• Ring counter value is saved at the following special K area.

type	Area per each channel (Double word)				Reference
	Ch.0	Ch.1	Ch.2	Ch.3	
Ring counter value	K310	K340	K270	K400	

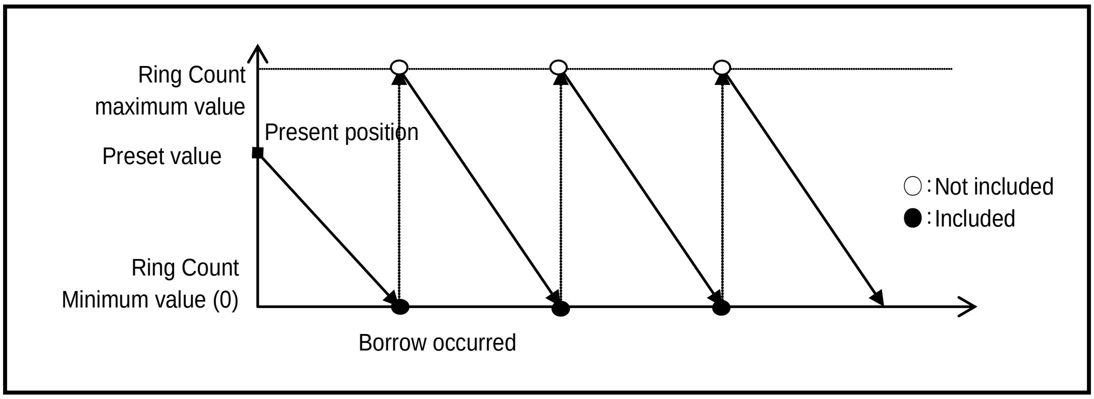
1) During increasing count

■ Even if count value exceeds user-defined maximum value during increasing count, Carry only occurs and count does not stop differently to Linear Count.



2) During decreasing count

■ Even if count value exceeds user-defined minimum value during decreasing count, Borrow only occurs and count does not stop differently to Linear Count.



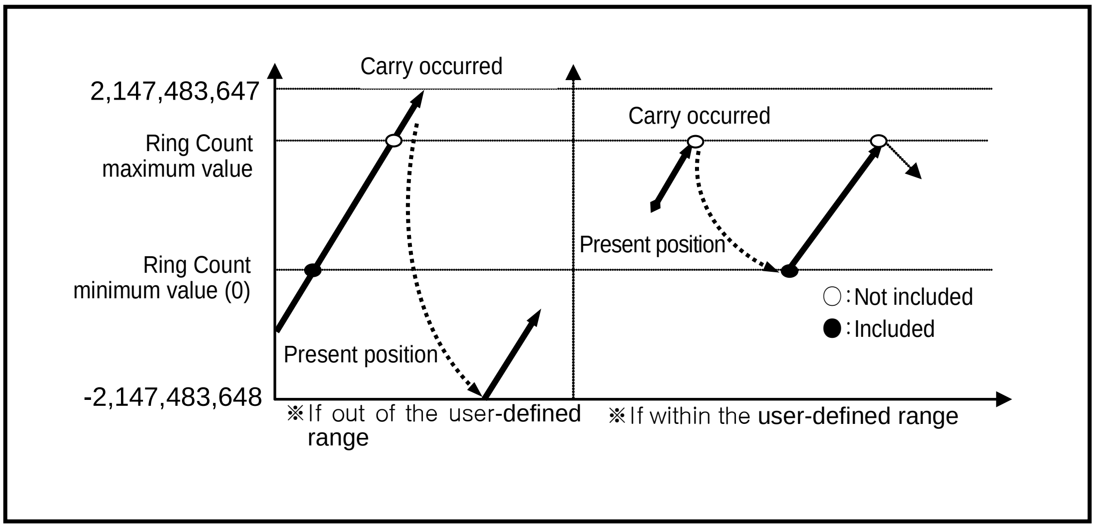
3) Operation when setting Ring Count based on present count value (during increasing count)

■ If present count value exceeds user-defined range when setting Ring Count

- Error (code no. 27) is occurred and it operates linear counter.

■ If present count value is within user-defined range when setting Ring Count

- Present count value starts to increase up to the user-defined maximum value and down to the user-defined minimum value and keeps counting after Carry occurs.
- Not the maximum but the minimum value only is displayed with count kept on as shown below.



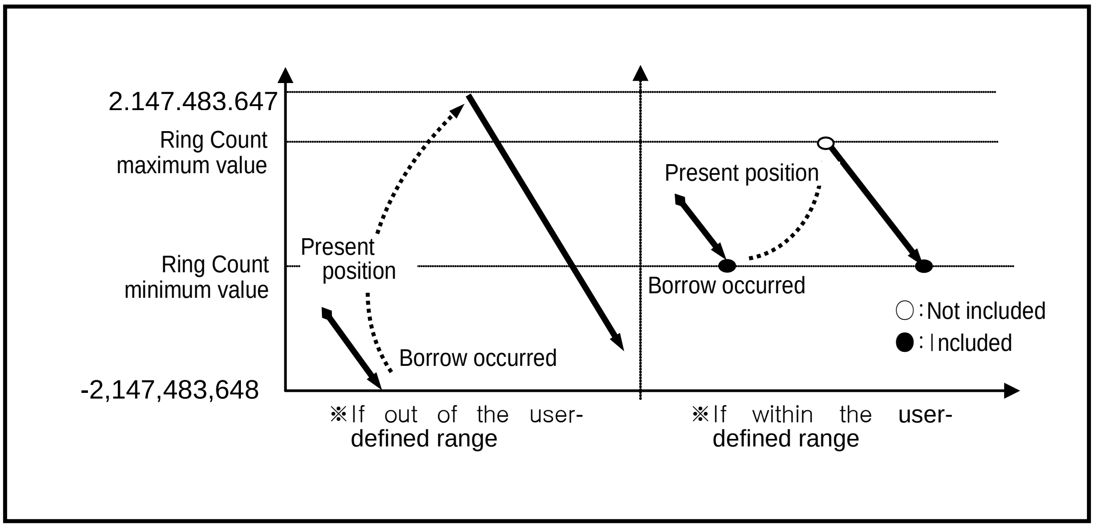
4) Operation when setting Ring Count based on present count value (during decreasing count)

■ If present count value exceeds user-defined range when setting Ring Count

- Error (code no. 27) is occurred and it operates linear counter.

■ If present count value is within user-defined range when setting Ring Count

- Present count value starts to decrease down to the user-defined minimum value and up to the user-defined maximum value and keeps counting after Borrow occurs.



Remark

(1) Based on count value within or out of user-defined range, count will be decided to be within or out of the range when setting Ring Count.

(2) Ring Count setting when count value is out of the range is regarded as user's mistake. The count is not available within the Ring Count range.

(3) Use preset function or the like when using Ring Count so to surely position the count value within the range.

(3) Compared output

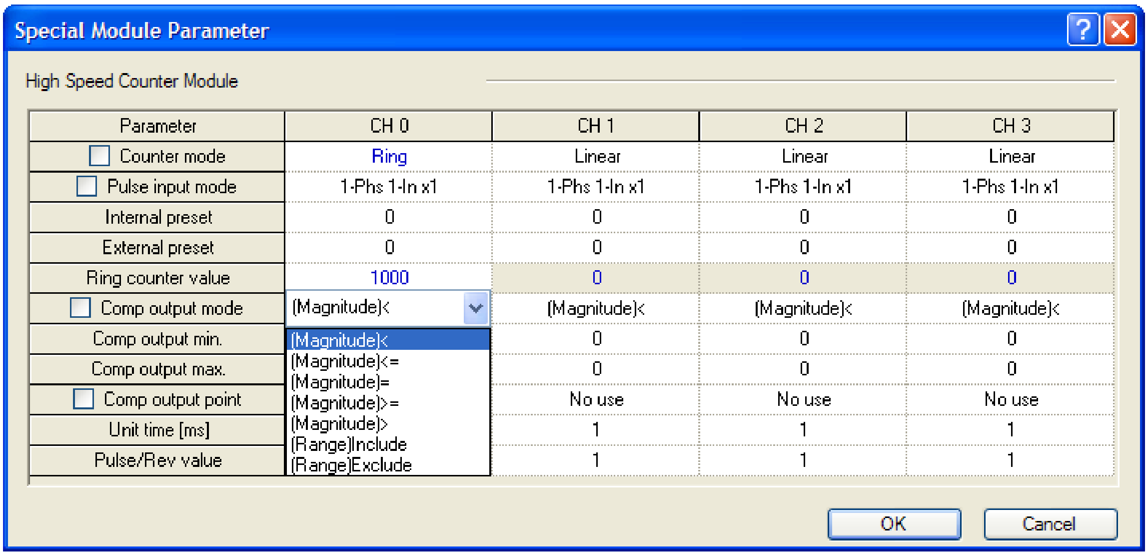
(a) High Speed counter module has a compared output function used to compare present count value with compared value in size to output as compared.

(b) Available compared outputs are 2 for 1 channel, which can be used separately.

(c) Compared output conditions are 7 associated with >, =, < .

(d) Parameter setting

■ Compared output mode setting



■ Upper setting value is saved in special K area.

Compared output condition	Memory address (word)	Value[*2)]
Present Value < Compared Value	Channel 0 : K302 Channel 1 : K330 Channel 2 : K358 Channel 3 : K386	Set to “0”
Present Value ≤ Compared Value		Set to “1”
Present Value = Compared Value		Set to “2”
Present Value ≥ Compared Value		Set to “3”
Present Value > Compared Value		Set to “4”
Compared value 1 ≤ Count value ≤ Compared value 2		Set to “5”
Count value ≤ Compared value 1, Count value ≥ Compared value 2		Set to “6”

*2) If compared output value not set to 0~6 using counter, error code ‘23’ will be occurred.

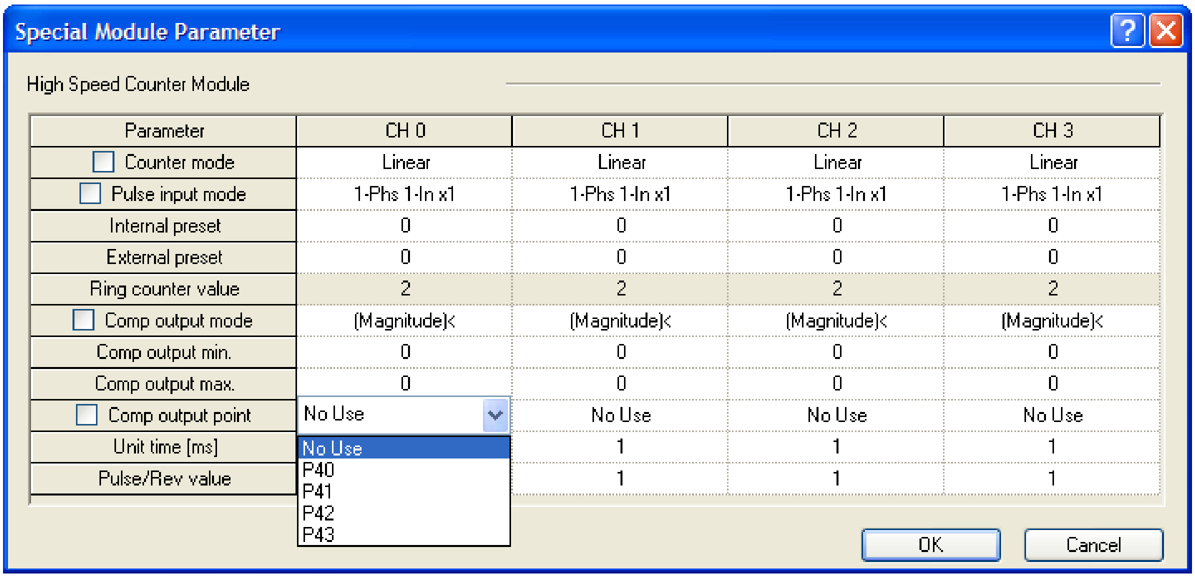
■ In order to make actual comparison enabled after compared output condition set, the compared enable signal is to be On.

Classification	Area per channel				Operation
	Ch. 0	Ch. 1	Ch. 2	Ch. 3	
Count enable signal	K2600	K2700	K2800	K2900	0: N/A, 1: enable
Compared enable signal	K2604	K2704	K2804	K2904	0: forbidden, 1: enable

▪ In order to make external output, the compared equivalent output signal (P20~P27) must be set. If Compared output contact is Off, Compared coincidence output signal (internal device) is only output.

Classification	Area per channel				Operation
	Ch. 0	Ch. 1	Ch. 2	Ch. 3	
Compared equivalent output signal	K2612	K2712	K2812	K2912	0: Compared output not equivalent 1: Compared output equivalent

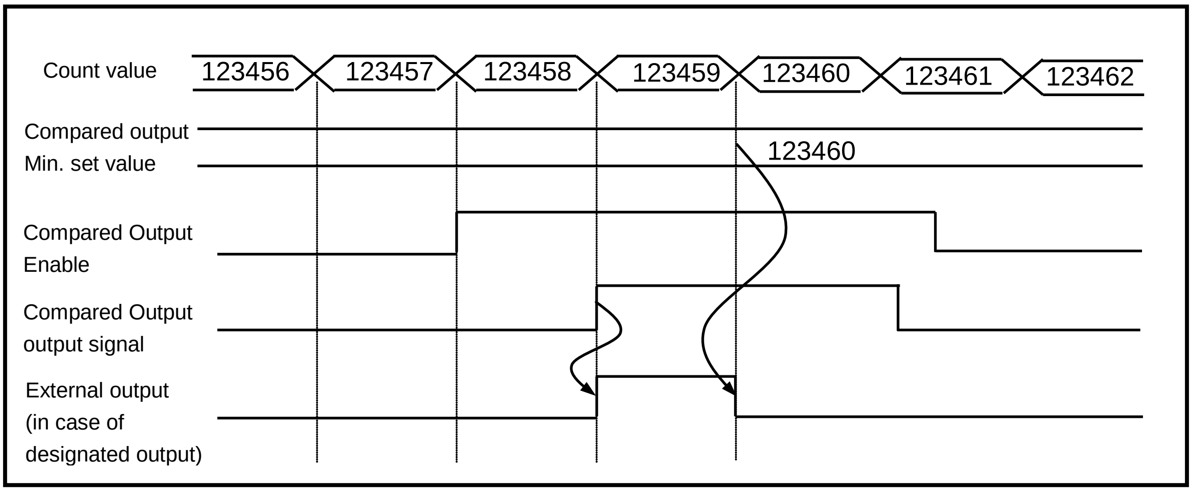
• Comp output point (P40 ~ P43) setting



(e) Detailed description for compared output

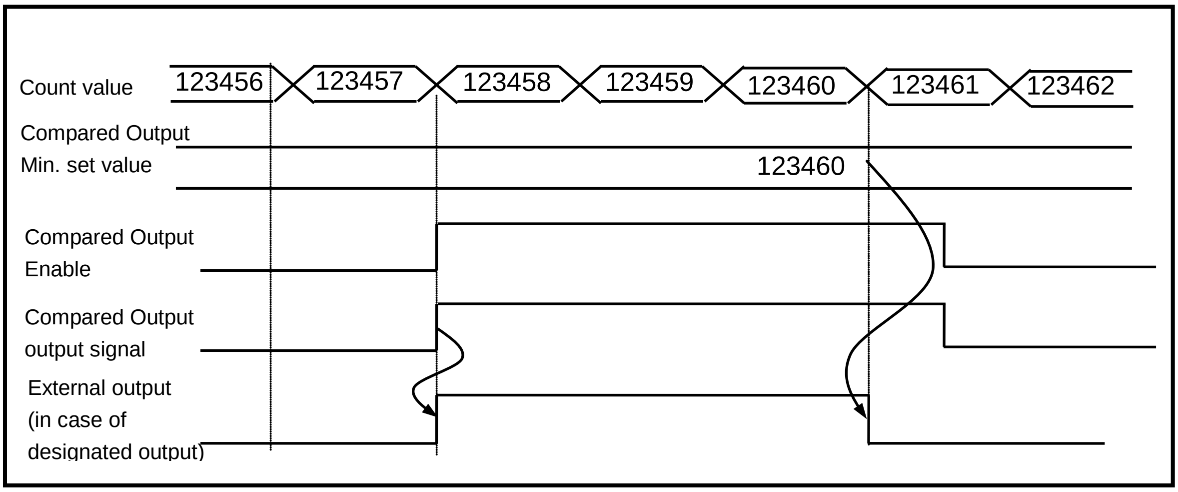
1) Mode 0 (Present value < Compared value)

■ If counted present value is less than compared value, output is sent out, and if present value increases to be equal to or greater than compared value, output is not sent out.



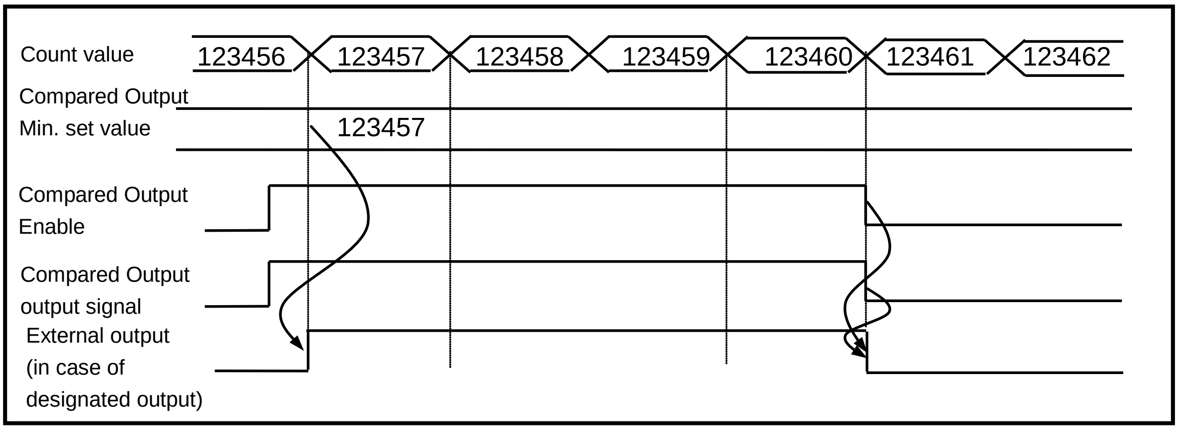
2) Mode1 (Count value ≤ Compared value)

■ If present count value is less than or equal to compared value, output is sent out, and if count value increases to be greater than compared value, output is not sent out.



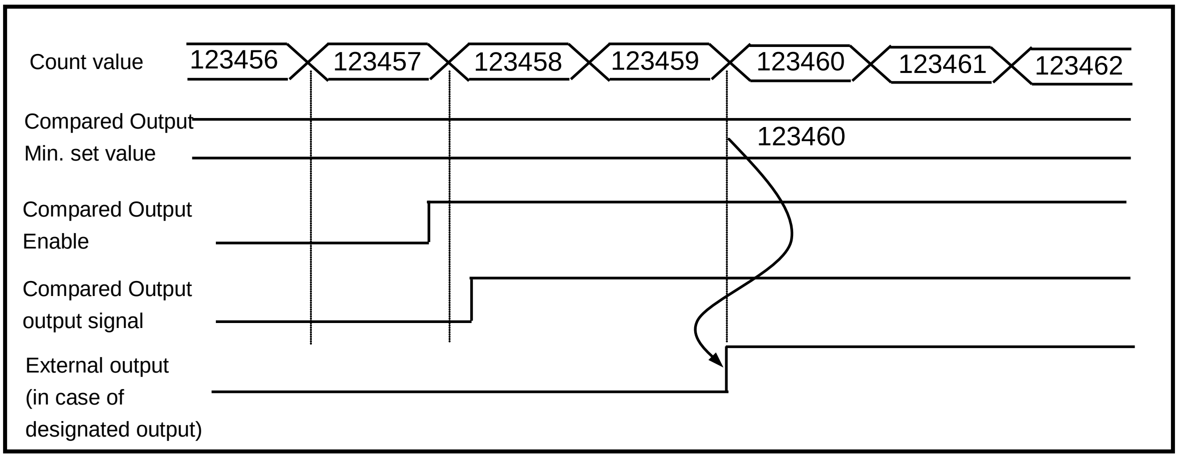
3) Mode 2 (Count value = Compared value)

■ If present count value is equal to compared value, output is sent out. In order to turn the output Off, Compared output Enable and Compared output signal is to be On.



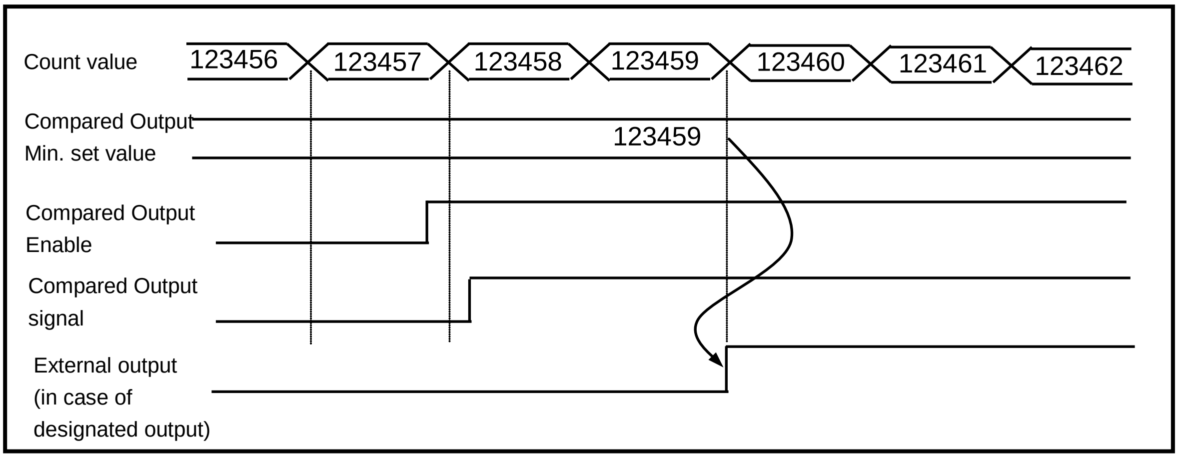
4) Mode 3 (Count value ≥ Compared value)

■ If present count value is greater than or equal to compared value, output is sent out, and if count value decreases to be less than compared value, output is not sent out.



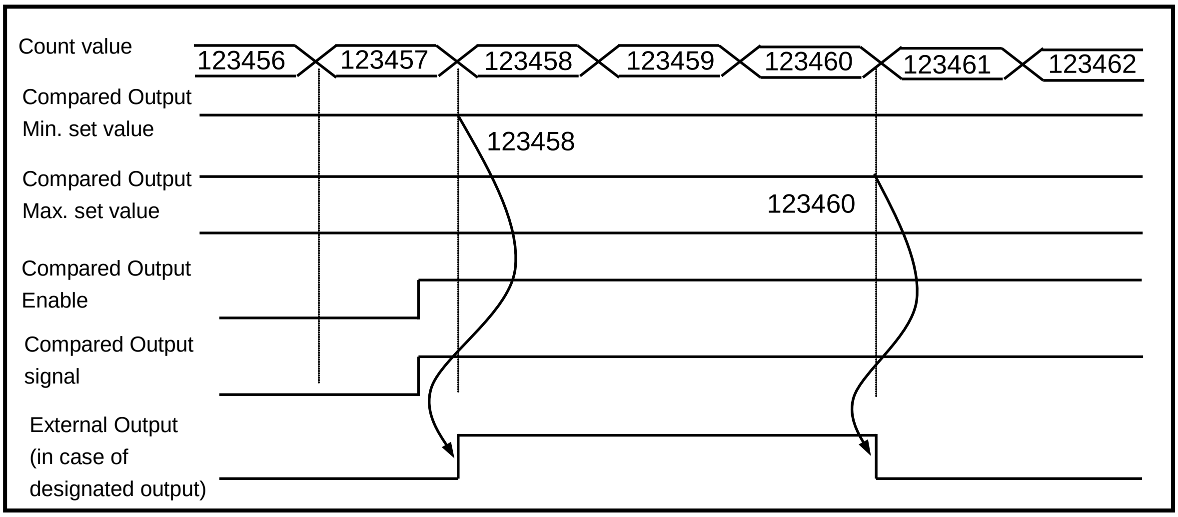
5) Mode 4 (Count value > Compared value)

■ If present count value is greater than compared value, output is sent out, and if count value decreases to be less than or equal to compared value, output is not sent out.



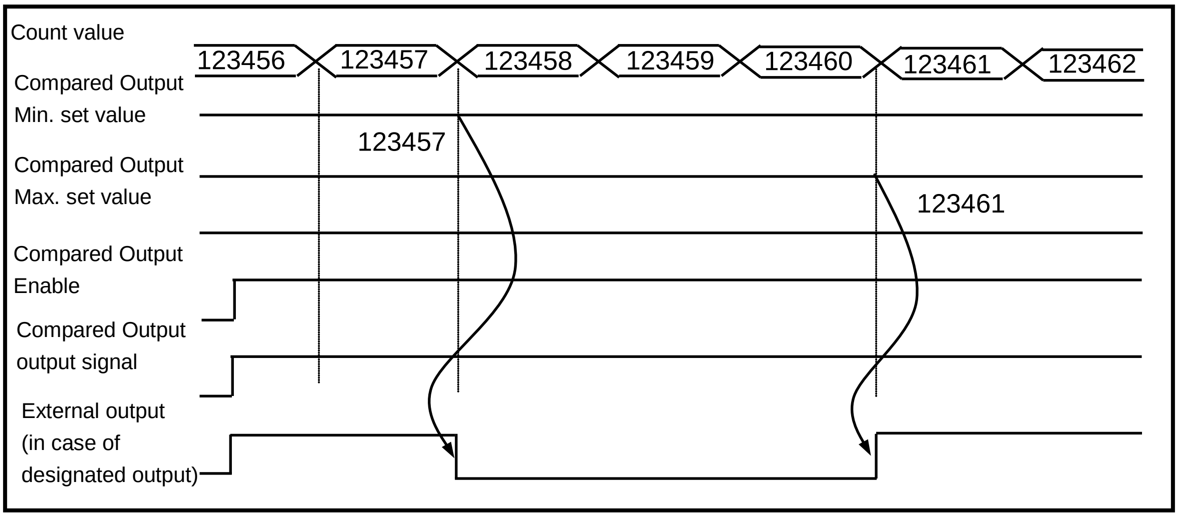
6) Mode 5 (Compared output Min. set value ≤ Count value ≤ Compared output Max. set value)

■ If present count value is greater than or equal to compared output Min. value and less than or equal to compared output Max. set value, output is sent out, and if count value increases/decreases to exceed compared value's range, output is not sent out.



7) Mode 6 (Count value ≤ Compared output Min. value, Count value ≥ Compared output Max. value)

■ If present count value is less than or equal to compared output Min. value and greater than or equal to compared output Max. value, output is sent out, and if count value increases/decreases to exceed compared value's range, output is not sent out.



(4) Carry signal

(a) Carry signal occurs

1) When count range maximum value of 2,147,483,647 is reached during Linear Count.

2) When user-defined maximum value of Ring Count changed to the minimum value during Ring Count.

(b) Count when Carry Signal occurs

1) Count stops if Carry occurs during Linear Count.

2) Count does not stop even if Carry occurs during Ring Count.

(c) Carry reset

1) The Carry generated can be cancelled by Carry/Borrow reset signal On.

Classification	Device area per channel			
	Channel 0	Channel 1	Channel 2	Channel 3
Carry signal	K2610	K2710	K2810	K2910

(5) Borrow signal

(a) Borrow signal occurs

1) When count range minimum value of -2,147,483,648 is reached during Linear Count.

2) When user-defined minimum value of Ring Count changed to the maximum value during Ring Count.

(b) Count when Borrow signal occurs

1) Count stops if Borrow occurs during Linear Count.

2) Count does not stop even if Borrow occurs during Ring Count.

(c) Borrow reset

1) The Borrow generated can be cancelled by Carry/Borrow reset signal On..

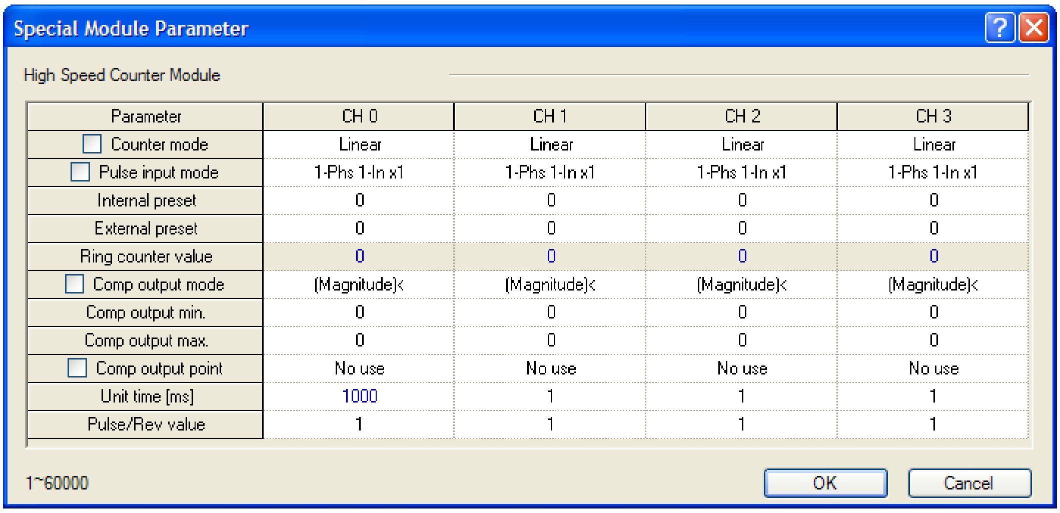
Classification	Device area per channel			
	Channel 0	Channel 1	Channel 2	Channel 3
Borrow signal	K2611	K2711	K2811	K2911

6) Revolution/Unit time

While auxiliary mode enable signal is On, it counts the number of input pulses for a specified time.

(a) Setting

1) Input unit time and pulse number per 1 revolution



Parameter	CH 0	CH 1	CH 2	CH 3
Counter mode	Linear	Linear	Linear	Linear
Pulse input mode	1-Phs 1-In x1	1-Phs 1-In x1	1-Phs 1-In x1	1-Phs 1-In x1
Internal preset	0	0	0	0
External preset	0	0	0	0
Ring counter value	0	0	0	0
Comp output mode	(Magnitude)<	(Magnitude)<	(Magnitude)<	(Magnitude)<
Comp output min.	0	0	0	0
Comp output max.	0	0	0	0
Comp output point	No use	No use	No use	No use
Unit time [ms]	1000	1	1	1
Pulse/Rev value	1	1	1	1

Setting value is saved at the following special K are and user can designate it directly.

Classification	Device area per channel			
	Channel 0	Channel 1	Channel 2	Channel 3
Unit time (1~60000㎳)*3)	K322	K352	K382	K412

*3) If revolution per unit time is enabled and unit time value is other than 1~60000ms, error code '34' occurs.

2) Input pulse number per 1 revolution

Classification	Device area per channel			
	Channel 0	Channel 1	Channel 2	Channel 3
Pulse number /revolution (1~60000)*4)	K323	K353	K383	K413

*4) If revolution per unit time is enabled and pulse number/revolution is other than 1~60000, error code '35' occurs.

3) If Count function of revolution per unit time is used, enable signal set by On.

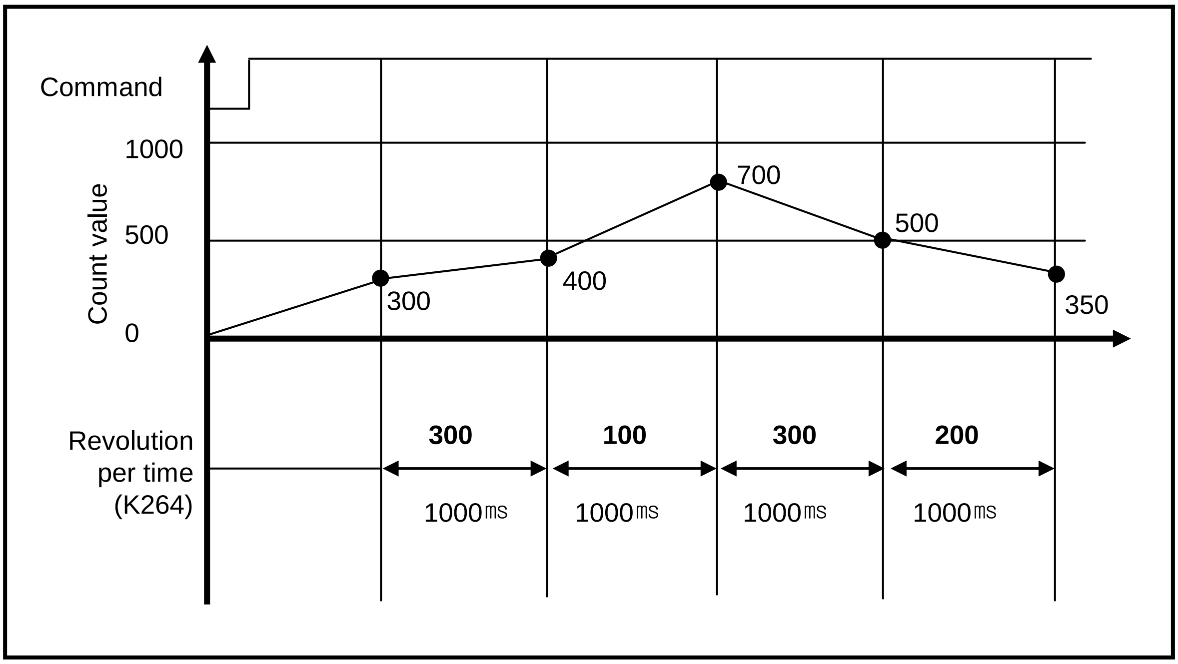
Classification	Device area per channel			
	Channel 0	Channel 1	Channel 2	Channel 3
Revolution/unit time command	K2605	K2705	K2805	K2905

(a) Count function of Revolution per Unit time is used to count the number of pulses for a specified time while Enable signal is On.

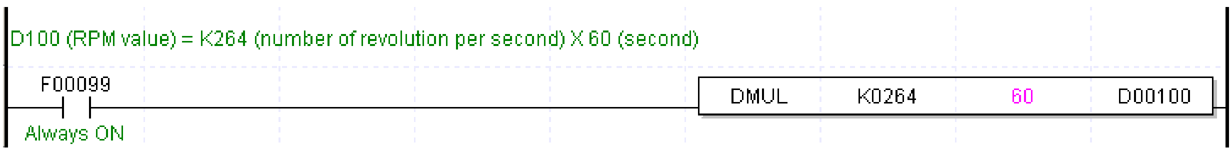
(b) With the displayed number of pulses updated for a specified time and the number of pulses per revolution input, Revolution/Unit time can be counted.

(c) Number of Revolution per 1 second is indicated after number of pulse per 1 revolution is set and time is set to 1 second (1000ms). In order to indicate by Revolutions per minute (RPM), the operation is executed in program.

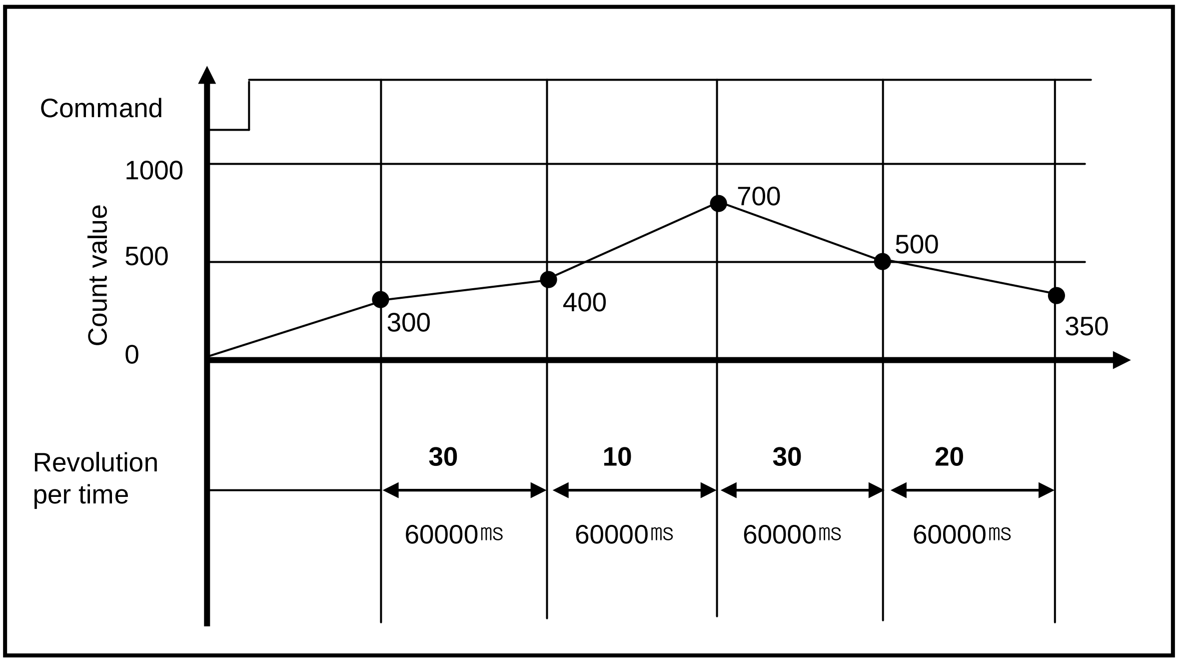
(d) The example that number of pulse per 1 revolution set to '1' and time is set to 1000 ms is as shown below. (Ch0)



(f) In order to indicate revolution per minute (RPM), the program is as shown below. In case of DMUL operation, RPM value is saved 64 bit in D100~D103. If operated RPM value is used, it can use to Word or Dword type according to system (case of RPM value is small number).



(g) The example that number of pulse per 1 revolution set to ‘10’ and time is set to 60,000 ms is as shown below.



(7) Count latch

(a) When Count latch signal is On, present count value is latched.

(b) Setting

If present counter value is to latch, Count Latch function is set ‘Use’.

Classification	Device area per channel			
	Channel 0	Channel 1	Channel 2	Channel 3
Count latch command	K2606	K2706	K2806	K2906

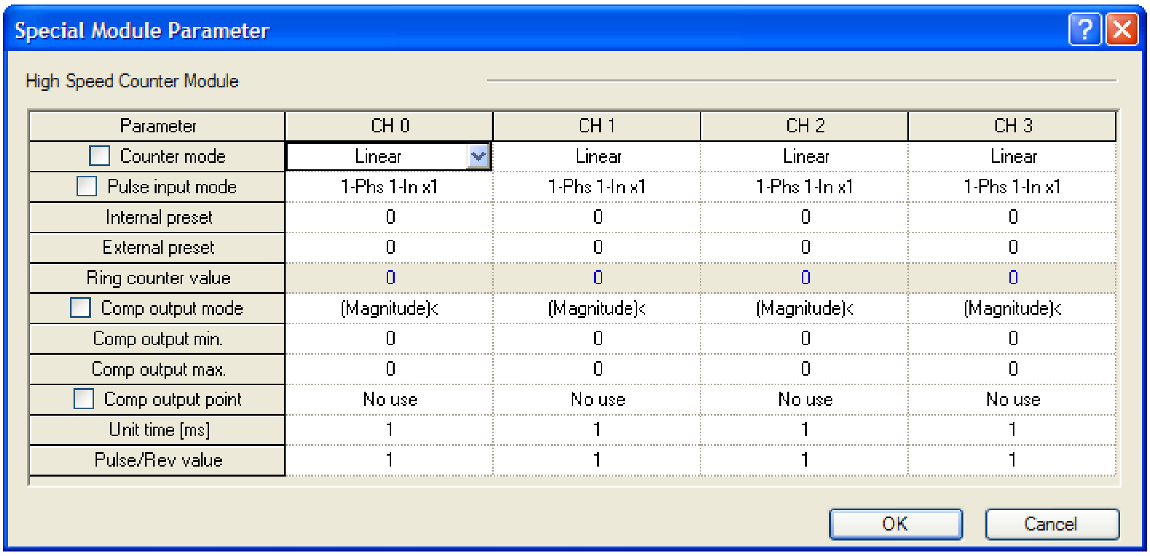
(c) Count latch function is operated when Count latch signal is On. Namely, counter value is not cleared when power supply Off =>On and mode change, it is counted from previous value.

(d) In latch counter function, internal or external preset function has to use for clearing present value.

(8) Preset function

It changes the current value into preset value.

There are two types of preset function, internal preset and external preset. External preset is fixed as input contact point.



• Preset setting value is saved at the following special K area.

Type	Area per each channel (Double word)				Ref.
	Ch.0	Ch.1	Ch.2	Ch.3	
Internal preset	K304	K334	K364	K394	-
External preset	K306	K336	K366	K396	-

• Preset command is specified through the following special K area, external preset is used by executing the designated input contact point after allowance bit is on.

Type	Area per each channel (Bit)				Ref.
	Ch.0	Ch.1	Ch.2	Ch.3	
Internal preset command	K2601	K2701	K2801	K2901	-
External preset allowance	K2602	K2702	K2802	K2902	-
External preset command	P004	P005	P006	P007	-

8.1.4 “S(U)” type Functions

(1) Counter mode

(a) High Speed counter module can count High Speed pulses which can not be processed by CPU module’s counter instructions (CTU, CTD, CTUD, etc.), up to binary value of 32 bits (-2,147,483,648 ~ 2,147,483,647).

(b) Available input is 1-phase input, 2-phase input and CW/ CCW input.

(c) Count increasing/decreasing methods are as follows;

1) For 1-phase input: a) Increasing/decreasing count operation by program setting
b) Increasing/decreasing count operation by B-phase input signal

2) For 2-phase input: setting by difference in phase between A-phase and B-phase

3) For CW/CCW input: Increasing operation if B-phase is LOW with A-phase input, and Decreasing operation if A-phase is LOW with B-phase input.

(d) Auxiliary modes are as follows;

1) Count Latch

2) Count function about the number of revolution per unit time

(e) Pulse input mode

1) 1 phase count mode

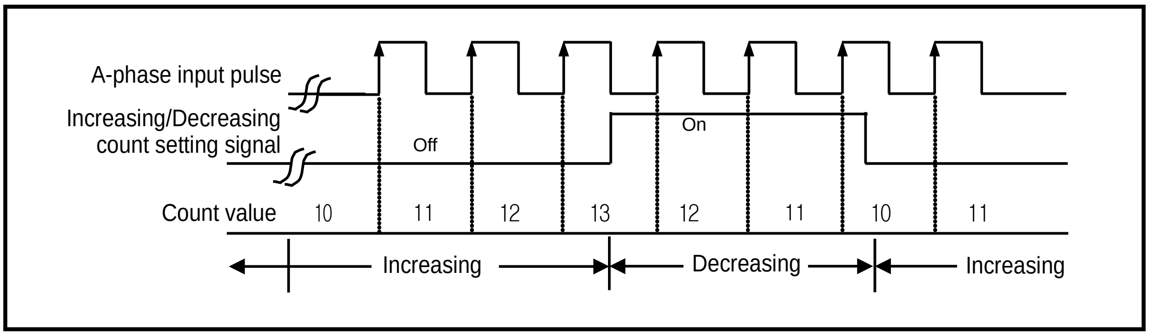
a) Increasing/decreasing count operation by program setting

● 1-phase 1-input 1-multiplication operation mode

A-phase input pulse counts at rising and increasing/decreasing will be decided by the applicable program.

Increasing/Decreasing classification	A-phase input pulse rising	A-phase input pulse falling
Increasing/decreasing count setting signal Off	Increasing count	-
Increasing/decreasing count setting signal On	Decreasing count	-

● Operation example



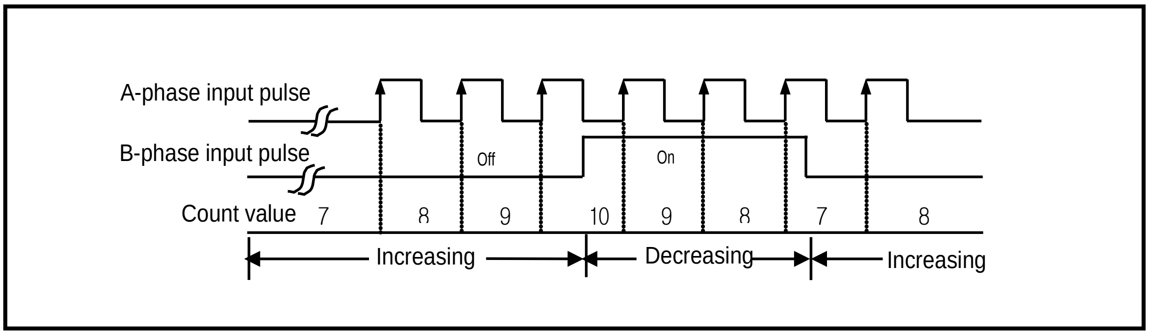
b) Increasing/decreasing count operation by B-phase input signal

● 1-phase 2-input 1-multiplication operation mode

A-phase input pulse counts at rising and increasing/decreasing will be decided by B-phase.

Increasing/Decreasing classification	A-phase input pulse rising	A-phase input pulse falling
B-phase input pulse Off	Increasing count	-
B-phase input pulse On	Decreasing count	-

● Operation example

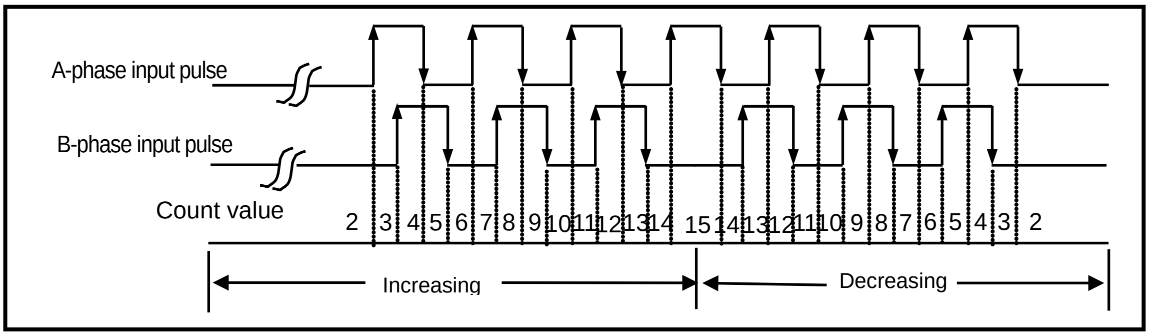


2) 2-phase count mode

a) 2-phase 4-multiplication operation mode

A-phase input pulse and B-phase input pulse count at rising/falling respectively. If A-phase input is antecedent to B-phase input, increasing operation starts, and if B-phase input is antecedent to A-phase input, decreasing operation starts.

▪ Operation example



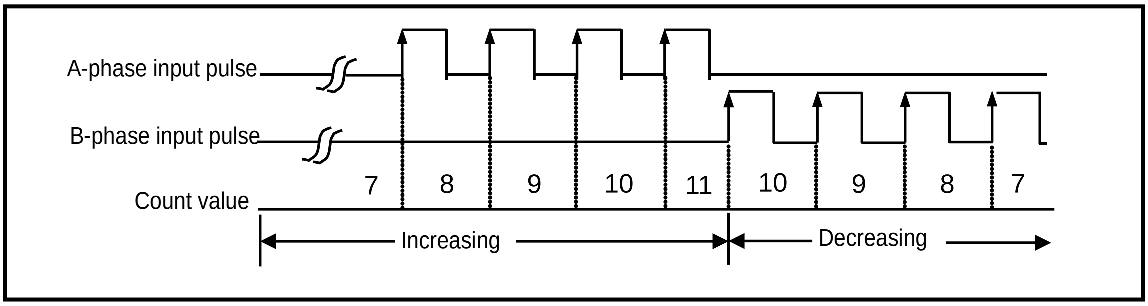
3) CW(Clockwise)/CCW(Counter Clockwise) operation mode

A-phase input pulse counts at rising , or B-phase input pulse counts at rising.

Increasing operation executed when B-phase input pulse is Low with A-phase input pulse at rising, and Decreasing operation executed when A-phase input pulse is Low with B-phase input pulse at rising.

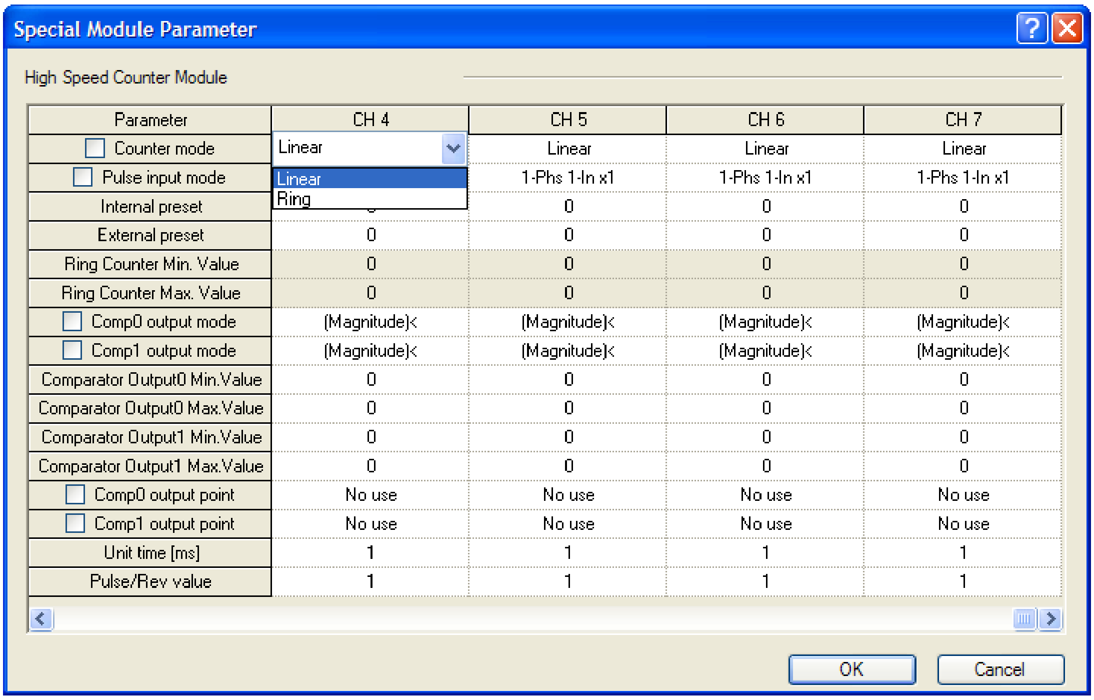
Increasing/Decreasing classification	A-phase input pulse High	A-phase input pulse Low
B-phase input pulse High	-	decreasing count
B-phase input pulse Low	Increasing count	-

▪ Operation example



(2) Counter mode

2 types of count (Linear counter, Ring counter) can be selected for the applicable use based on functions.



▪ Counter mode is saved at the following special K area.

Mode	Area per each channel (word)								Ref.
	Ch.0	Ch.1	Ch.2	Ch.3	Ch.4	Ch.5	Ch.6	Ch.7	
Counter mode	K300	K330	K360	K390	K2220	K2250	K2280	K2310	0 : linear 1 : ring

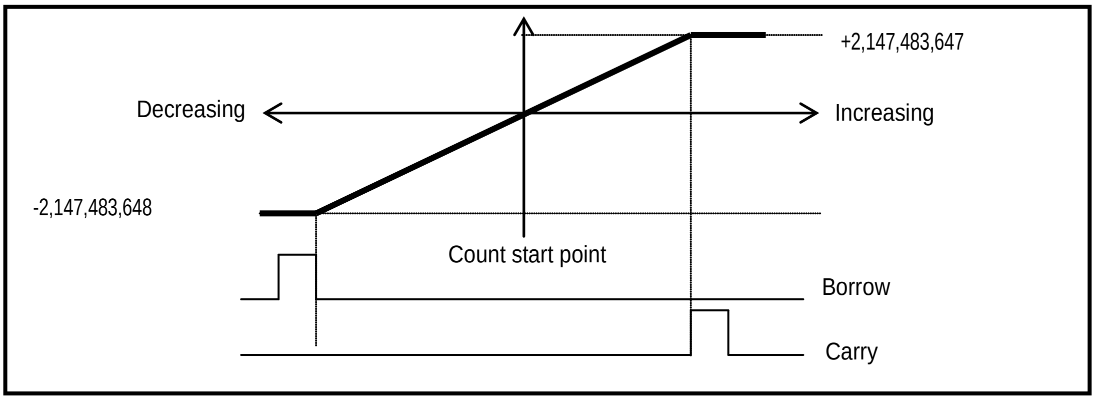
(a) Linear counter

■ Linear Count range: -2,147,483,648 ~ 2,147,483,647

■ If count value reaches the maximum value while increased, Carry will occur, and if count value reaches the minimum value while decreased, Borrow will occur.

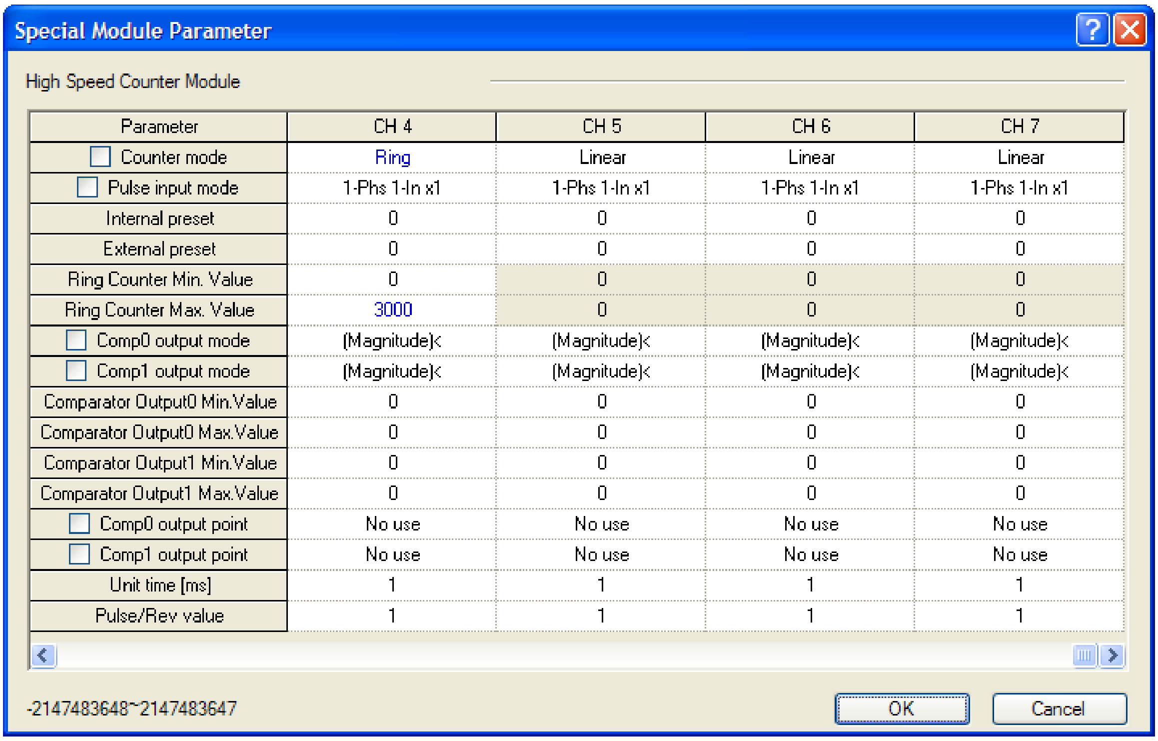
■ If Carry occurs, count stops and increasing is not available but decreasing is available.

■ If Borrow occurs, count stops and decreasing is not available but increasing is available.



(b) Ring count

Set Ring Counter Min. Value and Max. value. Preset value and compared set value should be in range of ring counter min. value and max. value.



Parameter	CH 4	CH 5	CH 6	CH 7
Counter mode	Ring	Linear	Linear	Linear
Pulse input mode	1-Phs 1-In x1	1-Phs 1-In x1	1-Phs 1-In x1	1-Phs 1-In x1
Internal preset	0	0	0	0
External preset	0	0	0	0
Ring Counter Min. Value	0	0	0	0
Ring Counter Max. Value	3000	0	0	0
Comp0 output mode	(Magnitude)<	(Magnitude)<	(Magnitude)<	(Magnitude)<
Comp1 output mode	(Magnitude)<	(Magnitude)<	(Magnitude)<	(Magnitude)<
Comparator Output0 Min.Value	0	0	0	0
Comparator Output0 Max.Value	0	0	0	0
Comparator Output1 Min.Value	0	0	0	0
Comparator Output1 Max.Value	0	0	0	0
Comp0 output point	No use	No use	No use	No use
Comp1 output point	No use	No use	No use	No use
Unit time [ms]	1	1	1	1
Pulse/Rev value	1	1	1	1

• Ring counter max. and min value is saved at the following special K area.

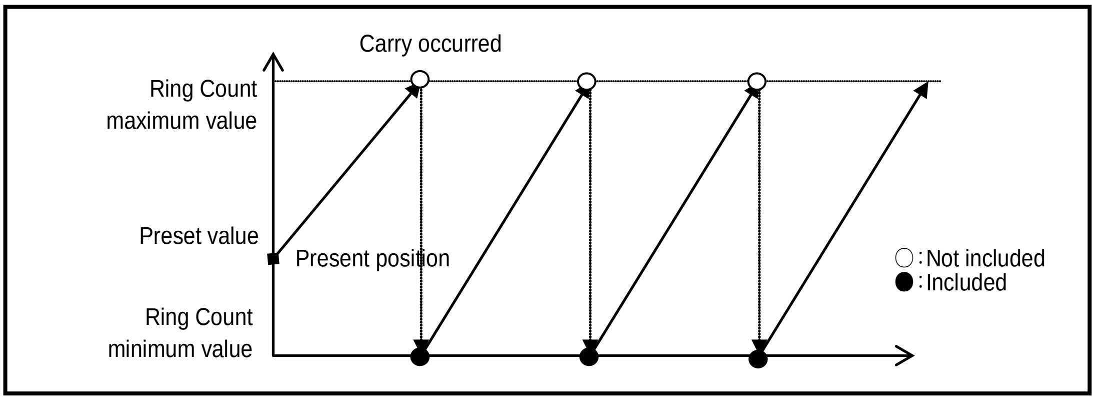
type	Area per each channel (Double word)								Ref.
	Ch.0	Ch.1	Ch.2	Ch.3	Ch.4	Ch.5	Ch.6	Ch.7	
Ring counter min. value	K308	K338	K368	K398	K2228	K2258	K2288	K2318	-
Ring counter max. value	K310	K340	K270	K400	K2230	K2260	K2290	K2320	-

▪ Range of Ring counter: user defined min. value ~ user defined max. value

▪ Counter display: in case of using ring counter, user defined max. value is not displayed.

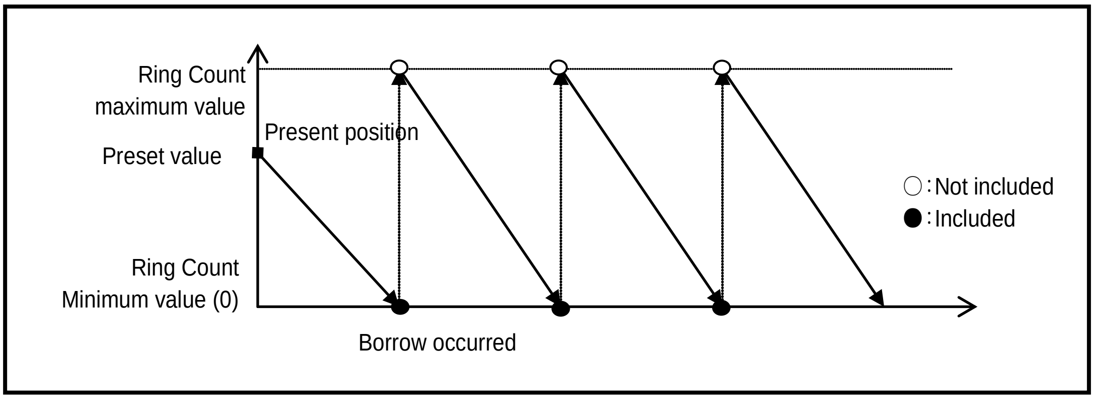
1) During increasing count

■ Even if count value exceeds user-defined maximum value during increasing count, Carry only occurs and count does not stop differently to Linear Count.



2) During decreasing count

■ Even if count value exceeds user-defined minimum value during decreasing count, Borrow only occurs and count does not stop differently to Linear Count.



3) Operation when setting Ring Count based on present count value (during increasing count)

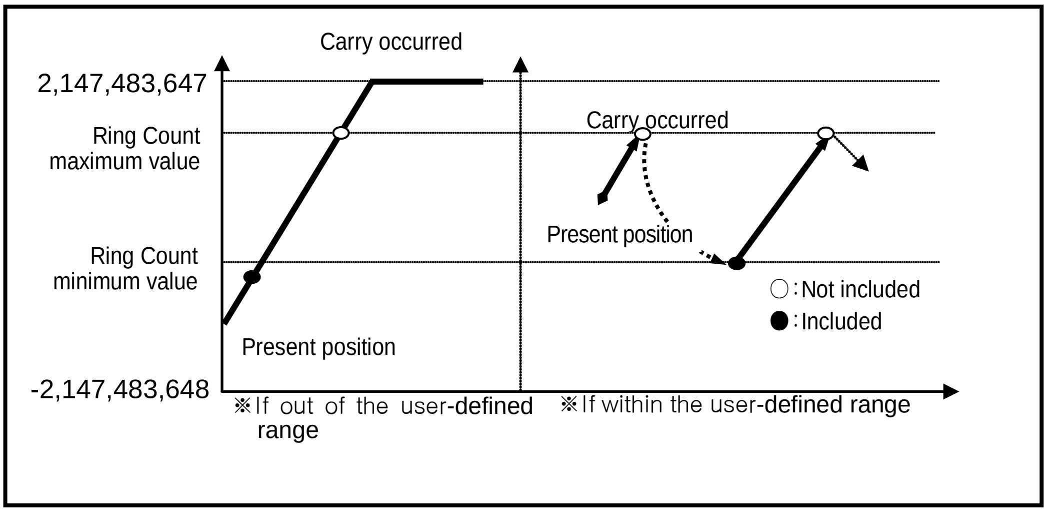
■ If present count value exceeds user-defined range when setting Ring Count

- Error (code no. 27) is occurred and it operates linear counter.

■ If present count value is within user-defined range when setting Ring Count

- Present count value starts to increase up to the user-defined maximum value and down to the user-defined minimum value and keeps counting after Carry occurs.

- Not the maximum but the minimum value only is displayed with count kept on as shown below.



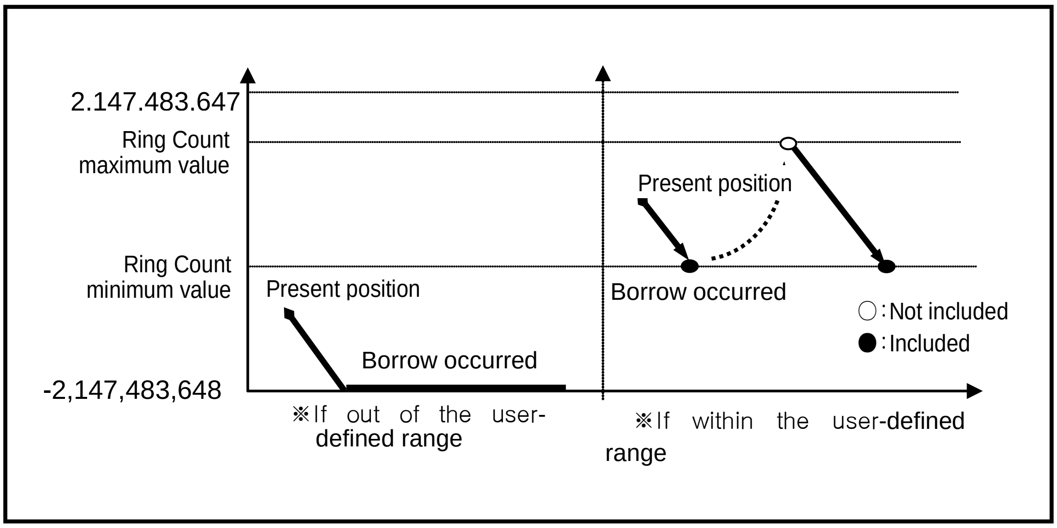
4) Operation when setting Ring Count based on present count value (during decreasing count)

■ If present count value exceeds user-defined range when setting Ring Count

- Error (code no. 27) is occurred and it operates linear counter.

■ If present count value is within user-defined range when setting Ring Count

- Present count value starts to decrease down to the user-defined minimum value and up to the user-defined maximum value and keeps counting after Borrow occurs.



Remark

(1) Based on count value within or out of user-defined range, count will be decided to be within or out of the range when setting Ring Count.

(2) Ring Count setting when count value is out of the range is regarded as user's mistake. The count is not available within the Ring Count range.

(3) Use preset function or the like when using Ring Count so to surely position the count value within the range.

(3) Compared output

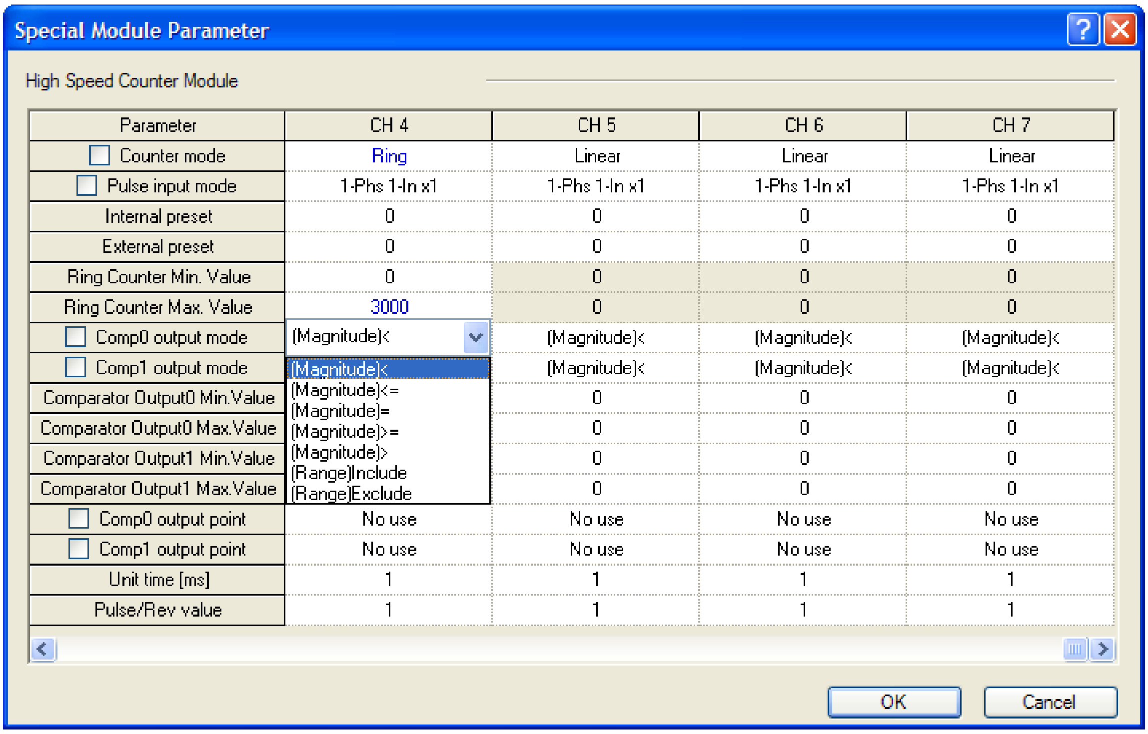
(a) High Speed counter module has a compared output function used to compare present count value with compared value in size to output as compared.

(b) Available compared outputs are 2 for 1 channel, which can be used separately.

(c) Compared output conditions are 7 associated with >, =, < .

(d) Parameter setting

■ Comp. output mode setting



■ Upper setting value is saved in special K area.

Compared output condition	Memory address (word) Comp output 0	Memory address (word) Comp output 1	Value[*2)]
Present Value < Compared Value	Ch.0 K302 Ch.1 K332 Ch.2 K362 Ch.3 K392 Ch.4 K2222 Ch.5 K2252 Ch.6 K2282 Ch.7 K2312	Ch.0 K303 Ch.1 K333 Ch.2 K363 Ch.3 K393 Ch.4 K2223 Ch.5 K2253 Ch.6 K2283 Ch.7 K2313	Set to “0”
Present Value ≤ Compared Value			Set to “1”
Present Value = Compared Value			Set to “2”
Present Value ≥ Compared Value			Set to “3”
Present Value > Compared Value			Set to “4”
Compared value 1 ≤ Count value ≤ Compared value 2			Set to “5”
Count value ≤ Compared value 1, Count value ≥ Compared value 2			Set to “6”

[*2)] If compared output mode set value is other than 0~6 at using counter, error code ‘23’ occurs.

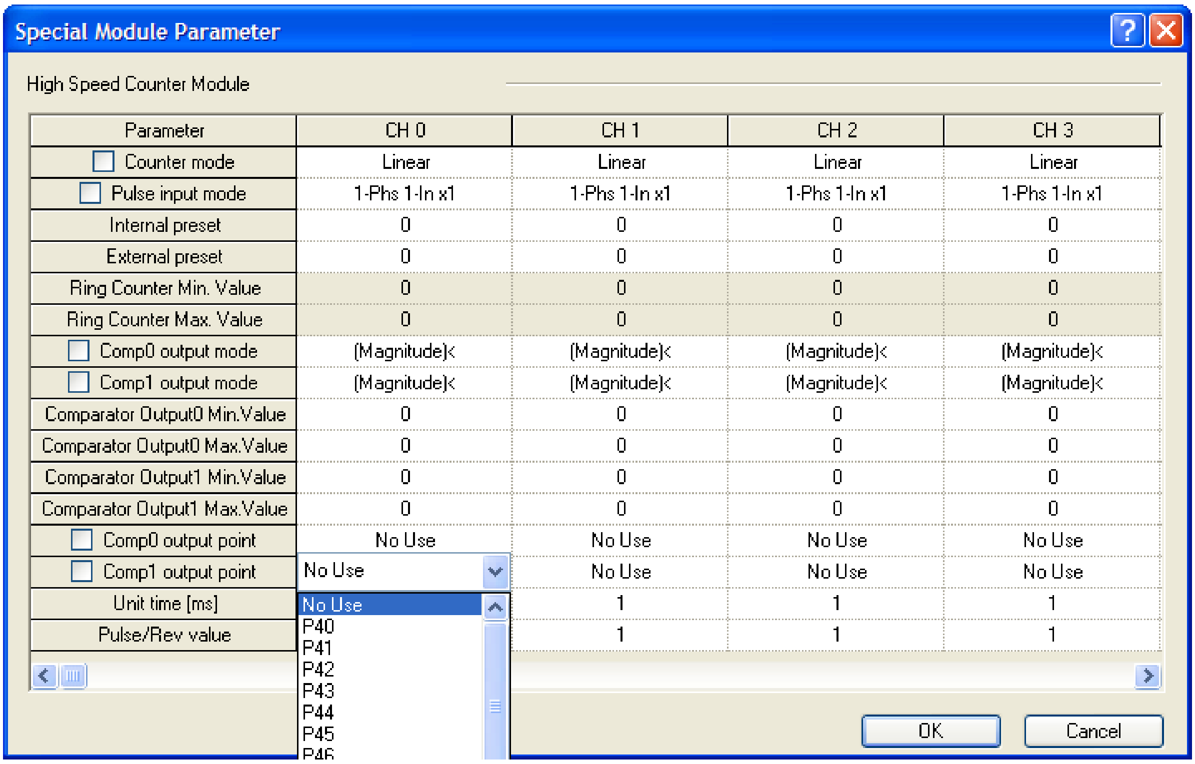
■ In order to output the compared output signal, compared output enable flag set to '1' after compared output condition set.

Classification	Area per channel								Operation
	Ch. 0	Ch. 1	Ch. 2	Ch. 3	Ch. 4	Ch. 5	Ch. 6	Ch. 7	
Count enable signal	K2600	K2700	K2800	K2900	K21800	K21900	K22000	K22100	0:disable, 1: enable
Compared 0 enable signal	K2604	K2704	K2804	K2904	K21804	K21904	K22004	K22104	0: disable, 1: enable
Compared 1 enable signal	K2607	K2707	K2807	K2907	K21807	K21907	K22007	K22107	0: disable, 1: enable

▪ In order to make external output, the compared coincidence output signal (P20~P2F) must be set. If Compared output contact is 'Off' at Special Module Parameter Setting of XG5000, Compared coincidence output signal (internal device) is only output.

Classification	Area per channel							Operation
	Ch. 0	Ch. 1	Ch. 2	Ch.4	Ch.5	Ch. 6	Ch.7	
Compared coincidence output signal 0	K2612	K2712	K2812	K2912	K21812	K22012	K22112	0: Compared output Off 1: Compared output On
Compared coincidence output signal 1	K2613	K2713	K2813	K2913	K21813	K22013	K22113	0: Compared output Off 1: Compared output On

• Comp. output point (P40 ~ P4F) setting

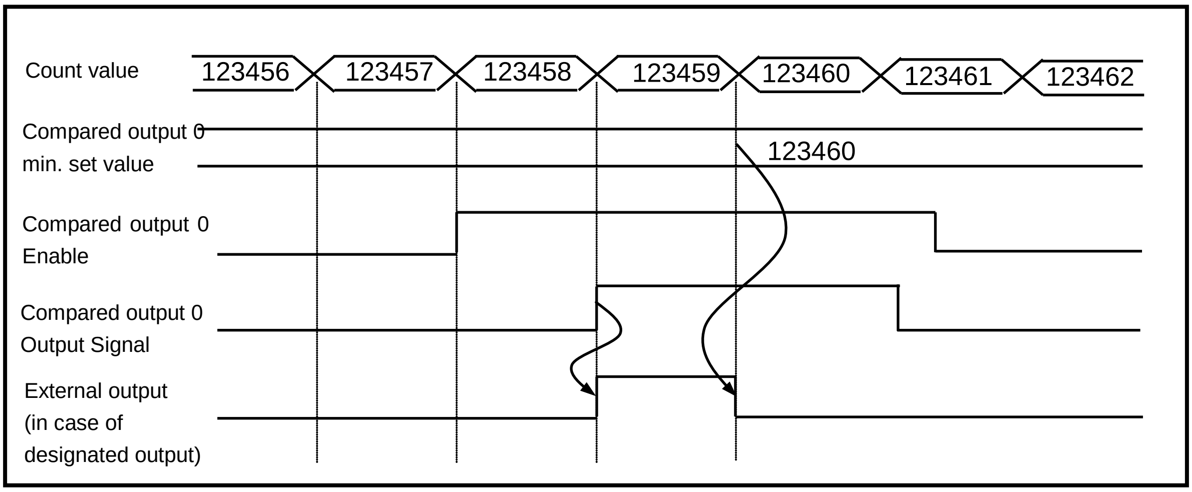


(e) Detail of comparator output

It describes detail of comparator output (based on comparator output 0)

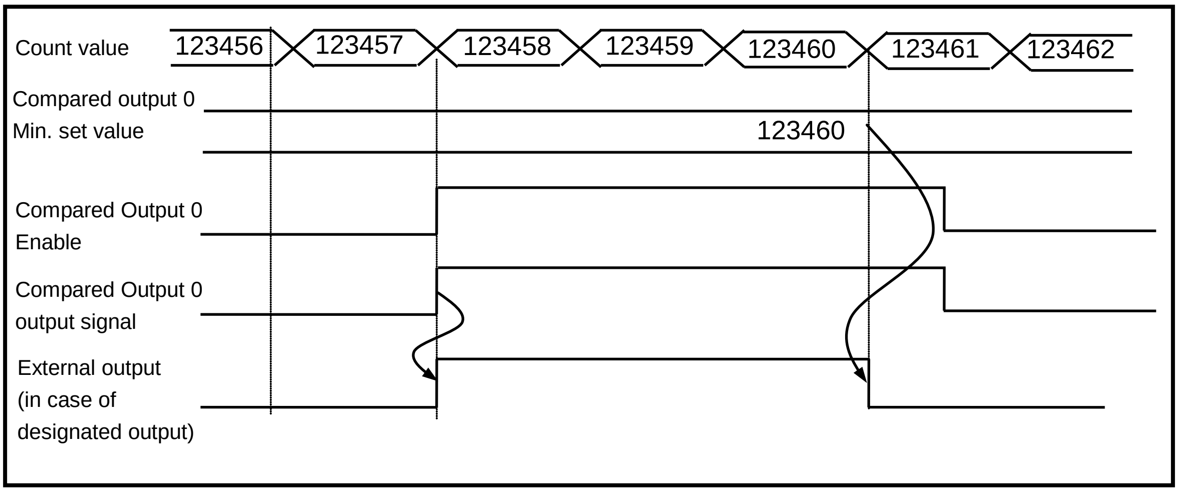
1) Mode 0 (Present value < Compared value)

■ If counted present value is less than the minimum value of compared output 0, output is sent out, and if present value increases to be equal to or greater than the minimum value of compared output 0, output is not sent out.



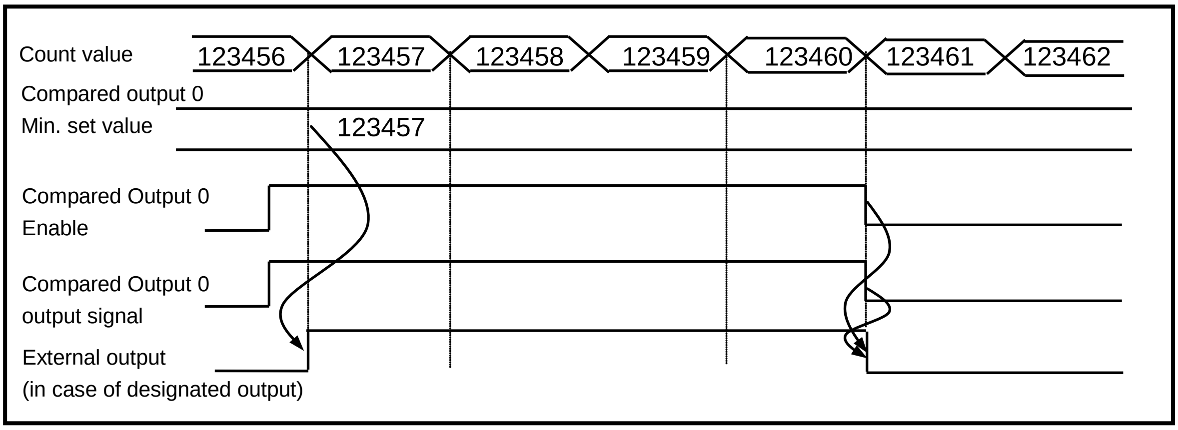
2) Mode1 (Count value ≤ Compared value)

■ If present count value is less than or equal to the minimum set value of compared output 0, output is sent out, and if count value increases to be greater than the minimum set value of compared output 0, output is not sent out.



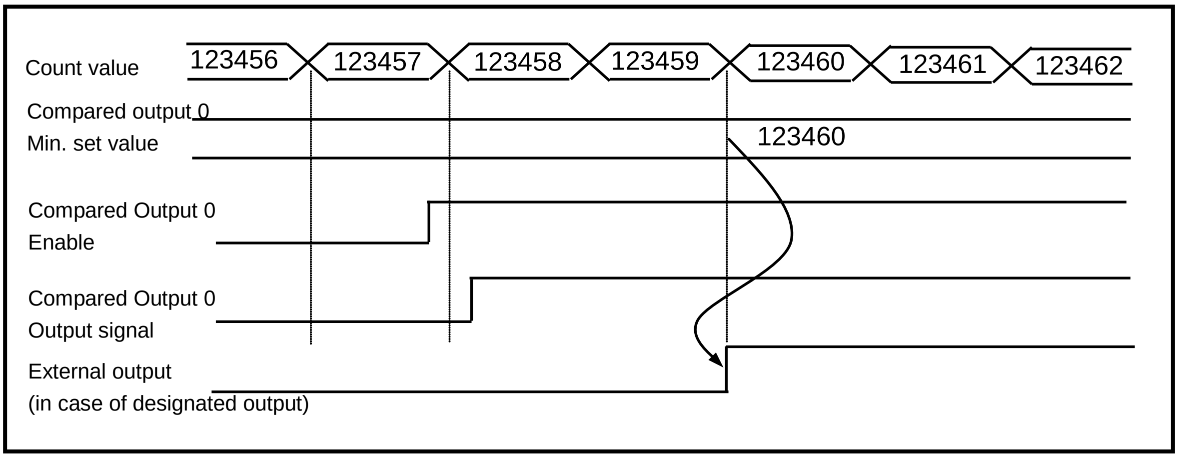
3) Mode 2 (Count value = Compared value)

■ If present count value is equal to the minimum set value of compared output 0, output is sent out. In order to turn the output Off, Compared output Enable signal 0 or Compared Coincidence Output Enable signal 0 is to be Off.



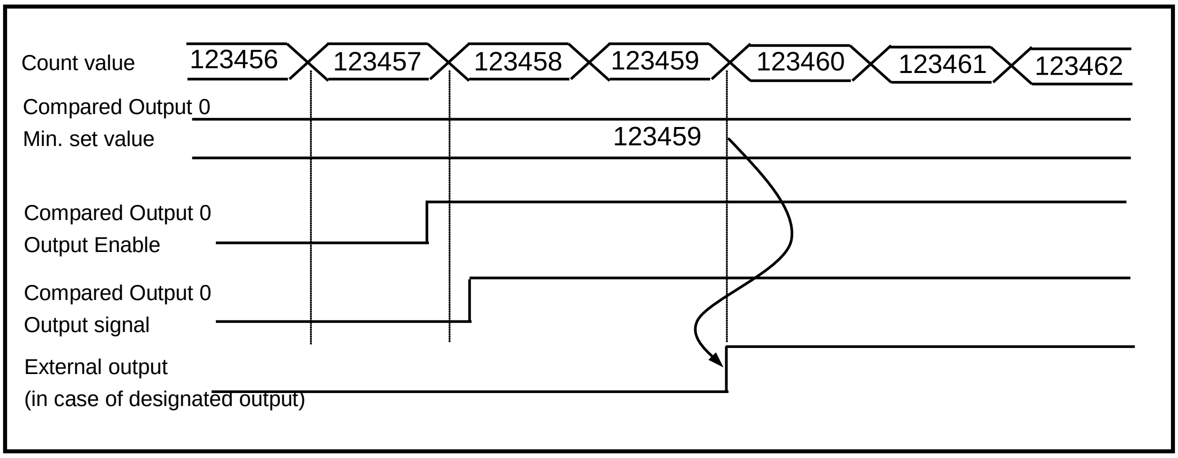
4) Mode 3 (Count value ≥ Compared value)

■ If present count value is greater than or equal to the minimum set value of compared output 0, output is sent out, and if count value decreases to be less than the minimum set value of compared output 0, output is not sent out.



5) Mode 4 (Count value > Compared Output value)

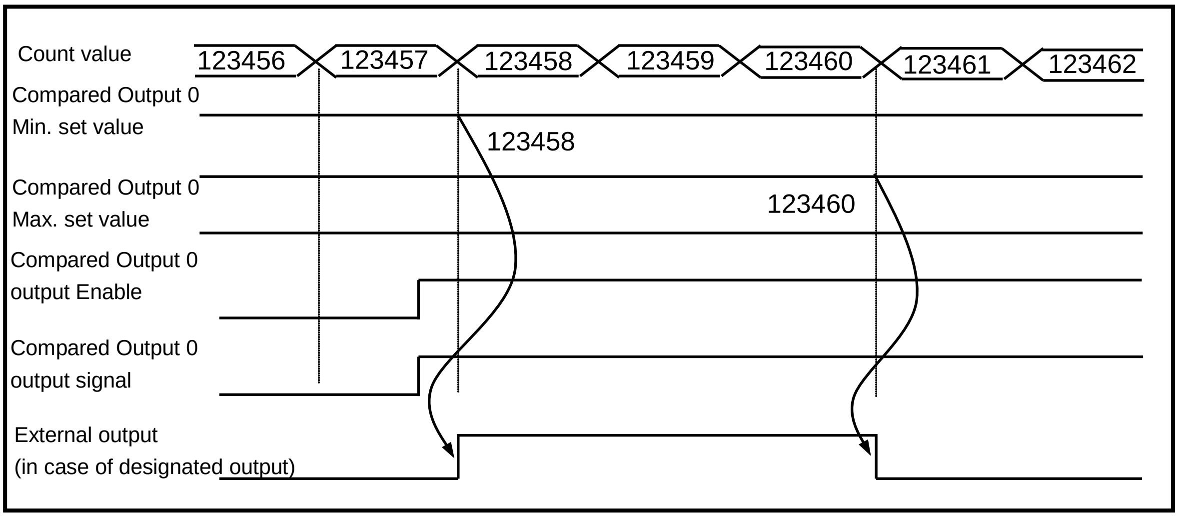
■ If present count value is greater than the minimum set value of compared output 0, output is sent out, and if count value decreases to be less than or equal to the minimum set value of compared output 0, output is not sent out.



6) Mode 5

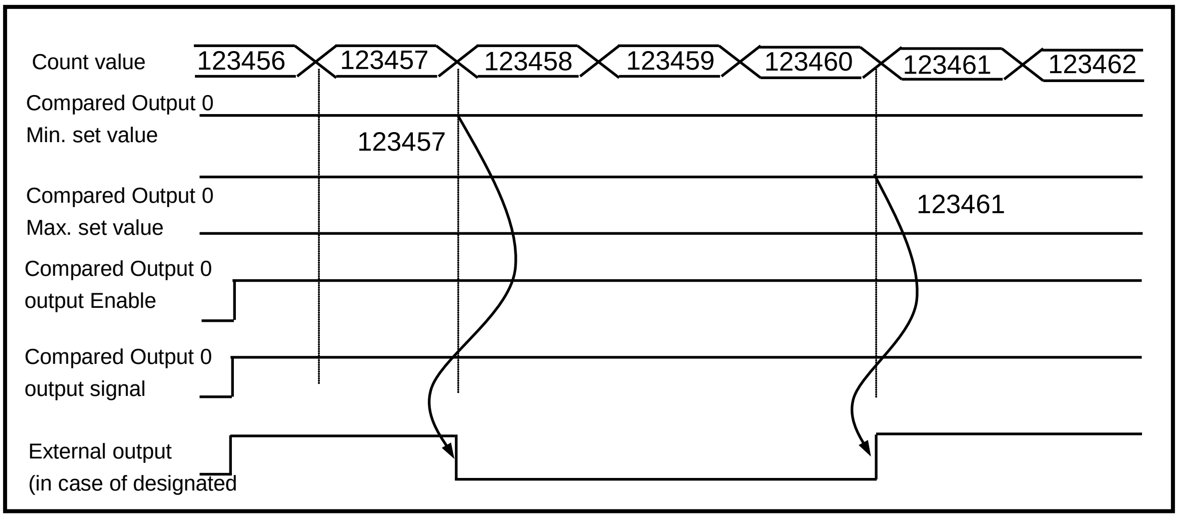
(Section comparison: Min. set value of Compared Output 0 ≤ Count value ≤ Max. set value of Compared Output 0)

■ If present count value is greater than or equal to the minimum set value of compared output 0 and less than or equal to the maximum set value of compared output 0, output is sent out, and if count value increases/decreases to exceed compared value's range, output is not sent out.



7) Mode 6 (Count value ≤ Min. set value of Compared Output 0 or Count value ≥ Max. set value of Compared Output 0)

■ If present count value is less than or equal to the minimum set value of compared 0 and greater than or equal to the maximum set value of compared 0, output is sent out, and if count value increases/decreases to exceed compared value's range, output is not sent out.



(4) Carry signal

(a) Carry signal occurs

1) When count range maximum value of 2,147,483,647 is reached during Linear Count.

2) When user-defined maximum value of Ring Count changed to the minimum value during Ring Count.

(b) Count when Carry Signal occurs

1) Count stops if Carry occurs during Linear Count.

2) Count does not stop even if Carry occurs during Ring Count.

(c) Carry reset

1) The Carry generated can be cancelled by Carry/Borrow reset signal On.

Classification	Device area per channel							
	Ch.0	Ch.1	Ch.2	Ch.3	Ch.4	Ch.5	Ch.6	Ch.7
Carry signal	K2610	K2710	K2810	K2910	K21810	K21910	K22010	K22110

(5) Borrow signal

(a) Borrow signal occurs

1) When count range minimum value of -2,147,483,648 is reached during Linear Count.

2) When user-defined minimum value of Ring Count changed to the maximum value during Ring Count.

(b) Count when Borrow signal occurs

1) Count stops if Borrow occurs during Linear Count.

2) Count does not stop even if Borrow occurs during Ring Count.

(c) Borrow reset

1) The Borrow generated can be cancelled by Carry/Borrow reset signal On.

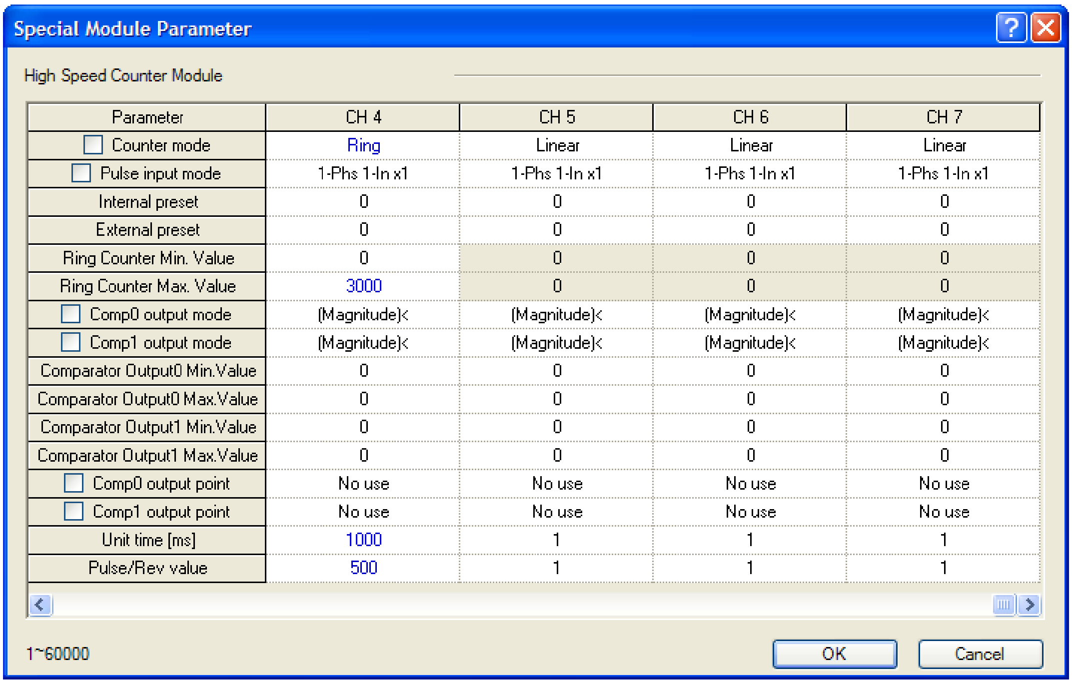
Classification	Device area per channel							
	Ch.0	Ch.1	Ch.2	Ch.3	Ch.4	Ch.5	Ch.6	Ch.7
Borrow signal	K2611	K2711	K2811	K2911	K21811	K21911	K22011	K22111

(6) Revolution/Unit time

While the Flag about the number of revolution per unit time is On, it counts the number of input pulses for a specified time.

(a) Setting

1) Set the unit time and the number of pulse per 1 revolution.



Parameter	CH 4	CH 5	CH 6	CH 7
Counter mode	Ring	Linear	Linear	Linear
Pulse input mode	1-Phs 1-In x1	1-Phs 1-In x1	1-Phs 1-In x1	1-Phs 1-In x1
Internal preset	0	0	0	0
External preset	0	0	0	0
Ring Counter Min. Value	0	0	0	0
Ring Counter Max. Value	3000	0	0	0
Comp0 output mode	(Magnitude)<	(Magnitude)<	(Magnitude)<	(Magnitude)<
Comp1 output mode	(Magnitude)<	(Magnitude)<	(Magnitude)<	(Magnitude)<
Comparator Output0 Min.Value	0	0	0	0
Comparator Output0 Max.Value	0	0	0	0
Comparator Output1 Min.Value	0	0	0	0
Comparator Output1 Max.Value	0	0	0	0
Comp0 output point	No use	No use	No use	No use
Comp1 output point	No use	No use	No use	No use
Unit time [ms]	1000	1	1	1
Pulse/Rev value	500	1	1	1

Setting value is saved at the following special K area and user can designate directly.

Class	Device per each channel (Word)								Setting range
	Ch.0	Ch.1	Ch.2	Ch.3	Ch.4	Ch.5	Ch.6	Ch.7	
Unit time	K322	K352	K382	K412	K2242	K2272	K2302	K2332	1~60000㎳
Pulse/Rev value	K323	K353	K383	K413	K2243	K2273	K2303	K2333	1~60000

2) In case of using Rev/unit time function, enable the following special K area

Class	Device per each channel (Word)								Operation
	Ch.0	Ch.1	Ch.2	Ch.3	Ch.4	Ch.5	Ch.6	Ch.7	
Rev/unit time command	K2605	K2705	K2805	K2905	K21805	K21905	K22005	K22105	0: disable 1: enable

3) Rev/unit time value is saved at the following special K area.

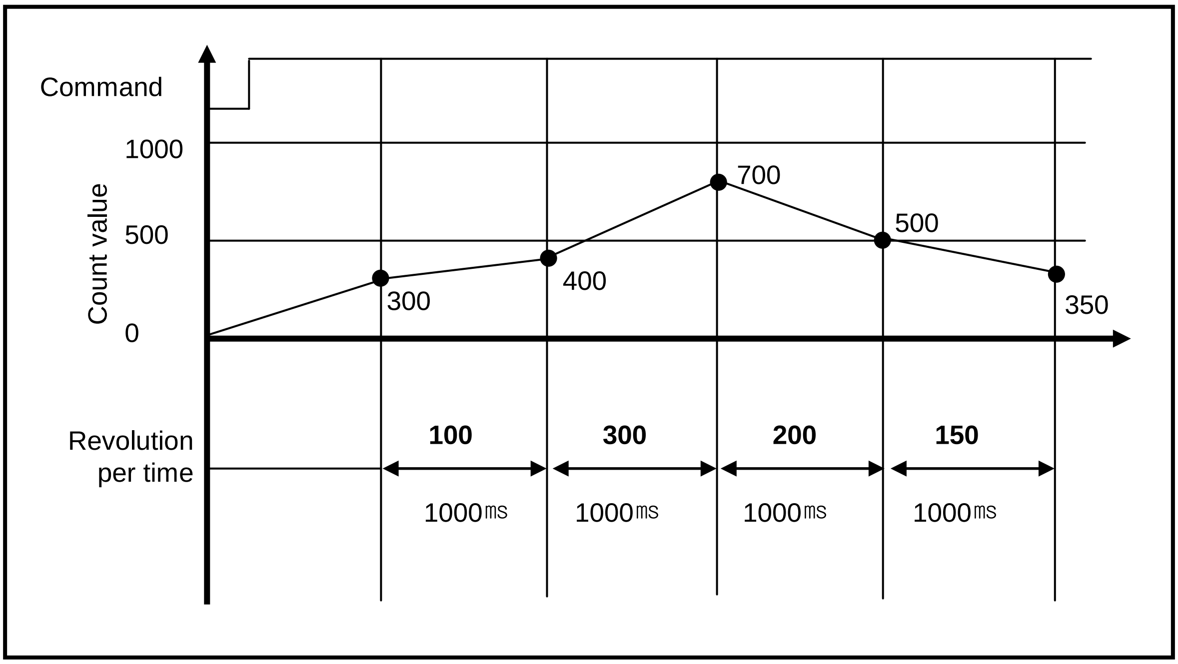
Class	Device per each channel (Word)								Ref.
	Ch.0	Ch.1	Ch.2	Ch.3	Ch.4	Ch.5	Ch.6	Ch.7	
Rev/unit time	K264	K274	K284	K294	K2184	K2194	K2204	K2214	-

(b) Count function of Revolution/Unit time is used to count the number of pulses for a specified time while auxiliary mode enable signal is On.

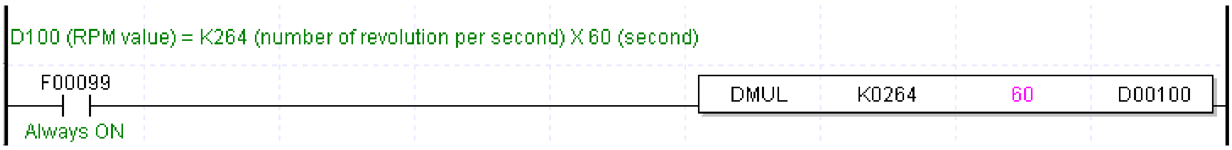
(c) With the displayed number of pulses updated for a specified time and the number of pulses per revolution input, Revolution/Unit time can be counted.

(d) Number of Revolution per 1 second is indicated after number of pulse per 1 revolution is set and time is set to 1 second (1000ms). In order to indicate by Revolutions per minute (RPM), the operation is executed in program.

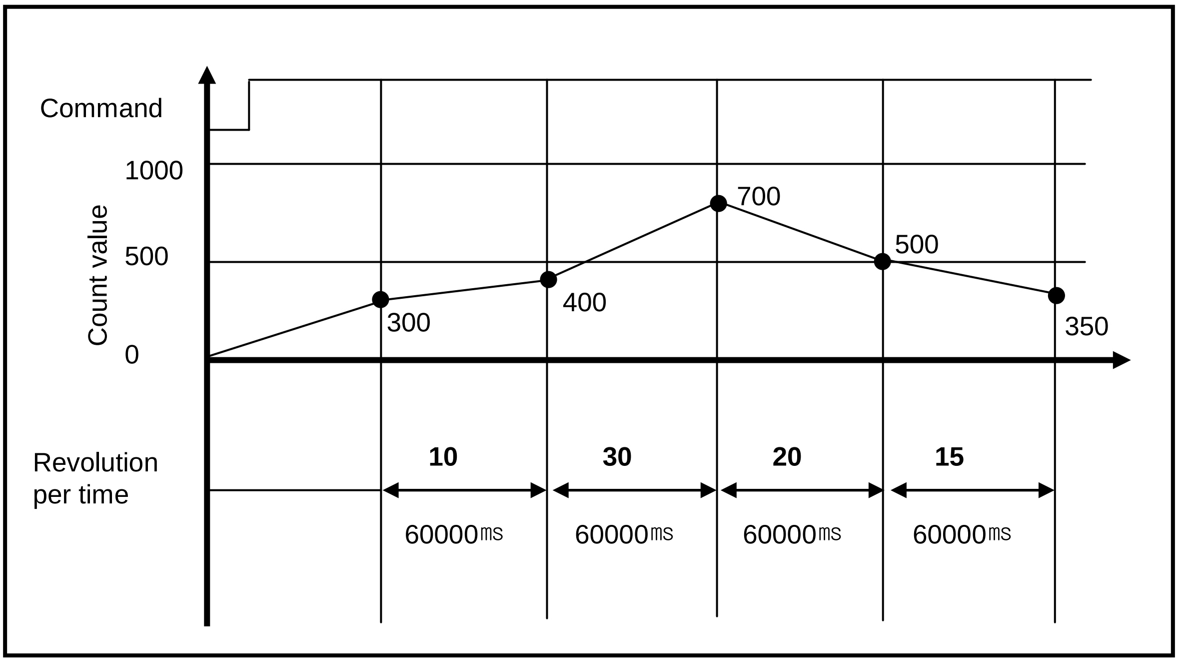
(e) The example that number of pulse per 1 revolution set to ‘1’ and time is set to 1000 ms is as shown below. (Ch0)



(f) In order to indicate revolution per minute (RPM), the program is as shown below. In case of DMUL operation, RPM value is saved 64 bit in D100~D103. If operated RPM value is used, it can use to Word or Dword type according to system (case of RPM value is small number).



(g) The example that number of pulse per 1 revolution set to ‘10’ and time is set to 60,000 ms is as shown below.



(7) Count latch

When Count latch signal is On, present count value is latched.

▪ Setting

If present counter value is to latch, Count Latch function is set ‘Use’.

Class	Device area per channel								Operation
	Ch.0	Ch.1	Ch.2	Ch.3	Ch.4	Ch.5	Ch.6	Ch.7	
Count latch command	K2606	K2706	K2806	K2906	K21806	K21906	K22006	K22106	0: disable 1: enable

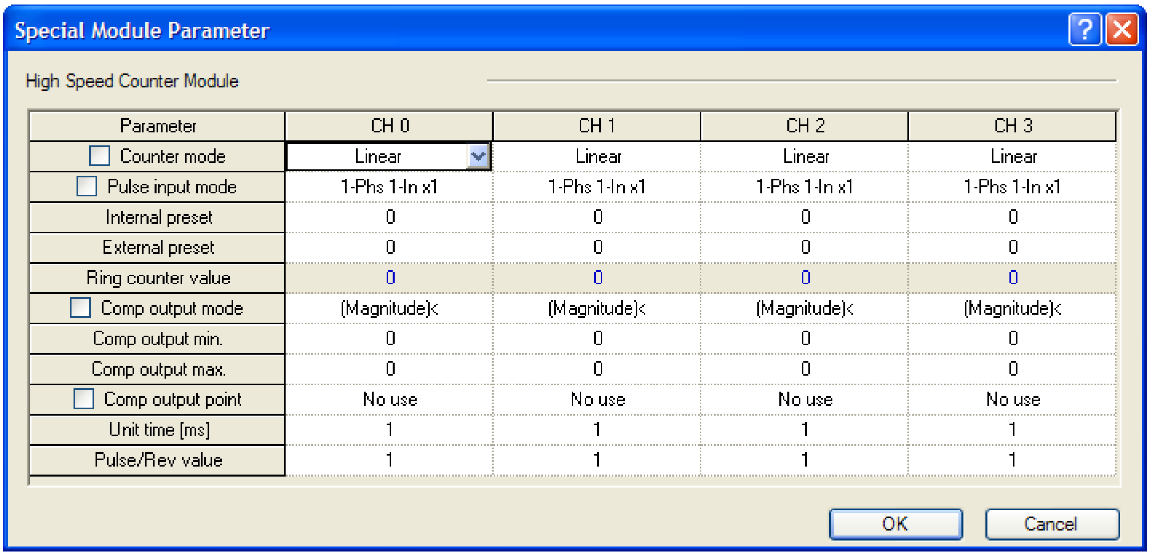
▪ Count latch function is operated when Count latch signal is On. Namely, counter value is not cleared when power supply Off =>On and mode change, it is counted from previous value.

▪ In latch counter function, internal or external preset function has to use for clearing present value.

(8) Preset function

It changes the current value into preset value.

There are two types of preset function, internal preset and external preset. External preset is fixed as input contact point.



Special Module Parameter

High Speed Counter Module

Parameter	CH 0	CH 1	CH 2	CH 3
Counter mode	Linear	Linear	Linear	Linear
Pulse input mode	1-Phs 1-In x1	1-Phs 1-In x1	1-Phs 1-In x1	1-Phs 1-In x1
Internal preset	0	0	0	0
External preset	0	0	0	0
Ring counter value	0	0	0	0
Comp output mode	(Magnitude)<	(Magnitude)<	(Magnitude)<	(Magnitude)<
Comp output min.	0	0	0	0
Comp output max.	0	0	0	0
Comp output point	No use	No use	No use	No use
Unit time [ms]	1	1	1	1
Pulse/Rev value	1	1	1	1

OK Cancel

• Preset setting value is saved at the following special K area.

Type	Area per each channel (Double word)								Ref.
	Ch.0	Ch.1	Ch.2	Ch.3	Ch.4	Ch.5	Ch.6	Ch.7	
Internal preset value	K304	K334	K364	K394	K2224	K2254	K2284	K2314	–
External preset value	K306	K336	K366	K396	K2226	K2256	K2286	K2316	–

• Preset command is specified through the following special K area, external preset is used by executing the designated input contact point after allowance bit is on.

Type	Area per each channel (Bit)								Ref.
	Ch.0	Ch.1	Ch.2	Ch.3	Ch.4	Ch.5	Ch.6	Ch.7	
Internal preset command	K2601	K2701	K2801	K2901	K21801	K21901	K22001	K22101	–
External preset allowance	K2602	K2702	K2802	K2902	K21802	K21902	K22002	K22102	–
External preset command	P008	P009	P00A	P00B	P00C	P00D	P00E	P00F	–

8.2 Installation and Wiring

8.2.1 Precaution for wiring

Pay attention to the counteractions against wiring noise especially for High-speed pulse input.

(1) Surely use twisted pair shielded cable, grounded with 3 class applied.

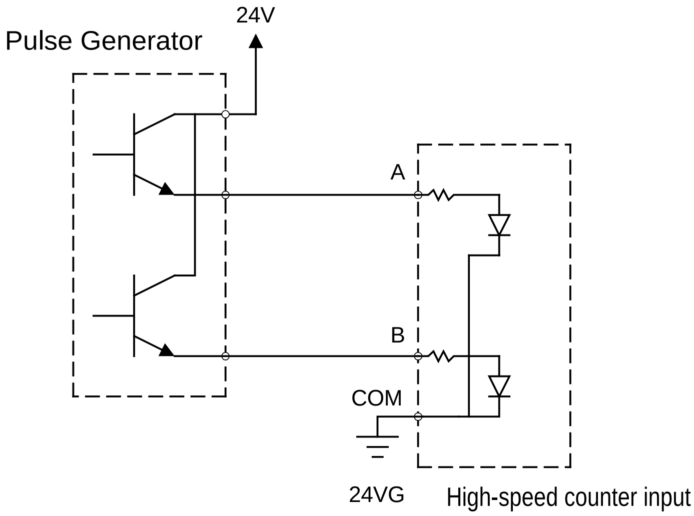
(2) Keep away from power cable or I/O line which may cause noise.

(3) Stabilized power should be used for filter.

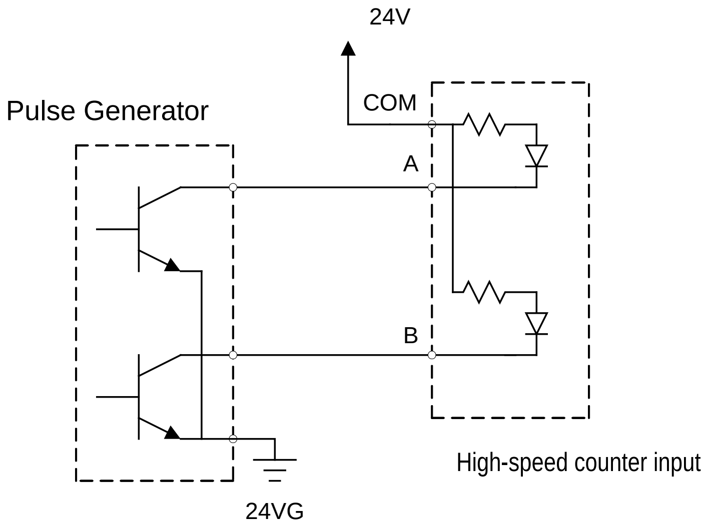
- ▶ Connect A-phase only for 1-phase input.
- ▶ Connect A-phase and B-phase for 2-phase input.

8.2.2 Example of wiring

(1) In case of pulse generator (encoder) is voltage output type



(2) In case of pulse generator is open collector type



8.3 Internal Memory

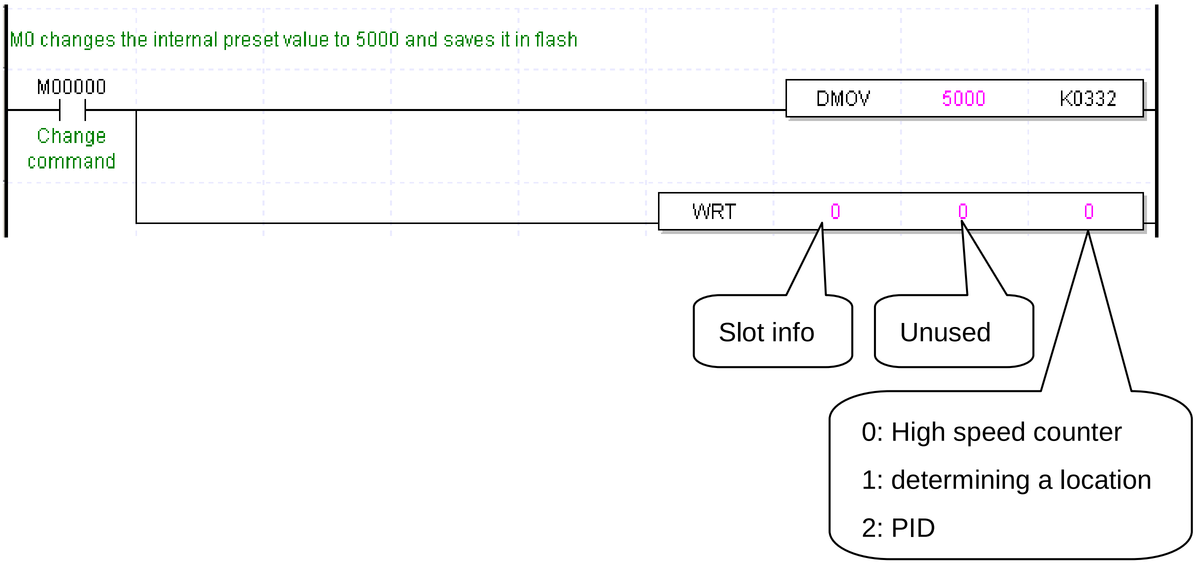
8.3.1 Special area for High-speed counter

Parameter and operation command area of built-in high-speed counter use a special K device.

If values set in parameter are changed, it works with the changed values. At the moment, makes sure to use WRT command to save the changed value to flash. If not saved in flash, the changed values with the power off => on and mode changed may not be maintained.

▪ The following example shows that the internal preset values of CH1 set in parameter are changed by program and saved in flash.

- Receiving an order command (M000), it moves (MOV) the new internal preset value (5000) to the CH1 present area (K332).
- To save the changed settings into flash, it uses WRT command. At the moment, slot information is set to ’0’ in case of built-in function.



(1) “E” type

(a) Parameter setting

Parameter	Description		Device area per channel				Remark
	Value	Setting	Ch 0	Ch 1	Ch 2	Ch 3	
Counter mode	h0000	Linear count	K300	K330	K360	K390	Word
	h0001	Ring count					
Pulse input mode	h0000	1 phase 1 input 1 multiplication	K301	K331	K361	K391	Word
	h0001	1 phase 2 input 1 multiplication					
	h0002	CW / CCW					
	h0003	2 phase 2 multiplication					
Comp. Output mode	h0000	(Magnitude) <	K302	K332	K362	K392	Word
	h0001	(Magnitude) ≤					
	h0002	(Magnitude) =					
	h0003	(Magnitude) ≥					
	h0004	(Magnitude) >					
	h0005	(Range) Include					
	h0006	(Range) Exclude					
Internal preset value setting	-2,147,483,648 ~ 2,147,483,647		K304	K334	K364	K394	DWord
External preset value setting	-2,147,483,648 ~ 2,147,483,647		K306	K336	K366	K396	DWord

<table>
<tr><th rowspan="2">Parameter</th><th colspan="2">Description</th><th colspan="4">Device area per channel</th><th rowspan="2">Remark</th></tr>
<tr><th>Value</th><th>Setting</th><th>Ch 0</th><th>Ch 1</th><th>Ch 2</th><th>Ch 3</th></tr>
<tr><td>Ring counter Max. value setting</td><td colspan="2">-2,147,483,648 ~ 2,147,483,647</td><td>K310</td><td>K340</td><td>K370</td><td>K400</td><td>DWord</td></tr>
<tr><td>Comp. Output Min. value setting</td><td colspan="2">-2,147,483,648 ~ 2,147,483,647</td><td>K312</td><td>K342</td><td>K372</td><td>K402</td><td>DWord</td></tr>
<tr><td>Comp. output Max. value setting</td><td colspan="2">-2,147,483,648 ~ 2,147,483,647</td><td>K314</td><td>K344</td><td>K374</td><td>K404</td><td>DWord</td></tr>
<tr><td rowspan="9">Comp. output point designation</td><td>HFFFF</td><td>No use</td><td rowspan="9">K320</td><td rowspan="9">K350</td><td rowspan="9">K380</td><td rowspan="9">K410</td><td rowspan="9">Word</td></tr>
<tr><td>h0000</td><td>P0020</td></tr>
<tr><td>h0001</td><td>P0021</td></tr>
<tr><td>h0002</td><td>P0022</td></tr>
<tr><td>h0003</td><td>P0023</td></tr>
<tr><td>h0004</td><td>P0024</td></tr>
<tr><td>h0005</td><td>P0025</td></tr>
<tr><td>h0006</td><td>P0026</td></tr>
<tr><td>h0007</td><td>P0027</td></tr>
<tr><td>Unit time [ms]</td><td colspan="2">1 ~ 60,000</td><td>K322</td><td>K352</td><td>K382</td><td>K412</td><td>DWord</td></tr>
<tr><td>Pulse/Rev.value</td><td colspan="2">1 ~ 60,000</td><td>K323</td><td>K353</td><td>K383</td><td>K413</td><td>DWord</td></tr>
</table>

(b) Operation command

Parameter	Device area per channel			
	Ch 0	Ch 1	Ch 2	Ch 3
Counter enabling	K2600	K2700	K2800	K2900
Internal preset designation of counter	K2601	K2701	K2801	K2901
External preset enabling of counter	K2602	K2702	K2802	K2902
Designation of decremental counter	K2603	K2703	K2803	K2903
Comp. output enabling	K2604	K2704	K2804	K2904
Enabling of revolution time per unit time	K2605	K2705	K2805	K2905
Designation of latch counter	K2606	K2706	K2806	K2906
Carry signal (Bit)	K2610	K2710	K2810	K2910
Borrow signal	K2611	K2711	K2811	K2911
Comp. output signal	K2612	K2712	K2812	K2912

(c) Area of monitoring

Parameter	Device area per channel				Remark
	Ch 0	Ch 1	Ch 2	Ch 3	
Current counter value	K262	K272	K282	K292	DWord
Revolution time per unit time	K264	K274	K284	K294	DWord

(2) “S(U)” type

(a) Parameter setting

Parameter	Description		Device area per channel				Remark
	Value	Setting	Ch 0 / Ch 4	Ch 1 / Ch 5	Ch 2 / Ch 6	Ch 3 / Ch 7	
Counter mode	h0000	Linear count	K300	K330	K360	K390	Word
	h0001	Ring count	K2220	K2250	K2280	K2310	
Pulse input mode setting	h0000	1 phase 1 input 1 multiplication	K301	K331	K361	K391	Word
	h0001	1 phase 2 input 1 multiplication					
	h0002	CW / CCW	K2221	K2251	K2281	K2311	Word
	h0003	2 phase 4 multiplication					
Comp. Output 0 mode setting	h0000	(Magnitude) <	K302	K332	K362	K392	Word
	h0001	(Magnitude) ≤					
	h0002	(Magnitude) =					
	h0003	(Magnitude) ≥					
	h0004	(Magnitude) >	K2222	K2252	K2282	K2312	
	h0005	(Range) Include					
	h0006	(Range) Exclude					
Comp. Output 1 mode setting	h0000	(Magnitude) <	K303	K333	K363	K393	Word
	h0001	(Magnitude) ≤					
	h0002	(Magnitude) =					
	h0003	(Magnitude) ≥					
	h0004	(Magnitude) >	K2223	K2253	K2283	K2313	
	h0005	(Range) Include					
	h0006	(Range) Exclude					
Internal preset value setting	-2,147,483,648 ~ 2,147,483,647		K304	K334	K364	K394	DWord
			K2224	K2254	K2284	K2314	
External preset value setting	-2,147,483,648 ~ 2,147,483,647		K306	K336	K366	K396	DWord
			K2226	K2256	K2286	K2316	

<table>
<tr><th rowspan="3">Parameter</th><th colspan="2">Description</th><th colspan="4">Device area per channel</th><th rowspan="3">Remark</th></tr>
<tr><th rowspan="2">Value</th><th rowspan="2">Setting</th><th>Ch 0</th><th>Ch 1</th><th>Ch 2</th><th>Ch 3</th></tr>
<tr><th>Ch 4</th><th>Ch 5</th><th>Ch 6</th><th>Ch 7</th></tr>
<tr><td rowspan="2">Ring counter min. value setting</td><td colspan="2" rowspan="2">-2,147,483,648 ~ 2,147,483,645</td><td>K308</td><td>K338</td><td>K368</td><td>K398</td><td rowspan="2">DWord</td></tr>
<tr><td>K2228</td><td>K2258</td><td>K2288</td><td>K2318</td></tr>
<tr><td rowspan="2">Ring counter max. value setting</td><td colspan="2" rowspan="2">-2,147,483,646 2,147,483,647</td><td>K310</td><td>K340</td><td>K370</td><td>K400</td><td rowspan="2">DWord</td></tr>
<tr><td>K2230</td><td>K2260</td><td>K2290</td><td>K2320</td></tr>
<tr><td rowspan="2">Comp. output min. value setting</td><td colspan="2" rowspan="2">-2,147,483,648 ~ 2,147,483,647</td><td>K312</td><td>K342</td><td>K372</td><td>K402</td><td rowspan="2">DWord</td></tr>
<tr><td>K2232</td><td>K2262</td><td>K2292</td><td>K2322</td></tr>
<tr><td rowspan="2">Comp. output max. value setting</td><td colspan="2" rowspan="2">-2,147,483,648 ~ 2,147,483,647</td><td>K314</td><td>K344</td><td>K374</td><td>K404</td><td rowspan="2">DWord</td></tr>
<tr><td>K2234</td><td>K2264</td><td>K2294</td><td>K2324</td></tr>
<tr><td rowspan="17">Comp. output 0 point designation</td><td>HFFFF</td><td>No use</td><td rowspan="9">K320</td><td rowspan="9">K350</td><td rowspan="9">K380</td><td rowspan="9">K410</td><td rowspan="17">Word</td></tr>
<tr><td>h0000</td><td>P0020</td></tr>
<tr><td>h0001</td><td>P0021</td></tr>
<tr><td>h0002</td><td>P0022</td></tr>
<tr><td>h0003</td><td>P0023</td></tr>
<tr><td>h0004</td><td>P0024</td></tr>
<tr><td>h0005</td><td>P0025</td></tr>
<tr><td>h0006</td><td>P0026</td></tr>
<tr><td>h0007</td><td>P0027</td></tr>
<tr><td>h0008</td><td>P0028</td><td rowspan="8">K2240</td><td rowspan="8">K2270</td><td rowspan="8">K2300</td><td rowspan="8">K2330</td></tr>
<tr><td>h0009</td><td>P0029</td></tr>
<tr><td>h000A</td><td>P002A</td></tr>
<tr><td>h000B</td><td>P002B</td></tr>
<tr><td>h000C</td><td>P002C</td></tr>
<tr><td>h000D</td><td>P002D</td></tr>
<tr><td>h000E</td><td>P002E</td></tr>
<tr><td>h000F</td><td>P002F</td></tr>
</table>

<table>
<tr><th rowspan="3">Parameter</th><th colspan="2">Description</th><th colspan="4">Device area per channel</th><th rowspan="3">Remark</th></tr>
<tr><th rowspan="2">Value</th><th rowspan="2">Setting</th><th>Ch 0</th><th>Ch 1</th><th>Ch 2</th><th>Ch 3</th></tr>
<tr><th>Ch 4</th><th>Ch 5</th><th>Ch 6</th><th>Ch 7</th></tr>
<tr><td rowspan="17">Comp. output 1 point designation</td><td>HFFFF</td><td>No use</td><td rowspan="9">K321</td><td rowspan="9">K351</td><td rowspan="9">K381</td><td rowspan="9">K411</td><td rowspan="17">Word</td></tr>
<tr><td>h0000</td><td>P0020</td></tr>
<tr><td>h0001</td><td>P0021</td></tr>
<tr><td>h0002</td><td>P0022</td></tr>
<tr><td>h0003</td><td>P0023</td></tr>
<tr><td>h0004</td><td>P0024</td></tr>
<tr><td>h0005</td><td>P0025</td></tr>
<tr><td>h0006</td><td>P0026</td></tr>
<tr><td>h0007</td><td>P0027</td></tr>
<tr><td>h0008</td><td>P0028</td><td rowspan="8">K2241</td><td rowspan="8">K2271</td><td rowspan="8">K2301</td><td rowspan="8">K2331</td></tr>
<tr><td>h0009</td><td>P0029</td></tr>
<tr><td>h000A</td><td>P002A</td></tr>
<tr><td>h000B</td><td>P002B</td></tr>
<tr><td>h000C</td><td>P002C</td></tr>
<tr><td>h000D</td><td>P002D</td></tr>
<tr><td>h000E</td><td>P002E</td></tr>
<tr><td>h000F</td><td>P002F</td></tr>
<tr><td rowspan="2">Unit time [ms]</td><td colspan="2" rowspan="2">1 ~ 60,000 ms</td><td>K322</td><td>K352</td><td>K382</td><td>K412</td><td rowspan="2">Word</td></tr>
<tr><td>K2242</td><td>K2272</td><td>K2302</td><td>K2332</td></tr>
<tr><td rowspan="2">Pulse/Rev.value</td><td colspan="2" rowspan="2">1 ~ 60,000</td><td>K323</td><td>K353</td><td>K383</td><td>K413</td><td rowspan="2">Word</td></tr>
<tr><td>K2243</td><td>K2273</td><td>K2303</td><td>K2333</td></tr>
</table>

(b) Operation command

Parameter	Device area per channel							
	Ch 0	Ch 1	Ch 2	Ch 3	Ch 4	Ch 5	Ch 6	Ch 7
Counter enabling	K2600	K2700	K2800	K2900	K21800	K21900	K22000	K22100
Internal preset designation of counter	K2601	K2701	K2801	K2901	K21801	K21901	K22001	K22101
External preset enabling of counter	K2602	K2702	K2802	K2902	K21802	K21902	K22002	K22102
Designation of decremental counter	K2603	K2703	K2803	K2903	K21803	K21903	K22003	K22103
Comp. output 0 enabling	K2604	K2704	K2804	K2904	K21804	K21904	K22004	K22104
Comp. output 1 enabling	K2607	K2707	K2807	K2907	K21807	K21907	K22007	K22107
Enabling of revolution time per unit time	K2605	K2705	K2805	K2905	K21805	K21905	K22005	K22105
Designation of latch counter	K2606	K2706	K2806	K2906	K21806	K21906	K22006	K22100
Carry signal (Bit)	K2610	K2710	K2810	K29100	K21810	K21910	K22010	K22110
Borrow signal	K2611	K2711	K2811	K29101	K21811	K21911	K22011	K22111
Comp. output 0 signal	K2612	K2712	K2812	K29102	K21812	K21912	K22012	K22112
Comp. output 1 signal	K2613	K2713	K2813	K29103	K21813	K21913	K22013	K22113

(c) Area of monitoring

Parameter	Device area per channel							
	Ch 0	Ch 1	Ch 2	Ch 3	Ch 4	Ch 5	Ch 6	Ch 7
Current counter value	K262	K272	K282	K292	K2182	K2192	K2202	K2212
Revolution per unit time	K264	K274	K284	K294	K2184	K2194	K2204	K2214

8.3.2 Error code

It describes errors of the built-in high-speed counter.

▪ Error occurred is saved in the following area.

Category	Device area per channel								Remark
	Ch0	Ch1	Ch2	Ch3	Ch4	Ch5	Ch6	Ch7	
Error code	K266	K276	K286	K296	K2186	K2196	K2206	K2216	Word

▪ Error codes and descriptions

Error code (Decimal)	Description
20	Counter type is set out of range
21	Pulse input type is set out of range
22	Requesting #1(3,)channel Run during the operation of #0(2) channel 2 phase(* During #0(2) channel 2 phase inputting, using #1(3)channel is not possible.
23	Compared output type setting is set out of range.
25	Internal preset value is set out of counter range
26	External present value is set out of counter range
27	Ring counter setting is set out of range * Note ring counter setting should be 2 and more.
28	Compared output min. value is set out of permissible max. input range
29	Compared output max. value is set out of permissible max. input range
30	Error of Compared output min. value>Compared output max. value
31	Compared output is set out of the default output value
34	Set value of Unit time is out of the range
35	Pulse value per 1 revolution is set out of range

Remark

▪ If two and more errors occur, the module saves the latter error code and removes the former one.

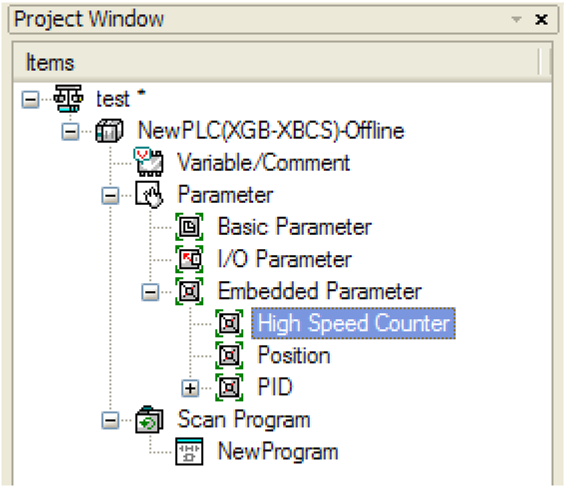
8.4 Examples: Using High-speed Counter

It describes examples of using high-speed counter.

(1)Setting high-speed counter parameter

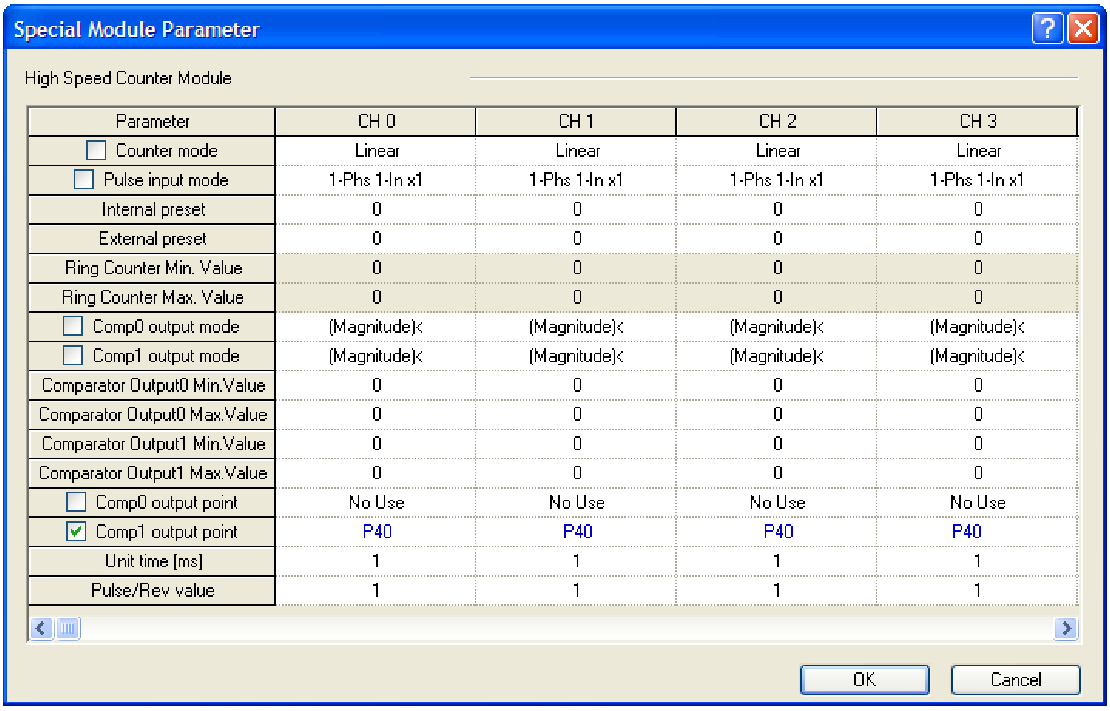
How to set types of parameters to operate a high-speed counter is described as follows.

(a) Set 『Internal Parameters』 in the basic project window.



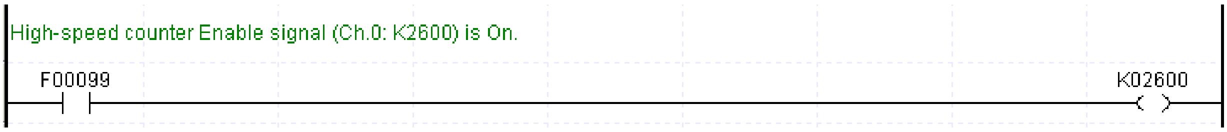
(b) Selecting high-speed counter opens a window to set high-speed counter parameters as follows. For details regarding each parameter setting, refer to 8.1~8.3.

(Every parameter settings are saved in the special K device area.)



Parameter	CH 0	CH 1	CH 2	CH 3
☐ Counter mode	Linear	Linear	Linear	Linear
☐ Pulse input mode	1-Phs 1-In x1	1-Phs 1-In x1	1-Phs 1-In x1	1-Phs 1-In x1
Internal preset	0	0	0	0
External preset	0	0	0	0
Ring Counter Min. Value	0	0	0	0
Ring Counter Max. Value	0	0	0	0
☐ Comp0 output mode	(Magnitude)<	(Magnitude)<	(Magnitude)<	(Magnitude)<
☐ Comp1 output mode	(Magnitude)<	(Magnitude)<	(Magnitude)<	(Magnitude)<
Comparator Output0 Min.Value	0	0	0	0
Comparator Output0 Max.Value	0	0	0	0
Comparator Output1 Min.Value	0	0	0	0
Comparator Output1 Max.Value	0	0	0	0
☐ Comp0 output point	No Use	No Use	No Use	No Use
☑ Comp1 output point	P40	P40	P40	P40
Unit time [ms]	1	1	1	1
Pulse/Rev value	1	1	1	1

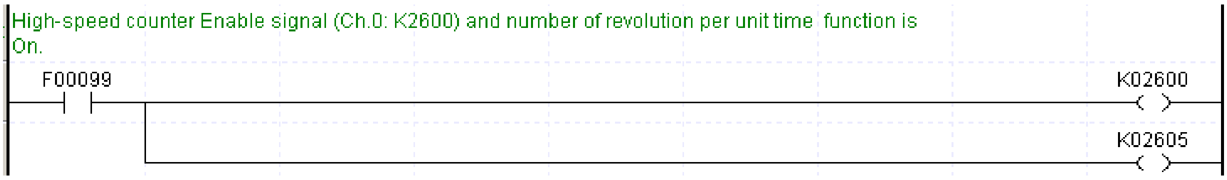
(c) Turn 'ON' the high-speed counter Enable signal (CH0:K2600) in the program.



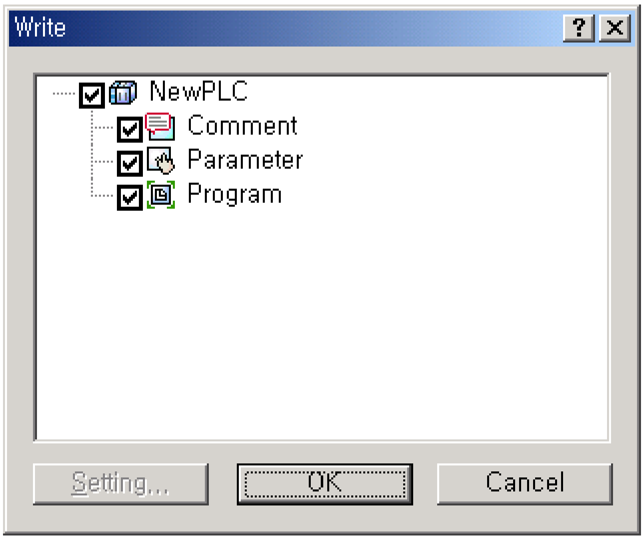
(d) To use additional functions of the high-speed counter, you needs to turn on the flag allowing an operation command.

* Refer to 2) Operation Command, <8.3.1 Special K Area for High-speed Counter>

For instance, turn on 2605 bit if among additional functions, rotation number function is used.



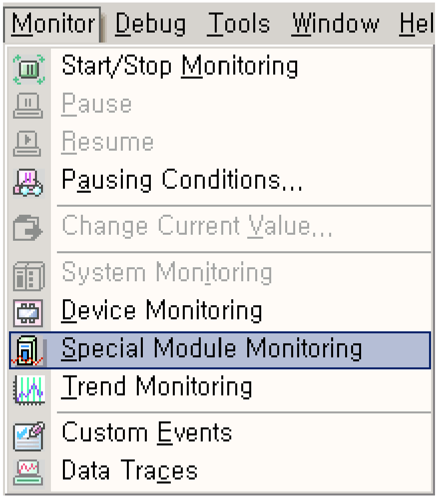
(e) Upon the setting, download program and parameter to PLC.

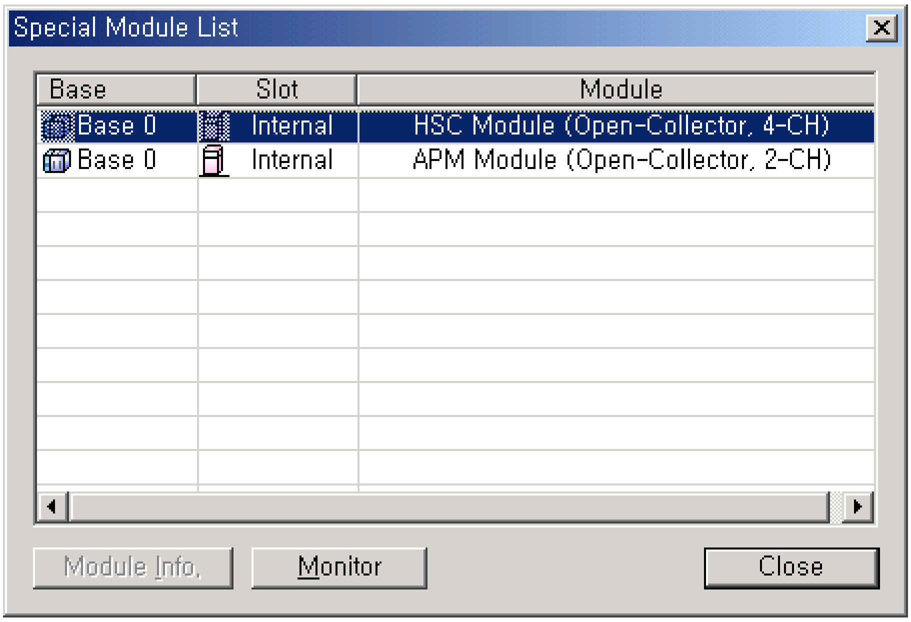


(2)Monitoring and setting command

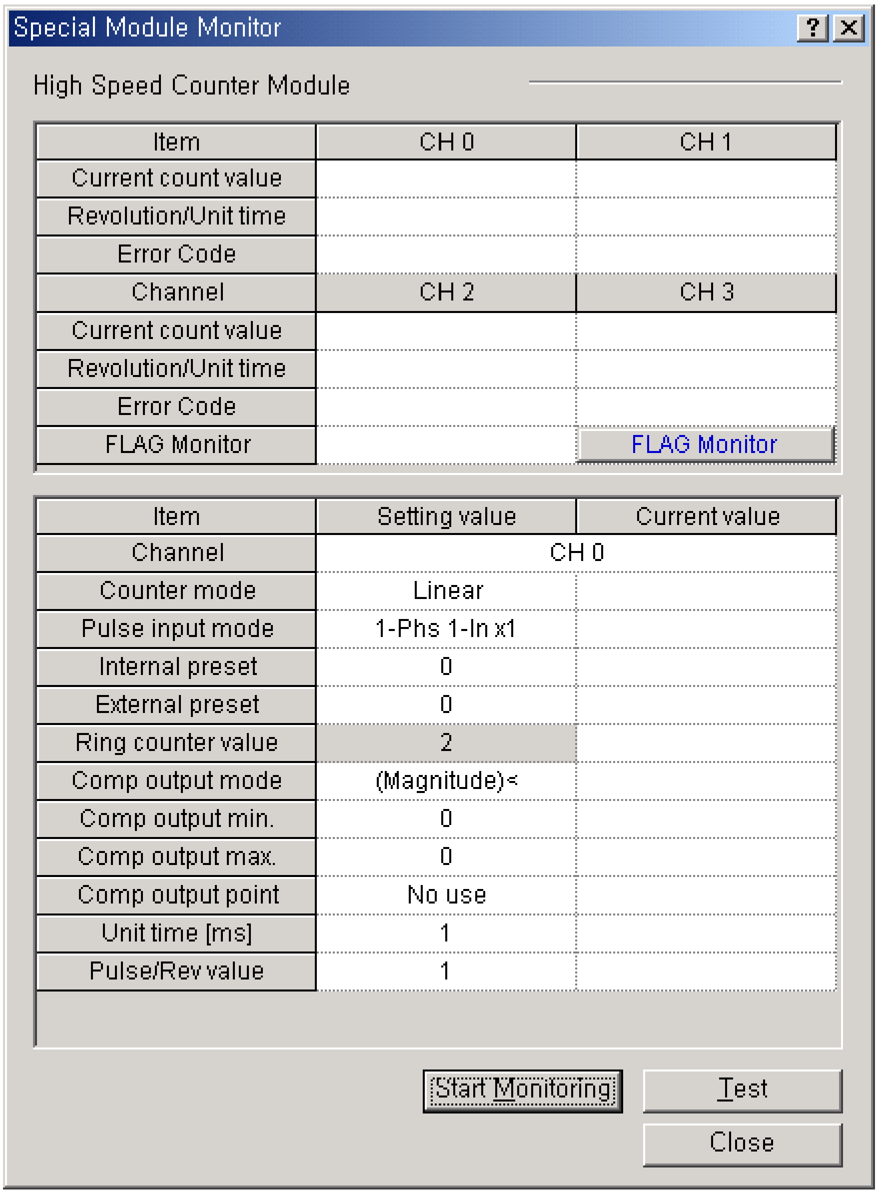
Monitoring and command setting of high-speed counter are described as follows.

(a) If starting a monitor and clicking a Special Module Monitor, the following window is opened.



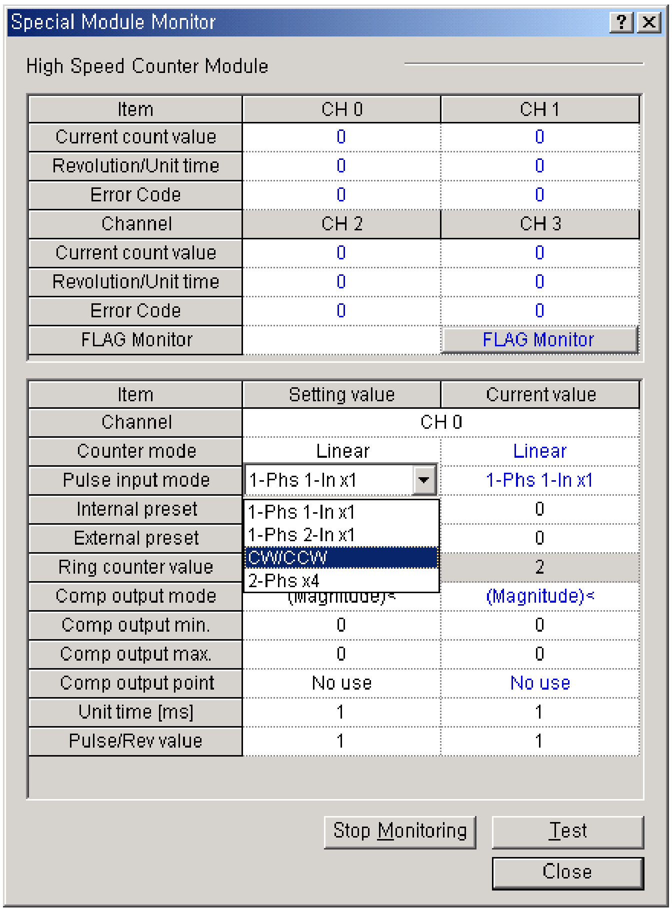


(b) Clicking 『Monitor』 shows monitor and test window of high-speed counter.

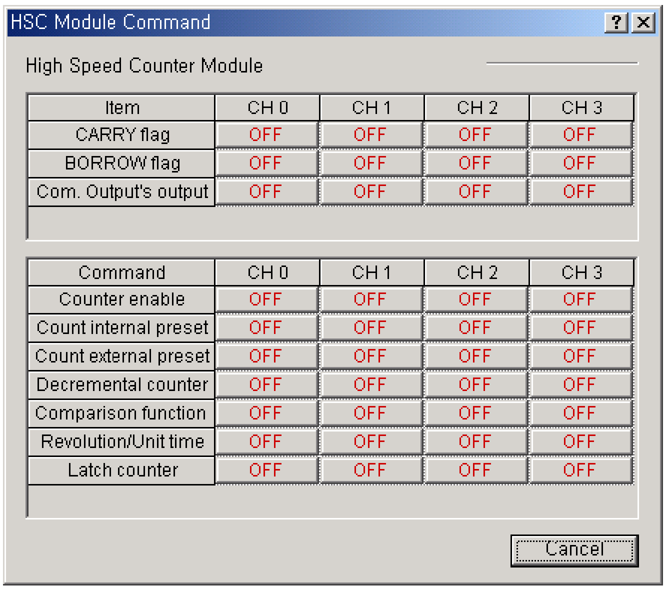


Item	Description
FLAG Monitor	Show flag monitoring and command window of high-speed counter
Start Monitoring	Start monitoring each item (special K device area monitor).
Test	Write each item setting to PLC. (Write the setting to special K device)
Close	Close monitor

(c) Clicking 『Start Monitoring』 shows the high-speed counter monitor display, in which you may set each parameter. At this moment, if any, changed values are not saved if power off=> on or mode is changed.



(d) Clicking『FLAG Monitor』 shows the monitor of each flag in high-speed counter, in which you may direct operation commands by flags (clicking commands reverse turn).



Chapter 9 RTC Option Board

9.1 Battery

9.1.1 Battery specification

Item	Specification
Voltage/Current	DC 3V / 220 mA
Warranty period	3 years (ambient temp.)
Purpose	Program and data backup, RTC operation in case of power failure
Specification	Manganese Dioxide lithium battery
Dimension (mm)	ϕ 20 X 3.2 mm

.

9.1.2 Notice in using

(1) Do not heat the battery or solder the polarity. (It may cause the reduction of life.)
(2) Do not measure the voltage or short with tester. (It may cause the fire.)
(3) Do not disassemble the battery.

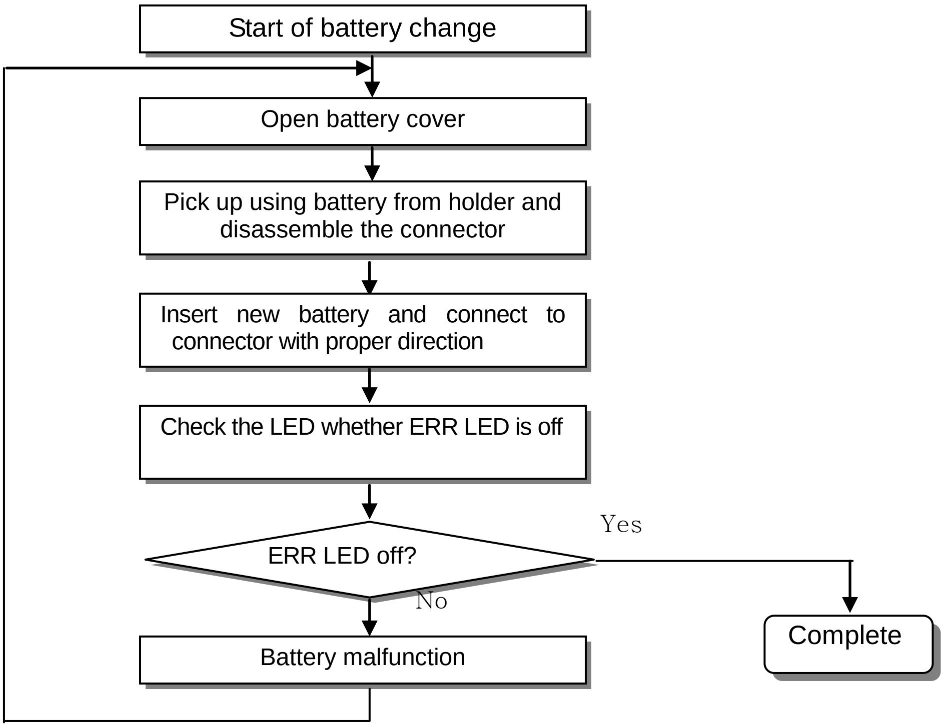
9.1.3 Life of battery

Life of battery depends on the power failure time and ambient temperature etc..
If battery is getting low, main unit cause the warning, ‘battery voltage low warning’. The user can check it by error LED, flag and error message of XG5000.
Since battery works properly for long time, after battery voltage low warning, so the user can take the action after battery voltage low warning occurred.

9.1.4 How to change battery

The user should change the battery used to save the program and backup the data in case of power failure periodically. Though the user eliminate the battery, it works for 30 minute by super capacitor. Change the battery as fast as possible.

Sequence changing battery is as follows.



9.2 RTC Function

Economic type (XBC-DxxxE), standard type (XBC-DxxxS, XBC-DxxxSU) doesn't support RTC function. If you equip RTC option board, you can use this function for time management of system or error log. RTC function is executed steadily when power is off or instantaneous power cut status. Current time of RTC is renewed every scan by system operation status information flag.

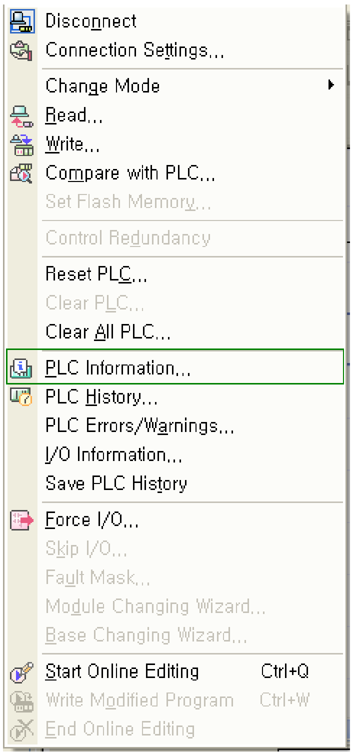
9.2.1 How to use

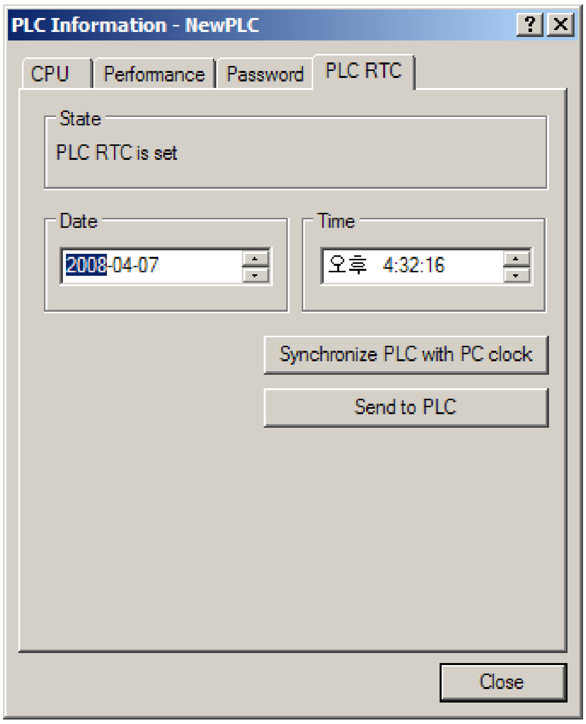
(1) Reading/setting clock data

(a) Reading or setting from XG5000

1) Click『Online』의『PLC Information』.

2) Click PLC RTC tap of PLC Information』.





3) In case the user wants to send the clock of PC to PLC, press 'Synchronize PLC with PC clock'.

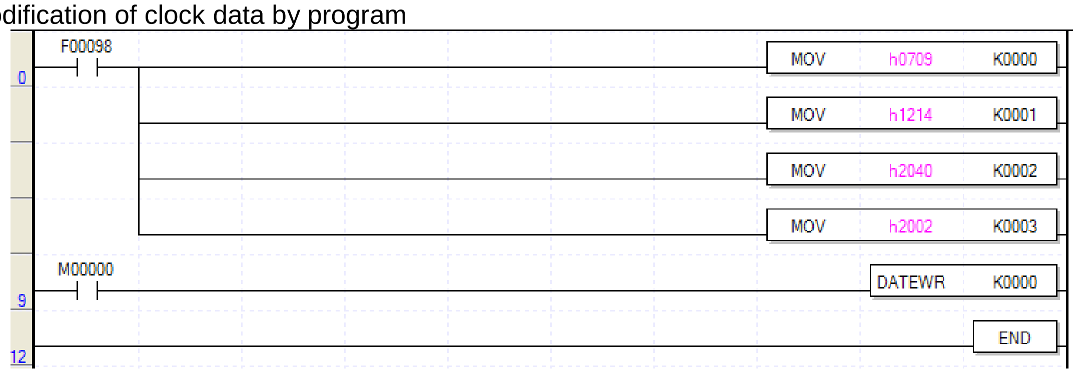
4) In case the user wants to send the clock the user wants, change the setting value of Time box and press 'Send to PLC'.

(b) Reading by special relay

The user can monitor as follows by special relay.

Special relay area	Data	Contents
F053	H0710	10year 07month
F054	H1729	29date 17hour
F055	H1020	10second 20minute
F056	H2004	20XXyear, Thursday

(c) Modification of clock data by program



area	Content
M0000	Month, year
M0001	Hour, date
M0002	Second, minute
M0003	Centaury, day

Write clock data to temporary device (P, M, K, L, Z, U, D, R) and turn on/off input contact point M0100. (If date and day data is not matched, Write is not available.)
Monitor and check the above special area (F053~F056)

(d) How to express the day

Number	0	1	2	3	4	5	6
Day	Sunday	Monday	Tuesday	Wednesday	Thursday	Friday	Saturday

(2) Deviation of clock data
±2. 2s / 1 d (normal temperature)

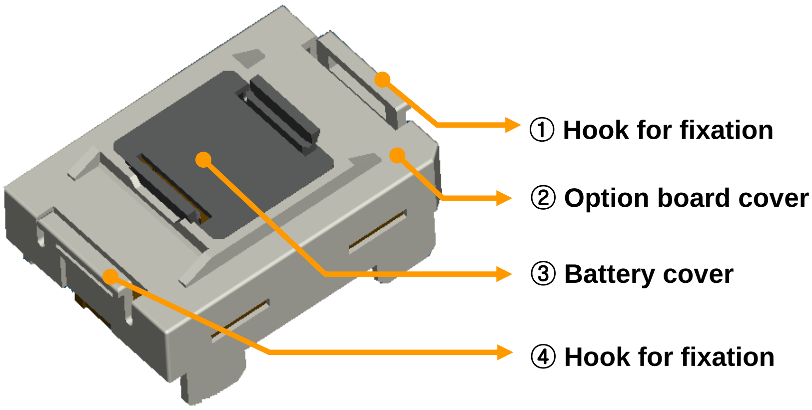
Operating temperature	Max deviation (second/day)
0 ℃	-5.5 ~ 1.5
25 ℃	-2.2 ~ 2.2
55 ℃	-7 ~ 1

Remark

1) Initially, RTC may not have any clock data.
2) When using the product, first make sure to set the accurate clock data.
3) If any data out of the clock data range is written into RTC, it does not work properly.
   i.e.) 14M 32D 25H
4) RTC may stop or have an error due to abnormal battery and other causes. The error is released if a new clock data is written.

9.3 Name and Function of Each Part

Describes the name and function of each part



No.	Name	Contents
①④	Hook for fixation	▶ Hook for fixing the option board to main unit
②	Option board cover	▶ Option board cover
③	Battery cover	▶ Battery cover

Chapter 10 DC Input Option Function

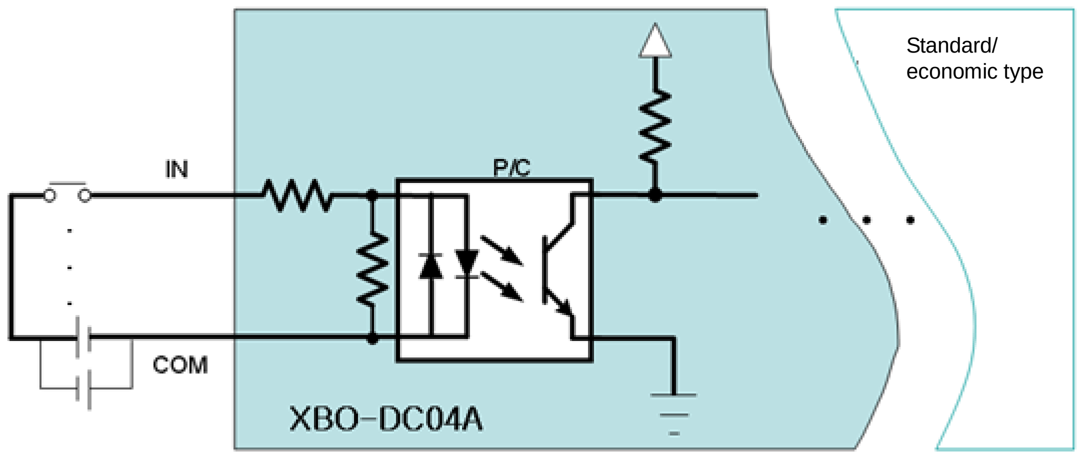
This chapter describes specifications and usage of input option board's function.

10.1 DC input Option Board Specification

10.1.1 DC Input Option Board Specification

Specification of XGB input option board is as follows.

Item		DC input specification	
		XBO-DC04A	Remark
Input point		4 points (supports high-speed counter function when installed at standard type)	
Insulation Method		Photo coupler insulation	
Rated input voltage		DC24V	
Rated input current		About 10㎃	
Voltage range		DC20.4~28.8V (ripple rate within 5%)	
On voltage / On current		DC19V or above / 3㎃ or above	
Off voltage / Off current		DC6V or less / 1㎃ or less	
Input resistance		About 2.7㏀	
Response time	Off → On	1/3/5/10/20/70/100㎳ (set through I/O parameter) Initial value: 3㎳	
	On → Off		
Common method		4 points / COM	〃
High speed counter	Performance	4kpps 4 channels (based on 1 phase)	when installed at standard type
	Mode	Linear counter	
Circuit configuration			



10.2 High Speed Counter Specification

High speed counter function is built in XGB input option board. It describes specifications, setting and usage of function, programming and wiring with external device.

10.2.1 Performance Specification

(1) Performance Specification

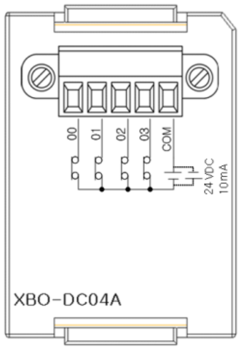
Item		Specification XBO-DC04A
Count input signal	Signal	A-phase, B-phase
	Input type	Voltage input (Open collector)
	Signal level	DC 24V
Max. count speed		4kpps
No. of channels	1 phase	4kpps 4 channels
	2 phase	2kpps 2 channels
Count range		Signed 32 Bit (-2,147,483,648 ~ 2,147,483,647)
Count type (Program setting)		Linear count (if it exceeds 32-bit range, Carry/Borrow occurs)
Input mode (Program setting)		1-phase input
		2-phase input
Signal type		Voltage
Up/Down setting	1-phase input	Increasing/decreasing operation setting by B-phase input
		Increasing/decreasing operation setting by program
	2-phase input	Automatic setting by difference in phase
Multiplication function	1 phase input	1 multiplication
	2 phase input	2 multiplication
Count Enable		Set by program (Counted on “Enable” statue)
Preset function		Set by program

(2) Counter input specification

Item	Specification
Input voltage	24V DC (20.4V ~ 28.8V)
Input current	10㎃
On guranteed voltage (min.)	20.4V
Off guranteed voltage (max.)	6V

10.2.2 Name of Each Part

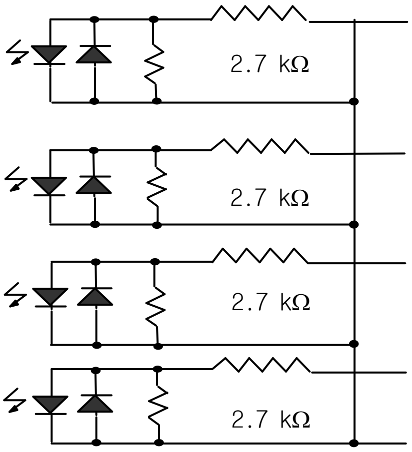
(1) Name of each part

Name	XBO-DC04A
Structure	

Terminal No.	Name		Usage	
	1-phase	2-phase	1-phase	2-phase
00	Ch0 counter input	Ch0 A-phase input	Counter input terminal	A-phase input terminal
01	Ch1 counter input	Ch0 B-phase input	Counter input terminal	B-phase input terminal
02	Ch2 counter input	Ch2 A-phase input	Counter input terminal	A-phase input terminal
03	Ch3 counter input	Ch2 B-phase input	Counter input terminal	B-phase input terminal
COM	Input common	Input common	Common terminal	Common terminal

(2) Interface with external devices

The following table describes interface with external devices

I/O	Internal circuit	Terminal No.	Signal		Operation	Input guaranteed voltage
			1-phase	2-phase		
Input		00	CH0 Pulse input	CH0 A-phase input	On	20.4~28.8V
					Off	6V or less
		01	CH 1 Pulse input	CH0 B-phase input	On	20.4~28.8V
					Off	6V or less
		02	CH 2 Pulse input	CH2 A-phase input	On	20.4~28.8V
					Off	6V or less
		03	CH 3 Pulse input	CH0 B-phase input	On	20.4~28.8V
					Off	6V or less
		COM	COM(Input common)			

10.2.3 Function

(1) Counter mode

(a) High Speed counter module can count High Speed pulses which can not be processed by CPU module's counter instructions (CTU, CTD, CTUD, etc.), up to binary value of 32 bits (-2,147,483,648 ~ 2,147,483,647).

(b) Available input mode is 1-phase input, 2-phase input

(c) Count increasing/decreasing methods are as follows;

1) 1-phase input : a) Increasing/decreasing count operation by program setting

b) Increasing/decreasing count operation by B-phase input signal

2) 2-phase input : setting by difference in phase between A-phase and B-phase

(d) Auxiliary modes are as follows

1) Count Latch

(e) Input mode

1) 1-phase count mode

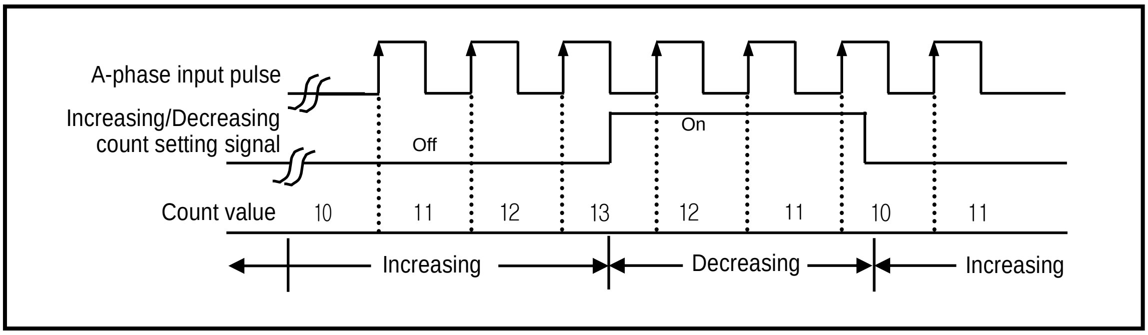
a) Increasing/decreasing count operation by program setting

• 1-phase 1-input 1-multiplication

A-phase input pulse is counted at rising and increasing/decreasing will be decided by the program.

Increasing/Decreasing classification	A-phase input pulse rising	A-phase input pulse falling
Increasing/decreasing count setting signal Off	Increasing count	-
Increasing/decreasing count setting signal On	Decreasing count	-

• Operation example



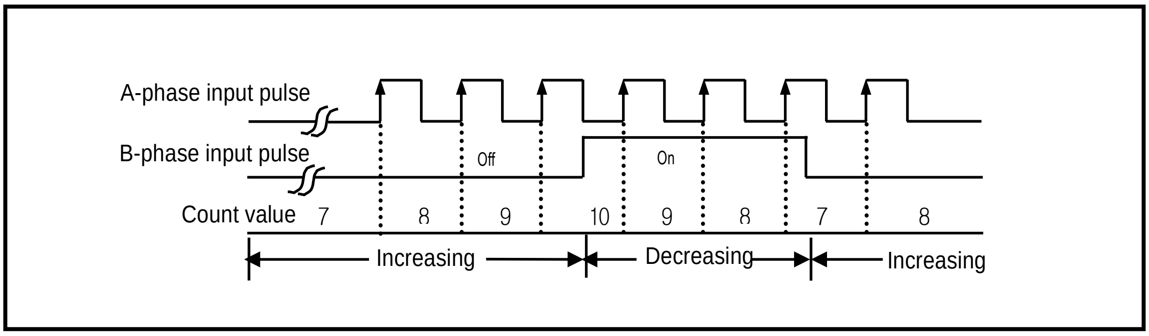
b) Increasing/decreasing count operation by B-phase input signal

•1-phase 2-input 1-multiplication

A-phase input pulse is counted at rising and increasing/decreasing will be decided by B-phase.

Increasing/Decreasing classification	A-phase input pulse rising	A-phase input pulse falling
B-phase input pulse Off	Increasing count	-
B-phase input pulse On	Decreasing count	-

• Operation example

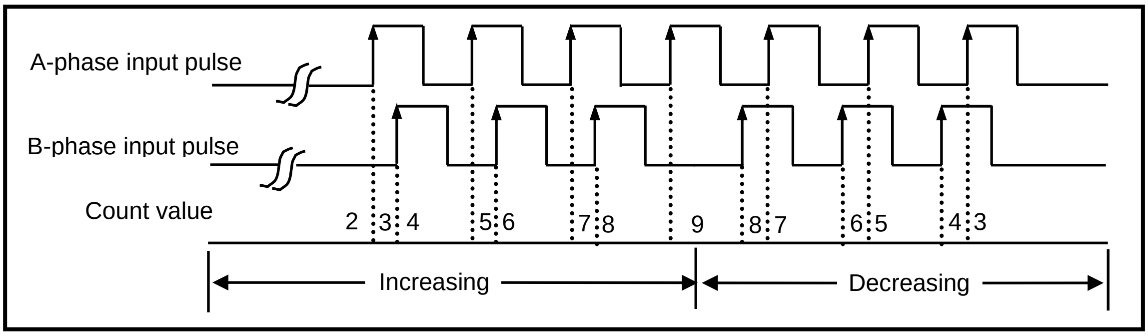


2) 2-phase count mode

a) 2-phase 2-multiplication

A-phase input pulse and B-phase input pulse are counted at rising respectively. If A-phase input is antecedent to B-phase input, increasing operation starts, and if B-phase input is antecedent to A-phase input, decreasing operation starts.

• Operation example



(2) Counter type

Option board supports linear counter.

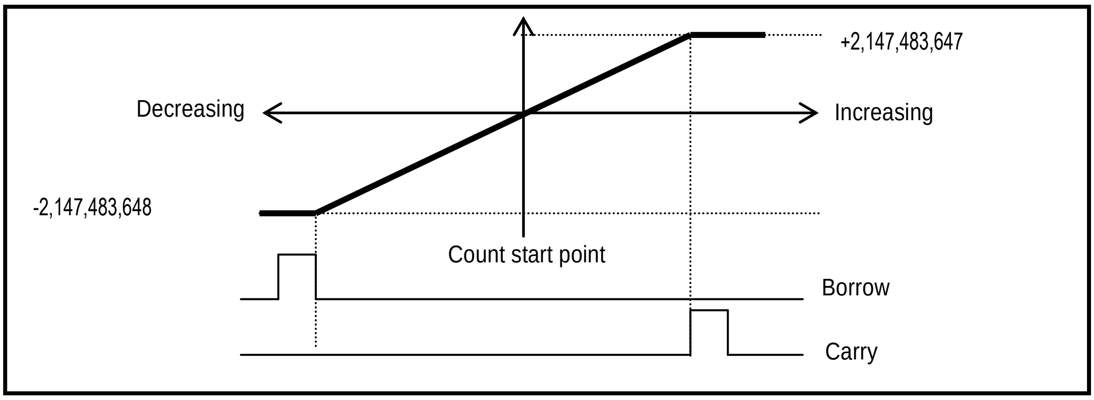
(a) Linear counter

1) Linear Count range: -2,147,483,648 ~ 2,147,483,647

2) If count value reaches the maximum value while increased, Carry will occur, and if count value reaches the minimum value while decreased, Borrow will occur.

3) If Carry occurs, count stops and increasing is not available but decreasing is available.

4) If Borrow occurs, count stops and decreasing is not available but increasing is available.



(3) Carry signal

(a) When Carry signal occurs

1) When count range maximum value of 2,147,483,647 is reached during Linear Count

(b) Count when Carry Signal occurs

1) Count stops if Carry occurs during Linear Count.

(c) Carry reset

1) ‘Carry reset’ instruction is not supported at option board. Reset ‘Carry’ by using ‘Preset’ instruction after making the counter value within counter range.

(4) Borrow signal

(a) When Count when Borrow signal occurs

1) When count range minimum value of -2,147,483,648 is reached during Linear Count.

(b) Count when Borrow signal occurs

1) Count stops if Borrow occurs during Linear Count.

(c) Borrow reset

1) ‘Carry reset’ instruction is not supported at option board. Reset ‘Carry’ by using ‘Preset’ instruction after making the counter value within counter range.

(5) Count latch

(a) When Count latch signal is On, present count value is latched

(b) Setting

If present counter value is to latch, Count Latch function is set 'Use'.

Type	Device area per channel				Ref.
	CH0	CH1	CH2	CH3	
When mounted at slot no.9	U9.0.6	U9.8.6	U9.16.6	U9.24.6	0: Disable 1: Enable
When mounted at slot no.10	UA.0.6	UA.8.6	UA.16.6	UA.24.6	

(c) Count latch function is operated when 'Count latch' signal is On. Namely, counter value is not cleared when power supply Off =>On and mode change, it is counted from previous value.

(d) In latch counter function, internal preset function has to be used for clearing present value.

(6) Preset function

It changes the current value into preset value.

• Preset setting value is saved at the following U area.

Type	Area per each channel (Double word)				Ref.
	CH0	CH1	CH2	CH3	
Slot no. 9 internal preset value	U9.6	U9.14	U9.22	U9.30	
Slot no. 10 internal preset value	UA.6	UA.14	UA.22	UA.30	

• Preset command is specified through the following U area

Type	Area per each channel (bit)				Ref.
	CH0	CH1	CH2	CH3	
Internal preset command	U9.0.1	U9.8.1	U9.16.1	U9.24.1	0: Disable 1: Enable
Internal preset command	UA.0.1	UA.8.1	UA.16.1	UA.24.1	

10.3 Installation and Wiring

10.3.1 Precaution for wiring

Pay attention to the counteractions against wiring noise especially for High-speed pulse input

(1) Surely use twisted pair shielded cable, grounded with 3 class applied.

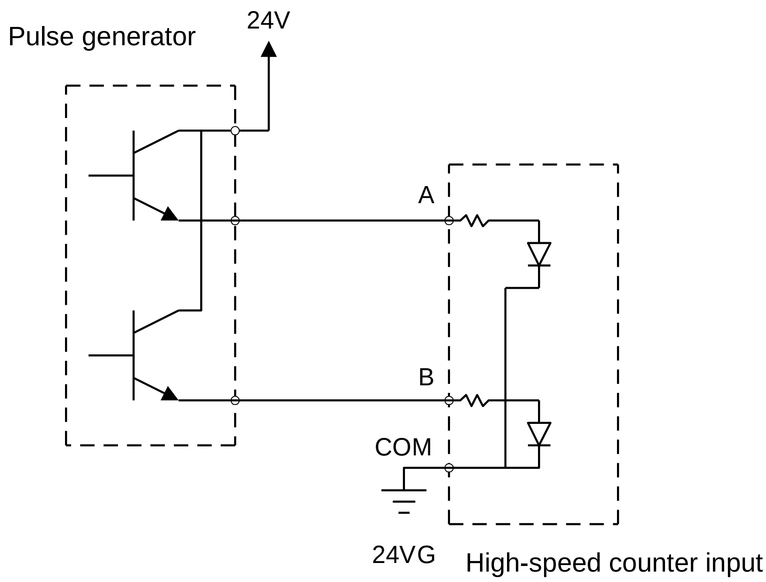
(2) Keep away from power cable or I/O line which may cause noise.

(3) Stabilized power should be used.

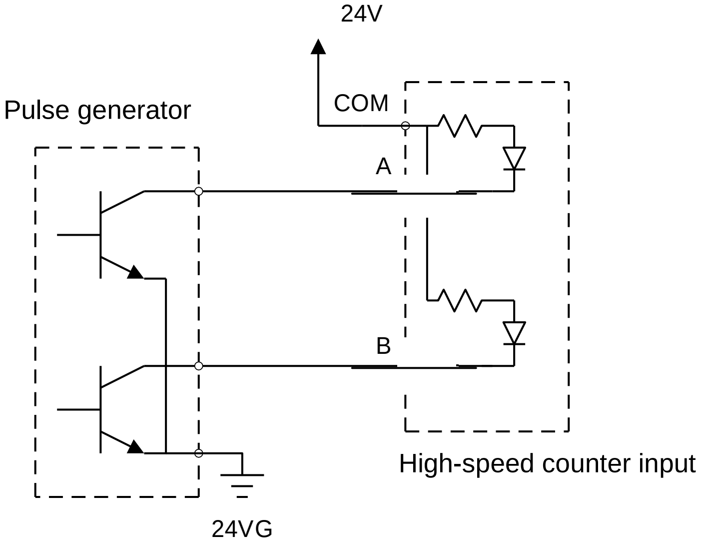
- ▶ Connect A-phase only for 1-phase input.
- ▶ Connect A-phase and B-phase for 2-phase input.

10.3.2 Example of wiring

(1) In case of pulse generator (encoder) is voltage output type



(2) In case of pulse generator is open collector type



10.4 Internal Memory

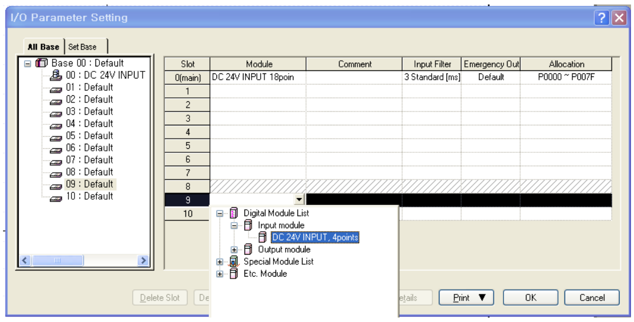
10.4.1 Special area for High-speed counter

U device is used for parameter and operation command area of built-in high-speed counter.

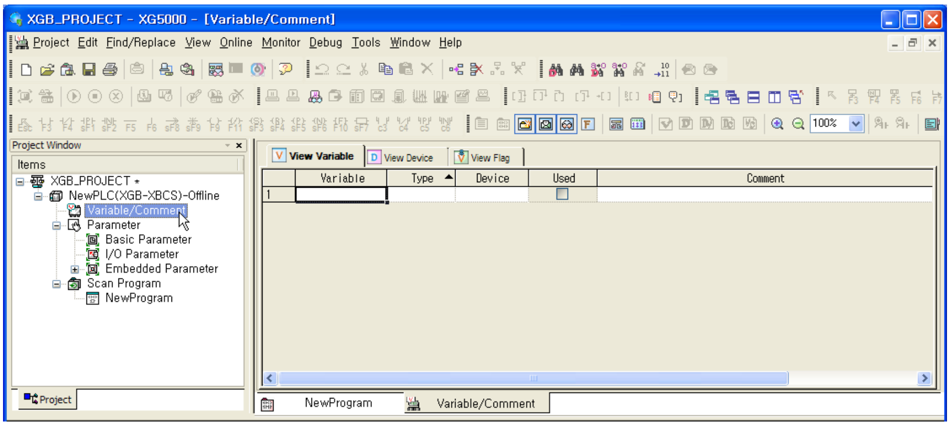
This chapter describes on how to register basic paramter and each item.

(1) U device auto-registration

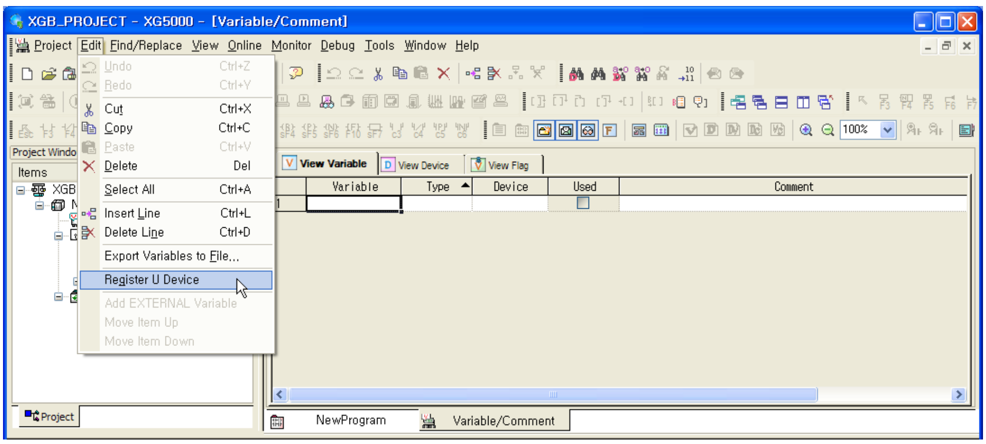
(a) Set the module at slot in [I/O parameter]



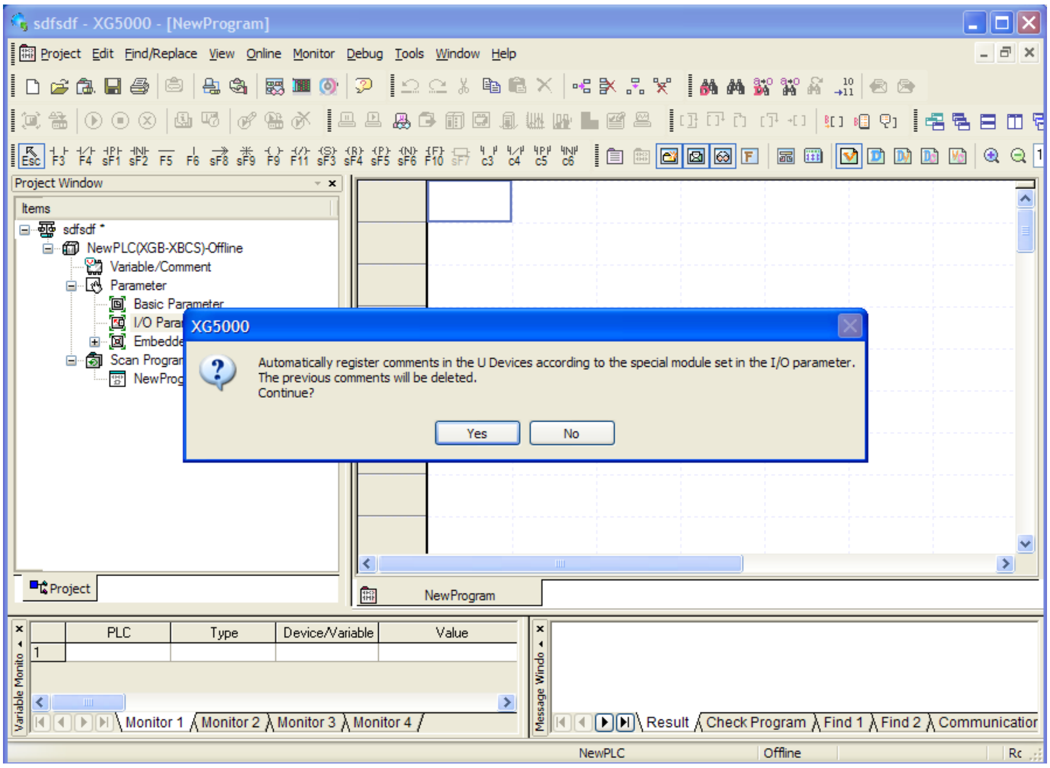
(b) Double-click [Variable/comment]



(c) Select 'Register U device' on menu 'Edit'



(d) Click 'Yes'.



(e) Variables are registered as follows.

Variable Monitoring Window

	PLC	Type	Device/Vari	Value	Variable/Device	Comment
1	NewPLC	BIT	U09.01.1	10	_0009_CH0_Borrow	Input Option Board: CH0 Borrow Flag
2	NewPLC	BIT	U09.01.0	10	_0009_CH0_Carry	Input Option Board: CH0 Carry Flag
3	NewPLC	BIT	U09.00.0	10	_0009_CH0_CNTEN	Input Option Board: CH0 Counter Enable(Level) Command
4	NewPLC	WORD	U09.05	HEX	_0009_CH0_CntMode	Input Option Board: CH0 Counter Mode
5	NewPLC	WORD	U09.02	HEX	_0009_CH0_CurCnt	Input Option Board: CH0 Current Count Value
6	NewPLC	BIT	U09.00.3	10	_0009_CH0_DN	Input Option Board: CH0 Count Inc/Dec Flag
7	NewPLC	WORD	U09.04	HEX	_0009_CH0_ErrCode	Input Option Board: CH0 Error Code
8	NewPLC	WORD	U09.06	HEX	_0009_CH0_IntPrs_Val	Input Option Board: CH0 Internal Preset Setting Value
9	NewPLC	BIT	U09.00.6	10	_0009_CH0_LATCH_EN	Input Option Board: CH0 Latch Counter Enable
10	NewPLC	BIT	U09.00.1	10	_0009_CH0_PREEN	Input Option Board: CH0 Preset Enable(Edge) Command
11	NewPLC	BIT	U09.09.1	10	_0009_CH1_Borrow	Input Option Board: CH1 Borrow Flag
12	NewPLC	BIT	U09.09.0	10	_0009_CH1_Carry	Input Option Board: CH1 Carry Flag
13	NewPLC	BIT	U09.08.0	10	_0009_CH1_CNTEN	Input Option Board: CH1 Counter Enable(Level) Command
14	NewPLC	WORD	U09.13	HEX	_0009_CH1_CntMode	Input Option Board: CH1 Counter Mode
15	NewPLC	WORD	U09.10	HEX	_0009_CH1_CurCnt	Input Option Board: CH1 Current Count Value
16	NewPLC	BIT	U09.08.3	10	_0009_CH1_DN	Input Option Board: CH1 Count Inc/Dec Flag
17	NewPLC	WORD	U09.12	HEX	_0009_CH1_ErrCode	Input Option Board: CH1 Error Code

Note

When registered by "auto-registration", data type is expressed as BIT, WORD. If you want to check with other types such as DINT, DWORD, change the type.

(2) No. 9 slot device area

(a) Action command

Type	Device area per each channel				Ref.
	CH0	CH1	CH2	CH3	
Enable counter	U9.0.0	U9.8.0	U9.16.0	U9.24.0	BIT
Enable internal preset	U9.0.1	U9.8.1	U9.16.1	U9.24.1	BIT
Count inc/dec flag	U9.0.3	U9.8.3	U9.16.3	U9.24.3	BIT
Latch counter enable	U9.0.6	U9.8.6	U9.16.6	U9.24.6	BIT
Pulse input mode	U9.5	U9.13	U9.21	U9.29	INT
Internal preset setting value	U9.6	U9.14	U9.22	U9.30	DINT

(b) Monitor area

Type	Device area per each channel				Ref.
	CH0	CH1	CH2	CH3	
Carry flag	U9.1.0	U9.9.0	U9.17.0	U9.25.0	BIT
Borrow flag	U9.1.1	U9.9.1	U9.17.1	U9.25.1	BIT
Current counter value	U9.2	U9.10	U9.18	U9.26	DINT
Error code	U9.4	U9.12	U9.20	U9.28	INT

(3) No. 10 slot device area

(a) Action command

Type	Device area per each channel				Ref.
	CH0	CH1	CH2	CH3	
Enable counter	UA.0.0	UA.8.0	UA.16.0	UA.24.0	BIT
Enable internal preset	UA.0.1	UA.8.1	UA.16.1	UA.24.1	BIT
Count inc/dec flag	UA.0.3	UA.8.3	U9.16.3	UA.24.3	BIT
Latch counter enable	UA.0.6	UA.8.6	UA.16.6	UA.24.6	BIT
Pulse input mode	UA.5	UA.13	UA.21	UA.29	INT
Internal preset setting value	UA.6	UA.14	UA.22	UA.30	DINT

(b) Monitor area

Type	Device area per each channel				Ref.
	CH0	CH1	CH2	CH3	
Carry flag	UA.1.0	UA.9.0	UA.17.0	UA.25.0	BIT
Borrow flag	UA.1.1	UA.9.1	UA.17.1	UA.25.1	BIT
Current counter value	UA.2	UA.10	UA.18	UA.26	DINT
Error code	UA.4	UA.12	UA.20	UA.28	INT

(4) Parameter setup

(a) Action command

Type	Device status information (based on slot 9, ch0)		Ref.
	CH0	Information	
Enable counter	U9.0.0	0: disable, 1: enable	BIT
Enable internal preset	U9.0.1	0: disable, 1: enable	BIT
Count inc/dec flag	U9.0.3	0: INC, 1: DEC	BIT
Latch counter enable	U9.0.6	0: disable, 1: enable	BIT
Pulse input mode	U9.5	0: 1-phase 1-input 1: 1-phase 2-input 2: 2-phase 2 multiplication	INT
Internal preset setting value	U9.6	-2,147,483,648 ~ 2,147,483,647	DINT

(b) Monitor area

Type	Device status information (based on slot 9, ch0)		Ref.
	CH0	Information	
Carry flag	U9.1.0	0: disable, 1: enable	BIT
Borrow flag	U9.1.1	0: disable, 1: enable	BIT
Current counter value	U9.2	-2,147,483,648 ~ 2,147,483,647	DINT
Error code	U9.4	Indicates error code	INT

10.4.2 Error code

Describes on error of option board high-speed counter

• Describes error code

Error code (Dec.)	Error contents	Ref.
21	Pulse input type range setting error	
22	CH1(3) RUN request while CH0(2) 2-phase RUN * CH1(3) is not available when CH0(2) operate as 2-phase mode	
25	Internal preset value exceeded counter range	

Note

If more than two errors occur, the latest error code is saved and previous error code is removed.

10.5 Example using high-speed counter

Describes on option board high-speed counter example

(1) High-speed counter setup

Set up option board high-speed counter operation by using U area.

(a) Select high-speed counter mode.

Set up high-speed counter mode

(b) If you need ‘Preset’ function, input ‘Preset value’ and turn on ‘Preset Enable” bit.

Input value to preset

Preset Enable signal ON

(c) Specify ‘Latch counter’ or ‘Up/Down counter’

(d) Turn on ‘High-speed counter enable’ signal

Turn on High-speed Counter Enable signal (No. 9 slot, No.0 ch) of input option board (XBO-DC04A)

(2) Monitoring

You can check option board high-speed counter value by registering U9.2 (no.0 slot, no.0 ch) at variable mornitring window or program.

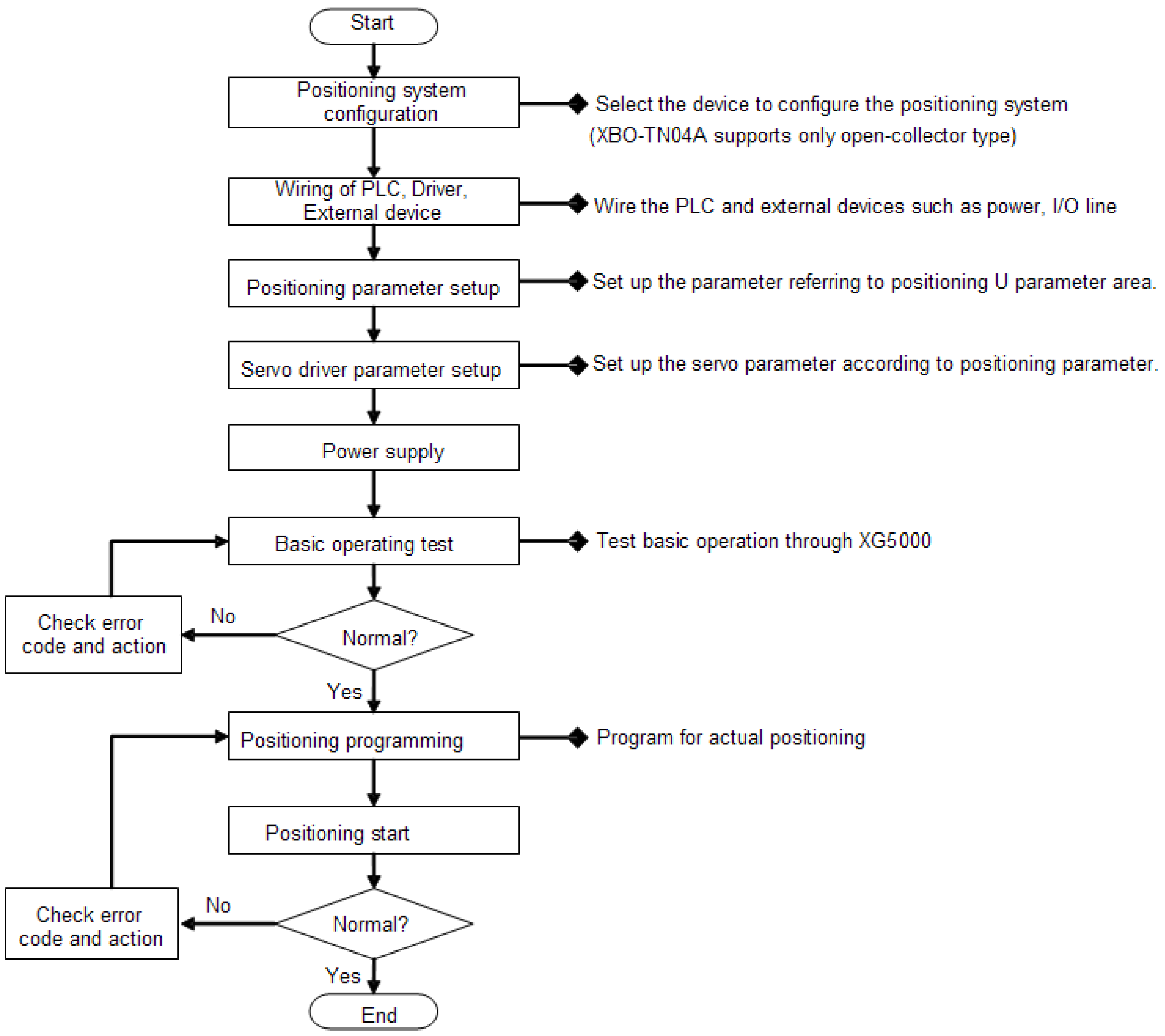
Chapter11 TR Output Option Board

This chapter describes specification and how to use the output option board.

11.1 TR Output Option Board Operation Sequence of Positioning

11.1.1 Operation Sequence of Positioning

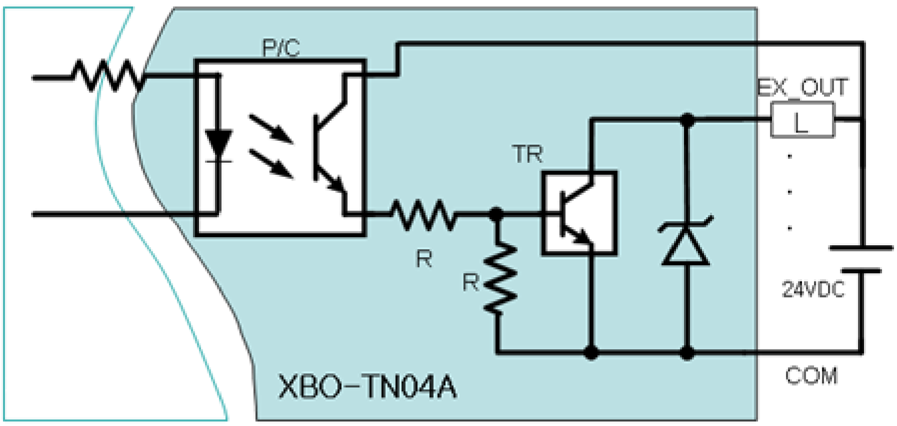
Operation sequence is as follows. Positioning function of the option board operates only at slot number 9.



11.2 XBO-TN04A Specification

11.2.1 Output option board specification

Item		Transistor output specification	
		XBO-TN04A	Remark
No. of output		4 (Pulse output function is supported when mounted on standard type)	
Insulation method		Photo coupler insulation	
Rated load voltage		DC 24V	
Max. load current		0.5A/point, 2A/COM	
Surge killer		Zener diode	
Leakage current when Off		0.1㎃ or less	
Voltage drop when On		DC 1V or less	
Inrush current		3A, 10㎳ or less	
Response time	Off → On	1㎳ or less	
	On → Off	1㎳ or less	
Operating indicator		-	
Pulse output	No. of axes	2	When mounted on standard type
	Output method	Open collector method	
	Control unit	Pulse	
	Control speed	10kpps (One option board supported _ No. 9 slot)	
	Setting method	Setup by DST instruction	
Circuit configuration			



11.3 Positioning Specification

Positioning function is built in XGB output option board. This describes specification, how-to-use, function, programming and wiring of built-in positioning.

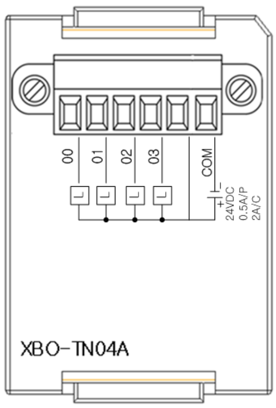
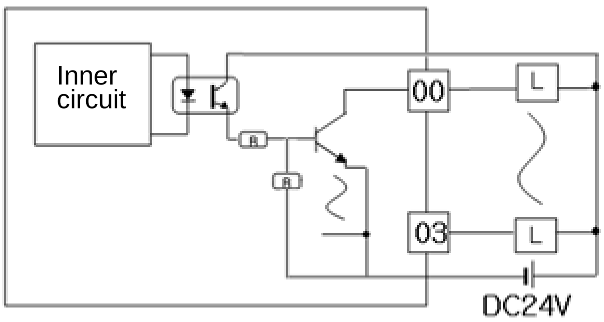
11.3.1 Performance Specification

(1) Performance Specification

Item \ Model		XBO-TN04A
No. of axes		2
Control method		Position control, speed control
Control unit		Pulse
Positioning	Method	Incremental
	Address range	-2,147,483,648 ～ 2,147,483,647(pulse)
	Speed range	1 ～10,000pps(1pps unit)
Manual operation		JOG operation
Home return		By DOG
Max. connection distance		2 m
Connector		6 Pin connector

11.3.2 Name of each part

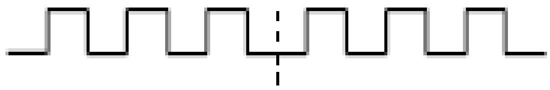
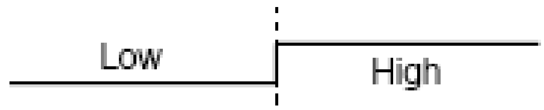
(1) Name of each part

Item	XBO-TN04A	
	Diagram	
Structure		

Connector	Output point No.		Description	Remark
Pulse output	X-axis	00	Positioning X-axis pulse string output point (Open collector output)	High Active
	Y-axis	01	Positioning Y-axis pulse string output point (Open collector output)	
Direction output	X-axis	02	Positioning X-axis direction output point (Open collector output)	
	Y-axis	03	Positioning Y-axis direction output point (Open collector output)	
External power	X/Y-axis	24V	Terminal for external power supply for TR	
Output common	X/Y-axis	COM	Output common terminal	

(2) Output pulse level

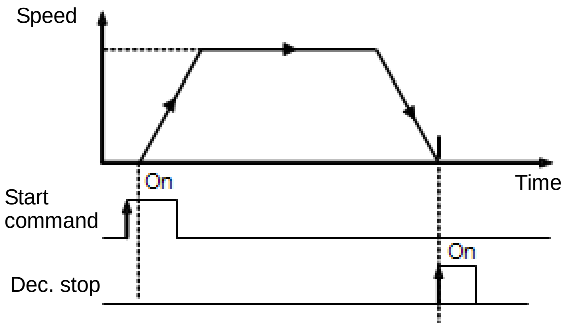
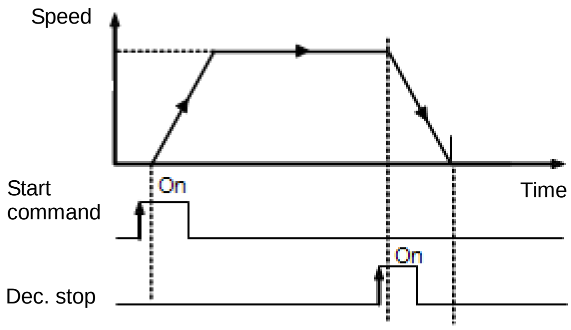
Basic option board output pulse is as follows.

Pulse output method	Output signal	Output signal level	
		Forward	Reverse
Pulse+Direction mode	Pulse		
	Direction		

11.3.3 Before Positioning

(1) Positioning function list

Positioning function of XGB option board built-in positioning is as follows.

<table>
<tr><th>Positioning function</th><th colspan="2">description</th><th>Instruction</th><th>Ref.</th></tr>
<tr><td rowspan="2">Position control</td><td>Operation pattern</td><td>
</td><td>DST</td><td></td></tr>
<tr><td>Operation</td><td colspan="3">If the rising edge of start command is detected, it moves with designated speed to designated position, and complete signal is on (dwell is not supported)</td></tr>
<tr><td rowspan="2">Speed control</td><td>Operation pattern</td><td>
</td><td>DST</td><td></td></tr>
<tr><td>Operation</td><td colspan="3">If the rising edge of start command is detected, it moves with designated speed and stops after deceleration by stop command. At this time, complete signal will not be not on.</td></tr>
</table>

(2) Position control

Position control is to move the designated axis from start address (present position) up to target address (movement). There are two position control methods, absolute and incremental.

(a) Control by absolute coordinates (Absolute coordinates)

Object moves from start address to target address. Position control is performed, based on the address designated in Home Return (home address).

Direction is determined by start address and target address.

• Start address < target address: forward positioning

• Start address > target address: reverse positioning

(b) Control by incremental coordinates (incremental coordinates)

Object moves from current position as far as the address set in operation data. At this time, target address is based on start address. Direction is determined by sign (+,-).

• In case Address is positive number: forward positioning（Direction increasing address)

• In case Address is negative number: reverse positioning (Direction decreasing address)

(3) Speed control

Speed control means that object moves with steady speed (steady pulse string) until stop command.

• In case of speed control, direction is determined by sign of Address set in operation data.

Forward : Address is positive number

Reverse : Address is negative number

In the speed control, direction is determined by sign of target address regardless of current position and target position.

For example, current position is 100 and target position is 90, though target position is less than current position, since sign is positive, it moves forward.

Note
• For more information, refer to XGB positioning manual.

11.3.4 Positioning Stop Factor

(1) Stop factor and how to deal with stop factor

• If following factor occurs during positioning, it stops without completing positioning.

In case positioning stops by stop instruction (STP, EMG) or following stop factor, generally, the only axis where stop instruction is executed or stop factor occurs stops.

<table>
<tr><th colspan="2">Operation status / Stop factor</th><th>Positioning *1</th><th>Homing</th><th>Jog operation</th><th>Axis operation status after stop instruction *2</th></tr>
<tr><td rowspan="2">Stop by sequence program *3</td><td>Dec. stop instruction</td><td>Dec. stop</td><td>Dec. stop</td><td>Error 322 (Keep operating)</td><td>Decelerating</td></tr>
<tr><td>Emg. Stop instruction</td><td colspan="3">Immediate stop</td><td>Error status (Error 481) Output prohibited</td></tr>
<tr><td rowspan="2">Stop by external signal</td><td>External upper limit “On”</td><td colspan="2">Immediate stop</td><td>Forward immediate stop</td><td>Error status (Error 492)</td></tr>
<tr><td>External lower limit “On”</td><td colspan="2">Immediate stop</td><td>Backward immediate stop</td><td>Error status (Erro 493)</td></tr>
</table>

Note

*1 : Positioning refers to position control, speed control by positioning data.

*2 : If axis is ‘Output prohibited status’ after being stopped, run a instruction to cancel ‘Output prohibited status’. (CLR instruction) .

*3 : Stop by sequence program refers to stop by “Stop instruction” at XGB program.

(2) Stop Process and Priority

(a) Dec. stop process

• If it stops due to deceleration stop instruction, since positioning operation is not complete, it does not generate positioning completion signal.

(b) Process of emergency stop and external input upper/lower limits

• If emergency stop instruction or external input upper/lower limits are inputted during positioning control, it stops positioning control and turns into ‘Output prohibited stats’, generating an error.

(c) Stop process priority

The priority of stop process is as follows.

Dec. stop < Emg. stop

(d) Emergency stop

- It immediately stops if it meets emergency stop while performing start-related instructions (indirect start, direct start, Home Return start, jog start).
- Emergency stop generates Error 481.
- Since it turns into “Output prohibited status” and “un-defined origin status”, once emergency stop is executed, execute origin determination (Home return, Current position preset) again to run an instruction that requires defined origin status”

11.3.5 Manual operation

In general, manual operations refer to operation which doesn’t use operation data. In output option board, JOG operation is supported.

(1) JOG operation

- Jog operation means positioning by jog operation stat contact point

		Jog forward start	Jog backward start	Jog high speed/low speed
XBO-TN04A	X-axis	U9.1.8	U9.1.9	U9.1.A
	Y-axis	U9.17.8	U9.17.9	U9.17.A

- It is operated by jog speed set in positioning parameter.
- It can be executed when origin is not determined.
- Acceleration/deceleration process is controlled by the duration set in jog acceleration/deceleration time among parameter settings of this software package.
- If jog speed is set out of allowable range, it generates an error and operation is not available

Range	High speed jog operation	1 ~ 100,000	(Unit: 1pps)
	Low speed jog operation	1 ~ jog high speed	

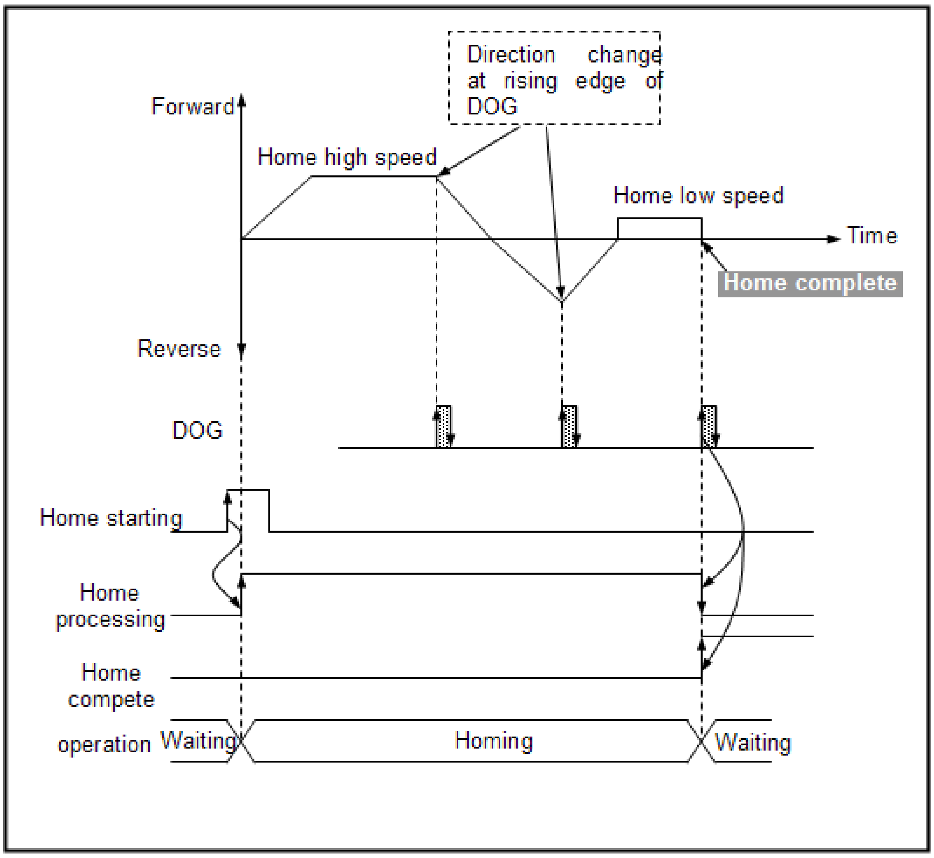
Remark

- Make sure to follow the cautions

Bias speed ≤ Jog high speed ≤ Speed limit

11.3.6 Home return

XBO-TN04A supports only “Home return by DOG”.



(a) If homing command (ORG instruction) is executed, it accelerates to home direction set in Home Parameter and it homes with high speed.

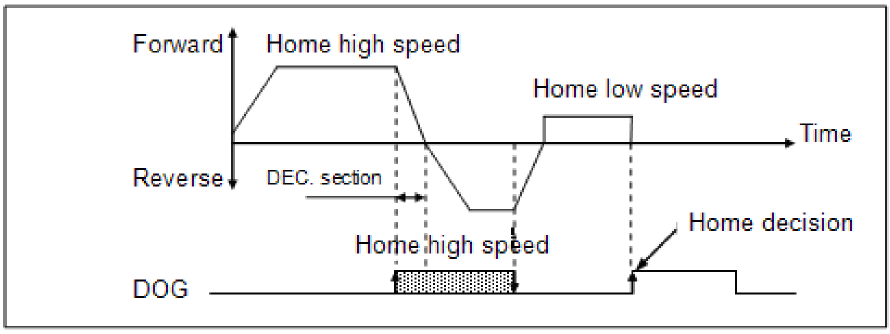
(The above figure is example when homing direction is forward)

(b) While target is homing with high speed, if rising edge of DOG (U9.1.B: X-axis) occurs, target speed decreases and change its direction.

(c) When it accelerates after changing direction, if rising edge of DOG occurs, it homes with low speed.

(d) In the homing status with low speed, rising edge occurs of DOG third time, it stops and determines the origin.

(e) When ‘On’ time of DOG signal is larger decreasing time, it changes the direction at the falling edge of DOG and moves with low speed and stops at the rising edge of DOG and determines the origin.

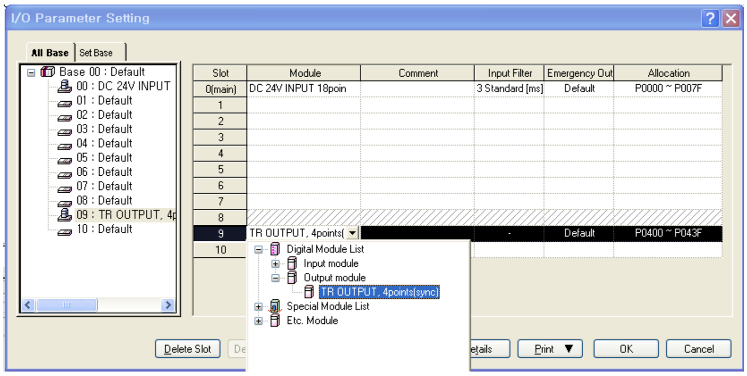


11.3.7 Positioning Basic Parameter Setup

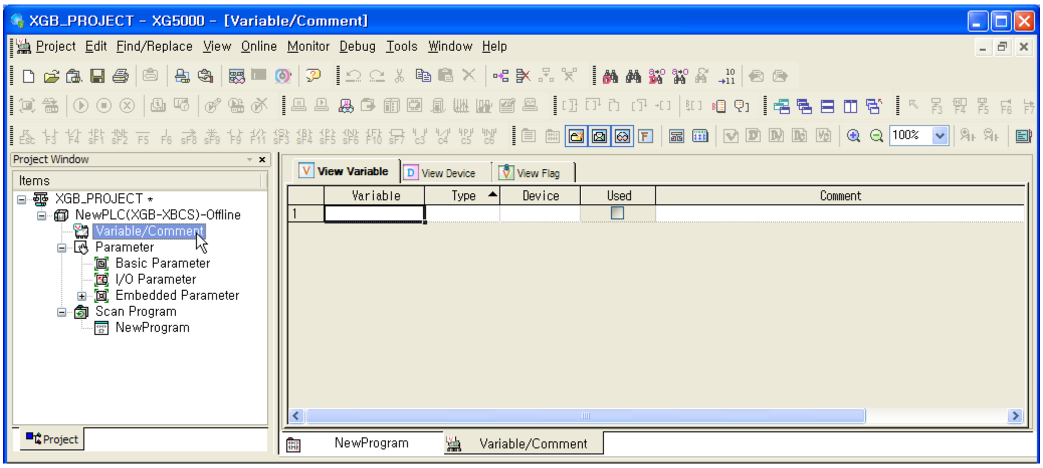
This chapter describes on how to register basic parameter of XGB main output option board positioning function and each item.

(1) U device auto registration

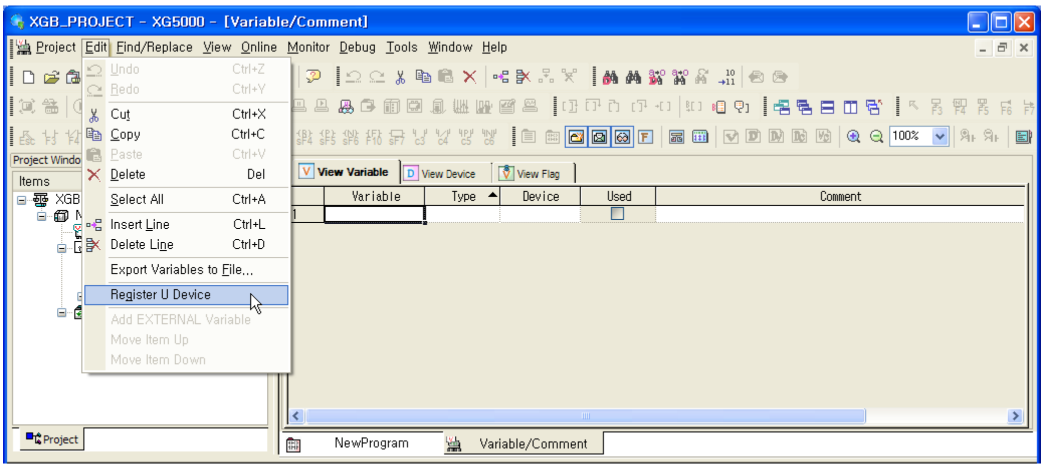
(a) Set up the module at the slot in [I/O Parameter]



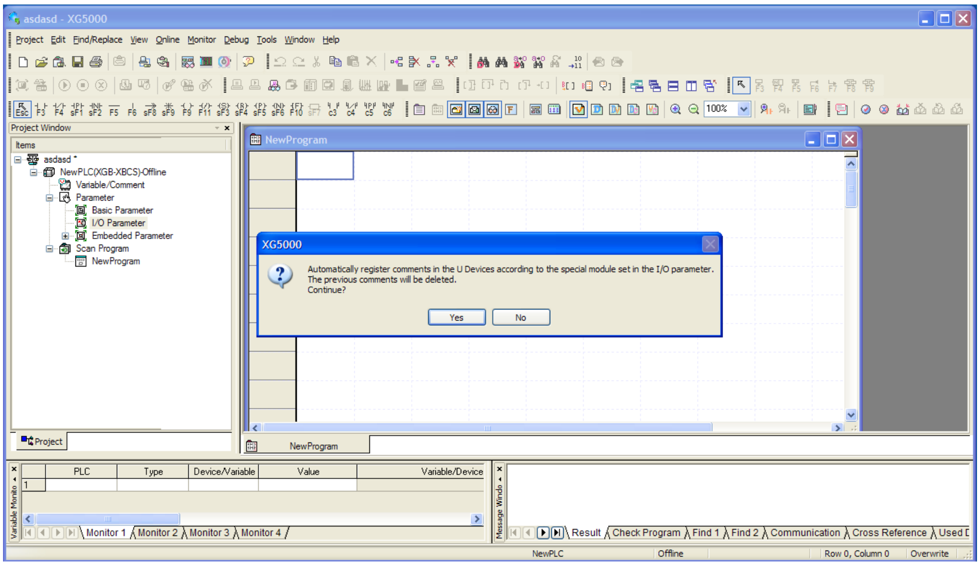
(b) Double-click [Variable/Comment].



(c) Select “Register U device” on menu ‘Edit’.



(d) Click ‘yes’.



(e) Variables are registered as the screen below.

Variable Monitoring Window

	PLC	Type	Device/Vari	Value	Variable/Device	Comment
1	NewPLC	BIT	U09.00.0	10	_0009_POS_X_Busy	XAxis BUSY
2	NewPLC	BIT	U09.00.1	10	_0009_POS_X_Err	XAxis Error
3	NewPLC	BIT	U09.00.2	10	_0009_POS_X_Done	XAxis Position Complete
4	NewPLC	BIT	U09.00.3	10	_0009_POS_X_OriginFix	XAxis Origin Fix
5	NewPLC	BIT	U09.00.4	10	_0009_POS_X_OutInhibit	XAxis Output Inhibit
6	NewPLC	BIT	U09.00.5	10	_0009_POS_X_Stop	XAxis Stop
7	NewPLC	BIT	U09.00.6	10	_0009_POS_X_ULimit	XAxis Upper Limit Detection
8	NewPLC	BIT	U09.00.7	10	_0009_POS_X_LLimit	XAxis Lower Limit Detection
9	NewPLC	BIT	U09.00.8	10	_0009_POS_X_Estop	XAxis Emergency Stop
10	NewPLC	BIT	U09.00.9	10	_0009_POS_X_Dir	XAxis CW/CCW
11	NewPLC	BIT	U09.00.A	10	_0009_POS_X_Acc	XAxis Move Status(Acceleration)
12	NewPLC	BIT	U09.00.B	10	_0009_POS_X_Const	XAxis Move Status(Constant)

Note

When variables are registered by above method, variables are expressed by BIT and WORD. If you want to check them as DINT, DOWRD, change the data type.

(2) Positioning parameter of XBO-TN04A

U area of each item is as follows.

Item	Data type	Signal direction	Status information	U area for positioning	
				X-axis	Y-axis
BUSY	BOOL	Output (monitoring)	0: Stop, 1: Run	U9.0.0	U9.16.0
Error			0: No error, 1: Error occurred	U9.0.1	U9.16.1
Positioning complete			0: not complete, 1: complete	U9.0.2	U9.16.2
Home determination			0: not determined, 1: determined	U9.0.3	U9.16.3
Output prohibited			0: output available, 1: output prohibited	U9.0.4	U9.16.4
Stop status			0: not stop status, 1: stop status	U9.0.5	U9.16.5
Upper limit			0: not detect, 1: detect	U9.0.6	U9.16.6
Lower limit			0: not detect, 1: detect	U9.0.7	U9.16.7
EMG. Stop			0: normal status, 1: EMG. Stop status	U9.0.8	U9.16.8
CW/CCW			0:CW, 1:CCW	U9.0.9	U9.16.9
Operation status (accelerating)			0: not accelerating , 1: accelerating	U9.0.A	U9.16.A
Operation status (steady status)			0: not steady status, 1: steady status	U9.0.B	U9.16.B
Operation status (decelerating)			0: not decelerating , 1: decelerating	U9.0.C	U9.16.C
Position control			0: not under position control 1: under position control	U9.0.D	U9.16.D
Speed control			0: not under speed control 1: under speed control	U9.0.E	U9.16.E
Home return			0: not under home return 1:under home return	U9.0.F	U9.16.F
JOG low speed			0: not under JOG low speed 1: under JOG low speed	U9.1.0	U9.17.0
JOG high speed			0: not under JOG high speed 1: under JOG high speed	U9.1.1	U9.17.1
Forward JOG start		Input	0: JOG stop, 1: forward JOG start	U9.1.8	U9.17.8
Reverse JOG start			0: JOG stop, 1: Reverse JOG start	U9.1.9	U9.17.9

Item	Data type	Signal direction	Status information	U area for positioning	
				X-axis	Y-axis
JOG low/high speed	BOOL	Input	0: JOG low speed, 1: JOG high speed	U9.1.A	U9.17.A
DOG			Operate at rising edge	U9.1.B	U9.17.B
Upper limit signal			Detected at falling edge	U9.1.C	U9.17.C
Lower limit signal			Detected at falling edge	U9.1.D	U9.17.D
Home return direction			0: CW, 1: CCW	U9.1.E	U9.17.E
Positioning status			0: disable, 1: enable	U9.1.F	U9.17.F
Current position	DINT	Output	-2,147,483,648 ~ 2,147,483,647	U9.2	U9.18
Current speed	WORD		1 ~ 10,000[pulse/s]	U9.4	U9.20
Error code	WORD		Indicates positioning error	U9.5	U9.21
Bias speed	WORD	Input	1 ~ 10,000[pulse/s]	U9.6	U9.22
Speed limit	WORD		1 ~ 10,000[pulse/s]	U9.7	U9.23
Acc. time	WORD		0 ~ 10,000[unit: ms]	U9.8	U9.24
Dec. time	WORD		0 ~ 10,000[unit: ms]	U9.9	U9.25
Home address	DINT		-2,147,483,648 ~ 2,147,483,647	U9.10	U9.26
Home return high speed	WORD		1 ~ 10,000[pulse/s]	U9.12	U9.28
Home return low speed	WORD		1 ~ 10,000[pulse/s]	U9.13	U9.29
JOG high speed	WORD		1 ~ 10,000[pulse/s]	U9.14	U9.30
JOG low speed	WORD		1 ~ 10,000[pulse/s]	U9.15	U9.31

Note

• For more information on positioning parameter item, refer to XGB built-in positioning manual.

11.4 Positioning Instruction List

Positioning instructions used in XBO-TN04A positioning are summarized as follows.

(1) XBO-TN04A positioning instruction

Instruction	Command	Command condition	XGB built-in positioning manual
ORG	Home return	Slot, command axis	5.2.1
DST	Direct start	Slot, command axis, position, speed, dwell time, M code, control word	5.2.3
STP	Stop	Slot, command axis, dec. time	5.2.9
PRS	Current position preset	Slot, command axis, position	5.2.18
EMG	EMG. Stop	Slot, command axis	5.2.19
CLR	Error reset, output prohibition cancel	Slot, command axis, disable/enable pulse output	5.2.20

Note

- XGB positioning instruction operates at rising edge. Namely, instruction is executed once when execution contact point is on.
- For instruction, refer to XGB positioning manual.
- When using DST instruction in XBO-TN04A, dwell time and M code are not supported.

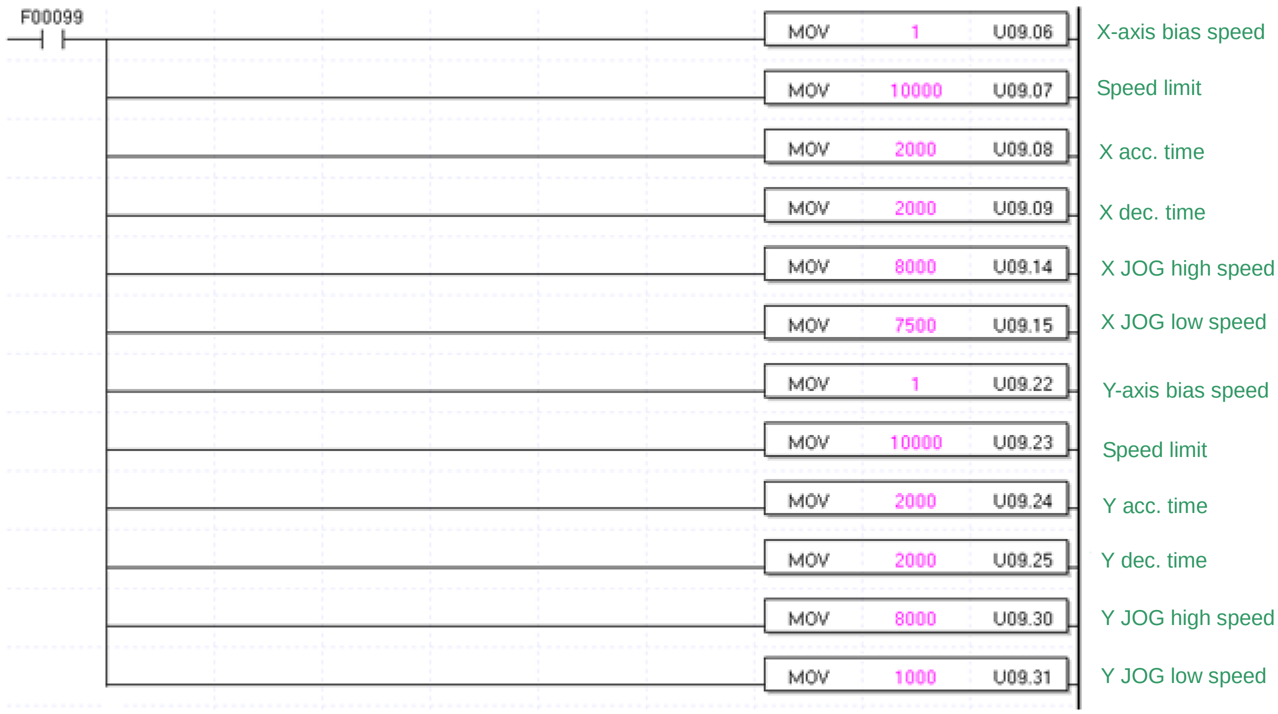
11.5 Positioning Example

This chapter describes positioning example of XBO-TN04A.

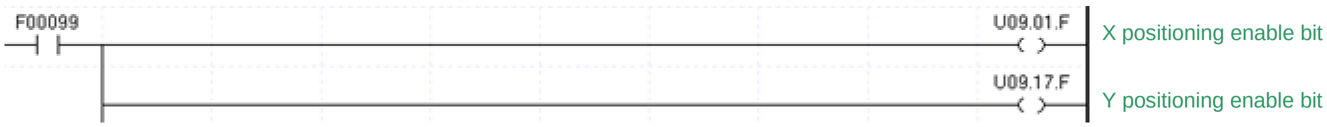
(1) Positioning setup

Option board positioning is set up by U area. Set up each parameter to use positioning function.

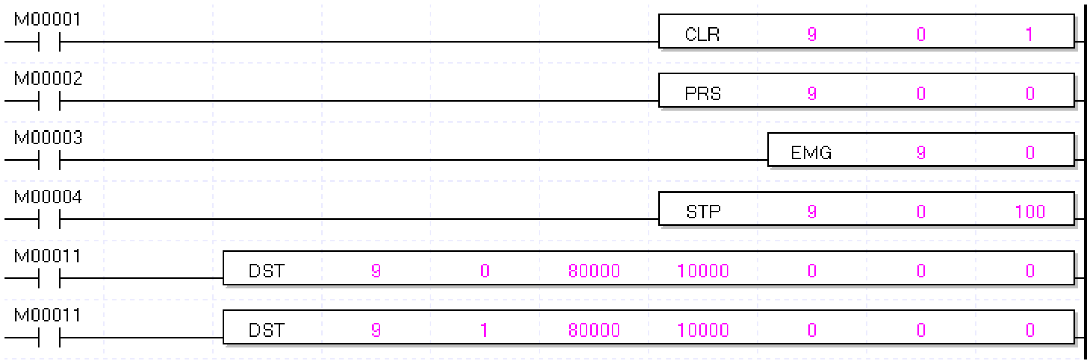
(a) Input each parameter value.



(b) Turn On or Off according whether to use positioning



(c) Set up the function as follows.



(2) Monitoring

You can check option board posioing speed, crrent position by regstering U9.2, U9.4(No. 9 slot, X-axis) at variable monitor window or program

Chapter12 Memory Module

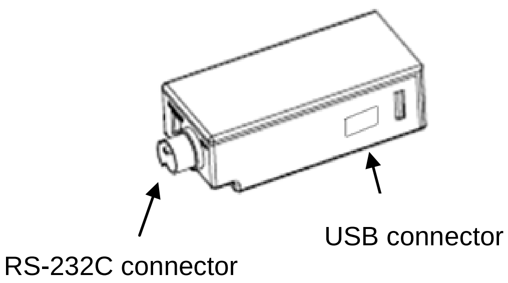
12.1 Memory Module Specification

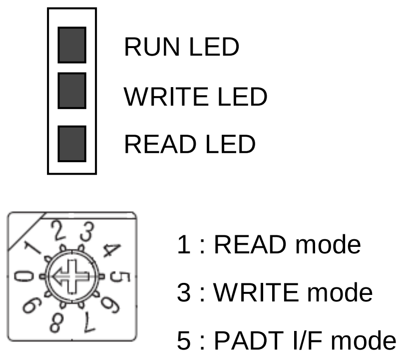
You can save user program safely or download user program to PLC without special handling when user program is damaged by using external memory module in XGB PLC

12.1.1 Memory module specification

Item	XBO-M2MB	Ref.
Memory capacity	2MByte	
Memory type	Flash Memory	
Specification	USB supported, Program Read/Write	
Indicator	LED	1. RUN 2. WRITE 3. READ
Operating mode setup	Mode setup by rotary switch	
Operating power supply	RS-232C communication connecter, USB connector	5V
Purpose	For moving	

12.1.2 Memory module structure





Note

-.Memory module can be used for XGB (not supported for XGK/I/R)
-.Memory module is not supported at the version below
(XBMS: V2.5 or less, XBCH: V1.8 or less, XECH: V1.2 or less)

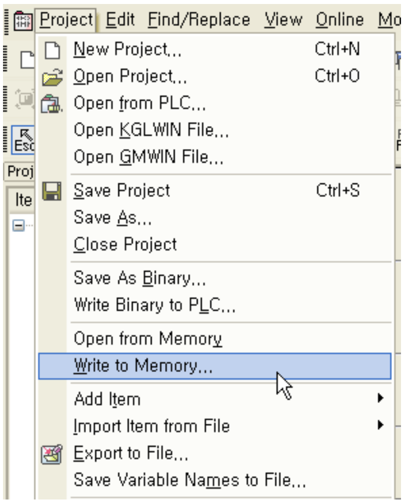
12.1.3 How to use memory module

(1) Save program, parameter, communication parameter at external memory module
   (a) Set the switch of memory module as 1
   (b) Install memory module at the RS-232C port of main unit
      - After installation, program and parameter (including communication) is saved into memory module and READ LED is on
      - If Saving program and parameter is complete, READ LED is off
   (c) Separate memory module from main unit

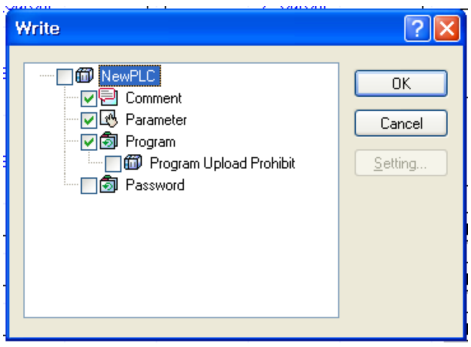
(2) Save user program of external memory module at main unit
   (a) Set the operating mode of main unit as STOP
      - In RUN mode, you can't save program
   (b) Set the switch of memory module as 3
   (c) Install the memory module
      - Install it at the RS-232C port of the main unit.
      - PLC program and parameter (including communication) is written and WRITE LED is on
      - If saving program and parameter is complete, WRITE LED is off.
   (d) If you change operation mode of PLC into RUN, PLC operates with program and parameter saved in memory module.

With the above handling, you can run PLC with program saved in memory module

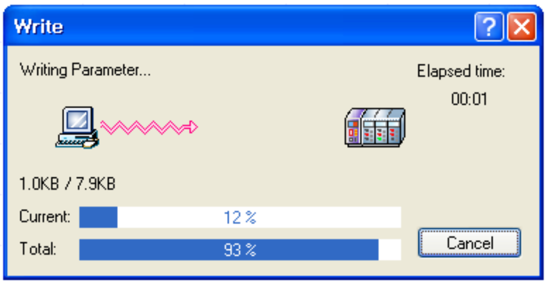
(3) Save program of XG5000at the memory module
   (a) Set the mode switch of XBO-M2MB as "5" and connect XBO-M2MB to USB port of PC
   (b) Select Project → Write to Memory on XG5000 menu.



   (c) 'Write' window is created as follows.



   (d) "Writing completed" window appears.

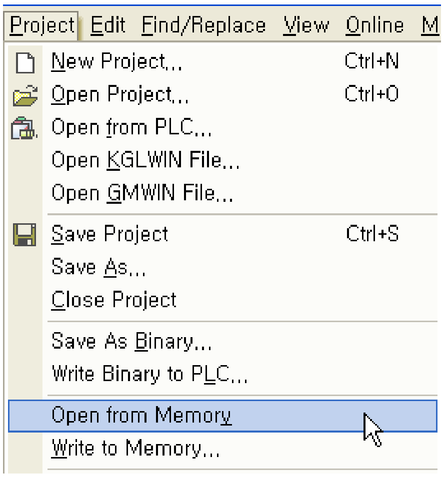


(e) With above method, through PADT, you can save program, parameter, communication parameter at XBO-M2MB

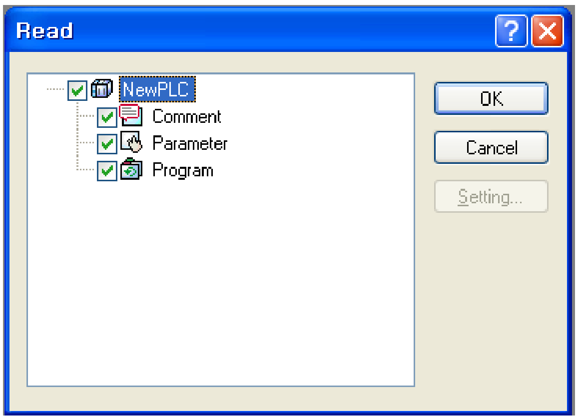
(4) Open from memory module

(a) Set the mode switch of XBO-M2MB as "5" and connect XBO-M2MB to USB port of PC

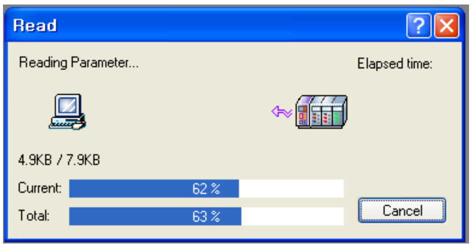
(b) Select "Project → Open from Memory" on XG5000 menu

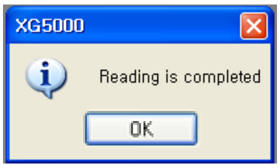


(c) "Read" window is created as follows.



(d) "Reading is completed" window appears.



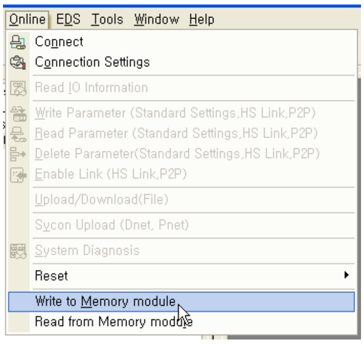


(e) With above method, through PADT, you can save program, parameter, communication parameter from XBO-M2MB

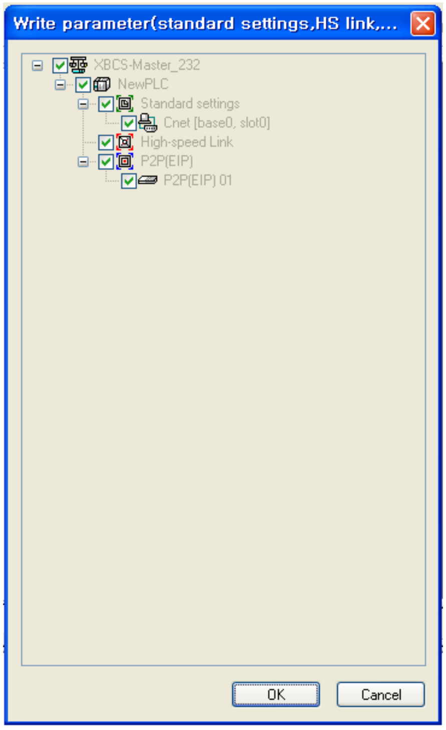
(5) Write to Memory module

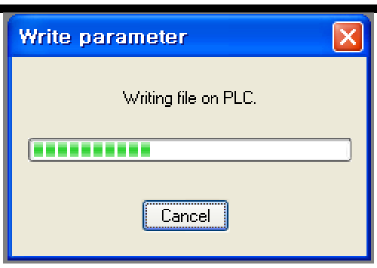
(a) Set the mode switch of XBO-M2MB as “5” and connect XBO-M2MB to USB port

(b) Click “Online → Write to Memory module” on XG-PD menu

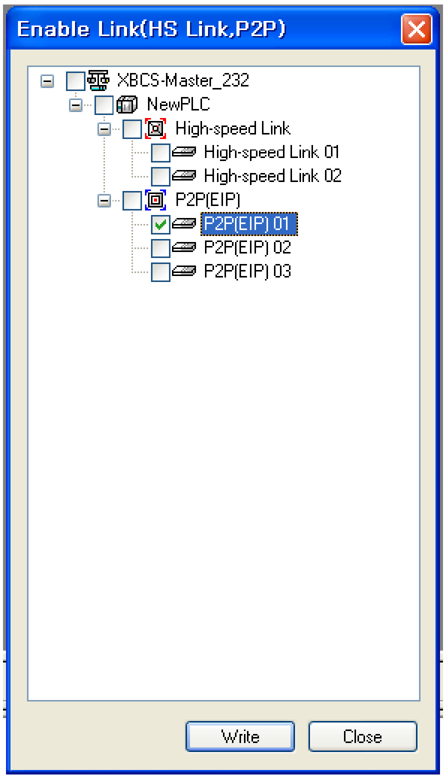


(c) If you click “OK” button, it saves each parameter at the memory module.

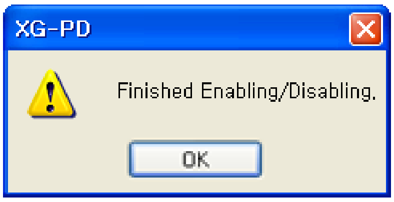




(d) If “Enable Link” window appears, check the item and press “Write”



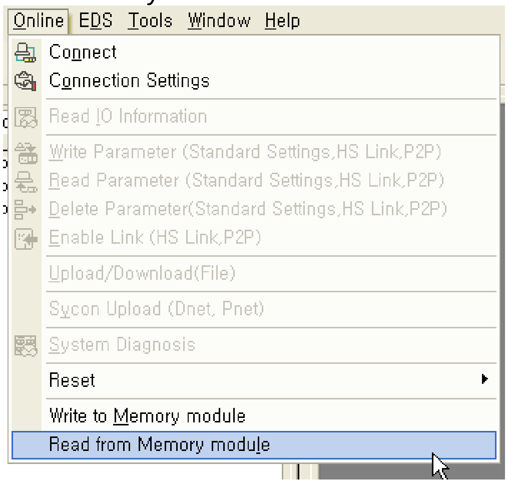
(e) “Enable, Disable” window appears



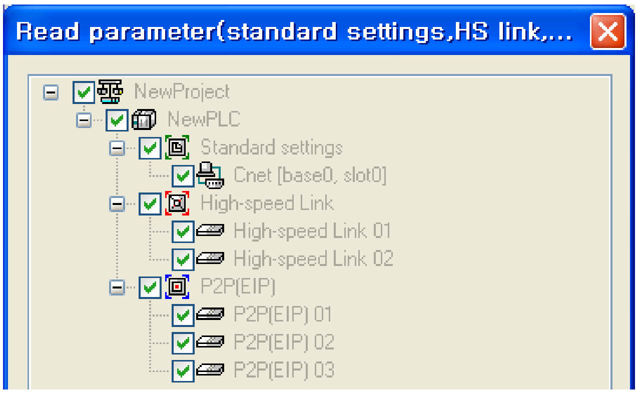
(6) Read from Memory module

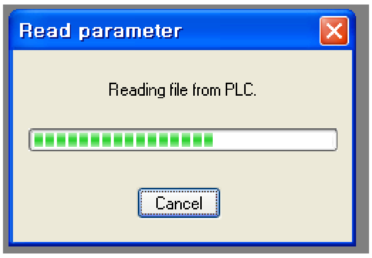
(a) Set the mode switch of XBO-M2MB as “5” and connect XBO-M2MB to USB port of PC

(b) Select “Online → Read from Memory module” on XG-PD menu.



(c) If you click “OK” button”, it read each parameter form the memory module.





Note

-. “Open from memory module” and “Write to Memory module” menus of PADT are activated when PLC is Offline. They are deactivated when PLC is Online.

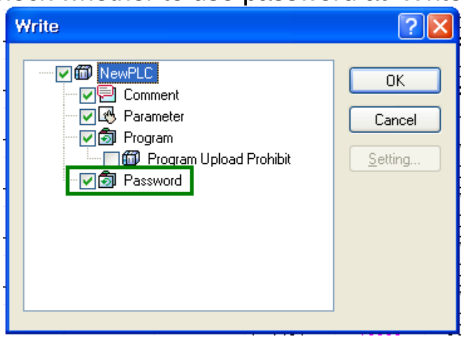
-. When connecting with PADT, connection type should be ‘USB’

12.1.4 How to use when password is set

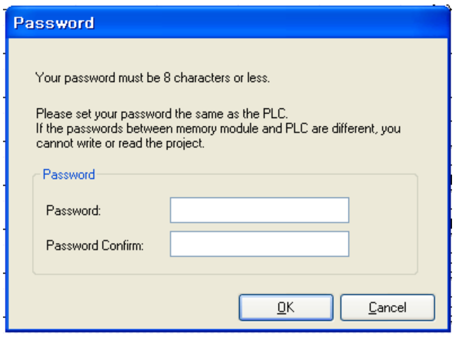
(1) When connecting PADT with memory module

(a) When setting password at program and writing program to memory module, it is saved according to rotary switch operating mode without functions cancelling the password

1) When writing program, check whether to use password at 'Write' window.



2) If you press 'OK' after setting password, program is saved at memory module with that password.

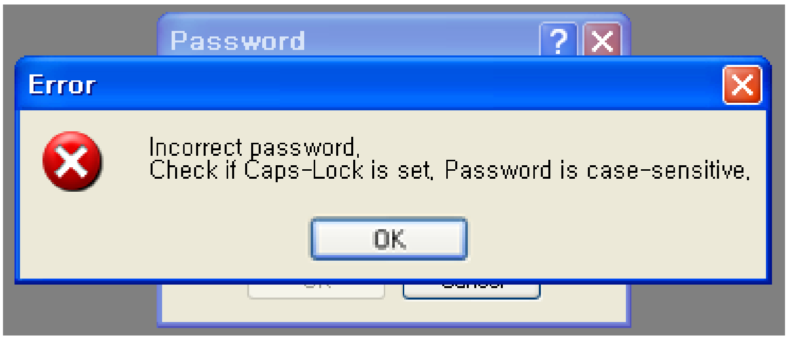


(b) When reading password-set program to PADT, screen appears, which is same as when password is set in PLC.

1) "Password" window is created.

2) If you input password same as that in memory module, it reads program.

3) When password is incorrect, error message appears as follows.



(2) Write to PLC by memory module

(a) When password of program in memory module is not set
1) When no password is set in PLC
- Saves program of the memory module in PLC
2) When password is set in PLC
- Writing is not executed

(b) When password of program in memory module is set
1) When no password is set in PLC
- Writing to PLC is executed
But, password of the memory module is not written to PLC.
2) When password is set in PLC
- When PLC password is same as that of the memory module, writing is executed.
- When PLC password is not same as that of the memory module, writing is not executed. (WRITE LED flickers)

(3) Reading program in PLC to memory module

(a) When password of program in PLC is not set
  1) When no password is set in the memory module
    - Reads program from PLC
  2) When password is set in the memory module
    - After reading, it clears password of the memory module

(b) When password of program in PLC is set
  1) When no password is set in the memory module
    - Writing is not executed
  2) When password is set in the memory module
    - When PLC password is same as that of the memory module, writing is executed.
    - When PLC password is not same as that of the memory module, writing is not executed.

(4) When LED flickers

	Condition	LED
1	PLC type is not XGB	RUN LED flickers
2	Operating mode changes while being connected to PADT or PLC	RUN LED flickers
3	Connected to PADT while mode switch is “1”	READ LED flickers
4	PLC program upload is prohibited	READ LED flickers
5	You execute reading when password is set in PLC (when password is not same as that of memory module)	READ LED flickers
6	Connected to PADT while mode switch is “3”	WRITE LED flickers
7	You execute writing the memory module when PLC mode is RUN	WRITE LED flickers
8	Connected to the different type of PLC with the type set in the memory module	WRITE LED flickers
9	You executes writing when PLC password is not same as that of memory module	WRITE LED flickers

Note

-. Memory module can cancel PLC password and read/write but can’t set, delete and change the password.
-. Do not run PLC while external memory module is connected to.
-. Do not remove memory module while READ/WRITE LED is on.

Chapter 13 Installation and Wiring

13.1 Safety Instruction

⚠ Danger

- Please design protection circuit at the external of PLC for entire system to operate safely because an abnormal output or an malfunction may cause accident when any error of external power or malfunction of PLC module.
  (1) It should be installed at the external side of PLC to emergency stop circuit, protection circuit, interlock circuit of opposition action such as forward /reverse operation and interlock circuit for protecting machine damage such as upper/lower limit of positioning.
  (2) If PLC detects the following error, all operation stops and all output is off.
  (Available to hold output according to parameter setting)
  (a) When over current protection equipment or over voltage protection operates
  (b) When self diagnosis function error such as WDT error in PLC CPU occurs
- In case of error about IO control part that is not detected by PLC CPU, all output is off.
  Design Fail Safe circuit at the external of PLC for machine to operate safely. Refer to 10.2 Fail Safe circuit.
  (1) Because of error of output device, Relay, TR, etc., output may not be normal. About output signal that may cause the heavy accident, design supervisory circuit to external.
- In case load current more than rating or over current by load short flows continuously, danger of heat, fire may occur so design safety circuit to external such as fuse.
- Design for external power supply to be done first after PLC power supply is done. If external power supply is done first, it may cause accident by misoutput, misoperation.
- In case communication error occurs, for operation status of each station, refer to each communication manual.
- In case of controlling the PLC while peripheral is connected to CPU module, configure the interlock circuit for system to operate safely. During operation, in case of executing program change, operation status change, familiarize the manual and check the safety status. Especially, in case of controlling long distance PLC, user may not response to error of PLC promptly because of communication error or etc.
  Limit how to take action in case of data communication error between PLC CPU and external device adding installing interlock circuit at the PLC program.

º

⚠ Danger

- Don't close the control line or communication cable to main circuit or power line. Distance should be more than 100mm. It may cause malfunction by noise.

- In case of controlling lamp load, heater, solenoid valve, etc. in case of Off -> On, large current (10 times of normal current) may flows, so consider changing the module to module that has margin at rated current.

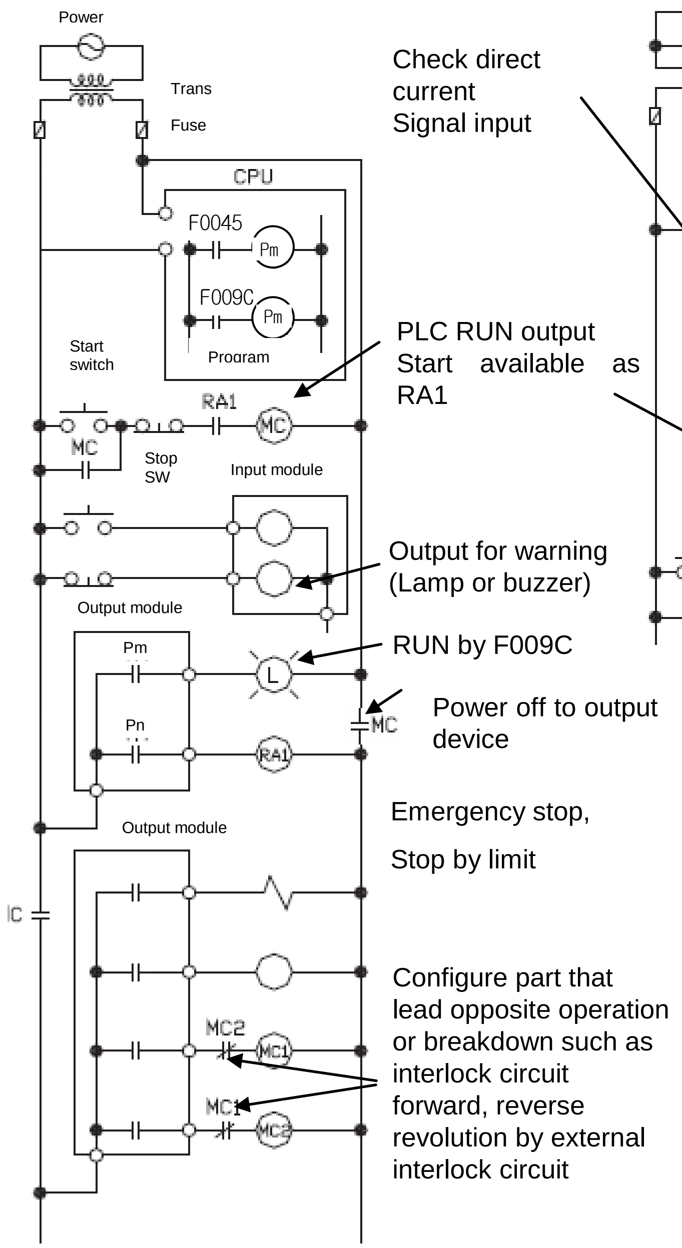
- Process output may not work properly according to difference of delay of PLC main power and external power for process (especially DC in case of PLC power On-Off and of start time.
  For example, in case of turning on PLC main power after supplying external power for process, DC output module may malfunction when PLC is on, so configure the circuit to turn on the PLC main power first
  Or in case of external power error or PLC error, it may cause the malfunction.

- Not to lead above error to entire system, part causing breakdown of machine or accident should be configured at the external of PLC

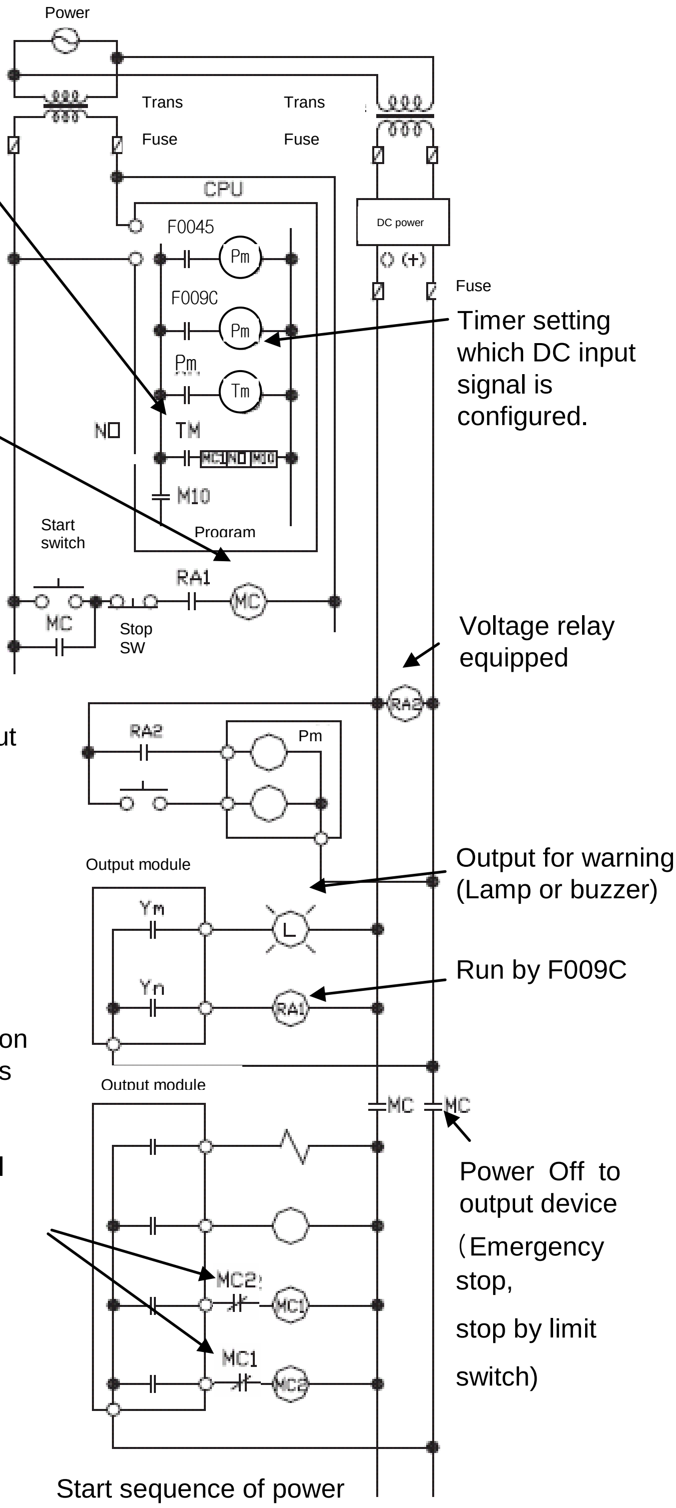
13.1.1 Fail safe circuit

(1) example of system design (In case of not using ERR contact point of power module)

In case of AC



In case of AC . DC



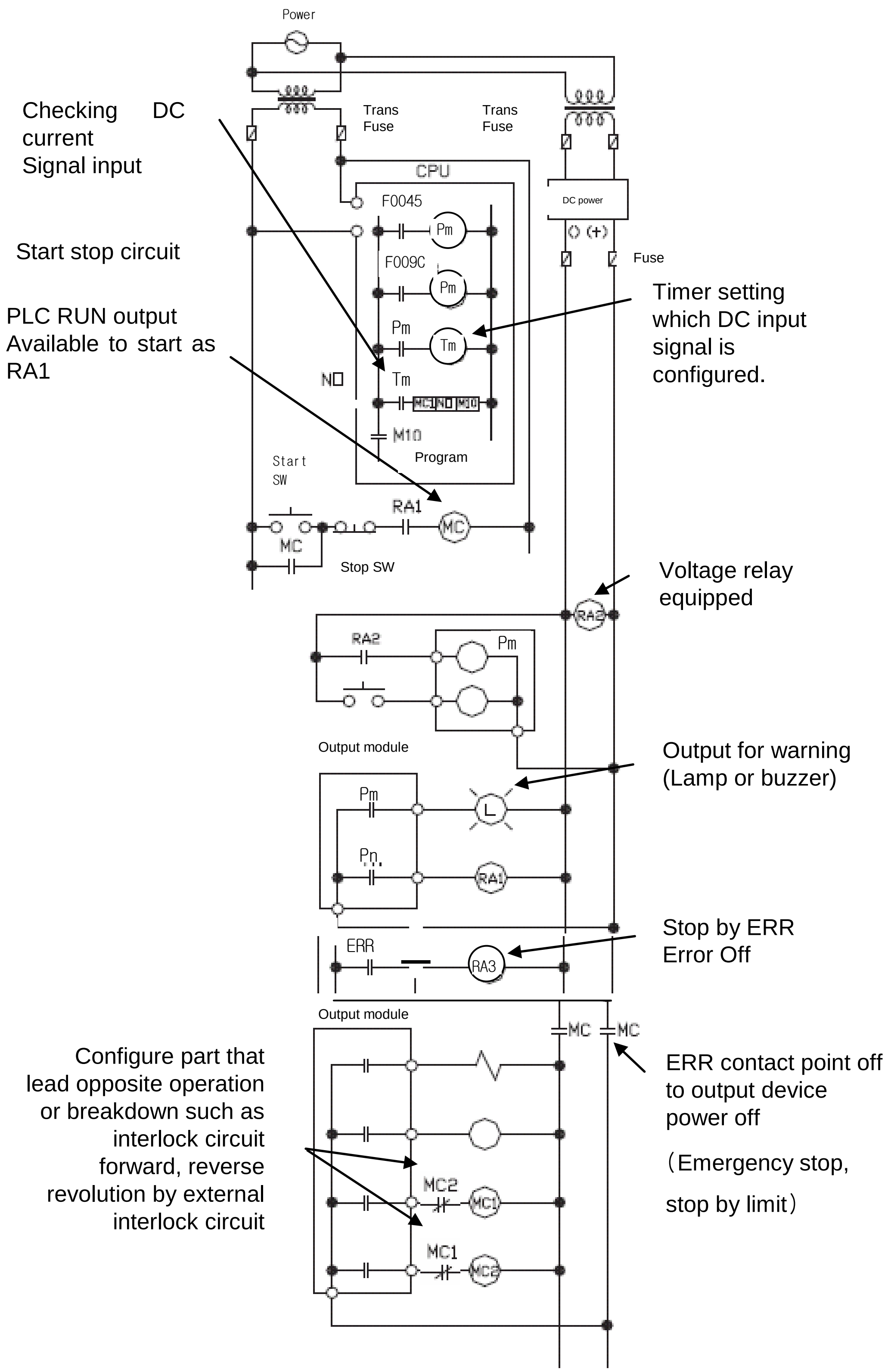
Start sequence of power
In case of AC

(1) Turn on power
(2) Run CPU.
(3) Turn on start switch
(4) Output device runs by program through magnetic contactor (MC) [On]

Start sequence of power
In case of AC DC

(1) Run CPU after power is on
(2) Turn on RA2 as DC power on
(3) Turn on timer after DC power is stable.
(4) Turn on start switch
(5) Output device runs by program through magnetic contactor (MC) [On]

(2) System design circuit example (In case of using ERR contact point of power module)



Start sequence of power
In case of AC DC

(1) Run CPU after turning on power.
(2) Turn on RA2 with DC power supplied
(3) Turn on timer after DC power is stable
(4) Turn on start s/w
(5) Turn on start switch Output device runs by program through magnetic contactor (MC) [On]

(3) Fail safe countermeasure in case of PLC error

Error of PLC CPU and memory is detected by self diagnosis but in case error occurs in IO control part, etc., CPU can detect the error. At this case, though it is different according to status of error, all contact point is on or off, so safety may not be guaranteed. Though we do out best to our quality as producer, configure safety circuit preparing that error occurs in PLC and it lead to breakdown or accident.

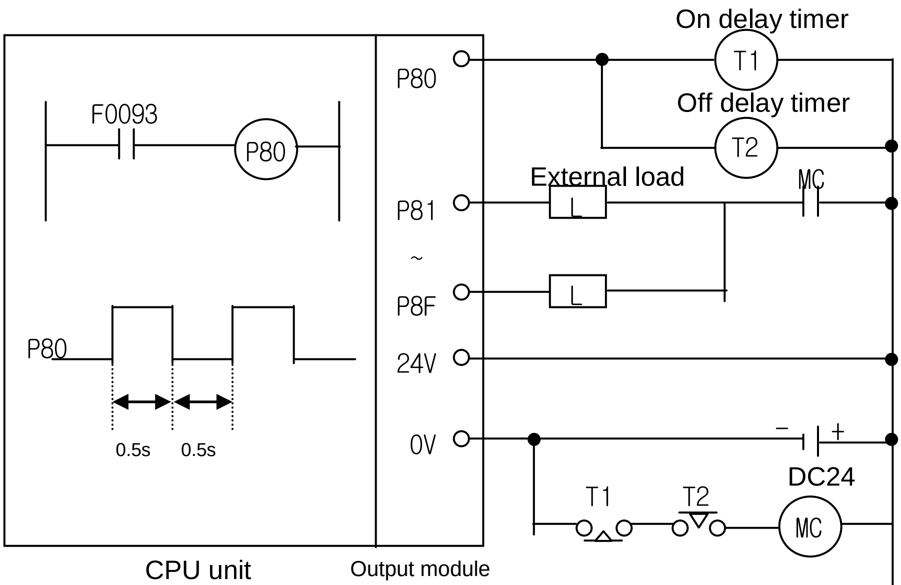
System example

Main unit	Input 16 point	Input 16 point	Input 16 point	Input 16 point	Output 16 point	Output 16 point

Output module for fail safe

Equip output module for fail safe to last slot of system.

[Fail safe circuit example]



Since P80 turn on/off every 0.5s, use TR output.

13.1.2 PLC heat calculation

(1) Power consumption of each part

(a) Power consumption of module

The power conversion efficiency of power module is about 70% and the other 30% is gone with heat; 3/7 of the output power is the pure power consumption. Therefore, the calculation is as follows.

- $W_{pw} = 3/7 \{(I_{5V} \times 5) + (I_{24V} \times 24)\}$ (W)

I_{5V} : power consumption of each module DC5V circuit(internal current consumption)

I_{24V}: the average current consumption of DC24V used for output module (current consumption of simultaneous On point)

If DC24V is externally supplied or a power module without DC24V is used, it is not applicable.

(b) Sum of DC5V circuit current consumption

The DC5V output circuit power of the power module is the sum of power consumption used by each module.

- $W_{5V} = I_{5V} \times 5$ (W)

(c) DC24V average power consumption(power consumption of simultaneous On point)

The DC24V output circuit's average power of the power module is the sum of power consumption used by each module.

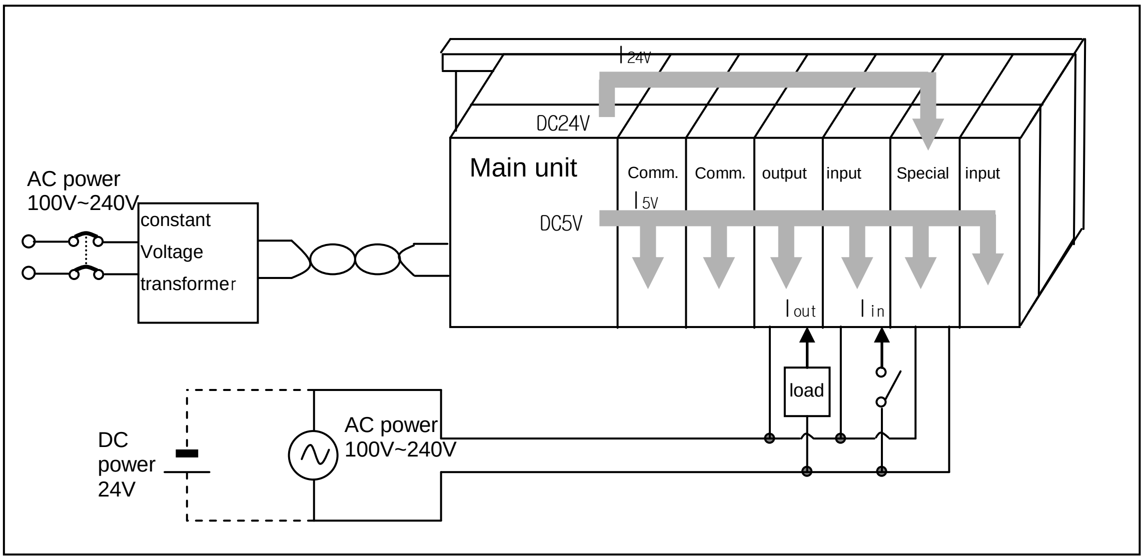
- $W_{24V} = I_{24V} \times 24$ (W)

(d) Average power consumption by output voltage drop of the output module(power consumption of simultaneous On point)

- $W_{out} = I_{out} \times V_{drop} \times$ output point X simultaneous On rate (W)

I_{out} : output current (actually used current) (A)

V_{drop}: voltage drop of each output module (V)



(e) Input average power consumption of input module
(power consumption of simultaneous On point)
• $W_{in} = I_{in}$ X E X input point X simultaneous On rate (W)
I_{in}: input current (root mean square value in case of AC) (A)
E : input voltage (actually used voltage) (V)

(f) Power consumption of special module power assembly
• $W_S = I_{5V}$ X 5 + I_{24V} X 24 + I_{100V} X 100 (W)
The sum of power consumption calculated by each block is the power consumption of the entire PLC system.
• $W = W_{PW} + W_{5V} + W_{24V} + W_{out} + W_{in} + W_s$ (W)
Calculate the heats according to the entire power consumption(W) and review the temperature increase within the control panel.

The calculation of temperature rise within the control panel is displayed as follows.
T = W / UA [°C]
W : power consumption of the entire PLC system (the above calculated value)
A : surface area of control panel [m^2]
U : if equalizing the temperature of the control panel by using a fan and others - - - 6
If the air inside the panel is not ventilated - - - - - - - - - - 4

If installing the PLC in an air-tight control panel, it needs heat-protective(control) design considering the heat from the PLC as well as other devices. If ventilating by vent or fan, inflow of dust or gas may affect the performance of the PLC system.

13.2 Attachment/Detachment of Modules

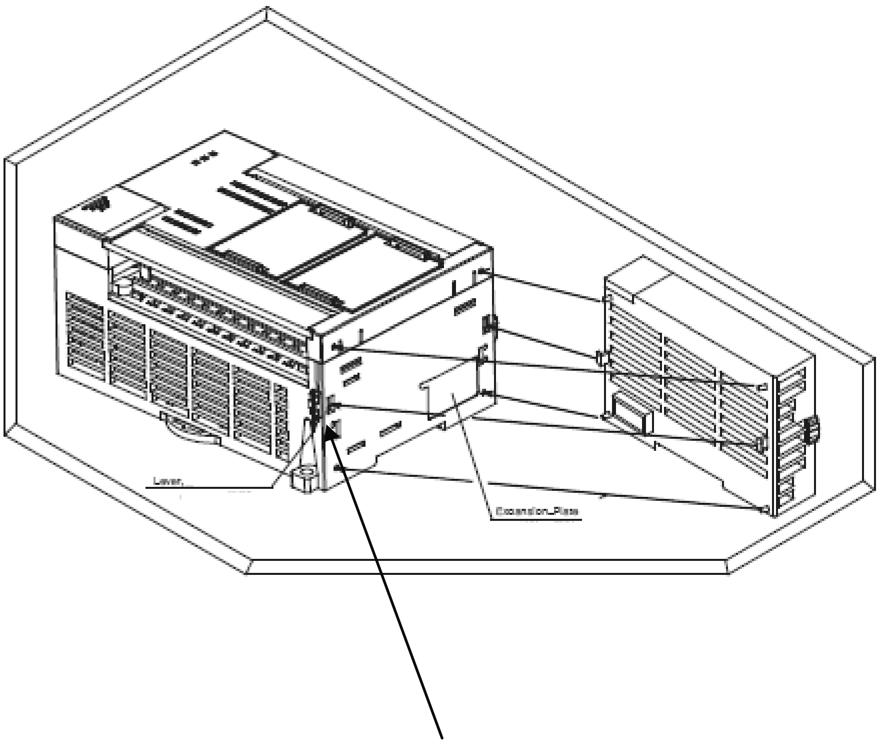
13.2.1 Attachment/Detachment of modules

Caution in handling
Use PLC in the range of general specification specified by manual.
In case of using out of range, it may cause electric shock, fire, malfunction, damage of product.

⚠ Warning
▸ Module must be mounted to hook for fixation properly before its fixation. The module may be damaged from over-applied force. If module is not mounted properly, it may cause malfunction. ▸ Do not drop or impact the module case, terminal block connector. ▸ Do not separate the PCB from case.

(1) Equipment of module

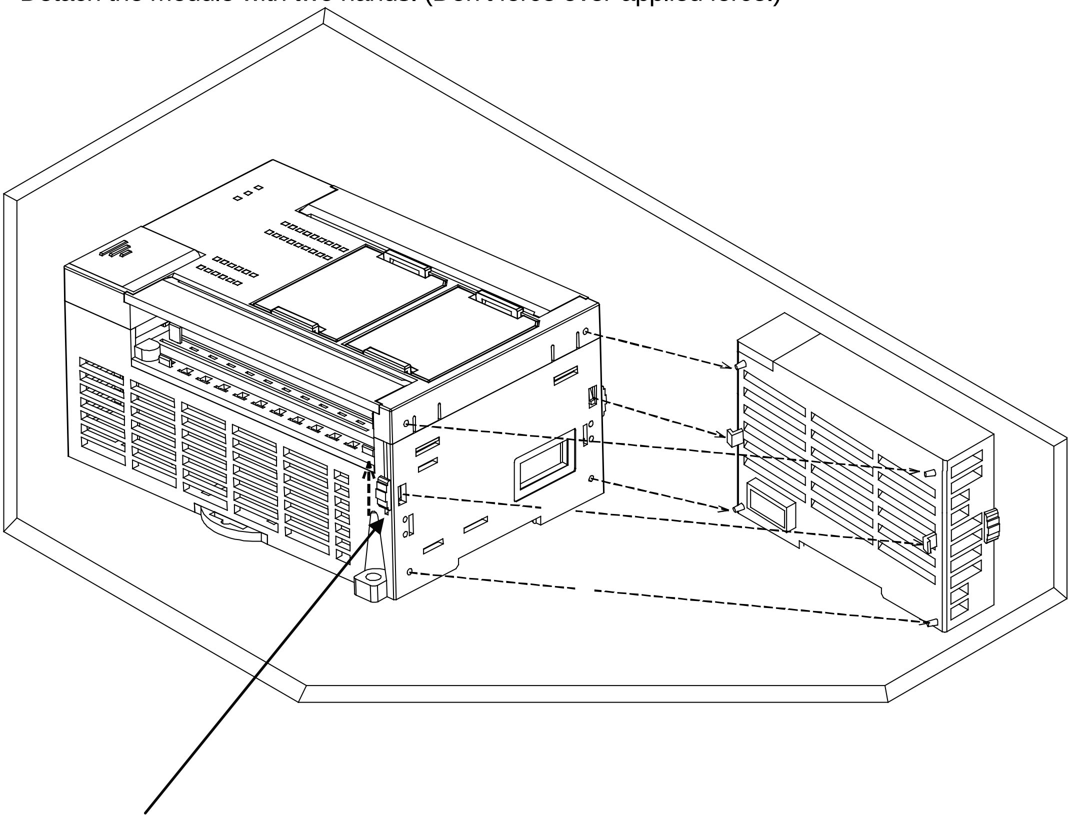
- Eliminate the extension cover at the upper of module.
- Push the module and connect it in agreement with hook for fixation of four edges and hook for connection at the bottom.
- After connection, get down the hook for fixation at the upper part and lower part and fix it completely.



Module fixation (Hook)

(2) Detachment of module

- Get up the hook for fixation of upper part and lower part and disconnect it.
- Detach the module with two hands. (Don’t force over-applied force.)

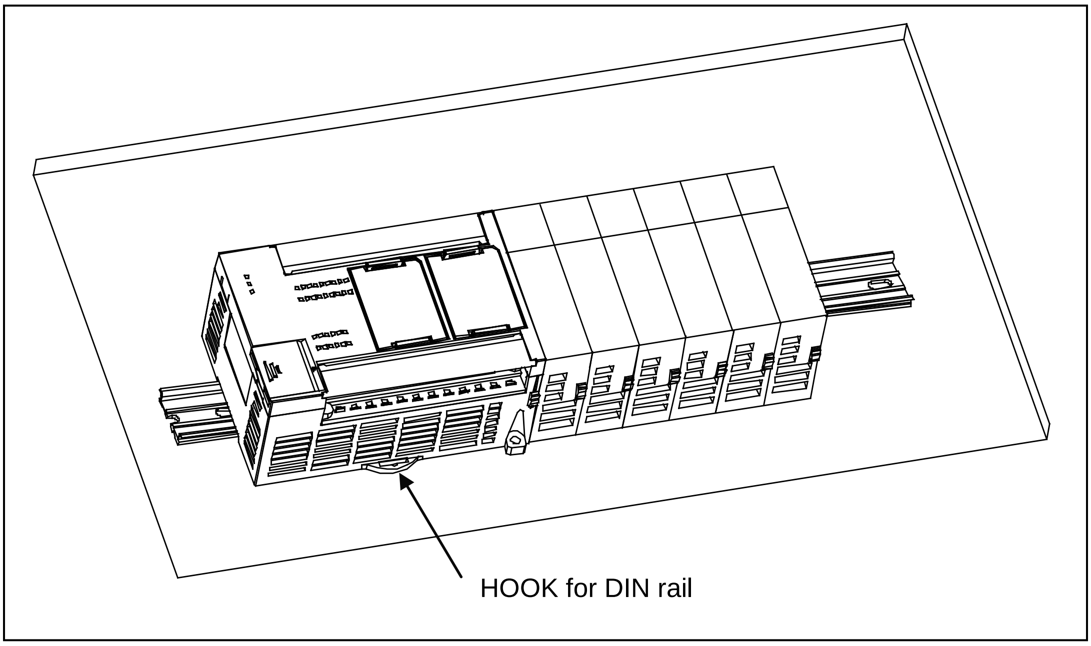


Hook for module fixation

⚠ Caution
▸ When separating module, don’t force over-applied power. If so, hook may be damaged.

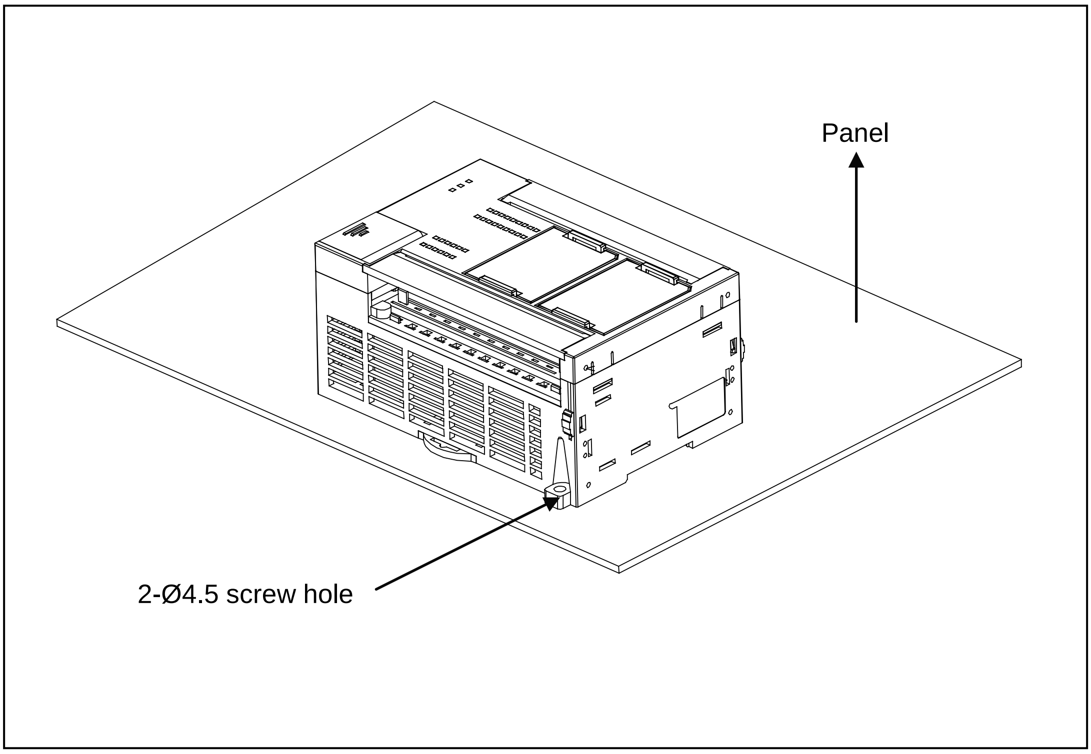
(3) Installation of module
XGB PLC is having hook for DIN rail (rail width: 35mm) so that cab be installed at DIN rail.

(a) In case of installing at DIN rail
- Pull hook for DIN rail at the bottom of module and install it at DIN rail
- Push hook to fix the module at DIN rail after installing module at DIN rail



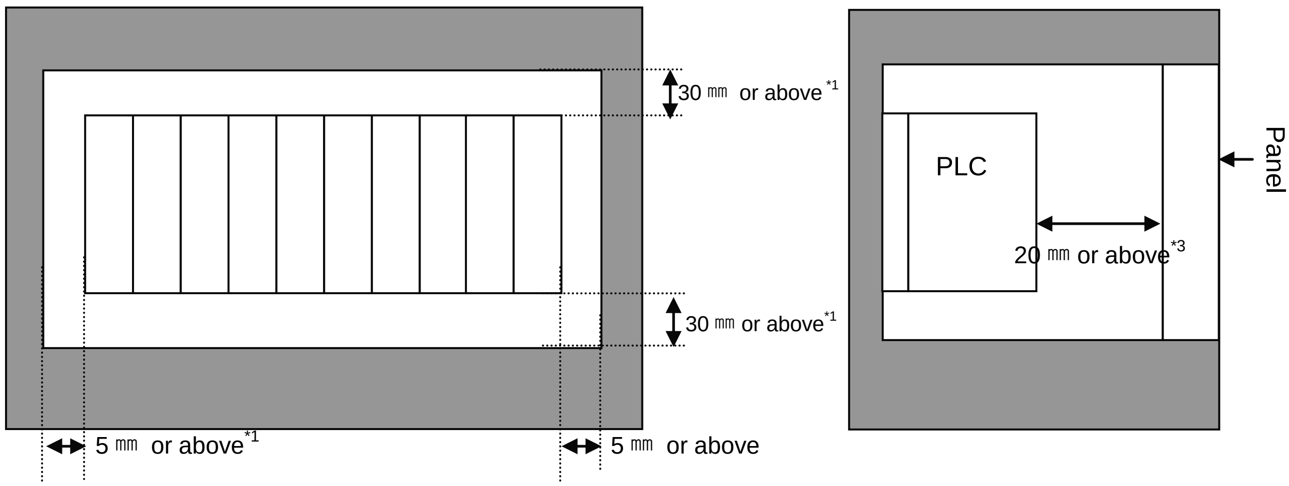
(b) In case of installing at panel

- You can install XGB compact type main unit at panel directly using screw hole
- Use M4 type screw to install the product at panel.



(4) Module equipment location

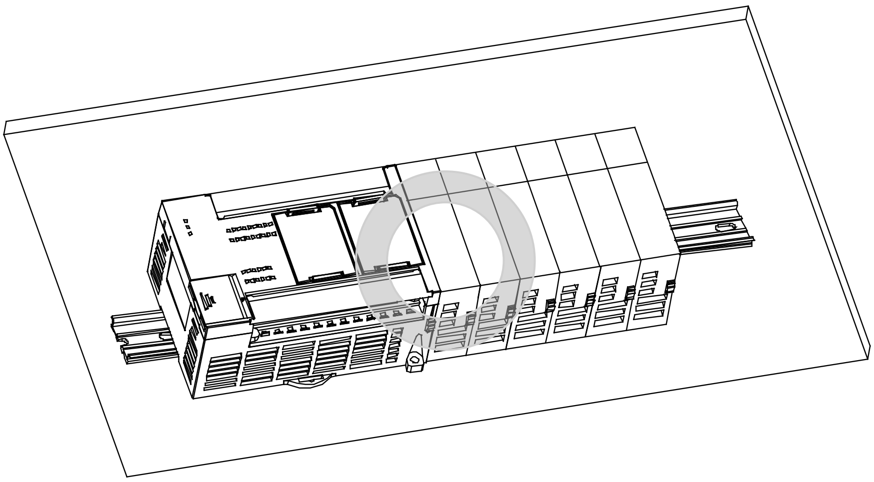
Keep the following distance between module and structure or part for well ventilation and easy detachment and attachment.



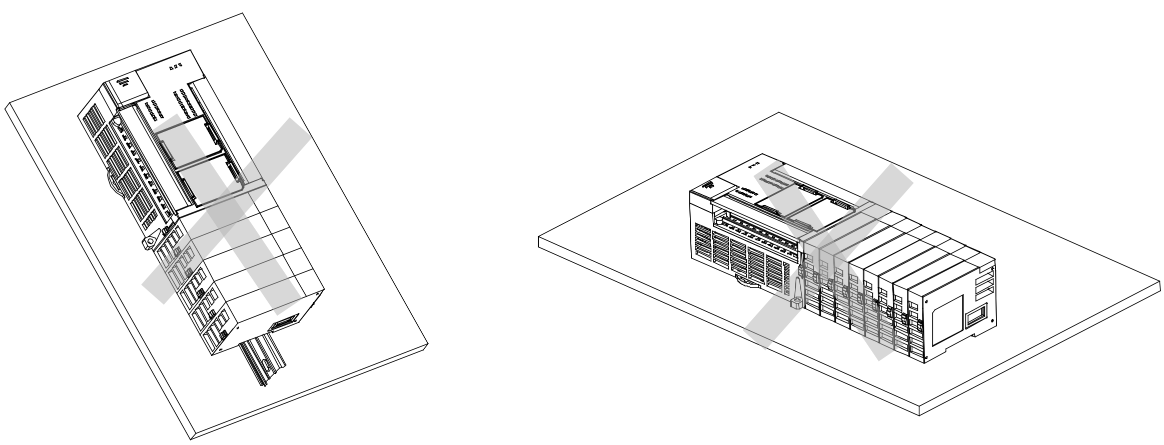
*1 : In case height of wiring duct is less than 50 mm (except this 40mm or above)
*2 : In case of equipping cable without removing near module, 20mm or above
*3 : In case of connector type, 80mm or above

(5) Module equipment direction

(a) For easy ventilation, install like the following figure.

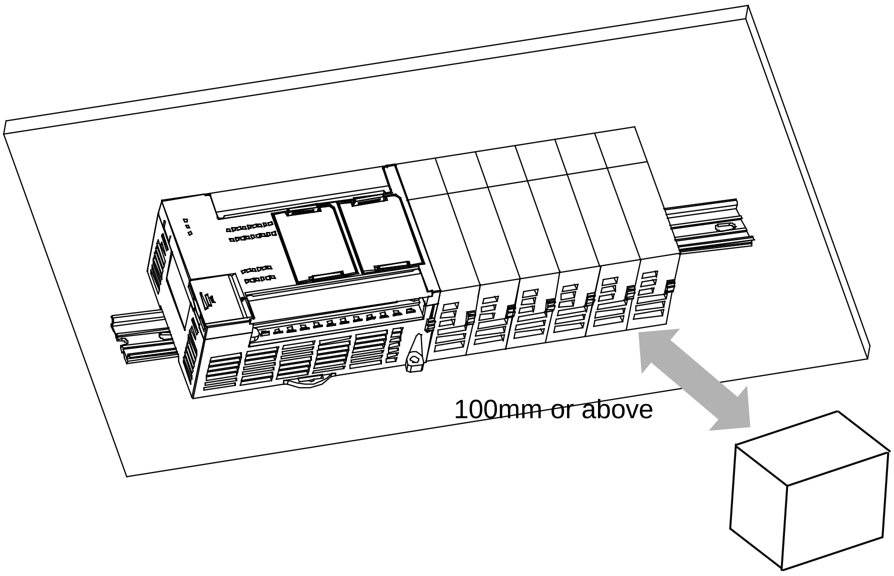


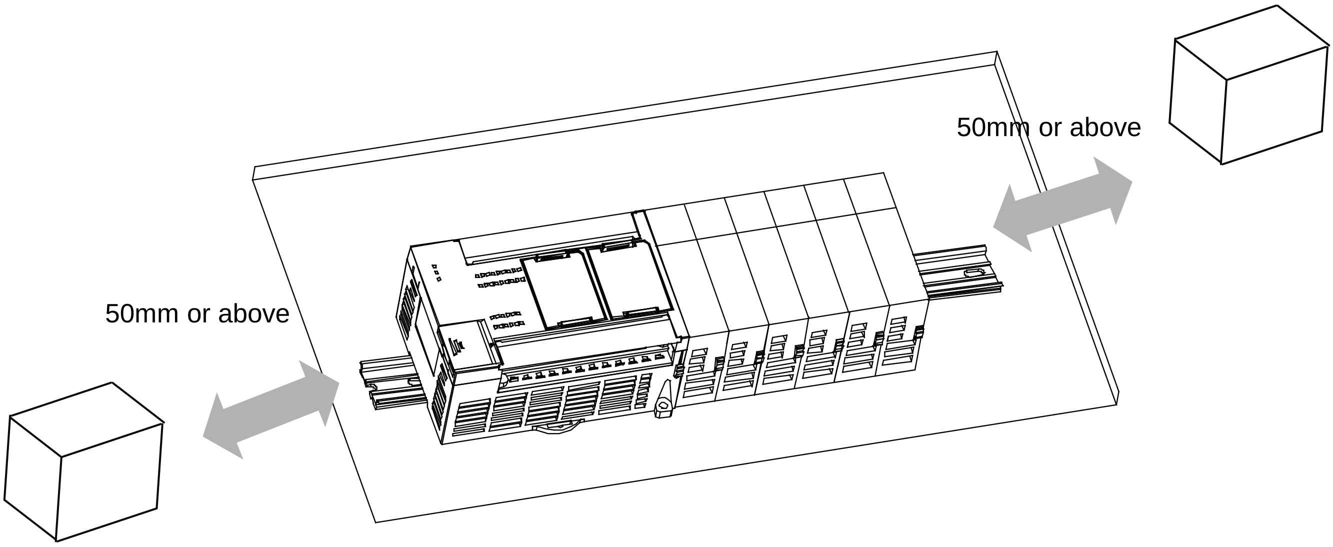
(b) Don’t install like the following figure



(6) Distance with other device

To avoid radiation noise or heat, keep the distance between PLC and device (connector and relay) as far as the following figure.
Device installed in front of PLC: 100 ㎜ or above
Device installed beside PLC: 50 ㎜ or above





13.2.2 Caution in handling

Here describes caution from open to install

- Don't drop or impact product.
- Don't disassemble the PCB from case. It may cause the error.
- In case of wiring, make sure foreign substance not to enter upper part of module. If it enters, eliminate it.

(1) Caution in handling IO module
It describes caution in handling IO module.

(a) Recheck of IO module specification
For input module, be cautious about input voltage, for output module, if voltage that exceeds the max. open/close voltage is induced, it may cause the malfunction, breakdown or fire.

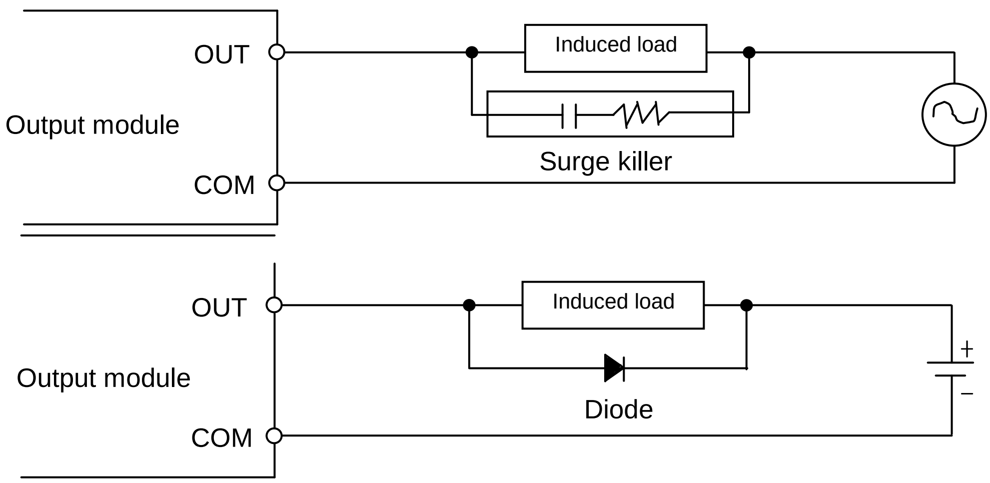
(b) Used wire
When selecting wire, consider ambient temp, allowed current and minimum size of wire is AWG22(0.3mm^2) or above.

(c) Environment
In case of wiring IO module, if device or material that induce high heat is too close or oil contacts wire too long time, it may cause short, malfunction or error.

(d) Polarity
Before supplying power of module which has terminal block, check the polarity.

(e) Wiring

- In case of wiring IO with high voltage line or power line, induced obstacle may cause error.
- Let no cable pass the IO operation indication part (LED).
  (You can't discriminate the IO indication.)
- In case induced load is connected with output module, connect the surge killer or diode load to load in parallel. Connect cathode of diode to + side of power.



(f) Terminal block
Check close adhesion status. Let no foreign material of wire enter into PLC when wring terminal block or processing screw hole. At this case, it may cause malfunction.

(g) Don't impact to IO module or don't disassemble the PCB from case.

13.3 Wire

In case using system, it describes caution about wiring.

⚠ Danger

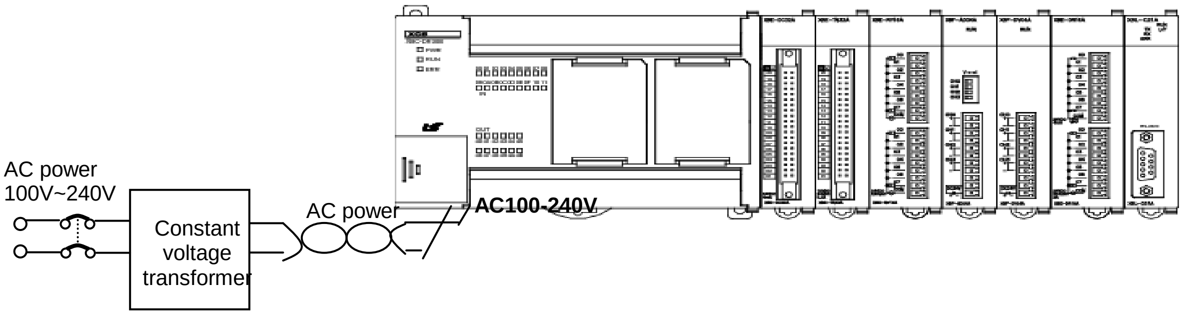
▸ When wiring, cut off the external power.
▸ If all power is cut, it may cause electric shock or damage of product.
▸ In case of flowing electric or testing after wiring, equip terminal cover included in product. It not, it may cause electric shock.

⚠ Caution

▸ Do D type ground (type 3 ground) or above dedicated for PLC for FG and LG terminal. It may cause electric shock or malfunction.
▸ When wiring module, check the rated voltage and terminal array and do properly.
If rating is different, it may cause fire, malfunction.
▸ For external connecting connector, use designated device and solder.
If connecting is not safe, it may cause short, fire, malfunction.
▸ For screwing, use designated torque range. If it is not fit, it may cause short, fire, malfunction.
▸ Let no foreign material enter such as garbage or disconnection part into module. It may cause fire, malfunction, error.

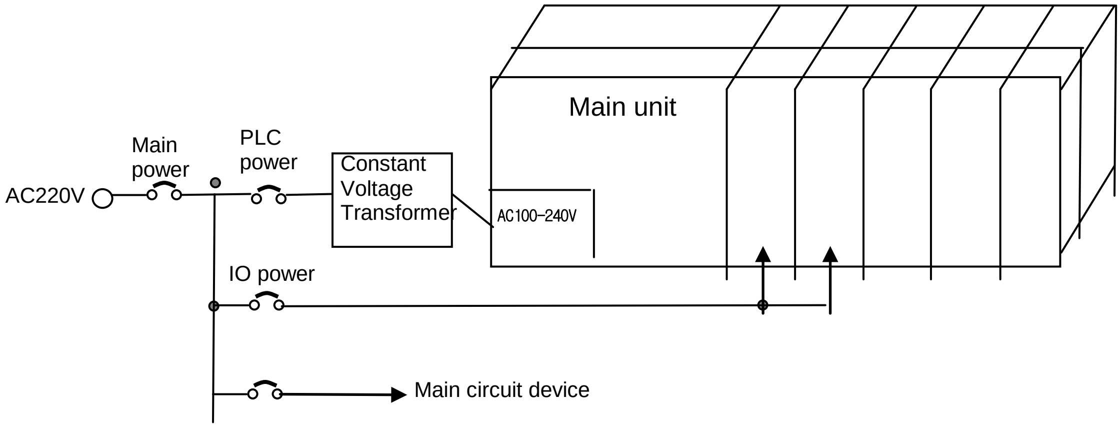
13.3.1Power wiring

(1) In case voltage regulation is larger than specified, connect constant voltage transformer.



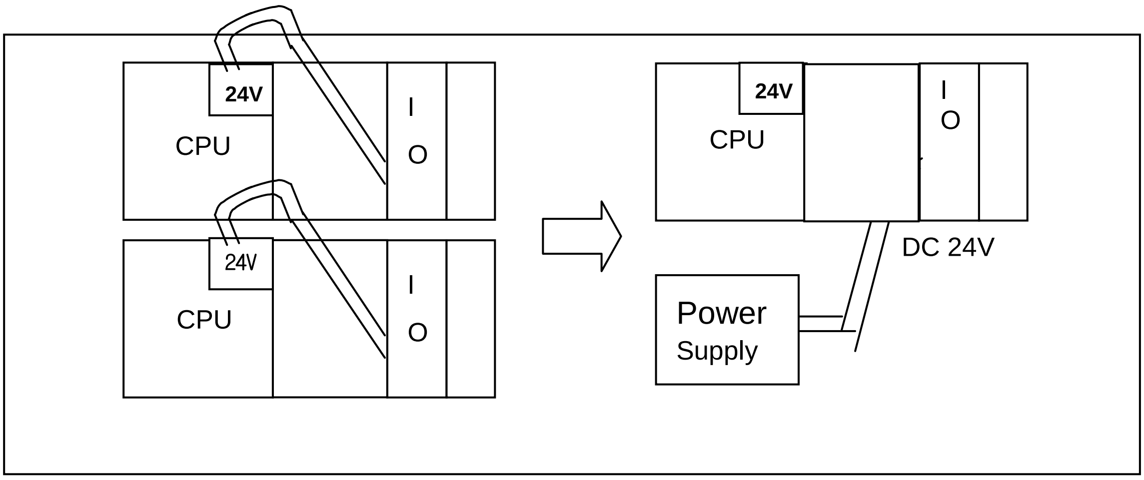
(2) Connect noise that include small noise between line and earth.
(When there are many noise, connect insulated transformer.)

(3) Isolate the PLC power, I/O devices and power devices as follows.



(4) If using DC24V of the main unit

(a) Do not connect DC24V of several power modules in parallel. It may cause the destruction of a module.
(b) If a power module can not meet the DC24V output capacity, supply DC24V externally as presented below.

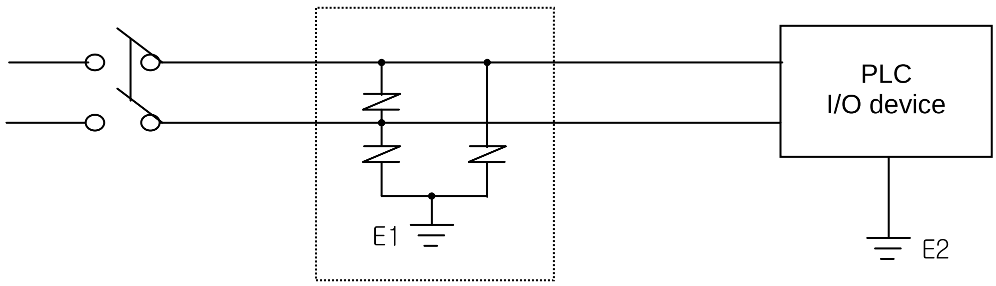


(5) AC110V/AC220V/DC24V cables should be compactly twisted and connected in the shortest distance.

(6) AC110V/AC220V cable should be as thick as possible($2mm^2$) to reduce voltage drop.

(7) AC110V/ DC24V cables should not be installed close to main circuit cable(high voltage/high current) and I/O signal cable. They should be 100mm away from such cables

(8) To prevent surge from lightning, use the lightning surge absorber as presented below.



Surge absorber to prevent

Note

(1) Isolate the grounding(E1) of lightning surge absorber from the grounding(E2) of the PLC.
(2) Select a lightning surge absorber type so that the max. voltage may not the specified allowable voltage of the absorber.

(9) When noise may be intruded inside it, use an insulated shielding transformer or noise filter.

(10) Wiring of each input power should be twisted as short as possible and the wiring of shielding transformer or noise filter should not be arranged via a duct.

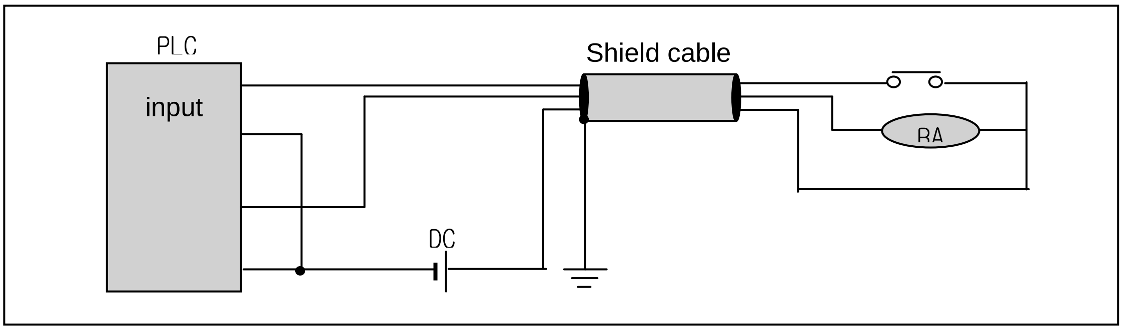
13.3.2 I/O Device wiring

(1) The size of I/O device cable is limited to 0.3~2 mm^2 but it is recommended to select a size(0.3 mm^2) to use conveniently.

(2) Please isolate input signal line from output signal line.

(3) I/O signal lines should be wired 100mm and more away from high voltage/high current main circuit cable.

(4) Batch shield cable should be used and the PLC side should be grounded unless the main circuit cable and power cable can not be isolated.



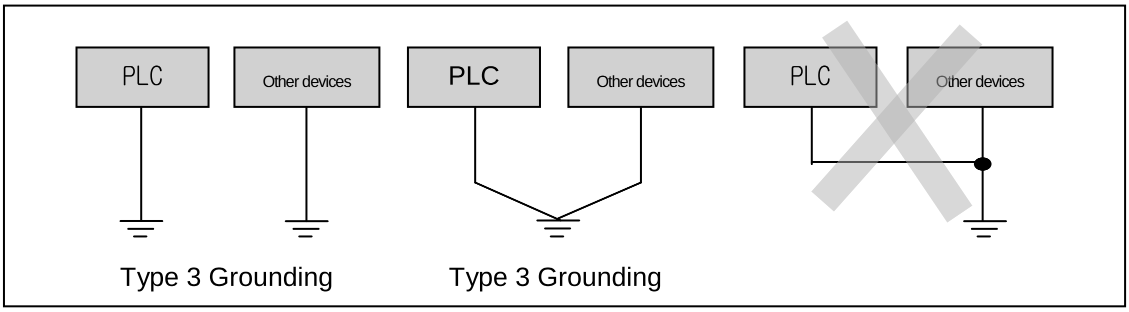
(5) When applying pipe-wiring, make sure to firmly ground the piping.

13.3.3 Grounding wiring

(1) The PLC contains a proper noise measure, so it can be used without any separate grounding if there is a large noise. However, if grounding is required, please refer to the followings.

(2) For grounding, please make sure to use the exclusive grounding.
For grounding construction, apply type 3 grounding(grounding resistance lower than 100 Ω)

(3) If the exclusive grounding is not possible, use the common grounding as presented in B) of the figure below.



A) Exclusive grounding : best B) common grounding : good C) common grounding: defective

(4) Use the grounding cable more than 2 mm^2. To shorten the length of the grounding cable, place the grounding point as close to the PLC as possible.

(5) If any malfunction from grounding is detected, separate the FG of the base from the grounding.

13.3.4 Specifications of wiring cable

The specifications of cable used for wiring are as follows.

Types of external connection	Cable specification (mm^2)	
	Lower limit	Upper limit
Digital input	0.18 (AWG24)	1.5 (AWG16)
Digital output	0.18 (AWG24)	2.0 (AWG14)
Analogue I/O	0.18 (AWG24)	1.5 (AWG16)
Communication	0.18 (AWG24)	1.5 (AWG16)
Main power	1.5 (AWG16)	2.5 (AWG12)
Protective grounding	1.5 (AWG16)	2.5 (AWG12)

Chapter 14 Maintenance

Be sure to perform daily and periodic maintenance and inspection in order to maintain the PLC in the best conditions.

14.1 Maintenance and Inspection

The I/O module mainly consist of semiconductor devices and its service life is semi-permanent. However, periodic inspection is requested for ambient environment may cause damage to the devices. When inspecting one or two times per six months, check the following items.

Check Items		Judgment	Corrective Actions
Change rate of input voltage		Within change rate of input voltage (Less than –15% to +20%)	Hold it with the allowable range.
Power supply for input/output		Input/Output specification of each module	Hold it with the allowable range of each module.
Ambient environment	Temperature	0 ~ + 55℃	Adjust the operating temperature and humidity with the defined range.
	Humidity	5 ~ 95%RH	
	Vibration	No vibration	Use vibration resisting rubber or the vibration prevention method.
Play of modules		No play allowed	Securely enrage the hook.
Connecting conditions of terminal screws		No loose allowed	Retighten terminal screws.
Spare parts		Check the number of Spare parts and their Store conditions	Cover the shortage and improve the conditions.

14.2 Daily Inspection

The following table shows the inspection and items which are to be checked daily.

Check Items		Check Points	Judgment	Corrective Actions
Connection conditions of base		Check the screws.	Screws should not be loose.	Retighten Screws.
Connection conditions of Input/Output module		Check the connecting screws Check module cover.	Screws should not be loose.	Retighten Screws.
Connecting conditions of terminal block or extension cable		Check for loose mounting screws.	Screws should not be loose.	Retighten Screws.
		Check the distance between solderless terminals.	Proper clearance should be provided.	Correct.
		Connecting of expansion cable.	Connector should not be loose.	Correct.
LED indicator	PWR LED	Check that the LED is On.	On(Off indicates an error)	See chapter 4.
	Run LED	Check that the LED is On during Run.	On (flickering or On indicates an error)	See chapter 4.
	ERR LED	Check that the LED is Off during Run.	Flickering indicates an error	See chapter 4.
	Input LED	Check that the LED turns On and Off.	On when input is On, Off when input is off.	See chapter 4.
	Output LED	Check that the LED turns On and Off	On when output is On, Off when output is off	See chapter 4.

14.3 Periodic Inspection

Check the following items once or twice every six months, and perform the needed corrective actions.

Check Items		Checking Methods	Judgment	Corrective Actions
Ambient environment	Ambient temperature	-. Measure with thermometer and hygrometer -. measure corrosive gas	0 ~ 55 °C	Adjust to general standard (Internal environmental standard of control section)
	Ambient Humidity		5 ~ 95%RH	
	Ambient pollution level		There should be no corrosive gases	
PLC Conditions	Looseness, Ingress	The module should be move the unit	The module should be mounted securely.	Retighten screws
	dust or foreign material	Visual check	No dust or foreign material	
Connecting conditions	Loose terminal screws	Re-tighten screws	Screws should not be loose	Retighten
	Distance between terminals	Visual check	Proper clearance	Correct
	Loose connectors	Visual check	Connectors should not be loose.	Retighten connector mounting screws
Line voltage check		Measure voltage between input terminals	DC24V: DC20.4 ~ 28.8V	Change supply power

Chapter 15 Troubleshooting

The following explains contents, diagnosis and corrective actions for various errors that can occur during system operation.

15.1 Basic Procedure of Troubleshooting

System reliability not only depends on reliable equipment but also on short downtimes in the event of fault. The short discovery and corrective action is needed for speedy operation of system. The following shows the basic instructions for troubleshooting.

(1) Visual checks
Check the following points.
- Machine operating condition (in stop and operation status)
- Power On/Off
- Status of I/O devices
- Condition of wiring (I/O wires, extension and communications cables)
- Display states of various indicators (such as POWER LED, RUN LED, ERR LED and I/O LED)

After checking them, connect peripheral devices and check the operation status of the PLC and the program contents.

(2) Trouble Check
Observe any change in the error conditions during the following.
- Switch to the STOP position, and then turn the power on and off.

(3) Narrow down the possible causes of the trouble where the fault lies, i.e.:
- Inside or outside of the PLC ?
- I/O module or another module?
- PLC program?

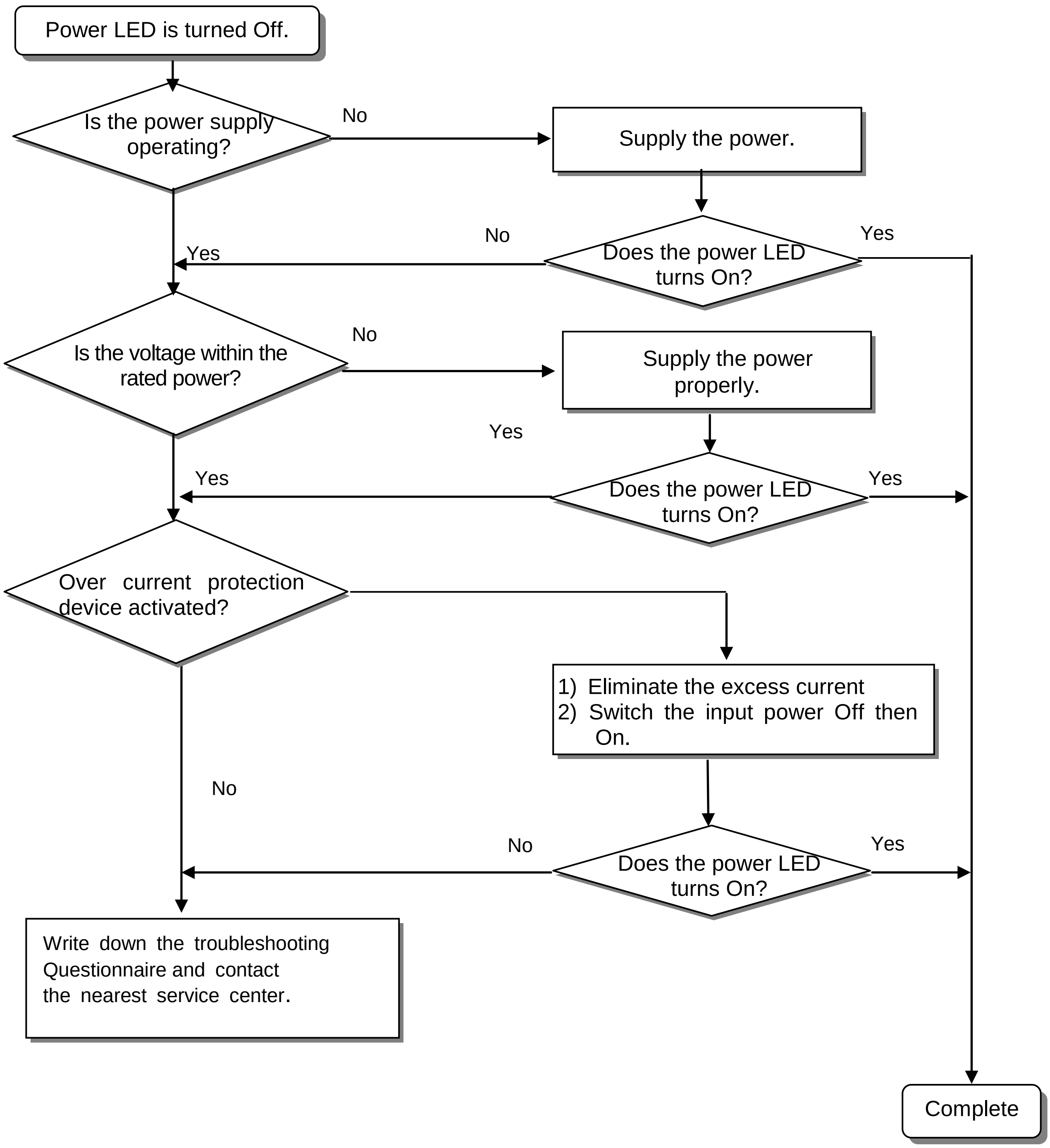
15.2 Troubleshooting

This section explains the procedure for determining the cause of troubles as well as the errors and corrective actions.

Symptoms		
Is the power LED turned Off ?	⇨	Flowchart used when the POWER LED is turned Off.
Is the ERR LED flickering ?	⇨	Flowchart used when the ERR LED is flickering.
Are the RUN LED turned Off ?	⇨	Flowchart used when the RUN turned Off.
I/O module doesn't operate properly.	⇨	Flowchart used when the output load of the output module doesn't turn on.
Program cannot be written.	⇨	Flowchart used when a program can't be written to the PLC.

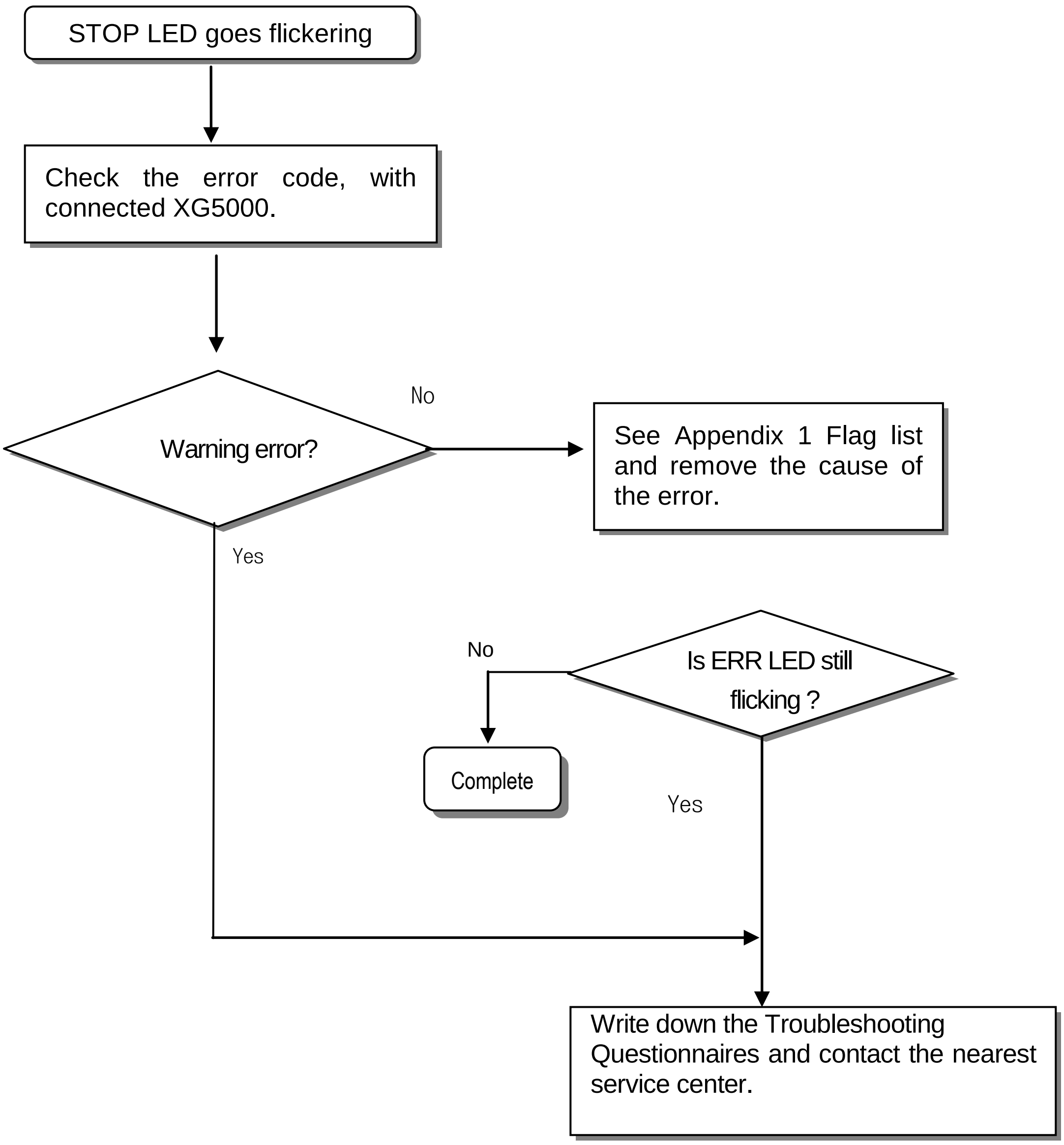
15.2.1 Troubleshooting flowchart used when the PWR (Power) LED turns Off.

The following flowchart explains corrective action procedure used when the power is supplied or the power LED turns Off during operation.



15.2.2 Troubleshooting flowchart used with when the ERR (Error) LED is flickering

The following flowchart explains corrective action procedure use when the power is supplied star ts or the ERR LED is flickering during operation.

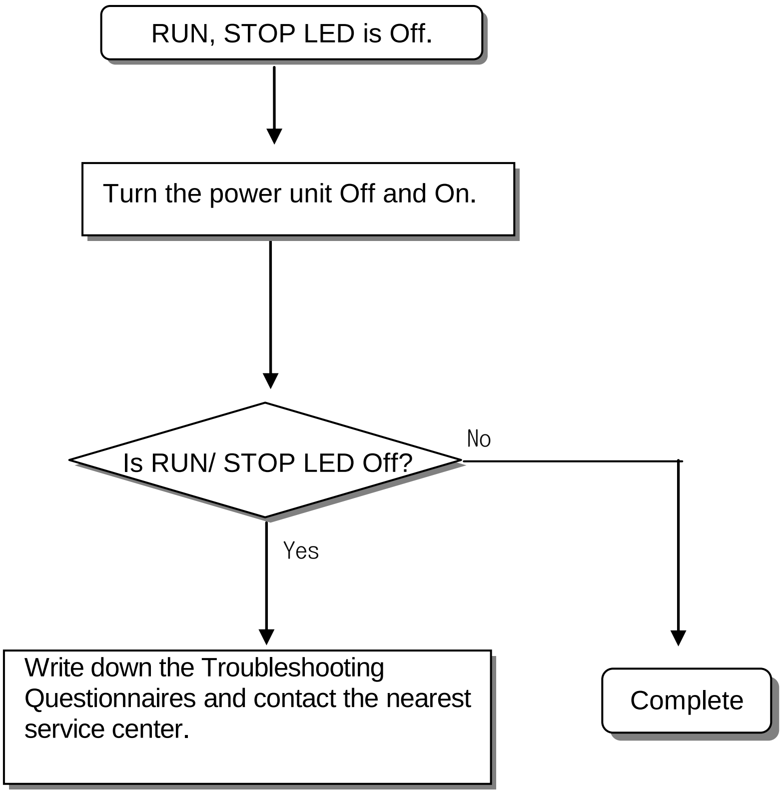


⚠ Warning

Though warning error appears, PLC system doesn't stop but corrective action is needed promptly. If not, it may cause the system failure.

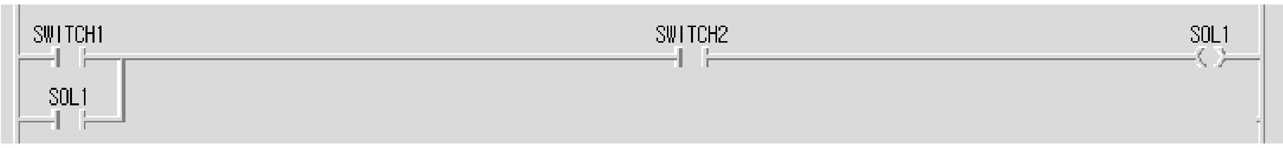
15.2.3 Troubleshooting flowchart used with when the RUN , STOP LED turns Off.

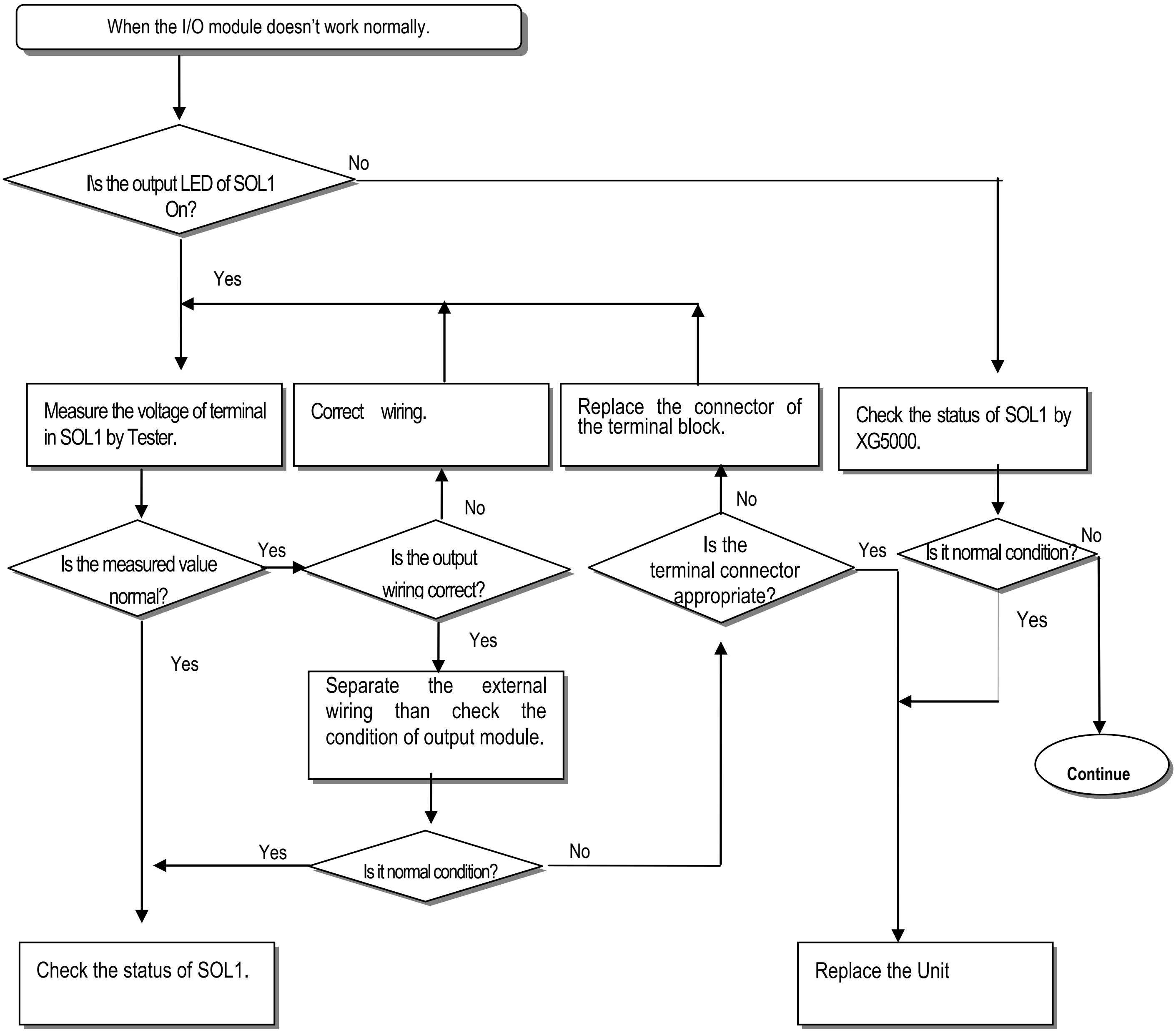
The following flowchart explains corrective action procedure to treat the lights-out of RUN LED when the power is supplied, operation starts or operation is in the process.

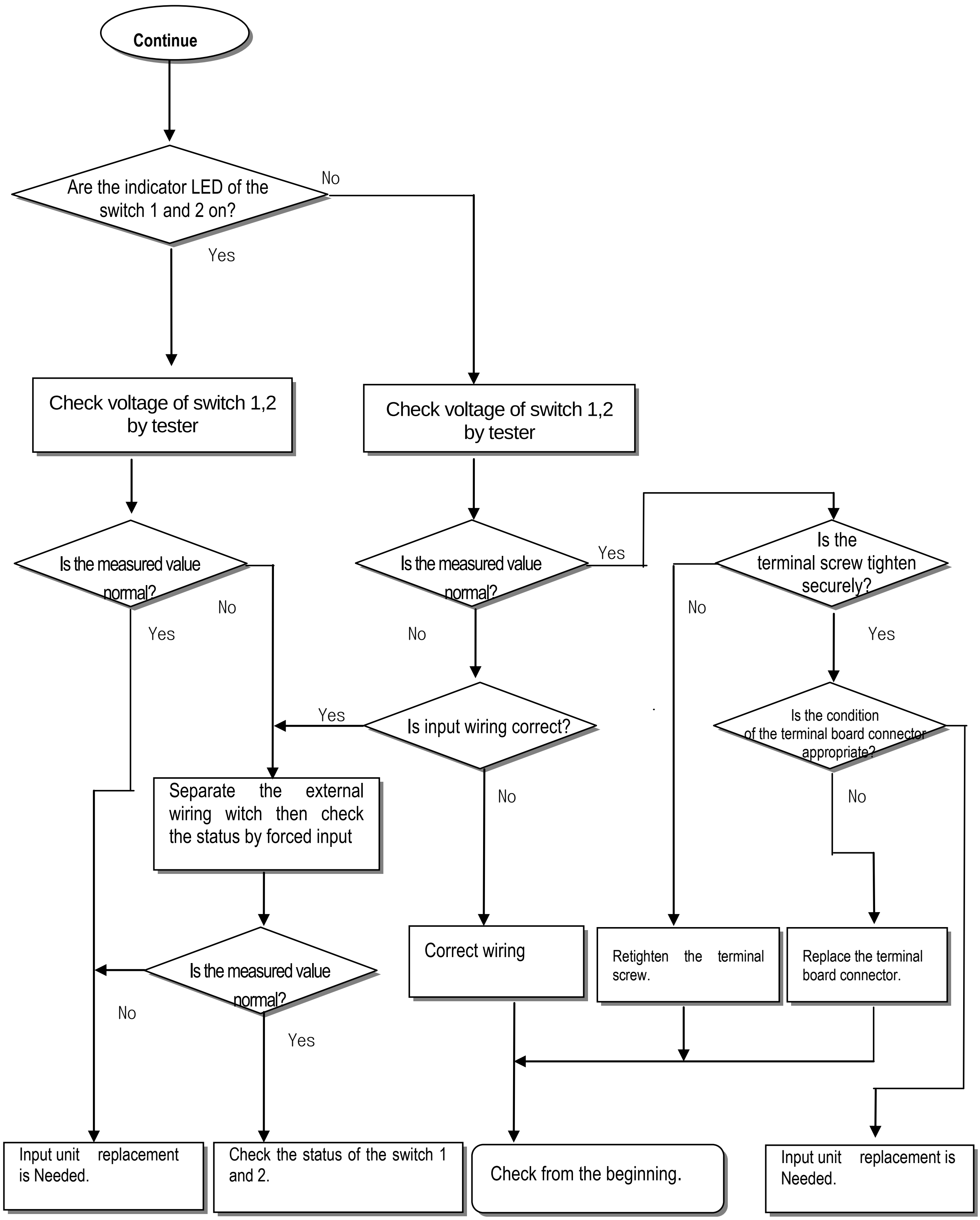


15.2.4 Troubleshooting flowchart used when the I/O part doesn't operate normally.

The following flowchart explains corrective action procedure used when the I/O module doesn't operate normally.






Continue
Are the indicator LED of the switch 1 and 2 on?
No
Yes
Check voltage of switch 1,2 by tester
Check voltage of switch 1,2 by tester
Is the measured value normal?
No
Yes
Is the measured value normal?
Yes
No
Is the terminal screw tighten securely?
No
Yes
Is input wiring correct?
Yes
No
Is the condition of the terminal board connector appropriate?
No
Separate the external wiring witch then check the status by forced input
Is the measured value normal?
No
Yes
Correct wiring
Retighten the terminal screw.
Replace the terminal board connector.
Input unit replacement is Needed.
Check the status of the switch 1 and 2.
Check from the beginning.
Input unit replacement is Needed.

15.3 Troubleshooting Questionnaire

When problems have been met during operation of the XGC series, please write down this Questionnaires and contact the service center via telephone or facsimile.
• For errors relating to special or communication modules, use the questionnaire included in the User's manual of the unit.

1. Telephone & FAX No
   Tell) FAX)
2. Using equipment model:

3. Details of using equipment
   CPU model: ( ) OS version No.:( ) Serial No.( )
   XG5000 (for program compile) version No.: ( )

4.General description of the device or system used as the control object:

5. The kind of the base unit:
– Operation by the mode setting switch ( ),
– Operation by the XG5000 or communications ( ),
– External memory module operation ( ),

6. Is the ERR. LED of the CPU module turned On ? Yes( ), No( )

7. XG5000 error message:

8. History of corrective actions for the error message in the article 7:

9. Other tried corrective actions:

10. Characteristics of the error
• Repetitive( ): Periodic( ), Related to a particular sequence( ), Related to environment( )
• Sometimes( ): General error interval:

11. Detailed Description of error contents:

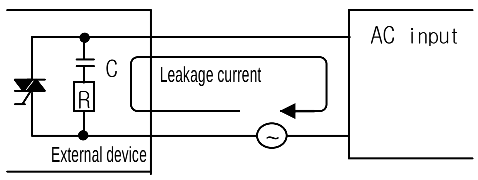
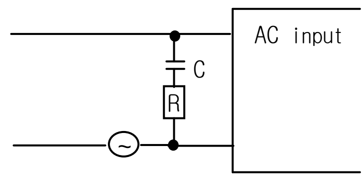
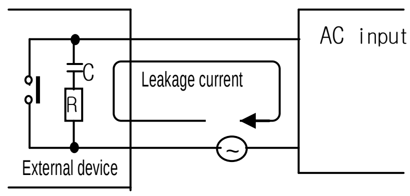
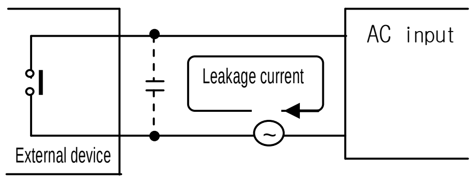
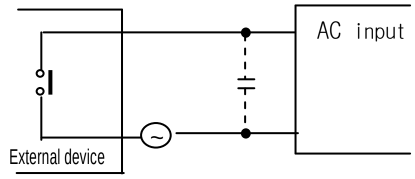
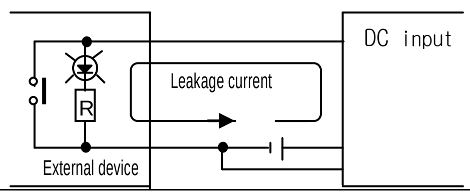
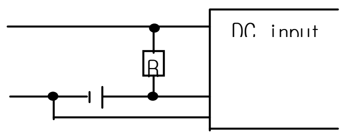
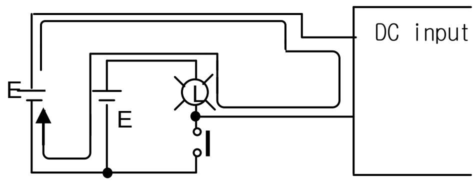
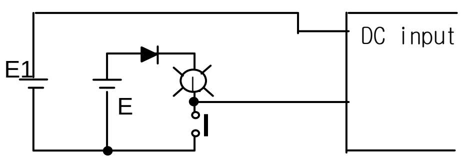
12. Configuration diagram for the applied system:

15.4 Troubleshooting Examples

Possible troubles with various circuits and their corrective actions are explained.

15.4.1 Input circuit troubles and corrective actions

The followings describe possible troubles with input circuits, as well as corrective actions.

Condition	Cause	Corrective Actions
Input signal doesn't turn off.	Leakage current of external device (Such as a drive by non-contact switch) 	• Connect an appropriate register and capacity, which will make the voltage lower across the terminals of the input module.  • CR values are determined by the leakage current value. – Recommended value C : 0.1 ~ 0.47 ㎌ R: 47 ~ 120 Ω (1/2W) Or make up another independent display circuit.
Input signal doesn't turn off. (Neon lamp may be still on)	Leakage current of external device (Drive by a limit switch with neon lamp) 	
Input signal doesn't turn off.	Leakage current due to line capacity of wiring cable. 	• Locate the power supply on the external device side as shown below. 
Input signal doesn't turn off.	Leakage current of external device (Drive by switch with LED indicator) 	• Connect an appropriate register, which will make the voltage higher than the OFF voltage across the input module terminal and common terminal. 
Input signal doesn't turn off.	• Sneak current due to the use of two different power supplies.  • E1 > E2, sneaked.	• Use only one power supply. • Connect a sneak current prevention diode. 

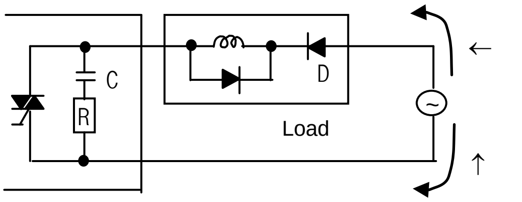
15.4.2 Output circuit and corrective actions

The following describes possible troubles with output circuits, as well as their corrective actions.

<table>
<tr><th>Condition</th><th>Cause</th><th>Corrective Action</th></tr>
<tr>
<td>When the output is off, excessive voltage is applied to the load.</td>
<td>

•Load is half-wave rectified inside (in some cases, it is true of a solenoid)

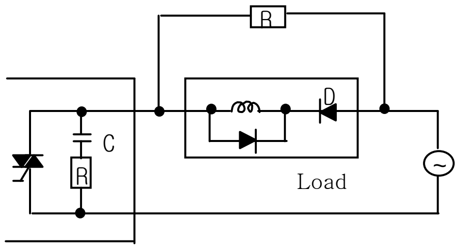
•When the polarity of the power supply is as shown in ①, C is charged. When the polarity is as shown in ②, the voltage charged in C plus the line voltage are applied across D. Max. voltage is approx. $2\sqrt{2}$.



*) If a resistor is used in this way, it does not pose a problem to the output element. But it may make the performance of the diode (D), which is built in the load, drop to cause problems.

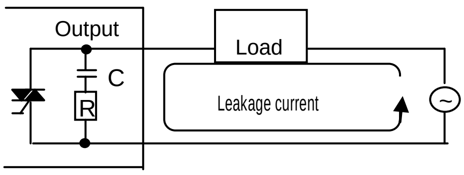
</td>
<td>

• Connect registers of tens to hundreds KΩ across the load in parallel.



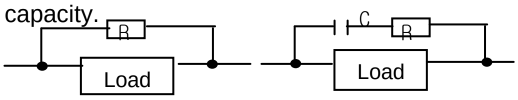
</td>
</tr>
<tr>
<td>The load doesn’t turn off.</td>
<td>

• Leakage current by surge absorbing circuit, which is connected to output element in parallel.



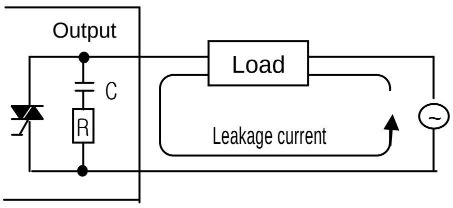
</td>
<td>

• Connect C and R across the load, which are of registers of tens KΩ. When the wiring distance from the output module to the load is long, there may be a leakage current due to the line capacity.



</td>
</tr>
<tr>
<td>When the load is C-R type timer, time constant fluctuates.</td>
<td>

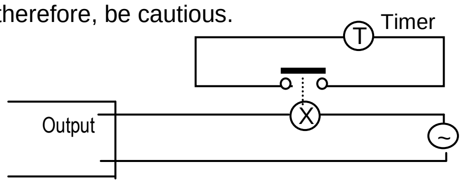
• Leakage current by surge absorbing circuit, which is connected to output element in parallel.



</td>
<td>

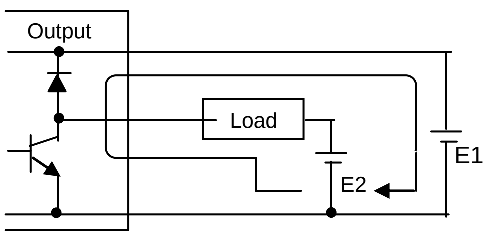
• Drive the relay using a contact and drive the C-R type timer using the since contact.

• Use other timer than the C–R contact some timers have half-ware rectified internal circuits therefore, be cautious.



</td>
</tr>
<tr>
<td>The load does not turn off.</td>
<td>

• Sneak current due to the use of two different power supplies.

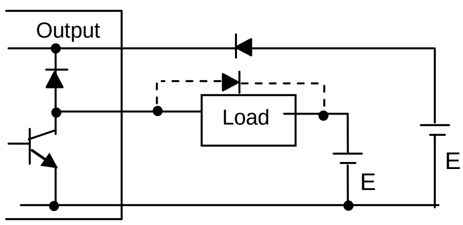


E1<E2, sneaks. E1 is off (E2 is on), sneaks.

</td>
<td>

• Use only one power supply.

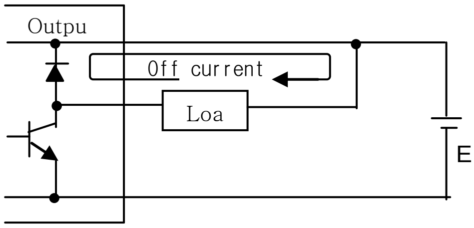
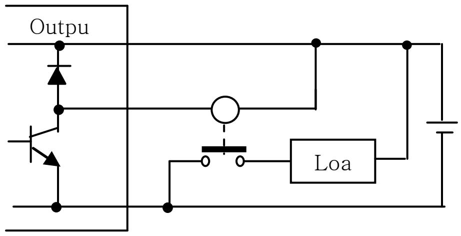
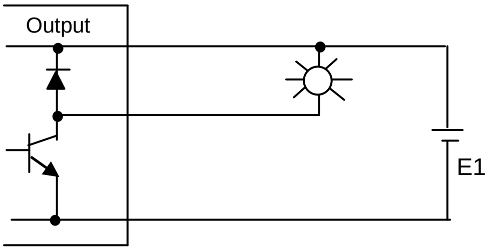
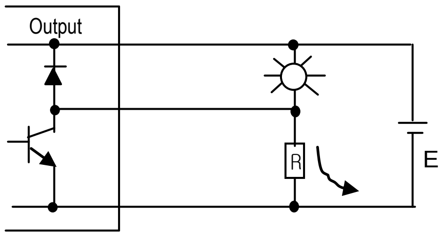
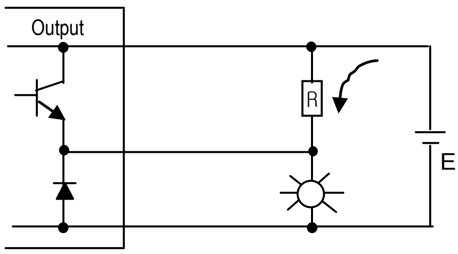
• Connect a sneak current prevention diode.



If the load is the relay, etc, connect a counter-electromotive voltage absorbing code as shown by the dot line.

</td>
</tr>
</table>

Output circuit troubles and corrective actions (continued).

Condition	Cause	Corrective actions
The load off response time is long.	• Over current at off state [The large solenoid current fluidic load (L/R is large) such as is directly driven with the transistor output.  • The off response time can be delayed by one or more second as some loads make the current flow across the diode at the off time of the transistor output.	• Insert a small L/R magnetic contact and drive the load using the same contact. 
Output transistor is destroyed.	Surge current of the white lamp  A surge current of 10 times or more when turned on.	• To suppress the surge current make the dark current of 1/3 to 1/5 rated current flow.  Sink type transistor output  Source type transistor output

15.5 Error Code List

Error code	Error cause	Action (restart mode after taking an action)	Operation status	LED status	Diagnosis point
23	Program to execute is abnormal	Start after reloading the program	Warning	0.5 second Flicker	RUN mode
24	I/O parameter error	Start after reloading I/O parameter, Battery change if battery has a problem. Check the preservation status after I/O parameter reloading and if error occurs, change the unit.	Warning	0.5 second Flicker	Reset RUN mode switching
25	Basic parameter error	Start after reloading Basic parameter, Change battery if it has a problem. Check the preservation status after Basic parameter reloading and if error occurs, change the unit.	Warning	0.5 second Flicker	Reset RUN mode switching
30	Module set in parameter and the installed module does not match	modify the module or parameter and then restart.	Warning	0.5 second Flicker	RUN mode switching
31	Module falling during operation or additional setup	After checking the position of attachment/detachment of expansion module during Run mode	Warning	0.1 second Flicker	Every scan
33	Data of I/O module does not access normally during operation.	After checking the position of slot where the access error occurs by XG5000, change the module and restart (acc.to parameter.)	Heavy error	0.1 second Flicker	Scan end
34	Normal access of special/link module data during operation not available	After checking the position of slot that access error occurred by XG5000, change the module and restart (acc.to parameter).	Heavy error	0.1 second Flicker	Scan end
39	Abnormal stop of CPU or malfunction	Abnormal system end by noise or hard ware error. 1) If it occurs repeatedly when power reinput, request service center 2) Noise measures	Heavy error	0.1 second Flicker	Ordinary time
40	Scan time of program during operation exceeds the scan watchdog time designated by parameter.	After checking the scan watchdog time designated by parameter, modify the parameter or the program and then restart.	Warning	0.5 second Flicker	While running the program
41	Operation error occurs while running the user program.	Remove operation error → reload the program and restart.	Warning	0.5 second Flicker	While running the program
44	Timer index user error	After reloading a timer index program modification, start	Warning	0.5 second Flicker	Scan end
50	Heavy error of external device	Refer to Heavy error detection flag and modifies the device and restart. (Acc. Parameter)	Heavy error	1 second Flicker	Scan end
60	E_STOP function executed	After removing error causes which starts E_STOP function in program, power reinput	Heavy error	1 second Flicker	While running the program

Error code	Error cause	Action (restart mode after taking an action)	Operation status	LED status	Diagnosis point
500	Data memory backup not possible	If not error in battery, power reinput Remote mode is switched to STOP mode.	Warning	1 second Flicker	Reset
501	Abnormal clock data	Setting the time by XG5000 if there is no error	Warning	0.1 second Flicker	Ordinary time
502	Battery voltage falling	Battery change at power On status	Warning	0.1 second Flicker	Ordinary time

Appendix 1 Flag List

Appendix 1.1 Special Relay (F) List

(1) “S(U)” type

Word	Bit	Variables	Function	Description
F000~1	-	_SYS_STATE	Mode and state	Indicates PLC mode and operation State.
	F0000	_RUN	Run	Run state.
	F0001	_STOP	Stop	Stop state.
	F0002	_ERROR	Error	Error state.
	F0003	_DEBUG	Debug	Debug state.
	F0004	_LOCAL_CON	Local control	Local control mode.
	F0006	_REMOTE_CON	Remote mode	Remote control mode.
	F0008	_RUN_EDIT_ST	Editing during RUN	Editing program download during RUN.
	F0009	_RUN_EDIT_CHK	Editing during RUN	Internal edit processing during RUN.
	F000A	_RUN_EDIT_DONE	Edit done during RUN	Edit is done during RUN.
	F000B	_RUN_EDIT_END	Edit end during RUN	Edit is ended during RUN.
	F000C	_CMOD_KEY	Operation mode	Operation mode changed by key.
	F000D	_CMOD_LPADT	Operation mode	Operation mode changed by local PADT.
	F000E	_CMOD_RPADT	Operation mode	Operation mode changed by Remote PADT.
	F000F	_CMOD_RLINK	Operation mode	Operation mode changed by Remote communication module.
	F0010	_FORCE_IN	Forced input	Forced input state.
	F0011	_FORCE_OUT	Forced output	Forced output state.
	F0014	_MON_On	Monitor	Monitor on execution.
	F0015	_USTOP_On	Stop	Stop by Stop function.
	F0016	_ESTOP_On	EStop	Stop by EStop function.
	F0017	_CONPILE_MODE	Compile	Compile on execution.
	F0018	_INIT_RUN	Initialize	Initialization task on execution.
	F001C	_PB1	Program Code 1	Program Code 1 selected.
	F001D	_PB2	Program Code 2	Program Code 2 selected.
	F001E	_CB1	Compile Code 1	Compile Code 1 selected.
	F001F	_CB2	Compile Code2	Compile Code 2 selected.
F002~3	-	_CNF_ER	System error	Reports heavy error state of system.
	F0021	_IO_TYER	Module Type error	Module Type does not match.
	F0022	_IO_DEER	Module detachment error	Module is detached.
	F0024	_IO_RWER	Module I/O error	Module I/O error.
	F0025	_IP_IFER	Module interface error	Special/communication module interface error.
	F0026	_ANNUM_ER	External device error	Detected heavy error in external Device.

Appendix 1 Flag List

Word	Bit	Variable	Function	Description
F002~3	F0028	_BPRM_ER	Basic parameter	Basic parameter error.
	F0029	_IOPRM_ER	IO parameter	I/O configuration parameter error.
	F002A	_SPPRM_ER	Special module parameter	Special module parameter is Abnormal.
	F002B	_CPPRM_ER	Communication module parameter	Communication module parameter is abnormal.
	F002C	_PGM_ER	Program error	Program error.
	F002D	_CODE_ER	Code error	Program Code error.
	F002E	_SWDT_ER	System watchdog	System watchdog operated.
	F0030	_WDT_ER	Scan watchdog	Scan watchdog operated.
F004	-	_CNF_WAR	System warning	Reports light error state of system.
	F0041	_DBCK_ER	Backup error	Data backup error.
	F0043	_ABSD_ER	Operation shutdown error	Stop by abnormal operation.
	F0046	_ANNUM_WAR	External device error	Detected light error of external device.
	F0048	_HS_WAR1	High speed link 1	High speed link – parameter 1 error.
	F0049	_HS_WAR2	High speed link 2	High speed link – parameter 2 error.
	F0054	_P2P_WAR1	P2P parameter 1	P2P – parameter 1 error.
	F0055	_P2P_WAR2	P2P parameter 2	P2P – parameter 2 error.
	F0056	_P2P_WAR3	P2P parameter 3	P2P – parameter 3 error.
	F005C	_CONSTANT_ER	Constant error	Constant error.
F009	-	_USER_F	User contact	Timer used by user.
	F0090	_T20MS	20ms	20ms cycle Clock.
	F0091	_T100MS	100ms	100ms cycle Clock.
	F0092	_T200MS	200ms	200ms cycle Clock.
	F0093	_T1S	1s Clock	1s cycle Clock.
	F0094	_T2S	2 s Clock	2s cycle Clock.
	F0095	_T10S	10 s Clock	10s cycle Clock.
	F0096	_T20S	20 s Clock	20s cycle Clock.
	F0097	_T60S	60 s Clock	60s cycle Clock.
	F0099	_On	Ordinary time On	Always On state Bit.
	F009A	_Off	Ordinary time Off	Always Off state Bit.
	F009B	_1On	1scan On	First scan On Bit.
	F009C	_1Off	1scan Off	First scan OFF bit.
	F009D	_STOG	Reversal	Reversal every scan.

Word	Bit	Variable	Function	Description
F010	-	_USER_CLK	User Clock	Clock available for user setting.
	F0100	_USR_CLK0	Setting scan repeat	On/Off as much as set scan Clock 0.
	F0101	_USR_CLK1	Setting scan repeat	On/Off as much as set scan Clock 1.
	F0102	_USR_CLK2	Setting scan repeat	On/Off as much as set scan Clock 2.
	F0103	_USR_CLK3	Setting scan repeat	On/Off as much as set scan Clock 3.
	F0104	_USR_CLK4	Setting scan repeat	On/Off as much as set scan Clock 4.
	F0105	_USR_CLK5	Setting scan repeat	On/Off as much as set scan Clock 5.
	F0106	_USR_CLK6	Setting scan repeat	On/Off as much as set scan Clock 6.
	F0107	_USR_CLK7	Setting scan repeat	On/Off as much as set scan Clock 7.
F011	-	_LOGIC_RESULT	Logic result	Indicates logic results.
	F0110	_LER	operation error	On during 1 scan in case of operation error.
	F0111	_ZERO	Zero flag	On when operation result is 0.
	F0112	_CARRY	Carry flag	On when carry occurs during operation.
	F0113	_ALL_Off	All output OFF	On in case that all output is Off.
	F0115	_LER_LATCH	Operation error Latch	Keeps On during operation error.
F012	-	_CMP_RESULT	Comparison result	Indicates the comparison result.
	F0120	_LT	LT flag	On in case of “less than”.
	F0121	_LTE	LTE flag	On in case of “equal or less than”.
	F0122	_EQU	EQU flag	On in case of “equal”.
	F0123	_GT	GT flag	On in case of “greater than”.
	F0124	_GTE	GTE flag	On in case of “equal or greater than”.
	F0125	_NEQ	NEQ flag	On in case of “not equal”.
F014	-	_FALS_NUM	FALS no.	Indicates FALS no.
F015	-	_PUTGET_ERR0	PUT/GET error 0	Main base Put / Get error.
F023	-	_PUTGET_NDR0	PUT/GET end 0	Main base Put/Get end.
F044	-	_CPU_TYPE	CPU Type	Indicates information for CPU Type.
F045	-	_CPU_VER	CPU version	Indicates CPU version.
F046	-	_OS_VER	OS version	Indicates OS version.
F048	-	_OS_DATE	OS date	Indicates OS distribution date.
F050	-	_SCAN_MAX	Max. scan time	Indicates max. scan time.
F051	-	_SCAN_MIN	Min. scan time	Indicates min. scan time.
F052	-	_SCAN_CUR	Current scan time	Current scan time.
F0053	-	_MON_YEAR	Month/year	Clock data (month/year) Supported when using RTC option module
F0054	-	_TIME_DAY	Hour/date	Clock data (hour/date) Supported when using RTC option module
F0055	-	_SEC_MIN	Second/minute	Clock data (Second/minute) Supported when using RTC option module

Word	Bit	Variable	Function	Description
F0056	-	_HUND_WK	Hundred year/week	Clock data (Hundred year/week) Supported when using RTC option module
F057	-	_FPU_INFO	N/A	-
	F0570	_FPU_LFLAG_I	N/A	-
	F0571	_FPU_LFLAG_U	N/A	-
	F0572	_FPU_LFLAG_O	N/A	-
	F0573	_FPU_LFLAG_Z	N/A	-
	F0574	_FPU_LFLAG_V	N/A	-
	F057A	_FPU_FLAG_I	N/A	-
	F057B	_FPU_FLAG_U	N/A	-
	F057C	_FPU_FLAG_O	N/A	-
	F057D	_FPU_FLAG_Z	N/A	-
	F057E	_FPU_FLAG_V	N/A	-
	F057F	_FPU_FLAG_E	Irregular input	Reports in case of irregular input.
F058	-	_ERR_STEP	Error step	Saves error step.
F060	-	_REF_COUNT	Refresh	Increase when module Refresh.
F062	-	_REF_OK_CNT	Refresh OK	Increase when module Refresh is normal.
F064	-	_REF_NG_CNT	Refresh NG	Increase when module Refresh is Abnormal.
F066	-	_REF_LIM_CNT	Refresh Limit	Increase when module Refresh is abnormal (Time Out).
F068	-	_REF_ERR_CNT	Refresh Error	Increase when module Refresh is Abnormal.
F070	-	_MOD_RD_ERR_CNT	-	-
F072	-	_MOD_WR_ERR_CNT	-	-
F074	-	_CA_CNT	-	-
F076	-	_CA_LIM_CNT	-	-
F078	-	_CA_ERR_CNT	-	-
F080	-	_BUF_FULL_CNT	Buffer Full	Increase when CPU internal buffer is full.
F082	-	_PUT_CNT	Put count	Increase when Put count.
F084	-	_GET_CNT	Get count	Increase when Get count.
F086	-	_KEY	Current key	indicates the current state of local key.
F088	-	_KEY_PREV	Previous key	indicates the previous state of local key
F090	-	_IO_TYER_N	Mismatch slot	Module Type mismatched slot no.
F091	-	_IO_DEER_N	Detach slot	Module detached slot no.
F093	-	_IO_RWER_N	RW error slot	Module read/write error slot no.
F094	-	_IP_IFER_N	IF error slot	Module interface error slot no.
F096	-	_IO_TYER0	Module Type 0 error	Main base module Type error.

Word	Bit	Variable	Function	Description
F104	-	_IO_DEER0	Module Detach 0 error	Main base module Detach error.
F120	-	_IO_RWER0	Module RW 0 error	Main base module read/write error.
F128	-	_IO_IFER_0	Module IF 0 error	Main base module interface error.
F140	-	_AC_FAIL_CNT	Power shutdown times	Saves the times of power shutdown.
F142	-	_ERR_HIS_CNT	Error occur times	Saves the times of error occur.
F144	-	_MOD_HIS_CNT	Mode conversion times	Saves the times of mode conversion.
F146	-	_SYS_HIS_CNT	History occur times	Saves the times of system history.
F148	-	_LOG_ROTATE	N/A	
F150	-	_BASE_INFO0	Slot information 0	Main base slot information.
F200	-	_USER_WRITE_F	Available contact point	Contact point available in program.
	F2000	_RTC_WR	RTC RW	Data write and read in RTC.
	F2001	_SCAN_WR	Scan WR	Initializing the value of scan.
	F2002	_CHK_ANC_ERR	Request detection of external serious error	Request detection of external error.
	F2003	_CHK_ANC_WAR	Request detection of external slight error (warning)	Request detection of external slight error (warning).
F201	-	_USER_STAUS_F	User contact point	User contact point.
	F2010	_INIT_DONE	Initialization completed	Initialization complete displayed.
F202	-	_ANC_ERR	Display information of external serious error	Display information of external serious error
F203	-	_ANC_WAR	Display information of external slight error (warning)	Display information of external slight error (warning)
F210	-	_MON_YEAR_DT	Month/year	Clock data (month/year) Supported when using RTC option module
F211	-	_TIME_DAY_DT	Hour/date	Clock data (hour/date) Supported when using RTC option module
F212	-	_SEC_MIN_DT	Second/minute	Clock data (Second/minute) Supported when using RTC option module
F213	-	_HUND_WK_DT	Hundred year/week	Clock data (Hundred year/week) Supported when using RTC option module

(2) “E” type

Word	Bit	Variables	Function	Description
F000~1	-	_SYS_STATE	Mode and state	Indicates PLC mode and operation State.
	F0000	_RUN	Run	Run state.
	F0001	_STOP	Stop	Stop state.
	F0002	_ERROR	Error	Error state.
	F0003	_DEBUG	N/A	
	F0004	_LOCAL_CON	Local control	Local control mode.
	F0006	_REMOTE_CON	Remote mode	Remote control mode.
	F0008	_RUN_EDIT_ST	Editing during RUN	Editing program download during RUN.
	F0009	_RUN_EDIT_CHK	Editing during RUN	Internal edit processing during RUN.
	F000A	_RUN_EDIT_DONE	Edit done during RUN	Edit is done during RUN.
	F000B	_RUN_EDIT_END	Edit end during RUN	Edit is ended during RUN.
	F000C	_CMOD_KEY	Operation mode	Operation mode changed by key.
	F000D	_CMOD_LPADT	Operation mode	Operation mode changed by local PADT.
	F000E	_CMOD_RPADT	Operation mode	Operation mode changed by Remote PADT.
	F000F	_CMOD_RLINK	Operation mode	Operation mode changed by Remote communication module.
	F0010	_FORCE_IN	Forced input	Forced input state.
	F0011	_FORCE_OUT	Forced output	Forced output state.
	F0014	_MON_On	Monitor	Monitor on execution.
	F0015	_USTOP_On	Stop	Stop by Stop function.
	F0016	_ESTOP_On	EStop	Stop by EStop function.
	F0017	_CONPILE_MODE	Compile	Compile on execution.
	F0018	_INIT_RUN	Initialize	Initialization task on execution.
	F001C	_PB1	Program Code 1	Program Code 1 selected.
	F001D	_PB2	Program Code 2	Program Code 2 selected.
	F001E	_CB1	Compile Code 1	Compile Code 1 selected.
	F001F	_CB2	Compile Code2	Compile Code 2 selected.
F002~3	-	_CNF_ER	System error	Reports heavy error state of system.
	F0021	_IO_TYER	Module Type error	Module Type does not match.
	F0022	_IO_DEER	Module detachment error	Module is detached.
	F0024	_IO_RWER	Module I/O error	Module I/O error.
	F0025	_IP_IFER	Module interface error	Special/communication module interface error.
	F0026	_ANNUM_ER	External device error	Detected heavy error in external Device.

Appendix 1 Flag List

Word	Bit	Variable	Function	Description
F002~3	F0028	_BPRM_ER	Basic parameter	Basic parameter error.
	F0029	_IOPRM_ER	IO parameter	I/O configuration parameter error.
	F002A	_SPPRM_ER	Special module parameter	Special module parameter is Abnormal.
	F002B	_CPPRM_ER	Communication module parameter	Communication module parameter is abnormal.
	F002C	_PGM_ER	Program error	Program error.
	F002D	_CODE_ER	Code error	Program Code error.
	F002E	_SWDT_ER	System watchdog	System watchdog operated.
	F0030	_WDT_ER	Scan watchdog	Scan watchdog operated.
F004	-	_CNF_WAR	System warning	Reports light error state of system.
	F0041	_DBCK_ER	Backup error	Data backup error.
	F0043	_ABSD_ER	Operation shutdown error	Stop by abnormal operation.
	F0046	_ANNUM_WAR	External device error	Detected light error of external device.
	F0048	_HS_WAR1	N/A	
	F0049	_HS_WAR2	N/A	
	F0054	_P2P_WAR1	P2P parameter 1	P2P – parameter 1 error.
	F0055	_P2P_WAR2	N/A	
	F0056	_P2P_WAR3	N/A	
	F005C	_CONSTANT_ER	Constant error	Constant error.
F009	-	_USER_F	User contact	Timer used by user.
	F0090	_T20MS	20ms	20ms cycle Clock.
	F0091	_T100MS	100ms	100ms cycle Clock.
	F0092	_T200MS	200ms	200ms cycle Clock.
	F0093	_T1S	1s Clock	1s cycle Clock.
	F0094	_T2S	2 s Clock	2s cycle Clock.
	F0095	_T10S	10 s Clock	10s cycle Clock.
	F0096	_T20S	20 s Clock	20s cycle Clock.
	F0097	_T60S	60 s Clock	60s cycle Clock.
	F0099	_On	Ordinary time On	Always On state Bit.
	F009A	_Off	Ordinary time Off	Always Off state Bit.
	F009B	_1On	1scan On	First scan On Bit.
	F009C	_1Off	1scan Off	First scan OFF bit.
	F009D	_STOG	Reversal	Reversal every scan.

Word	Bit	Variable	Function	Description
F010	-	_USER_CLK	User Clock	Clock available for user setting.
	F0100	_USR_CLK0	Setting scan repeat	On/Off as much as set scan Clock 0.
	F0101	_USR_CLK1	Setting scan repeat	On/Off as much as set scan Clock 1.
	F0102	_USR_CLK2	Setting scan repeat	On/Off as much as set scan Clock 2.
	F0103	_USR_CLK3	Setting scan repeat	On/Off as much as set scan Clock 3.
	F0104	_USR_CLK4	Setting scan repeat	On/Off as much as set scan Clock 4.
	F0105	_USR_CLK5	Setting scan repeat	On/Off as much as set scan Clock 5.
	F0106	_USR_CLK6	Setting scan repeat	On/Off as much as set scan Clock 6.
	F0107	_USR_CLK7	Setting scan repeat	On/Off as much as set scan Clock 7.
F011	-	_LOGIC_RESULT	Logic result	Indicates logic results.
	F0110	_LER	operation error	On during 1 scan in case of operation error.
	F0111	_ZERO	Zero flag	On when operation result is 0.
	F0112	_CARRY	Carry flag	On when carry occurs during operation.
	F0113	_ALL_Off	All output OFF	On in case that all output is Off.
	F0115	_LER_LATCH	Operation error Latch	Keeps On during operation error.
F012	-	_CMP_RESULT	Comparison result	Indicates the comparison result.
	F0120	_LT	LT flag	On in case of “less than”.
	F0121	_LTE	LTE flag	On in case of “equal or less than”.
	F0122	_EQU	EQU flag	On in case of “equal”.
	F0123	_GT	GT flag	On in case of “greater than”.
	F0124	_GTE	GTE flag	On in case of “equal or greater than”.
	F0125	_NEQ	NEQ flag	On in case of “not equal”.
F014	-	_FALS_NUM	FALS no.	Indicates FALS no.
F015	-	_PUTGET_ERR0	PUT/GET error 0	Main base Put / Get error.
F023	-	_PUTGET_NDR0	PUT/GET end 0	Main base Put/Get end.
F044	-	_CPU_TYPE	CPU Type	Indicates information for CPU Type.
F045	-	_CPU_VER	CPU version	Indicates CPU version.
F046	-	_OS_VER	OS version	Indicates OS version.
F048	-	_OS_DATE	OS date	Indicates OS distribution date.
F050	-	_SCAN_MAX	Max. scan time	Indicates max. scan time.
F051	-	_SCAN_MIN	Min. scan time	Indicates min. scan time.
F052	-	_SCAN_CUR	Current scan time	Current scan time.
F0053	-	_MON_YEAR	Month/year	Clock data (month/year) Supported when using RTC option module
F0054	-	_TIME_DAY	Hour/date	Clock data (hour/date) Supported when using RTC option module
F0055	-	_SEC_MIN	Second/minute	Clock data (Second/minute) Supported when using RTC option module

Word	Bit	Variable	Function	Description
F0056	-	_HUND_WK	Hundred year/week	Clock data (Hundred year/week) Supported when using RTC option module
F057	-	_FPU_INFO	N/A	-
	F0570	_FPU_LFLAG_I	N/A	-
	F0571	_FPU_LFLAG_U	N/A	-
	F0572	_FPU_LFLAG_O	N/A	-
	F0573	_FPU_LFLAG_Z	N/A	-
	F0574	_FPU_LFLAG_V	N/A	-
	F057A	_FPU_FLAG_I	N/A	-
	F057B	_FPU_FLAG_U	N/A	-
	F057C	_FPU_FLAG_O	N/A	-
	F057D	_FPU_FLAG_Z	N/A	-
	F057E	_FPU_FLAG_V	N/A	-
	F057F	_FPU_FLAG_E	Irregular input	Reports in case of irregular input.
F058	-	_ERR_STEP	Error step	Saves error step.
F060	-	_REF_COUNT	Refresh	Increase when module Refresh.
F062	-	_REF_OK_CNT	Refresh OK	Increase when module Refresh is normal.
F064	-	_REF_NG_CNT	Refresh NG	Increase when module Refresh is Abnormal.
F066	-	_REF_LIM_CNT	Refresh Limit	Increase when module Refresh is abnormal (Time Out).
F068	-	_REF_ERR_CNT	Refresh Error	Increase when module Refresh is Abnormal.
F070	-	_MOD_RD_ERR_CNT	-	-
F072	-	_MOD_WR_ERR_CNT	-	-
F074	-	_CA_CNT	-	-
F076	-	_CA_LIM_CNT	-	-
F078	-	_CA_ERR_CNT	-	-
F080	-	_BUF_FULL_CNT	Buffer Full	Increase when CPU internal buffer is full.
F082	-	_PUT_CNT	Put count	Increase when Put count.
F084	-	_GET_CNT	Get count	Increase when Get count.
F086	-	_KEY	Current key	indicates the current state of local key.
F088	-	_KEY_PREV	Previous key	indicates the previous state of local key
F090	-	_IO_TYER_N	Mismatch slot	Module Type mismatched slot no.
F091	-	_IO_DEER_N	Detach slot	Module detached slot no.
F093	-	_IO_RWER_N	RW error slot	Module read/write error slot no.
F094	-	_IP_IFER_N	IF error slot	Module interface error slot no.
F096	-	_IO_TYER0	Module Type 0 error	Main base module Type error.

Word	Bit	Variable	Function	Description
F104	-	_IO_DEER0	Module Detach 0 error	Main base module Detach error.
F120	-	_IO_RWER0	Module RW 0 error	Main base module read/write error.
F128	-	_IO_IFER_0	Module IF 0 error	Main base module interface error.
F140	-	_AC_FAIL_CNT	N/A	
F142	-	_ERR_HIS_CNT	N/A	
F144	-	_MOD_HIS_CNT	N/A	
F146	-	_SYS_HIS_CNT	History occur times	Saves the times of system history.
F148	-	_LOG_ROTATE	N/A	
F150	-	_BASE_INFO0	Slot information 0	Main base slot information.
F200	-	_USER_WRITE_F	Available contact point	Contact point available in program.
	F2000	_RTC_WR	RTC RW	Data write and read in RTC.
	F2001	_SCAN_WR	Scan WR	Initializing the value of scan.
	F2002	_CHK_ANC_ERR	Request detection of external serious error	Request detection of external error.
	F2003	_CHK_ANC_WAR	Request detection of external slight error (warning)	Request detection of external slight error (warning).
F201	-	_USER_STAUS_F	User contact point	User contact point.
	F2010	_INIT_DONE	Initialization completed	Initialization complete displayed.
F202	-	_ANC_ERR	Display information of external serious error	Display information of external serious error
F203	-	_ANC_WAR	Display information of external slight error (warning)	Display information of external slight error (warning)
F210	-	_MON_YEAR_DT	Month/year	Clock data (month/year) Supported when using RTC option module
F211	-	_TIME_DAY_DT	Hour/date	Clock data (hour/date) Supported when using RTC option module
F212	-	_SEC_MIN_DT	Second/minute	Clock data (Second/minute) Supported when using RTC option module
F213	-	_HUND_WK_DT	Hundred year/week	Clock data (Hundred year/week) Supported when using RTC option module

Appendix 1.2 Communication Relay (L) List

Here describes data link communication relay(L). (Supported in “S(U)” type)

(1) High-speed Link 1

Device	Keyword	Type	Description
L000	_HS1_RLINK	Bit	High speed link parameter 1 normal operation of all station Indicates normal operation of all station according to parameter set in High speed link, and On under the condition as below. 1. In case that all station set in parameter is RUN mode and no error, 2. All data block set in parameter is communicated normally, and 3. The parameter set in each station itself is communicated normally. Once RUN_LINK is On, it keeps On unless stopped by LINK_DISABLE.
L001	_HS1_LTRBL	Bit	Abnormal state after _HS1RLINK On In the state of _HSmRLINK flag On, if communication state of the station set in the parameter and data block is as follows, this flag shall be On. 1. In case that the station set in the parameter is not RUN mode, or 2. There is an error in the station set in the parameter, or 3. The communication state of data block set in the parameter is not good. LINK TROUBLE shall be On if the above 1, 2 & 3 conditions occur, and if the condition return to the normal state, it shall be OFF again.
L0020 ~ L005F	_HS1_STATE[k] (k = 00~63)	Bit Array	High speed link parameter 1, K block general state Indicates the general state of communication information for each data block of setting parameter. _HS1_STATE[k] = HS1MOD[k]&_HS1TRX[k]&(~_HS1_ERR[k])
L0060 ~ L009F	_HS1_MOD[k] (k = 00~63)	Bit Array	High speed link parameter 1, k block station RUN operation mode Indicates operation mode of station set in K data block of parameter.
L0100 ~ L013F	_HS1_TRX[k] (k = 00~63)	Bit Array	Normal communication with High speed link parameter 1, k block station Indicates if communication state of Kdata of parameter is communicated smoothly according to the setting.
L0140 ~ L017F	_HS1_ERR[k] (k = 00~63)	Bit Array	High speed link parameter 1, K block station operation error mode Indicates if the error occurs in the communication state of k data block of parameter.
L0180 ~ L021F	_HS1_SETBLOCK[k]	Bit Array	High speed link parameter 1, K block setting Indicates whether or not to set k data block of parameter.

(2) High-speed Link2

Device	Keyword	Type	Description
L0260	_HS2_RLINK	Bit	High-speed link parameter 2 normal operation of all station. Indicates normal operation of all station according to parameter set in High-speed link and On under the condition as below. 1. In case that all station set in parameter is Run mode and no error 2. All data block set in parameter is communicated and 3.The parameter set in each station itself is communicated normally. Once RUN_LINK is On, it keeps On unless stopped by LINK_DISABLE.
L0261	_HS2_LTRBL	Bit	Abnormal state after _HS2RLINK On. In the state of _HSmRLINK flag On, if communication state of the station set in the parameter and data block is as follows, this flag shall be On. 1. In case that the station set in the parameter is not RUN mode, or 2. There is an error in the station set in the parameter, or 3. The communication state of data block set in the parameter is not good. LINK TROUBLE shall be On if the above 1, 2 & 3 conditions occur, and if the condition return to the normal state, it shall be OFF again.
L0280 ~ L031F	_HS2_STATE[k] (k = 00~63)	Bit Array	High speed link parameter 1, k block general state. Indicates the general state of communication information for each data block of setting parameter. _HS2_STATE[k]=HS2MOD[k]&_HS2TRX[k]&(~_HS2_ERR[k])
L0320 ~ L035F	_HS2_MOD[k] (k = 00~63)	Bit Array	High speed link parameter 1, k block station RUN operation mode. Indicates operation mode of station set in k data block of parameter.
L0360 ~ L039F	_HS2_TRX[k] (k = 00~63)	Bit Array	Normal communication with High speed link parameter 1, K block station. Indicates if communication state of K data of parameter is communicated smoothly according to the setting.
L0400 ~ L043F	_HS2_ERR[k] (k = 00~63)	Bit Array	High speed link parameter 1, K block station operation error mode. Indicates if the error occurs in the communication state of k data block of parameter.
L0440 ~ L047F	_HS2_SETBLOCK[k]	Bit Array	High speed link parameter 1, K block setting. Indicates whether or not to set k data block of parameter.

(3) Common area

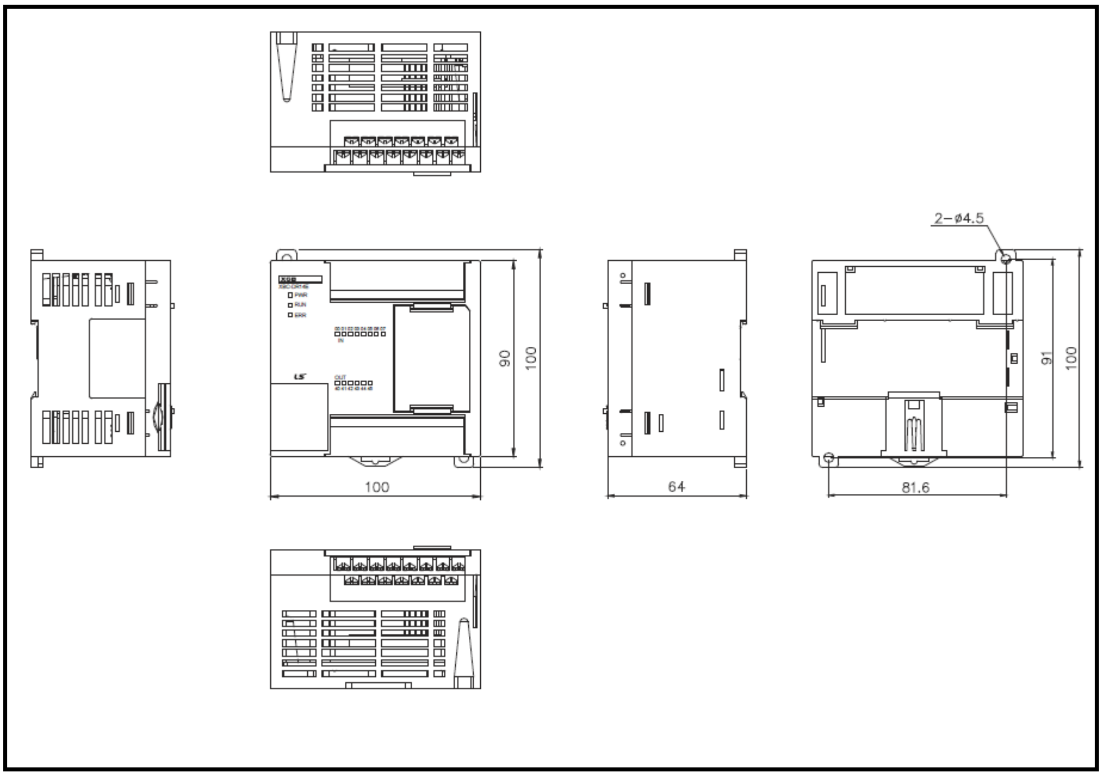
Communication flag list according to P2P service setting.
P2P parameter: “S” type 1~3, “E” type 1
P2P block: “S” type and “E” type 0~31

Device	Keyword	Type	Description
L5120	_P2P1_NDR00	Bit	Indicates P2P parameter 1, 0 Block service normal end.
L5121	_P2P1_ERR00	Bit	Indicates P2P parameter 1, 0 Block service abnormal end.
L513	_P2P1_STATUS00	Word	Indicates error code in case of P2P parameter 1, 0 Block service abnormal end.
L514	_P2P1_SVCCNT00	DWord	Indicates P2P parameter 1, 0 Block service normal count.
L516	_P2P1_ERRCNT00	DWord	Indicates P2P parameter 1, 0 Block service abnormal count.
L5180	_P2P1_NDR01	Bit	P2P parameter 1, 1 Block service normal end.
L5181	_P2P1_ERR01	Bit	P2P parameter 1, 1 Block service abnormal end.
L519	_P2P1_STATUS01	Word	Indicates error code in case of P2P parameter 1, 1 Block service abnormal end.
L520	_P2P1_SVCCNT01	DWord	Indicates P2P parameter 1, 1 Block service normal count.
L522	_P2P1_ERRCNT01	DWord	Indicates P2P parameter 1, 1 Block service abnormal count.
L524~L529	-	Word	P2P parameter 1,2 Block service total.
L530~L535	-	Word	P2P parameter 1,3 Block service total.
L536~L697	-	Word	P2P parameter 1,4~30 Block service total.
L698~L703	-	Word	P2P parameter 1,31 Block service total.

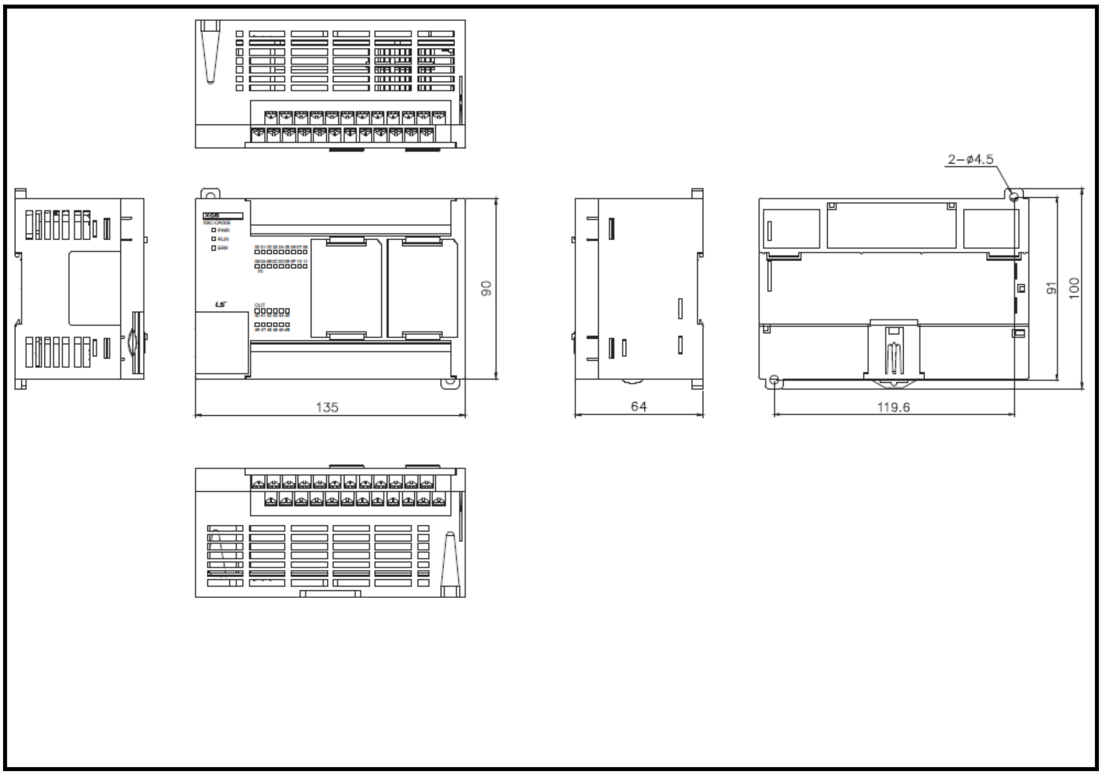
Appendix 2 Dimension (Unit: mm)

(1) Economy type main unit (“E” type)

-. XBC-DR10/14E, XBC-DN10/14E, XBC-DP10/14E

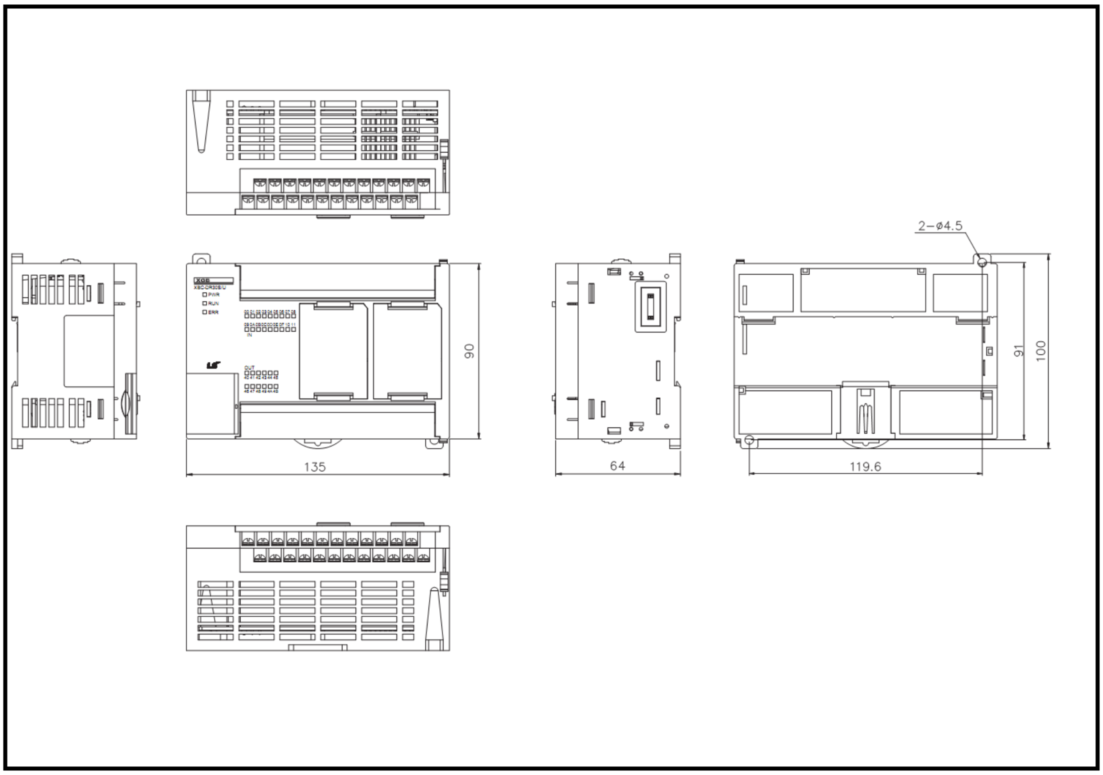


-. XBC-DR20/30E, XBC-DN20/30E, XBC-DP20/30E

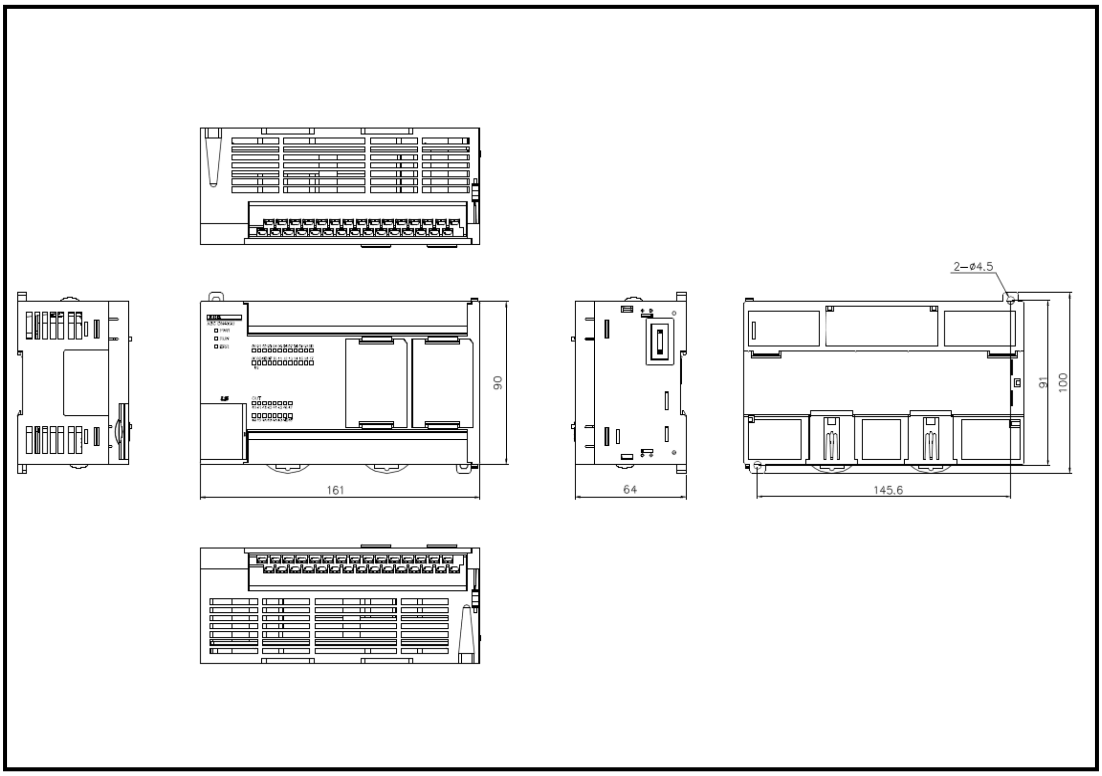


(2) Standard type main unit (“S(U)” type)

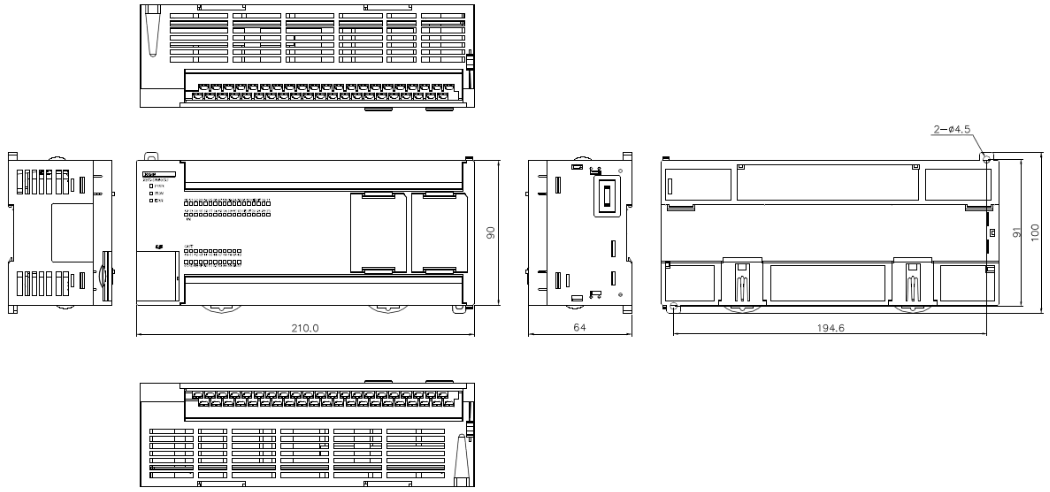
-. XBC-DN20/30S(U), XBC-DR20/30SU, XBC-DP20/30SU



－ XBC-DN40SU, XBC-DR40SU ¸ XBC-DP40SU

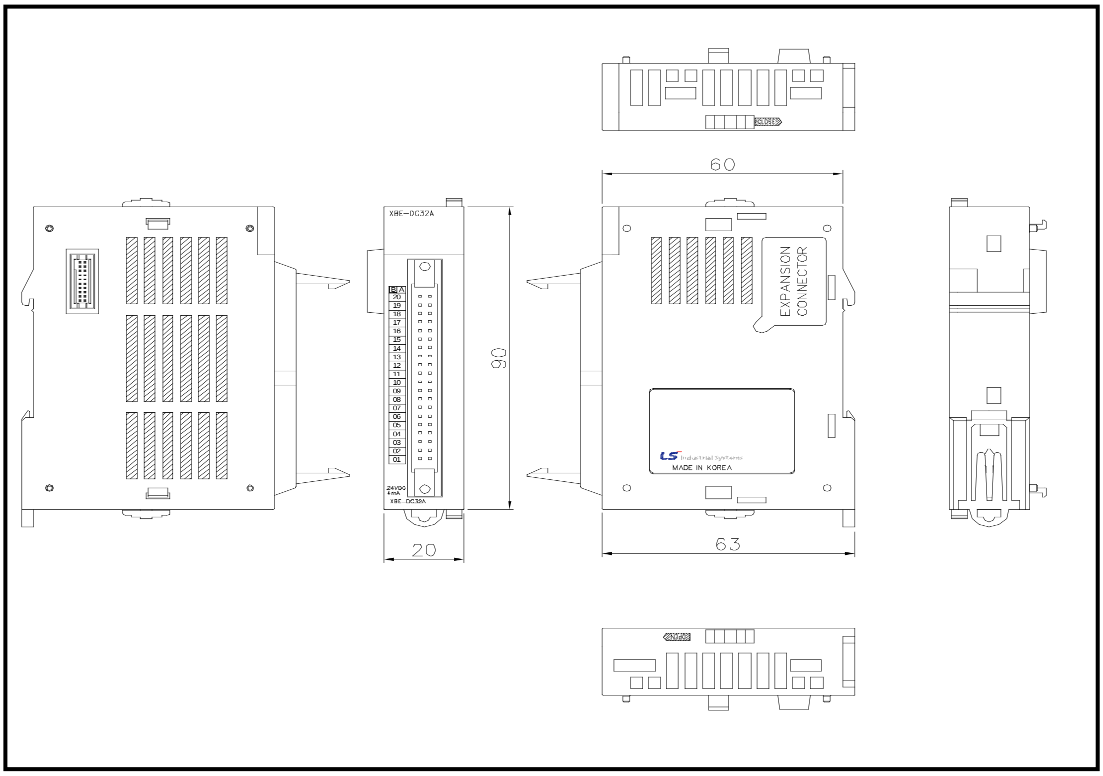


- XBC-DN60SU, XBC-DR60SU, XBC-DP60SU

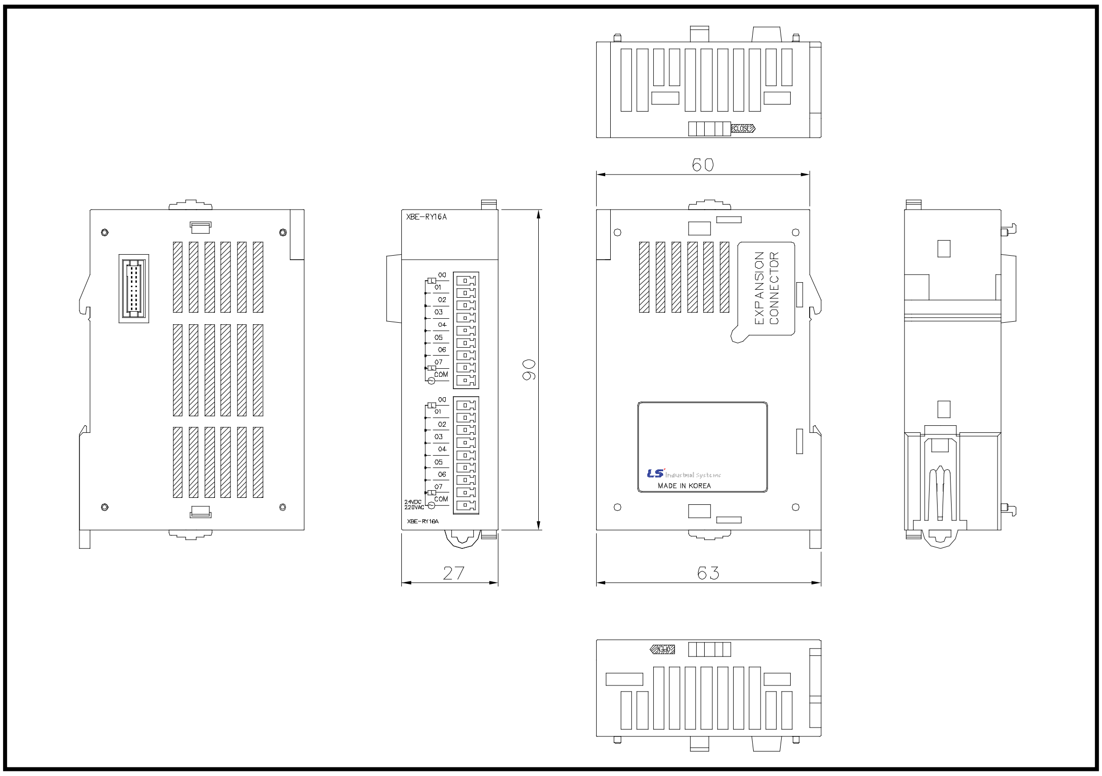


(3) Extension I/O module

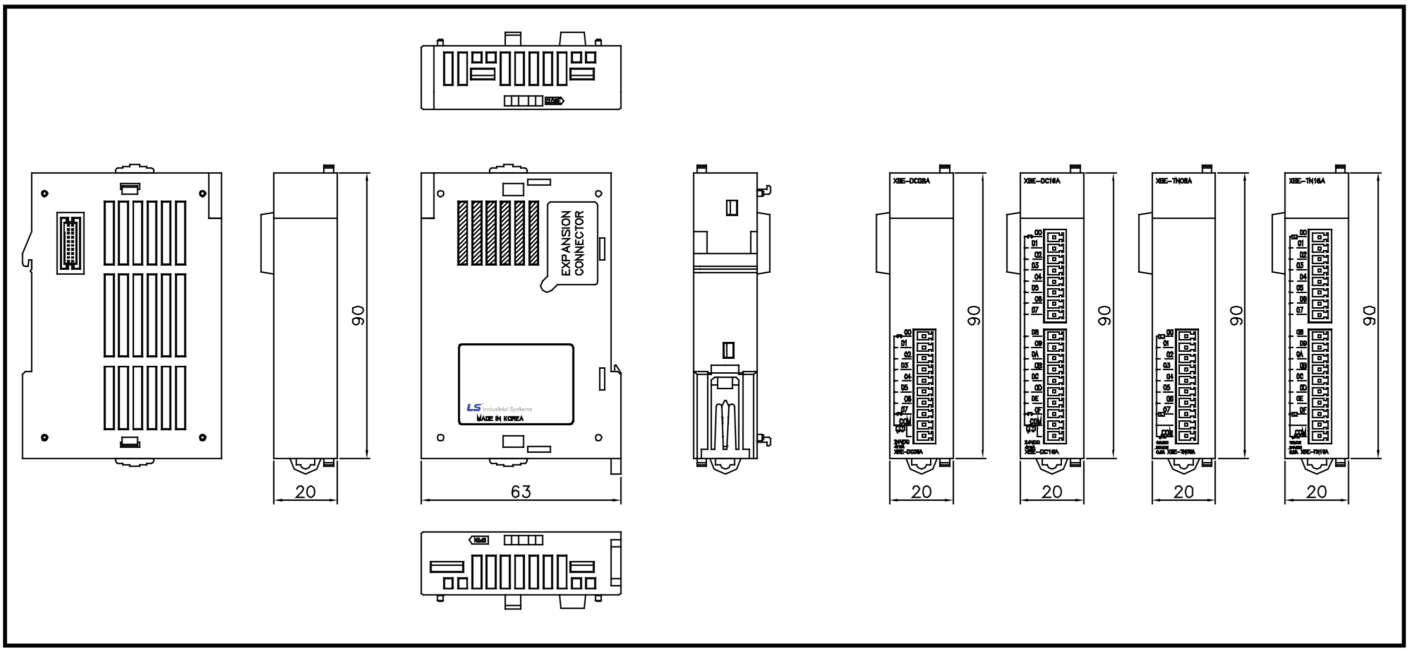
-. XBE-DC32A, XBE-TR32A



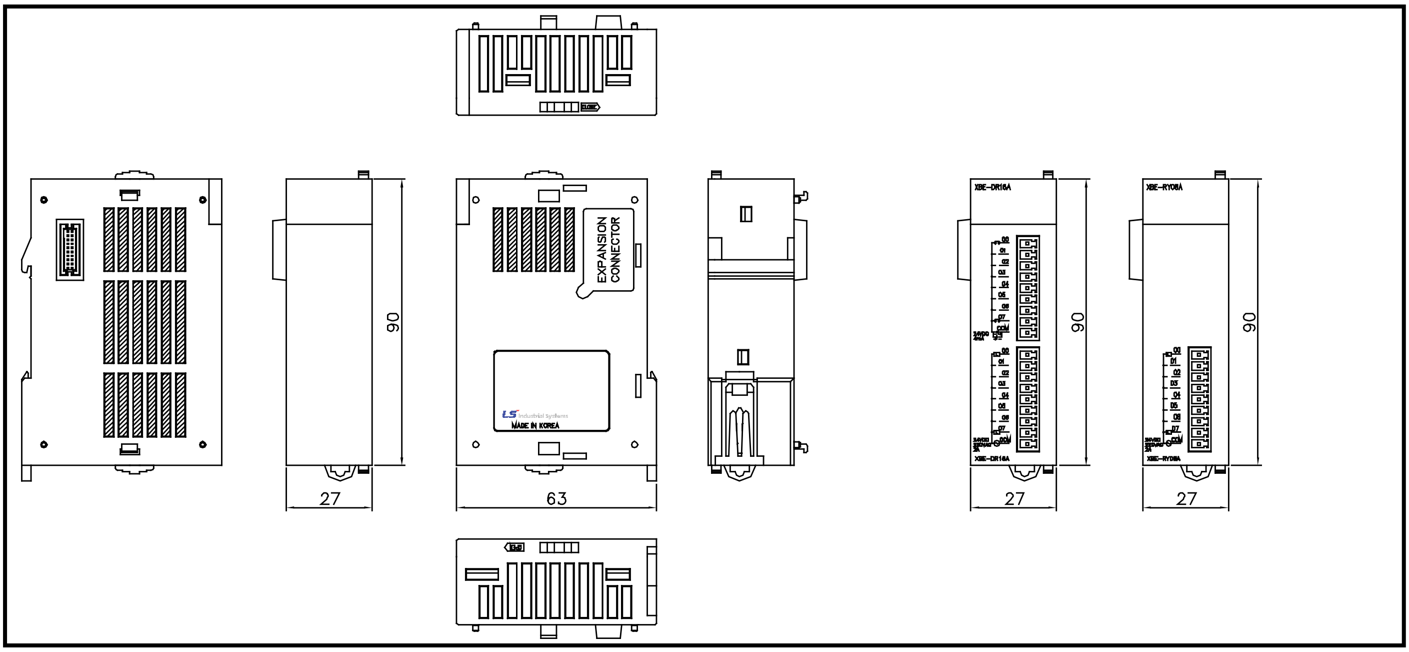
-. XBE-RY16A



-. XBE-DC08A, XBE-DC16A, XBE-TN08A, XBE-TN16A



-. XBE-DR16A, XBE-RY08A



Appendix 3 Compatibility with MASTER-K (Special Relay)

MASTER-K		Symbol	XGB	
Device	Function		Device	Function
F0000	RUN mode	_RUN	F0000	RUN Edit mode
F0001	Program mode	_STOP	F0001	Program mode
F0002	Pause mode	_ERROR	F0002	Error mode
F0003	Debug mode	_DEBUG	F0003	Debug mode
F0004	N/A	_LOCAL_CON	F0006	Remote mode
F0005	N/A	_MODBUS_CON	F0006	Remote mode
F0006	Remote mode	_REMOTE_CON	F0006	Remote mode
F0007	User memory setup	-	F0007	N/A
F0008	N/A	_RUN_EDIT_ST	F0008	Editing during RUN
F0009	N/A	_RUN_EDIT_CHK	F0009	Editing during RUN
F000A	User memory operation	_RUN_EDIT_DONE	F000A	Edit done during RUN
F000B	N/A	_RUN_EDIT_END	F000B	Edit end during RUN
F000C	N/A	_CMOD_KEY	F000C	Operation mode change by KEY
F000D	N/A	_CMOD_LPADT	F000D	Operation mode change by PADT
F000E	N/A	_CMOD_RPADT	F000E	Operation mode change by Remote PADT
F000F	STOP command execution	_CMOD_RLINK	F000F	Operation mode change cause by remote communication module
F0010	Ordinary time On	_FORCE_IN	F0010	Forced input
F0011	Ordinary time Off	_FORCE_OUT	F0011	Forced output
F0012	1 Scan On	_SKIP_ON	F0012	I/O Skip execution
F0013	1 Scan Off	_EMASK_ON	F0013	Error mask execution
F0014	Reversal every Scan	_MON_ON	F0014	Monitor execution
F0015 ~ F001C	N/A	_USTOP_ON	F0015	Stop by Stop Function
		_ESTOP_ON	F0016	Stop by ESTOP Function
		_CONPILE_MODE	F0017	Compile
		_INIT_RUN	F0018	Initialize
		-	F0019 ~ F001F	N/A
		_PB1	F001C	Program Code 1
F001D	N/A	_PB2	F001D	Program Code 2
F001E	N/A	_CB1	F001E	Compile code 1
F001F	N/A	_CB2	F001F	Compile code 2

MASTER-K		Symbol	XGB	
Device	Function		Device	Function
F0020	1 Step RUN	_CPU_ER	F0020	CPU configuration error
F0021	Break Point RUN	_IO_TYER	F0021	Module type mismatch error
F0022	Scan RUN	_IO_DEER	F0022	Module detach error
F0023	Contact value match RUN	_FUSE_ER	F0023	Fuse cutoff error
F0024	Word value match RUN	_IO_RWER	F0024	I/O module read/write error
F0025 ~ F002F	N/A	_IP_IFER	F0025	Special/communication module interface error
		_ANNUM_ER	F0026	Heavy error detection of external equipment error
		-	F0027	N/A
		_BPRM_ER	F0028	Basic parameter error
		_IOPRM_ER	F0029	I/O configuration parameter error
		_SPPRM_ER	F002A	Special module parameter error
		_CPPRM_ER	F002B	Communication module parameter error
		_PGM_ER	F002C	Program error
		_CODE_ER	F002D	Program Code error
		_SWDT_ER	F002E	System watchdog error
		_BASE_POWER_ER	F002F	Base power error
F0030	Heavy error	_WDT_ER	F0030	Scan watchdog
F0031	Light error	-	F0031	-
F0032	WDT error	-	F0032	-
F0033	I/O combination error	-	F0033	-
F0034	Battery voltage error	-	F0034	-
F0035	Fuse error	-	F0035	-
F0036 ~ F0038	N/A	-	F0036 ~ F0038	-
F0039	Backup normal	-	F0039	-
F003A	Clock data error	-	F003A	-
F003B	Program change	-	F003B	-
F003C	Program change error	-	F003C	-
F003D ~ F003F	N/A	-	F003D ~ F003F	N/A
F0040~ F005F	N/A	_RTC_ER	F0040	RTC data error
		_DBCK_ER	F0041	Data backup error
		_HBCK_ER	F0042	Hot restart disabled error
		_ABSD_ER	F0043	Abnormal operation stop
		_TASK_ER	F0044	Task collision
		_BAT_ER	F0045	Battery error
		_ANNUM_ER	F0046	Light error detection of external equipment

MASTER-K		Symbol	XGB	
Device	Function		Device	Function
F0040 ~ F005F	N/A	_LOG_FULL	F0047	Log memory full warning
		_HS_WAR1	F0048	High speed link parameter 1 error
		_HS_WAR2	F0049	High speed link parameter 2 error
		-	F004A ~ F0053	N/A
		_P2P_WAR1	F0054	P2P parameter 1 error
		_P2P_WAR2	F0055	P2P parameter 2 error
		_P2P_WAR3	F0056	P2P parameter 3 error
		-	F0057 ~ F005B	N/A
		_Constant_ER	F005C	Constant error
		-	F005D ~ F005F	N/A
F0060 ~ F006F	Error Code save	-	F0060 ~ F006F	N/A
F0070 ~ F008F	Fuse cutoff save	-	F0070 ~ F008F	N/A
F0090	20ms cycle Clock	_T20MS	F0090	20ms cycle Clock
F0091	100ms cycle Clock	_T100MS	F0091	100ms cycle Clock
F0092	200ms cycle Clock	_T200MS	F0092	200ms cycle Clock
F0093	1s cycle Clock	_T1S	F0093	1s cycle Clock
F0094	2s cycle Clock	_T2S	F0094	2s cycle Clock
F0095	10s cycle Clock	_T10S	F0095	10s cycle Clock
F0096	20s cycle Clock	_T20S	F0096	20s cycle Clock
F0097	60s cycle Clock	_T60S	F0097	60s cycle Clock
F0098 ~F009F	N/A	-	F0098	N/A
		_ON	F0099	Ordinary time On
		_OFF	F009A	Ordinary time Off
		_1ON	F009B	1 Scan On
		_1OFF	F009C	1 Scan Off
		_STOG	F009D	Reversal every Scan
		-	F009B ~ F009F	N/A
F0100	User Clock 0	-	F0100	User Clock 0
F0101	User Clock 1	-	F0101	User Clock 1
F0102	User Clock 2	-	F0102	User Clock 2
F0103	User Clock 3	-	F0103	User Clock 3
F0104	User Clock 4	-	F0104	User Clock 4
F0105	User Clock 5	-	F0105	User Clock 5
F0106	User Clock 6	-	F0106	User Clock 6
F0107	User Clock 7	-	F0107	User Clock 7

MASTER-K		Symbol	XGB	
Device	Function		Device	Function
F0108 ~ F010F		-	F0108 ~ F010F	N/A
F0110	Operation error flag	_Ler	F0110	Operation error flag
F0111	Zero flag	_Zero	F0111	Zero flag
F0112	Carry flag	_Carry	F0112	Carry flag
F0113	Full output Off	_All_Off	F0113	Full output Off
F0114	Common RAM R/W error	-	F0114	N/A
F0115	Operation error flag (latch)	_Ler_Latch	F0115	Operation error flag(latch)
F0116 ~ F011F		-	F0116 ~ F011F	N/A
F0120	LT flag	_LT	F0120	LT flag
F0121	LTE flag	_LTE	F0121	LTE flag
F0122	EQU flag	_EQU	F0122	EQU flag
F0123	GT flag	_GT	F0123	GT flag
F0124	GTE flag	_GTE	F0124	GTE flag
F0125	NEQ flag	_NEQ	F0125	NEQ flag
F0126 ~ F012F	N/A	-	F0126 ~ F012F	N/A
F0130~ F013F	AC Down Count	_AC_F_CNT	F0130~ F013F	AC Down Count
F0140~ F014F	FALS no.	_FALS_NUM	F0140~ F014F	FALS no.
F0150~ F015F	PUT/GET error flag	_PUTGET_ERR	F0150~ F030F	PUT/GET error flag
		CPU TYPE	F0440 ~ F044F	CPU TYPE
		CPU VERSION	F0450 ~ F045F	CPU VERSION
		OS version no.	F0460 ~ F047F	System OS version no.
F0160~ F049F	N/A	OS date	F0480 ~ F049F	System OS DATE

MASTER-K		Symbol	XGB	
Device	Function		Device	Function
F0500~ F050F	Max. Scan time	_SCAN_MAX	F0500~ F050F	Max. Scan time
F0510~ F051F	Min. Scan time	_SCAN_MIN	F0510~ F051F	Min. Scan time
F0520~ F052F	Current Scan time	_SCAN_CUR	F0520~ F052F	Current Scan time
F0530~ F053F	Clock data (year/month)	_YEAR_MON	F0530~ F053F	Clock data (year/month)
F0540~ F054F	Clock data (day/hr)	_DAY_TIME	F0540~ F054F	Clock data(day/hr)
F0550~ F055F	Clock data (min/sec)	_MIN_SEC	F0550~ F055F	Clock data(min/sec)
F0560~ F056F	Clock data (100year/weekday)	_HUND_WK	F0560~ F056F	Clock data(100year/weekday)
F0570~ F058F	N/A	_FPU_LFlag_I	F0570	-
		_FPU_LFlag_U	F0571	-
		_FPU_LFlag_O	F0572	-
		_FPU_LFlag_Z	F0573	-
		_FPU_LFlag_V	F0574	-
		-	F0575 ~ F0579	N/A
		_FPU_Flag_I	F057A	-
		_FPU_Flag_U	F057B	-
		_FPU_Flag_O	F057C	-
		_FPU_Flag_Z	F057D	-
		_FPU_Flag_V	F057E	-
		_FPU_Flag_E	F057F	-
		Error Step	F0580~ F058F	Error step save
F0590~ F059F	Error step save	-	F0590~ F059F	N/A
F0600~ F060F	FMM detailed error information	_REF_COUNT	F060~F061	Refresh Count
F0610~ F063F	N/A	_REF_OK_CNT	F062~F063	Refresh OK Count
-	-	_REF_NG_CNT	F064~F065	Refresh NG Count
-	-	_REF_LIM_CNT	F066~F067	Refresh Limit Count
-	-	_REF_ERR_CNT	F068~F069	Refresh Error Count
-	-	_MOD_RD_ERR_CNT	F070~F071	MODULE Read Error Count
-	-	_MOD_WR_ERR_CNT	F072~F073	MODULE Write Error Count
-	-	_CA_CNT	F074~F075	Cmd Access Count
-	-	_CA_LIM_CNT	F076~F077	Cmd Access Limit Count
-	-	_CA_ERR_CNT	F078~F079	Cmd Access Error Count
-	-	_BUF_FULL_CNT	F080~F081	Buffer Full Count

Note

1. When you convert the project written by KGLWIN in MASTER-K series (K80S, K200S, K300S, and K1000S) into XG5000 project, some instructions used in only MASTER-K is not converted. And the previous parameter used in MASTER-K is converted into default value.
2. XGB economy type project can be converted into XGB standard type project but parameter is converted into default value.
3. When you convert the XGB standard type project into XGB economy type project, some instructions used in only XGB standard type is not converted. And the parameter is converted into default value.

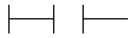
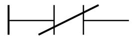
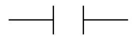
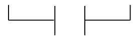
Appendix 4 Instruction List

Appendix 4.1 Classification of Instructions

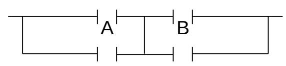
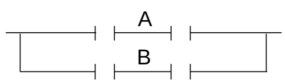
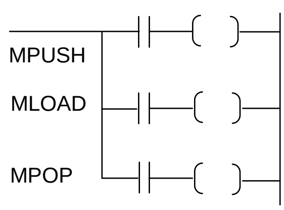
Classification	Instructions	Details	Remarks
Basic Instructions	Contact Point Instruction	LOAD, AND, OR related Instructions	
	Unite Instruction	AND LOAD, OR LOAD, MPUSH, MLOAD, MPOP	
	Reverse Instruction	NOT	
	Master Control Instruction	MCS, MCSCLR	
	Output Instruction	OUT, SET, RST, 1 Scan Output Instruction, Output Reverse Instruction (FF)	
	Sequence/Last-input Preferred Instruction	Step Control Instruction (SET Sxx.xx, OUT Sxx.xx)	
	End Instruction	END	
	Non-Process Instruction	NOP	
	Timer Instruction	TON, TOFF, TMR, TMON, TRTG	
	Counter Instruction	CTD, CTU, CTUD, CTR	
Application Instructions	Data Transfer Instruction	Transfers specified Data, Group, String	4/8/64 Bits available
	Conversion Instruction	Converts BIN/BCD of specified Data & Group	4/8 Bits available
	Data Type Conversion Instruction	Converts Integer/Real Number	
	Output Terminal Compare Instruction	Saves compared results in special relay	Compare to Unsigned
	Input Terminal Compare Instruction	Saves compared results in BR. Compares Real Number, String & Group. Compares 3 Operands	Compare to Signed
	Increase/Decrease Instruction	Increases or decreases specified data 1 by 1	4/8 Bits available
	Rotate Instruction	Rotates specified data to the left and right, including Carry	4/8 Bits available
	Move Instruction	Moves specified data to the left and right, word by word, bit by bit	4/8 Bits available
	Exchange Instruction	Exchanges between devices, higher & lower byte, group data	
	BIN Operation Instruction	Addition, Subtraction, Multiplication & Division for Integer/ Real Number, Addition for String, Addition & Subtraction for Group	
	BCD Operation Instruction	Addition, Subtraction, Multiplication, Division.	
	Logic Operation Instruction	Logic Multiplication, Logic Addition, Exclusive OR, Exclusive NOR, Group Operation	
	System Instruction	Error Display, WDT Initialize, Output Control, Operation Stop, etc.	
	Data Process Instruction	Encode, Decode, Data Disconnect/Connect, Search, Align, Max., Min., Total, Average, etc.	
	Data Table Process Instruction	Data Input/Output of Data Table	
	String Process Instruction	String related Convert, Comment Read, String Extract, ASCII Convert, HEX Convert, String Search, etc.	
	Special Function Instruction	Trigonometric Function, Exponential/Log Function, Angle/ Radian Convert, etc.	
	Data Control Instruction	Max/Min Limit Control, Dead-zone Control, Zone Control	
	Time related Instruction	Date Time Data Read/Write, Time Data Adjust & Convert	
	Diverge Instruction	JMP, CALL	
	Loop Instruction	FOR/NEXT/BREAK	
	Flag related Instruction	Carry Flag Set/Reset, Error Flag Clear	
	Special/Communication related Instruction	Data Read/Write by BUSCON Direct Access	
	Interrupt related Instruction	Interrupt Enable/Disable	
	Signal Reverse Instruction	Reverse Integer/Real Signals, Absolute Value Operation	
	File related Instruction	Blcok Read/Write/Compare/Convert, Flash data Transmission	

Appendix 4.2 Basic Instructions

(1) Contact point instruction

Classification	Designations	Symbol	Description	Support	
				XGK	XGB
Contact Point	LOAD		A Contact Point Operation Start	○	○
	LOAD NOT		B Contact Point Operation Start	○	○
	AND		A Contact Point Series-Connected	○	○
	AND NOT		B Contact Point Series-Connected	○	○
	OR		A Contact Point Parallel-Connected	○	○
	OR NOT		B Contact Point Parallel-Connected	○	○
	LOADP		Positive Convert Detected Contact Point	○	○
	LOADN		Negative Convert Detected Contact Point	○	○
	ANDP		Positive Convert Detected Contact Point Series-Connected	○	○
	ANDN		Negative Convert Detected Contact Point Series-Connected	○	○
	ORP		Positive Convert Detected Contact Point Parallel-	○	○
	ORN		Negative Convert Detected Contact Point Parallel-	○	○

(2) Union instruction

Classification	Designations	Symbol	Description	Support	
				XGK	XGB
Unite	AND LOAD		A,B Block Series-Connected	○	○
	OR LOAD		A,B Block Parallel-Connected	○	○
	MPUSH		Operation Result Push up to present	○	○
	MLOAD		Operation Result Load Previous to Diverge Point	○	○
	MPOP		Operation Result Pop Previous to Diverge Point	○	○

(3) Reverse instruction

Classification	Designations	Symbol	Description	Support XGK	Support XGB
Reverse	NOT	—*—	Previous Operation results Reverse	○	○

(4) Master Control instruction

Classification	Designations	Symbol	Description	Support XGK	Support XGB
Master Control	MCS	[MCS | n]	Master Control Setting (n:0~7)	○	○
	MCSCLR	[MCSCLR | n]	Master Control Cancel (n:0~7)	○	○

(5) Output instruction

Classification	Designations	Symbol	Description	Support XGK	Support XGB
Output	OUT	( )	Operation Results Output	○	○
	OUT NOT	(/)	Operation Results Reverse Output	○	○
	OUTP	(P)	1 Scan Output if Input Condition rises	○	○
	OUTN	(N)	1 Scan Output if Input Condition falls	○	○
	SET	(S)	Contact Point Output ON kept	○	○
	RST	(R)	Contact Point Output OFF kept	○	○
	FF	[FF | D]	Output Reverse if Input Condition rises	○	○

(6) Sequence/Last-input preferred instruction

Classification	Designations	Symbol	Description	Support XGK	Support XGB
Step Control	SET S	Syy.xx (S)	Sequence Control	○	○
	OUT S	Syy.xx ( )	Last-input Preferred	○	○

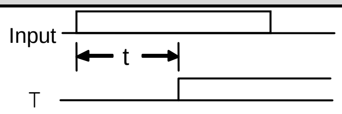
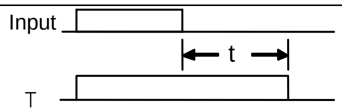
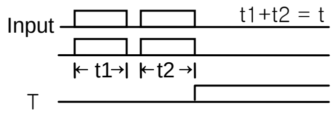
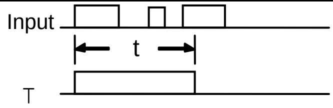
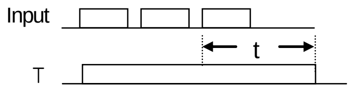
(7) End instruction

Classification	Designations	Symbol	Description	Support XGK	Support XGB
End	END	[END]	Program End	○	○

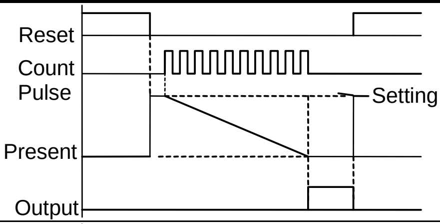
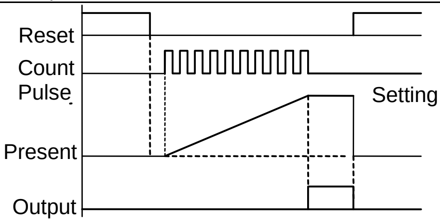
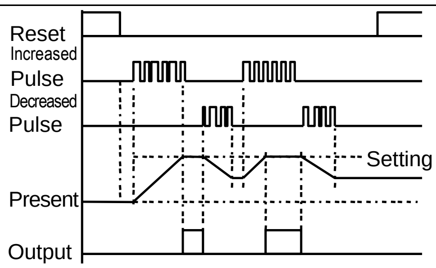
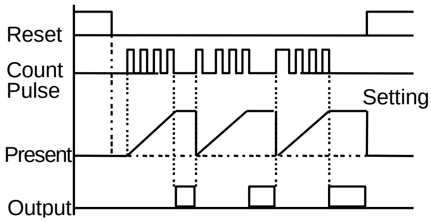
(8) Non-process instruction

Classification	Designations	Symbol	Description	Support XGK	Support XGB
Non-Process	NOP	Ladder not displayed	Non-Process Instruction, used in Nimonic	○	○

(9) Timer instruction

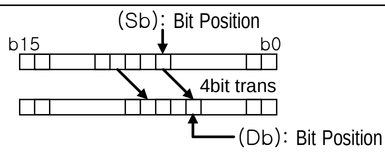
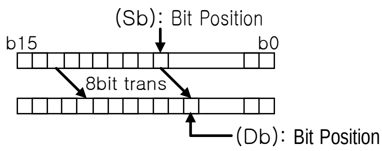
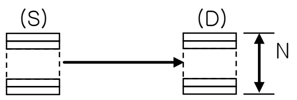
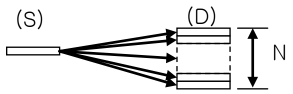
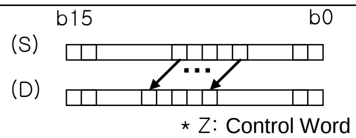
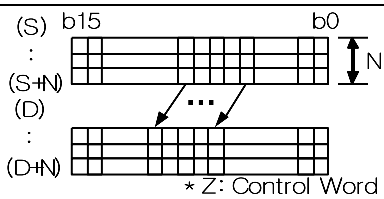
Classification	Designations	Symbol	Description	Support	
				XGK	XGB
Timer	TON	TON | T | t		○	○
	TOFF	TOFF | T | t		○	○
	TMR	TMR | T | t		○	○
	TMON	TMON | T | t		○	○
	TRTG	TRTG | T | t		○	○

(10) Counter instruction

Classification	Designations	Symbol	Description	Support	
				XGK	XGB
Counter	CTD	CTD | C | c		○	○
	CTU	CTU | C | c		○	○
	CTUD	CTUD | C | U | D | c		○	○
	CTR	CTR | C | c		○	○

Appendix 4.3 Application Instruction

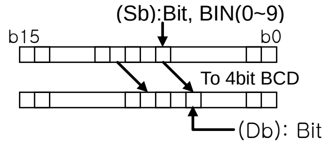
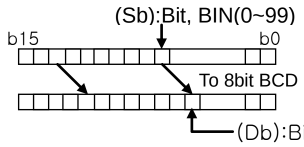
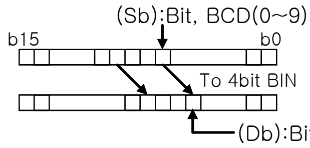
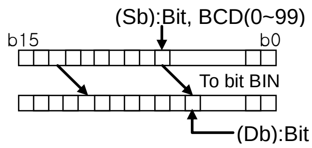
(1) Data transfer instruction

Classification	Designations	Symbol	Description	Support XGK	Support XGB
16 bits Transfer	MOV	MOV S D	(S) → (D)	○	○
	MOVP	MOVP S D			
32 bits Transfer	DMOV	DMOV S D	(S+1,S) → (D+1,D)	○	○
	DMOVP	DMOVP S D			
Short Real Number Transfer	RMOV	RMOV S D	(S+1,S) → (D+1,D)	○	○
	RMOVP	RMOVP S D			
Long Real Number Transfer	LMOV	LMOV S D	(S+3,S+2,S+1,S) → (D+3,D+2,D+1,D)	○	○
	LMOVP	LMOVP S D			
4 bits Transfer	MOV4	MOV4 Sb Db		○	○
	MOV4P	MOV4P Sb Db			
8 bits Transfer	MOV8	MOV8 Sb Db		○	○
	MOV8P	MOV8P Sb Db			
1's complement Transfer	CMOV	CMOV S D	1's complement (S) → (D)	○	○
	CMOVP	CMOVP S D			
	DCMOV	DCMOV S D	1's complement (S+1,S) → (D+1,D)	○	○
	DCMOVP	DCMOVP S D			
16 bits Group Transfer	GMOV	GMOV S D N		○	○
	GMOVP	GMOVP S D N			
Multiple Transfer	FMOV	FMOV S D N		○	○
	FMOVP	FMOVP S D N			
Specified Bits Transfer	BMOV	BMOV S D N		○	○
	BMOVP	BMOVP S D N			
Specified Bits Group Transfer	GBMOV	GBMOV S D Z N		○	○
	GBMOVP	GBMOVP S D Z N		○	○

(1) Data Transfer Instruction (continued)

Classification	Designations	Symbol	Description	Support XGK	Support XGB
String Transfer	$MOV	$MOV S D	String started from (S) → String started from (D)	○	○
	$MOVP	$MOVP S D		○	○

(2) BCD/BIN conversion instruction

Classification	Designations	Symbol	Description	Support XGK	Support XGB
BCD Conversion	BCD	BCD S D	(S) $\xrightarrow{\text{To BCD}}$ (D) BIN(0~9999)	○	○
	BCDP	BCDP S D			
	DBCD	DBCD S D	(S+1,S) $\xrightarrow{\text{To BCD}}$ (D+1,D) BIN(0~99999999)	○	○
	DBCDP	DBCDP S D			
4/8 Bits BCD Conversion	BCD4	BCD4 Sb Db		○	○
	BCD4P	BCD4P Sb Db			
	BCD8	BCD8 Sb Db		○	○
	BCD8P	BCD8P Sb Db			
BIN Conversion	BIN	BIN S D	(S) $\xrightarrow{\text{To BIN}}$ (D) BCD(0~9999)	○	○
	BINP	BINP S D			
	DBIN	DBIN S D	(S+1,S) $\xrightarrow{\text{To BIN}}$ (D+1,D) BCD(0~99999999)	○	○
	DBINP	DBINP S D			
4/8 Bits BIN Conversion	BIN4	BIN4 Sb Db		○	○
	BIN4P	BIN4P Sb Db			
	BIN8	BIN8 Sb Db		○	○
	BIN8P	BIN8P Sb Db			
Group BCD,BIN Conversion	GBCD	GBCD S D N	Data (S) to N converted to BCD, and (D) to N saved	○	○
	GBCDP	GBCDP S D N			
	GBIN	GBIN S D N	Data (S) to N converted to BIN, and (D) to N saved	○	○
	GBINP	GBINP S D N			

(3) Data type conversion instruction

Classification	Designations	Symbol	Description	Support	
				XGK	XGB
16 Bits Integer/Real Conversion	I2R	I2R S D	(S) $\xrightarrow{\text{To Real}}$ (D+1,D) Int(-32768~32767)	○	○
	I2RP	I2RP S D			
	I2L	I2L S D	(S) $\xrightarrow{\text{To Long}}$ (D+3,D+2,D+1,D) Int(-32768~32767)	○	○
	I2LP	I2LP S D			
32 Bits Integer/Real Conversion	D2R	D2R S D	(S+1,S) $\xrightarrow{\text{To Real}}$ (D+1,D) Dint(-2147483648~2147483647)	○	○
	D2RP	D2RP S D			
	D2L	D2L S D	(S+1,S) $\xrightarrow{\text{To Long}}$ (D+3,D+2,D+1,D) Dint(-2147483648~2147483647)	○	○
	D2LP	D2LP S D			
Short Real/Integer Conversion	R2I	R2I S D	(S+1,S) $\xrightarrow{\text{To INT}}$ (D) Whole Sing Real Range	○	○
	R2IP	R2IP S D			
	R2D	R2D S D	(S+1,S) $\xrightarrow{\text{To DINT}}$ (D+1,D) Whole Sing Real Range	○	○
	R2DP	R2DP S D			
Long Real/Integer Conversion	L2I	L2I S D	(S+3,S+2,S+1,S) $\xrightarrow{\text{To INT}}$ (D) Whole Double Real Range	○	○
	L2IP	L2IP S D			
	L2D	L2D S D	(S+3,S+2,S+1,S) $\xrightarrow{\text{To DINT}}$ (D+1,D) Whole Double Real Range	○	○
	L2DP	L2DP S D			

Remark

Integer value and Real value will be saved respectively in quite different format. For such reason, Real Number Data should be converted as applicable before used for Integer Operation.

(4) Comparison instruction

Classification	Designations	Symbol	Description	Support	
				XGK	XGB
Unsigned Compare with Special Relay used	CMP	CMP S1 S2	CMP(S1,S2) and applicable Flag SET (S1, S2 is Word)	○	○
	CMPP	CMPP S1 S2			
	DCMP	DCMP S1 S2	CMP(S1,S2) and applicable Flag SET (S1, S2 is Double Word)	○	○
	DCMPP	DCMPP S1 S2			
4/8 Bits Compare	CMP4	CMP4 S1 S2	CMP(S1,S2) and applicable Flag SET (S1, S2 is Nibble)	○	○
	CMP4P	CMP4P S1 S2			
	CMP8	CMP8 S1 S2	CMP(S1,S2) and applicable Flag SET (S1, S2 is Byte)	○	○
	CMP8P	CMP8P S1 S2			
Table Compare	TCMP	TCMP S1 S2 D	CMP(S1,S2)) : CMP(S1+15,S2+15) Result:(D) ~ (D+15), 1 if identical	○	○
	TCMPP	TCMPP S1 S2 D			
	DTCMP	DTCMP S1 S2 D	CMP((S1+1,S1),(S2+1,S2)) : CMP((S1+31,S1+30),(S2+31,S2+30)) Result:(D) ~ (D+15)	○	○
	DTCMPP	DTCMPP S1 S2 D			
Group Compare (16 Bits)	GEQ	GEQ S1 S2 D N	Compares S1 data to S2 data word by word, and saves its result in Device (D) bit by bit from the lower bit (N ≤ 16)	○	○
	GEQP	GEQP S1 S2 D N			
	GGT	GGT S1 S2 D N			
	GGTP	GGTP S1 S2 D N			
	GLT	GLT S1 S2 D N			
	GLTP	GLTP S1 S2 D N			
	GGE	GGE S1 S2 D N			
	GGEP	GGEP S1 S2 D N			
	GLE	GLE S1 S2 D N			
	GLEP	GLEP S1 S2 D N			
	GNE	GNE S1 S2 D N			
	GNEP	GNEP S1 S2 D N			

Remark

CMP(P), DCMP(P), CMP4(P), CMP8(P), TCMP(P) & DTCMP(P) Instructions all process the results of Unsigned Compare. All the other Compare Instructions will perform Signed Compare.

4) Comparison instruction (continued)

Classification	Designations	Symbol	Description	Support	
				XGK	XGB
Group Compare (32 Bits)	GDEQ	GDEQ S1 S2 D N	Compares S1 data to S2 data 2 by 2 words, and saves its result in Device (D) bit by bit from the lower bit (N ≤ 16)	○	○
	GDEQP	GDEQP S1 S2 D N		○	○
	GDGT	GDGT S1 S2 D N		○	○
	GDGTP	GDGTP S1 S2 D N		○	○
	GDLT	GDLT S1 S2 D N		○	○
	GDLTP	GDLTP S1 S2 D N		○	○
	GDGE	GDGE S1 S2 D N		○	○
	GDGEP	GDGEP S1 S2 D N		○	○
	GDLE	GDLE S1 S2 D N		○	○
	GDLEP	GDLEP S1 S2 D N		○	○
	GDNE	GDNE S1 S2 D N		○	○
	GDNEP	GDNEP S1 S2 D N		○	○

(4) Comparison instruction (continued)

Classification	Designations	Symbol	Description	Support	
				XGK	XGB
16 Bits Data Compare (LOAD)	LOAD=	= S1 S2	Compares (S1) to (S2), and saves its result in Bit Result(BR) (Signed Operation)	○	○
	LOAD>	> S1 S2			
	LOAD<	< S1 S2			
	LOAD>=	>= S1 S2			
	LOAD<=	<= S1 S2			
	LOAD<>	<> S1 S2			
16 Bits Data Compare (AND)	AND=	= S1 S2	Performs AND operation of (S1) & (S2) Compare Result and Bit Result (BR), and then saves its result in BR (Signed Operation)	○	○
	AND>	> S1 S2			
	AND<	< S1 S2			
	AND>=	>= S1 S2			
	AND<=	<= S1 S2			
	AND<>	<> S1 S2			
16 Bits Data Compare (OR)	OR=	= S1 S2	Performs OR operation of (S1) & (S2) Compare Result and Bit Result (BR), and then saves its result in BR (Signed Operation)	○ ○	○ ○
	OR<=	<= S1 S2			
	OR<>	<> S1 S2			
32 Bits Data Compare (LOAD)	LOADD=	D= S1 S2	Compares (S1) to (S2), and saves its result in Bit Result(BR) (Signed Operation)		
	LOADD>	D> S1 S2			
	LOADD<	D< S1 S2			
	LOADD>=	D>= S1 S2			
	LOADD<=	D<= S1 S2			
	LOADD<>	D<> S1 S2			

Remark

Comparison instruction for input process the result of Signed comparison instruction generally. To process Unsigned comparison, Use comparison instruction for input.

(4) Comparison instruction (continued)

Classification	Designations	Symbol	Description	Support XGK	Support XGB
32 Bits Data Compare (AND)	ANDD=	D= S1 S2	Performs AND operation of (S1) & (S2) Compare Result and Bit Result (BR), and then saves its result in BR (Signed Operation)	○	○
	ANDD>	D> S1 S2			
	ANDD<	D< S1 S2			
	ANDD>=	D>= S1 S2			
	ANDD<=	D<= S1 S2			
	ANDD<>	D<> S1 S2			
32bt Data Compare (OR)	ORD=	D= S1 S2	Performs OR operation of (S1) & (S2) Compare Result and Bit Result (BR), and then saves its result in BR (Signed Operation)	○	○
	ORD>	D> S1 S2			
	ORD<	D< S1 S2			
	ORD>=	D>= S1 S2			
	ORD<=	D<= S1 S2			
	ORD<>	D<> S1 S2			
Short Real Number Compare (LOAD)	LOADR=	R= S1 S2	Performs OR operation of (S1) & (S2) Compare Result and Bit Result (BR), and then saves its result in BR (Signed Operation)	○	○
	LOADR>	R> S1 S2			
	LOADR<	R< S1 S2			
	LOADR>=	R>= S1 S2			
	LOADR<=	R<= S1 S2			
	LOADR<>	R<> S1 S2			
Short Real Number Compare (AND)	ANDR=	R= S1 S2	Compares (S1+1,S) to (S2+1,S2) and saves its result in Bit Result (BR) (Signed Operation)	○	○
	ANDR>	R> S1 S2			
	ANDR<	R< S1 S2			
	ANDR>=	R>= S1 S2			
	ANDR<=	R<= S1 S2			
	ANDR<>	R<> S1 S2			

(4) Comparison instruction (continued)

Classification	Designations	Symbol	Description	Support	
				XGK	XGB
Real Number Compare (OR)	ORR=	R= S1 S2	Compares (S1+1,S1) to (S2+1,S2) and saves its result in Bit Result (BR) (Signed Operation)	○	○
	ORR>	R> S1 S2			
	ORR<	R< S1 S2			
	ORR>=	R>= S1 S2			
	ORR<=	R<= S1 S2			
	ORR<>	R<> S1 S2			
Long Real Number Compare (LOAD)	LOADL=	L= S1 S2	Compares (S1+3,S1+2,S1+1,S) to (S2+3,S2+2, S2+1,S2) and saves its result in Bit Result(BR) (Signed Operation)	○	○
	LOADL>	L> S1 S2			
	LOADL<	L< S1 S2			
	LOADL>=	L>= S1 S2			
	LOADL<=	L<= S1 S2			
	LOADL<>	L<> S1 S2			
Long Real Number Compare (AND)	ANDL=	L= S1 S2	Performs AND operation of (S1+1,S1) & (S2+1,S2) Compare Result and Bit Result(BR), and then saves its result in BR (Signed Operation)	○	○
	ANDL>	L> S1 S2			
	ANDL<	L< S1 S2			
	ANDL>=	L>= S1 S2			
	ANDL<=	L<= S1 S2			
	ANDL<>	L<> S1 S2			

(4) Comparison instruction (continued)

Classification	Designations	Symbol	Description	Support XGK	Support XGB
Double Real Number Compare (OR)	ORL=	L= S1 S2	Performs OR operation of (S1 +1,S1) & (S2+1,S2) Compare Result and Bit Result(BR), and then saves its result in BR (Signed Operation)	○	○
	ORL>	L> S1 S2			
	ORL<	L< S1 S2			
	ORL>=	L>= S1 S2			
	ORL<=	L<= S1 S2			
	ORL<>	L<> S1 S2			
String Compare (LOAD)	LOAD$=	$= S1 S2	Compares (S1) to (S2) Starting String and saves its result in Bit Result(BR)	○	○
	LOAD$>	$> S1 S2			
	LOAD$<	$< S1 S2			
	LOAD$>=	$>= S1 S2			
	LOAD$<=	$<= S1 S2			
	LOAD$<>	$<> S1 S2			
String Compare (AND)	AND$=	$= S1 S2	Performs AND operation of (S 1) & (S2) Starting String Compare Result and Bit Result(BR), and then saves its result in BR	○	○
	AND$>	$> S1 S2			
	AND$<	$< S1 S2			
	AND$>=	$>= S1 S2			
	AND$<=	$<= S1 S2			
	AND$<>	$<> S1 S2			

(4) Comparison instruction (continued)

Classification	Designations	Symbol	Description	Support	
				XGK	XGB
String Compare (OR)	OR$=	$= S1 S2	Performs OR operation of (S1) & (S2) Starting String Compare Result and Bit Result(BR), and then saves its result in BR	○	○
	OR$>	$> S1 S2			
	OR$<	$< S1 S2			
	OR$>=	$>= S1 S2			
	OR$<=	$<= S1 S2			
	OR$<>	$<> S1 S2			
16 Bits Data Group Compare (LOAD)	LOADG=	G= S1 S2 N	Compares (S1), (S1+1), ⋯, (S1+N) to (S2), (S2+1), ⋯ , (S2+N) 1 to 1, and then saves 1 in Bit Result(BR) if each value compared meets given condition	○	○
	LOADG>	G> S1 S2 N			
	LOADG<	G< S1 S2 N			
	LOADG>=	G>= S1 S2 N			
	LOADG<=	G<= S1 S2 N			
	LOADG<>	G<> S1 S2 N			
16 Bits Data Group Compare (AND)	ANDG=	G= S1 S1 N	Performs AND operation of (S1), (S1+1), ⋯, (S1+N) & (S2), (S2+1), ⋯ , (S2+N) 1 to 1 Compare Result and Bit Result (BR), and then saves its result in BR	○	○
	ANDG>	G> S1 S1 N			
	ANDG<	G< S1 S1 N			
	ANDG>=	G>= S1 S1 N			
	ANDG<=	G<= S1 S1 N			
	ANDG<>	G<> S1 S1 N			
16 Bits Data Group Compare (OR)	ORG=	G= S1 S2 N	Performs OR operation of (S1), (S1+1), ⋯, (S1+N) & (S2), (S2+1), ⋯ , (S2+N) 1 to 1 Compare Result and Bit Result (BR), and then saves its result in BR	○	○
	ORG>	G> S1 S2 N			
	ORG<	G< S1 S2 N			
	ORG>=	G>= S1 S2 N			
	ORG<=	G<= S1 S2 N			
	ORG<>	G<> S1 S2 N			

(4) Comparison instruction (continued)

Classification	Designations	Symbol	Description	Support XGX	Support XGB
32 Bits Data Group Compare (LOAD)	LOADDG=	DG= S1 S2 N	Compares (S1), (S1+1), ⋯, (S1+N) to (S2), (S2+1), ⋯ , (S2+N) 1 to 1, and then saves 1 in Bit Result(BR) if each value compared meets given condition	○	○
	LOADDG>	DG> S1 S2 N			
	LOADDG<	DG< S1 S2 N			
	LOADDG>=	DG>= S1 S2 N			
	LOADDG<=	DG<= S1 S2 N			
	LOADDG<>	DG<> S1 S2 N			
32 Bits Data Group Compare (AND)	ANDDG=	DG= S1 S1 N	Performs AND operation of (S1), (S1+1), ⋯, (S1+N) & (S2), (S2+1), ⋯ , (S2+N) 1 to 1 Compare Result and Bit Result(BR), and then saves its result in BR	○	○
	ANDDG>	DG> S1 S1 N			
	ANDDG<	DG< S1 S1 N			
	ANDDG>=	DG>= S1 S1 N			
	ANDDG<=	DG<= S1 S1 N			
	ANDDG<>	DG<> S1 S1 N			
32 Bits Data Group Compare (OR)	ORDG=	DG= S1 S2 N	Performs OR operation of (S1), (S1+1), ⋯, (S1+N) & (S2), (S2+1), ⋯ , (S2+N) 1 to 1 Compare Result and Bit Result(BR), and then saves its result in BR	○	○
	ORDG>	DG> S1 S2 N			
	ORDG<	DG< S1 S2 N			
	ORDG>=	DG>= S1 S2 N			
	ORDG<=	DG<= S1 S2 N			
	ORDG<>	DG<> S1 S2 N			

(4) Comparison instruction (continued)

Classification	Designations	Symbol	Description	Support	
				XGK	XGB
Three 16-Bit Data Compare (LOAD)	LOAD3=	3= S1 S2 S3	Saves 1 in Bit Result(BR) if each value of (S1), (S2), (S3) meets given condition	○	○
	LOAD3>	3> S1 S2 S3			
	LOAD3<	3< S1 S2 S3			
	LOAD3>=	3>= S1 S2 S3			
	LOAD3<=	3<= S1 S2 S3			
	LOAD3<>	3<> S1 S2 S3			
Three 16-Bit Data Compare (AND)	AND3=	3= S1 S2 S3	Performs AND operation of (S1), (S2), (S3) Compare Result by given condition and Bit Result (BR), and then saves its result in BR	○	○
	AND3>	3> S1 S2 S3			
	AND3<	3< S1 S2 S3			
	AND3>=	3>= S1 S2 S3			
	AND3<=	3<= S1 S2 S3			
	AND3<>	3<> S1 S2 S3			
Three 32-Bit Data Compare (OR)	OR3=	3= S1 S2 S3	Performs OR operation of (S1), (S2), (S3) Compare Result by given condition and Bit Result (BR), and then saves its result in BR	○	○
	OR3>	3> S1 S2 S3			
	OR3<	<3 S1 S2 S3			
	OR3>=	>=3 S1 S2 S3			
	OR3<=	3<= S1 S2 S3			
	OR3<>	3<> S1 S2 S3			
Three 16-Bit Data Compare (LOAD)	LOADD3=	D3= S1 S2 S3	Saves 1 in Bit Result(BR) if each value of (S1+1,S1), (S2+ 1,S2), (S3+1,S3) meets given condition	○	○
	LOADD3>	D3> S1 S2 S3			
	LOADD3<	D3< S1 S2 S3			
	LOADD3>=	D3>= S1 S2 S3			
	LOADD3<=	D3<= S1 S2 S3			
	LOADD3<>	D3<> S1 S2 S3			

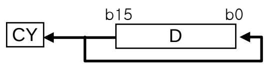
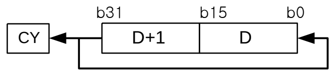
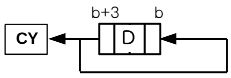
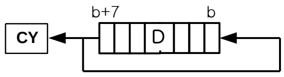
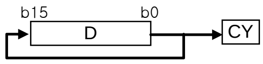
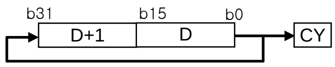
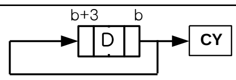
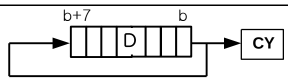
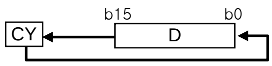
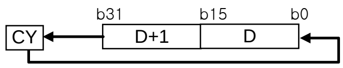
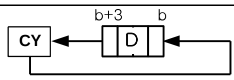
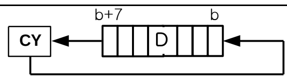
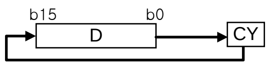
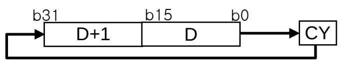
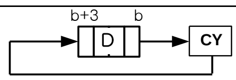
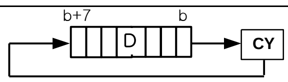
(4) Comparison instruction (continued)

Classification	Designations	Symbol	Description	Support	
				XGK	XGB
Three 32-Bit Data Compare (AND)	ANDD3=	D3= S1 S2 S3	Performs AND operation of (S1+1,S1), (S2+1,S2), (S3+1,S3) Compare Result by given condition and Bit Result (BR), and then saves its result in BR	○	○
	ANDD3>	D3> S1 S2 S3			
	ANDD3<	D3< S1 S2 S3			
	ANDD3>=	D3>= S1 S2 S3			
	ANDD3<=	D3<= S1 S2 S3			
	ANDD<>	D3<> S1 S2 S3			
Three 32-Bit Data Compare (OR)	ORD3=	D3= S1 S2 S3	Performs OR operation of (S1+1, S1), (S2+1,S2), (S3+1,S3) Compare Result by given condition and Bit Result (BR), and then saves its result in BR	○	○
	ORD3>	D3> S1 S2 S3			
	ORD3<	D3< S1 S2 S3			
	ORD3>=	D3>= S1 S2 S3			
	ORD3<=	D3<= S1 S2 S3			
	ORD3<>	D3<> S1 S2 S3			

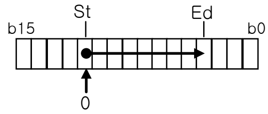
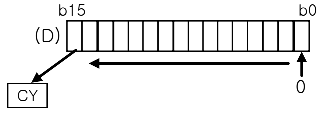
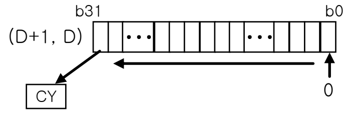
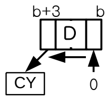
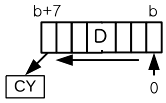
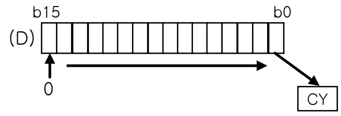
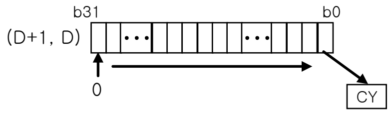
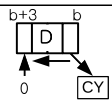
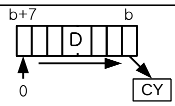
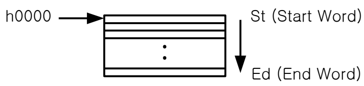
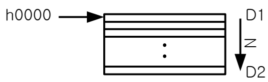
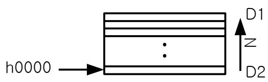
(5) Increase/Decrease instruction

Classification	Designations	Symbol	Description	Support XGK	Support XGB
BIN Data Increase / Decrease (Signed)	INC	INC D	(D)+1 → (D)	2	4-94
	INCP	INCP D			
	DINC	DINC D	(D+1,D)+1 → (D+1,D)	2	
	DINCP	DINCP D			
	DEC	DEC D	(D)−1 → (D)	2	4-96
	DECP	DECP D			
	DDEC	DDEC D	(D+1,D)−1 → (D+1,D)	2	
	DDECP	DDECP D			
4/8 Bits Data Increase / Decrease (Signed)	INC4	INC4 Db	(D:x bit ~ D:x bit+4) + 1 → (D:x bit ~ D:x bit+4)	2	4-95
	INC4P	INC4P Db		3	
	INC8	INC8 Db	(D:x bit ~ D:x bit+8) + 1 → (D:x bit ~ D:x bit+8)	2	
	INC8P	INC8P Db		3	
	DEC4	DEC4 Db	(D:x bit ~ D:x bit+4) − 1 → (D:x bit ~ D:x bit+4)	2	4-97
	DEC4P	DEC4P Db		3	
	DEC8	DEC8 Db	(D:x bit ~ D:x bit+8) − 1 → (D:x bit ~ D:x bit+8)	2	
	DEC8P	DEC8P Db		3	
BIN Data Increase / Decrease (Unsigned)	INCU	INCU D	(D)+1 → (D)	2	4-98
	INCUP	INCUP D			
	DINCU	DINCU D	(D+1,D)+1 → (D+1,D)	2	
	DINCUP	DINCUP D			
	DECU	DECU D	(D)−1 → (D)	2	4-99
	DECUP	DECUP D			
	DDECU	DDECU D	(D+1,D)−1 → (D+1,D)	2	
	DDECUP	DDECUP D			

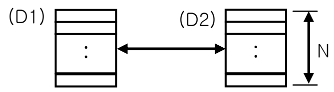
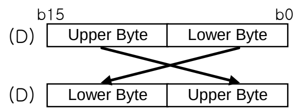
(6) Rotation instruction

Classification	Designations	Symbol	Description	Support XGK	Support XGB
Rotate to Left	ROL	ROL D n		○	○
	ROLP	ROLP D n			
	DROL	DROL D n			
	DROLP	DROLP D n			
4/8 Bits Rotate to Left	ROL4	ROL4 Db n		○	○
	ROL4P	ROL4P Db n			
	ROL8	ROL8 Db n			
	ROL8P	ROL8P Db n			
Rotate to Right	ROR	ROR D n		○	○
	RORP	RORP D n			
	DROR	DROR D n			
	DRORP	DRORP D n			
4/8 Bits Rotate to Right	ROR4	ROR4 Db n		○	○
	ROR4P	ROR4P Db n			
	ROR8	ROR8 Db n			
	ROR8P	ROR8P Db n			
Rotate to Left (including Carry)	RCL	RCL D n		○	○
	RCLP	RCLP D n			
	DRCL	DRCL D n			
	DRCLP	DRCLP D n			
4/8 Bits Rotate to Left (including Carry)	RCL4	RCL4 Db n		○	○
	RCL4P	RCL4P Db n			
	RCL8	RCL8 Db n			
	RCL8P	RCL8P Db n			
Rotate to Right (including Carry)	RCR	RCR D n		○	○
	RCRP	RCRP D n			
	DRCR	DRCR D n			
	DRCRP	DRCRP D n			
4/8 Bits Rotate to Right (including Carry)	RCR4	RCR4 Db n		○	○
	RCR4P	RCR4P Db n			
	RCR8	RCR8 Db n			
	RCR8P	RCR8P Db n			

(7) Move instruction

Classification	Designations	Symbol	Description	Support	
				XGK	XGB
Bits Move	BSFT	BSFT | St | Ed		○	○
	BSFTP	BSFTP | St | Ed			
Move to Higher Bit	BSFL	BSFL | D | n		○	○
	BSFLP	BSFLP | D | n			
	DBSFL	DBSFL | D | n			
	DBSFLP	DBSFLP | D | n			
Move to Higher Bit within 4/8 Bits range	BSFL4	BSFL4 | Db | n		○	○
	BSFL4P	BSFL4P | Db | n			
	BSFL8	BSFL8 | Db | n			
	BSFL8P	BSFL8P | Db | n			
Move to Lower Bit	BSFR	BSFR | D | n		○	○
	BSFRP	BSFRP | D | n			
	DBSFR	DBSFR | D | n			
	DBSFRP	DBSFRP | D | n			
Move to Lower Bit within 4/8 Bits range	BSFR4	BSFR4 | Db | n		○	○
	BSFR4P	BSFR4P | Db | n			
	BSFR8	BSFR8 | Db | n			
	BSFR8P	BSFR8P | Db | n			
Word Move	WSFT	WSFT | Et | Ed		○	○
	WSFTP	WSFTP | Et | Ed			
Word Data Move to Left/Right	WSFL	WSFL | D1 | D2 | N		○	○
	WSFLP	WSFLP | D1 | D2 | N			
	WSFR	WSFR | D1 | D2 | N			
	WSFRP	WSFRP | D1 | D2 | N			
Bit Move	SR	SR | Db | I | D | N	Moves N bits starting from Db bit along Input direction (I) and Move direction (D)	○	○

(8) Exchange instruction

Classification	Designations	Symbol	Description	Support XGK	Support XGB
Data Exchange	XCHG	XCHG D1 D2	(D1) ↔ (D2)	○	○
	XCHGP	XCHGP D1 D2			
	DXCHG	DXCHG D1 D2	(D1+1, D1) ↔ (D2+1, D2)		
	DXCHGP	DXCHGP D1 D2			
Group Data Exchange	GXCHG	GXCHG D1 D2 N		○	○
	GXCHGP	GXCHGP D1 D2 N			
Higher/Lower Byte Exchange	SWAP	SWAP D		○	○
	SWAPP	SWAPP D			
Group Byte Exchange	GSWAP	GSWAP D N	Exchanges Higher/Lower Byte of Words N starting from D	○	○
	GSWAPP	GSWAPP D N			

(9) BIN operation instruction

Classification	Designations	Symbol	Description	Support	
				XGK	XGB
Integer Addition (Signed)	ADD	ADD S1 S2 D	(S1)+(S2) → (D)	○	○
	ADDP	ADDP S1 S2 D			
	DADD	DADD S1 S2 D	(S1+1,S1)+(S2+1,S2) → (D+1,D)		
	DADDP	DADDP S1 S2 D			
Integer Subtraction (Signed)	SUB	SUB S1 S2 D	(S1)−(S2) → (D)	○	○
	SUBP	SUBP S1 S2 D			
	DSUB	DSUB S1 S2 D	(S1+1,S1)−(S2+1,S2) → (D+1,D)		
	DSUBP	DSUBP S1 S2 D			
Integer Multiplication (Signed)	MUL	MUL S1 S2 D	(S1)×(S2) → (D+1,D)	○	○
	MULP	MULP S1 S2 D			
	DMUL	DMUL S1 S2 D	(S1+1,S1)×(S2+1,S2) → (D+3,D+2,D+1,D)		
	DMULP	DMULP S1 S2 D			
Integer Division (Signed)	DIV	DIV S1 S2 D	(S1)÷(S2) → (D) Quotient, (D+1) Remainder	○	○
	DIVP	DIVP S1 S2 D			
	DDIV	DDIV S1 S2 D	(S1+1,S1)÷(S2+1,S2) → (D+1,D) Quotient, (D+3,D+2) Remainder		
	DDIVP	DDIVP S1 S2 D			
Integer Addition (Unsigned)	ADDU	ADDU S1 S2 D	(S1)+(S2) → (D)	○	○
	ADDUP	ADDUP S1 S2 D			
	DADDU	DADDU S1 S2 D	(S1+1,S1)+(S2+1,S2) → (D+1,D)		
	DADDUP	DADDUP S1 S2 D			
Integer Subtraction (Unsigned)	SUBU	SUBU S1 S2 D	(S1)−(S2) → (D)	○	○
	SUBUP	SUBUP S1 S2 D			
	DSUBU	DSUBU S1 S2 D	(S1+1,S1)−(S2+1,S2) → (D+1,D)		
	DSUBUP	DSUBUP S1 S2 D			
Integer Multiplication (Unsigned)	MULU	MULU S1 S2 D	(S1)×(S2) → (D+1,D)	○	○
	MULUP	MULUP S1 S2 D			
	DMULU	DMULU S1 S2 D	(S1+1,S1)×(S2+1,S2) → (D+3,D+2,D+1,D)		
	DMULUP	DMULUP S1 S2 D			

(9) BIN operation instruction (continued)

Classification	Designations	Symbol	Description	Support XGK	Support XGB
Integer Division (Unsigned)	DIVU	DIVU S1 S2 D	(S1)÷(S2) → (D) Quotient, (D+1) Remainder	○	○
	DIVUP	DIVUP S1 S2 D			
	DDIVU	DDIVU S1 S2 D	(S1+1,S1)÷(S2+1,S2) → (D+1,D) Quotient, (D+3,D+2) Remainder		
	DDIVUP	DDIVUP S1 S2 D			
Real Number Addition	RADD	RADD S1 S2 D	(S1+1,S1)+(S2+1,S2) → (D+1,D)	○	○
	RADDP	RADDP S1 S2 D			
	LADD	LADD S1 S2 D	(S1+3,S1+2,S1+1,S1) +(S2+3,S2+2,S2+1,S2) → (D+3,D+2,D+1,D)		
	LADDP	LADDP S1 S2 D			
Real Number Subtraction	RSUB	RSUB S1 S2 D	(S1+1,S1)−(S2+1,S2) → (D+1,D)	○	○
	RSUBP	RSUBP S1 S2 D			
	LSUB	LSUB S1 S2 D	(S1+3,S1+2,S1+1,S1) −(S2+3,S2+2,S2+1,S2) → (D+3,D+2,D+1,D)		
	LSUBP	LSUBP S1 S2 D			
Real Number Multiplication	RMUL	RMUL S1 S2 D	(S1+1,S1)×(S2+1,S2) → (D+1,D)	○	○
	RMULP	RMULP S1 S2 D			
	LMUL	LMUL S1 S2 D	(S1+3,S1+2,S1+1,S1) ×(S2+3,S2+2,S2+1,S2) → (D+3,D+2,D+1,D)		
	LMULP	LMULP S1 S2 D			
Real Number Division	RDIV	RDIV S1 S2 D	(S1+1,S1)÷(S2+1,S2) → (D+1,D)	○	○
	RDIVP	RDIVP S1 S2 D			
	LDIV	LDIV S1 S2 D	(S1+3,S1+2,S1+1,S1) ÷(S2+3,S2+2,S2+1,S2) → (D+3,D+2,D+1,D)		
	LDIVP	LDIVP S1 S2 D			
String Addition	$ADD	$ADD S1 S2 D	Connects S1 String with S2 String to save in D	○	○
	$ADDP	$ADDP S1 S2 D			
Group Addition	GADD	GADD S1 S2 D N	(S1) + (S2) = (D), N	○	○
	GADDP	GADDP S1 S2 D N			
Group Subtraction	GSUB	GSUB S1 S2 D N	(S1) − (S2) = (D), N	○	○
	GSUBP	GSUBP S1 S2 D N			

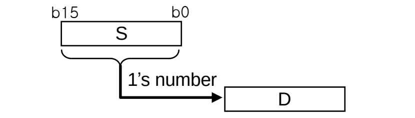
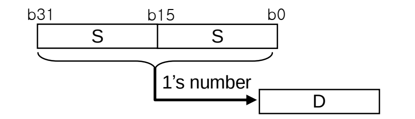
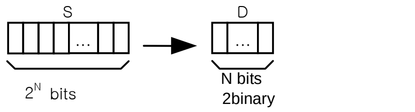
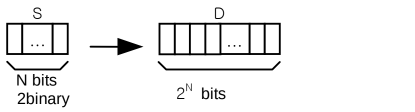
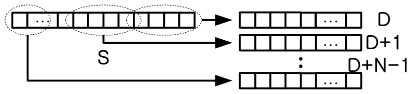
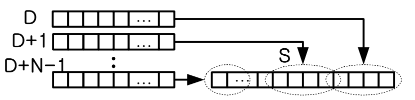
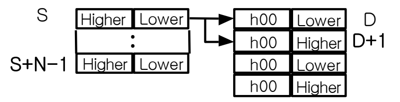
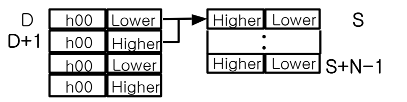
(10) BCD operation instruction

Classification	Designations	Symbol	Description	Support XGK	Support XGB
BCD Addition	ADDB	ADDB S1 S2 D	(S1)+(S2) → (D)	○	○
	ADDBP	ADDBP S1 S2 D			
	DADDB	DADDB S1 S2 D	(S1+1,S1)+(S2+1,S2) → (D+1,D)		
	DADDBP	DADDBP S1 S2 D			
BCD Subtraction	SUBB	SUBB S1 S2 D	(S1)−(S2) → (D)	○	○
	SUBBP	SUBBP S1 S2 D			
	DSUBB	DSUBB S1 S2 D	(S1+1,S1)−(S2+1,S2) → (D+1,D)		
	DSUBBP	DSUBBP S1 S2 D			
BCD Multiplication	MULB	MULB S1 S2 D	(S1)×(S2) → (D+1,D)	○	○
	MULBP	MULBP S1 S2 D			
	DMULB	DMULB S1 S2 D	(S1+1,S1)×(S2+1,S2) → (D+3,D+2,D+1,D)		
	DMULBP	DMULBP S1 S2 D			
BCD Division	DIVB	DIVB S1 S2 D	(S1)÷(S2) → (D) Quotient, (D+1) Remainder	○	○
	DIVBP	DIVBP S1 S2 D			
	DDIVB	DDIVB S1 S2 D	(S1+1,S1)÷(S2+1,S2) → (D+1,D) Quotient, (D+3,D+2) Remainder		
	DDIVBP	DDIVBP S1 S2 D			

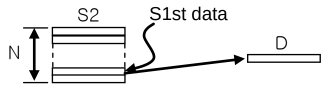
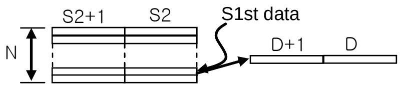
(11) Logic operation instruction

Classification	Designations	Symbol	Description	Basic Steps	Page
Logic Multiplication	WAND	WAND S1 S2 D	Word AND (S1) ∧ (S2) → (D)	○	○
	WANDP	WANDP S1 S2 D			
	DWAND	DWAND S1 S2 D	DWord AND (S1+1,S1) ∧ (S2+1,S2) → (D+1,D)		
	DWANDP	DWANDP S1 S2 D			
Logic Addition	WOR	WOR S1 S2 D	Word OR (S1) ∨ (S2) → (D)	○	○
	WORP	WORP S1 S2 D			
	DWOR	DWOR S1 S2 D	DWord OR (S1+1,S1) ∨ (S2+1,S2) → (D+1,D)		
	DWORP	DWORP S1 S2 D			
Exclusive OR	WXOR	WXOR S1 S2 D	Word Exclusive OR (S1) ⊻ (S2) → (D)	○	○
	WXORP	WXORP S1 S2 D			
	DWXOR	DWXOR S1 S2 D	DWord Exclusive OR (S1+1,S1) ⊻ (S2+1,S2) → (D+1,D)		
	DWXORP	DWXORP S1 S2 D			
Exclusive NOR	WXNR	WXNR S1 S2 D	Word Exclusive NOR $\overline{(S1) ⊻ (S2)}$ → (D)	○	○
	WXNRP	WXNRP S1 S2 D			
	DWXNR	DWXNR S1 S2 D	DWord Exclusive NOR $\overline{(S1+1,S1) ⊻ (S2+1,S2)}$ → (D+1,D)		
	DWXNRP	DWXNRP S1 S2 D			
Group Logic Operation	GWAND	GWAND S1 S2 D N	(S1) ∧ (S2) = (D), N	○	○
	GWANDP	GWANDP S1 S2 D N			
	GWOR	GWOR S1 S2 D N	(S1) ∨ (S2) = (D), N	○	○
	GWORP	GWORP S1 S2 D N			
	GWXOR	GWXOR S1 S2 D N	(S1) ⊻ (S2) = (D), N	○	○
	GWXORP	GWXORP S1 S2 D N			
	GWXNR	GWXNR S1 S2 D N	$\overline{(S1) ⊻ (S2)}$ = (D), N	○	○
	GWXNRP	GWXNRP S1 S2 D N			

(12) Data process instruction

Classification	Designations	Symbol	Description	Support XGK	Support XGB
Bit Check	BSUM	BSUM S D		○	○
	BSUMP	BSUMP S D			
	DBSUM	DBSUM S D			
	DBSUMP	DBSUMP S D			
Bit Reset	BRST	BRST D N	Resets N Bits (starting from D) to 0	○	○
	BRSTP	BRSTP D N			
Encode	ENCO	ENCO S D n		○	○
	ENCOP	ENCOP S D n			
Decode	DECO	DECO S D n		○	○
	DECOP	DECOP S D n			
Data Disconnect & Connect	DIS	DIS S D n		○	○
	DISP	DISP S D n			
	UNI	UNI S D n			
	UNIP	UNIP S D n			
Word/ Byte Conversion	WTOB	WTOB S D n		○	○
	WTOBP	WTOBP S D n			
	BTOW	BTOW S D n			
	BTOWP	BTOWP S D n			
I/O Refresh	IORF	IORF S1 S2 S3	Right after masking I/O data (located on S1) with S2 and S3 data, perform process	○	○
	IORFP	IORFP S1 S2 S3			
Data Search	SCH	SCH S1 S2 D N	Finds S1 value within S2 ~ N range and saves the first identical valued position in D and S1's identical valued total number in D+1	○	○
	SCHP	SCHP S1 S2 D N			
	DSCH	DSCH S1 S2 D N			
	DSCHP	DSCHP S1 S2 D N			
Max. Value Search	MAX	MAX S D n	Saves the max value in D among N words starting from S	○	○
	MAXP	MAXP S D n			
	DMAX	DMAX S D n	Saves the max value in D among N double words starting from S		
	DMAXP	DMAXP S D n			

(12) Data process instruction (continued)

Classification	Designations	Symbol	Description	Support XGK	Support XGB
Min. Value Search	MIN	MIN S D n	Saves the min value in D among N words starting from S	○	○
	MINP	MINP S D n			
	DMIN	DMIN S D n	Saves the min value in D among N double words starting from S		
	DMINP	DMINP S D n			
Sum	SUM	SUM S D n	Adds up N words starting from S to save in D	○	○
	SUMP	SUMP S D n			
	DSUM	DSUM S D n	Adds up N double words starting from S to save in D		
	DSUMP	DSUMP S D n			
Average	AVE	AVE S D n	Averages N words starting from S to save in D	○	○
	AVEP	AVEP S D n			
	DAVE	DAVE S D n	Averages N double words starting from S to save in D		
	DAVEP	DAVEP S D n			
MUX	MUX	MUX S1 S2 D N		○	○
	MUXP	MUXP S1 S2 D N			
	DMUX	DMUX S1 S2 D N			
	DMUXP	DMUXP S1 S2 D N			
Data Detect	DETECT	DETECT S1 S2 D N	Detects N data from S1, to save the first value larger than S2 in D, and the extra number in D+1	○	○
	DETECTP	DETECTP S1 S2 D N			
Ramp Signal Output	RAMP	RAMP n1 n2 D1 n3 D2	Saves linear-changed value in D1 during n3 scanning of initial value n1 to final n2 and present scanning number in D1+1, and changes D2 value to ON after completed	○	○
Data Align	SORT	SORT S n1 n2 D1 D2	S : Head Address of Sort Data n1 : Number of Words to sort n1+1 : Sorting Method n2: Operation number per Scan D1 : ON if complete D2 : Auxiliary Area	○	○
	SORTP	SORTP S n1 n2 D1 D2			

(13) Data table process instruction

Classification	Designations	Symbol	Description	Support	
				XGK	XGB
Data Write	FIWR	FIWR S D	Adds S to the last of Data Table D ~ D+N, and increases Data Table Length(N) saved in D by 1	○	○
	FIWRP	FIWRP S D			
First-input Data Read	FIFRD	FIFRD S D	Moves first data, S+1 of Data Table S ~ S+N to D (pull 1 place after origin deleted) and decreases Data Table Length(N) saved in D by 1 S	○	○
	FIFRDP	FIFRDP S D			
Last-Input Data Read	FILRD	FILRD S D	Moves last data, S+N of Data Table S ~ S+N to D (origin deleted) and decreases Data Table Length(N) saved in D by 1 S	○	○
	FILRDP	FILRDP S D			
Data Insert	FIINS	FINS S D n	Adds S to 'N'th place of Data Table D ~ D+N (origin data pulled by 1), and increases Data Table Length(N) saved in D by 1	○	○
	FIINSP	FINSP S D n			
Data Pull	FIDEL	FDEL S D n	Deletes 'N'th data of Data Table S ~ S+N (pull 1 place) and decreases Data Table Length(N) saved in D by 1	○	○
	FIDELP	FDELP S D n			

(14) Display instruction

Classification	Designations	Symbol	Description	Support	
				XGK	XGB
7 Segment Display	SEG	SEG S D Z	Converts S Data to 7-Segment as adjusted in Z Format so to save in D	○	○
	SEGP	SEGP S D Z			

(15) String Process instruction

Classification	Designations	Symbol	Description	Support XGK	Support XGB
Convert to Decimal ASCII Cord	BINDA	BINDA S D	Converts S of 1-word BIN value to Decimal ASCII Cord to save in starting D	○	○
	BINDAP	BINDAP S D			
	DBINDA	DBINDA S D	Converts S of 2-word BIN value to Decimal ASCII Cord to save in starting D		
	DBINDAP	DBINDAP S D			
Convert to Hexadecimal ASCII Cord	BINHA	BINHA S D	Converts S of 1-word BIN value to Hexadecimal ASCII Cord to save in starting D	○	○
	BINHAP	BINHAP S D			
	DBINHA	DBINHA S D	Converts S of 2-word BIN value to Hexadecimal ASCII Cord to save in starting D		
	DBINHAP	DBINHAP S D			
Convert BCD to Decimal ASCII Cord	BCDDA	BCDDA S D	Converts S of 1-word BCD to ASCII Cord to save in starting D	○	○
	BCDDAP	BCDDAP S D			
	DBCDDA	DBCDDA S D	Converts S of 2-word BCD to ASCII Cord to save in starting D		
	DBCDDAP	DBCDDAP S D			
Convert Decimal ASCII to BIN	DABIN	DABIN S D	Converts S S+2,S+1,S's Decimal ASCII Cord to BIN to save in D	○	○
	DABINP	DABINP S D			
	DDABIN	DDABIN S D	Converts S+5~S's Decimal ASCII Cord to BIN value to save in D+1 & D		
	DDABINP	DDABINP S D			
Convert Hexadecimal ASCII to BIN	HABIN	HABIN S D	Converts S+1,S's Hexadecimal ASCII Cord to BIN value to save in D	○	○
	HABINP	HABINP S D			
	DHABIN	DHABIN S D	Converts S+3~S's Hexadecimal ASCII Cord to BIN to save in D		
	DHABINP	DHABINP S D			
Convert Decimal ASCII to BCD	DABCD	DABCD S D	Converts S+1,S's Decimal ASCII Cord to BCD to save in D	○	○
	DABCDP	DABCDP S D			
	DDABCD	DDABCD S D	Converts S+3~S's Decimal ASCII Cord to BCD to save in D		
	DDABCDP	DDABCDP S D			
String Length Detect	LEN	LEN S D	Saves String Length with S starting in D	○	○
	LENP	LENP S D			

(15) String process instruction (continued)

Classification	Designations	Symbol	Description	Support XGK	Support XGB
Convert BIN16/32 to String	STR	STR S1 S2 D	Adjusts S2 saved word data to S1 saved place number to convert to String and save in D	○	○
	STRP	STRP S1 S2 D			
	DSTR	DSTR S1 S2 D	Adjusts S2 saved double word data to S1 saved place number to convert to String and save in D		
	DSTRP	DSTRP S1 S2 D			
Convert String to BIN16/32	VAL	VAL S D1 D2	Adjusts S saved string to number to save in word D1 and saves the place number in D2	○	○
	VALP	VALP S D1 D2			
	DVAL	DVAL S D1 D2	Adjusts S saved string to number to save in double word D1 and saves the place number in D2		
	DVALP	DVALP S D1 D2			
Convert Real Number to String	RSTR	RSTR S1 S2 D	Adjusts Floating decimal point point Real Number Data (S1: number, S2: places) to String format to save in D	○	X
	RSTRP	RSTRP S1 S2 D			
	LSTR	LSTR S1 S2 D	Adjusts Floating decimal point point Double Real Number Data (S1:number, S2:places) to String format to save in D		
	LSTRP	LSTRP S1 S2 D			
Convert String to Real Number	STRR	STRR S D	Converts String S to Floating decimal point point Real Number Data to save in D	○	X
	STRRP	STRRP S D			
	STRL	STRL S D	Converts String S to Floating decimal point point Double Real Number Data to save in D		
	STRLP	STRLP S D			
ASCII Conversion	ASC	ASC S D cw	Converts BIN Data to ASCII in Nibble unit, based on cw's format from S to save in D	○	○
	ASCP	ASCP S D cw			
HEX Conversion	HEX	HEX S D N	Converts 2N ASCII saved in N words from S in byte unit to Nibble unit of Hexadecimal BIN so to save in D	○	○
	HEXP	HEXP S D N			
String Extract from Right	RIGHT	RIGHT S D N	Extracts n string from S string's final letter to save in starting D	○	○
	RIGHTP	RIGHTP S D N			
String Extract from Left	LEFT	LEFT S D N	Extracts n string from S string's first letter to save in starting D	○	○
	LEFTP	LEFTP S D N			
String Random Extract	MID	MID S1 S2 D	Extracts string which conforms to S2 condition among S1 string to save in starting D	○	○
	MIDP	MIDP S1 S2 D			

(15) String process instruction (continued)

Classification	Designations	Symbol	Description	Basic Steps	Page
String Random Replace	REPLACE	REPLACE | S1 | D | S2	Processes S1 String as applicable to S2 Condition to save in D String	○	○
	REPLACEP	REPLACEP | S1 | D | S2			
String Find	FIND	FIND | S1 | S2 | D | N	Finds identical String to S2 in S1 ~ N data to save the absolute position in D	○	○
	FINDP	FINDP | S1 | S2 | D | N			
Parse Real Number to BCD	RBCD	RBCD | S1 | S2 | D	Adjusts Floating decimal point point Real Number Data S1 to S2 place to convert to BCD, and then to save in D	○	X
	RBCDP	RBCDP | S1 | S2 | D			
	LBCD	LBCD | S1 | S2 | D	Adjusts Floating decimal point point Double Real Number Data S1 to S2 place to convert to BCD, and then to save in D		
	LBCDP	LBCDP | S1 | S2 | D			
Convert BCD Data to Real Number	BCDR	BCDR | S1 | S2 | D	Adjusts BCD Data S1 to S2 place to convert to Floating decimal point point Real Number, and then to save in D	○	X
	BCDRP	BCDRP | S1 | S2 | D			
	BCDL	BCDR | S1 | S2 | D	Adjusts BCD Data S1 to S2 place to convert to Floating decimal point point Double Real Number, and then to save in D		
	BCDLP	BCDLP | S1 | S2 | D			

(16) Special function instruction

Classification	Designations	Symbol	Description	Basic Steps	Page
SIN Operation	SIN	SIN S D	SIN(S+1,S) → (D+1,D)	○	○
	SINP	SINP S D			
COS Operation	COS	COS S D	COS(S+1,S) → (D+1,D)	○	○
	COSP	COSP S D			
TAN Operation	TAN	TAN S D	TAN(S+1,S) → (D+1,D)	○	○
	TANP	TANP S D			
RAD Conversion	RAD	RAD S D	(S+1,S) → (D+1,D) Converts angle to radian	○	○
	RADP	RADP S D			
Angle Conversion	DEG	DEG S D	(S+1,S) → (D+1,D) Converts radian to angle	○	○
	DEGP	DEGP S D			
Square Root Operation	SQRT	SQRT S D	$\sqrt{(S+1,S)}$ → (D+1,D)	○	○
	SQRTP	SQRTP S D			

(17) Data control instruction

Classification	Designations	Symbol	Description	Basic Steps	Page
Limit Control	LIMIT	LIMIT S1 S2 S3 D	If S1 < S2, then D = S2 If S2 < S1 < S3, then D = S1 If S3 < S1, then D = S3	○	○
	LIMITP	LIMITP S1 S2 S3 D			
	DLIMIT	DLIMIT S1 S2 S3 D			
	DLIMITP	DLIMITP S1 S2 S3 D			
Dead-zone Control	DZONE	DZONE S1 S2 S3 D	If S1 < -S2, then D = S1+S2-S2(S3/100) If –S2 < S1 < S2, then D = (S3/100)S1 If S1 < S2, then D = S1-S2+S2(S3/100)	○	○
	DZONEP	DZONEP S1 S2 S3 D			
	DDZONE	DDZONE S1 S2 S3 D			
	DDZONEP	DDZONEP S1 S2 S3 D			
Vertical-zone Control	VZONE	VZONE S1 S2 S3 D	If S1 < -S2(S3/100), then D = S1-S2+S2(S3/100) If –S2(S3/100) <S1< S2(S3/100), then D = (100/S3)S1 If S1 < S2(S3/100), then D = S1+S2-S2(S3/100)	○	○
	VZONEP	VZONEP S1 S2 S3 D			
	DVZONE	DVZONE S1 S2 S3 D			
	DVZONEP	DVZONEP S1 S2 S3 D			
Built-in PID Control Instruction	PIDRUN	PIDRUN N	Operates PID Loop N	○	○
	PIDPAUSE	PIDPAUSE N	Stops PID Loop N momentarily	○	X
	PIDPRMT	PIDPRMT S N	Changes PID Loop N’s Parameter. (SV(word) / Ts(word) / Kp(real) / Ti(real) / Td(real))	○	X
	PIDAT	PIDRUN N	Start of PID loop Auto-tuning	X	○
	PIDCAS	PIDPRMT S N	Start of PID loop cascade operation	X	○
	PIDHBD	PIDPRMT S N	Start of PID loop combination operation	X	○

(18) Time related instruction

Classification	Designations	Symbol	Description	Support	
				XGK	XGB
Date/Time Data Read	DATERD	DATERD D	Reads PLC Time to save in D ~ D+6 (Yr/Mn/Dt/Hr/Mn/Sd/Day)	○	X
	DATERDP	DATERDP D			
Date/Time Data Write	DATEWR	DATEWR S	Input S ~ S+6's Time Data in PLC (Yr/Mn/Dt/Hr/Mn/Sd/Day)	○	X
	DATEWRP	DATEWRP S			
Time Data Increase	ADDCLK	ADDCLK S1 S2 D	Adds S1 ~ S1+2 & S2 ~ S2+2 Time Data to save in D ~ D+2 in Time Data format (Hr/Mn/Sd)	○	X
	ADDCLKP	ADDCLKP S1 S2 D			
Time Data Decrease	SUBCLK	SUBCLK S1 S2 D	Extracts S2 ~ S2+2's Time Data from S1 ~ S1+2 to save in D ~ D+2 in Time Data format (Hr/Mn/Sd)	○	X
	SUBCLKP	SUBCLKP S1 S2 D			
Time Data Format Conversion	SECOND	SECOND S D	Converts Time Data S ~ S+2 to seconds to save in double word D	○	X
	SECONDP	SECONDP S D			
	HOUR	HOUR S D	Converts the seconds saved in double word S to Hr/Mn/Sd to save in D ~ D+2	○	X
	HOURP	HOURP S D			

(19) Divergence instruction

Classification	Designations	Symbol	Description	Support	
				XGK	XGB
Divergence Instruction	JMP	JMP LABEL	Jumps to LABEL location	○	○
	LABEL	LABEL ( )	Jumps and designates the location to move to		
Subroutine Call Functional	CALL	CALL LABEL	Calls Function applicable to LABEL	○	○
	CALLP	CALLP LABEL			
	SBRT	SBRT LABEL	Designates Function to be called by CALL		
	RET	RET	RETURN		

(20) Loop instruction

Classification	Designations	Symbol	Description	Support	
				XGK	XGB
Loop Instruction	FOR	FOR N	Operates FOR~NEXT section n times	○	○
	NEXT	NEXT			
	BREAK	BREAK	Escapes from FOR~NEXT section	○	○

(21) Flag instruction

Classification	Designations	Symbol	Description	Support	
				XGK	XGB
Carry Flag Set, Reset	STC	STC	Carry Flag (F0112) SET	○	○
	CLC	CLC	Carry Flag (F0112) RESET		
Error Flag Clear	CLE	CLE	Error Latch Flag (F0115) RESET	○	○

(22) System instruction

Classification	Designations	Symbol	Description	Support	
				XGK	XGB
Error Display	FALS	FALS n	Self Diagnosis (Error Display)	○	○
Scan Cluck	DUTY	DUTY D n1 n2	On during n1 Scan, Off during n2 Scan	○	○
Time Cluck	TFLK	TFLK D1 S1 S2 D2	On during S1 set time, Off during S2 set time	○	○
WDT Initialize	WDT	WDT	Watch Dog Timer Clear	○	○
	WDTP	WDTP			
Output Control	OUTOFF	OUTOFF	All Output Off	○	○
Operation Stop	STOP	STOP	Finishes applicable scan to end PLC Operation	○	○
Emergent Operation Stop	ESTOP	ESTOP	Ends PLC operation right after Instruction executed	○	○

(23) Interrupt related instruction

Classification	Designations	Symbol	Description	Support	
				XGK	XGB
All Channels Interrupt Setting	EI	EI	All Channels Interrupt allowed	○	○
	DI	DI	All Channel Interrupt prohibited		
Individual Channel Interrupt Setting	EIN	EIN N	Individual Channel Interrupt allowed	○	○
	DIN	DIN N	Individual Channel Interrupt prohibited		

(24) Sign reversion instruction

Classification	Designations	Symbol	Description	Support	
				XGK	XGB
2's complement	NEG	NEG D	Saves D value again in D with 2's complement taken	○	○
	NEGP	NEGP D			
	DNEG	DNEG D	Saves (D+1,D) value again in (D+1,D) with 2's complement taken		
	DNEGP	DNEGP D			
Real Number Data Sign Reverse	RNEG	RNEG D	Reverses D Real Number Sign then to save again	○	○
	RNEGP	RNEGP D			
	LNEGR	LNEG D	Reverses D Double Real Number Sign then to save again		
	LNEGP	LNEGP D			
Absolute Value Operation	ABS	ABS D	Converts D highest Bit to 0	○	○
	ABSP	ABSP D			
	DABS	DABS D	Converts (D+1,D) highest Bit to 0		
	DABSP	DABSP D			

(25) File related instruction

Classification	Designations	Symbol	Description	Support	
				XGK	XGB
Block Conversion	RSET	RSET S	Changes Block Number of file register to S Number	○	X
	RSETP	RSETP S			
Flash Word Data Transfer	EMOV	EMOV S1 S2 D	Transfers S2 word data in S1 Block to D	o	X
	EMOVP	EMOVP S1 S2 D			
Flash Double Word Data Transfer	EDMOV	EDMOV S1 S2 D	Transfers S2+1, S2 double word data in S1 Block to D+1, D		
	EDMOVP	EDMOVP S1 S2 D			
Block Read	EBREAD	EBREAD S1 S2	Reads Flash Memory Block	○	X
Block Write	EBWRITE	EBWRITE S1 S2	Writes Flash Memory Block	○	X
Block Compare	EBCMP	EBCMP S1 S2 D1 D2	Compares R Area's Bank with Flash Area's Block	○	X

Appendix 4.4 Special/Communication Instruction

(1) Communication module related instruction

Classification	Designations	Symbol	Description	Support	
				XGK	XGB
Station No. Set	P2PSN	P2PSN n1 n2 n3	Sets opposite station No. for P2P Communication. n1:P2P No., n2:Block, n3:Station No.	○	X
Read Area Set (WORD)	P2PWRD	P2PWRD n1 n2 n3 n4 n5	Sets word data Read Area n1:P2P No., n2:Block, n3:Variable sequence, n4:Variable Size, n5:Device	○	X
Write Area Set (WORD)	P2PWWR	P2PWWR n1 n2 n3 n4 n5	Sets word data Write Area n1:P2P No., n2:Block, n3:Variable sequence, n4:Variable Size, n5:Device	○	X
Read Area Set (BIT)	P2PBRD	P2PBRD n1 n2 n3 n4 n5	Sets bit data Read Area n1:P2P No., n2:Block, n3:Variable sequence, n4: Variable Size, n5:Device	○	X
Write Area Set (BIT)	P2PBWR	P2PBWR n1 n2 n3 n4 n5	Sets bit data Write Area n1:P2P No., n2:Block, n3:Variable sequence,n4:Variable Size, n5:Device	○	X

(2) Special module common instruction

Classification	Designations	Symbol	Description	Support	
				XGK	XGB
Special Module Read/Write	GET	GET sl S D N	Reads data of special module memory is installed on	○	○
	GETP	GETP sl S D N			
	PUT	PUT sl S1 S2 N	Writes data on special module memory is installed on	○	○
	PUTP	PUTP sl S1 S2 N			

(3) Exclusive positioning instruction

Classification	Designations	Symbol	Description	Support	
				XGK	XGB
Return to Origin Point	ORG	ORG | sl | ax	Instructions Positioning Module's ax axis installed on sl slot to return to Origin Point	○	○
Floating Origin Point	FLT	FLT | sl | ax	Instructions Positioning Module's ax axis installed on sl slot to set Floating Origin Point	○	○
Direct Start	DST	DST | sl | ax | n1 | n2 | n3 | n4 | n5	Instructions Positioning Module's ax axis installed on sl slot to start directly with Target Position(n1), Target Speed(n2), Dwell Time(n3), M Code(n4) & Control Word(n5)	○	○
Indirect Start	IST	IST | sl | ax | n	Instructions Positioning Module's ax axis installed on sl slot to start n step indirectly	○	○
Linear Interpolation	LIN	LIN | sl | ax | n1 | n2	Instructions Positioning Module's ax axis installed on sl slot to let n2 axes operate n1 step by Linear Interpolation	○	○
Circular Interpolation	CIN	CIN | sl | ax | n1 | n2	Instructions Positioning Module's ax axis installed on sl slot to let n2 axes operate n1 step by Circular Interpolation	○	X
Simultaneous Start	SST	SST | sl | ax | n1 | n2 | n3 | n4	Instructions Positioning Module's ax axis installed on sl slot to let n4 axes operate n1(X), n2(Y), n3(Z) steps by Simultaneous Start	○	○
Speed/Position Control Switch	VTP	VTP | sl | ax	Instructions Positioning Module's ax axis installed on sl slot to switch Speed to Position Control	○	○
Position/Speed Control Switch	PTV	PTV | sl | ax	Instructions Positioning Module's ax axis installed on sl slot to switch Position to Speed Control	○	○
Decelerated Stop	STP	STP | sl | ax	Instructions Positioning Module's ax axis installed on sl slot to stop as decelerated.	○	○
Skip	SKP	SKP | sl | ax	Instructions Positioning Module's ax axis installed on sl slot to skip	○	X
Position Synchronization	SSP	SSP | sl | ax | n1 | n2 | n3	Instructions Positioning Module's ax axis installed on sl slot to do Position Sync with main axis of n3, n1 sync-positioned and n2 step operated	○	○
Speed Synchronization	SSS	SSS | sl | ax | n1 | n2 | n3	Instructions Positioning Module's ax axis installed on sl slot to do Speed Sync with main axis of n3, n1 master and n2 slave	○	○
Position Override	POR	POR | sl | ax | n	Instructions Positioning Module's ax axis installed on sl slot to override Position to change the target position to n	○	○

(4) Exclusive position control instruction (continued)

Classification	Designations	Symbol	Description	Support	
				XGK	XGB
Speed Override	SOR	SOR | sl | ax | n	Instructions Positioning Module's ax axis installed on sl slot to override Speed to change the target speed to n	○	○
Position specified Speed Override	PSO	PSO | sl | ax | n	Instructions Positioning Module's ax axis installed on sl slot to override position specified speed to change the target speed to n2 from n1 position	○	○
Continuous Operation	NMV	NMV | sl | ax	Instructions Positioning Module's ax axis installed on sl slot to operate continuously to n step	○	X
Inching	INCH	INCH | sl | ax | n	Instructions Positioning Module's ax axis installed on sl slot to inch to n position	○	○
Return to Position Previous to Manual Operation	RTP	RTP | sl | ax	Instructions Positioning Module's ax axis installed on sl slot to return to position previous to manual operation	○	X
Operation Step Change	SNS	SNS | sl | ax | n	Instructions Positioning Module's ax axis installed on sl slot to change operation step to n	○	○
Repeated Operation Step Change	SRS	SRS | sl | ax | n	Instructions Positioning Module's ax axis installed on sl slot to change repeated operation step to n	○	X
M Code Off	MOF	MOF | sl | ax	Instructions Positioning Module's ax axis installed on sl slot to make M code off	○	○
Present Position Change	PRS	PRS | sl | ax | n	Instructions Positioning Module's ax axis to change present position to n	○	○
Zone Allowed	ZOE	ZOE | sl | ax	Allows zone output of Positioning Module installed on sl slot	○	X
Zone Prohibited	ZOD	ZOD | sl | ax	Prohibits zone output of Positioning Module installed on sl slot	○	X
Encoder Value change	EPRS	EPRS | sl | ax | n	Changes Encoder Value of Positioning Module installed on sl slot to n	○	X
Teaching	TEA	TEA | sl | ax | n1 | n2 | n3 | n4	Changes n1 step's target position or speed of Positioning Module's ax axis installed on sl slot	○	X
Teaching Array	TEAA	TEAA | sl | ax | n1 | n2 | n3 | n4	Changes multiple target positions or speed of Positioning Module's ax axis installed on sl slot	○	X
Emergent Stop	EMG	EMG | sl | ax	Instructions Positioning Module installed on sl slot to perform Emergent Stop	○	○

(5) Exclusive position control instruction (continued)

Classification	Designations	Symbol	Description	Support	
				XGK	XGB
Error Reset	CLR	CLR sl ax n	Resets Error originated from Positioning Module's ax axis installed on sl slot	○	○
Error History Reset	ECLR	ECLR sl ax	Deletes Error History originated from Positioning Module's ax axis installed on sl slot	○	X
Point Operation	PST	PST sl ax n	Performs Point Operation of Positioning Module's ax axis installed on sl slot	○	X
Basic Parameter Teaching	TBP	TBP sl ax n1 n2	Changes n2 to n1 among basic parameters of Positioning Module's ax axis installed on sl slot	○	X
Extended Parameter Teaching	TEP	TEP sl ax n1 n2	Changes n2 to n1 among extended parameters of Positioning Module's ax axis installed on sl slot	○	X
Return to Origin Point Parameter Teaching	THP	THP sl ax n1 n2	Changes n2 to n1 among returned parameters to origin point of Positioning Module's ax axis installed on sl slot	○	X
Manual Operation Parameter Teaching	TMP	TMP sl ax n1 n2	Changes n2 to n1 among manual operation parameters of Positioning Module's ax axis installed on sl slot	○	X
Input Signal Parameter Teaching	TSP	TSP sl ax n	Changes input signal parameter of Positioning Module's ax axis installed on sl slot to the value set in n1	○	X
Common Parameter Teaching	TCP	TCP sl ax n1 n2	Changes n2 to n1 among common parameters of Positioning Module installed on sl slot	○	X
Parameter Save	WRT	WRT sl ax n	Instructions Positioning Module's ax axis installed on sl slot to save present parameter of n axis in flash ROM.	○	○
Present State Read	SRD	SRD sl ax D	Reads and saves present state of Positioning Module's ax axis installed on sl slot in D area of CPU	○	X
Point Operation Step Write	PWR	PWR sl ax S n1	Writes value of S area of CPU on point operation step area of Positioning Module's ax axis installed on sl slot in	○	X
Plural Teaching Data Write	TWR	TWR sl ax S n1	Writes n value of S area of CPU on plural teaching dada area of Positioning Module's ax axis installed on sl slot in	○	X

Warranty

1. Warranty Period
The product you purchased will be guaranteed for 18 months from the date of manufacturing.

2. Scope of Warranty
Any trouble or defect occurring for the above-mentioned period will be partially replaced or repaired. However, please note the following cases will be excluded from the scope of warranty.

(1) Any trouble attributable to unreasonable condition, environment or handling otherwise specified in the manual,
(2) Any trouble attributable to others' products,
(3) If the product is modified or repaired in any other place not designated by the company,
(4) Due to unintended purposes
(5) Owing to the reasons unexpected at the level of the contemporary science and technology when delivered.
(6) Not attributable to the company; for instance, natural disasters or fire

3. Since the above warranty is limited to PLC unit only, make sure to use the product considering the safety for system configuration or applications.

Environmental Policy

LSIS Co.,Ltd. supports and observes the environmental policy as below.

Environmental Management

LSIS considers the environmental preservation as the preferential management subject and every staff of LSIS use the reasonable endeavors for the pleasurably environmental preservation of the earth.

About Disposal

LSIS' PLC unit is designed to protect the environment. For the disposal, separate aluminum, iron and synthetic resin (cover) from the product as they are reusable.

LSIS values every single customers.

Quality and service come first at LSIS.

Always at your service, standing for our customers.

http://eng.lsis.biz

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※ LSIS constantly endeavors to improve its product so that information in this manual is subject to change without notice.

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